# dsPIC33FJ16(GP/MC)101/102 AND dsPIC33FJ32(GP/MC)101/102/104

# 16-Bit Digital Signal Controllers (up to 32-Kbyte Flash and 2-Kbyte SRAM)

## Operating Conditions

- 3.0V to 3.6V, -40°C to +125°C, DC to 16 MIPS
- 3.0V to 3.6V, -40°C to +150°C, DC to 5 MIPS

## Core: 16-Bit dsPIC33F CPU

- Code-Efficient (C and Assembly) Architecture
- Two 40-Bit Wide Accumulators
- Single-Cycle (MAC/MPY) with Dual Data Fetch
- Single-Cycle Mixed-Sign MUL plus Hardware Divide
- 32-Bit Multiply Support

## Clock Management

- ±0.25% Internal Oscillator
- Programmable PLLs and Oscillator Clock Sources
- Fail-Safe Clock Monitor (FSCM)
- Independent Watchdog Timer (WDT)
- Fast Wake-up and Start-up

## Power Management

- Low-Power Management modes (Sleep, Idle, Doze)
- Integrated Power-on Reset and Brown-out Reset
- 1 mA/MHz Dynamic Current (typical)
- 30 µA $I_{PD}$ Current (typical)

## PWM

- Up to Three PWM Pairs
- Two Dead-Time Generators
- 31.25 ns PWM Resolution
- PWM Support for:
  - Inverters, PFC, UPS
  - BLDC, PMSM, ACIM, SRM
- Class B-Compliant Fault Inputs
- Possibility of ADC Synchronization with PWM Signal

## Advanced Analog Features

- ADC module:
  - 10-bit, 1.1 Msps with four S&H
  - Four analog inputs on 18-pin devices and up to 14 analog inputs on 44-pin devices
- Flexible and Independent ADC Trigger Sources
- Three Comparator modules
- Charge Time Measurement Unit (CTMU):
  - Supports mTouch™ capacitive touch sensing
  - Provides high-resolution time measurement (1 ns)
  - On-chip temperature measurement

## Timers/Output Compare/Input Capture

- Up to Five General Purpose Timers:
  - One 16-bit and up to two 32-bit timers/counters
- Two Output Compare modules
- Three Input Capture modules
- Peripheral Pin Select (PPS) to allow Function Remap

## Communication Interfaces

- UART module (4 Mbps):
  - With support for LIN/J2602 Protocols and IrDA®
- 4-Wire SPI module (8 MHz maximum speed):
  - Remappable pins in 32-Kbyte Flash devices
- $I^2C$™ module (400 kHz)

## Input/Output

- Sink/Source 10 mA or 6 mA, Pin-Specific for Standard $V_{OH}/V_{OL}$, up to 16 mA or 12 mA for Non-Standard $V_{OH}1$
- 5V Tolerant Pins
- Up to 20 Selectable Open-Drain and Pull-ups
- Three External Interrupts (two are remappable)

## Qualification and Class B Support

- AEC-Q100 REV G (Grade 0 -40°C to +150°C)
- Class B Safety Library, IEC 60730, UDE Certified

## Debugger Development Support

- In-Circuit and In-Application Programming
- Up to Three Complex Data Breakpoints
- Trace and Run-Time Watch

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## dsPIC33FJ16(GP/MC)101/102 AND dsPIC33FJ32(GP/MC)101/102/104 PRODUCT FAMILIES

The device names, pin counts, memory sizes and peripheral availability of each device are listed in Table 1. The following pages show their pinout diagrams.

**TABLE 1: dsPIC33FJ16(GP/MC)101/102 DEVICE FEATURES**

| Device | Pins | Program Flash (Kbyte) | RAM (Kbytes) | Remappable Peripherals | | | | | | | Motor Control PWM | PWM Faults | 10-Bit, 1.1 Msps ADC | RTCC | I²C™ | Comparators | CTMU | I/O Pins | Packages |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| | | | | Remappable Pins | 16-bit Timer(1,2) | Input Capture | Output Compare | UART | External Interrupts(3) | SPI | | | | | | | | | |
| dsPIC33FJ16GP101 | 18 | 16 | 1 | 8 | 3 | 3 | 2 | 1 | 3 | 1 | — | — | 1 ADC, 4-ch | Y | 1 | 3 | Y | 13 | PDIP, SOIC |
| | 20 | 16 | 1 | 8 | 3 | 3 | 2 | 1 | 3 | 1 | — | — | 1 ADC, 4-ch | Y | 1 | 3 | Y | 15 | SSOP |
| dsPIC33FJ16GP102 | 28 | 16 | 1 | 16 | 3 | 3 | 2 | 1 | 3 | 1 | — | — | 1 ADC, 6-ch | Y | 1 | 3 | Y | 21 | SPDIP, SOIC, SSOP, QFN |
| | 36 | 16 | 1 | 16 | 3 | 3 | 2 | 1 | 3 | 1 | — | — | 1 ADC, 6-ch | Y | 1 | 3 | Y | 21 | VTLA |
| dsPIC33FJ16MC101 | 20 | 16 | 1 | 10 | 3 | 3 | 2 | 1 | 3 | 1 | 6-ch | 1 | 1 ADC, 4-ch | Y | 1 | 3 | Y | 15 | PDIP, SOIC, SSOP |
| dsPIC33FJ16MC102 | 28 | 16 | 1 | 16 | 3 | 3 | 2 | 1 | 3 | 1 | 6-ch | 2 | 1 ADC, 6-ch | Y | 1 | 3 | Y | 21 | SPDIP, SOIC, SSOP, QFN |
| | 36 | 16 | 1 | 16 | 3 | 3 | 2 | 1 | 3 | 1 | 6-ch | 2 | 1 ADC, 6-ch | Y | 1 | 3 | Y | 21 | VTLA |

**Note 1:** Two out of three timers are remappable.
**2:** One pair can be combined to create one 32-bit timer.
**3:** Two out of three interrupts are remappable.


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**TABLE 2: dsPIC33FJ32(GP/MC)101/102/104 DEVICE FEATURES**

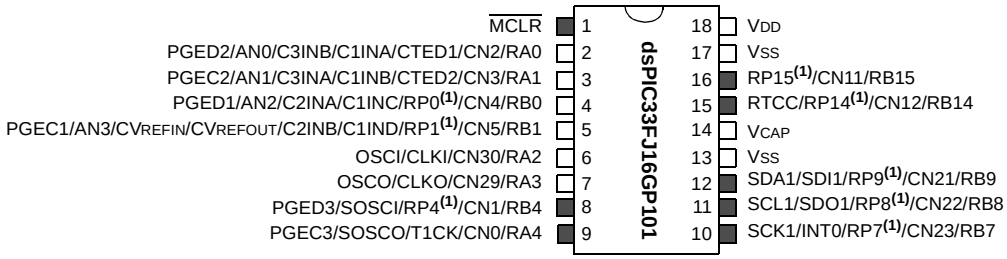
| Device | Pins | Program Flash (Kbyte) | RAM (Kbytes) | Remappable Peripherals | | | | | | | Motor Control PWM | PWM Faults | 10-Bit, 1.1 Msps ADC | RTCC | $I^2C$™ | Comparators | CTMU | I/O Pins | Packages |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| | | | | Remappable Pins | 16-bit Timer(1,2) | Input Capture | Output Compare | UART | External Interrupts(3) | SPI | | | | | | | | | |
| dsPIC33FJ32GP101 | 18 | 32 | 2 | 8 | 5 | 3 | 2 | 1 | 3 | 1 | — | — | 1 ADC, 6-ch | Y | 1 | 3 | Y | 13 | PDIP, SOIC |
| | 20 | 32 | 2 | 8 | 5 | 3 | 2 | 1 | 3 | 1 | — | — | 1 ADC, 6-ch | Y | 1 | 3 | Y | 15 | SSOP |
| dsPIC33FJ32GP102 | 28 | 32 | 2 | 16 | 5 | 3 | 2 | 1 | 3 | 1 | — | — | 1 ADC, 8-ch | Y | 1 | 3 | Y | 21 | SPDIP, SOIC, SSOP, QFN |
| | 36 | 32 | 2 | 16 | 5 | 3 | 2 | 1 | 3 | 1 | — | — | 1 ADC, 8-ch | Y | 1 | 3 | Y | 21 | VTLA |
| dsPIC33FJ32GP104 | 44 | 32 | 2 | 26 | 5 | 3 | 2 | 1 | 3 | 1 | — | — | 1 ADC, 14-ch | Y | 1 | 3 | Y | 35 | TQFP, QFN, VTLA |
| dsPIC33FJ32MC101 | 20 | 32 | 2 | 10 | 5 | 3 | 2 | 1 | 3 | 1 | 6-ch | 1 | 1 ADC, 6-ch | Y | 1 | 3 | Y | 15 | PDIP, SOIC, SSOP |
| dsPIC33FJ32MC102 | 28 | 32 | 2 | 16 | 5 | 3 | 2 | 1 | 3 | 1 | 6-ch | 2 | 1 ADC, 8-ch | Y | 1 | 3 | Y | 21 | SPDIP, SOIC, SSOP, QFN |
| | 36 | 32 | 2 | 16 | 5 | 3 | 2 | 1 | 3 | 1 | 6-ch | 2 | 1 ADC, 8-ch | Y | 1 | 3 | Y | 21 | VTLA |
| dsPIC33FJ32MC104 | 44 | 32 | 2 | 26 | 5 | 3 | 2 | 1 | 3 | 1 | 6-ch | 2 | 1 ADC, 14-ch | Y | 1 | 3 | Y | 35 | TQFP, QFN, VTLA |

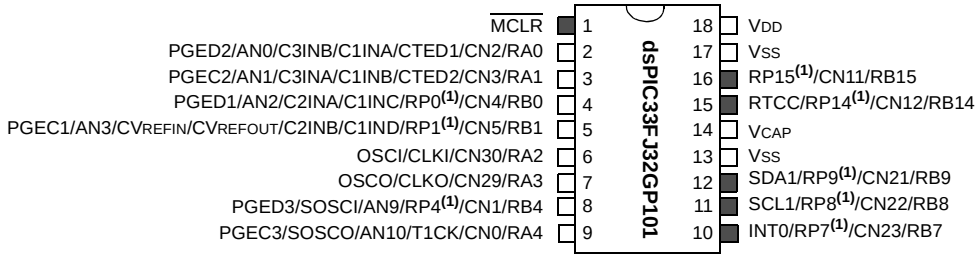
**Note 1:** Four out of five timers are remappable.
**2:** Two pairs can be combined to have up to two 32-bit timers.
**3:** Two out of three interrupts are remappable.

## Pin Diagrams

**18-Pin PDIP/SOIC**

■ = Pins are up to 5V tolerant




**Note 1:** The RPn pins can be used by any remappable peripheral. See Table 1 for the list of available peripherals.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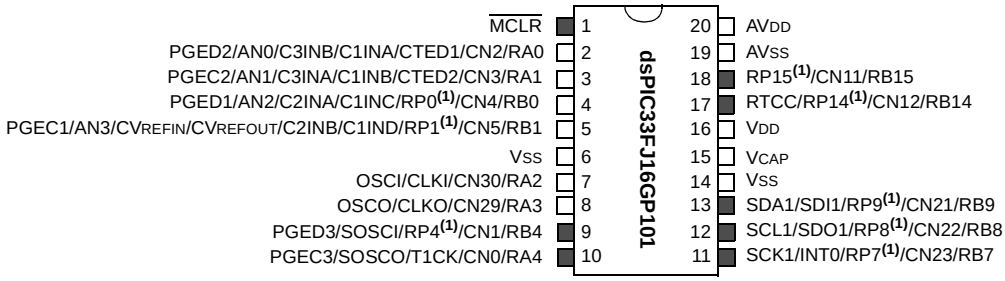
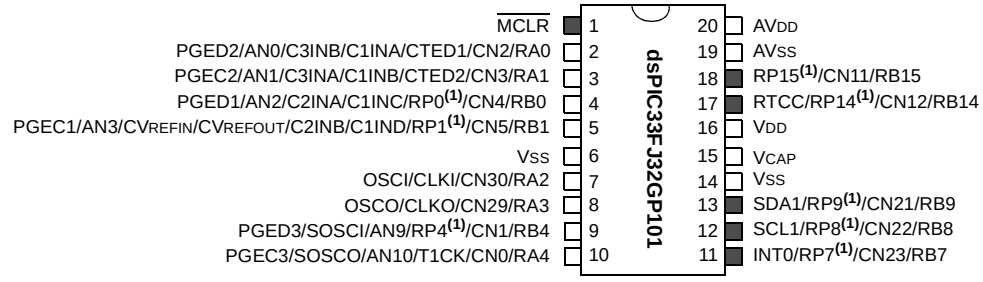
## Pin Diagrams (Continued)

**20-Pin SSOP**

■ = Pins are up to 5V tolerant



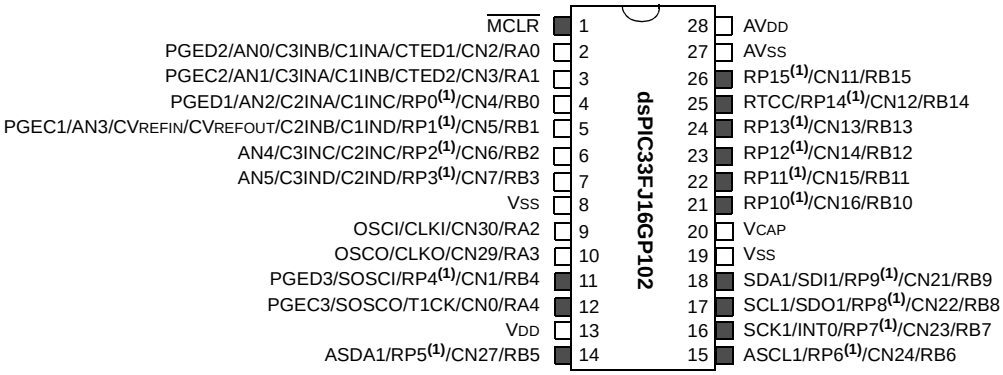



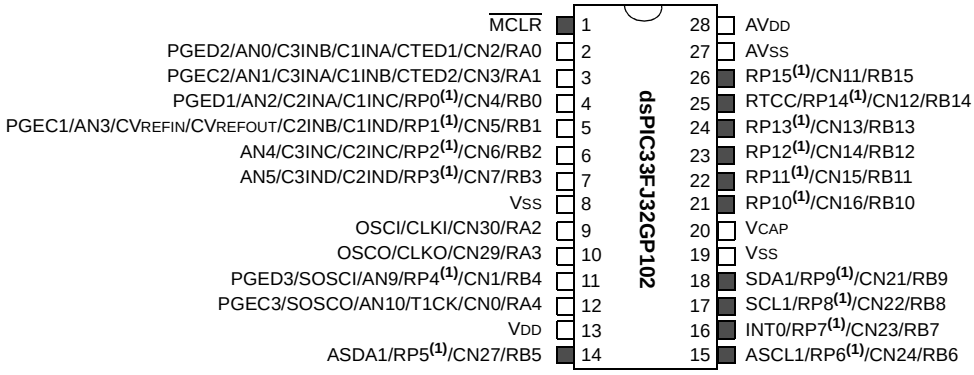

**Note 1:** The RPn pins can be used by any remappable peripheral. See Table 1 for the list of available peripherals.

## Pin Diagrams (Continued)

**28-Pin SPDIP/SOIC/SSOP**

■ = Pins are up to 5V tolerant




**Note 1:** The RPn pins can be used by any remappable peripheral. See Table 1 for the list of available peripherals.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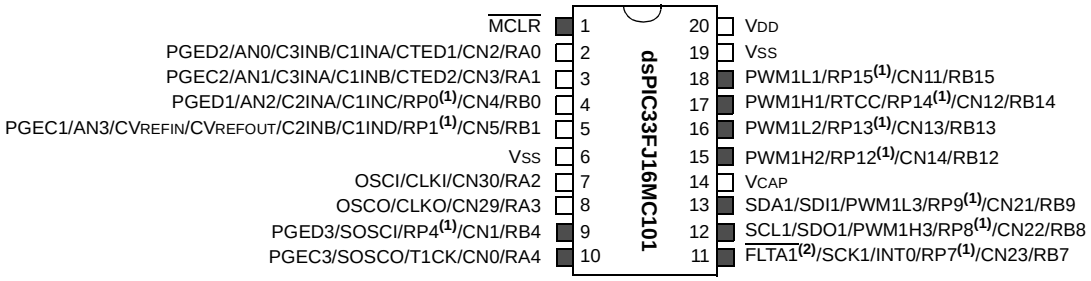
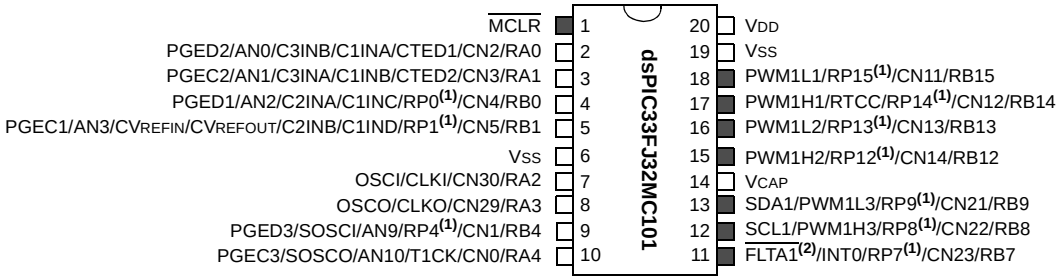
## Pin Diagrams (Continued)

**20-Pin PDIP/SOIC/SSOP**

■ = Pins are up to 5V tolerant



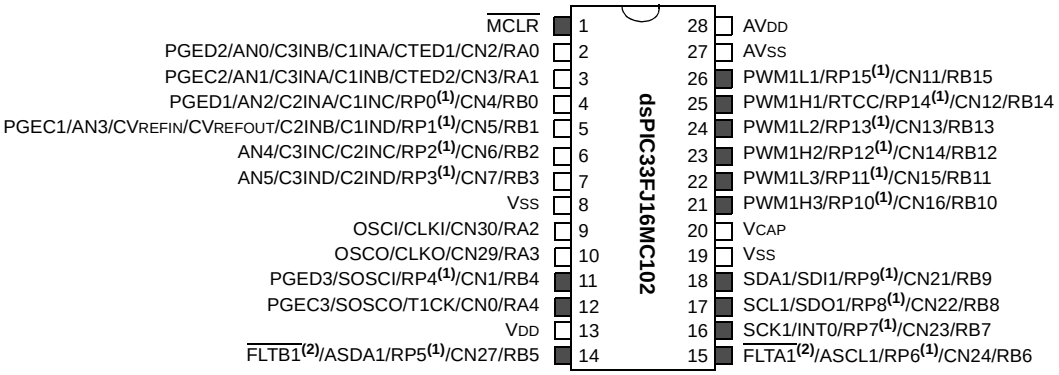

**Note 1:** The RPn pins can be used by any remappable peripheral. See Table 1 for the list of available peripherals.

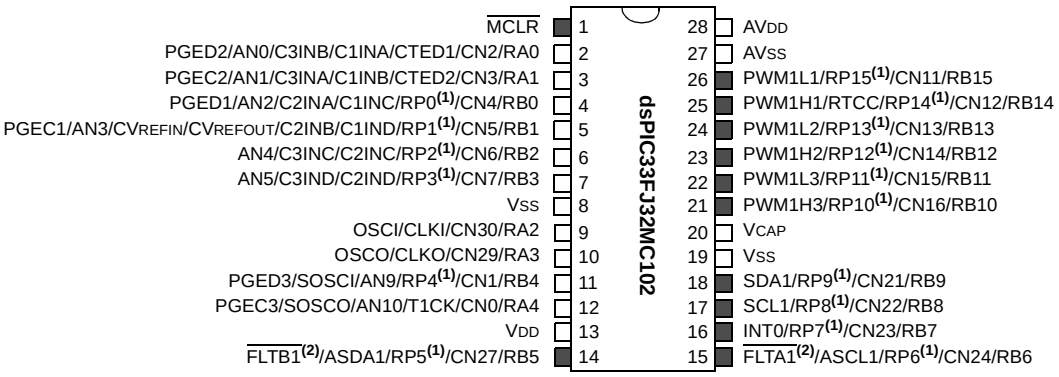
**2:** The PWM Fault pins are enabled and asserted during any Reset event. Refer to **Section 15.2 "PWM Faults"** for more information on the PWM Faults.

## Pin Diagrams (Continued)

**28-Pin SPDIP/SOIC/SSOP**

■ = Pins are up to 5V tolerant




**Note 1:** The RPn pins can be used by any remappable peripheral. See Table 1 for the list of available peripherals.

**2:** The PWM Fault pins are enabled and asserted during any Reset event. Refer to **Section 15.2 "PWM Faults"** for more information on the PWM Faults.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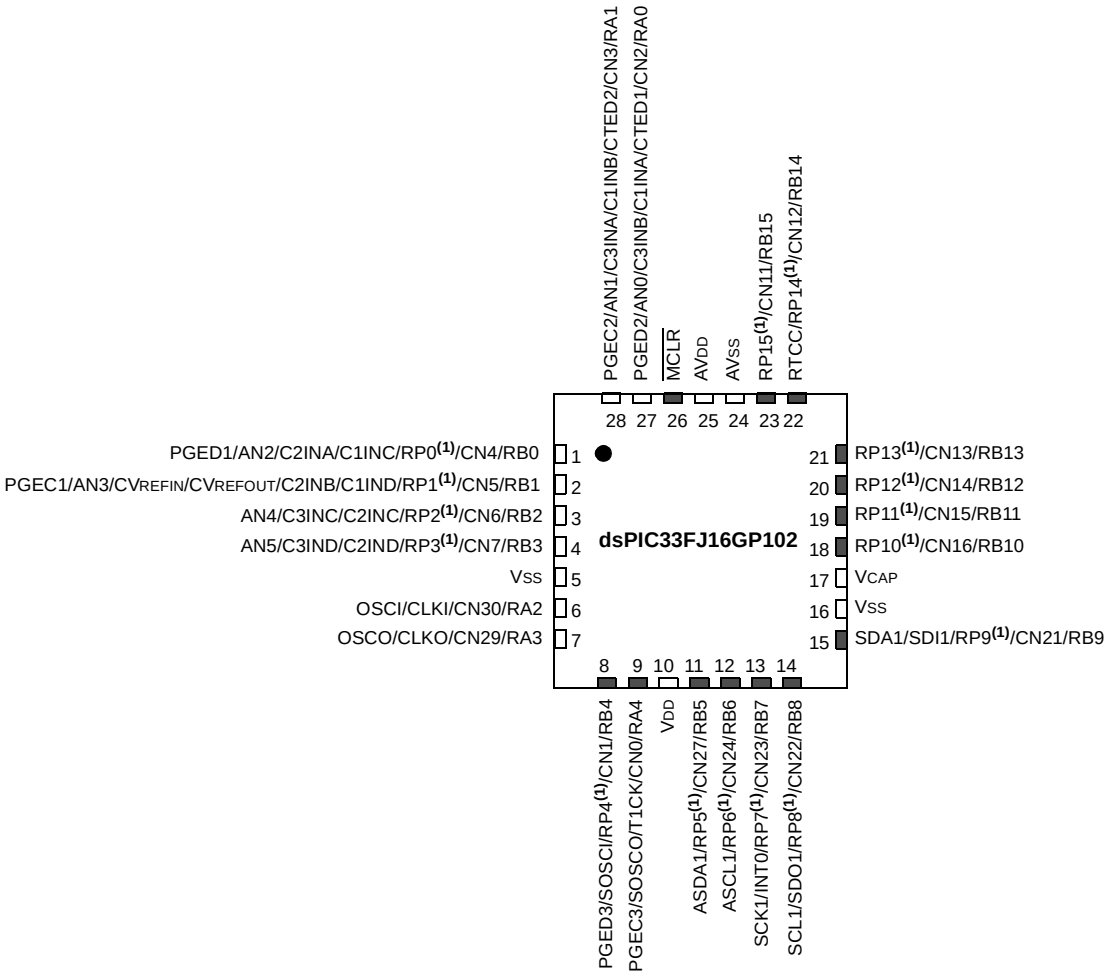
## Pin Diagrams (Continued)

**28-Pin QFN(2)**

■ = Pins are up to 5V tolerant



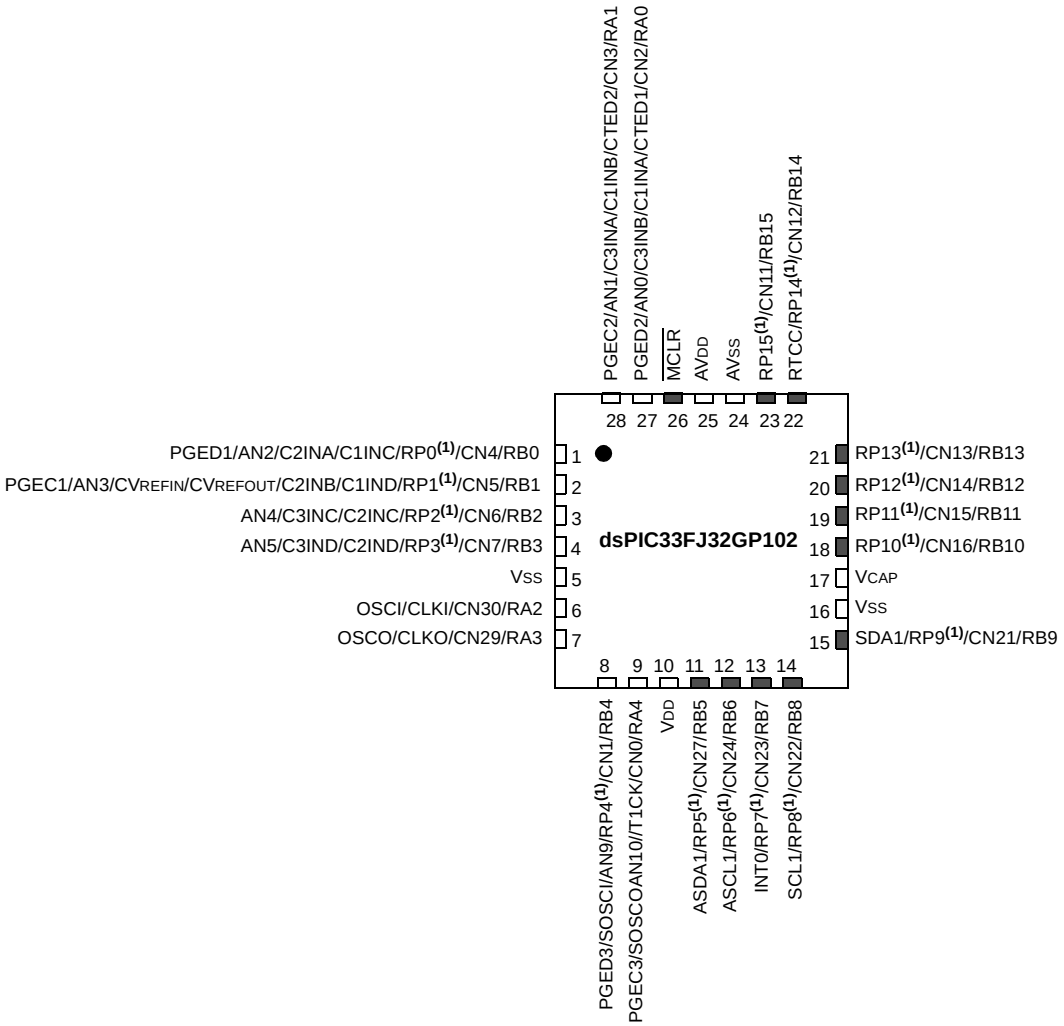

**Note 1:** The RPn pins can be used by any remappable peripheral. See Table 1 for the list of available peripherals.

**2:** The metal pad at the bottom of the device is not connected to any pins and is recommended to be connected to VSS externally.

## Pin Diagrams (Continued)

**28-Pin QFN(2)**

■ = Pins are up to 5V tolerant




**Note 1:** The RPn pins can be used by any remappable peripheral. See Table 1 for the list of available peripherals.

**2:** The metal pad at the bottom of the device is not connected to any pins and is recommended to be connected to VSS externally.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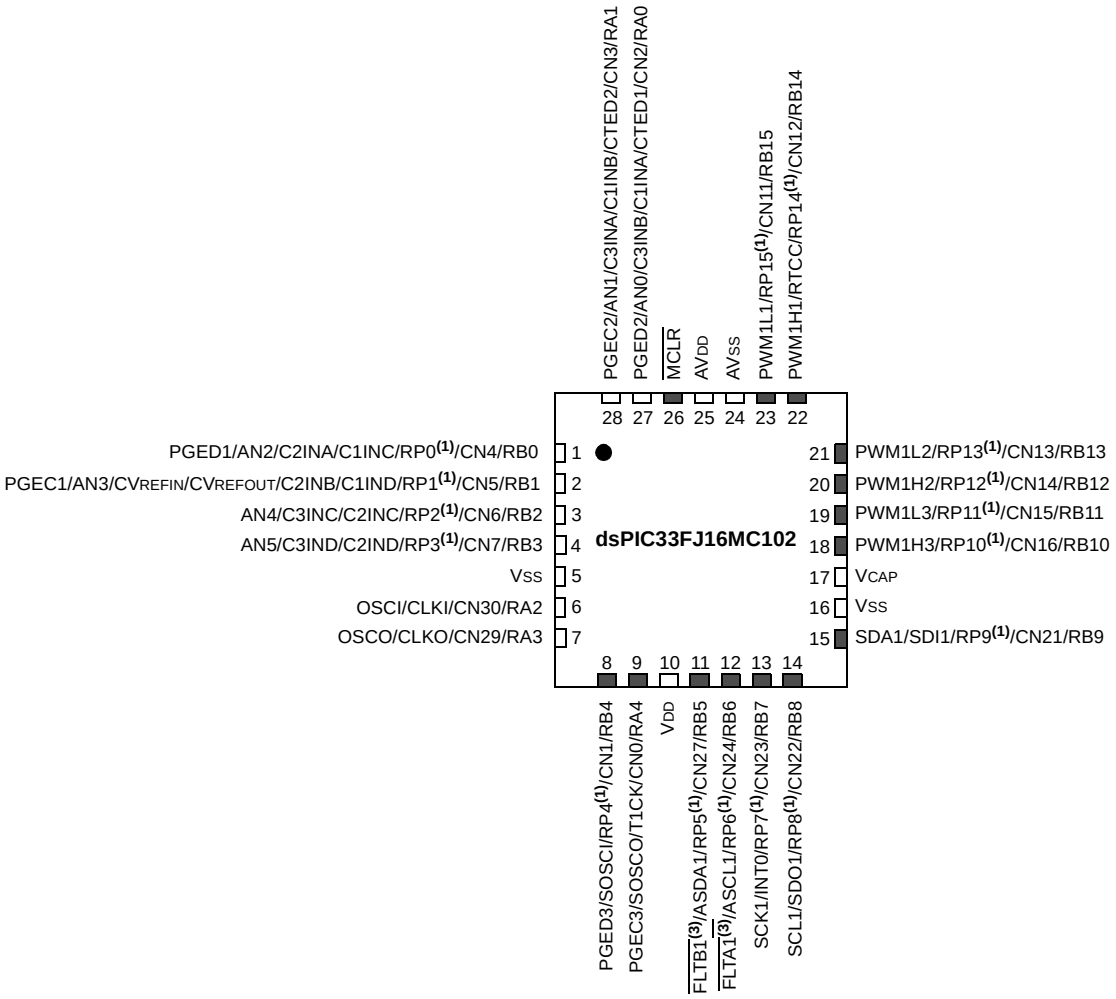
## Pin Diagrams (Continued)

**28-Pin QFN(2)**

= Pins are up to 5V tolerant




**Note 1:** The RPn pins can be used by any remappable peripheral. See Table 1 for the list of available peripherals.

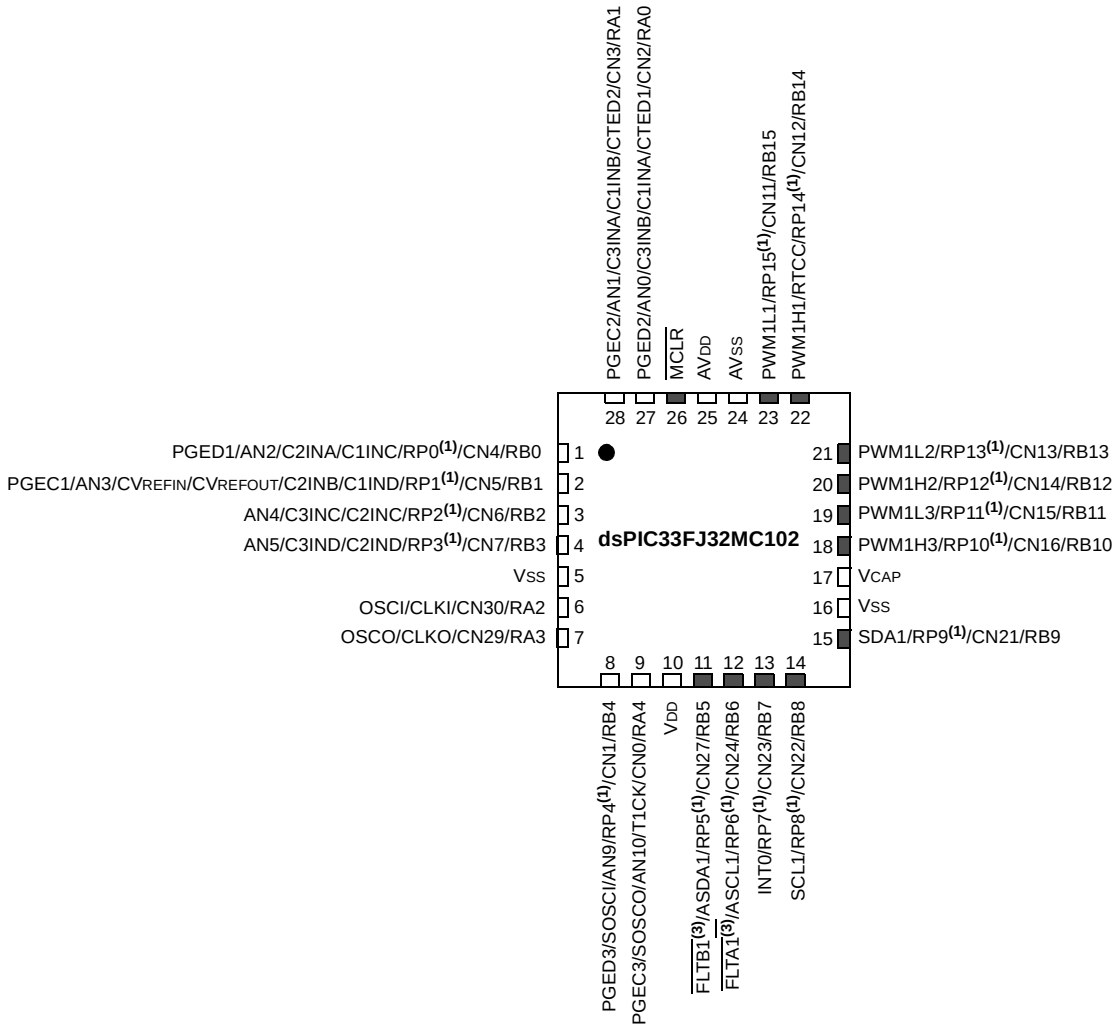
**2:** The metal pad at the bottom of the device is not connected to any pins and is recommended to be connected to VSS externally.

**3:** The PWM Fault pins are enabled and asserted during any Reset event. Refer to **Section 15.2 "PWM Faults"** for more information on the PWM Faults.

## Pin Diagrams (Continued)

**28-Pin QFN(2)**

■ = Pins are up to 5V tolerant




**Note 1:** The RPn pins can be used by any remappable peripheral. See Table 1 for the list of available peripherals.

**2:** The metal pad at the bottom of the device is not connected to any pins and is recommended to be connected to Vss externally.

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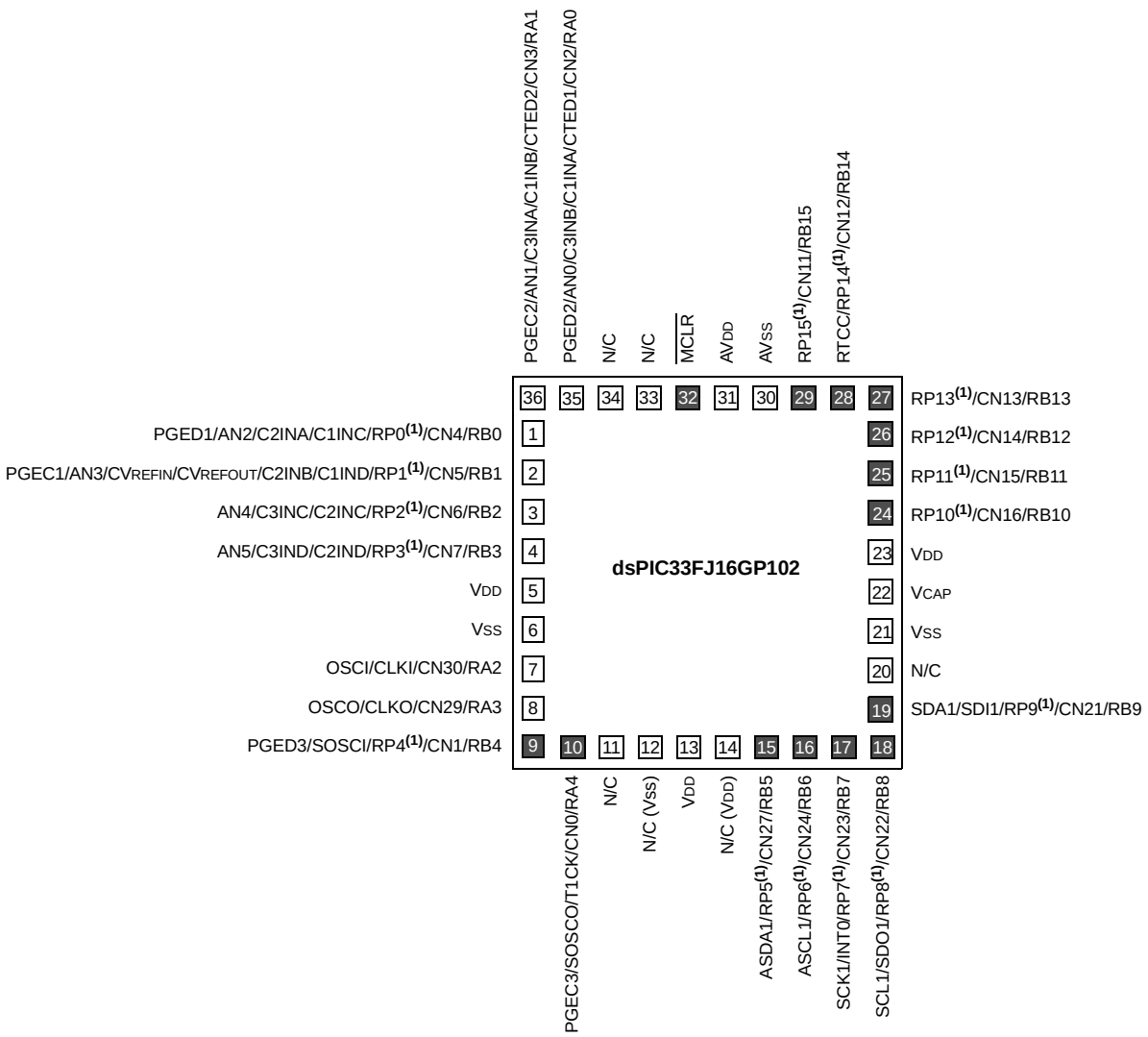
## Pin Diagrams (Continued)

**36-Pin VTLA(2)**

■ = Pins are up to 5V tolerant



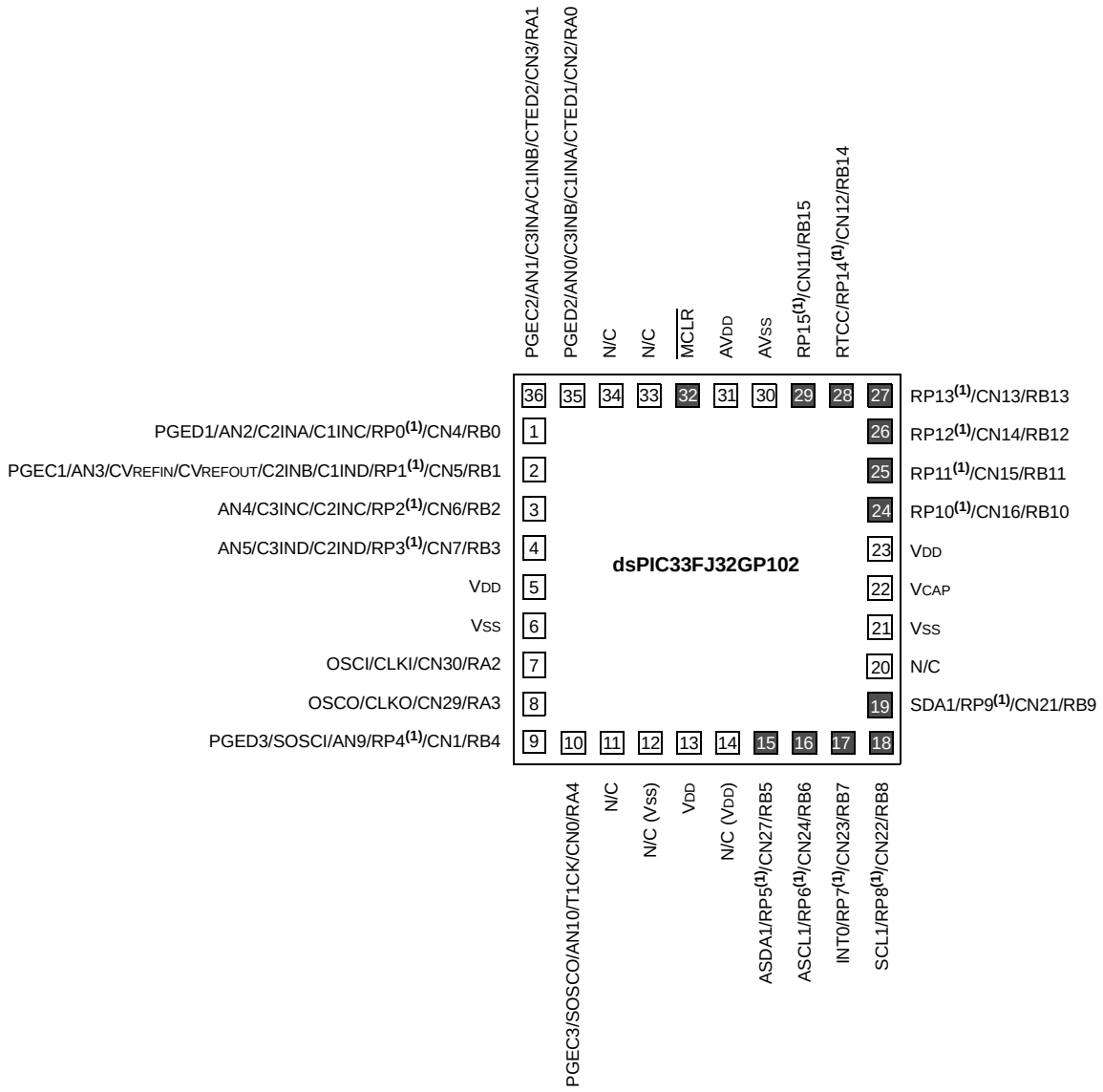

**Note 1:** The RPn pins can be used by any remappable peripheral. See Table 1 for the list of available peripherals.

**2:** The metal pad at the bottom of the device is not connected to any pins and is recommended to be connected to VSS externally.

## Pin Diagrams (Continued)

**36-Pin VTLA(2)**

■ = Pins are up to 5V tolerant




**Note 1:** The RPn pins can be used by any remappable peripheral. See Table 1 for the list of available peripherals.

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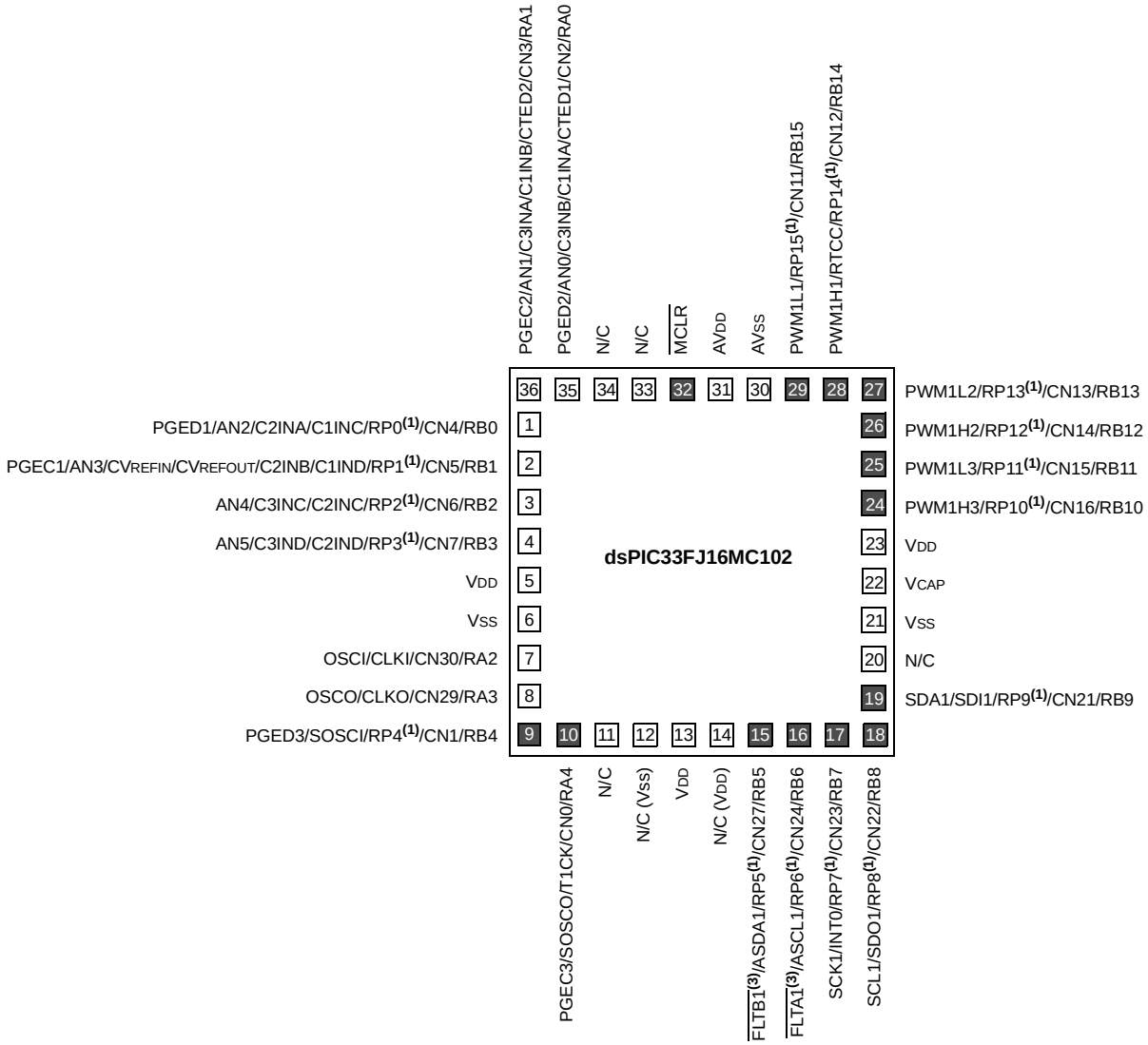
## Pin Diagrams (Continued)

**36-Pin VTLA(2)**

■ = Pins are up to 5V tolerant




**Note 1:** The RPn pins can be used by any remappable peripheral. See Table 1 for the list of available peripherals.

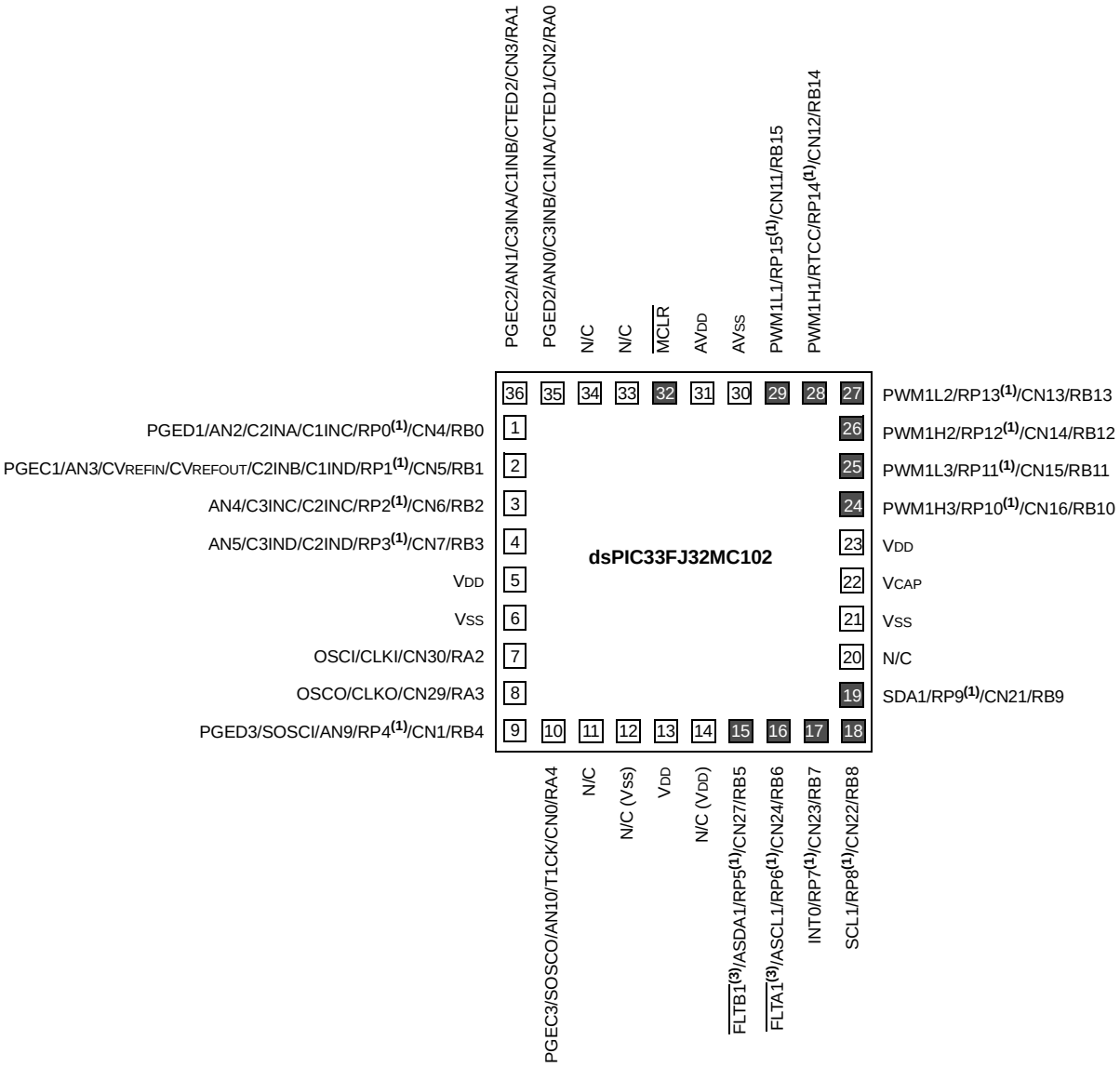
**2:** The metal pad at the bottom of the device is not connected to any pins and is recommended to be connected to VSS externally.

**3:** The PWM Fault pins are enabled and asserted during any Reset event. Refer to **Section 15.2 "PWM Faults"** for more information on the PWM Faults.

## Pin Diagrams (Continued)

**36-Pin VTLA(2)**

■ = Pins are up to 5V tolerant




**Note 1:** The RPn pins can be used by any remappable peripheral. See Table 1 for the list of available peripherals.

**2:** The metal pad at the bottom of the device is not connected to any pins and is recommended to be connected to VSS externally.

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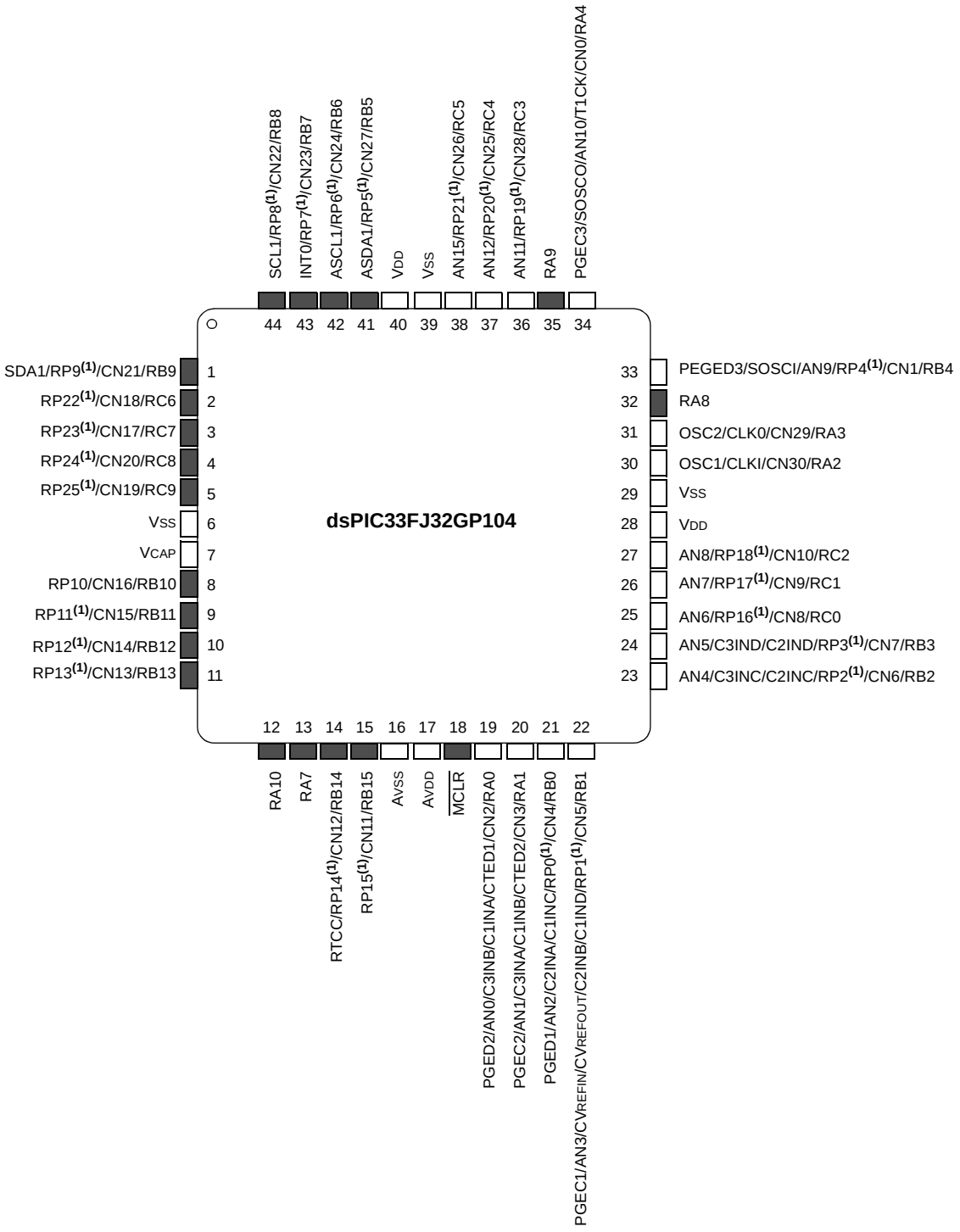
## Pin Diagrams (Continued)

**44-Pin TQFP**

■ = Pins are up to 5V tolerant

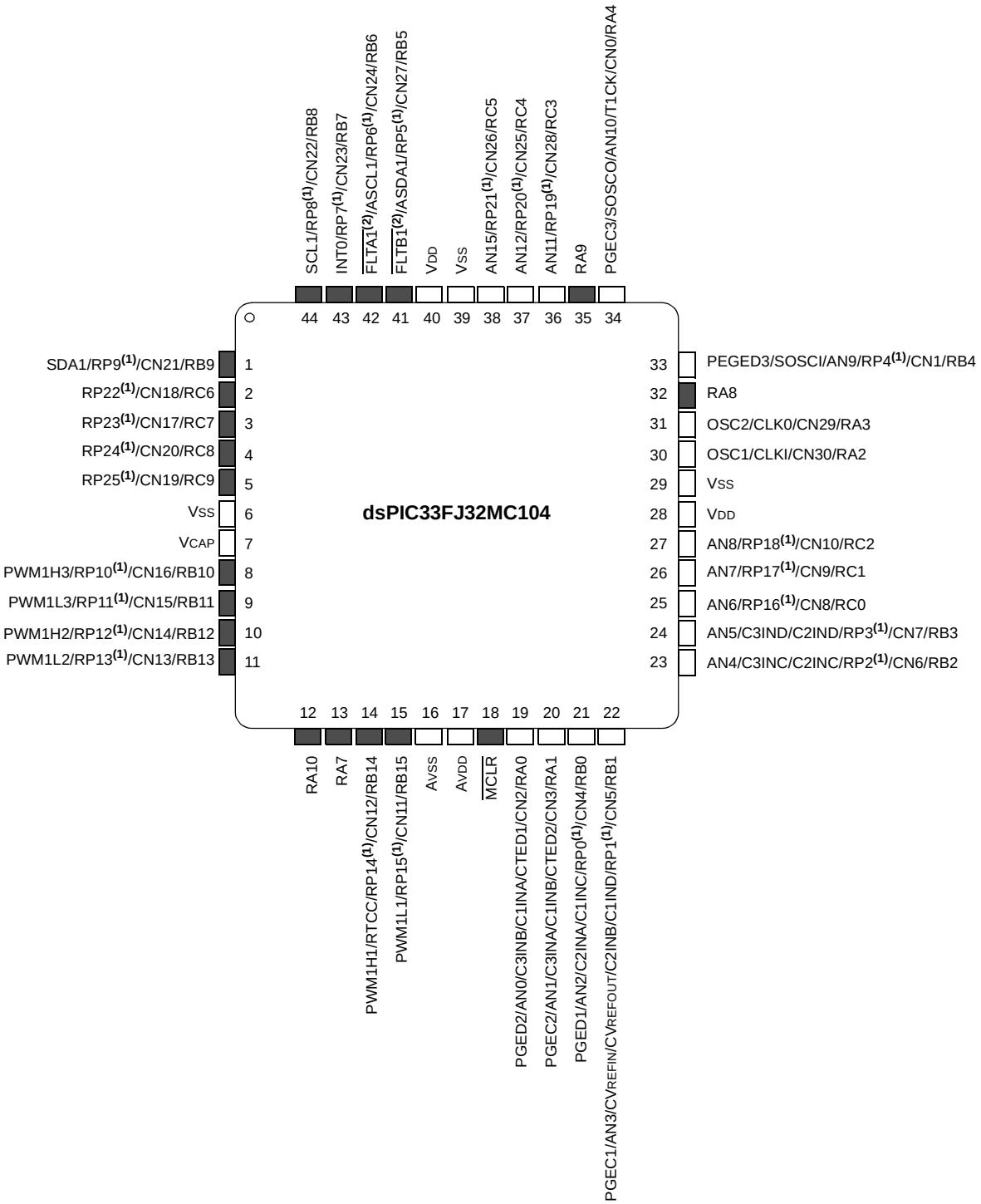



**Note 1:** The RPn pins can be used by any remappable peripheral. See Table 1 for the list of available peripherals.

## Pin Diagrams (Continued)

**44-Pin TQFP**

■ = Pins are up to 5V tolerant




**Note 1:** The RPn pins can be used by any remappable peripheral. See Table 1 for the list of available peripherals.

**2:** The PWM Fault pins are enabled and asserted during any Reset event. Refer to **Section 15.2 "PWM Faults"** for more information on the PWM Faults.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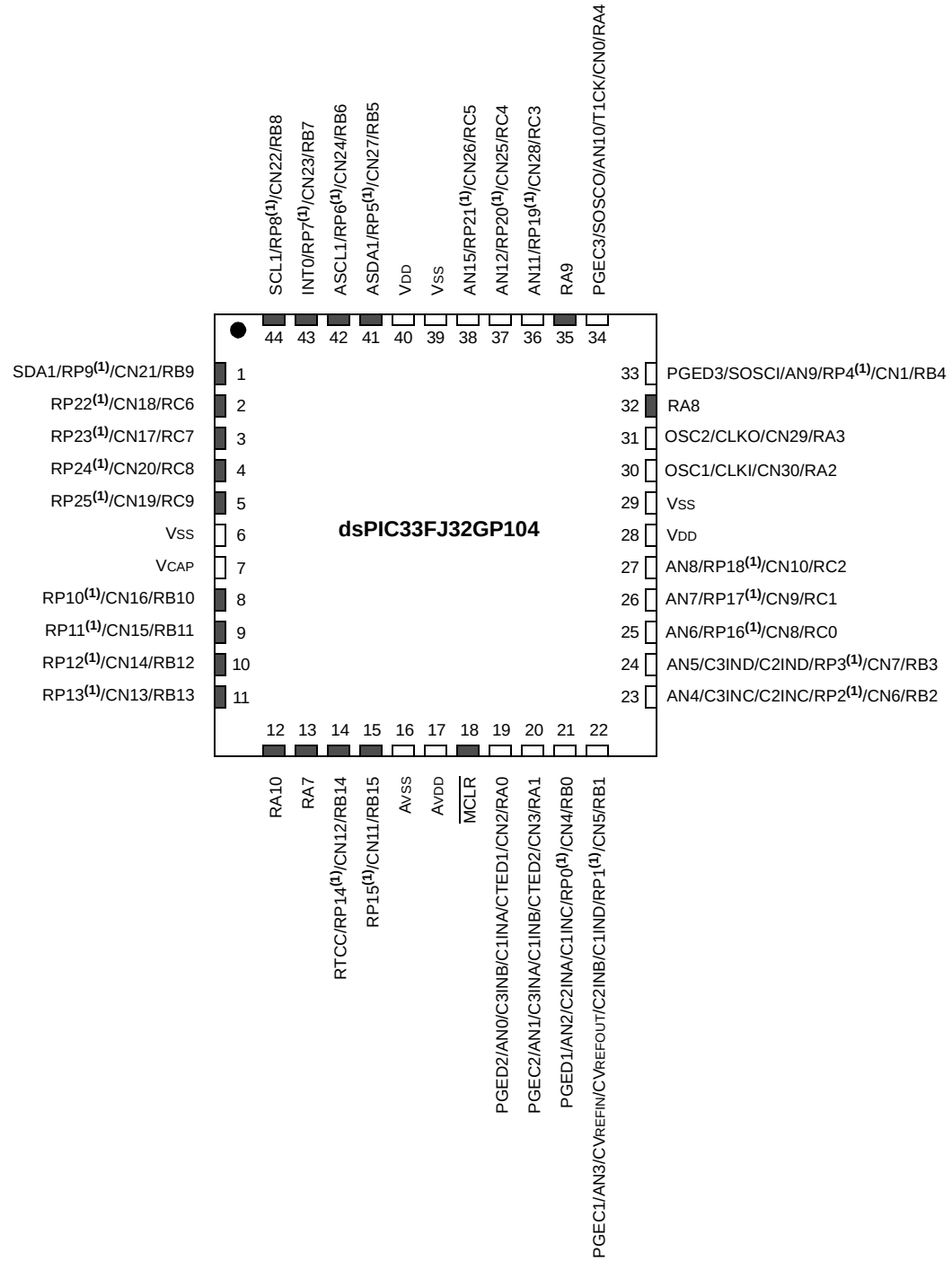
## Pin Diagrams (Continued)

**44-Pin QFN(2)**

= Pins are up to 5V tolerant

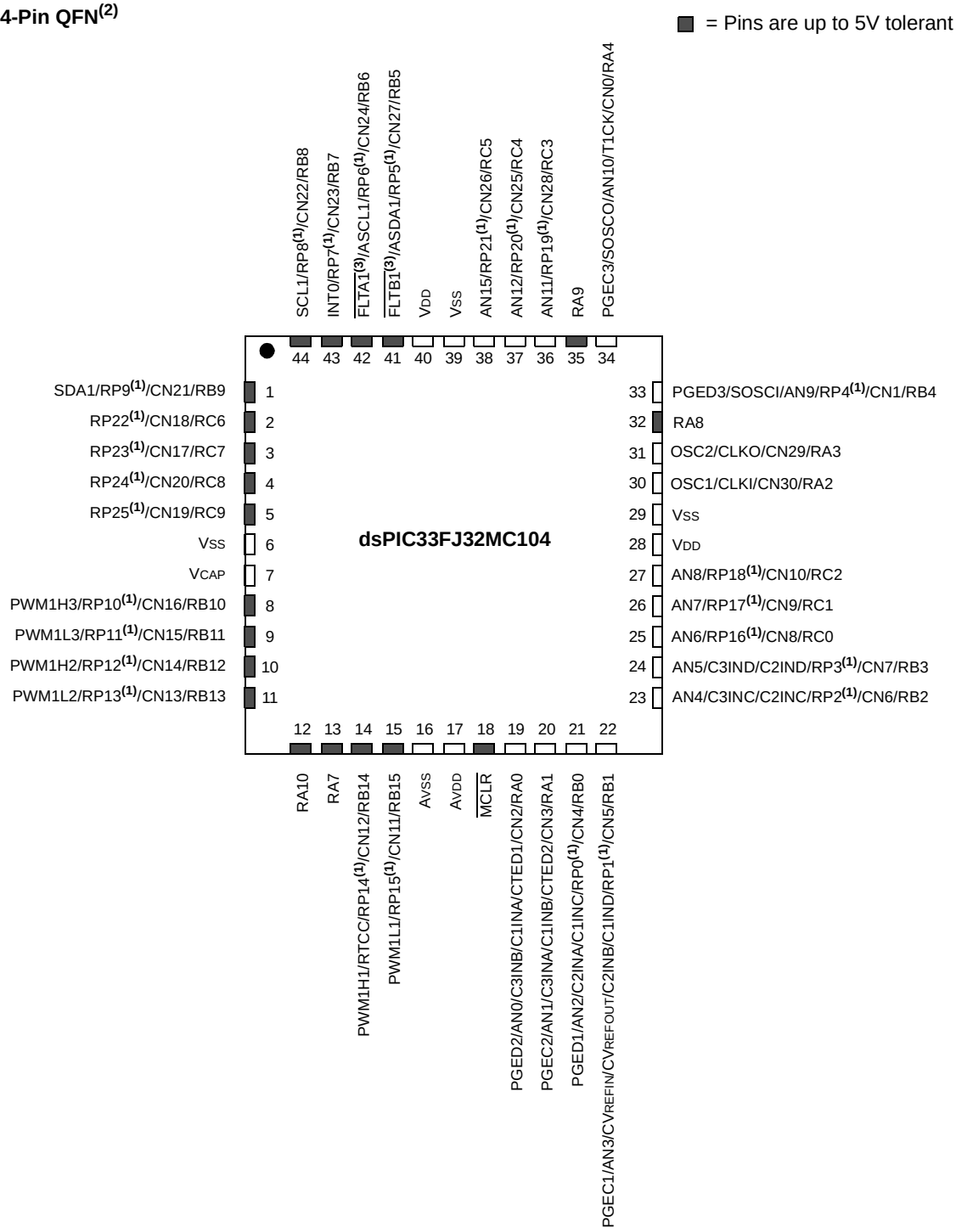



**Note 1:** The RPn pins can be used by any remappable peripheral. See Table 1 for the list of available peripherals.

**2:** The metal pad at the bottom of the device is not connected to any pins and is recommended to be connected to VSS externally.

## Pin Diagrams (Continued)

**44-Pin QFN(2)**




**Note 1:** The RPn pins can be used by any remappable peripheral. See Table 1 for the list of available peripherals.

**2:** The metal pad at the bottom of the device is not connected to any pins and is recommended to be connected to VSS externally.

**3:** The PWM Fault pins are enabled and asserted during any Reset event. Refer to **Section 15.2 "PWM Faults"** for more information on the PWM Faults.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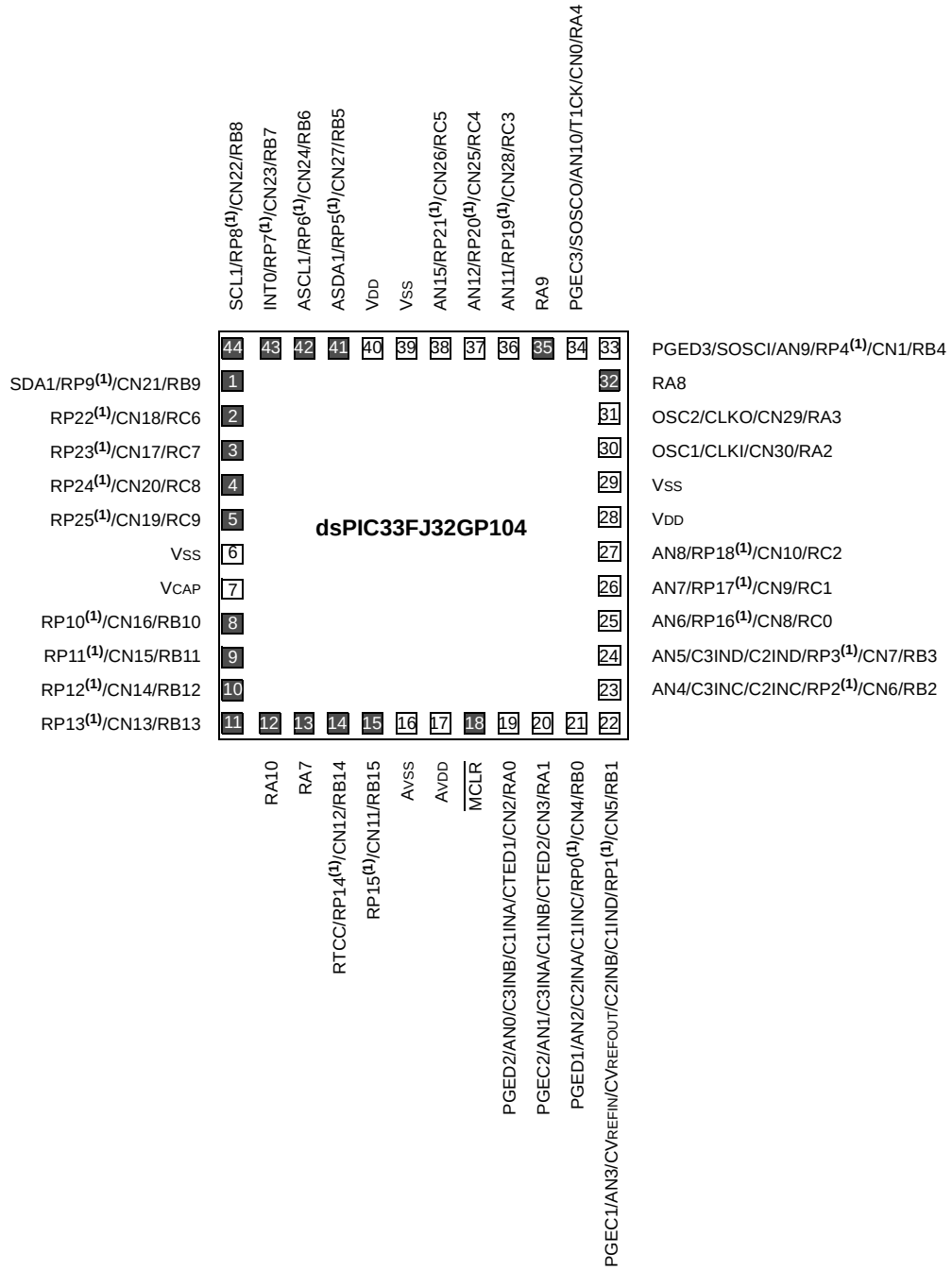
## Pin Diagrams (Continued)

**44-Pin TLA(2)**

■ = Pins are up to 5V tolerant



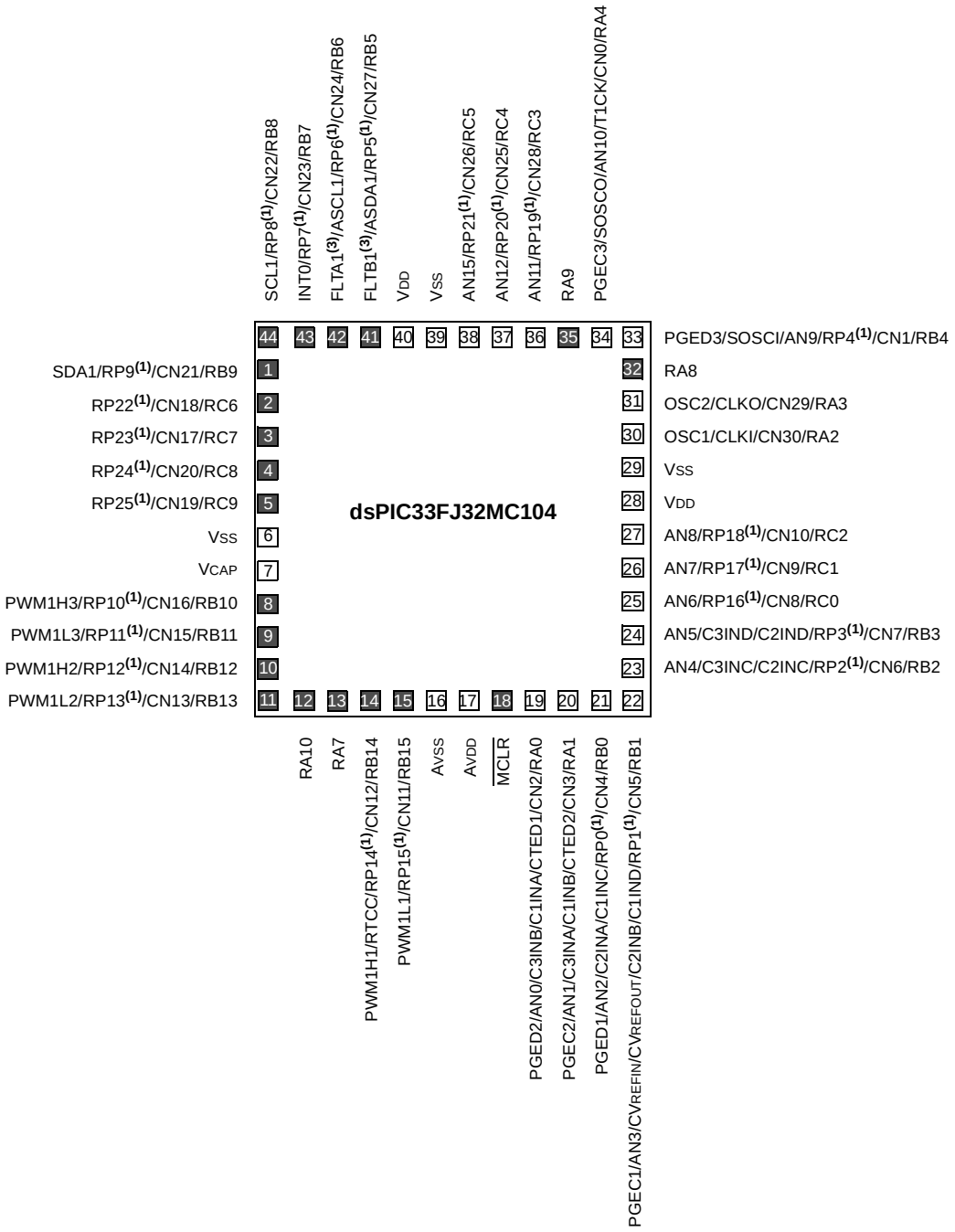

**Note 1:** The RPn pins can be used by any remappable peripheral. See Table 1 for the list of available peripherals.

**2:** The metal pad at the bottom of the device is not connected to any pins and is recommended to be connected to VSS externally.

## Pin Diagrams (Continued)

**44-Pin TLA(2)**

■ = Pins are up to 5V tolerant




**Note 1:** The RPn pins can be used by any remappable peripheral. See Table 1 for the list of available peripherals.

**2:** The metal pad at the bottom of the device is not connected to any pins and is recommended to be connected to VSS externally.

**3:** The PWM Fault pins are enabled and asserted during any Reset event. Refer to **Section 15.2 "PWM Faults"** for more information on the PWM Faults.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## Table of Contents

1.0 Device Overview ..... 27
2.0 Guidelines for Getting Started with 16-bit Digital Signal Controllers ..... 33
3.0 CPU ..... 37
4.0 Memory Organization ..... 49
5.0 Flash Program Memory ..... 83
6.0 Resets ..... 87
7.0 Interrupt Controller ..... 95
8.0 Oscillator Configuration ..... 125
9.0 Power-Saving Features ..... 133
10.0 I/O Ports ..... 139
11.0 Timer1 ..... 165
12.0 Timer2/3 and Timer4/5 ..... 167
13.0 Input Capture ..... 175
14.0 Output Compare ..... 177
15.0 Motor Control PWM Module ..... 181
16.0 Serial Peripheral Interface (SPI) ..... 197
17.0 Inter-Integrated Circuit™ ($I^2C$™) ..... 203
18.0 Universal Asynchronous Receiver Transmitter (UART) ..... 211
19.0 10-Bit Analog-to-Digital Converter (ADC) ..... 217
20.0 Comparator Module ..... 231
21.0 Real-Time Clock and Calendar (RTCC) ..... 243
22.0 Charge Time Measurement Unit (CTMU) ..... 255
23.0 Special Features ..... 261
24.0 Instruction Set Summary ..... 269
25.0 Development Support ..... 277
26.0 Electrical Characteristics ..... 281
27.0 High-Temperature Electrical Characteristics ..... 339
28.0 Packaging Information ..... 343
Appendix A: Revision History ..... 373
Index ..... 381
The Microchip Web Site ..... 387
Customer Change Notification Service ..... 387
Customer Support ..... 387
Product Identification System ..... 389

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### Errata

An errata sheet, describing minor operational differences from the data sheet and recommended workarounds, may exist for current devices. As device/documentation issues become known to us, we will publish an errata sheet. The errata will specify the revision of silicon and revision of document to which it applies.

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## Referenced Sources

This device data sheet is based on the following individual chapters of the *"dsPIC33/PIC24 Family Reference Manual"*. These documents should be considered as the primary reference for the operation of a particular module or device feature.

**Note 1:** To access the documents listed below, browse to the documentation section of the dsPIC33FJ16MC102 product page of the Microchip Web site (www.microchip.com).

In addition to parameters, features and other documentation, the resulting page provides links to the related family reference manual sections.

- **"CPU"** (DS70204)
- **"Data Memory"** (DS70202)
- **"Program Memory"** (DS70203)
- **"Flash Programming"** (DS70191)
- **"Reset"** (DS70192)
- **"Watchdog Timer and Power-Saving Modes"** (DS70196)
- **"Timers"** (DS70205)
- **"Input Capture"** (DS70198)
- **"Output Compare"** (DS70209)
- **"Motor Control PWM"** (DS70187)
- **"Analog-to-Digital Converter (ADC)"** (DS70183)
- **"UART"** (DS70188)
- **"Serial Peripheral Interface (SPI)"** (DS70206)
- **"Inter-Integrated Circuit™ ($I^2C$™)"** (DS70195)
- **"CodeGuard Security"** (DS70199)
- **"Programming and Diagnostics"** (DS70207)
- **"Device Configuration"** (DS70194)
- **"I/O Ports with Peripheral Pin Select (PPS)"** (DS70190)
- **"Real-Time Clock and Calendar (RTCC)"** (DS70301)
- **"Introduction (Part VI)"** (DS70655)
- **"Oscillator (Part VI)"** (DS70644)
- **"Interrupts (Part VI)"** (DS70633)
- **"Comparator with Blanking"** (DS70647)
- **"Charge Time Measurement Unit (CTMU)"** (DS70635)

**NOTES:**


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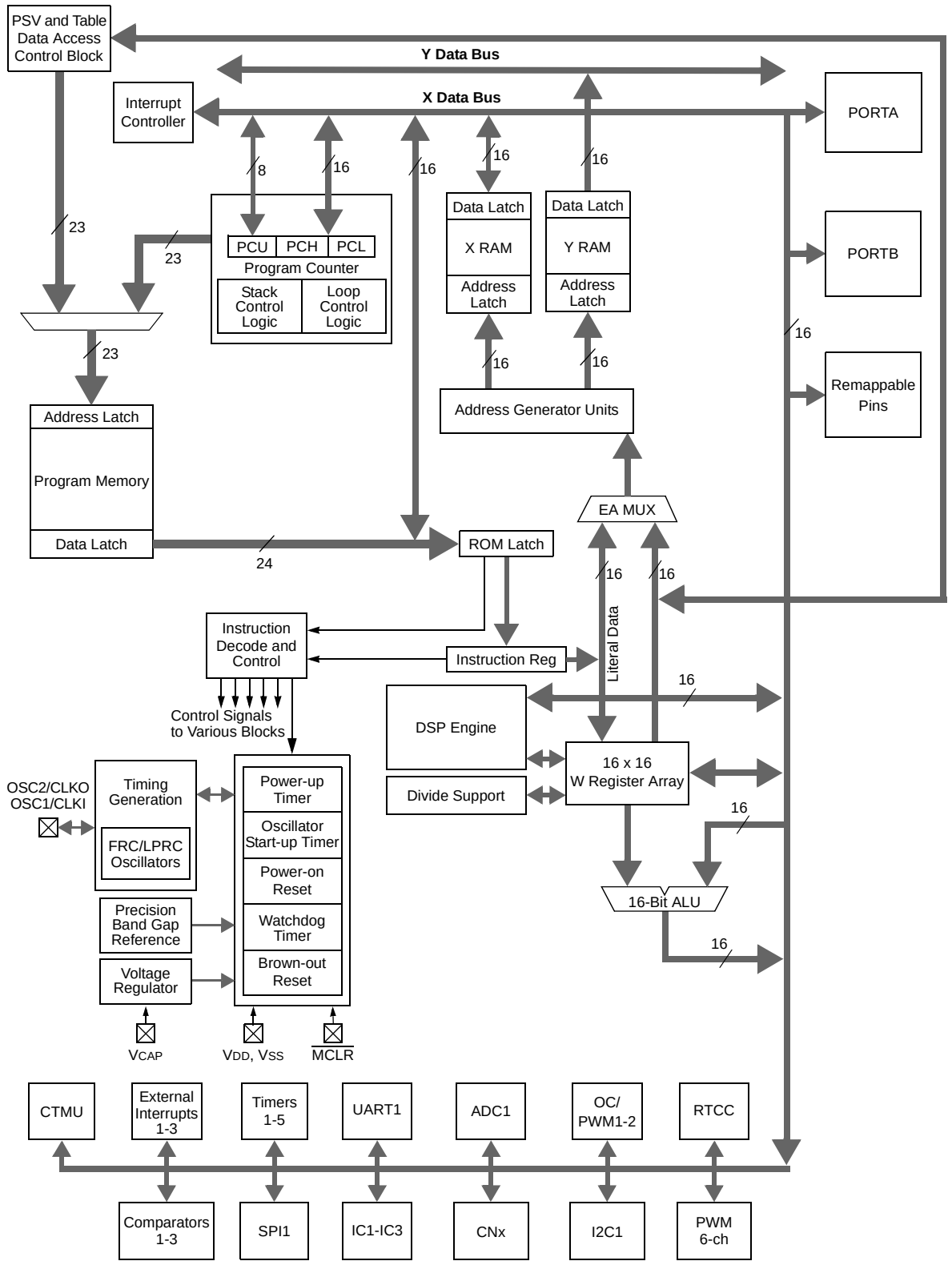
## 1.0 DEVICE OVERVIEW

**Note:** This data sheet summarizes the features of the dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 devices. However, it is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to the latest family reference sections of the *"dsPIC33/PIC24 Family Reference Manual"*, which are available from the Microchip web site (www.microchip.com).

This data sheet contains device-specific information for dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 Digital Signal Controller (DSC) devices. These devices contain extensive Digital Signal Processor (DSP) functionality with a high-performance, 16-bit microcontroller (MCU) architecture.

Figure 1-1 shows a general block diagram of the core and peripheral modules in the dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 family of devices. Table 1-1 lists the functions of the various pins shown in the pinout diagrams.

**FIGURE 1-1: dsPIC33FJ16(GP/MC)101/102 AND dsPIC33FJ32(GP/MC)101/102/104 BLOCK DIAGRAM**




**Note:** Not all pins or features are implemented on all device pinout configurations. See the **"Pin Diagrams"** section for the specific pins and features present on each device.


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**TABLE 1-1: PINOUT I/O DESCRIPTIONS**

| Pin Name | Pin Type | Buffer Type | PPS | Description |
|---|---|---|---|---|
| AN0-AN12, AN15(5) | I | Analog | No | Analog input channels. |
| CLKI<br>CLKO | I<br>O | ST/CMOS<br>— | No<br>No | External clock source input. Always associated with OSC1 pin function.<br>Oscillator crystal output. Connects to crystal or resonator in Crystal Oscillator mode. Optionally functions as CLKO in RC and EC modes. Always associated with OSC2 pin function. |
| OSC1<br><br>OSC2 | I<br><br>I/O | ST/CMOS<br>— | No<br><br>No | Oscillator crystal input. ST buffer when configured in RC mode; CMOS otherwise.<br>Oscillator crystal output. Connects to crystal or resonator in Crystal Oscillator mode. Optionally functions as CLKO in RC and EC modes. |
| SOSCI<br>SOSCO | I<br>O | ST/CMOS<br>— | No<br>No | 32.768 kHz low-power oscillator crystal input; CMOS otherwise.<br>32.768 kHz low-power oscillator crystal output. |
| CN0-CN30(5) | I | ST | No | Change Notification inputs. Can be software programmable for internal weak pull-ups on all inputs. |
| IC1-IC3 | I | ST | Yes | Capture Inputs 1/2/3. |
| OCFA<br>OC1-OC2 | I<br>O | ST<br>— | Yes<br>Yes | Compare Fault A input (for Compare Channels 1 and 2).<br>Compare Outputs 1/2. |
| INT0<br>INT1<br>INT2 | I<br>I<br>I | ST<br>ST<br>ST | No<br>Yes<br>Yes | External Interrupt 0.<br>External Interrupt 1.<br>External Interrupt 2. |
| RA0-RA4, RA7-RA10(5) | I/O | ST | No | PORTA is a bidirectional I/O port. |
| RB0-RB15(5) | I/O | ST | No | PORTB is a bidirectional I/O port. |
| RC0-RC9(5) | I/O | ST | No | PORTC is a bidirectional I/O port. |
| T1CK<br>T2CK<br>T3CK<br>T4CK(6)<br>T5CK(6) | I<br>I<br>I<br>I<br>I | ST<br>ST<br>ST<br>ST<br>ST | No<br>Yes<br>Yes<br>Yes<br>Yes | Timer1 external clock input.<br>Timer2 external clock input.<br>Timer3 external clock input.<br>Timer4 external clock input.<br>Timer5 external clock input. |
| $\overline{U1CTS}$<br>$\overline{U1RTS}$<br>U1RX<br>U1TX | I<br>O<br>I<br>O | ST<br>—<br>ST<br>— | Yes<br>Yes<br>Yes<br>Yes | UART1 Clear-to-Send.<br>UART1 Ready-to-Send.<br>UART1 receive.<br>UART1 transmit. |
| SCK1<br>SDI1<br>SDO1 | I/O<br>I<br>O | ST<br>ST<br>— | Yes<br>Yes<br>Yes | Synchronous serial clock input/output for SPI1.<br>SPI1 data in.<br>SPI1 data out. |

**Legend:** CMOS = CMOS compatible input or output; Analog = Analog input; P = Power; ST = Schmitt Trigger input with CMOS levels; O = Output; I = Input; PPS = Peripheral Pin Select

**Note 1:** An external pull-down resistor is required for the $\overline{FLTA1}$ pin in dsPIC33FJXXMC101 (20-pin) devices.

**2:** The $\overline{FLTA1}$ pin and the PWM1Lx/PWM1Hx pins are available in dsPIC(16/32)MC10X devices only.

**3:** The $\overline{FLTB1}$ pin is available in dsPIC(16/32)MC102/104 devices only.

**4:** The PWM Fault pins are enabled during any Reset event. Refer to **Section 15.2 "PWM Faults"** for more information on the PWM Faults.

**5:** Not all pins are available on all devices. Refer to the specific device in the **"Pin Diagrams"** section for availability.

**6:** These pins are available in dsPIC33FJ32(GP/MC)104 (44-pin) devices only.

**TABLE 1-1: PINOUT I/O DESCRIPTIONS (CONTINUED)**

| Pin Name | Pin Type | Buffer Type | PPS | Description |
|---|---|---|---|---|
| SCL1 | I/O | ST | No | Synchronous serial clock input/output for I2C1. |
| SDA1 | I/O | ST | No | Synchronous serial data input/output for I2C1. |
| ASCL1 | I/O | ST | No | Alternate synchronous serial clock input/output for I2C1. |
| ASDA1 | I/O | ST | No | Alternate synchronous serial data input/output for I2C1. |
| $\overline{\text{FLTA1}}$(1,2,4) | I | ST | No | PWM1 Fault A input. |
| $\overline{\text{FLTB1}}$(3,4) | I | ST | No | PWM1 Fault B input. |
| PWM1L1 | O | — | No | PWM1 Low Output 1. |
| PWM1H1 | O | — | No | PWM1 High Output 1. |
| PWM1L2 | O | — | No | PWM1 Low Output 2. |
| PWM1H2 | O | — | No | PWM1 High Output 2. |
| PWM1L3 | O | — | No | PWM1 Low Output 3. |
| PWM1H3 | O | — | No | PWM1 High Output 3. |
| RTCC | O | Digital | No | RTCC Alarm output. |
| CTPLS | O | Digital | Yes | CTMU pulse output. |
| CTED1 | I | Digital | No | CTMU External Edge Input 1. |
| CTED2 | I | Digital | No | CTMU External Edge Input 2. |
| CVREFIN | I | Analog | No | Comparator Voltage Positive Reference Input. |
| CVREFOUT | O | Analog | No | Comparator Voltage Positive Reference Output. |
| C1INA | I | Analog | No | Comparator 1 Positive Input A. |
| C1INB | I | Analog | No | Comparator 1 Negative Input B. |
| C1INC | I | Analog | No | Comparator 1 Negative Input C. |
| C1IND | I | Analog | No | Comparator 1 Negative Input D. |
| C1OUT | O | Digital | Yes | Comparator 1 Output. |
| C2INA | I | Analog | No | Comparator 2 Positive Input A. |
| C2INB | I | Analog | No | Comparator 2 Negative Input B. |
| C2INC | I | Analog | No | Comparator 2 Negative Input C. |
| C2IND | I | Analog | No | Comparator 2 Negative Input D. |
| C2OUT | O | Digital | Yes | Comparator 2 Output. |
| C3INA | I | Analog | No | Comparator 3 Positive Input A. |
| C3INB | I | Analog | No | Comparator 3 Negative Input B. |
| C3INC | I | Analog | No | Comparator 3 Negative Input C. |
| C3IND | I | Analog | No | Comparator 3 Negative Input D. |
| C3OUT | O | Digital | Yes | Comparator 3 Output. |
| PGED1 | I/O | ST | No | Data I/O pin for Programming/Debugging Communication Channel 1. |
| PGEC1 | I | ST | No | Clock input pin for Programming/Debugging Communication Channel 1. |
| PGED2 | I/O | ST | No | Data I/O pin for Programming/Debugging Communication Channel 2. |
| PGEC2 | I | ST | No | Clock input pin for Programming/Debugging Communication Channel 2. |
| PGED3 | I/O | ST | No | Data I/O pin for Programming/Debugging Communication Channel 3. |
| PGEC3 | I | ST | No | Clock input pin for Programming/Debugging Communication Channel 3. |
| $\overline{\text{MCLR}}$ | I/P | ST | No | Master Clear (Reset) input. This pin is an active-low Reset to the device. |

**Legend:** CMOS = CMOS compatible input or output; Analog = Analog input; P = Power; ST = Schmitt Trigger input with CMOS levels; O = Output; I = Input; PPS = Peripheral Pin Select

**Note 1:** An external pull-down resistor is required for the $\overline{\text{FLTA1}}$ pin in dsPIC33FJXXMC101 (20-pin) devices.

**2:** The $\overline{\text{FLTA1}}$ pin and the PWM1Lx/PWM1Hx pins are available in dsPIC(16/32)MC10X devices only.

**3:** The $\overline{\text{FLTB1}}$ pin is available in dsPIC(16/32)MC102/104 devices only.

**4:** The PWM Fault pins are enabled during any Reset event. Refer to **Section 15.2 "PWM Faults"** for more information on the PWM Faults.

**5:** Not all pins are available on all devices. Refer to the specific device in the **"Pin Diagrams"** section for availability.

**6:** These pins are available in dsPIC33FJ32(GP/MC)104 (44-pin) devices only.


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**TABLE 1-1: PINOUT I/O DESCRIPTIONS (CONTINUED)**

| Pin Name | Pin Type | Buffer Type | PPS | Description |
|---|---|---|---|---|
| AVDD | P | P | No | Positive supply for analog modules. This pin must be connected at all times. AVDD is connected to VDD in the 18-pin dsPIC33FJXXGP101 and 20-pin dsPIC33FJXXMC101 devices. In all other devices, AVDD is separated from VDD. |
| AVSS | P | P | No | Ground reference for analog modules. AVSS is connected to VSS in the 18-pin dsPIC33FJXXGP101 and 20-pin dsPIC33FJXXMC101 devices. In all other devices, AVSS is separated from VSS. |
| VDD | P | — | No | Positive supply for peripheral logic and I/O pins. |
| VCAP | P | — | No | CPU logic filter capacitor connection. |
| VSS | P | — | No | Ground reference for logic and I/O pins. |

**Legend:** CMOS = CMOS compatible input or output; Analog = Analog input; P = Power
ST = Schmitt Trigger input with CMOS levels; O = Output; I = Input
PPS = Peripheral Pin Select

**Note 1:** An external pull-down resistor is required for the $\overline{\text{FLTA1}}$ pin in dsPIC33FJXXMC101 (20-pin) devices.

**2:** The $\overline{\text{FLTA1}}$ pin and the PWM1Lx/PWM1Hx pins are available in dsPIC(16/32)MC10X devices only.

**3:** The $\overline{\text{FLTB1}}$ pin is available in dsPIC(16/32)MC102/104 devices only.

**4:** The PWM Fault pins are enabled during any Reset event. Refer to **Section 15.2 “PWM Faults”** for more information on the PWM Faults.

**5:** Not all pins are available on all devices. Refer to the specific device in the **“Pin Diagrams”** section for availability.

**6:** These pins are available in dsPIC33FJ32(GP/MC)104 (44-pin) devices only.

**NOTES:**


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# 2.0 GUIDELINES FOR GETTING STARTED WITH 16-BIT DIGITAL SIGNAL CONTROLLERS

**Note 1:** This data sheet summarizes the features of the dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 family devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to the *"dsPIC33/PIC24 Family Reference Manual"*. Please see the Microchip web site (www.microchip.com) for the latest *"dsPIC33/PIC24 Family Reference Manual"* sections.

**2:** Some registers and associated bits described in this section may not be available on all devices. Refer to **Section 4.0 "Memory Organization"** in this data sheet for device-specific register and bit information.

## 2.1 Basic Connection Requirements

Getting started with the dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 family of 16-bit Digital Signal Controllers (DSCs) requires attention to a minimal set of device pin connections before proceeding with development. The following is a list of pin names, which must always be connected:

- All VDD and VSS pins
  (see **Section 2.2 "Decoupling Capacitors"**)
- All AVDD and AVSS pins, if present on the device
  (regardless if ADC module is not used)
  (see **Section 2.2 "Decoupling Capacitors"**)
- VCAP
  (see **Section 2.3 "CPU Logic Filter Capacitor Connection (VCAP)"**)
- $\overline{\text{MCLR}}$ pin
  (see **Section 2.4 "Master Clear (MCLR) Pin"**)
- PGECx/PGEDx pins used for In-Circuit Serial Programming™ (ICSP™) and debugging purposes
  (see **Section 2.5 "ICSP Pins"**)
- OSC1 and OSC2 pins when external oscillator source is used
  (see **Section 2.6 "External Oscillator Pins"**)

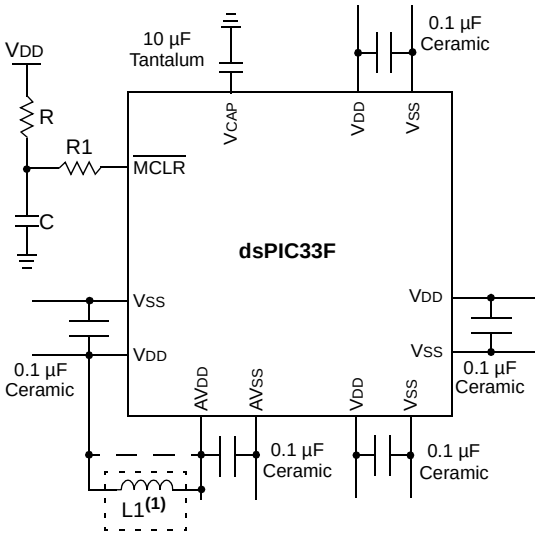
## 2.2 Decoupling Capacitors

The use of decoupling capacitors on every pair of power supply pins, such as VDD, VSS, AVDD and AVSS, is required.

Consider the following criteria when using decoupling capacitors:

- **Value and type of capacitor:** Recommendation of 0.1 µF (100 nF), 10V-20V. This capacitor should be a low-ESR and have resonance frequency in the range of 20 MHz and higher. It is recommended that ceramic capacitors be used.
- **Placement on the printed circuit board:** The decoupling capacitors should be placed as close to the pins as possible. It is recommended to place the capacitors on the same side of the board as the device. If space is constricted, the capacitor can be placed on another layer on the PCB using a via; however, ensure that the trace length from the pin to the capacitor is within one-quarter inch (6 mm) in length.
- **Handling high-frequency noise:** If the board is experiencing high-frequency noise, upward of tens of MHz, add a second ceramic-type capacitor in parallel to the above described decoupling capacitor. The value of the second capacitor can be in the range of 0.01 µF to 0.001 µF. Place this second capacitor next to the primary decoupling capacitor. In high-speed circuit designs, consider implementing a decade pair of capacitances as close to the power and ground pins as possible. For example, 0.1 µF in parallel with 0.001 µF.
- **Maximizing performance:** On the board layout from the power supply circuit, run the power and return traces to the decoupling capacitors first, and then to the device pins. This ensures that the decoupling capacitors are first in the power chain. Equally important is to keep the trace length between the capacitor and the power pins to a minimum thereby reducing PCB track inductance.

**FIGURE 2-1: RECOMMENDED MINIMUM CONNECTION**




**Note 1:** As an option, instead of a hard-wired connection, an inductor (L1) can be substituted between VDD and AVDD to improve ADC noise rejection. The inductor impedance should be less than 1Ω and the inductor capacity greater than 10 mA.

Where:

$$f = \frac{FCNV}{2}$$ (i.e., ADC conversion rate/2)

$$f = \frac{1}{(2\pi\sqrt{LC})}$$

$$L = \left(\frac{1}{(2\pi f\sqrt{C})}\right)^2$$

### 2.2.1 TANK CAPACITORS

On boards with power traces running longer than six inches in length, it is suggested to use a tank capacitor for integrated circuits including DSCs to supply a local power source. The value of the tank capacitor should be determined based on the trace resistance that connects the power supply source to the device and the maximum current drawn by the device in the application. In other words, select the tank capacitor so that it meets the acceptable voltage sag at the device. Typical values range from 4.7 µF to 47 µF.

## 2.3 CPU Logic Filter Capacitor Connection (VCAP)

A low-ESR (< 5 Ohms) capacitor is required on the VCAP pin, which is used to stabilize the voltage regulator output voltage. The VCAP pin must not be connected to VDD, and must have a capacitor between 4.7 µF and 10 µF, 16V connected to ground. The type can be ceramic or tantalum. Refer to **Section 26.0 "Electrical Characteristics"** for additional information.

The placement of this capacitor should be close to the VCAP. It is recommended that the trace length not exceed one-quarter inch (6 mm). Refer to **Section 23.2 "On-Chip Voltage Regulator"** for details.

## 2.4 Master Clear (MCLR) Pin

The MCLR pin provides two specific device functions:

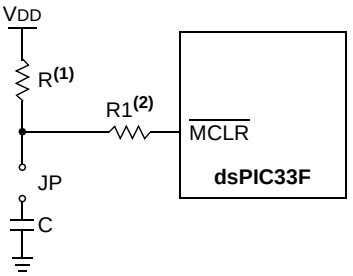
- Device Reset
- Device programming and debugging

During device programming and debugging, the resistance and capacitance that can be added to the pin must be considered. Device programmers and debuggers drive the MCLR pin. Consequently, specific voltage levels (VIH and VIL) and fast signal transitions must not be adversely affected. Therefore, specific values of R and C will need to be adjusted based on the application and PCB requirements.

For example, as shown in Figure 2-2, it is recommended that the capacitor C, be isolated from the MCLR pin during programming and debugging operations.

Place the components shown in Figure 2-2 within one-quarter inch (6 mm) from the MCLR pin.

**FIGURE 2-2: EXAMPLE OF MCLR PIN CONNECTIONS**




**Note 1:** R ≤ 10 kΩ is recommended. A suggested starting value is 10 kΩ. Ensure that the MCLR pin VIH and VIL specifications are met.

**2:** R1 ≤ 470Ω will limit any current flowing into MCLR from the external capacitor, C, in the event of MCLR pin breakdown, due to Electrostatic Discharge (ESD) or Electrical Overstress (EOS). Ensure that the MCLR pin VIH and VIL specifications are met.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## 2.5 ICSP Pins

The PGECx and PGEDx pins are used for In-Circuit Serial Programming™ (ICSP™) and debugging purposes. It is recommended to keep the trace length between the ICSP connector and the ICSP pins on the device as short as possible. If the ICSP connector is expected to experience an ESD event, a series resistor is recommended, with the value in the range of a few tens of Ohms, not to exceed 100 Ohms.

Pull-up resistors, series diodes, and capacitors on the PGECx and PGEDx pins are not recommended as they will interfere with the programmer/debugger communications to the device. If such discrete components are an application requirement, they should be removed from the circuit during programming and debugging. Alternately, refer to the AC/DC characteristics and timing requirements information in the *"dsPIC33F Flash Programming Specification for Devices with Volatile Configuration Bits"* (DS70659) for information on capacitive loading limits and pin Voltage Input High ($V_{IH}$) and Voltage Input Low ($V_{IL}$) requirements.

Ensure that the "Communication Channel Select" (i.e., PGECx/PGEDx pins) programmed into the device matches the physical connections for the ICSP to MPLAB® ICD 3 or MPLAB REAL ICE™.

For more information on ICD 3 and REAL ICE connection requirements, refer to the following documents that are available on the Microchip web site.

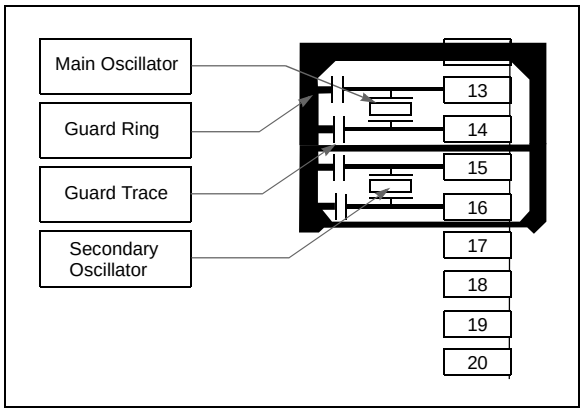
- *"Using MPLAB® ICD 3"* (poster) (DS51765)
- *"MPLAB® ICD 3 Design Advisory"* (DS51764)
- *"MPLAB® REAL ICE™ In-Circuit Debugger User's Guide" (*DS51616)
- *"Using MPLAB® REAL ICE™"* (poster) (DS51749)

## 2.6 External Oscillator Pins

Many DSCs have options for at least two oscillators: a high-frequency primary oscillator and a low-frequency secondary oscillator (refer to **Section 8.0 "Oscillator Configuration"** for details).

The oscillator circuit should be placed on the same side of the board as the device. Also, place the oscillator circuit close to the respective oscillator pins, not exceeding one-half inch (12 mm) distance between them. The load capacitors should be placed next to the oscillator itself, on the same side of the board. Use a grounded copper pour around the oscillator circuit to isolate them from surrounding circuits. The grounded copper pour should be routed directly to the MCU ground. Do not run any signal traces or power traces inside the ground pour. Also, if using a two-sided board, avoid any traces on the other side of the board where the crystal is placed. A suggested layout is shown in Figure 2-3.

**FIGURE 2-3: SUGGESTED PLACEMENT OF THE OSCILLATOR CIRCUIT**



## 2.7 Oscillator Value Conditions on Device Start-up

If the PLL of the target device is enabled and configured for the device start-up oscillator, the maximum oscillator source frequency must be limited to 4 MHz < FIN < 8 MHz (for MSPLL mode) or 3 MHz < FIN < 8 MHz (for ECPLL mode) to comply with device PLL start-up conditions. HSPLL mode is not supported. This means that if the external oscillator frequency is outside this range, the application must start-up in the FRC mode first. The fixed PLL settings of 4x after a POR with an oscillator frequency outside this range will violate the device operating speed.

Once the device powers up, the application firmware can enable the PLL and then perform a clock switch to the Oscillator + PLL clock source. Note that clock switching must be enabled in the device Configuration Word.

## 2.8 Configuration of Analog and Digital Pins During ICSP Operations

If MPLAB ICD 3 or MPLAB REAL ICE in-circuit emulator is selected as a debugger, it automatically initializes all of the Analog-to-Digital input pins (ANx) as “digital” pins, by setting all bits in the AD1PCFGL register.

The bits in the register that correspond to the Analog-to-Digital pins that are initialized by MPLAB ICD 3 or MPLAB REAL ICE in-circuit emulator, must not be cleared by the user application firmware; otherwise, communication errors will result between the debugger and the device.

If your application needs to use certain Analog-to-Digital pins as analog input pins during the debug session, the user application must clear the corresponding bits in the AD1PCFGL register during initialization of the ADC module.

When MPLAB ICD 3 or MPLAB REAL ICE in-circuit emulator is used as a programmer, the user application firmware must correctly configure the AD1PCFGL register. Automatic initialization of this register is only done during debugger operation. Failure to correctly configure the register(s) will result in all Analog-to-Digital pins being recognized as analog input pins, resulting in the port value being read as a logic ‘0’, which may affect user application functionality.

## 2.9 Unused I/Os

Unused I/O pins should be configured as outputs and driven to a logic-low state.

Alternately, connect a 1k to 10k resistor between VSS and unused pins.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# 3.0 CPU

**Note 1:** This data sheet summarizes the features of the dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 family devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **"CPU"** (DS70204) in the *"dsPIC33/PIC24 Family Reference Manual"*, which is available from the Microchip web site (www.microchip.com).

**2:** Some registers and associated bits described in this section may not be available on all devices. Refer to **Section 4.0 "Memory Organization"** in this data sheet for device-specific register and bit information.

The dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 CPU module has a 16-bit (data) modified Harvard architecture with an enhanced instruction set, including significant support for DSP. The CPU has a 24-bit instruction word with a variable length opcode field. The Program Counter (PC) is 23 bits wide and addresses up to 4M x 24 bits of user program memory space. The actual amount of program memory implemented varies by device. A single-cycle instruction prefetch mechanism is used to help maintain throughput and provides predictable execution. All instructions execute in a single cycle, with the exception of instructions that change the program flow, the double-word move (`MOV.D`) instruction and the table instructions. Overhead-free program loop constructs are supported using the `DO` and `REPEAT` instructions, both of which are interruptible at any point.

The dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 devices have sixteen, 16-bit Working registers in the programmer's model. Each of the Working registers can serve as a data, address, or address offset register. The 16th Working register (W15) operates as a Software Stack Pointer (SSP) for interrupts and calls.

There are two classes of instruction in the dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 devices: MCU and DSP. These two instruction classes are seamlessly integrated into a single CPU. The instruction set includes many addressing modes and is designed for optimum C compiler efficiency. For most instructions, dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 devices are capable of executing a data (or program data) memory read, a Working register (data) read, a data memory write and a program (instruction) memory read per instruction cycle. As a result, three parameter instructions can be supported, allowing A + B = C operations to be executed in a single cycle.

A block diagram of the CPU is shown in Figure 3-1, and the programmer's model for the dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 is shown in Figure 3-2.

## 3.1 Data Addressing Overview

The data space can be addressed as 32K words or 64 Kbytes and is split into two blocks, referred to as X and Y data memory. Each memory block has its own independent Address Generation Unit (AGU). The MCU class of instructions operates solely through the X memory AGU, which accesses the entire memory map as one linear data space. Certain DSP instructions operate through the X and Y AGUs to support dual operand reads, which splits the data address space into two parts. The X and Y data space boundary is device-specific.

Overhead-free circular buffers (Modulo Addressing mode) are supported in both X and Y address spaces. The Modulo Addressing removes the software boundary checking overhead for DSP algorithms. Furthermore, the X AGU circular addressing can be used with any of the MCU class of instructions. The X AGU also supports Bit-Reversed Addressing to greatly simplify input or output data reordering for radix-2 FFT algorithms.

The upper 32 Kbytes of the data space memory map can optionally be mapped into program space at any 16K program word boundary defined by the 8-bit Program Space Visibility Page (PSVPAG) register. The program-to-data-space mapping feature lets any instruction access program space as if it were data space.

## 3.2 DSP Engine Overview

The DSP engine features a high-speed, 17-bit by 17-bit multiplier, a 40-bit ALU, two 40-bit saturating accumulators and a 40-bit bidirectional barrel shifter. The barrel shifter is capable of shifting a 40-bit value up to 16 bits right or left, in a single cycle. The DSP instructions operate seamlessly with all other instructions and have been designed for optimal real-time performance. The `MAC` instruction and other associated instructions can concurrently fetch two data operands from memory, while multiplying two W registers and accumulating and optionally saturating the result in the same cycle. This instruction functionality requires that the RAM data space be split for these instructions and linear for all others. Data space partitioning is achieved in a transparent and flexible manner through dedicating certain Working registers to each address space.

## 3.3 Special MCU Features

The dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 features a 17-bit by 17-bit, single-cycle multiplier that is shared by both the MCU ALU and DSP engine. The multiplier can perform signed, unsigned and mixed-sign multiplication. Using a 17-bit by 17-bit multiplier for 16-bit by 16-bit multiplication not only allows you to perform mixed-sign multiplication, it also achieves accurate results for special operations, such as (-1.0) x (-1.0).

The dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 supports 16/16 and 32/16 divide operations, both fractional and integer. All divide instructions are iterative operations. They must be executed within a REPEAT loop, resulting in a total execution time of 19 instruction cycles. The divide operation can be interrupted during any of those 19 cycles without loss of data.

A 40-bit barrel shifter is used to perform up to a 16-bit left or right shift in a single cycle. The barrel shifter can be used by both MCU and DSP instructions.

**FIGURE 3-1: dsPIC33FJ16(GP/MC)101/102 AND dsPIC33FJ32(GP/MC)101/102/104 CPU CORE BLOCK DIAGRAM**

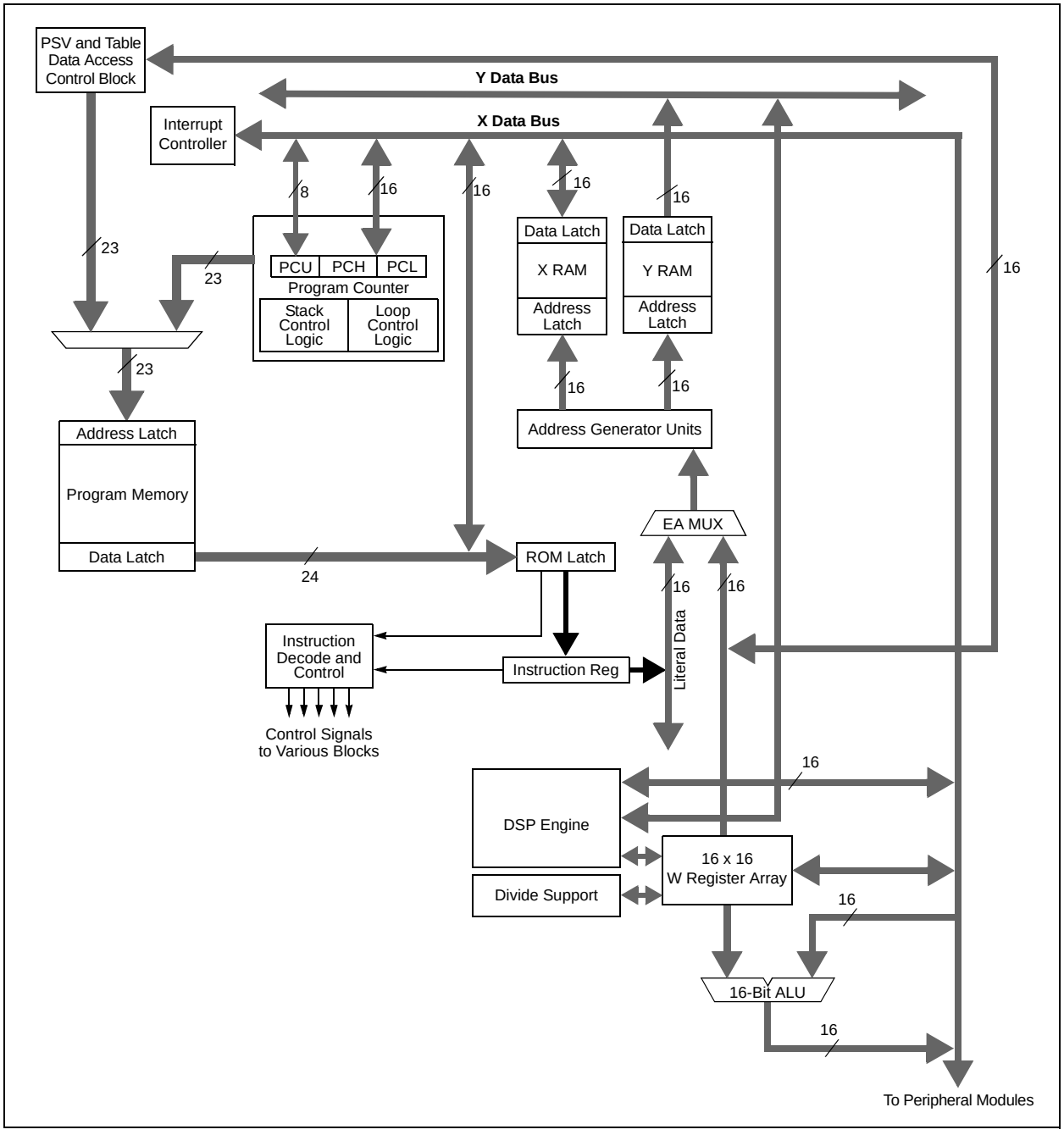



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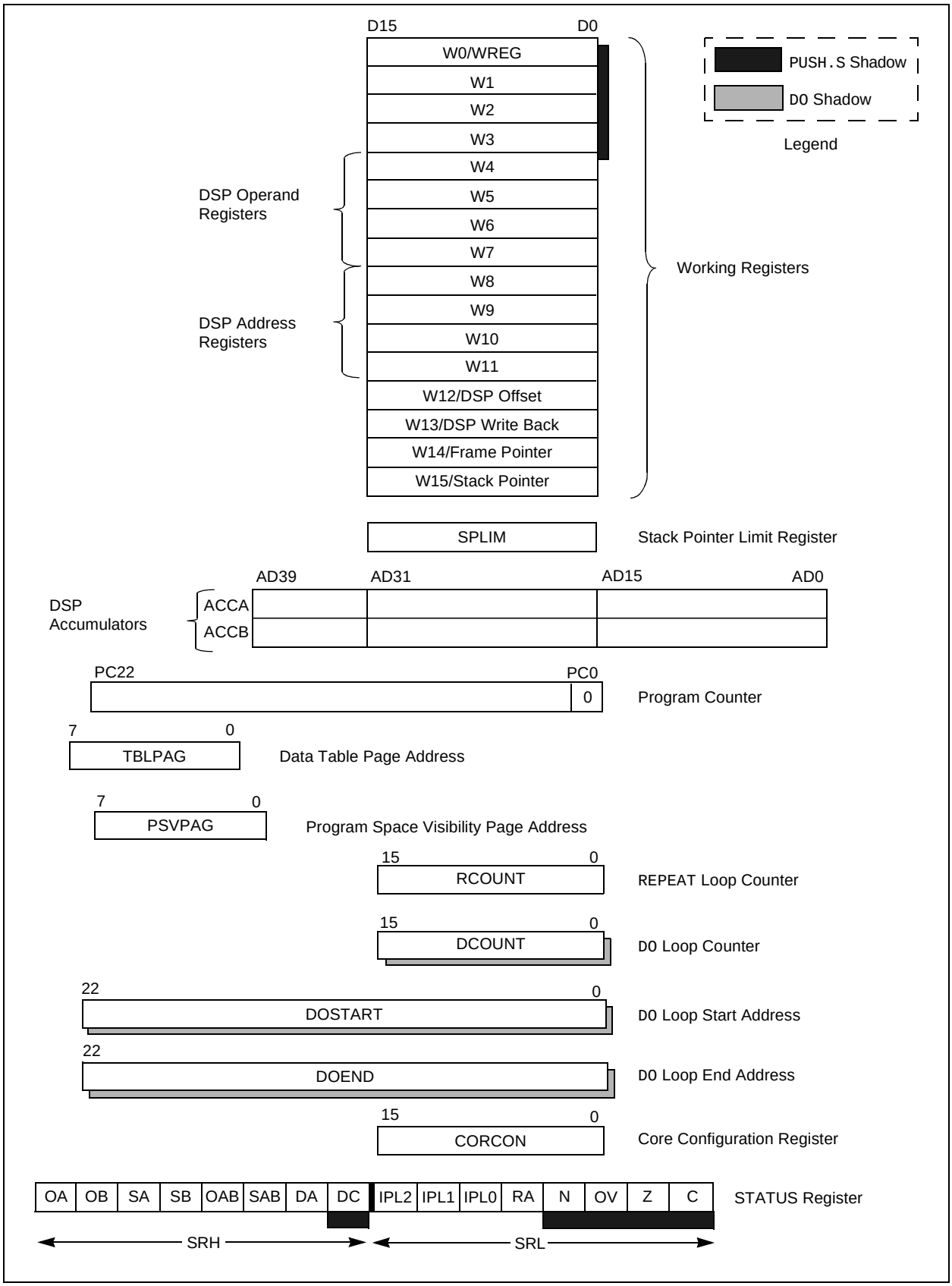
**FIGURE 3-2: dsPIC33FJ16(GP/MC)101/102 AND dsPIC33FJ32(GP/MC)101/102/104 PROGRAMMER'S MODEL**



## 3.4 CPU Control Registers

**REGISTER 3-1: SR: CPU STATUS REGISTER**

| R-0 | R-0 | R/C-0 | R/C-0 | R-0 | R/C-0 | R-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| OA | OB | SA(1) | SB(1) | OAB | SAB | DA | DC |
| bit 15 | | | | | | | bit 8 |

| R/W-0(3) | R/W-0(3) | R/W-0(3) | R-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| IPL2(2) | IPL1(2) | IPL0(2) | RA | N | OV | Z | C |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | C = Clearable bit | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15 **OA:** Accumulator A Overflow Status bit
1 = Accumulator A has overflowed
0 = Accumulator A has not overflowed

bit 14 **OB:** Accumulator B Overflow Status bit
1 = Accumulator B has overflowed
0 = Accumulator B has not overflowed

bit 13 **SA:** Accumulator A Saturation 'Sticky' Status bit(1)
1 = Accumulator A is saturated or has been saturated at some time
0 = Accumulator A is not saturated

bit 12 **SB:** Accumulator B Saturation 'Sticky' Status bit(1)
1 = Accumulator B is saturated or has been saturated at some time
0 = Accumulator B is not saturated

bit 11 **OAB:** OA || OB Combined Accumulator Overflow Status bit
1 = Accumulators A or B have overflowed
0 = Neither Accumulators A or B have overflowed

bit 10 **SAB:** SA || SB Combined Accumulator 'Sticky' Status bit
1 = Accumulators A or B are saturated or have been saturated at some time in the past
0 = Neither Accumulator A or B are saturated
This bit may be read or cleared (not set). *Clearing this bit will clear SA and SB*.

bit 9 **DA:** DO Loop Active bit
1 = DO loop is in progress
0 = DO loop is not in progress

bit 8 **DC:** MCU ALU Half Carry/$\overline{\text{Borrow}}$ bit
1 = A carry-out from the 4th low-order bit (for byte-sized data) or 8th low-order bit (for word-sized data) of the result occurred
0 = No carry-out from the 4th low-order bit (for byte-sized data) or 8th low-order bit (for word-sized data) of the result occurred

**Note 1:** This bit can be read or cleared (not set).
**2:** The IPL<2:0> bits are concatenated with the IPL<3> bit (CORCON<3>) to form the CPU Interrupt Priority Level. The value in parentheses indicates the IPL if IPL<3> = 1. User interrupts are disabled when IPL<3> = 1.
**3:** The IPL<2:0> Status bits are read-only when NSTDIS = 1 (INTCON1<15>).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**REGISTER 3-1: SR: CPU STATUS REGISTER (CONTINUED)**

bit 7-5 **IPL<2:0>:** CPU Interrupt Priority Level Status bits(2,3)

111 = CPU Interrupt Priority Level is 7 (15), user interrupts are disabled
110 = CPU Interrupt Priority Level is 6 (14)
101 = CPU Interrupt Priority Level is 5 (13)
100 = CPU Interrupt Priority Level is 4 (12)
011 = CPU Interrupt Priority Level is 3 (11)
010 = CPU Interrupt Priority Level is 2 (10)
001 = CPU Interrupt Priority Level is 1 (9)
000 = CPU Interrupt Priority Level is 0 (8)

bit 4 **RA:** REPEAT Loop Active bit

1 = REPEAT loop is in progress
0 = REPEAT loop is not in progress

bit 3 **N:** MCU ALU Negative bit

1 = Result was negative
0 = Result was non-negative (zero or positive)

bit 2 **OV:** MCU ALU Overflow bit

This bit is used for signed arithmetic (2's complement). It indicates an overflow of a magnitude that causes the sign bit to change state.
1 = Overflow occurred for signed arithmetic (in this arithmetic operation)
0 = No overflow occurred

bit 1 **Z:** MCU ALU Zero bit

1 = An operation that affects the Z bit has set it at some time in the past
0 = The most recent operation that affects the Z bit has cleared it (i.e., a non-zero result)

bit 0 **C:** MCU ALU Carry/$\overline{\text{Borrow}}$ bit

1 = A carry-out from the Most Significant bit of the result occurred
0 = No carry-out from the Most Significant bit of the result occurred

**Note 1:** This bit can be read or cleared (not set).

**2:** The IPL<2:0> bits are concatenated with the IPL<3> bit (CORCON<3>) to form the CPU Interrupt Priority Level. The value in parentheses indicates the IPL if IPL<3> = 1. User interrupts are disabled when IPL<3> = 1.

**3:** The IPL<2:0> Status bits are read-only when NSTDIS = 1 (INTCON1<15>).

**REGISTER 3-2: CORCON: CORE CONTROL REGISTER**

| U-0 | U-0 | U-0 | R/W-0 | R/W-0 | R-0 | R-0 | R-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | US | EDT(1) | DL2 | DL1 | DL0 |
| bit 15 | | | | | | | bit 8 |

| R/W-0 | R/W-0 | R/W-1 | R/W-0 | R/C-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| SATA | SATB | SATDW | ACCSAT | IPL3(2) | PSV | RND | IF |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | C = Clearable bit | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | -n = Value at POR | '1' = Bit is set |
| 0' = Bit is cleared | 'x = Bit is unknown | U = Unimplemented bit, read as '0' | |

bit 15-13 **Unimplemented:** Read as '0'

bit 12 **US:** DSP Multiply Unsigned/Signed Control bit
1 = DSP engine multiplies are unsigned
0 = DSP engine multiplies are signed

bit 11 **EDT:** Early DO Loop Termination Control bit(1)
1 = Terminates executing DO loop at the end of current loop iteration
0 = No effect

bit 10-8 **DL<2:0>:** DO Loop Nesting Level Status bits
111 = 7 DO loops are active
•
•
•
001 = 1 DO loop is active
000 = 0 DO loops are active

bit 7 **SATA:** ACCA Saturation Enable bit
1 = Accumulator A saturation is enabled
0 = Accumulator A saturation is disabled

bit 6 **SATB:** ACCB Saturation Enable bit
1 = Accumulator B saturation is enabled
0 = Accumulator B saturation is disabled

bit 5 **SATDW:** Data Space Write from DSP Engine Saturation Enable bit
1 = Data space write saturation is enabled
0 = Data space write saturation is disabled

bit 4 **ACCSAT:** Accumulator Saturation Mode Select bit
1 = 9.31 saturation (super saturation)
0 = 1.31 saturation (normal saturation)

bit 3 **IPL3:** CPU Interrupt Priority Level Status bit 3(2)
1 = CPU Interrupt Priority Level is greater than 7
0 = CPU Interrupt Priority Level is 7 or less

bit 2 **PSV:** Program Space Visibility in Data Space Enable bit
1 = Program space is visible in data space
0 = Program space is not visible in data space

bit 1 **RND:** Rounding Mode Select bit
1 = Biased (conventional) rounding is enabled
0 = Unbiased (convergent) rounding is enabled

bit 0 **IF:** Integer or Fractional Multiplier Mode Select bit
1 = Integer mode is enabled for DSP multiply operations
0 = Fractional mode is enabled for DSP multiply operations

**Note 1:** This bit will always read as '0'.
**2:** The IPL3 bit is concatenated with the IPL<2:0> bits (SR<7:5>) to form the CPU Interrupt Priority Level.


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## 3.5 Arithmetic Logic Unit (ALU)

The dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 ALU is 16 bits wide, and is capable of addition, subtraction, bit shifts and logic operations. Unless otherwise mentioned, arithmetic operations are 2's complement in nature. Depending on the operation, the ALU can affect the values of the Carry (C), Zero (Z), Negative (N), Overflow (OV) and Digit Carry (DC) Status bits in the SR register. The C and DC Status bits operate as Borrow and Digit Borrow bits, respectively, for subtraction operations.

The ALU can perform 8-bit or 16-bit operations, depending on the mode of the instruction that is used. Data for the ALU operation can come from the W register array or data memory, depending on the addressing mode of the instruction. Likewise, output data from the ALU can be written to the W register array or a data memory location.

Refer to the *"16-Bit MCU and DSC Programmer's Reference Manual"* (DS70157) for information on the SR bits affected by each instruction.

The dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 CPU incorporates hardware support for both multiplication and division. This includes a dedicated hardware multiplier and support hardware for 16-bit-divisor division.

### 3.5.1 MULTIPLIER

Using the high-speed, 17-bit x 17-bit multiplier of the DSP engine, the ALU supports unsigned, signed or mixed-sign operation in several MCU multiplication modes:

- 16-bit x 16-bit signed
- 16-bit x 16-bit unsigned
- 16-bit signed x 5-bit (literal) unsigned
- 16-bit unsigned x 16-bit unsigned
- 16-bit unsigned x 5-bit (literal) unsigned
- 16-bit unsigned x 16-bit signed
- 8-bit unsigned x 8-bit unsigned

### 3.5.2 DIVIDER

The divide block supports 32-bit/16-bit and 16-bit/16-bit signed and unsigned integer divide operations with the following data sizes:

- 32-bit signed/16-bit signed divide
- 32-bit unsigned/16-bit unsigned divide
- 16-bit signed/16-bit signed divide
- 16-bit unsigned/16-bit unsigned divide

The quotient for all divide instructions ends up in W0 and the remainder in W1. The 16-bit signed and unsigned DIV instructions can specify any W register for both the 16-bit divisor (Wn) and any W register (aligned) pair (W(m + 1):Wm) for the 32-bit dividend. The divide algorithm takes one cycle per bit of divisor, so both 32-bit/16-bit and 16-bit/16-bit instructions take the same number of cycles to execute.

## 3.6 DSP Engine

The DSP engine consists of a high-speed, 17-bit x 17-bit multiplier, a barrel shifter and a 40-bit adder/subtracter (with two target accumulators, round and saturation logic).

The dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 is a single-cycle instruction flow architecture; therefore, concurrent operation of the DSP engine with MCU instruction flow is not possible. However, some MCU ALU and DSP engine resources can be used concurrently by the same instruction (e.g., ED, EDAC).

The DSP engine can also perform inherent accumulator-to-accumulator operations that require no additional data. These instructions are ADD, SUB and NEG.

The DSP engine has options selected through bits in the CPU Core Control register (CORCON), as listed below:

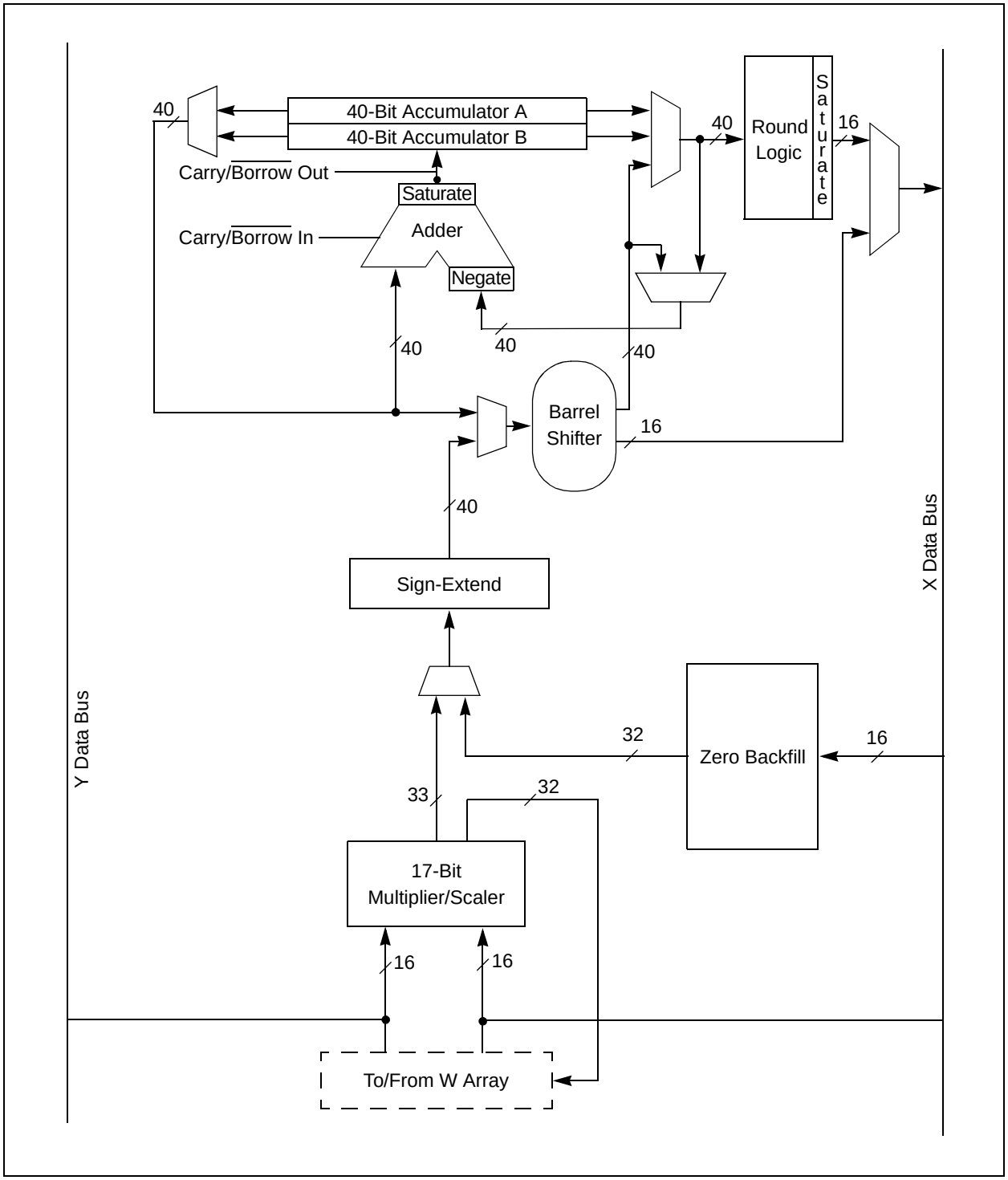
- Fractional or Integer DSP Multiply (IF)
- Signed or Unsigned DSP Multiply (US)
- Conventional or Convergent Rounding (RND)
- Automatic Saturation On/Off for ACCA (SATA)
- Automatic Saturation On/Off for ACCB (SATB)
- Automatic Saturation On/Off for Writes to Data Memory (SATDW)
- Accumulator Saturation mode Selection (ACCSAT)

A block diagram of the DSP engine is shown in Figure 3-3.

**TABLE 3-1: DSP INSTRUCTIONS SUMMARY**

| Instruction | Algebraic Operation | ACC Write Back |
|---|---|---|
| CLR | $A = 0$ | Yes |
| ED | $A = (x - y)^2$ | No |
| EDAC | $A = A + (x - y)^2$ | No |
| MAC | $A = A + (x * y)$ | Yes |
| MAC | $A = A + x^2$ | No |
| MOVSAC | No change in $A$ | Yes |
| MPY | $A = x * y$ | No |
| MPY | $A = x^2$ | No |
| MPY.N | $A = -x * y$ | No |
| MSC | $A = A - x * y$ | Yes |

**FIGURE 3-3: DSP ENGINE BLOCK DIAGRAM**





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### 3.6.1 MULTIPLIER

The 17-bit x 17-bit multiplier is capable of signed or unsigned operation and can multiplex its output using a scaler to support either 1.31 fractional (Q31) or 32-bit integer results. Unsigned operands are zero-extended into the 17th bit of the multiplier input value. Signed operands are sign-extended into the 17th bit of the multiplier input value. The output of the 17-bit x 17-bit multiplier/scaler is a 33-bit value that is sign-extended to 40 bits. Integer data is inherently represented as a signed 2's complement value, where the Most Significant bit (MSb) is defined as a sign bit. The range of an N-bit 2's complement integer is $-2^{N-1}$ to $2^{N-1} – 1$.

- For a 16-bit integer, the data range is -32768 (0x8000) to 32767 (0x7FFF) including 0.
- For a 32-bit integer, the data range is -2,147,483,648 (0x8000 0000) to 2,147,483,647 (0x7FFF FFFF).

When the multiplier is configured for fractional multiplication, the data is represented as a 2's complement fraction, where the MSb is defined as a sign bit and the radix point is implied to lie just after the sign bit (QX format). The range of an N-bit 2's complement fraction with this implied radix point is -1.0 to $(1 – 2^{1-N})$. For a 16-bit fraction, the Q15 data range is -1.0 (0x8000) to 0.999969482 (0x7FFF) including 0 and has a precision of $3.01518 \times 10^{-5}$. In Fractional mode, the 16 x 16 multiply operation generates a 1.31 product that has a precision of $4.65661 \times 10^{-10}$.

The same multiplier is used to support the MCU multiply instructions, which include integer 16-bit signed, unsigned and mixed sign multiply operations.

The `MUL` instruction can be directed to use byte or word-sized operands. Byte operands will direct a 16-bit result and word operands will direct a 32-bit result to the specified register(s) in the W array.

### 3.6.2 DATA ACCUMULATORS AND ADDER/SUBTRACTER

The data accumulator consists of a 40-bit adder/subtracter with automatic sign extension logic. It can select one of two accumulators (A or B) as its pre-accumulation source and post-accumulation destination. For the `ADD` and `LAC` instructions, the data to be accumulated or loaded can be optionally scaled using the barrel shifter prior to accumulation.

#### 3.6.2.1 Adder/Subtracter, Overflow and Saturation

The adder/subtracter is a 40-bit adder with an optional zero input into one side and either true or complement data into the other input.

- In the case of addition, the Carry/$\overline{\text{Borrow}}$ input is active-high and the other input is true data (not complemented).
- In the case of subtraction, the Carry/$\overline{\text{Borrow}}$ input is active-low and the other input is complemented.

The adder/subtracter generates Overflow Status bits, SA/SB and OA/OB, which are latched and reflected in the STATUS Register:

- Overflow from bit 39: this is a catastrophic overflow in which the sign of the accumulator is destroyed.
- Overflow into guard bits 32 through 39: this is a recoverable overflow. This bit is set whenever all the guard bits are not identical to each other.

The adder has an additional saturation block that controls accumulator data saturation, if selected. It uses the result of the adder, the Overflow Status bits described previously, and the SAT<A:B> (CORCON<7:6>) and ACCSAT (CORCON<4>) mode control bits to determine when and to what value, to saturate.

Six STATUS Register bits support saturation and overflow:

- OA: ACCA overflowed into guard bits
- OB: ACCB overflowed into guard bits
- SA: ACCA saturated (bit 31 overflow and saturation)

  *or*

  ACCA overflowed into guard bits and saturated (bit 39 overflow and saturation)
- SB: ACCB saturated (bit 31 overflow and saturation)

  *or*

  ACCB overflowed into guard bits and saturated (bit 39 overflow and saturation)
- OAB: Logical OR of OA and OB
- SAB: Logical OR of SA and SB

The OA and OB bits are modified each time data passes through the adder/subtracter. When set, they indicate that the most recent operation has overflowed into the accumulator guard bits (bits 32 through 39). The OA and OB bits can also optionally generate an arithmetic warning trap when OA and OB are set and the corresponding Overflow Trap Flag Enable bits (OVATE, OVBTE) in the INTCON1 register are set (refer to **Section 7.0 "Interrupt Controller"**). This allows the user application to take immediate action; for example, to correct system gain.

The SA and SB bits are modified each time data passes through the adder/subtracter, but can only be cleared by the user application. When set, they indicate that the accumulator has overflowed its maximum range (bit 31 for 32-bit saturation or bit 39 for 40-bit saturation) and will be saturated (if saturation is enabled). When saturation is not enabled, SA and SB default to bit 39 overflow, and therefore, indicate that a catastrophic overflow has occurred. If the COVTE bit in the INTCON1 register is set, the SA and SB bits will generate an arithmetic warning trap when saturation is disabled.

The Overflow and Saturation Status bits can optionally be viewed in the STATUS Register (SR) as the logical OR of OA and OB (in bit OAB) and the logical OR of SA and SB (in bit SAB). Programmers can check one bit in the STATUS Register to determine whether either accumulator has overflowed, or one bit to determine whether either accumulator has saturated. This is useful for complex number arithmetic, which typically uses both accumulators.

The device supports three Saturation and Overflow modes:

- Bit 39 Overflow and Saturation:
  When bit 39 overflow and saturation occurs, the saturation logic loads the maximally positive 9.31 value (0x7FFFFFFFFF) or maximally negative 9.31 value (0x8000000000) into the target accumulator. The SA or SB bit is set and remains set until cleared by the user application. This condition is referred to as ‘super saturation’ and provides protection against erroneous data or unexpected algorithm problems (such as gain calculations).
- Bit 31 Overflow and Saturation:
  When bit 31 overflow and saturation occurs, the saturation logic then loads the maximally positive 1.31 value (0x007FFFFFFF) or maximally negative 1.31 value (0x0080000000) into the target accumulator. The SA or SB bit is set and remains set until cleared by the user application. When this Saturation mode is in effect, the guard bits are not used, so the OA, OB or OAB bits are never set.
- Bit 39 Catastrophic Overflow:
  The bit 39 Overflow Status bit from the adder is used to set the SA or SB bit, which remains set until cleared by the user application. No saturation operation is performed and the accumulator is allowed to overflow, destroying its sign. If the COVTE bit in the INTCON1 register is set, a catastrophic overflow can initiate a trap exception.

### 3.6.3 ACCUMULATOR ‘WRITE BACK’

The MAC class of instructions (with the exception of MPY, MPY.N, ED and EDAC) can optionally write a rounded version of the high word (bits 31 through 16) of the accumulator which is not targeted by the instruction into data space memory. The write is performed across the X bus into combined X and Y address space. The following addressing modes are supported:

- W13, Register Direct:
  The rounded contents of the non-target accumulator are written into W13 as a 1.15 fraction.
- [W13]+ = 2, Register Indirect with Post-Increment:
  The rounded contents of the non-target accumulator are written into the address pointed to by W13 as a 1.15 fraction. W13 is then incremented by 2 (for a word write).

#### 3.6.3.1 Round Logic

The round logic is a combinational block that performs a conventional (biased) or convergent (unbiased) round function during an accumulator write (store). The Round mode is determined by the state of the RND bit in the CORCON register. It generates a 16-bit, 1.15 data value that is passed to the data space write saturation logic. If rounding is not indicated by the instruction, a truncated 1.15 data value is stored and the least significant word (lsw) is simply discarded.

Conventional rounding will zero-extend bit 15 of the accumulator and will add it to the ACCxH word (bits 16 through 31 of the accumulator).

- If the ACCxL word (bits 0 through 15 of the accumulator) is between 0x8000 and 0xFFFF (0x8000 included), ACCxH is incremented.
- If ACCxL is between 0x0000 and 0x7FFF, ACCxH is left unchanged.

A consequence of this algorithm is that over a succession of random rounding operations, the value tends to be biased slightly positive.

Convergent (or unbiased) rounding operates in the same manner as conventional rounding, except when ACCxL equals 0x8000. In this case, the Least Significant bit (LSb), bit 16 of the accumulator, of ACCxH is examined:

- If it is ‘1’, ACCxH is incremented.
- If it is ‘0’, ACCxH is not modified.

Assuming that bit 16 is effectively random in nature, this scheme removes any rounding bias that may accumulate.


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The SAC and SAC.R instructions store either a truncated (SAC), or rounded (SAC.R) version of the contents of the target accumulator to data memory via the X bus, subject to data saturation (see **Section 3.6.3.2 "Data Space Write Saturation"**). For the MAC class of instructions, the accumulator write-back operation functions in the same manner, addressing combined MCU (X and Y) data space though the X bus. For this class of instructions, the data is always subject to rounding.

#### 3.6.3.2 Data Space Write Saturation

In addition to adder/subtracter saturation, writes to data space can also be saturated, but without affecting the contents of the source accumulator. The data space write saturation logic block accepts a 16-bit, 1.15 fractional value from the round logic block as its input, together with overflow status from the original source (accumulator) and the 16-bit round adder. These inputs are combined and used to select the appropriate 1.15 fractional value as output to write to data space memory.

If the SATDW bit in the CORCON register is set, data (after rounding or truncation) is tested for overflow and adjusted accordingly:

- For input data greater than 0x007FFF, data written to memory is forced to the maximum positive 1.15 value, 0x7FFF.
- For input data less than 0xFF8000, data written to memory is forced to the maximum negative 1.15 value, 0x8000.

The MSb of the source (bit 39) is used to determine the sign of the operand being tested.

If the SATDW bit in the CORCON register is not set, the input data is always passed through unmodified under all conditions.

### 3.6.4 BARREL SHIFTER

The barrel shifter can perform up to 16-bit arithmetic or logic right shifts, or up to 16-bit left shifts, in a single cycle. The source can be either of the two DSP accumulators or the X bus (to support multi-bit shifts of register or memory data).

The shifter requires a signed binary value to determine both the magnitude (number of bits) and direction of the shift operation. A positive value shifts the operand right. A negative value shifts the operand left. A value of '0' does not modify the operand.

The barrel shifter is 40 bits wide, thereby obtaining a 40-bit result for DSP shift operations and a 16-bit result for MCU shift operations. Data from the X bus is presented to the barrel shifter between Bit Positions 16 and 31 for right shifts, and between Bit Positions 0 and 16 for left shifts.

**NOTES:**


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# 4.0 MEMORY ORGANIZATION

**Note:** This data sheet summarizes the features of the dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 family devices. However, it is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **"Data Memory"** (DS70202) and **"Program Memory"** (DS70203) in the *"dsPIC33/PIC24 Family Reference Manual"*, which are available from the Microchip web site (www.microchip.com).

The device architecture features separate program and data memory spaces and buses. This architecture also allows the direct access of program memory from the data space during code execution.

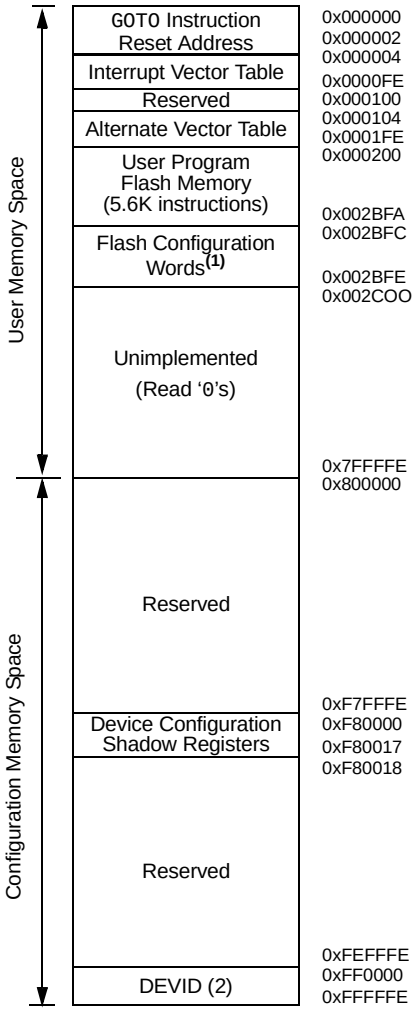
## 4.1 Program Address Space

The program address memory space of the dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 devices is 4M instructions. The space is addressable by a 24-bit value derived either from the 23-bit Program Counter (PC) during program execution, or from table operation or data space remapping as described in **Section 4.6 "Interfacing Program and Data Memory Spaces"**.

User application access to the program memory space is restricted to the lower half of the address range (0x000000 to 0x7FFFFF). The exception is the use of TBLRD/TBLWT operations, which use TBLPAG<7> to permit access to the Configuration bits and Device ID sections of the configuration memory space.

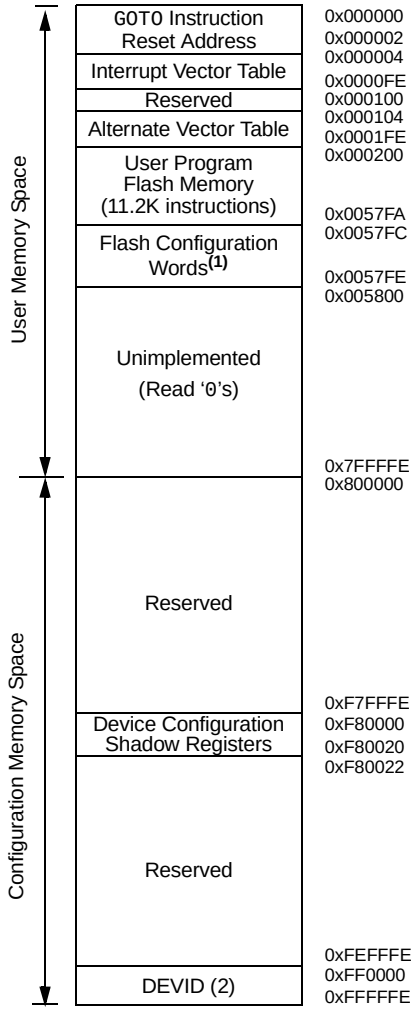
The memory maps for the dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 family of devices are shown in Figure 4-1 and Figure 4-2.

**FIGURE 4-1: PROGRAM MEMORY MAP FOR dsPIC33FJ16(GP/MC)101/102 DEVICES**




**Note 1:** On Reset, these bits are automatically copied into the device Configuration Shadow registers.

**FIGURE 4-2: PROGRAM MEMORY MAP FOR dsPIC33FJ32(GP/MC)101/102/104 DEVICES**




**Note 1:** On Reset, these bits are automatically copied into the device Configuration Shadow registers.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### 4.1.1 PROGRAM MEMORY ORGANIZATION

The program memory space is organized in word-addressable blocks. Although it is treated as 24 bits wide, it is more appropriate to think of each address of the program memory as a lower and upper word, with the upper byte of the upper word being unimplemented. The lower word always has an even address, while the upper word has an odd address (Figure 4-3).

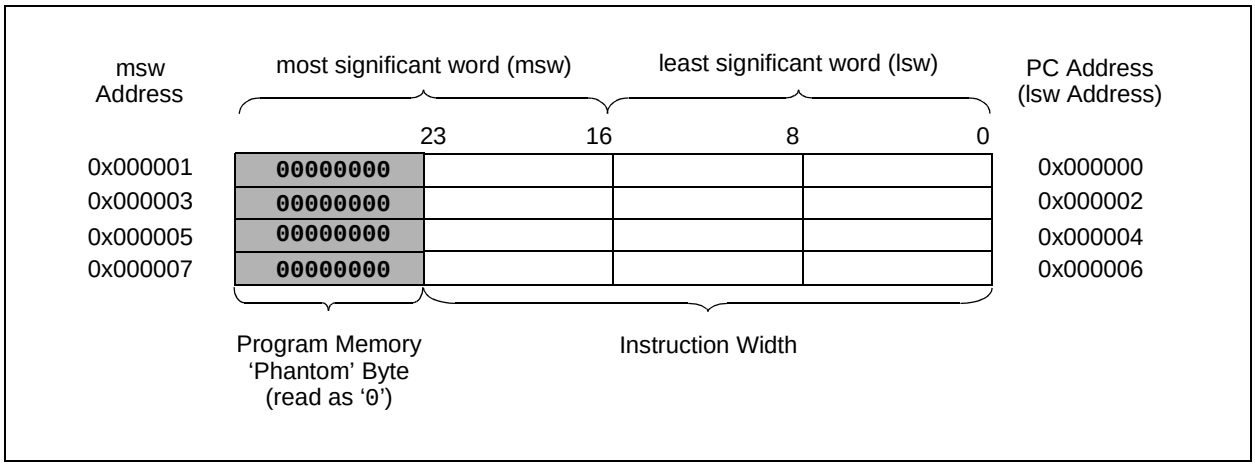
Program memory addresses are always word-aligned on the lower word and addresses are incremented or decremented by two during code execution. This arrangement provides compatibility with data memory space addressing and makes data in the program memory space accessible.

### 4.1.2 INTERRUPT AND TRAP VECTORS

All of the dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 devices reserve the addresses between 0x00000 and 0x000200 for hard-coded program execution vectors. A hardware Reset vector is provided to redirect code execution from the default value of the PC on device Reset to the actual start of code. A GOTO instruction is programmed by the user application at 0x000000, with the actual address for the start of code at 0x000002.

dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 devices also have two Interrupt Vector Tables (IVTs), located from 0x000004 to 0x0000FF and 0x000100 to 0x0001FF. These vector tables allow each of the device interrupt sources to be handled by separate Interrupt Service Routines (ISRs). A more detailed discussion of the Interrupt Vector Tables is provided in **Section 7.1 "Interrupt Vector Table"**.

**FIGURE 4-3: PROGRAM MEMORY ORGANIZATION**



## 4.2 Data Address Space

The dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 family CPU has a separate 16-bit-wide data memory space. The data space is accessed using separate Address Generation Units (AGUs) for read and write operations. The data memory maps is shown in Figure 4-4.

All Effective Addresses (EAs) in the data memory space are 16 bits wide and point to bytes within the data space. This arrangement gives a data space address range of 64 Kbytes or 32K words. The lower half of the data memory space (that is, when EA<15> = 0) is used for implemented memory addresses, while the upper half (EA<15> = 1) is reserved for the Program Space Visibility area (see **Section 4.6.3 "Reading Data from Program Memory Using Program Space Visibility"**).

Microchip dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 devices implement up to 2 Kbytes of data memory. Should an EA point to a location outside of this area, an all-zero word or byte will be returned.

### 4.2.1 DATA SPACE WIDTH

The data memory space is organized in byte-addressable, 16-bit wide blocks. Data is aligned in data memory and registers as 16-bit words, but all data space EAs resolve to bytes. The Least Significant Bytes (LSBs) of each word have even addresses, while the Most Significant Bytes (MSBs) have odd addresses.

### 4.2.2 DATA MEMORY ORGANIZATION AND ALIGNMENT

To maintain backward compatibility with PIC® MCU devices and improve data space memory usage efficiency, the dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 family instruction set supports both word and byte operations. As a consequence of byte accessibility, all Effective Address calculations are internally scaled to step through word-aligned memory. For example, the core recognizes that Post-Modified Register Indirect Addressing mode [Ws++] will result in a value of Ws + 1 for byte operations and Ws + 2 for word operations.

Data byte reads will read the complete word that contains the byte, using the LSB of any EA to determine which byte to select. The selected byte is placed onto the LSB of the data path. That is, data memory and registers are organized as two parallel byte-wide entities with shared (word) address decoding but separate write lines. Data byte writes only write to the corresponding side of the array or register that matches the byte address.

All word accesses must be aligned to an even address. Misaligned word data fetches are not supported, so care must be taken when mixing byte and word operations, or translating from 8-bit MCU code. If a misaligned read or write is attempted, an address error trap is generated. If the error occurred on a read, the instruction in progress is completed. If the error occurred on a write, the instruction is executed but the write does not occur. In either case, a trap is then executed, allowing the system and/or user application to examine the machine state prior to execution of the address Fault.

All byte loads into any W register are loaded into the LSB. The MSB is not modified.

A Sign-Extend (SE) instruction is provided to allow user applications to translate 8-bit signed data to 16-bit signed values. Alternately, for 16-bit unsigned data, user applications can clear the MSB of any W register by executing a Zero-Extend (ZE) instruction on the appropriate address.

### 4.2.3 SFR SPACE

The first 2 Kbytes of the Near Data Space, from 0x0000 to 0x07FF, is primarily occupied by Special Function Registers (SFRs). These are used by the dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 family core and peripheral modules for controlling the operation of the device.

SFRs are distributed among the modules that they control and are generally grouped together by module. Much of the SFR space contains unused addresses; these are read as '0'.

| | |
|---|---|
| **Note:** | The actual set of peripheral features and interrupts varies by the device. Refer to the corresponding device tables and pinout diagrams for device-specific information. |

### 4.2.4 NEAR DATA SPACE

The 8-Kbyte area, between 0x0000 and 0x1FFF, is referred to as the Near Data Space. Locations in this space are directly addressable via a 13-bit absolute address field within all memory direct instructions. Additionally, the whole data space is addressable using the MOV class of instructions, which support Memory Direct Addressing mode with a 16-bit address field or by using Indirect Addressing mode with a Working register as an Address Pointer.


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**FIGURE 4-4: DATA MEMORY MAP FOR dsPIC33FJ16(GP/MC)101/102 DEVICES WITH 1-KBYTE RAM**

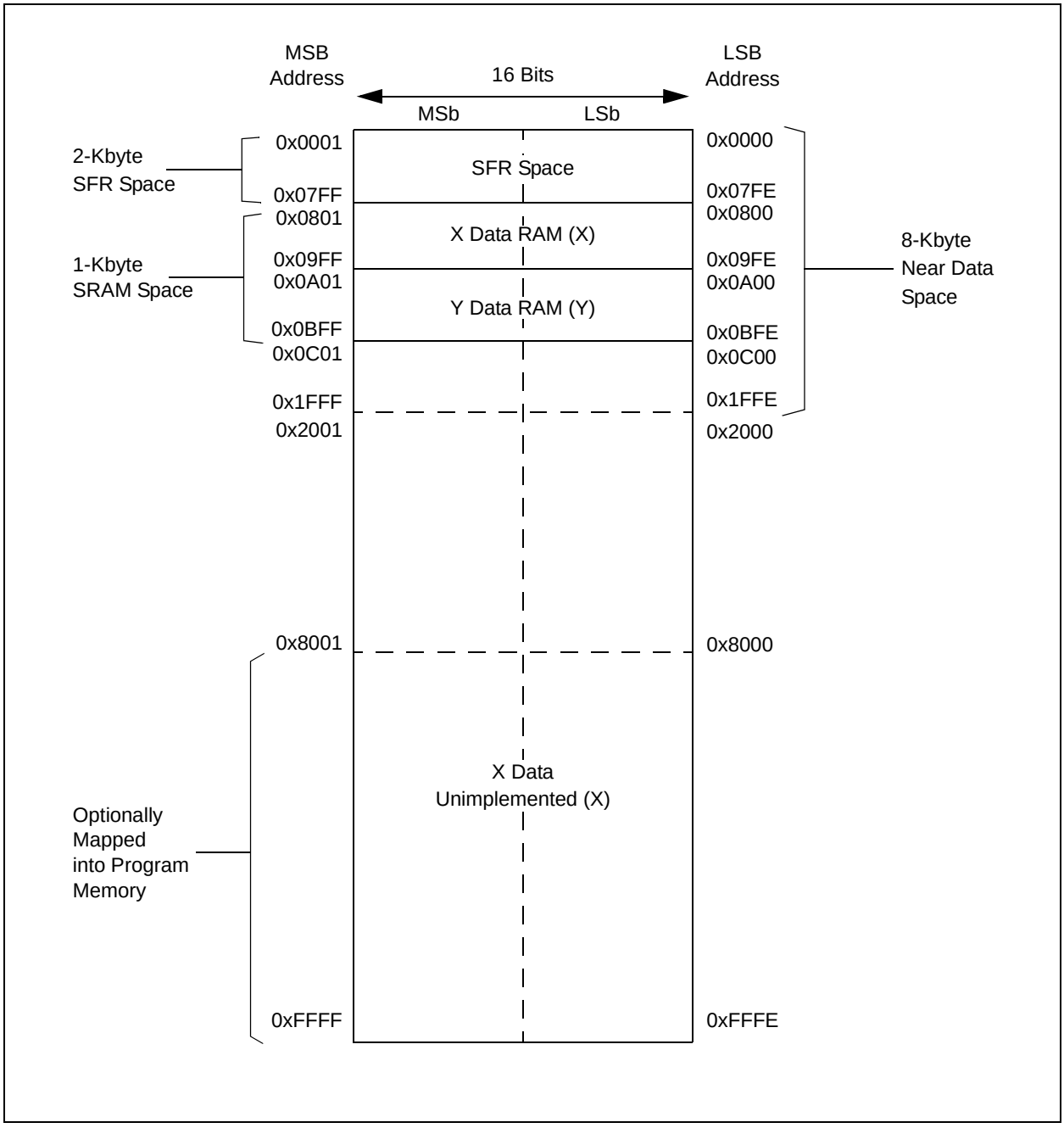
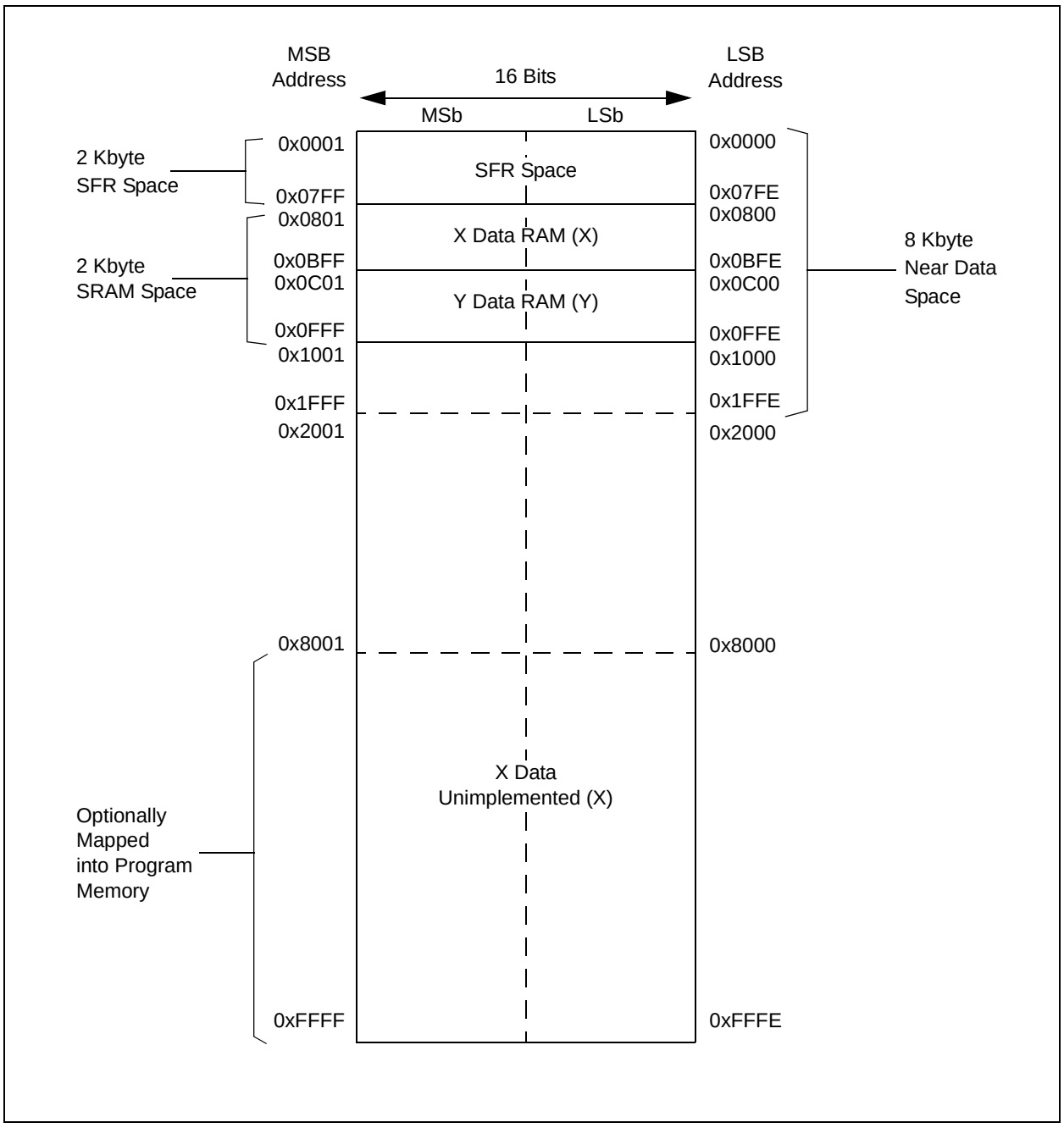


**FIGURE 4-5: DATA MEMORY MAP FOR dsPIC33FJ32(GP/MC)101/102/104 DEVICES WITH 2-KBYTE RAM**





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### 4.2.5 X AND Y DATA SPACES

The core has two data spaces, X and Y. These data spaces can be considered either separate (for some DSP instructions), or as one unified linear address range (for MCU instructions). The data spaces are accessed using two Address Generation Units (AGUs) and separate data paths. This feature allows certain instructions to concurrently fetch two words from RAM, thereby enabling efficient execution of DSP algorithms such as Finite Impulse Response (FIR) filtering and Fast Fourier transform (FFT).

The X data space is used by all instructions and supports all addressing modes. X data space has separate read and write data buses. The X read data bus is the read data path for all instructions that view data space as combined X and Y address space. It is also the X data prefetch path for the dual operand DSP instructions (MAC class).

The Y data space is used in concert with the X data space by the MAC class of instructions (CLR, ED, EDAC, MAC, MOVSAC, MPY, MPY.N and MSC) to provide two concurrent data read paths.

Both the X and Y data spaces support Modulo Addressing mode for all instructions, subject to addressing mode restrictions. Bit-Reversed Addressing mode is only supported for writes to X data space.

All data memory writes, including in DSP instructions, view data space as combined X and Y address space. The boundary between the X and Y data spaces is device-dependent and is not user-programmable.

All Effective Addresses are 16 bits wide and point to bytes within the data space. Therefore, the data space address range is 64 Kbytes, or 32K words, although the implemented memory locations vary by device.

**TABLE 4-1: CPU CORE REGISTER MAP**

| SFR Name | SFR Addr | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | All Resets |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| WREG0 | 0000 | Working Register 0 | | | | | | | | | | | | | | | | xxxx |
| WREG1 | 0002 | Working Register 1 | | | | | | | | | | | | | | | | xxxx |
| WREG2 | 0004 | Working Register 2 | | | | | | | | | | | | | | | | xxxx |
| WREG3 | 0006 | Working Register 3 | | | | | | | | | | | | | | | | xxxx |
| WREG4 | 0008 | Working Register 4 | | | | | | | | | | | | | | | | xxxx |
| WREG5 | 000A | Working Register 5 | | | | | | | | | | | | | | | | xxxx |
| WREG6 | 000C | Working Register 6 | | | | | | | | | | | | | | | | xxxx |
| WREG7 | 000E | Working Register 7 | | | | | | | | | | | | | | | | xxxx |
| WREG8 | 0010 | Working Register 8 | | | | | | | | | | | | | | | | xxxx |
| WREG9 | 0012 | Working Register 9 | | | | | | | | | | | | | | | | xxxx |
| WREG10 | 0014 | Working Register 10 | | | | | | | | | | | | | | | | xxxx |
| WREG11 | 0016 | Working Register 11 | | | | | | | | | | | | | | | | xxxx |
| WREG12 | 0018 | Working Register 12 | | | | | | | | | | | | | | | | xxxx |
| WREG13 | 001A | Working Register 13 | | | | | | | | | | | | | | | | xxxx |
| WREG14 | 001C | Working Register 14 | | | | | | | | | | | | | | | | xxxx |
| WREG15 | 001E | Working Register 15 | | | | | | | | | | | | | | | | 0800 |
| SPLIM | 0020 | Stack Pointer Limit Register | | | | | | | | | | | | | | | | xxxx |
| ACCAL | 0022 | Accumulator A Low Word Register | | | | | | | | | | | | | | | | xxxx |
| ACCAH | 0024 | Accumulator A High Word Register | | | | | | | | | | | | | | | | xxxx |
| ACCAU | 0026 | Accumulator A Upper Word Register | | | | | | | | | | | | | | | | xxxx |
| ACCBL | 0028 | Accumulator B Low Word Register | | | | | | | | | | | | | | | | xxxx |
| ACCBH | 002A | Accumulator B High Word Register | | | | | | | | | | | | | | | | xxxx |
| ACCBU | 002C | Accumulator B Upper Word Register | | | | | | | | | | | | | | | | xxxx |
| PCL | 002E | Program Counter Low Word Register | | | | | | | | | | | | | | | | 0000 |
| PCH | 0030 | — | — | — | — | — | — | — | — | Program Counter High Byte Register | | | | | | | | 0000 |
| TBLPAG | 0032 | — | — | — | — | — | — | — | — | Table Page Address Pointer Register | | | | | | | | 0000 |
| PSVPAG | 0034 | — | — | — | — | — | — | — | — | Program Memory Visibility Page Address Pointer Register | | | | | | | | 0000 |
| RCOUNT | 0036 | Repeat Loop Counter Register | | | | | | | | | | | | | | | | xxxx |
| DCOUNT | 0038 | DCOUNT<15:0> | | | | | | | | | | | | | | | | xxxx |
| DOSTARTL | 003A | DOSTARTL<15:1> | | | | | | | | | | | | | | | 0 | xxxx |
| DOSTARTH | 003C | — | — | — | — | — | — | — | — | — | — | DOSTARTH<5:0> | | | | | | 00xx |
| DOENDL | 003E | DOENDL<15:1> | | | | | | | | | | | | | | | 0 | xxxx |
| DOENDH | 0040 | — | — | — | — | — | — | — | — | — | — | DOENDH | | | | | | 00xx |
| SR | 0042 | OA | OB | SA | SB | OAB | SAB | DA | DC | IPL2 | IPL1 | IPL0 | RA | N | OV | Z | C | 0000 |

**Legend:** x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.



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**TABLE 4-1: CPU CORE REGISTER MAP (CONTINUED)**

| SFR Name | SFR Addr | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | All Resets |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| CORCON | 0044 | — | — | — | US | EDT | DL2 | DL1 | DL0 | SATA | SATB | SATDW | ACCSAT | IPL3 | PSV | RND | IF | 0020 |
| MODCON | 0046 | XMODEN | YMODEN | — | — | BWM3 | BWM2 | BWM1 | BWM0 | YWM3 | YWM2 | YWM1 | YWM0 | XWM3 | XWM2 | XWM1 | XWM0 | 0000 |
| XMODSRT | 0048 | XS<15:1> | | | | | | | | | | | | | | | 0 | xxxx |
| XMODEND | 004A | XE<15:1> | | | | | | | | | | | | | | | 1 | xxxx |
| YMODSRT | 004C | YS<15:1> | | | | | | | | | | | | | | | 0 | xxxx |
| YMODEND | 004E | YE<15:1> | | | | | | | | | | | | | | | 1 | xxxx |
| XBREV | 0050 | BREN | XB<14:0> | | | | | | | | | | | | | | | xxxx |
| DISICNT | 0052 | — | — | Disable Interrupts Counter Register | | | | | | | | | | | | | | 0000 |

**Legend:** x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

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**TABLE 4-2: CHANGE NOTIFICATION REGISTER MAP FOR dsPIC33FJXXGP101 DEVICES**

| SFR Name | SFR Addr | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | All Resets |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| CNEN1 | 0060 | — | — | — | CN12IE | CN11IE | — | — | — | — | — | CN5IE | CN4IE | CN3IE | CN2IE | CN1IE | CN0IE | 0000 |
| CNEN2 | 0062 | — | CN30IE | CN29IE | — | — | — | — | — | CN23IE | CN22IE | CN21IE | — | — | — | — | — | 0000 |
| CNPU1 | 0068 | — | — | — | CN12PUE | CN11PUE | — | — | — | — | — | CN5PUE | CN4PUE | CN3PUE | CN2PUE | CN1PUE | CN0PUE | 0000 |
| CNPU2 | 006A | — | CN30PUE | CN29PUE | — | — | — | — | — | CN23PUE | CN22PUE | CN21PUE | — | — | — | — | — | 0000 |

**Legend:** — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

**TABLE 4-3: CHANGE NOTIFICATION REGISTER MAP FOR dsPIC33FJXXMC101 DEVICES**

| SFR Name | SFR Addr | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | All Resets |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| CNEN1 | 0060 | — | CN14IE | CN13IE | CN12IE | CN11IE | — | — | — | — | — | CN5IE | CN4IE | CN3IE | CN2IE | CN1IE | CN0IE | 0000 |
| CNEN2 | 0062 | — | CN30IE | CN29IE | — | — | — | — | — | CN23IE | CN22IE | CN21IE | — | — | — | — | — | 0000 |
| CNPU1 | 0068 | — | CN14PUE | CN13PUE | CN12PUE | CN11PUE | — | — | — | — | — | CN5PUE | CN4PUE | CN3PUE | CN2PUE | CN1PUE | CN0PUE | 0000 |
| CNPU2 | 006A | — | CN30PUE | CN29PUE | — | — | — | — | — | CN23PUE | CN22PUE | CN21PUE | — | — | — | — | — | 0000 |

**Legend:** — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

**TABLE 4-4: CHANGE NOTIFICATION REGISTER MAP FOR dsPIC33FJXX(GP/MC)102 DEVICES**

| SFR Name | SFR Addr | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | All Resets |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| CNEN1 | 0060 | CN15IE | CN14IE | CN13IE | CN12IE | CN11IE | — | — | — | CN7IE | CN6IE | CN5IE | CN4IE | CN3IE | CN2IE | CN1IE | CN0IE | 0000 |
| CNEN2 | 0062 | — | CN30IE | CN29IE | — | CN27IE | — | — | CN24IE | CN23IE | CN22IE | CN21IE | — | — | — | — | CN16IE | 0000 |
| CNPU1 | 0068 | CN15PUE | CN14PUE | CN13PUE | CN12PUE | CN11PUE | — | — | — | CN7PUE | CN6PUE | CN5PUE | CN4PUE | CN3PUE | CN2PUE | CN1PUE | CN0PUE | 0000 |
| CNPU2 | 006A | — | CN30PUE | CN29PUE | — | CN27PUE | — | — | CN24PUE | CN23PUE | CN22PUE | CN21PUE | — | — | — | — | CN16PUE | 0000 |

**Legend:** — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

**TABLE 4-5: CHANGE NOTIFICATION REGISTER MAP FOR dsPIC33FJ32(GP/MC)104 DEVICES**

| SFR Name | SFR Addr | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | All Resets |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| CNEN1 | 0060 | CN15IE | CN13IE | CN13IE | CN12IE | CN11IE | CN10IE | CN9IE | CN8IE | CN7IE | CN6IE | CN5IE | CN4IE | CN3IE | CN2IE | CN1IE | CN0IE | 0000 |
| CNEN2 | 0062 | — | CN30IE | CN29IE | CN28IE | CN27IE | CN26IE | CN25IE | CN24IE | CN23IE | CN22IE | CN21IE | CN20IE | CN19IE | CN18IE | CN17IE | CN16IE | 0000 |
| CNPU1 | 0068 | CN15PUE | CN13PUE | CN13PUE | CN12PUE | CN11PUE | CN10PUE | CN9PUE | CN8PUE | CN7PUE | CN6PUE | CN5PUE | CN4PUE | CN3PUE | CN2PUE | CN1PUE | CN0PUE | 0000 |
| CNPU2 | 006A | — | CN30PUE | CN29PUE | CN28PUE | CN27PUE | CN26PUE | CN25PUE | CN24PUE | CN23PUE | CN22PUE | CN21PUE | CN20PUE | CN19PUE | CN18PUE | CN17PUE | CN16PUE | 0000 |

**Legend:** — = unimplemented, read as '0'. Reset values are shown in hexadecimal.



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**TABLE 4-6: INTERRUPT CONTROLLER REGISTER MAP**

| SFR Name | SFR Addr | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | All Resets |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| INTCON1 | 0080 | NSTDIS | OVAERR | OVBERR | COVAERR | COVBERR | OVATE | OVBTE | COVTE | SFTACERR | DIV0ERR | — | MATHERR | ADDRERR | STKERR | OSCFAIL | — | 0000 |
| INTCON2 | 0082 | ALTIVT | DISI | — | — | — | — | — | — | — | — | — | — | — | INT2EP | INT1EP | INT0EP | 0000 |
| IFS0 | 0084 | — | — | AD1IF | U1TXIF | U1RXIF | SPI1IF | SPI1EIF | T3IF | T2IF | OC2IF | IC2IF | — | T1IF | OC1IF | IC1IF | INT0IF | 0000 |
| IFS1 | 0086 | — | — | INT2IF | T5IF(2) | T4IF(2) | — | — | — | — | — | — | INT1IF | CNIF | CMIF | MI2C1IF | SI2C1IF | 0000 |
| IFS2 | 0088 | — | — | — | — | — | — | — | — | — | — | IC3IF | — | — | — | — | — | 0000 |
| IFS3 | 008A | FLTA1IF(1) | RTCIF | — | — | — | — | PWM1IF(1) | — | — | — | — | — | — | — | — | — | 0000 |
| IFS4 | 008C | — | — | CTMUIF | — | — | — | — | — | — | — | — | — | — | — | U1EIF | FLTB1IF(3) | 0000 |
| IEC0 | 0094 | — | — | AD1IE | U1TXIE | U1RXIE | SPI1IE | SPI1EIE | T3IE | T2IE | OC2IE | IC2IE | — | T1IE | OC1IE | IC1IE | INT0IE | 0000 |
| IEC1 | 0096 | — | — | INT2IE | T5IE(2) | T4IE(2) | — | — | — | — | — | — | INT1IE | CNIE | CMIE | MI2C1IE | SI2C1IE | 0000 |
| IEC2 | 0098 | — | — | — | — | — | — | — | — | — | — | IC3IE | — | — | — | — | — | 0000 |
| IEC3 | 009A | FLTA1IE(1) | RTCIE | — | — | — | — | PWM1IE(1) | — | — | — | — | — | — | — | — | — | 0000 |
| IEC4 | 009C | — | — | CTMUIE | — | — | — | — | — | — | — | — | — | — | — | U1EIE | FLTB1IE(3) | 0000 |
| IPC0 | 00A4 | — | T1IP2 | T1IP1 | T1IP0 | — | OC1IP2 | OC1IP1 | OC1IP0 | — | IC1IP2 | IC1IP1 | IC1IP0 | — | INT0IP2:0> | | | 4444 |
| IPC1 | 00A6 | — | T2IP2 | T2IP1 | T2IP0 | — | OC2IP2 | OC2IP1 | OC2IP0 | — | IC2IP2 | IC2IP1 | IC2IP0 | — | — | — | — | 4440 |
| IPC2 | 00A8 | — | U1RXIP2 | U1RXIP1 | U1RXIP0 | — | SPI1IP2 | SPI1IP1 | SPI1IP0 | — | SPI1EIP2 | SPI1EIP1 | SPI1EIP0 | — | T3IP2 | T3IP1 | T3IP0 | 4444 |
| IPC3 | 00AA | — | — | — | — | — | — | — | — | — | AD1IP2 | AD1IP1 | AD1IP0 | — | U1TXIP2 | U1TXIP1 | U1TXIP0 | 0044 |
| IPC4 | 00AC | — | CNIP2 | CNIP1 | CNIP0 | — | CMIP2 | CMIP1 | CMIP0 | — | MI2C1IP2 | MI2C1IP1 | MI2C1IP0 | — | SI2C1IP2 | SI2C1IP1 | SI2C1IP0 | 4444 |
| IPC5 | 00AE | — | — | — | — | — | — | — | — | — | — | — | — | — | INT1IP2 | INT1IP1 | INT1IP0 | 0004 |
| IPC6 | 00B0 | — | T4IP2(2) | T4IP1(2) | T4IP0(2) | — | — | — | — | — | — | — | — | — | — | — | — | 4000 |
| IPC7 | 00B2 | — | — | — | — | — | — | — | — | — | INT2IP2 | INT2IP1 | INT2IP0 | — | T5IP2(2) | T5IP1(2) | T5IP0(2) | 0044 |
| IPC9 | 00B6 | — | — | — | — | — | — | — | — | — | IC3IP2 | IC3IP1 | IC3IP0 | — | — | — | — | 0040 |
| IPC14 | 00C0 | — | — | — | — | — | — | — | — | — | PWM1IP2(1) | PWM1IP1(1) | PWM1IP0(1) | — | — | — | — | 0040 |
| IPC15 | 00C2 | — | FLTA1IP2(1) | FLTA1IP1(1) | FLTA1IP0(1) | — | RTCIP2 | RTCIP1 | RTCIP0 | — | — | — | — | — | — | — | — | 4400 |
| IPC16 | 00C4 | — | — | — | — | — | — | — | — | — | U1EIP2 | U1EIP1 | U1EIP0 | — | FLTB1IP2(3) | FLTB1IP1(3) | FLTB1IP0(3) | 0040 |
| IPC19 | 00CA | — | — | — | — | — | — | — | — | — | CTMUIP2 | CTMUIP1 | CTMUIP0 | — | — | — | — | 0040 |
| INTTREG | 00E0 | — | — | — | — | ILR3 | ILR2 | ILR1 | ILR0 | — | VECNUM6 | VECNUM5 | VECNUM4 | VECNUM3 | VECNUM2 | VECNUM1 | VECNUM0 | 0000 |

**Legend:** — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

**Note 1:** These bits are available in dsPIC33FJXXMC10X devices only.

**2:** These bits are available in dsPIC33FJ32(GP/MC)10X devices only.

**3:** These bits are available in dsPIC33FJ(16/32)MC102/104 devices only.

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**TABLE 4-7: TIMERS REGISTER MAP FOR dsPIC33FJ16(GP/MC)10X DEVICES**

| SFR Name | SFR Addr | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | All Resets |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| TMR1 | 0100 | Timer1 Register | | | | | | | | | | | | | | | | 0000 |
| PR1 | 0102 | Period Register 1 | | | | | | | | | | | | | | | | FFFF |
| T1CON | 0104 | TON | — | TSIDL | — | — | — | — | — | — | TGATE | TCKPS1 | TCKPS0 | — | TSYNC | TCS | — | 0000 |
| TMR2 | 0106 | Timer2 Register | | | | | | | | | | | | | | | | 0000 |
| TMR3HLD | 0108 | Timer3 Holding Register (for 32-bit timer operations only) | | | | | | | | | | | | | | | | xxxx |
| TMR3 | 010A | Timer3 Register | | | | | | | | | | | | | | | | 0000 |
| PR2 | 010C | Period Register 2 | | | | | | | | | | | | | | | | FFFF |
| PR3 | 010E | Period Register 3 | | | | | | | | | | | | | | | | FFFF |
| T2CON | 0110 | TON | — | TSIDL | — | — | — | — | — | — | TGATE | TCKPS1 | TCKPS0 | T32 | — | TCS | — | 0000 |
| T3CON | 0112 | TON | — | TSIDL | — | — | — | — | — | — | TGATE | TCKPS1 | TCKPS0 | — | — | TCS | — | 0000 |

**Legend:** — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

**TABLE 4-8: TIMERS REGISTER MAP FOR DSPIC33FJ32(GP/MC)10X DEVICES**

| SFR Name | SFR Addr | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | All Resets |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| TMR1 | 0100 | Timer1 Register | | | | | | | | | | | | | | | | 0000 |
| PR1 | 0102 | Period Register 1 | | | | | | | | | | | | | | | | FFFF |
| T1CON | 0104 | TON | — | TSIDL | — | — | — | — | — | — | TGATE | TCKPS1 | TCKPS0 | — | TSYNC | TCS | — | 0000 |
| TMR2 | 0106 | Timer2 Register | | | | | | | | | | | | | | | | 0000 |
| TMR3HLD | 0108 | Timer3 Holding Register (for 32-bit timer operations only) | | | | | | | | | | | | | | | | xxxx |
| TMR3 | 010A | Timer3 Register | | | | | | | | | | | | | | | | 0000 |
| PR2 | 010C | Period Register 2 | | | | | | | | | | | | | | | | FFFF |
| PR3 | 010E | Period Register 3 | | | | | | | | | | | | | | | | FFFF |
| T2CON | 0110 | TON | — | TSIDL | — | — | — | — | — | — | TGATE | TCKPS1 | TCKPS0 | T32 | — | TCS | — | 0000 |
| T3CON | 0112 | TON | — | TSIDL | — | — | — | — | — | — | TGATE | TCKPS1 | TCKPS0 | — | — | TCS | — | 0000 |
| TMR4 | 0114 | Timer4 Register | | | | | | | | | | | | | | | | 0000 |
| TMR5HLD | 0116 | Timer5 Holding Register (for 32-bit operations only) | | | | | | | | | | | | | | | | xxxx |
| TMR5 | 0118 | Timer5 Register | | | | | | | | | | | | | | | | 0000 |
| PR4 | 011A | Period Register 4 | | | | | | | | | | | | | | | | FFFF |
| PR5 | 011C | Period Register 5 | | | | | | | | | | | | | | | | FFFF |
| T4CON | 011E | TON | — | TSIDL | — | — | — | — | — | — | TGATE | TCKPS1 | TCKPS0 | T32 | — | TCS | — | 0000 |
| T5CON | 0120 | TON | — | TSIDL | — | — | — | — | — | — | TGATE | TCKPS1 | TCKPS0 | — | — | TCS | — | 0000 |

**Legend:** x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.



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**TABLE 4-9: INPUT CAPTURE REGISTER MAP**

| SFR Name | SFR Addr | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | All Resets |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| IC1BUF | 0140 | Input Capture 1 Register | | | | | | | | | | | | | | | | xxxx |
| IC1CON | 0142 | — | — | ICSIDL | — | — | — | — | — | ICTMR | ICI1 | ICI0 | ICOV | ICBNE | ICM2 | ICM1 | ICM0 | 0000 |
| IC2BUF | 0144 | Input Capture 2 Register | | | | | | | | | | | | | | | | xxxx |
| IC2CON | 0146 | — | — | ICSIDL | — | — | — | — | — | ICTMR | ICI1 | ICI0 | ICOV | ICBNE | ICM2 | ICM1 | ICM0 | 0000 |
| IC3BUF | 0148 | Input Capture 3 Register | | | | | | | | | | | | | | | | xxxx |
| IC3CON | 014A | — | — | ICSIDL | — | — | — | — | — | ICTMR | ICI1 | ICI0 | ICOV | ICBNE | ICM2 | ICM1 | ICM0 | 0000 |

**Legend:** x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

**TABLE 4-10: OUTPUT COMPARE REGISTER MAP**

| SFR Name | SFR Addr | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | All Resets |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| OC1RS | 0180 | Output Compare 1 Secondary Register | | | | | | | | | | | | | | | | xxxx |
| OC1R | 0182 | Output Compare 1 Register | | | | | | | | | | | | | | | | xxxx |
| OC1CON | 0184 | — | — | OCSIDL | — | — | — | — | — | — | — | — | OCFLT | OCTSEL | OCM2 | OCM1 | OCM0 | 0000 |
| OC2RS | 0186 | Output Compare 2 Secondary Register | | | | | | | | | | | | | | | | xxxx |
| OC2R | 0188 | Output Compare 2 Register | | | | | | | | | | | | | | | | xxxx |
| OC2CON | 018A | — | — | OCSIDL | — | — | — | — | — | — | — | — | OCFLT | OCTSEL | OCM2 | OCM1 | OCM0 | 0000 |

**Legend:** x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

**TABLE 4-11: 6-OUTPUT PWM1 REGISTER MAP FOR dsPIC33FJXXMC10X DEVICES**

| SFR Name | SFR Addr. | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Reset State |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| P1TCON | 01C0 | PTEN | — | PTSIDL | — | — | — | — | — | PTOPS3 | PTOPS2 | PTOPS1 | PTOPS0 | PTCKPS1 | PTCKPS0 | PTMOD1 | PTMOD0 | 0000 0000 0000 0000 |
| P1TMR | 01C2 | PTDIR | PWM1 Timer Count Value Register | | | | | | | | | | | | | | | 0000 0000 0000 0000 |
| P1TPER | 01C4 | — | PWM1 Time Base Period Register | | | | | | | | | | | | | | | 0111 1111 1111 1111 |
| P1SECMP | 01C6 | SEVTDIR | PWM1 Special Event Compare Register | | | | | | | | | | | | | | | 0000 0000 0000 0000 |
| PWM1CON1 | 01C8 | — | — | — | — | — | PMOD3 | PMOD2 | PMOD1 | — | PEN3H | PEN2H | PEN1H | — | PEN3L | PEN2L | PEN1L | 0000 0000 0000 0000 |
| PWM1CON2 | 01CA | — | — | — | — | SEVOPS3 | SEVOPS2 | SEVOPS1 | SEVOPS0 | — | — | — | — | — | IUE | OSYNC | UDIS | 0000 0000 0000 0000 |
| P1DTCON1 | 01CC | DTBPS1 | DTBPS0 | DTB5 | DTB4 | DTB3 | DTB2 | DTB1 | DTB0 | DTAPS1 | DTAPS0 | DTA5 | DTA4 | DTA3 | DTA2 | DTA1 | DTA0 | 0000 0000 0000 0000 |
| P1DTCON2 | 01CE | — | — | — | — | — | — | — | — | — | — | DTS3A | DTS3I | DTS2A | DTS2I | DTS1A | DTS1I | 0000 0000 0000 0000 |
| P1FLTACON | 01D0 | — | — | FAOV3H | FAOV3L | FAOV2H | FAOV2L | FAOV1H | FAOV1L | FLTAM | — | — | — | — | FAEN3 | FAEN2 | FAEN1 | 0000 0000 0000 0111 |
| P1FLTBCON | 01D2 | — | — | FBOV3H | FBOV3L | FBOV2H | FBOV2L | FBOV1H | FBOV1L | FLTBM | — | — | — | — | FBEN3 | FBEN2 | FBEN1 | 0000 0000 0000 0111 |
| P1OVDCON | 01D4 | — | — | POVD3H | POVD3L | POVD2H | POVD2L | POVD1H | POVD1L | — | — | POUT3H | POUT3L | POUT2H | POUT2L | POUT1H | POUT1L | 0011 1111 0000 0000 |
| P1DC1 | 01D6 | PWM1 Duty Cycle 1 Register | | | | | | | | | | | | | | | | 0000 0000 0000 0000 |
| P1DC2 | 01D8 | PWM1 Duty Cycle 2 Register | | | | | | | | | | | | | | | | 0000 0000 0000 0000 |
| P1DC3 | 01DA | PWM1 Duty Cycle 3 Register | | | | | | | | | | | | | | | | 0000 0000 0000 0000 |
| PWM1KEY | 01DE | PWMKEY<15:0> | | | | | | | | | | | | | | | | 0000 0000 0000 0000 |

**Legend:** — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

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**TABLE 4-12: I2C1 REGISTER MAP**

| SFR Name | SFR Addr | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | All Resets |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| I2C1RCV | 0200 | — | — | — | — | — | — | — | — | I2C1 Receive Register | | | | | | | | 0000 |
| I2C1TRN | 0202 | — | — | — | — | — | — | — | — | I2C1 Transmit Register | | | | | | | | 00FF |
| I2C1BRG | 0204 | — | — | — | — | — | — | — | Baud Rate Generator Register | | | | | | | | | 0000 |
| I2C1CON | 0206 | I2CEN | — | I2CSIDL | SCLREL | IPMIEN | A10M | DISSLW | SMEN | GCEN | STREN | ACKDT | ACKEN | RCEN | PEN | RSEN | SEN | 1000 |
| I2C1STAT | 0208 | ACKSTAT | TRSTAT | — | — | — | BCL | GCSTAT | ADD10 | IWCOL | I2COV | D_A | P | S | R_W | RBF | TBF | 0000 |
| I2C1ADD | 020A | — | — | — | — | — | — | I2C1 Address Register | | | | | | | | | | 0000 |
| I2C1MSK | 020C | — | — | — | — | — | — | I2C1 Address Mask Register | | | | | | | | | | 0000 |

**Legend:** — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

**TABLE 4-13: UART1 REGISTER MAP**

| SFR Name | SFR Addr | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | All Resets |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| U1MODE | 0220 | UARTEN | — | USIDL | IREN | RTSMD | — | UEN1 | UEN0 | WAKE | LPBACK | ABAUD | URXINV | BRGH | PDSEL1 | PDSEL0 | STSEL | 0000 |
| U1STA | 0222 | UTXISEL1 | UTXINV | UTXISEL0 | — | UTXBRK | UTXEN | UTXBF | TRMT | URXISEL1 | URXISEL0 | ADDEN | RIDLE | PERR | FERR | OERR | URXDA | 0110 |
| U1TXREG | 0224 | — | — | — | — | — | — | — | UART1 Transmit Register | | | | | | | | | xxxx |
| U1RXREG | 0226 | — | — | — | — | — | — | — | UART1 Receive Register | | | | | | | | | 0000 |
| U1BRG | 0228 | Baud Rate Generator Prescaler | | | | | | | | | | | | | | | | 0000 |

**Legend:** x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

**TABLE 4-14: SPI1 REGISTER MAP**

| SFR Name | SFR Addr | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | All Resets |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| SPI1STAT | 0240 | SPIEN | — | SPISIDL | — | — | — | — | — | — | SPIROV | — | — | — | — | SPITBF | SPIRBF | 0000 |
| SPI1CON1 | 0242 | — | — | — | DISSCK | DISSDO | MODE16 | SMP | CKE | SSEN | CKP | MSTEN | SPRE2 | SPRE1 | SPRE0 | PPRE1 | PPRE0 | 0000 |
| SPI1CON2 | 0244 | FRMEN | SPIFSD | FRMPOL | — | — | — | — | — | — | — | — | — | — | — | FRMDLY | — | 0000 |
| SPI1BUF | 0248 | SPI1 Transmit and Receive Buffer Register | | | | | | | | | | | | | | | | 0000 |

**Legend:** — = unimplemented, read as '0'. Reset values are shown in hexadecimal.



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**TABLE 4-15: ADC1 REGISTER MAP FOR dsPIC33FJXX(GP/MC)101 DEVICES**

| File Name | SFR Addr | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | All Resets |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| ADC1BUF0 | 0300 | ADC1 Data Buffer 0 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUF1 | 0302 | ADC1 Data Buffer 1 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUF2 | 0304 | ADC1 Data Buffer 2 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUF3 | 0306 | ADC1 Data Buffer 3 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUF4 | 0308 | ADC1 Data Buffer 4 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUF5 | 030A | ADC1 Data Buffer 5 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUF6 | 030C | ADC1 Data Buffer 6 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUF7 | 030E | ADC1 Data Buffer 7 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUF8 | 0310 | ADC1 Data Buffer 8 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUF9 | 0312 | ADC1 Data Buffer 9 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUFA | 0314 | ADC1 Data Buffer 10 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUFB | 0316 | ADC1 Data Buffer 11 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUFC | 0318 | ADC1 Data Buffer 12 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUFD | 031A | ADC1 Data Buffer 13 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUFE | 031C | ADC1 Data Buffer 14 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUFF | 031E | ADC1 Data Buffer 15 | | | | | | | | | | | | | | | | xxxx |
| AD1CON1 | 0320 | ADON | — | ADSIDL | — | — | — | FORM1 | FORM0 | SSRC2 | SSRC1 | SSRC0 | — | SIMSAM | ASAM | SAMP | DONE | 0000 |
| AD1CON2 | 0322 | VCFG2 | VCFG1 | VCFG0 | — | — | CSCNA | CHPS1 | CHPS0 | BUFS | — | SMPI3 | SMPI2 | SMPI1 | SMPI0 | BUFM | ALTS | 0000 |
| AD1CON3 | 0324 | ADRC | — | — | SAMC4 | SAMC3 | SAMC2 | SAMC1 | SAMC0 | ADCS7 | ADCS6 | ADCS5 | ADCS4 | ADCS3 | ADCS2 | ADCS1 | ADCS0 | 0000 |
| AD1CHS123 | 0326 | — | — | — | — | — | CH123NB1 | CH123NB0 | CH123SB | — | — | — | — | — | CH123NA1 | CH123NA0 | CH123SA | 0000 |
| AD1CHS0 | 0328 | CH0NB | — | — | CH0SB4 | CH0SB3 | CH0SB2 | CH0SB1 | CH0SB0 | CH0NA | — | — | CH0SA4 | CH0SA3 | CH0SA2 | CH0SA1 | CH0SA0 | 0000 |
| AD1PCFGL | 032C | — | — | — | — | — | PCFG<10:9>(1) | | — | — | — | — | — | PCFG<3:0> | | | | 0000 |
| AD1CSSL | 0330 | — | — | — | — | — | CSS<10:9>(1) | | — | — | — | — | — | CSS<3:0> | | | | 0000 |

**Legend:** x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

**Note 1:** The PCFG<10:9> and CSS<10:9> bits are available in dsPIC33FJ32(GP/MC)101/102 devices only.

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**TABLE 4-16: ADC1 REGISTER MAP FOR dsPIC33FJXX(GP/MC)102 DEVICES**

| File Name | SFR Addr | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | All Resets |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| ADC1BUF0 | 0300 | ADC1 Data Buffer 0 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUF1 | 0302 | ADC1 Data Buffer 1 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUF2 | 0304 | ADC1 Data Buffer 2 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUF3 | 0306 | ADC1 Data Buffer 3 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUF4 | 0308 | ADC1 Data Buffer 4 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUF5 | 030A | ADC1 Data Buffer 5 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUF6 | 030C | ADC1 Data Buffer 6 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUF7 | 030E | ADC1 Data Buffer 7 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUF8 | 0310 | ADC1 Data Buffer 8 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUF9 | 0312 | ADC1 Data Buffer 9 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUFA | 0314 | ADC1 Data Buffer 10 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUFB | 0316 | ADC1 Data Buffer 11 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUFC | 0318 | ADC1 Data Buffer 12 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUFD | 031A | ADC1 Data Buffer 13 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUFE | 031C | ADC1 Data Buffer 14 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUFF | 031E | ADC1 Data Buffer 15 | | | | | | | | | | | | | | | | xxxx |
| AD1CON1 | 0320 | ADON | — | ADSIDL | — | — | — | FORM1 | FORM0 | SSRC2 | SSRC1 | SSRC0 | — | SIMSAM | ASAM | SAMP | DONE | 0000 |
| AD1CON2 | 0322 | VCFG2 | VCFG1 | VCFG0 | — | — | CSCNA | CHPS1 | CHPS0 | BUFS | — | SMPI3 | SMPI2 | SMPI1 | SMPI0 | BUFM | ALTS | 0000 |
| AD1CON3 | 0324 | ADRC | — | — | SAMC4 | SAMC3 | SAMC2 | SAMC1 | SAMC0 | ADCS7 | ADCS6 | ADCS5 | ADCS4 | ADCS3 | ADCS2 | ADCS1 | ADCS0 | 0000 |
| AD1CHS123 | 0326 | — | — | — | — | — | CH123NB1 | CH123NB0 | CH123SB | — | — | — | — | — | CH123NA1 | CH123NA0 | CH123SA | 0000 |
| AD1CHS0 | 0328 | CH0NB | — | — | CH0SB4 | CH0SB3 | CH0SB2 | CH0SB1 | CH0SB0 | CH0NA | — | — | CH0SA4 | CH0SA3 | CH0SA2 | CH0SA1 | CH0SA0 | 0000 |
| AD1PCFGL | 032C | — | — | — | — | — | PCFG<10:9>(1) | | — | — | — | PCFG<5:0> | | | | | | 0000 |
| AD1CSSL | 0330 | — | — | — | — | — | CSS<10:9>(1) | | — | — | — | CSS<5:0> | | | | | | 0000 |

**Legend:** x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

**Note 1:** The PCFG<10:9> and CSS<10:9> bits are available in dsPIC33FJ32(GP/MC)101/102 devices only.



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**TABLE 4-17: ADC1 REGISTER MAP FOR dsPIC33FJ32(GP/MC)104 DEVICES**

| File Name | SFR Addr | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | All Resets |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| ADC1BUF0 | 0300 | ADC1 Data Buffer 0 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUF1 | 0302 | ADC1 Data Buffer 1 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUF2 | 0304 | ADC1 Data Buffer 2 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUF3 | 0306 | ADC1 Data Buffer 3 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUF4 | 0308 | ADC1 Data Buffer 4 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUF5 | 030A | ADC1 Data Buffer 5 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUF6 | 030C | ADC1 Data Buffer 6 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUF7 | 030E | ADC1 Data Buffer 7 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUF8 | 0310 | ADC1 Data Buffer 8 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUF9 | 0312 | ADC1 Data Buffer 9 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUFA | 0314 | ADC1 Data Buffer 10 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUFB | 0316 | ADC1 Data Buffer 11 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUFC | 0318 | ADC1 Data Buffer 12 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUFD | 031A | ADC1 Data Buffer 13 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUFE | 031C | ADC1 Data Buffer 14 | | | | | | | | | | | | | | | | xxxx |
| ADC1BUFF | 031E | ADC1 Data Buffer 15 | | | | | | | | | | | | | | | | xxxx |
| AD1CON1 | 0320 | ADON | — | ADSIDL | — | — | — | FORM1 | FORM0 | SSRC2 | SSRC1 | SSRC0 | — | SIMSAM | ASAM | SAMP | DONE | 0000 |
| AD1CON2 | 0322 | VCFG2 | VCFG1 | VCFG0 | — | — | CSCNA | CHPS1 | CHPS0 | BUFS | — | SMPI3 | SMPI2 | SMPI1 | SMPI0 | BUFM | ALTS | 0000 |
| AD1CON3 | 0324 | ADRC | — | — | SAMC4 | SAMC3 | SAMC2 | SAMC1 | SAMC0 | ADCS7 | ADCS6 | ADCS5 | ADCS4 | ADCS3 | ADCS2 | ADCS1 | ADCS0 | 0000 |
| AD1CHS123 | 0326 | — | — | — | — | — | CH123NB1 | CH123NB0 | CH123SB | — | — | — | — | — | CH123NA1 | CH123NA0 | CH123SA | 0000 |
| AD1CHS0 | 0328 | CH0NB | — | — | CH0SB4 | CH0SB3 | CH0SB2 | CH0SB1 | CH0SB0 | CH0NA | — | — | CH0SA4 | CH0SA3 | CH0SA2 | CH0SA1 | CH0SA0 | 0000 |
| AD1PCFGL | 032C | PCFG15 | — | — | PCFG<12:0>[1] | | | | | | | | | | | | | 0000 |
| AD1CSSL | 0330 | CSS15 | — | — | CSS12:0>[1] | | | | | | | | | | | | | 0000 |

**Legend:** x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

**Note 1:** The PCFG<10:9> and CSS<10:9> bits are available in dsPIC33FJ32(GP/MC)104 devices only.

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**TABLE 4-18: CTMU REGISTER MAP**

| File Name | SFR Addr | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | All Resets |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| CTMUCON1 | 033A | CTMUEN | — | CTMUSIDL | TGEN | EDGEN | EDGSEQEN | IDISSEN | CTTRIG | — | — | — | — | — | — | — | — | 0000 |
| CTMUCON2 | 033C | EDG1MOD | EDG1POL | EDG1SEL3 | EDG1SEL2 | EDG1SEL1 | EDG1SEL0 | EDG2STAT | EDG1STAT | EDG2MOD | EDG2POL | EDG2SEL3 | EDG2SEL2 | EDG2SEL1 | EDG2SEL0 | — | — | 0000 |
| CTMUICON | 033E | ITRIM5 | ITRIM4 | ITRIM3 | ITRIM2 | ITRIM1 | ITRIM0 | IRNG1 | IRNG0 | — | — | — | — | — | — | — | — | 0000 |

**Legend:** — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

**TABLE 4-19: REAL-TIME CLOCK AND CALENDAR REGISTER MAP**

| File Name | SFR Addr | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | All Resets |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| ALRMVAL | 0620 | Alarm Value Register Window based on ALRMPTR<1:0> | | | | | | | | | | | | | | | | xxxx |
| ALCFGRPT | 0622 | ALRMEN | CHIME | AMASK3 | AMASK2 | AMASK1 | AMASK0 | ALRMPTR1 | ALRMPTR0 | ARPT7 | ARPT6 | ARPT5 | ARPT4 | ARPT3 | ARPT2 | ARPT1 | ARPT0 | 0000 |
| RTCVAL | 0624 | RTCC Value Register Window based on RTCPTR<1:0> | | | | | | | | | | | | | | | | xxxx |
| RCFGCAL | 0626 | RTCEN | — | RTCWREN | RTCSYNC | HALFSEC | RTCOE | RTCPTR1 | RTCPTR0 | CAL7 | CAL6 | CAL5 | CAL4 | CAL3 | CAL2 | CAL1 | CAL0 | 0000 |

**Legend:** x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

**TABLE 4-20: PAD CONFIGURATION REGISTER MAP**

| File Name | SFR Addr | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | All Resets |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| PADCFG1 | 02FC | — | — | — | — | — | — | — | — | — | — | — | — | — | — | RTSECSEL | — | 0000 |

**Legend:** — = unimplemented, read as '0'. Reset values are shown in hexadecimal.



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**TABLE 4-21: COMPARATOR REGISTER MAP**

| File Name | SFR Addr | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | All Resets |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| CMSTAT | 0650 | CMSIDL | — | — | — | — | C3EVT | C2EVT | C1EVT | — | — | — | — | — | C3OUT | C2OUT | C1OUT | 0000 |
| CVRCON | 0652 | — | — | — | — | — | VREFSEL | BGSEL1 | BGSEL0 | CVREN | CVROE | CVRR | — | CVR3 | CVR2 | CVR1 | CVR0 | 0000 |
| CM1CON | 0654 | CON | COE | CPOL | — | — | — | CEVT | COUT | EVPOL1 | EVPOL0 | — | CREF | — | — | CCH1 | CCH0 | 0000 |
| CM1MSKSRC | 0656 | — | — | — | — | SELSRCC3 | SELSRCC2 | SELSRCC1 | SELSRCC0 | SELSRCB3 | SELSRCB2 | SELSRCB1 | SELSRCB0 | SELSRCA3 | SELSRCA2 | SELSRCA1 | SELSRCA0 | 0000 |
| CM1MSKCON | 0658 | HLMS | — | OCEN | OCNEN | OBEN | OBNEN | OAEN | OANEN | NAGS | PAGS | ACEN | ACNEN | ABEN | ABNEN | AAEN | AANEN | 0000 |
| CM1FLTR | 065A | — | — | — | — | — | — | — | — | — | CFSEL2 | CFSEL1 | CFSEL0 | CFLTREN | CFDIV2 | CFDIV1 | CFDIV0 | 0000 |
| CM2CON | 065C | CON | COE | CPOL | — | — | — | CEVT | COUT | EVPOL1 | EVPOL0 | — | CREF | — | — | CCH1 | CCH0 | 0000 |
| CM2MSKSRC | 065E | — | — | — | — | SELSRCC3 | SELSRCC2 | SELSRCC1 | SELSRCC0 | SELSRCB3 | SELSRCB2 | SELSRCB1 | SELSRCB0 | SELSRCA3 | SELSRCA2 | SELSRCA1 | SELSRCA0 | 0000 |
| CM2MSKCON | 0660 | HLMS | — | OCEN | OCNEN | OBEN | OBNEN | OAEN | OANEN | NAGS | PAGS | ACEN | ACNEN | ABEN | ABNEN | AAEN | AANEN | 0000 |
| CM2FLTR | 0662 | — | — | — | — | — | — | — | — | — | CFSEL2 | CFSEL1 | CFSEL0 | CFLTREN | CFDIV2 | CFDIV1 | CFDIV0 | 0000 |
| CM3CON | 0664 | CON | COE | CPOL | — | — | — | CEVT | COUT | EVPOL1 | EVPOL0 | — | CREF | — | — | CCH1 | CCH0 | 0000 |
| CM3MSKSRC | 0666 | — | — | — | — | SELSRCC3 | SELSRCC2 | SELSRCC1 | SELSRCC0 | SELSRCB3 | SELSRCB2 | SELSRCB1 | SELSRCB0 | SELSRCA3 | SELSRCA2 | SELSRCA1 | SELSRCA0 | 0000 |
| CM3MSKCON | 0668 | HLMS | — | OCEN | OCNEN | OBEN | OBNEN | OAEN | OANEN | NAGS | PAGS | ACEN | ACNEN | ABEN | ABNEN | AAEN | AANEN | 0000 |
| CM3FLTR | 066A | — | — | — | — | — | — | — | — | — | CFSEL2 | CFSEL1 | CFSEL0 | CFLTREN | CFDIV2 | CFDIV1 | CFDIV0 | 0000 |

**Legend:** — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

**TABLE 4-22: PERIPHERAL PIN SELECT INPUT REGISTER MAP**

| File Name | SFR Addr | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | All Resets |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| RPINR0 | 0680 | — | — | — | INT1R<4:0> | | | | | — | — | — | — | — | — | — | — | 1F00 |
| RPINR1 | 0682 | — | — | — | — | — | — | — | — | — | — | — | INT2R<4:0> | | | | | 001F |
| RPINR3 | 0686 | — | — | — | T3CKR<4:0> | | | | | — | — | — | T2CKR<4:0> | | | | | 1F1F |
| RPINR4 | 0688 | — | — | — | T5CKR<4:0>(1) | | | | | — | — | — | T4CKR<4:0>(1) | | | | | 1F1F |
| RPINR7 | 068E | — | — | — | IC2R<4:0> | | | | | — | — | — | IC1R<4:0> | | | | | 1F1F |
| RPINR8 | 0690 | — | — | — | — | — | — | — | — | — | — | — | IC3R<4:0> | | | | | 001F |
| RPINR11 | 0696 | — | — | — | — | — | — | — | — | — | — | — | OCFAR<4:0> | | | | | 001F |
| RPINR18 | 06A4 | — | — | — | U1CTSR<4:0> | | | | | — | — | — | U1RXR<4:0> | | | | | 1F1F |
| RPINR20 | 06A8 | — | — | — | SCK1R<4:0>(1) | | | | | — | — | — | SDI1R<4:0>(1) | | | | | 1F1F |
| RPINR21 | 06AA | — | — | — | — | — | — | — | — | — | — | — | SS1R<4:0> | | | | | 001F |

**Legend:** x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

**Note 1:** These bits are available in dsPIC33FJ32(GP/MC)10X devices only.

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**TABLE 4-23: PERIPHERAL PIN SELECT OUTPUT REGISTER MAP FOR dsPIC33FJXXGP101 DEVICES**

| File Name | SFR Addr | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | All Resets |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| RPOR0 | 06C0 | — | — | — | RP1R<4:0> | | | | | — | — | — | RP0R<4:0> | | | | | 0000 |
| RPOR2 | 06C4 | — | — | — | — | — | — | — | — | — | — | — | RP4R<4:0> | | | | | 0000 |
| RPOR3 | 06C6 | — | — | — | RP7R<4:0> | | | | | — | — | — | — | — | — | — | — | 0000 |
| RPOR4 | 06C8 | — | — | — | RP9R<4:0> | | | | | — | — | — | RP8R<4:0> | | | | | 0000 |
| RPOR7 | 06CE | — | — | — | RP15R<4:0> | | | | | — | — | — | RP14R<4:0> | | | | | 0000 |

**Legend:** — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

**TABLE 4-24: PERIPHERAL PIN SELECT OUTPUT REGISTER MAP FOR dsPIC33FJXXMC101 DEVICES**

| File Name | SFR Addr | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | All Resets |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| RPOR0 | 06C0 | — | — | — | RP1R<4:0> | | | | | — | — | — | RP0R<4:0> | | | | | 0000 |
| RPOR2 | 06C4 | — | — | — | — | — | — | — | — | — | — | — | RP4R<4:0> | | | | | 0000 |
| RPOR3 | 06C6 | — | — | — | RP7R<4:0> | | | | | — | — | — | — | — | — | — | — | 0000 |
| RPOR4 | 06C8 | — | — | — | RP9R<4:0> | | | | | — | — | — | RP8R<4:0> | | | | | 0000 |
| RPOR6 | 06CC | — | — | — | RP13R<4:0> | | | | | — | — | — | RP12R<4:0> | | | | | 0000 |
| RPOR7 | 06CE | — | — | — | RP15R<4:0> | | | | | — | — | — | RP14R<4:0> | | | | | 0000 |

**Legend:** — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

**TABLE 4-25: PERIPHERAL PIN SELECT OUTPUT REGISTER MAP FOR dsPIC33FJXX(GP/MC)102 DEVICES**

| File Name | SFR Addr | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | All Resets |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| RPOR0 | 06C0 | — | — | — | RP1R<4:0> | | | | | — | — | — | RP0R<4:0> | | | | | 0000 |
| RPOR1 | 06C2 | — | — | — | RP3R<4:0> | | | | | — | — | — | RP2R<4:0> | | | | | 0000 |
| RPOR2 | 06C4 | — | — | — | RP5R<4:0> | | | | | — | — | — | RP4R<4:0> | | | | | 0000 |
| RPOR3 | 06C6 | — | — | — | RP7R<4:0> | | | | | — | — | — | RP6R<4:0> | | | | | 0000 |
| RPOR4 | 06C8 | — | — | — | RP9R<4:0> | | | | | — | — | — | RP8R<4:0> | | | | | 0000 |
| RPOR5 | 06CA | — | — | — | RP11R<4:0> | | | | | — | — | — | RP10R<4:0> | | | | | 0000 |
| RPOR6 | 06CC | — | — | — | RP13R<4:0> | | | | | — | — | — | RP12R<4:0> | | | | | 0000 |
| RPOR7 | 06CE | — | — | — | RP15R<4:0> | | | | | — | — | — | RP14R<4:0> | | | | | 0000 |

**Legend:** — = unimplemented, read as '0'. Reset values are shown in hexadecimal.



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**TABLE 4-26: PERIPHERAL PIN SELECT OUTPUT REGISTER MAP FOR dsPIC33FJ32(GP/MC)104 DEVICES**

| File Name | SFR Addr | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | All Resets |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| RPOR0 | 06C0 | — | — | — | RP1R<4:0> | | | | | — | — | — | RP0R<4:0> | | | | | 0000 |
| RPOR1 | 06C2 | — | — | — | RP3R<4:0> | | | | | — | — | — | RP2R<4:0> | | | | | 0000 |
| RPOR2 | 06C4 | — | — | — | RP5R<4:0> | | | | | — | — | — | RP4R<4:0> | | | | | 0000 |
| RPOR3 | 06C6 | — | — | — | RP7R<4:0> | | | | | — | — | — | RP6R<4:0> | | | | | 0000 |
| RPOR4 | 06C8 | — | — | — | RP9R<4:0> | | | | | — | — | — | RP8R<4:0> | | | | | 0000 |
| RPOR5 | 06CA | — | — | — | RP11R<4:0> | | | | | — | — | — | RP10R<4:0> | | | | | 0000 |
| RPOR6 | 06CC | — | — | — | RP13R<4:0> | | | | | — | — | — | RP12R<4:0> | | | | | 0000 |
| RPOR7 | 06CE | — | — | — | RP15R<4:0> | | | | | — | — | — | RP14R<4:0> | | | | | 0000 |
| RPOR8 | 06D0 | — | — | — | RP17R<4:0> | | | | | — | — | — | RP16R<4:0> | | | | | 0000 |
| RPOR9 | 06D2 | — | — | — | RP19R<4:0> | | | | | — | — | — | RP18R<4:0> | | | | | 0000 |
| RPOR10 | 06D4 | — | — | — | RP21R<4:0> | | | | | — | — | — | RP20R<4:0> | | | | | 0000 |
| RPOR11 | 06D6 | — | — | — | RP23R<4:0> | | | | | — | — | — | RP22R<4:0> | | | | | 0000 |
| RPOR12 | 06D8 | — | — | — | RP25R<4:0> | | | | | — | — | — | RP24R<4:0> | | | | | 0000 |

**Legend:** — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

**TABLE 4-27: PORTA REGISTER MAP FOR dsPIC33FJ16(GP/MC)101/102 DEVICES**

| File Name | SFR Addr | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | All Resets |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| TRISA | 02C0 | — | — | — | — | — | — | — | — | — | — | — | TRISA<4:0> | | | | | 001F |
| PORTA | 02C2 | — | — | — | — | — | — | — | — | — | — | — | RA<4:0 | | | | | xxxx |
| LATA | 02C4 | — | — | — | — | — | — | — | — | — | — | — | LATA<4:0 | | | | | xxxx |
| ODCA | 02C6 | — | — | — | — | — | — | — | — | — | — | — | ODCA<4:2> | | | — | — | 0000 |

**Legend:** x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

**TABLE 4-28: PORTA REGISTER MAP FOR dsPIC33FJ32(GP/MC)101/102 DEVICES**

| File Name | SFR Addr | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | All Resets |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| TRISA | 02C0 | — | — | — | — | — | — | — | — | — | — | — | TRISA<4:0> | | | | | 001F |
| PORTA | 02C2 | — | — | — | — | — | — | — | — | — | — | — | RA<4:0 | | | | | xxxx |
| LATA | 02C4 | — | — | — | — | — | — | — | — | — | — | — | LATA<4:0 | | | | | xxxx |
| ODCA | 02C6 | — | — | — | — | — | — | — | — | — | — | — | — | ODCA<3:2> | | — | — | 0000 |

**Legend:** x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

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**TABLE 4-29: PORTA REGISTER MAP FOR dsPIC33FJ32(GP/MC)104 DEVICES**

| File Name | SFR Addr | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | All Resets |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| TRISA | 02C0 | — | — | — | — | — | TRISA<10:7> | | | | — | — | TRISA<4:0> | | | | | 001F |
| PORTA | 02C2 | — | — | — | — | — | RA<10:7> | | | | — | — | RA<4:0> | | | | | xxxx |
| LATA | 02C4 | — | — | — | — | — | LATA<10:7> | | | | — | — | LATA<4:0> | | | | | xxxx |
| ODCA | 02C6 | — | — | — | — | — | ODCA<10:7> | | | | — | — | — | ODCA<3:2> | | — | — | 0000 |

**Legend:** x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

**TABLE 4-30: PORTB REGISTER MAP FOR dsPIC33FJ16GP101 DEVICES**

| File Name | SFR Addr | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | All Resets |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| TRISB | 02C8 | TRISB<15:14> | | — | — | — | — | TRISB<9:7> | | | — | — | TRISB4 | — | — | TRISB<1:0> | | C393 |
| PORTB | 02CA | RB<15:14> | | — | — | — | — | RB<9:7> | | | — | — | RB4 | — | — | RB<1:0> | | xxxx |
| LATB | 02CC | LATB<15:14> | | — | — | — | — | LATB<9:7> | | | — | — | LATB4 | — | — | LATB<1:0> | | xxxx |
| ODCB | 02CE | ODCB<15:14> | | — | — | — | — | ODCB<9:7> | | | — | — | ODCB4 | — | — | — | — | 0000 |

**Legend:** x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

**TABLE 4-31: PORTB REGISTER MAP FOR dsPIC33FJ16MC101 DEVICES**

| File Name | SFR Addr | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | All Resets |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| TRISB | 02C8 | TRISB<15:12> | | | | — | — | TRISB<9:7> | | | — | — | TRISB4 | — | — | TRISB<1:0> | | F393 |
| PORTB | 02CA | RB<15:12> | | | | — | — | RB<9:7> | | | — | — | RB4 | — | — | RB<1:0> | | xxxx |
| LATB | 02CC | LATB<15:12> | | | | — | — | LATB<9:7> | | | — | — | LATB4 | — | — | LATB<1:0> | | xxxx |
| ODCB | 02CE | ODCB<15:12> | | | | — | — | ODCB<9:7> | | | — | — | ODCB4 | — | — | — | — | 0000 |

**Legend:** x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

**TABLE 4-32: PORTB REGISTER MAP FOR dsPIC33FJ16(GP/MC)102 DEVICES**

| File Name | SFR Addr | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | All Resets |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| TRISB | 02C8 | TRISB<15:0> | | | | | | | | | | | | | | | | FFFF |
| PORTB | 02CA | RB<15:0> | | | | | | | | | | | | | | | | xxxx |
| LATB | 02CC | LATB<15:0> | | | | | | | | | | | | | | | | xxxx |
| ODCB | 02CE | ODCB<15:4> | | | | | | | | | | | | — | — | — | — | 0000 |

**Legend:** x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.



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**TABLE 4-33: PORTB REGISTER MAP FOR dsPIC33FJ32GP101 DEVICES**

| File Name | SFR Addr | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | All Resets |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| TRISB | 02C8 | TRISB<15:14> | | — | — | — | — | TRISB<9:7> | | | — | — | TRISB4 | — | — | TRISB<1:0> | | C393 |
| PORTB | 02CA | RB<15:14> | | — | — | — | — | RB<9:7> | | | — | — | RB4 | — | — | RB<1:0> | | xxxx |
| LATB | 02CC | LATB<15:14> | | — | — | — | — | LATB<9:7> | | | — | — | LATB4 | — | — | LATB<1:0> | | xxxx |
| ODCB | 02CE | ODCB<15:14> | | — | — | — | — | ODCB<9:7> | | | — | — | — | — | — | — | — | 0000 |

**Legend:** x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

**TABLE 4-34: PORTB REGISTER MAP FOR dsPIC33FJ32MC101 DEVICES**

| File Name | SFR Addr | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | All Resets |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| TRISB | 02C8 | TRISB<15:12> | | | | — | — | TRISB<9:7> | | | — | — | TRISB4 | — | — | TRISB<1:0> | | F393 |
| PORTB | 02CA | RB<15:12> | | | | — | — | RB<9:7> | | | — | — | RB4 | — | — | RB<1:0> | | xxxx |
| LATB | 02CC | LATB<15:12> | | | | — | — | LATB<9:7> | | | — | — | LATB4 | — | — | LATB<1:0> | | xxxx |
| ODCB | 02CE | ODCB<15:12> | | | | — | — | ODCB<9:7> | | | — | — | — | — | — | — | — | 0000 |

**Legend:** x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

**TABLE 4-35: PORTB REGISTER MAP FOR dsPIC33FJ32(GP/MC)102 AND dsPIC33FJ32(GP/MC)104 DEVICES**

| File Name | SFR Addr | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | All Resets |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| TRISB | 02C8 | TRISB<15:0> | | | | | | | | | | | | | | | | FFFF |
| PORTB | 02CA | RB<15:0> | | | | | | | | | | | | | | | | xxxx |
| LATB | 02CC | LATB<15:0> | | | | | | | | | | | | | | | | xxxx |
| ODCB | 02CE | ODCB<15:5> | | | | | | | | | | | — | — | — | — | — | 0000 |

**Legend:** x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

**TABLE 4-36: PORTC REGISTER MAP FOR dsPIC33FJ32(GP/MC)104 DEVICES**

| File Name | SFR Addr | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | All Resets |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| TRISC | 02D0 | — | — | — | — | — | — | TRISC<9:0> | | | | | | | | | | FFFF |
| PORTC | 02D2 | — | — | — | — | — | — | RC<9:0> | | | | | | | | | | xxxx |
| LATC | 02D4 | — | — | — | — | — | — | LATC<9:0> | | | | | | | | | | xxxx |
| ODCC | 02D6 | — | — | — | — | — | — | ODCC<9:6> | | | | — | — | — | — | — | — | 0000 |

**Legend:** x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

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**TABLE 4-37: SYSTEM CONTROL REGISTER MAP**

| File Name | SFR Addr | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | All Resets |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| RCON | 0740 | TRAPR | IOPUWR | — | — | — | — | CM | VREGS | EXTR | SWR | SWDTEN | WDTO | SLEEP | IDLE | BOR | POR | xxxx(1) |
| OSCCON | 0742 | — | COSC2 | COSC1 | COSC0 | — | NOSC2 | NOSC1 | NOSC0 | CLKLOCK | IOLOCK | LOCK | — | CF | — | LPOSCEN | OSWEN | 0300(2) |
| CLKDIV | 0744 | ROI | DOZE2 | DOZE1 | DOZE0 | DOZEN | FRCDIV2 | FRCDIV1 | FRCDIV0 | — | — | — | — | — | — | — | — | 3040 |
| OSCTUN | 0748 | — | — | — | — | — | — | — | — | — | — | TUN<5:0> | | | | | | 0000 |

**Legend:** x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.
**Note 1:** RCON register Reset values are dependent on the type of Reset.
**2:** OSCCON register Reset values are dependent on the FOSC Configuration bits and by type of Reset.

**TABLE 4-38: NVM REGISTER MAP**

| File Name | SFR Addr | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | All Resets |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| NVMCON | 0760 | WR | WREN | WRERR | — | — | — | — | — | — | ERASE | — | — | NVMOP3 | NVMOP2 | NVMOP1 | NVMOP0 | 0000(1) |
| NVMKEY | 0766 | — | — | — | — | — | — | — | — | NVMKEY<7:0> | | | | | | | | 0000 |

**Legend:** — = unimplemented, read as '0'. Reset values are shown in hexadecimal.
**Note 1:** Reset value shown is for POR only. Value on other Reset states is dependent on the state of memory write or erase operations at the time of Reset.

**TABLE 4-39: PMD REGISTER MAP**

| File Name | SFR Addr | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | All Resets |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| PMD1 | 0770 | T5MD(2) | T4MD(2) | T3MD | T2MD | T1MD | — | PWM1MD(1) | — | I2C1MD | — | U1MD | — | SPI1MD | — | — | AD1MD | 0000 |
| PMD2 | 0772 | — | — | — | — | — | IC3MD | IC2MD | IC1MD | — | — | — | — | — | — | OC2MD | OC1MD | 0000 |
| PMD3 | 0774 | — | — | — | — | — | CMPMD | RTCCMD | — | — | — | — | — | — | — | — | — | 0000 |
| PMD4 | 0776 | — | — | — | — | — | — | — | — | — | — | — | — | — | CTMUMD | — | — | 0000 |

**Legend:** — = unimplemented, read as '0'. Reset values are shown in hexadecimal.
**Note 1:** This bit is available in dsPIC33FJXXMC10X devices only.
**2:** These bits are available in dsPIC33FJ32(GP/MC)10X devices only.


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### 4.2.6 SOFTWARE STACK

In addition to its use as a working register, the W15 register in the dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 devices is also used as a Software Stack Pointer. The Stack Pointer always points to the first available free word and grows from lower to higher addresses. It pre-decrements for stack pops and post-increments for stack pushes, as shown in Figure 4-6. For a PC push during any CALL instruction, the MSb of the PC is zero-extended before the push, ensuring that the MSb is always clear.

| | |
|---|---|
| **Note:** | A PC push during exception processing concatenates the SRL register to the MSb of the PC prior to the push. |

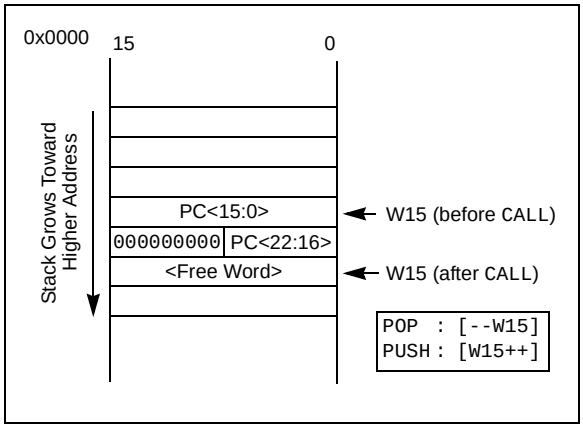
The Stack Pointer Limit register (SPLIM) associated with the Stack Pointer sets an upper address boundary for the stack. SPLIM is uninitialized at Reset. As is the case for the Stack Pointer, SPLIM<0> is forced to '0' because all stack operations must be word-aligned.

Whenever an EA is generated using W15 as a source or destination pointer, the resulting address is compared with the value in SPLIM. If the contents of the Stack Pointer (W15) and the SPLIM register are equal and a push operation is performed, a stack error trap will not occur. However, the stack error trap will occur on a subsequent push operation. For example, to cause a stack error trap when the stack grows beyond address 0x0C00 in RAM, initialize the SPLIM with the value 0x0BFE.

Similarly, a Stack Pointer underflow (stack error) trap is generated when the Stack Pointer address is found to be less than 0x0800. This prevents the stack from interfering with the SFR space.

A write to the SPLIM register should not be immediately followed by an indirect read operation using W15.

**FIGURE 4-6: CALL STACK FRAME**




### 4.2.7 DATA RAM PROTECTION FEATURE

The dsPIC33F product family supports data RAM protection features that enable segments of RAM to be protected when used in conjunction with Boot and Secure Code Segment Security. BSRAM (Secure RAM Segment for BS) is accessible only from the Boot Segment Flash code when enabled. SSRAM (Secure RAM Segment for RAM) is accessible only from the Secure Segment Flash code when enabled. See Table 4-1 for an overview of the BSRAM and SSRAM SFRs.

## 4.3 Instruction Addressing Modes

The addressing modes shown in Table 4-40 form the basis of the addressing modes that are optimized to support the specific features of individual instructions. The addressing modes provided in the MAC class of instructions differ from those provided in other instruction types.

### 4.3.1 FILE REGISTER INSTRUCTIONS

Most file register instructions use a 13-bit address field (f) to directly address data present in the first 8192 bytes of data memory (Near Data Space). Most file register instructions employ a Working register, W0, which is denoted as WREG in these instructions. The destination is typically either the same file register or WREG (with the exception of the MUL instruction), which writes the result to a register or register pair. The MOV instruction allows additional flexibility and can access the entire data space.

### 4.3.2 MCU INSTRUCTIONS

The three-operand MCU instructions are of the form:

```
Operand 3 = Operand 1 <function> Operand 2
```

where Operand 1 is always a Working register (that is, the addressing mode can only be Register Direct), which is referred to as Wb. Operand 2 can be a W register, fetched from data memory, or a 5-bit literal. The result location can be either a W register or a data memory location. The following addressing modes are supported by MCU instructions:

- Register Direct
- Register Indirect
- Register Indirect Post-Modified
- Register Indirect Pre-Modified
- 5-Bit or 10-Bit Literal

| | |
|---|---|
| **Note:** | Not all instructions support all of the addressing modes given above. Individual instructions can support different subsets of these addressing modes. |

**TABLE 4-40: FUNDAMENTAL ADDRESSING MODES SUPPORTED**

| Addressing Mode | Description |
|---|---|
| File Register Direct | The address of the file register is specified explicitly. |
| Register Direct | The contents of a register are accessed directly. |
| Register Indirect | The contents of Wn forms the Effective Address (EA). |
| Register Indirect Post-Modified | The contents of Wn forms the EA. Wn is post-modified (incremented or decremented) by a constant value. |
| Register Indirect Pre-Modified | Wn is pre-modified (incremented or decremented) by a signed constant value to form the EA. |
| Register Indirect with Register Offset (Register Indexed) | The sum of Wn and Wb forms the EA. |
| Register Indirect with Literal Offset | The sum of Wn and a literal forms the EA. |

### 4.3.3 MOVE AND ACCUMULATOR INSTRUCTIONS

Move instructions and the DSP accumulator class of instructions provide a greater degree of addressing flexibility than other instructions. In addition to the addressing modes supported by most MCU instructions, move and accumulator instructions also support Register Indirect with Register Offset Addressing mode, also referred to as Register Indexed mode.

**Note:** For the MOV instructions, the addressing mode specified in the instruction can differ for the source and destination EA. However, the 4-bit Wb (Register Offset) field is shared by both source and destination (but typically only used by one).

In summary, the following addressing modes are supported by move and accumulator instructions:

- Register Direct
- Register Indirect
- Register Indirect Post-modified
- Register Indirect Pre-modified
- Register Indirect with Register Offset (Indexed)
- Register Indirect with Literal Offset
- 8-Bit Literal
- 16-Bit Literal

**Note:** Not all instructions support all the addressing modes given above. Individual instructions may support different subsets of these addressing modes.

### 4.3.4 MAC INSTRUCTIONS

The dual source operand DSP instructions (CLR, ED, EDAC, MAC, MPY, MPY.N, MOVSAC and MSC), also referred to as MAC instructions, use a simplified set of addressing modes to allow the user application to effectively manipulate the Data Pointers through register indirect tables.

The two-source operand prefetch registers must be members of the set {W8, W9, W10, W11}. For data reads, W8 and W9 are always directed to the X RAGU, and W10 and W11 are always directed to the Y AGU. The Effective Addresses generated (before and after modification) must, therefore, be valid addresses within X data space for W8 and W9 and Y data space for W10 and W11.

**Note:** Register Indirect with Register Offset Addressing mode is available only for W9 (in X space) and W11 (in Y space).

In summary, the following addressing modes are supported by the MAC class of instructions:

- Register Indirect
- Register Indirect Post-Modified by 2
- Register Indirect Post-Modified by 4
- Register Indirect Post-Modified by 6
- Register Indirect with Register Offset (Indexed)

### 4.3.5 OTHER INSTRUCTIONS

In addition to the addressing modes outlined previously, some instructions use literal constants of various sizes. For example, BRA (branch) instructions use 16-bit signed literals to specify the branch destination directly, whereas the DISI instruction uses a 14-bit unsigned literal field. In some instructions, such as ADD Acc, the source of an operand or result is implied by the opcode itself. Certain operations, such as NOP, do not have any operands.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## 4.4 Modulo Addressing

Modulo Addressing mode is a method of providing an automated means to support circular data buffers using hardware. The objective is to remove the need for software to perform data address boundary checks when executing tightly looped code, as is typical in many DSP algorithms.

Modulo Addressing can operate in either data or program space (since the Data Pointer mechanism is essentially the same for both). One circular buffer can be supported in each of the X (which also provides the pointers into program space) and Y data spaces. Modulo Addressing can operate on any W Register Pointer. However, it is not advisable to use W14 or W15 for Modulo Addressing since these two registers are used as the Stack Frame Pointer and Stack Pointer, respectively.

In general, any particular circular buffer can be configured to operate in only one direction as there are certain restrictions on the buffer start address (for incrementing buffers), or end address (for decrementing buffers), based upon the direction of the circular buffer.

The only exception to the usage restrictions is for buffers that have a power-of-two length. As these buffers satisfy the start and end address criteria, they can operate in a bidirectional mode (that is, address boundary checks are performed on both the lower and upper address boundaries).

### 4.4.1 START AND END ADDRESS

The Modulo Addressing scheme requires that a starting and ending address be specified, and loaded into the 16-bit Modulo Buffer Address registers: XMODSRT, XMODEND, YMODSRT and YMODEND (see Table 4-1).

| **Note:** | Y space Modulo Addressing EA calculations assume word-sized data (LSb of every EA is always clear). |
|---|---|

The length of a circular buffer is not directly specified. It is determined by the difference between the corresponding start and end addresses. The maximum possible length of the circular buffer is 32K words (64 Kbytes).

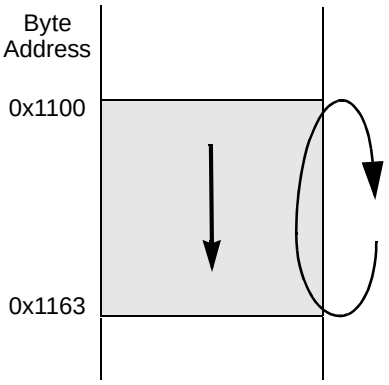
### 4.4.2 W ADDRESS REGISTER SELECTION

- The Modulo and Bit-Reversed Addressing Control register, MODCON<15:0>, contains enable flags as well as a W register field to specify the W Address registers. The XWM and YWM fields select which registers will operate with Modulo Addressing.
- If XWM = 15, X RAGU and X WAGU Modulo Addressing is disabled.
- If YWM = 15, Y AGU Modulo Addressing is disabled.

The X Address Space Pointer W register (XWM), to which Modulo Addressing is to be applied, is stored in MODCON<3:0> (see Table 4-1). Modulo Addressing is enabled for X data space when XWM is set to any value other than ‘15’ and the XMODEN bit is set at MODCON<15>.

The Y Address Space Pointer W register (YWM) to which Modulo Addressing is to be applied is stored in MODCON<7:4>. Modulo Addressing is enabled for Y data space when YWM is set to any value other than ‘15’ and the YMODEN bit is set at MODCON<14>.

**FIGURE 4-7: MODULO ADDRESSING OPERATION EXAMPLE**




```
MOV     #0x1100, W0
MOV     W0, XMODSRT     ;set modulo start address
MOV     #0x1163, W0
MOV     W0, MODEND      ;set modulo end address
MOV     #0x8001, W0
MOV     W0, MODCON      ;enable W1, X AGU for modulo

MOV     #0x0000, W0     ;W0 holds buffer fill value

MOV     #0x1110, W1     ;point W1 to buffer

DO      AGAIN, #0x31    ;fill the 50 buffer locations
MOV     W0, [W1++]      ;fill the next location
AGAIN:  INC  W0, W0     ;increment the fill value
```

### 4.4.3 MODULO ADDRESSING APPLICABILITY

Modulo Addressing can be applied to the Effective Address (EA) calculation associated with any W register. Address boundaries check for addresses equal to:

- The upper boundary addresses for incrementing buffers
- The lower boundary addresses for decrementing buffers

It is important to realize that the address boundaries check for addresses less than or greater than the upper (for incrementing buffers) and lower (for decrementing buffers) boundary addresses (not just equal to). Address changes can, therefore, jump beyond boundaries and still be adjusted correctly.

| | |
|---|---|
| **Note:** | The modulo corrected Effective Address is written back to the register only when Pre-Modify or Post-Modify Addressing mode is used to compute the Effective Address. When an address offset (such as [W7 + W2]) is used, Modulo Addressing correction is performed, but the contents of the register remain unchanged. |

## 4.5 Bit-Reversed Addressing

Bit-Reversed Addressing mode is intended to simplify data reordering for radix-2 FFT algorithms. It is supported by the X AGU for data writes only.

The modifier, which can be a constant value or register contents, is regarded as having its bit order reversed. The address source and destination are kept in normal order. Thus, the only operand requiring reversal is the modifier.

### 4.5.1 BIT-REVERSED ADDRESSING IMPLEMENTATION

Bit-Reversed Addressing mode is enabled in any of these situations:

- BWM<3:0> bits (W register selection) in the MODCON register are any value other than ‘15’ (the stack cannot be accessed using Bit-Reversed Addressing)
- The BREN bit is set in the XBREV register
- The addressing mode used is Register Indirect with Pre-Increment or Post-Increment

If the length of a bit-reversed buffer is $M = 2^N$ bytes, the last ‘N’ bits of the data buffer start address must be zeros.

XB<14:0> is the bit-reversed address modifier, or ‘pivot point,’ which is typically a constant. In the case of an FFT computation, its value is equal to half of the FFT data buffer size.

| | |
|---|---|
| **Note:** | All bit-reversed EA calculations assume word-sized data (LSb of every EA is always clear). The XB<14:0> value is scaled accordingly to generate compatible (byte) addresses. |

When enabled, Bit-Reversed Addressing is executed only for Register Indirect with Pre-Increment or Post-Increment Addressing and word-sized data writes. It will not function for any other addressing mode or for byte-sized data and normal addresses are generated instead. When Bit-Reversed Addressing is active, the W Address Pointer is always added to the address modifier (XB) and the offset associated with the Register Indirect Addressing mode is ignored. In addition, as word-sized data is a requirement, the LSb of the EA is ignored (and always clear).

| | |
|---|---|
| **Note:** | Modulo Addressing and Bit-Reversed Addressing should not be enabled together. If an application attempts to do so, Bit-Reversed Addressing will assume priority when active. For the X WAGU and Y AGU, Modulo Addressing will be disabled. However, Modulo Addressing will continue to function in the X RAGU. |

If Bit-Reversed Addressing has already been enabled by setting the BREN (XBREV<15>) bit, a write to the XBREV register should not be immediately followed by an indirect read operation using the W register that has been designated as the Bit-Reversed Pointer.


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**FIGURE 4-8: BIT-REVERSED ADDRESS EXAMPLE**

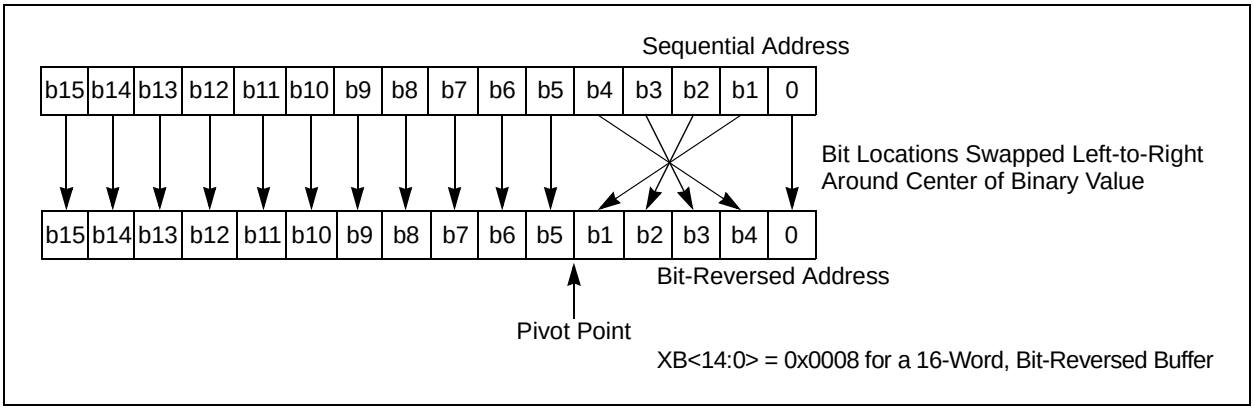


**TABLE 4-41: BIT-REVERSED ADDRESS SEQUENCE (16-ENTRY)**

| Normal Address | | | | | Bit-Reversed Address | | | | |
|---|---|---|---|---|---|---|---|---|---|
| **A3** | **A2** | **A1** | **A0** | **Decimal** | **A3** | **A2** | **A1** | **A0** | **Decimal** |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 0 | 0 | 0 | 1 | 1 | 1 | 0 | 0 | 0 | 8 |
| 0 | 0 | 1 | 0 | 2 | 0 | 1 | 0 | 0 | 4 |
| 0 | 0 | 1 | 1 | 3 | 1 | 1 | 0 | 0 | 12 |
| 0 | 1 | 0 | 0 | 4 | 0 | 0 | 1 | 0 | 2 |
| 0 | 1 | 0 | 1 | 5 | 1 | 0 | 1 | 0 | 10 |
| 0 | 1 | 1 | 0 | 6 | 0 | 1 | 1 | 0 | 6 |
| 0 | 1 | 1 | 1 | 7 | 1 | 1 | 1 | 0 | 14 |
| 1 | 0 | 0 | 0 | 8 | 0 | 0 | 0 | 1 | 1 |
| 1 | 0 | 0 | 1 | 9 | 1 | 0 | 0 | 1 | 9 |
| 1 | 0 | 1 | 0 | 10 | 0 | 1 | 0 | 1 | 5 |
| 1 | 0 | 1 | 1 | 11 | 1 | 1 | 0 | 1 | 13 |
| 1 | 1 | 0 | 0 | 12 | 0 | 0 | 1 | 1 | 3 |
| 1 | 1 | 0 | 1 | 13 | 1 | 0 | 1 | 1 | 11 |
| 1 | 1 | 1 | 0 | 14 | 0 | 1 | 1 | 1 | 7 |
| 1 | 1 | 1 | 1 | 15 | 1 | 1 | 1 | 1 | 15 |

## 4.6 Interfacing Program and Data Memory Spaces

The dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 architecture uses a 24-bit-wide program space and a 16-bit-wide data space. The architecture is also a modified Harvard scheme, meaning that data can also be present in the program space. To use this data successfully, it must be accessed in a way that preserves the alignment of information in both spaces.

Aside from normal execution, the dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 architecture provides two methods by which program space can be accessed during operation:

- Using table instructions to access individual bytes, or words, anywhere in the program space
- Remapping a portion of the program space into the data space (Program Space Visibility)

Table instructions allow an application to read or write to small areas of the program memory. This capability makes the method ideal for accessing data tables that need to be updated periodically. It also allows access to all bytes of the program word. The remapping method allows an application to access a large block of data on a read-only basis, which is ideal for lookups from a large table of static data. The application can only access the lsw of the program word.

### 4.6.1 ADDRESSING PROGRAM SPACE

Since the address ranges for the data and program spaces are 16 and 24 bits, respectively, a method is needed to create a 23-bit or 24-bit program address from 16-bit data registers. The solution depends on the interface method to be used.

For table operations, the 8-bit Table Page (TBLPAG) register is used to define a 32K word region within the program space. This is concatenated with a 16-bit EA to arrive at a full 24-bit program space address. In this format, the MSb of TBLPAG is used to determine if the operation occurs in the user memory (TBLPAG<7> = 0) or the configuration memory (TBLPAG<7> = 1).

For remapping operations, the 8-bit Program Space Visibility (PSVPAG) register is used to define a 16K word page in the program space. When the MSb of the EA is '1', PSVPAG is concatenated with the lower 15 bits of the EA to form a 23-bit program space address. Unlike table operations, this limits remapping operations strictly to the user memory area.

Table 4-42 and Figure 4-9 show how the program EA is created for table operations and remapping accesses from the data EA.

**TABLE 4-42: PROGRAM SPACE ADDRESS CONSTRUCTION**

| Access Type | Access Space | Program Space Address | | | | |
|---|---|---|---|---|---|---|
| | | <23> | <22:16> | <15> | <14:1> | <0> |
| Instruction Access (Code Execution) | User | 0 | PC<22:1> | | | 0 |
| | | 0xx xxxx xxxx xxxx xxxx xxx0 | | | | |
| TBLRD/TBLWT (Byte/Word Read/Write) | User | TBLPAG<7:0> | | Data EA<15:0> | | |
| | | 0xxx xxxx | | xxxx xxxx xxxx xxxx | | |
| | Configuration | TBLPAG<7:0> | | Data EA<15:0> | | |
| | | 1xxx xxxx | | xxxx xxxx xxxx xxxx | | |
| Program Space Visibility (Block Remap/Read) | User | 0 | PSVPAG<7:0> | | Data EA<14:0>(1) | |
| | | 0 | xxxx xxxx | | xxx xxxx xxxx xxxx | |

**Note 1:** Data EA<15> is always '1' in this case, but is not used in calculating the program space address. Bit 15 of the address is PSVPAG<0>.


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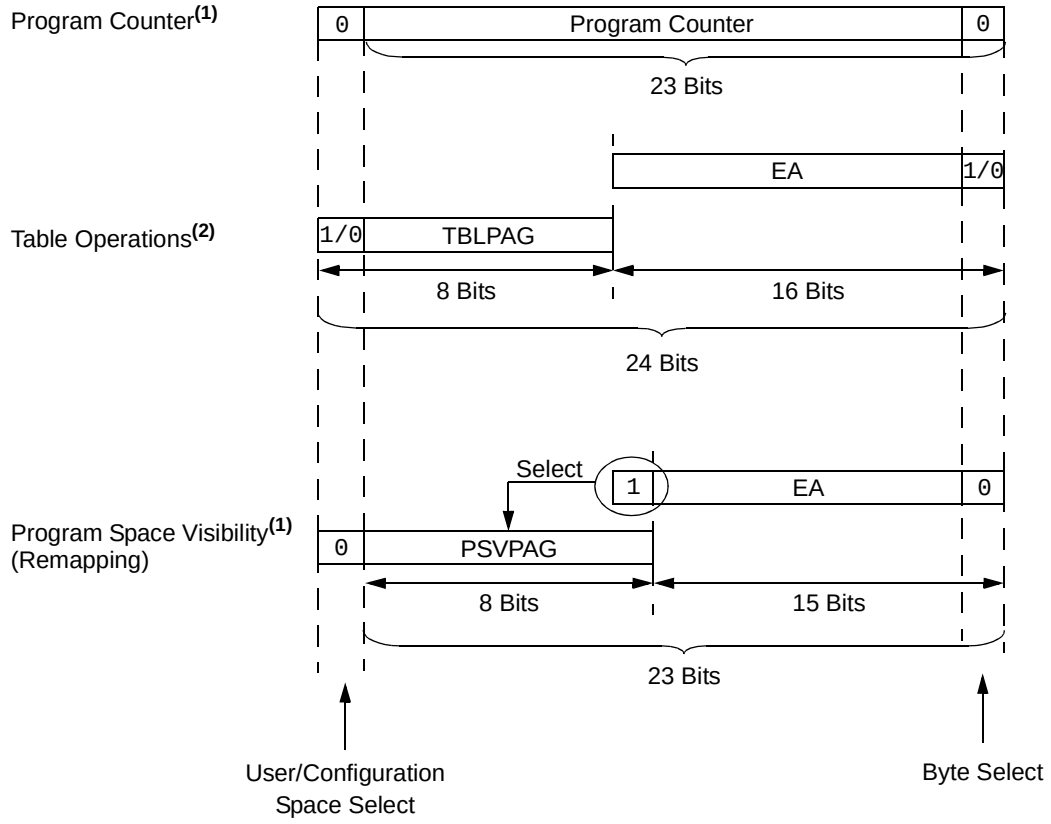
**FIGURE 4-9: DATA ACCESS FROM PROGRAM SPACE ADDRESS GENERATION**




**Note 1:** The Least Significant bit of program space addresses is always fixed as '0' to maintain word alignment of data in the program and data spaces.

**2:** Table operations are not required to be word-aligned. Table read operations are permitted in the configuration memory space.

### 4.6.2 DATA ACCESS FROM PROGRAM MEMORY USING TABLE INSTRUCTIONS

The TBLRDL and TBLWTL instructions offer a direct method of reading or writing the lower word of any address within the program space without going through data space. The TBLRDH and TBLWTH instructions are the only method to read or write the upper 8 bits of a program space word as data.

The PC is incremented by two for each successive 24-bit program word. This allows program memory addresses to directly map to data space addresses. Program memory can thus be regarded as two 16-bit-wide word address spaces, residing side by side, each with the same address range. TBLRDL and TBLWTL access the space that contains the least significant data word. TBLRDH and TBLWTH access the space that contains the upper data byte.

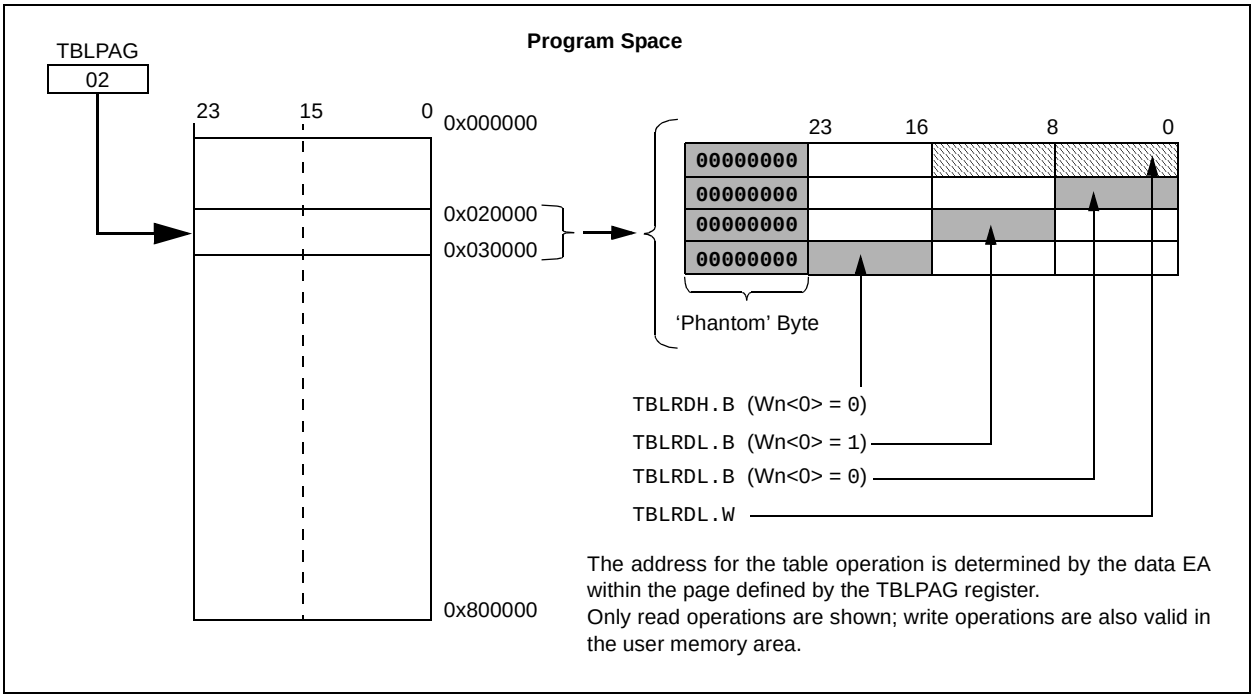
Two table instructions are provided to move byte or word-sized (16-bit) data to and from program space. Both function as either byte or word operations.

- TBLRDL (Table Read Low):
  - In Word mode, this instruction maps the lower word of the program space location (P<15:0>) to a data address (D<15:0>).
  - In Byte mode, either the upper or lower byte of the lower program word is mapped to the lower byte of a data address. The upper byte is selected when Byte Select is '1'; the lower byte is selected when it is '0'.
- TBLRDH (Table Read High):
  - In Word mode, this instruction maps the entire upper word of a program address (P<23:16>) to a data address. Note that D<15:8>, the 'phantom byte', will always be '0'.
  - In Byte mode, this instruction maps the upper or lower byte of the program word to D<7:0> of the data address, in the TBLRDL instruction. The data is always '0' when the upper 'phantom' byte is selected (Byte Select = 1).

In a similar fashion, two table instructions, TBLWTH and TBLWTL, are used to write individual bytes or words to a program space address. The details of their operation are explained in **Section 5.0 "Flash Program Memory"**.

For all table operations, the area of program memory space to be accessed is determined by the Table Page register (TBLPAG). TBLPAG covers the entire program memory space of the device, including user and configuration spaces. When TBLPAG<7> = 0, the table page is located in the user memory space. When TBLPAG<7> = 1, the page is located in configuration space.

**FIGURE 4-10: ACCESSING PROGRAM MEMORY WITH TABLE INSTRUCTIONS**




The address for the table operation is determined by the data EA within the page defined by the TBLPAG register.
Only read operations are shown; write operations are also valid in the user memory area.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### 4.6.3 READING DATA FROM PROGRAM MEMORY USING PROGRAM SPACE VISIBILITY

The upper 32 Kbytes of data space may optionally be mapped into any 16K word page of the program space. This option provides transparent access to stored constant data from the data space without the need to use special instructions (such as TBLRDL and TBLRDH).

Program space access through the data space occurs if the MSb of the data space EA is '1' and program space visibility is enabled by setting the PSV bit in the Core Control register (CORCON<2>). The location of the program memory space to be mapped into the data space is determined by the Program Space Visibility Page register (PSVPAG). This 8-bit register defines any one of 256 possible pages of 16K words in program space. In effect, PSVPAG functions as the upper 8 bits of the program memory address, with the 15 bits of the EA functioning as the lower bits. By incrementing the PC by 2 for each program memory word, the lower 15 bits of data space addresses directly map to the lower 15 bits in the corresponding program space addresses.

Data reads to this area add a cycle to the instruction being executed, since two program memory fetches are required.

Although each data space address, 0x8000 and higher, maps directly into a corresponding program memory address (see Figure 4-11), only the lower 16 bits of the 24-bit program word are used to contain the data. The upper 8 bits of any program space location used as data should be programmed with '1111 1111' or '0000 0000' to force a NOP. This prevents possible issues should the area of code ever be accidentally executed.

| **Note:** | PSV access is temporarily disabled during Table Reads/Writes. |
|---|---|

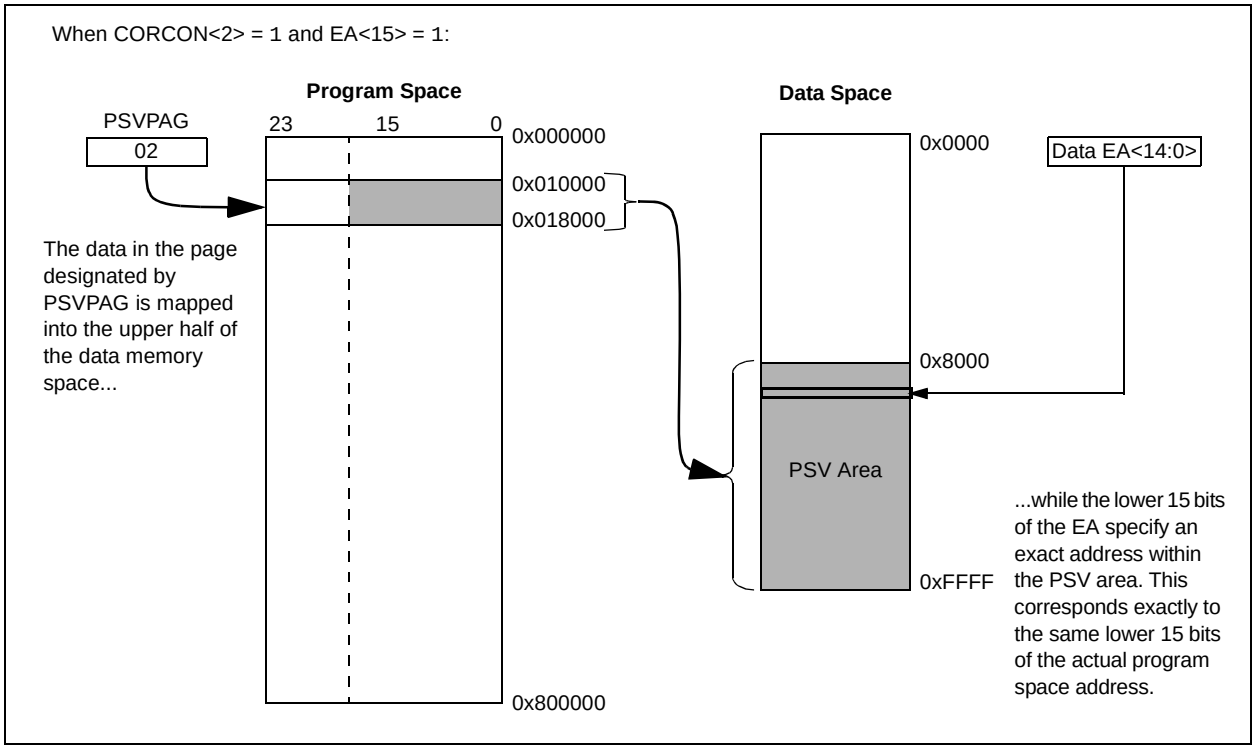
For operations that use PSV and are executed outside a REPEAT loop, the MOV and MOV.D instructions require one instruction cycle in addition to the specified execution time. All other instructions require two instruction cycles in addition to the specified execution time.

For operations that use PSV, and are executed inside a REPEAT loop, these instances require two instruction cycles in addition to the specified execution time of the instruction:

- Execution in the first iteration
- Execution in the last iteration
- Execution prior to exiting the loop due to an interrupt
- Execution upon re-entering the loop after an interrupt is serviced

Any other iteration of the REPEAT loop will allow the instruction using PSV to access data, to execute in a single cycle.

**FIGURE 4-11: PROGRAM SPACE VISIBILITY OPERATION**



**NOTES:**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## 5.0 FLASH PROGRAM MEMORY

**Note 1:** This data sheet summarizes the features of the dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 family devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **"Flash Programming"** (DS70191) in the *"dsPIC33/PIC24 Family Reference Manual"*, which is available from the Microchip web site (www.microchip.com).

**2:** Some registers and associated bits described in this section may not be available on all devices. Refer to **Section 4.0 "Memory Organization"** in this data sheet for device-specific register and bit information.

The dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 devices contain internal Flash program memory for storing and executing application code. The memory is readable, writable and erasable during normal operation over the entire VDD range.

Flash memory can be programmed in two ways:

- In-Circuit Serial Programming™ (ICSP™) programming capability
- Run-Time Self-Programming (RTSP)

ICSP allows a device to be serially programmed while in the end application circuit. This is done with two lines for programming clock and programming data (one of the alternate programming pin pairs: PGECx/PGEDx), and three other lines for power (VDD), ground (VSS) and Master Clear ($\overline{MCLR}$). This allows users to manufacture boards with unprogrammed devices and then program the Digital Signal Controller just before shipping the product. This also allows the most recent firmware or a custom firmware to be programmed.

RTSP is accomplished using TBLRD (Table Read) and TBLWT (Table Write) instructions. With RTSP, the user application can write program memory data in a single program memory word and erase program memory in blocks or 'pages' of 512 instructions (1536 bytes).

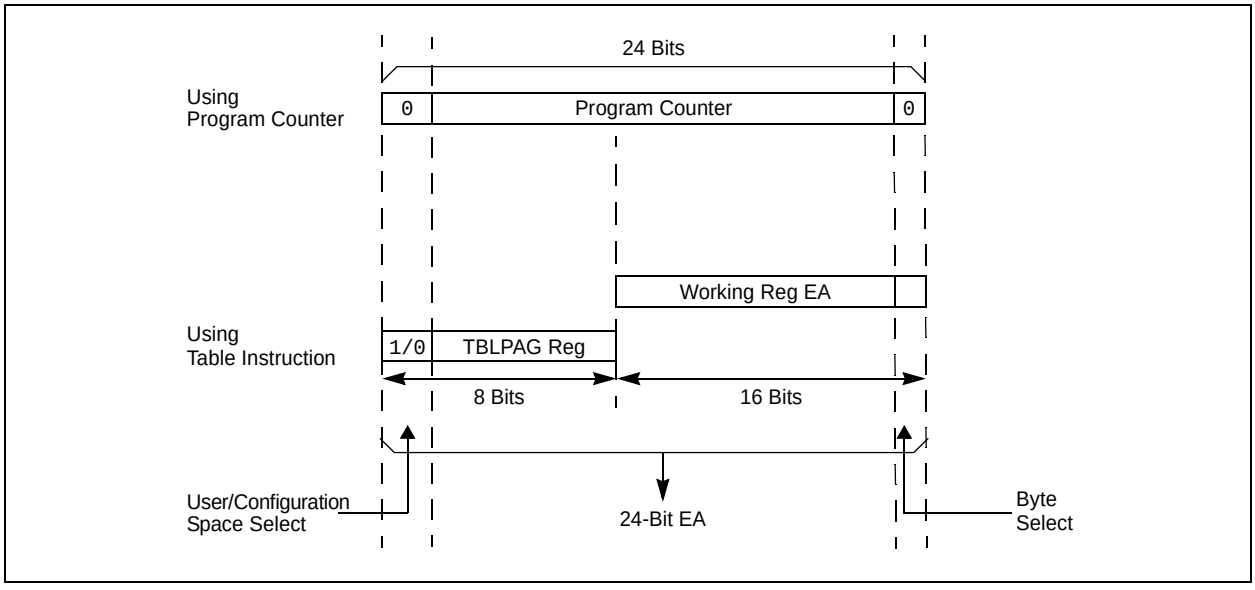
### 5.1 Table Instructions and Flash Programming

Regardless of the method used, all programming of Flash memory is done with the Table Read and Table Write instructions. These allow direct read and write access to the program memory space, from the data memory, while the device is in normal operating mode. The 24-bit target address in the program memory is formed using bits<7:0> of the TBLPAG register and the Effective Address (EA) from a W register specified in the table instruction, as shown in Figure 5-1.

The TBLRDL and the TBLWTL instructions are used to read or write to bits<15:0> of program memory. TBLRDL and TBLWTL can access program memory in both Word and Byte modes.

The TBLRDH and TBLWTH instructions are used to read or write to bits<23:16> of program memory. TBLRDH and TBLWTH can also access program memory in Word or Byte mode.

**FIGURE 5-1: ADDRESSING FOR TABLE REGISTERS**



## 5.2 RTSP Operation

The dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 Flash program memory array is organized into rows of 64 instructions or 192 bytes. RTSP allows the user application to erase a page of memory, which consists of eight rows (512 instructions); and to program one word. Table 26-12 shows typical erase and programming times. The 8-row erase pages are edge-aligned from the beginning of program memory, on boundaries of 1536 bytes.

## 5.3 Programming Operations

A complete programming sequence is necessary for programming or erasing the internal Flash in RTSP mode. The processor stalls (waits) until the operation is finished.

The programming time depends on the FRC accuracy (see Table 26-18) and the value of the FRC Oscillator Tuning register (see Register 8-3). Use the following formula to calculate the minimum and maximum values for the Word write time and page erase time (see Parameters D138a and D138b, and Parameters D137a and D137b in Table 26-12, respectively).

**EQUATION 5-1: PROGRAMMING TIME**

$$\frac{T}{7.37\ MHz \times (FRC\ Accuracy)\% \times (FRC\ Tuning)\%}$$

For example, if the device is operating at +125°C, the FRC accuracy will be ±2%. If the TUN<5:0> bits (see Register 8-3) are set to `'b000000`, the minimum row write time is equal to Equation 5-2.

**EQUATION 5-2: MINIMUM ROW WRITE TIME**

$$T_{RW} = \frac{355\ Cycles}{7.37\ MHz \times (1+0.02) \times (1-0.00375)} = 47.4\mu s$$

The maximum row write time is equal to Equation 5-3.

**EQUATION 5-3: MAXIMUM ROW WRITE TIME**

$$T_{RW} = \frac{355\ Cycles}{7.37\ MHz \times (1-0.02) \times (1-0.00375)} = 49.3\mu s$$

Setting the WR bit (NVMCON<15>) starts the operation and the WR bit is automatically cleared when the operation is finished.

### 5.3.1 PROGRAMMING ALGORITHM FOR FLASH PROGRAM MEMORY

Programmers can program one word (24 bits) of program Flash memory at a time. To do this, it is necessary to erase the 8-row erase page that contains the desired address of the location the user wants to change.

For protection against accidental operations, the write initiate sequence for NVMKEY must be used to allow any erase or program operation to proceed. After the programming command has been executed, the user application must wait for the programming time until programming is complete. The two instructions following the start of the programming sequence should be `NOP`s.

| | |
|---|---|
| **Note:** | Performing a page erase operation on the last page of program memory will clear the Flash Configuration Words, thereby enabling code protection as a result. Therefore, users should avoid performing page erase operations on the last page of program memory. |

Refer to **"Flash Programming"** (DS70191) in the *"dsPIC33/PIC24 Family Reference Manual"* for details and codes examples on programming using RTSP.

## 5.4 Control Registers

Two SFRs are used to read and write the program Flash memory: NVMCON and NVMKEY.

The NVMCON register (Register 5-1) controls which blocks are to be erased, which memory type is to be programmed and the start of the programming cycle.

NVMKEY is a write-only register that is used for write protection. To start a programming or erase sequence, the user application must consecutively write 0x55 and 0xAA to the NVMKEY register. Refer to **Section 5.3 "Programming Operations"** for further details.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**REGISTER 5-1: NVMCON: FLASH MEMORY CONTROL REGISTER**

| R/SO-0(1) | R/W-0(1) | R/W-0(1) | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| WR | WREN | WRERR | — | — | — | — | — |
| bit 15 | | | | | | | bit 8 |

| U-0 | R/W-0(1) | U-0 | U-0 | R/W-0(1) | R/W-0(1) | R/W-0(1) | R/W-0(1) |
|---|---|---|---|---|---|---|---|
| — | ERASE | — | — | NVMOP3(2) | NVMOP2(2) | NVMOP1(2) | NVMOP0(2) |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | SO = Settable Only bit | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15 **WR:** Write Control bit(1)
- 1 = Initiates a Flash memory program or erase operation; the operation is self-timed and the bit is cleared by hardware once operation is complete
- 0 = Program or erase operation is complete and inactive

bit 14 **WREN:** Write Enable bit(1)
- 1 = Enables Flash program/erase operations
- 0 = Inhibits Flash program/erase operations

bit 13 **WRERR:** Write Sequence Error Flag bit(1)
- 1 = An improper program or erase sequence attempt or termination has occurred (bit is set automatically on any set attempt of the WR bit)
- 0 = The program or erase operation completed normally

bit 12-7 **Unimplemented:** Read as '0'

bit 6 **ERASE:** Erase/Program Enable bit(1)
- 1 = Performs the erase operation specified by NVMOP<3:0> on the next WR command
- 0 = Performs the program operation specified by NVMOP<3:0> on the next WR command

bit 5-4 **Unimplemented:** Read as '0'

bit 3-0 **NVMOP<3:0>:** NVM Operation Selection bits(1,2)

If ERASE = 1:
- 1111 = No operation
- 1101 = Erase General Segment
- 1100 = No operation
- 0011 = No operation
- 0010 = Memory page erase operation
- 0001 = No operation
- 0000 = No operation

If ERASE = 0:
- 1111 = No operation
- 1101 = No operation
- 1100 = No operation
- 0011 = Memory word program operation
- 0010 = No operation
- 0001 = No operation
- 0000 = No operation

**Note 1:** These bits can only be reset on a POR.

**2:** All other combinations of NVMOP<3:0> are unimplemented.

**REGISTER 5-2: NVMKEY: NONVOLATILE MEMORY KEY REGISTER**

| U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | — | — | — |

| bit 15 | | | | | | | bit 8 |
|---|---|---|---|---|---|---|---|

| W-0 | W-0 | W-0 | W-0 | W-0 | W-0 | W-0 | W-0 |
|---|---|---|---|---|---|---|---|
| NVMKEY<7:0> | | | | | | | |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15-8 **Unimplemented:** Read as ‘0’

bit 7-0 **NVMKEY<7:0>:** Key Register bits (write-only)


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## 6.0 RESETS

**Note 1:** This data sheet summarizes the features of the dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 family devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **"Reset"** (DS70192) in the "*dsPIC33/PIC24 Family Reference Manual*", which is available from the Microchip web site (www.microchip.com).

**2:** Some registers and associated bits described in this section may not be available on all devices. Refer to **Section 4.0 "Memory Organization"** in this data sheet for device-specific register and bit information.

The Reset module combines all Reset sources and controls the device Master Reset Signal, $\overline{\text{SYSRST}}$. The following is a list of device Reset sources:

- POR: Power-on Reset
- BOR: Brown-out Reset
- $\overline{\text{MCLR}}$: Master Clear Pin Reset
- SWR: RESET Instruction
- WDTO: Watchdog Timer Reset
- CM: Configuration Mismatch Reset
- TRAPR: Trap Conflict Reset
- IOPUWR: Illegal Condition Device Reset
  - Illegal Opcode Reset
  - Uninitialized W Register Reset
  - Security Reset

A simplified block diagram of the Reset module is shown in Figure 6-1.

Any active source of Reset will make the $\overline{\text{SYSRST}}$ signal active. On system Reset, some of the registers associated with the CPU and peripherals are forced to a known Reset state, and some are unaffected.

**Note:** Refer to the specific peripheral section or **Section 3.0 "CPU"** of this data sheet for register Reset states.

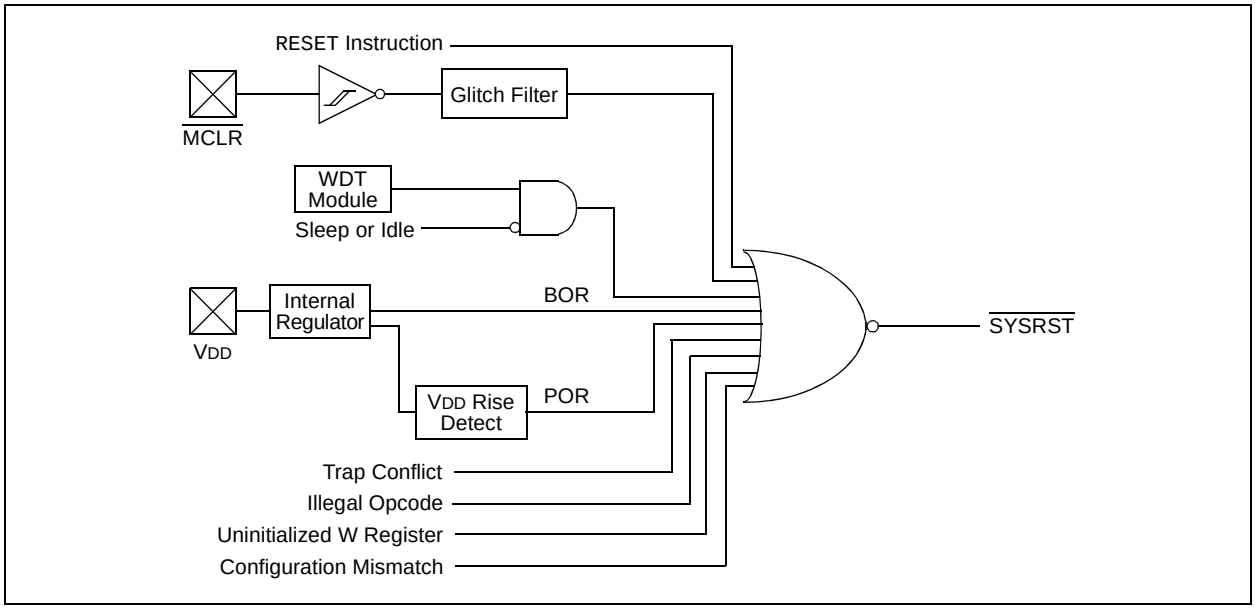
All types of device Reset set a corresponding status bit in the RCON register to indicate the type of Reset (see Register 6-1).

All bits that are set, with the exception of the POR bit (RCON<0>), are cleared during a POR event. The user application can set or clear any bit at any time during code execution. The RCON bits only serve as status bits. Setting a particular Reset status bit in software does not cause a device Reset to occur.

The RCON register also has other bits associated with the Watchdog Timer and device power-saving states. The function of these bits is discussed in other sections of this data sheet.

**Note:** The status bits in the RCON register should be cleared after they are read so that the next RCON register value after a device Reset is meaningful.

**FIGURE 6-1: RESET SYSTEM BLOCK DIAGRAM**



## 6.1 Reset Control Register

**REGISTER 6-1: RCON: RESET CONTROL REGISTER(1)**

| R/W-0 | R/W-0 | U-0 | U-0 | U-0 | U-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| TRAPR | IOPUWR | — | — | — | — | CM | VREGS |
| bit 15 | | | | | | | bit 8 |

| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-1 | R/W-1 |
|---|---|---|---|---|---|---|---|
| EXTR | SWR | SWDTEN(2) | WDTO | SLEEP | IDLE | BOR | POR |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15 **TRAPR:** Trap Reset Flag bit
1 = A Trap Conflict Reset has occurred
0 = A Trap Conflict Reset has not occurred

bit 14 **IOPUWR:** Illegal Opcode or Uninitialized W Access Reset Flag bit
1 = An illegal opcode detection, an illegal address mode or Uninitialized W register used as an Address Pointer caused a Reset
0 = An Illegal Opcode or Uninitialized W Reset has not occurred

bit 13-10 **Unimplemented:** Read as '0'

bit 9 **CM:** Configuration Mismatch Flag bit
1 = A Configuration Mismatch Reset has occurred
0 = A Configuration Mismatch Reset has not occurred

bit 8 **VREGS:** Voltage Regulator Stand-by During Sleep bit
1 = Voltage regulator is active during Sleep
0 = Voltage regulator goes into Stand-by mode during Sleep

bit 7 **EXTR:** External Reset ($\overline{MCLR}$) Pin bit
1 = A Master Clear (pin) Reset has occurred
0 = A Master Clear (pin) Reset has not occurred

bit 6 **SWR:** Software Reset (Instruction) Flag bit
1 = A RESET instruction has been executed
0 = A RESET instruction has not been executed

bit 5 **SWDTEN:** Software Enable/Disable of WDT bit(2)
1 = WDT is enabled
0 = WDT is disabled

bit 4 **WDTO:** Watchdog Timer Time-out Flag bit
1 = WDT time-out has occurred
0 = WDT time-out has not occurred

bit 3 **SLEEP:** Wake-up from Sleep Flag bit
1 = Device has been in Sleep mode
0 = Device has not been in Sleep mode

**Note 1:** All of the Reset status bits can be set or cleared in software. Setting one of these bits in software does not cause a device Reset.

**2:** If the FWDTEN Configuration bit is set to '1' (unprogrammed), the WDT is always enabled, regardless of the SWDTEN bit setting.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**REGISTER 6-1: RCON: RESET CONTROL REGISTER(1) (CONTINUED)**

bit 2 **IDLE:** Wake-up from Idle Flag bit
1 = Device has been in Idle mode
0 = Device has not been in Idle mode

bit 1 **BOR:** Brown-out Reset Flag bit
1 = A Brown-out Reset has occurred
0 = A Brown-out Reset has not occurred

bit 0 **POR:** Power-on Reset Flag bit
1 = A Power-on Reset has occurred
0 = A Power-on Reset has not occurred

**Note 1:** All of the Reset status bits can be set or cleared in software. Setting one of these bits in software does not cause a device Reset.

**2:** If the FWDTEN Configuration bit is set to '1' (unprogrammed), the WDT is always enabled, regardless of the SWDTEN bit setting.

## 6.2 System Reset

The dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 family of devices have two types of Reset:

- Cold Reset
- Warm Reset

A Cold Reset is the result of a POR or a BOR. On a Cold Reset, the FNOSC<2:0> Configuration bits in the FOSCSEL Configuration register selects the device clock source.

A Warm Reset is the result of all other Reset sources, including the RESET instruction. On Warm Reset, the device will continue to operate from the current clock source as indicated by the Current Oscillator Selection (COSC<2:0>) bits in the Oscillator Control (OSCCON<14:12>) register.

The device is kept in a Reset state until the system power supplies have stabilized at appropriate levels and the oscillator clock is ready. The sequence in which this occurs is shown in Figure 6-2.

**TABLE 6-1: OSCILLATOR DELAY**

| Oscillator Mode | Oscillator Start-up Delay | Oscillator Start-up Timer | PLL Lock Time | Total Delay |
|---|---|---|---|---|
| FRC, FRCDIV16, FRCDIVN | TOSCD(1) | — | — | TOSCD |
| FRCPLL | TOSCD(1) | — | TLOCK(3) | TOSCD(1) + TLOCK(3) |
| MS | TOSCD(1) | TOST(2) | — | TOSCD(1) + TOST(2) |
| HS | TOSCD(1) | TOST(2) | — | TOSCD(1) + TOST(2) |
| EC | — | — | — | — |
| MSPLL | TOSCD(1) | TOST(2) | TLOCK(3) | TOSCD(1) + TOST(2) + TLOCK(3) |
| ECPLL | — | — | TLOCK(3) | TLOCK(3) |
| SOSC | TOSCD(1) | TOST(2) | — | TOSCD(1) + TOST(2) |
| LPRC | TOSCD(1) | — | — | TOSCD(1) |

**Note 1:** TOSCD = Oscillator Start-up Delay (1.1 μs max. for FRC, 70 μs max. for LPRC). Crystal oscillator start-up times vary with crystal characteristics, load capacitance, etc.

**2:** TOST = Oscillator Start-up Timer Delay (1024 oscillator clock period). For example, TOST = 102.4 μs for a 10 MHz crystal and TOST = 32 ms for a 32 kHz crystal.

**3:** TLOCK = PLL Lock time (1.5 ms nominal) if PLL is enabled.


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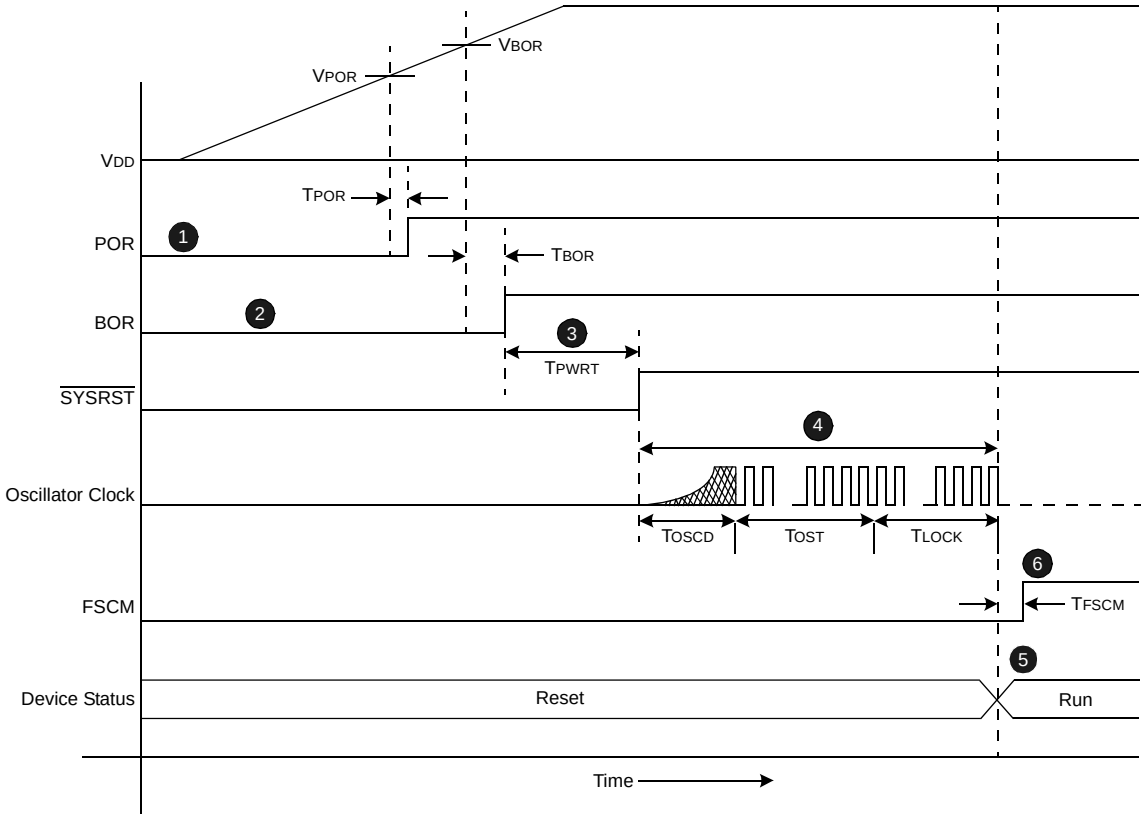
**FIGURE 6-2: SYSTEM RESET TIMING**




1. **POR:** A POR circuit holds the device in Reset when the power supply is turned on. The POR circuit is active until VDD crosses the VPOR threshold and the delay, TPOR, has elapsed.
2. **BOR:** The on-chip voltage regulator has a BOR circuit that keeps the device in Reset until VDD crosses the VBOR threshold and the delay, TBOR, has elapsed. The delay, TBOR, ensures the voltage regulator output becomes stable.
3. **PWRT Timer:** The Power-up Timer continues to hold the processor in Reset for a specific period of time (TPWRT) after a BOR. The delay, TPWRT, ensures that the system power supplies have stabilized at the appropriate level for full-speed operation. After the delay, TPWRT, has elapsed, the SYSRST becomes inactive, which in turn, enables the selected oscillator to start generating clock cycles.
4. **Oscillator Delay:** The total delay for the clock to be ready for various clock source selections is given in Table 6-1. Refer to **Section 8.0 "Oscillator Configuration"** for more information.
5. When the oscillator clock is ready, the processor begins execution from location, 0x000000. The user application programs a GOTO instruction at the Reset address, which redirects program execution to the appropriate start-up routine.
6. The Fail-Safe Clock Monitor (FSCM), if enabled, begins to monitor the system clock when the system clock is ready and the delay, TFSCM, has elapsed.

**TABLE 6-2: OSCILLATOR PARAMETERS**

| Symbol | Parameter | Value |
|---|---|---|
| VPOR | POR Threshold | 1.8V nominal |
| TPOR | POR Extension Time | 30 μs maximum |
| VBOR | BOR Threshold | 2.5V nominal |
| TBOR | BOR Extension Time | 100 μs maximum |
| TPWRT | Power-up Time Delay | 64 ms nominal |
| TFSCM | Fail-Safe Clock Monitor Delay | 900 μs maximum |

**Note:** When the device exits the Reset condition (begins normal operation), the device operating parameters (voltage, frequency, temperature, etc.) must be within their operating ranges; otherwise, the device may not function correctly. The user application must ensure that the delay between the time power is first applied, and the time SYSRST becomes inactive, is long enough to get all operating parameters within specification.

## 6.3 POR

A POR circuit ensures the device is reset from power-on. The POR circuit is active until VDD crosses the VPOR threshold and the delay, TPOR, has elapsed. The delay, TPOR, ensures that the internal device bias circuits become stable.

The device supply voltage characteristics must meet the specified starting voltage and rise rate requirements to generate the POR. Refer to **Section 26.0 "Electrical Characteristics"** for details.

The Power-on Reset (POR) status bit in the Reset Control (RCON<0>) register is set to indicate the Power-on Reset.

## 6.4 BOR and PWRT

The on-chip regulator has a BOR circuit that resets the device when the VDD is too low (VDD < VBOR) for proper device operation. The BOR circuit keeps the device in Reset until VDD crosses the VBOR threshold and the delay, TBOR, has elapsed. The delay, TBOR, ensures the voltage regulator output becomes stable.

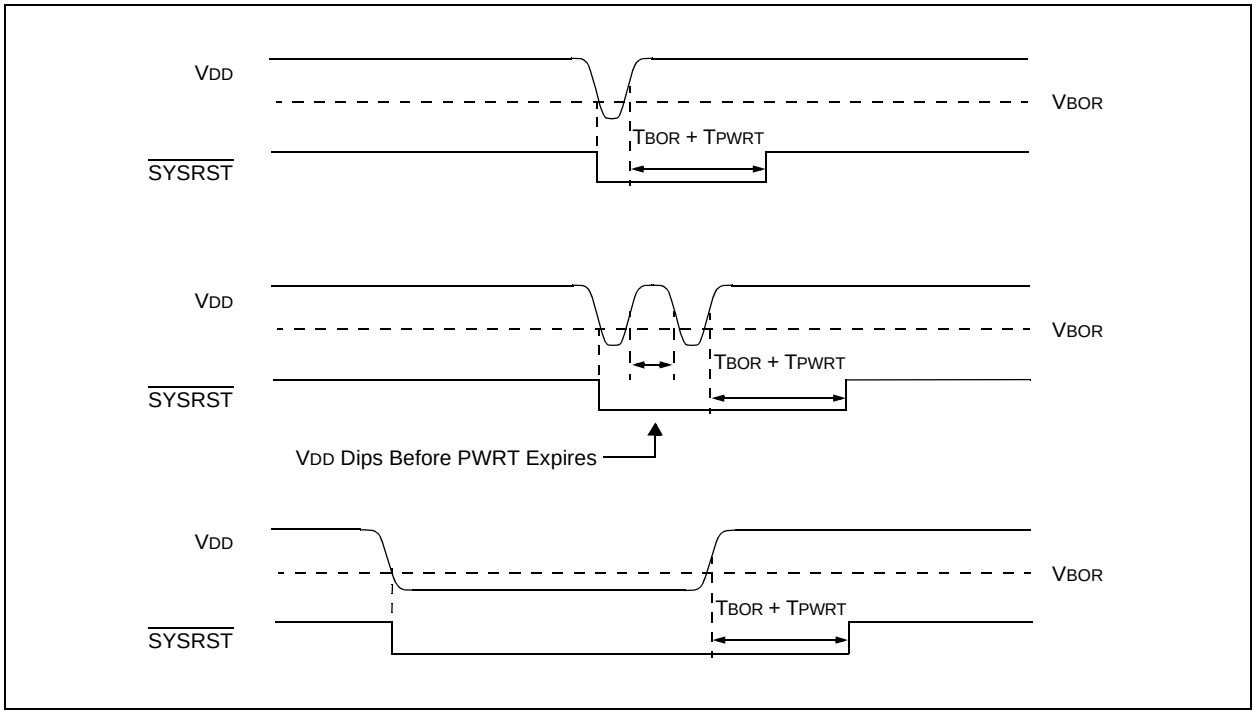
The Brown-out Reset (BOR) status bit in the Reset Control (RCON<1>) register is set to indicate the Brown-out Reset.

The device will not run at full speed after a BOR as the VDD should rise to acceptable levels for full-speed operation. The Power-up Timer (PWRT) provides power-up time delay (TPWRT) to ensure that the system power supplies have stabilized at the appropriate levels for full-speed operation before the $\overline{\text{SYSRST}}$ is released.

Refer to **Section 23.0 "Special Features"** for further details.

Figure 6-3 shows the typical brown-out scenarios. The Reset delay (TBOR + TPWRT) is initiated each time VDD rises above the VBOR trip point.

**FIGURE 6-3: BROWN-OUT RESET SITUATIONS**





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## 6.5 External Reset (EXTR)

The External Reset is generated by driving the MCLR pin low. The MCLR pin is a Schmitt trigger input with an additional glitch filter. Reset pulses that are longer than the minimum pulse width will generate a Reset. Refer to **Section 26.0 "Electrical Characteristics"** for minimum pulse-width specifications. The External Reset pin (MCLR) bit (EXTR) in the Reset Control (RCON) register is set to indicate the MCLR Reset.

### 6.5.1 EXTERNAL SUPERVISORY CIRCUIT

Many systems have external supervisory circuits that generate Reset signals to reset multiple devices in the system. This External Reset signal can be directly connected to the MCLR pin to reset the device when the rest of the system is reset.

### 6.5.2 INTERNAL SUPERVISORY CIRCUIT

When using the internal power supervisory circuit to reset the device, the External Reset pin (MCLR) should be tied directly or resistively to VDD. In this case, the MCLR pin will not be used to generate a Reset. The External Reset pin (MCLR) does not have an internal pull-up and must not be left unconnected.

## 6.6 Software RESET Instruction (SWR)

Whenever the RESET instruction is executed, the device will assert SYSRST, placing the device in a special Reset state. This Reset state will not re-initialize the clock. The clock source in effect prior to the RESET instruction will remain as the source. SYSRST is released at the next instruction cycle and the Reset vector fetch will commence.

The Software RESET (Instruction) Flag (SWR) bit in the Reset Control (RCON<6>) register is set to indicate the Software Reset.

## 6.7 Watchdog Timer Time-out Reset (WDTO)

Whenever a Watchdog Timer Time-out Reset occurs, the device will asynchronously assert SYSRST. The clock source will remain unchanged. A WDT time-out during Sleep or Idle mode will wake-up the processor, but will not reset the processor.

The Watchdog Timer Time-out Flag (WDTO) bit in the Reset Control (RCON<4>) register is set to indicate the Watchdog Timer Reset. Refer to **Section 23.4 "Watchdog Timer (WDT)"** for more information on the Watchdog Timer Reset.

## 6.8 Trap Conflict Reset

If a lower priority hard trap occurs while a higher priority trap is being processed, a hard Trap Conflict Reset occurs. The hard traps include exceptions of Priority Level 13 through Level 15, inclusive. The address error (Level 13) and oscillator error (Level 14) traps fall into this category.

The Trap Reset Flag (TRAPR) bit in the Reset Control (RCON<15>) register is set to indicate the Trap Conflict Reset. Refer to **Section 7.0 "Interrupt Controller"** for more information on Trap Conflict Resets.

## 6.9 Configuration Mismatch Reset

To maintain the integrity of the Peripheral Pin Select Control registers, they are constantly monitored with shadow registers in hardware. If an unexpected change in any of the registers occurs (such as cell disturbances caused by ESD or other external events), a Configuration Mismatch Reset occurs.

The Configuration Mismatch Flag (CM) bit in the Reset Control (RCON<9>) register is set to indicate the Configuration Mismatch Reset. Refer to **Section 10.0 "I/O Ports"** for more information on the Configuration Mismatch Reset.

| **Note:** | The Configuration Mismatch feature and associated Reset flag is not available on all devices. |
|---|---|

## 6.10 Illegal Condition Device Reset

An Illegal Condition Device Reset occurs due to the following sources:

- Illegal Opcode Reset
- Uninitialized W Register Reset
- Security Reset

The Illegal Opcode or Uninitialized W Access Reset Flag (IOPUWR) bit in the Reset Control (RCON<14>) register is set to indicate the Illegal Condition Device Reset.

### 6.10.1 ILLEGAL OPCODE RESET

A device Reset is generated if the device attempts to execute an illegal opcode value that is fetched from program memory.

The Illegal Opcode Reset function can prevent the device from executing program memory sections that are used to store constant data. To take advantage of the Illegal Opcode Reset, use only the lower 16 bits of each program memory section to store the data values. The upper 8 bits should be programmed with 0x3F, which is an illegal opcode value.

### 6.10.2 UNINITIALIZED W REGISTER RESET

Any attempts to use the Uninitialized W register as an Address Pointer will reset the device. The W register array (with the exception of W15) is cleared during all Resets and is considered uninitialized until written to.

### 6.10.3 SECURITY RESET

If a Program Flow Change (PFC) or Vector Flow Change (VFC) targets a restricted location in a protected segment (Boot and Secure Segment), that operation will cause a Security Reset.

The PFC occurs when the Program Counter is reloaded as a result of a Call, Jump, Computed Jump, Return, Return from Subroutine or other form of branch instruction.

The VFC occurs when the Program Counter is reloaded with an interrupt or trap vector.

## 6.11 Using the RCON Status Bits

The user application can read the Reset Control (RCON) register after any device Reset to determine the cause of the Reset.

| | |
|---|---|
| **Note:** | The status bits in the RCON register should be cleared after they are read so that the next RCON register value after a device Reset will be meaningful. |

Table 6-3 provides a summary of Reset flag bit operation.

**TABLE 6-3: RESET FLAG BIT OPERATION**

| Flag Bit | Set by: | Cleared by: |
|---|---|---|
| TRAPR (RCON<15>) | Trap conflict event | POR, BOR |
| IOPWR (RCON<14>) | Illegal opcode or uninitialized W register access or Security Reset | POR, BOR |
| CM (RCON<9>) | Configuration Mismatch | POR, BOR |
| EXTR (RCON<7>) | $\overline{\text{MCLR}}$ Reset | POR |
| SWR (RCON<6>) | RESET instruction | POR, BOR |
| WDTO (RCON<4>) | WDT Time-out | PWRSAV instruction, CLRWDT instruction, POR, BOR |
| SLEEP (RCON<3>) | PWRSAV #SLEEP instruction | POR, BOR |
| IDLE (RCON<2>) | PWRSAV #IDLE instruction | POR, BOR |
| BOR (RCON<1>) | POR, BOR | — |
| POR (RCON<0>) | POR | — |

**Note:** All Reset flag bits can be set or cleared by user software.


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# 7.0 INTERRUPT CONTROLLER

**Note 1:** This data sheet summarizes the features of the dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 family devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **"Interrupts (Part IV)"** (DS70300) in the "*dsPIC33/PIC24 Family Reference Manual*", which is available on the Microchip web site (www.microchip.com).

**2:** Some registers and associated bits described in this section may not be available on all devices. Refer to **Section 4.0 "Memory Organization"** in this data sheet for device-specific register and bit information.

The interrupt controller reduces the numerous peripheral interrupt request signals to a single interrupt request signal to the dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 family CPU. It has the following features:

- Up to eight processor exceptions and software traps
- Seven user-selectable priority levels
- Interrupt Vector Table (IVT) with up to 118 vectors
- A unique vector for each interrupt or exception source
- Fixed priority within a specified user priority level
- Alternate Interrupt Vector Table (AIVT) for debug support
- Fixed interrupt entry and return latencies

## 7.1 Interrupt Vector Table

The Interrupt Vector Table (IVT) is shown in Figure 7-1. The IVT resides in program memory, starting at location, 000004h. The IVT contains 126 vectors consisting of eight non-maskable trap vectors, plus up to 118 sources of interrupt. In general, each interrupt source has its own vector. Each interrupt vector contains a 24-bit-wide address. The value programmed into each interrupt vector location is the starting address of the associated Interrupt Service Routine (ISR).

Interrupt vectors are prioritized in terms of their natural priority. This priority is linked to their position in the vector table. Lower addresses generally have a higher natural priority. For example, the interrupt associated with Vector 0 will take priority over interrupts at any other vector address.

dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 devices implement up to 26 unique interrupts and 4 nonmaskable traps. These are summarized in Table 7-1 and Table 7-2.

### 7.1.1 ALTERNATE INTERRUPT VECTOR TABLE

The Alternate Interrupt Vector Table (AIVT) is located after the IVT, as shown in Figure 7-1. Access to the AIVT is provided by the ALTIVT control bit (INTCON2<15>). If the ALTIVT bit is set, all interrupt and exception processes use the alternate vectors instead of the default vectors. The alternate vectors are organized in the same manner as the default vectors.

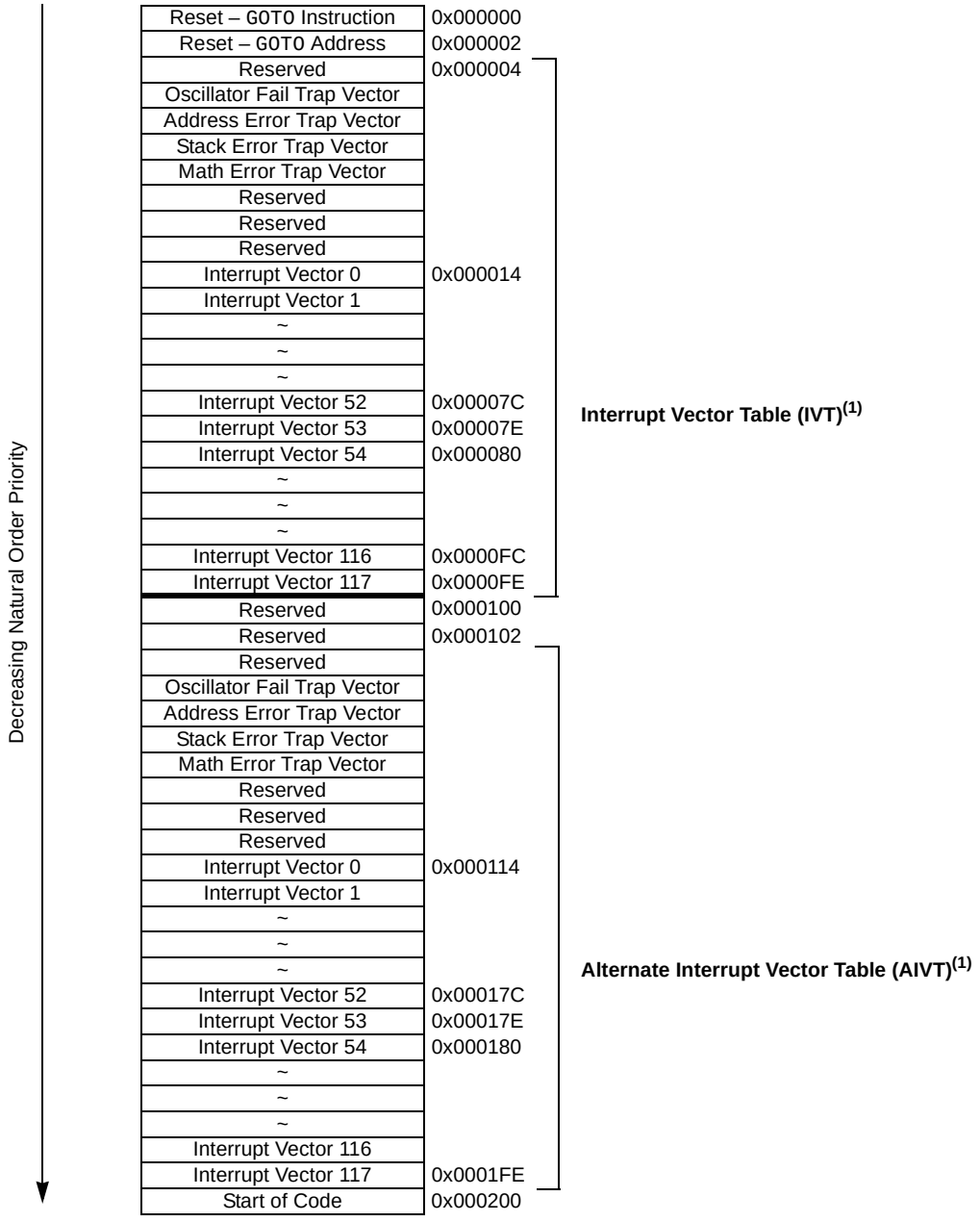
The AIVT supports debugging by providing a way to switch between an application and a support environment without requiring the interrupt vectors to be reprogrammed. This feature also enables switching between applications to facilitate evaluation of different software algorithms at run time. If the AIVT is not needed, the AIVT should be programmed with the same addresses used in the IVT.

## 7.2 Reset Sequence

A device Reset is not a true exception because the interrupt controller is not involved in the Reset process. The dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 devices clear their registers in response to a Reset, forcing the PC to zero. The Digital Signal Controller then begins program execution at location, 0x000000. A `GOTO` instruction at the Reset address can redirect program execution to the appropriate start-up routine.

**Note:** Any unimplemented or unused vector locations in the IVT and AIVT should be programmed with the address of a default interrupt handler routine that contains a `RESET` instruction.

**FIGURE 7-1: dsPIC33FJ16(GP/MC)101/102 AND dsPIC33FJ32(GP/MC)101/102/104 INTERRUPT VECTOR TABLE**




**Note 1:** See Table 7-1 for the list of implemented interrupt vectors.


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**TABLE 7-1: INTERRUPT VECTORS**

| Vector Number | Interrupt Request (IRQ) Number | IVT Address | AIVT Address | Interrupt Source |
|---|---|---|---|---|
| 8 | 0 | 0x000014 | 0x000114 | INT0 – External Interrupt 0 |
| 9 | 1 | 0x000016 | 0x000116 | IC1 – Input Capture 1 |
| 10 | 2 | 0x000018 | 0x000118 | OC1 – Output Compare 1 |
| 11 | 3 | 0x00001A | 0x00011A | T1 – Timer1 |
| 12 | 4 | 0x00001C | 0x00011C | Reserved |
| 13 | 5 | 0x00001E | 0x00011E | IC2 – Input Capture 2 |
| 14 | 6 | 0x000020 | 0x000120 | OC2 – Output Compare 2 |
| 15 | 7 | 0x000022 | 0x000122 | T2 – Timer2 |
| 16 | 8 | 0x000024 | 0x000124 | T3 – Timer3 |
| 17 | 9 | 0x000026 | 0x000126 | SPI1E – SPI1 Error |
| 18 | 10 | 0x000028 | 0x000128 | SPI1 – SPI1 Transfer Done |
| 19 | 11 | 0x00002A | 0x00012A | U1RX – UART1 Receiver |
| 20 | 12 | 0x00002C | 0x00012C | U1TX – UART1 Transmitter |
| 21 | 13 | 0x00002E | 0x00012E | ADC1 – ADC1 |
| 22-23 | 14-15 | 0x000030-0x000032 | 0x000130-0x000132 | Reserved |
| 24 | 16 | 0x000034 | 0x000134 | SI2C1 – I2C1 Slave Events |
| 25 | 17 | 0x000036 | 0x000136 | MI2C1 – I2C1 Master Events |
| 26 | 18 | 0x000038 | 0x000138 | CMP – Comparator Interrupt |
| 27 | 19 | 0x00003A | 0x00013A | Change Notification Interrupt |
| 28 | 20 | 0x00003C | 0x00013C | INT1 – External Interrupt 1 |
| 29-34 | 21-26 | 0x00003E-0x000038 | 0x00013E-0x000138 | Reserved |
| 35 | 27 | 0x00004A | 0x00014A | T4 – Timer4(2) |
| 36 | 28 | 0x00004C | 0x00014C | T5 – Timer5(2) |
| 37 | 29 | 0x00004E | 0x00014E | INT2 – External Interrupt 2 |
| 38-44 | 30-36 | 0x000050-0x00005C | 0x000150-0x00015C | Reserved |
| 45 | 37 | 0x00005E | 0x00015E | IC3 – Input Capture 3 |
| 46-64 | 38-56 | 0x000060-0x000084 | 0x000160-0x000184 | Reserved |
| 65 | 57 | 0x000086 | 0x000186 | PWM1 – PWM1 Period Match(1) |
| 66-69 | 58-61 | 0x000088-0x00008E | 0x000188-0x00018E | Reserved |
| 70 | 62 | 0x000090 | 0x000190 | RTCC – Real-Time Clock and Calendar |
| 71 | 63 | 0x000092 | 0x000192 | $\overline{\text{FLTA1}}$ – PWM1 Fault A(1) |
| 72 | 64 | 0x000094 | 0x000194 | $\overline{\text{FLTB1}}$ – PWM1 Fault B(3) |
| 73 | 65 | 0x000096 | 0x000196 | U1E – UART1 Error |
| 74-84 | 66-76 | 0x000098-0x0000AC | 0x000198-0x0001AC | Reserved |
| 85 | 77 | 0x0000AE | 0x0001AE | CTMU – Charge Time Measurement Unit |
| 86-125 | 78-117 | 0x0000B0-0x0000FE | 0x0001B0-0x0001FE | Reserved |

**Note 1:** This interrupt vector is available in dsPIC33FJ(16/32)MC10X devices only.

**2:** This interrupt vector is available in dsPIC33FJ32(GP/MC)10X devices only.

**3:** This interrupt vector is available in dsPIC33FJ(16/32)MC102/104 devices only.

**TABLE 7-2: TRAP VECTORS**

| Vector Number | IVT Address | AIVT Address | Trap Source |
|---|---|---|---|
| 0 | 0x000004 | 0x000104 | Reserved |
| 1 | 0x000006 | 0x000106 | Oscillator Failure |
| 2 | 0x000008 | 0x000108 | Address Error |
| 3 | 0x00000A | 0x00010A | Stack Error |
| 4 | 0x00000C | 0x00010C | Math Error |
| 5 | 0x00000E | 0x00010E | Reserved |
| 6 | 0x000010 | 0x000110 | Reserved |
| 7 | 0x000012 | 0x000112 | Reserved |

## 7.3 Interrupt Control and Status Registers

The dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 devices implement a total of 26 registers for the interrupt controller:

- INTCON1
- INTCON2
- IFSx
- IECx
- IPCx
- INTTREG

### 7.3.1 INTCON1 AND INTCON2

Global interrupt functions are controlled from INTCON1 and INTCON2. INTCON1 contains the Interrupt Nesting Disable (NSTDIS) bit as well as the control and status flags for the processor trap sources. The INTCON2 register controls the external interrupt request signal behavior and the use of the Alternate Interrupt Vector Table.

### 7.3.2 IFSx Registers

The IFSx registers maintain all of the interrupt request flags. Each source of interrupt has a status bit, which is set by the respective peripherals or external signal and is cleared via software.

### 7.3.3 IECx Registers

The IECx registers maintain all of the interrupt enable bits. These control bits are used to individually enable interrupts from the peripherals or external signals.

### 7.3.4 IPCx Registers

The IPCx registers are used to set the Interrupt Priority Level (IPL) for each source of interrupt. Each user interrupt source can be assigned to one of eight priority levels.

### 7.3.5 INTTREG

The INTTREG register contains the associated interrupt vector number and the new CPU Interrupt Priority Level, which are latched into Vector Number (VECNUM<6:0>) and Interrupt Level (ILR<3:0>) bit fields in the INTTREG register. The new Interrupt Priority Level is the priority of the pending interrupt.

The interrupt sources are assigned to the IFSx, IECx and IPCx registers in the same sequence that they are listed in Table 7-1. For example, the INT0 (External Interrupt 0) is shown as having Vector Number 8 and a natural order priority of 0. Thus, the INT0IF bit is found in IFS0<0>, the INT0IE bit in IEC0<0> and the INT0IPx bits in the first positions of IPC0 (IPC0<2:0>).

### 7.3.6 STATUS/CONTROL REGISTERS

Although they are not specifically part of the interrupt control hardware, two of the CPU Control registers contain bits that control interrupt functionality.

- The CPU STATUS Register, SR, contains the IPL<2:0> bits (SR<7:5>). These bits indicate the current CPU Interrupt Priority Level. The user application can change the current CPU Interrupt Priority Level by writing to the IPLx bits.
- The CORCON register contains the IPL3 bit which, together with IPL<2:0>, also indicates the current CPU Interrupt Priority Level. IPL3 is a read-only bit so that trap events cannot be masked by the user software.

All Interrupt registers are described in Register 7-1 through Register 7-28 on the following pages.


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**REGISTER 7-1: SR: CPU STATUS REGISTER(1)**

| R-0 | R-0 | R/C-0 | R/C-0 | R-0 | R/C-0 | R-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| OA | OB | SA | SB | OAB | SAB | DA | DC |
| bit 15 | | | | | | | bit 8 |

| R/W-0(3) | R/W-0(3) | R/W-0(3) | R-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| **IPL2(2)** | **IPL1(2)** | **IPL0(2)** | RA | N | OV | Z | C |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | C = Clearable bit | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 7-5 **IPL<2:0>:** CPU Interrupt Priority Level Status bits(2,3)
111 = CPU Interrupt Priority Level is 7 (15); user interrupts are disabled
110 = CPU Interrupt Priority Level is 6 (14)
101 = CPU Interrupt Priority Level is 5 (13)
100 = CPU Interrupt Priority Level is 4 (12)
011 = CPU Interrupt Priority Level is 3 (11)
010 = CPU Interrupt Priority Level is 2 (10)
001 = CPU Interrupt Priority Level is 1 (9)
000 = CPU Interrupt Priority Level is 0 (8)

**Note 1:** For complete register details, see Register 3-1.
**2:** The IPL<2:0> bits are concatenated with the IPL<3> bit (CORCON<3>) to form the CPU Interrupt Priority Level. The value in parentheses indicates the IPL if IPL<3> = 1. User interrupts are disabled when IPL<3> = 1.
**3:** The IPL<2:0> Status bits are read-only when NSTDIS (INTCON1<15>) = 1.

**REGISTER 7-2: CORCON: CORE CONTROL REGISTER(1)**

| U-0 | U-0 | U-0 | R/W-0 | R/W-0 | R-0 | R-0 | R-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | US | EDT | DL2 | DL1 | DL0 |
| bit 15 | | | | | | | bit 8 |

| R/W-0 | R/W-0 | R/W-1 | R/W-0 | R/C-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| SATA | SATB | SATDW | ACCSAT | **IPL3(2)** | PSV | RND | IF |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | C = Clearable bit | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 3 **IPL3:** CPU Interrupt Priority Level Status bit 3(2)
1 = CPU Interrupt Priority Level is greater than 7
0 = CPU Interrupt Priority Level is 7 or less

**Note 1:** For complete register details, see Register 3-2.
**2:** The IPL3 bit is concatenated with the IPL<2:0> bits (SR<7:5>) to form the CPU Interrupt Priority Level.

**REGISTER 7-3: INTCON1: INTERRUPT CONTROL REGISTER 1**

| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| NSTDIS | OVAERR | OVBERR | COVAERR | COVBERR | OVATE | OVBTE | COVTE |
| bit 15 | | | | | | | bit 8 |

| R/W-0 | R/W-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | U-0 |
|---|---|---|---|---|---|---|---|
| SFTACERR | DIV0ERR | — | MATHERR | ADDRERR | STKERR | OSCFAIL | — |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15 **NSTDIS:** Interrupt Nesting Disable bit
1 = Interrupt nesting is disabled
0 = Interrupt nesting is enabled

bit 14 **OVAERR:** Accumulator A Overflow Trap Flag bit
1 = Trap was caused by overflow of Accumulator A
0 = Trap was not caused by overflow of Accumulator A

bit 13 **OVBERR:** Accumulator B Overflow Trap Flag bit
1 = Trap was caused by overflow of Accumulator B
0 = Trap was not caused by overflow of Accumulator B

bit 12 **COVAERR:** Accumulator A Catastrophic Overflow Trap Flag bit
1 = Trap was caused by catastrophic overflow of Accumulator A
0 = Trap was not caused by catastrophic overflow of Accumulator A

bit 11 **COVBERR:** Accumulator B Catastrophic Overflow Trap Flag bit
1 = Trap was caused by catastrophic overflow of Accumulator B
0 = Trap was not caused by catastrophic overflow of Accumulator B

bit 10 **OVATE:** Accumulator A Overflow Trap Enable bit
1 = Trap overflow of Accumulator A
0 = Trap is disabled

bit 9 **OVBTE:** Accumulator B Overflow Trap Enable bit
1 = Trap overflow of Accumulator B
0 = Trap is disabled

bit 8 **COVTE:** Catastrophic Overflow Trap Enable bit
1 = Trap on catastrophic overflow of Accumulator A or B is enabled
0 = Trap is disabled

bit 7 **SFTACERR:** Shift Accumulator Error Status bit
1 = Math error trap was caused by an invalid accumulator shift
0 = Math error trap was not caused by an invalid accumulator shift

bit 6 **DIV0ERR:** Arithmetic Error Status bit
1 = Math error trap was caused by a divide-by-zero
0 = Math error trap was not caused by a divide-by-zero

bit 5 **Unimplemented:** Read as ‘0’

bit 4 **MATHERR:** Arithmetic Error Status bit
1 = Math error trap has occurred
0 = Math error trap has not occurred


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**REGISTER 7-3: INTCON1: INTERRUPT CONTROL REGISTER 1 (CONTINUED)**

bit 3 **ADDRERR:** Address Error Trap Status bit
1 = Address error trap has occurred
0 = Address error trap has not occurred

bit 2 **STKERR:** Stack Error Trap Status bit
1 = Stack error trap has occurred
0 = Stack error trap has not occurred

bit 1 **OSCFAIL:** Oscillator Failure Trap Status bit
1 = Oscillator failure trap has occurred
0 = Oscillator failure trap has not occurred

bit 0 **Unimplemented:** Read as '0'

**REGISTER 7-4: INTCON2: INTERRUPT CONTROL REGISTER 2**

| R/W-0 | R-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| ALTIVT | DISI | — | — | — | — | — | — |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | INT2EP | INT1EP | INT0EP |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15 **ALTIVT:** Enable Alternate Interrupt Vector Table bit
1 = Uses Alternate Interrupt Vector Table
0 = Uses standard Interrupt Vector Table (default)

bit 14 **DISI:** DISI Instruction Status bit
1 = DISI instruction is active
0 = DISI instruction is not active

bit 13-3 **Unimplemented:** Read as ‘0’

bit 2 **INT2EP:** External Interrupt 2 Edge Detect Polarity Select bit
1 = Interrupt on negative edge
0 = Interrupt on positive edge

bit 1 **INT1EP:** External Interrupt 1 Edge Detect Polarity Select bit
1 = Interrupt on negative edge
0 = Interrupt on positive edge

bit 0 **INT0EP:** External Interrupt 0 Edge Detect Polarity Select bit
1 = Interrupt on negative edge
0 = Interrupt on positive edge


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**REGISTER 7-5: IFS0: INTERRUPT FLAG STATUS REGISTER 0**

| U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | AD1IF | U1TXIF | U1RXIF | SPI1IF | SPI1EIF | T3IF |
| bit 15 | | | | | | | bit 8 |

| R/W-0 | R/W-0 | R/W-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| T2IF | OC2IF | IC2IF | — | T1IF | OC1IF | IC1IF | INT0IF |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15-14 **Unimplemented:** Read as '0'

bit 13 **AD1IF:** ADC1 Conversion Complete Interrupt Flag Status bit
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

bit 12 **U1TXIF:** UART1 Transmitter Interrupt Flag Status bit
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

bit 11 **U1RXIF:** UART1 Receiver Interrupt Flag Status bit
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

bit 10 **SPI1IF:** SPI1 Event Interrupt Flag Status bit
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

bit 9 **SPI1EIF:** SPI1 Fault Interrupt Flag Status bit
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

bit 8 **T3IF:** Timer3 Interrupt Flag Status bit
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

bit 7 **T2IF:** Timer2 Interrupt Flag Status bit
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

bit 6 **OC2IF:** Output Compare Channel 2 Interrupt Flag Status bit
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

bit 5 **IC2IF:** Input Capture Channel 2 Interrupt Flag Status bit
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

bit 4 **Unimplemented:** Read as '0'

bit 3 **T1IF:** Timer1 Interrupt Flag Status bit
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

**REGISTER 7-5: IFS0: INTERRUPT FLAG STATUS REGISTER 0 (CONTINUED)**

bit 2 **OC1IF:** Output Compare Channel 1 Interrupt Flag Status bit
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

bit 1 **IC1IF:** Input Capture Channel 1 Interrupt Flag Status bit
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

bit 0 **INT0IF:** External Interrupt 0 Flag Status bit
1 = Interrupt request has occurred
0 = Interrupt request has not occurred


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**REGISTER 7-6: IFS1: INTERRUPT FLAG STATUS REGISTER 1**

| U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | — | INT2IF | T5IF(1) | T4IF(1) | — | — | — |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | INT1IF | CNIF | CMIF | MI2C1IF | SI2C1IF |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15-14 **Unimplemented:** Read as '0'

bit 13 **INT2IF:** External Interrupt 2 Flag Status bit
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

bit 12 **T5IF:** Timer5 Interrupt Flag Status bit(1)
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

bit 11 **T4IF:** Timer4 Interrupt Flag Status bit(1)
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

bit 10-5 **Unimplemented:** Read as '0'

bit 4 **INT1IF:** External Interrupt 1 Flag Status bit
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

bit 3 **CNIF:** Input Change Notification Interrupt Flag Status bit
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

bit 2 **CMIF:** Comparator Interrupt Flag Status bit
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

bit 1 **MI2C1IF:** I2C1 Master Events Interrupt Flag Status bit
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

bit 0 **SI2C1IF:** I2C1 Slave Events Interrupt Flag Status bit
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

**Note 1:** These bits are available in dsPIC33FJ32(GP/MC)10X devices only.

**REGISTER 7-7: IFS2: INTERRUPT FLAG STATUS REGISTER 2**

| U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | — | — | — |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | R/W-0 | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | — | IC3IF | — | — | — | — | — |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15-6 **Unimplemented:** Read as '0'

bit 5 **IC3IF:** Input Capture Channel 3 Interrupt Flag Status bit
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

bit 4-0 **Unimplemented:** Read as '0'

**REGISTER 7-8: IFS3: INTERRUPT FLAG STATUS REGISTER 3**

| R/W-0 | R/W-0 | U-0 | U-0 | U-0 | U-0 | R/W-0 | U-0 |
|---|---|---|---|---|---|---|---|
| FLTA1IF(1) | RTCIF | — | — | — | — | PWM1IF(1) | — |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | — | — | — |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15 **FLTA1IF:** PWM1 Fault A Interrupt Flag Status bit(1)
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

bit 14 **RTCIF:** RTCC Interrupt Flag Status bit
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

bit 13-10 **Unimplemented:** Read as '0'

bit 9 **PWM1IF:** PWM1 Interrupt Flag Status bit(1)
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

bit 8-0 **Unimplemented:** Read as '0'

**Note 1:** These bits are available in dsPIC(16/32)MC10X devices only.


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**REGISTER 7-9: IFS4: INTERRUPT FLAG STATUS REGISTER 4**

| U-0 | U-0 | R/W-0 | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | — | CTMUIF | — | — | — | — | — |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | — | U1EIF | FLTB1IF(1) |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15-14 **Unimplemented:** Read as '0'

bit 13 **CTMUIF:** CTMU Interrupt Flag Status bit
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

bit 12-2 **Unimplemented:** Read as '0'

bit 1 **U1EIF:** UART1 Error Interrupt Flag Status bit
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

bit 0 **FLTB1IF:** PWM1 Fault B Interrupt Flag Status bit(1)
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

**Note 1:** This bit is available in dsPIC(16/32)MC102/104 devices only.

**REGISTER 7-10: IEC0: INTERRUPT ENABLE CONTROL REGISTER 0**

| U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | AD1IE | U1TXIE | U1RXIE | SPI1IE | SPI1EIE | T3IE |
| bit 15 | | | | | | | bit 8 |

| R/W-0 | R/W-0 | R/W-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| T2IE | OC2IE | IC2IE | — | T1IE | OC1IE | IC1IE | INT0IE |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15-14 **Unimplemented:** Read as '0'

bit 13 **AD1IE:** ADC1 Conversion Complete Interrupt Enable bit
1 = Interrupt request is enabled
0 = Interrupt request is not enabled

bit 12 **U1TXIE:** UART1 Transmitter Interrupt Enable bit
1 = Interrupt request is enabled
0 = Interrupt request is not enabled

bit 11 **U1RXIE:** UART1 Receiver Interrupt Enable bit
1 = Interrupt request is enabled
0 = Interrupt request is not enabled

bit 10 **SPI1IE:** SPI1 Event Interrupt Enable bit
1 = Interrupt request is enabled
0 = Interrupt request is not enabled

bit 9 **SPI1EIE:** SPI1 Error Interrupt Enable bit
1 = Interrupt request is enabled
0 = Interrupt request is not enabled

bit 8 **T3IE:** Timer3 Interrupt Enable bit
1 = Interrupt request is enabled
0 = Interrupt request is not enabled

bit 7 **T2IE:** Timer2 Interrupt Enable bit
1 = Interrupt request is enabled
0 = Interrupt request is not enabled

bit 6 **OC2IE:** Output Compare Channel 2 Interrupt Enable bit
1 = Interrupt request is enabled
0 = Interrupt request is not enabled

bit 5 **IC2IE:** Input Capture Channel 2 Interrupt Enable bit
1 = Interrupt request is enabled
0 = Interrupt request is not enabled

bit 4 **Unimplemented:** Read as '0'

bit 3 **T1IE:** Timer1 Interrupt Enable bit
1 = Interrupt request is enabled
0 = Interrupt request is not enabled

bit 2 **OC1IE:** Output Compare Channel 1 Interrupt Enable bit
1 = Interrupt request is enabled
0 = Interrupt request is not enabled

bit 1 **IC1IE:** Input Capture Channel 1 Interrupt Enable bit
1 = Interrupt request is enabled
0 = Interrupt request is not enabled

bit 0 **INT0IE:** External Interrupt 0 Enable bit
1 = Interrupt request is enabled
0 = Interrupt request is not enabled


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**REGISTER 7-11: IEC1: INTERRUPT ENABLE CONTROL REGISTER 1**

| U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | — | INT2IE | T5IE(1) | T4IE(1) | — | — | — |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | INT1IE | CNIE | CMIE | MI2C1IE | SI2C1IE |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15-14 **Unimplemented:** Read as ‘0’

bit 13 **INT2IE:** External Interrupt 2 Enable bit
1 = Interrupt request is enabled
0 = Interrupt request is not enabled

bit 12 **T5IE:** Timer5 Interrupt Enable bit(1)
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

bit 11 **T4IE:** Timer4 Interrupt Enable bit(1)
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

bit 10-5 **Unimplemented:** Read as ‘0’

bit 4 **INT1IE:** External Interrupt 1 Enable bit
1 = Interrupt request is enabled
0 = Interrupt request is not enabled

bit 3 **CNIE:** Input Change Notification Interrupt Enable bit
1 = Interrupt request is enabled
0 = Interrupt request is not enabled

bit 2 **CMIE:** Comparator Interrupt Enable bit
1 = Interrupt request is enabled
0 = Interrupt request is not enabled

bit 1 **MI2C1IE:** I2C1 Master Events Interrupt Enable bit
1 = Interrupt request is enabled
0 = Interrupt request is not enabled

bit 0 **SI2C1IE:** I2C1 Slave Events Interrupt Enable bit
1 = Interrupt request is enabled
0 = Interrupt request is not enabled

**Note 1:** These bits are available in dsPIC33FJ32(GP/MC)10X devices only.

**REGISTER 7-12: IEC2: INTERRUPT ENABLE CONTROL REGISTER 2**

| U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | — | — | — |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | R/W-0 | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | — | IC3IE | — | — | — | — | — |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15-6 **Unimplemented:** Read as '0'

bit 5 **IC3IE:** Input Capture Channel 3 Interrupt Enable bit
1 = Interrupt request is enabled
0 = Interrupt request is not enabled

bit 4-0 **Unimplemented:** Read as '0'

**REGISTER 7-13: IEC3: INTERRUPT ENABLE CONTROL REGISTER 3**

| R/W-0 | R/W-0 | U-0 | U-0 | U-0 | U-0 | R/W-0 | U-0 |
|---|---|---|---|---|---|---|---|
| FLTA1IE(1) | RTCIE | — | — | — | — | PWM1IE(1) | — |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | — | — | — |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15 **FLTA1IE:** PWM1 Fault A Interrupt Enable bit(1)
1 = Interrupt request is enabled
0 = Interrupt request is not enabled

bit 14 **RTCIE:** RTCC Interrupt Enable bit
1 = Interrupt request is enabled
0 = Interrupt request is not enabled

bit 13-10 **Unimplemented:** Read as '0'

bit 9 **PWM1IE:** PWM1 Interrupt Enable bit(1)
1 = Interrupt request is enabled
0 = Interrupt request is not enabled

bit 8-0 **Unimplemented:** Read as '0'

**Note 1:** These bits are available in dsPIC(16/32)MC10X devices only.


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**REGISTER 7-14: IEC4: INTERRUPT ENABLE CONTROL REGISTER 4**

| U-0 | U-0 | R/W-0 | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | — | CTMUIE | — | — | — | — | — |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | — | U1EIE | FLTB1IE(1) |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15-14 **Unimplemented:** Read as ‘0’

bit 13 **CTMUIE:** CTMU Interrupt Enable bit
1 = Interrupt request is enabled
0 = Interrupt request is not enabled

bit 12-2 **Unimplemented:** Read as ‘0’

bit 1 **U1EIE:** UART1 Error Interrupt Enable bit
1 = Interrupt request is enabled
0 = Interrupt request is not enabled

bit 0 **FLTB1IE:** PWM1 Fault B Interrupt Enable bit(1)
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

**Note 1:** This bit is available in dsPIC(16/32)MC102/104 devices only.

**REGISTER 7-15: IPC0: INTERRUPT PRIORITY CONTROL REGISTER 0**

| U-0 | R/W-1 | R/W-0 | R/W-0 | U-0 | R/W-1 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | T1IP2 | T1IP1 | T1IP0 | — | OC1IP2 | OC1IP1 | OC1IP0 |
| bit 15 | | | | | | | bit 8 |

| U-0 | R/W-1 | R/W-0 | R/W-0 | U-0 | R/W-1 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | IC1IP2 | IC1IP1 | IC1IP0 | — | INT0IP2 | INT0IP1 | INT0IP0 |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15 **Unimplemented:** Read as '0'

bit 14-12 **T1IP<2:0>:** Timer1 Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 11 **Unimplemented:** Read as '0'

bit 10-8 **OC1IP<2:0>:** Output Compare Channel 1 Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 7 **Unimplemented:** Read as '0'

bit 6-4 **IC1IP<2:0>:** Input Capture Channel 1 Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 3 **Unimplemented:** Read as '0'

bit 2-0 **INT0IP<2:0>:** External Interrupt 0 Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled


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**REGISTER 7-16: IPC1: INTERRUPT PRIORITY CONTROL REGISTER 1**

| U-0 | R/W-1 | R/W-0 | R/W-0 | U-0 | R/W-1 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | T2IP2 | T2IP1 | T2IP0 | — | OC2IP2 | OC2IP1 | OC2IP0 |
| bit 15 | | | | | | | bit 8 |

| U-0 | R/W-1 | R/W-0 | R/W-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | IC2IP2 | IC2IP1 | IC2IP0 | — | — | — | — |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15 **Unimplemented:** Read as ‘0’

bit 14-12 **T2IP<2:0>:** Timer2 Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 11 **Unimplemented:** Read as ‘0’

bit 10-8 **OC2IP<2:0>:** Output Compare Channel 2 Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 7 **Unimplemented:** Read as ‘0’

bit 6-4 **IC2IP<2:0>:** Input Capture Channel 2 Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 3-0 **Unimplemented:** Read as ‘0’

**REGISTER 7-17: IPC2: INTERRUPT PRIORITY CONTROL REGISTER 2**

| U-0 | R/W-1 | R/W-0 | R/W-0 | U-0 | R/W-1 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | U1RXIP2 | U1RXIP1 | U1RXIP0 | — | SPI1IP2 | SPI1IP1 | SPI1IP0 |
| bit 15 | | | | | | | bit 8 |

| U-0 | R/W-1 | R/W-0 | R/W-0 | U-0 | R/W-1 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | SPI1EIP2 | SPI1EIP1 | SPI1EIP0 | — | T3IP2 | T3IP1 | T3IP0 |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15 **Unimplemented:** Read as ‘0’

bit 14-12 **U1RXIP<2:0>:** UART1 Receiver Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 11 **Unimplemented:** Read as ‘0’

bit 10-8 **SPI1IP<2:0>:** SPI1 Event Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 7 **Unimplemented:** Read as ‘0’

bit 6-4 **SPI1EIP<2:0>:** SPI1 Error Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 3 **Unimplemented:** Read as ‘0’

bit 2-0 **T3IP<2:0>:** Timer3 Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled


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**REGISTER 7-18: IPC3: INTERRUPT PRIORITY CONTROL REGISTER 3**

| U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | — | — | — |
| bit 15 | | | | | | | bit 8 |

| U-0 | R/W-1 | R/W-0 | R/W-0 | U-0 | R/W-1 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | AD1IP2 | AD1IP1 | AD1IP0 | — | U1TXIP2 | U1TXIP1 | U1TXIP0 |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15-7 **Unimplemented:** Read as ‘0’

bit 6-4 **AD1IP<2:0>:** ADC1 Conversion Complete Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 3 **Unimplemented:** Read as ‘0’

bit 2-0 **U1TXIP<2:0>:** UART1 Transmitter Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

**REGISTER 7-19: IPC4: INTERRUPT PRIORITY CONTROL REGISTER 4**

| U-0 | R/W-1 | R/W-0 | R/W-0 | U-0 | R/W-1 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | CNIP2 | CNIP1 | CNIP0 | — | CMIP2 | CMIP1 | CMIP0 |
| bit 15 | | | | | | | bit 8 |

| U-0 | R/W-1 | R/W-0 | R/W-0 | U-0 | R/W-1 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | MI2C1IP2 | MI2C1IP1 | MI2C1IP0 | — | SI2C1IP2 | SI2C1IP1 | SI2C1IP0 |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15 **Unimplemented:** Read as ‘0’

bit 14-12 **CNIP<2:0>:** Change Notification Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 11 **Unimplemented:** Read as ‘0’

bit 10-8 **CMIP<2:0>:** Comparator Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 7 **Unimplemented:** Read as ‘0’

bit 6-4 **MI2C1IP<2:0>:** I2C1 Master Events Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 3 **Unimplemented:** Read as ‘0’

bit 2-0 **SI2C1IP<2:0>:** I2C1 Slave Events Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled


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**REGISTER 7-20: IPC5: INTERRUPT PRIORITY CONTROL REGISTER 5**

| U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | — | — | — |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | U-0 | U-0 | R/W-1 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | INT1IP2 | INT1IP1 | INT1IP0 |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15-3 **Unimplemented:** Read as ‘0’

bit 2-0 **INT1IP<2:0>:** External Interrupt 1 Priority bits

111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

**REGISTER 7-21: IPC6: INTERRUPT PRIORITY CONTROL REGISTER 6**

| U-0 | R/W-1 | R/W-0 | R/W-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | T4IP2(1) | T4IP1(1) | T4IP0(1) | — | — | — | — |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | — | — | — |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15 **Unimplemented:** Read as ‘0’

bit 14-12 **T4IP<2:0>:** Timer4 Interrupt Priority bits(1)

111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 11-0 **Unimplemented:** Read as ‘0’

**Note 1:** These bits are available in dsPIC33FJ32(GP/MC)10X devices only.

**REGISTER 7-22: IPC7: INTERRUPT PRIORITY CONTROL REGISTER 7**

| U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | — | — | — |
| bit 15 | | | | | | | bit 8 |

| U-0 | R/W-1 | R/W-0 | R/W-0 | U-0 | R/W-1 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | INT2IP2 | INT2IP1 | INT2IP0 | — | T5IP2(1) | T5IP1(1) | T5IP0(1) |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15-7 **Unimplemented:** Read as ‘0’

bit 6-4 **INT2IP<2:0>:** External Interrupt 2 Priority bits

111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 3 **Unimplemented:** Read as ‘0’

bit 2-0 **T5IP<2:0>:** Timer5 Interrupt Priority bits(1)

111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

**Note 1:** These bits are available in dsPIC33FJ32(GP/MC)10X devices only.


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**REGISTER 7-23: IPC9: INTERRUPT PRIORITY CONTROL REGISTER 9**

| U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | — | — | — |
| bit 15 | | | | | | | bit 8 |

| U-0 | R/W-1 | R/W-0 | R/W-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | IC3IP2 | IC3IP1 | IC3IP0 | — | — | — | — |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15-7 **Unimplemented:** Read as ‘0’

bit 6-4 **IC3IP<2:0>:** External Interrupt 3 Priority bits

111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 3-0 **Unimplemented:** Read as ‘0’

**REGISTER 7-24: IPC14: INTERRUPT PRIORITY CONTROL REGISTER 14**

| U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | — | — | — |
| bit 15 | | | | | | | bit 8 |

| U-0 | R/W-1 | R/W-0 | R/W-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | PWM1IP2(1) | PWM1IP1(1) | PWM1IP0(1) | — | — | — | — |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15-7 **Unimplemented:** Read as ‘0’

bit 6-4 **PWM1IP<2:0>:** PWM1 Interrupt Priority bits(1)

111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 3-0 **Unimplemented:** Read as ‘0’

**Note 1:** These bits are available in dsPIC(16/32)MC10X devices only.

**REGISTER 7-25: IPC15: INTERRUPT PRIORITY CONTROL REGISTER 15**

| U-0 | R/W-1 | R/W-0 | R/W-0 | U-0 | R/W-1 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | FLTA1IP2(1) | FLTA1IP1(1) | FLTA1IP0(1) | — | RTCIP2 | RTCIP1 | RTCIP0 |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | — | — | — |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15 **Unimplemented:** Read as '0'

bit 14-12 **FLTA1IP<2:0>:** PWM1 Fault A Interrupt Priority bits(1)
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 11 **Unimplemented:** Read as '0'

bit 10-8 **RTCIP<2:0>:** RTCC Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 7-0 **Unimplemented:** Read as '0'

**Note 1:** These bits are available in dsPIC(16/32)MC10X devices only.


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**REGISTER 7-26: IPC16: INTERRUPT PRIORITY CONTROL REGISTER 16**

| U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | — | — | — |
| bit 15 | | | | | | | bit 8 |

| U-0 | R/W-1 | R/W-0 | R/W-0 | U-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | U1EIP2 | U1EIP1 | U1EIP0 | — | FLTB1IP2(1) | FLTB1IP1(1) | FLTB1IP0(1) |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15-7 **Unimplemented:** Read as ‘0’

bit 6-4 **U1EIP<2:0>:** UART1 Error Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 3 **Unimplemented:** Read as ‘0’

bit 2-0 **FLTB1IP<2:0>:** PWM1 Fault B Interrupt Priority bits(1)
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

**Note 1:** These bits are available in dsPIC(16/32)MC102/104 devices only.

**REGISTER 7-27: IPC19: INTERRUPT PRIORITY CONTROL REGISTER 19**

| U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | — | — | — |
| bit 15 | | | | | | | bit 8 |

| U-0 | R/W-1 | R/W-0 | R/W-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | CTMUIP2 | CTMUIP1 | CTMUIP0 | — | — | — | — |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15-7 **Unimplemented:** Read as ‘0’

bit 6-4 **CTMUIP<2:0>:** CTMU Interrupt Priority bits
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 3-0 **Unimplemented:** Read as ‘0’


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**REGISTER 7-28: INTTREG: INTERRUPT CONTROL AND STATUS REGISTER**

| U-0 | U-0 | U-0 | U-0 | R-0 | R-0 | R-0 | R-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | ILR3 | ILR2 | ILR1 | ILR0 |
| bit 15 | | | | | | | bit 8 |

| U-0 | R-0 | R-0 | R-0 | R-0 | R-0 | R-0 | R-0 |
|---|---|---|---|---|---|---|---|
| — | VECNUM6 | VECNUM5 | VECNUM4 | VECNUM3 | VECNUM2 | VECNUM1 | VECNUM0 |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15-12 **Unimplemented:** Read as ‘0’

bit 11-8 **ILR<3:0>:** New CPU Interrupt Priority Level bits
1111 = CPU Interrupt Priority Level is 15
•
•
•
0001 = CPU Interrupt Priority Level is 1
0000 = CPU Interrupt Priority Level is 0

bit 7 **Unimplemented:** Read as ‘0’

bit 6-0 **VECNUM<6:0>:** Vector Number of Pending Interrupt bits
0111111 = Interrupt vector pending is Number 135
•
•
•
0000001 = Interrupt vector pending is Number 9
0000000 = Interrupt vector pending is Number 8

## 7.4 Interrupt Setup Procedures

### 7.4.1 INITIALIZATION

To configure an interrupt source at initialization:

1. Set the NSTDIS bit (INTCON1<15>) if nested interrupts are not desired.
2. Select the user-assigned priority level for the interrupt source by writing the control bits into the appropriate IPCx register. The priority level will depend on the specific application and type of interrupt source. If multiple priority levels are not desired, the IPCx register control bits for all enabled interrupt sources can be programmed to the same non-zero value.

   **Note:** At a device Reset, the IPCx registers are initialized such that all user interrupt sources are assigned to Interrupt Priority Level 4.
3. Clear the interrupt flag status bit associated with the peripheral in the associated IFSx register.
4. Enable the interrupt source by setting the interrupt enable control bit associated with the source in the appropriate IECx register.

### 7.4.2 INTERRUPT SERVICE ROUTINE

The method used to declare an ISR and initialize the IVT with the correct vector address depends on the programming language (C or assembler), and the language development toolsuite used to develop the application.

In general, the user application must clear the interrupt flag in the appropriate IFSx register for the source of interrupt that the ISR handles. Otherwise, the program will re-enter the ISR immediately after exiting the routine. If the ISR is coded in assembly language, it must be terminated using a `RETFIE` instruction to unstack the saved PC value, SRL value and old CPU priority level.

### 7.4.3 TRAP SERVICE ROUTINE

A Trap Service Routine (TSR) is coded like an ISR, except that the appropriate trap status flag in the INTCON1 register must be cleared to avoid re-entry into the TSR.

### 7.4.4 INTERRUPT DISABLE

All user interrupts can be disabled using this procedure:

1. Push the current SR value onto the software stack using the `PUSH` instruction.
2. Force the CPU to Priority Level 7 by inclusive ORing the value OEh with SRL.

To enable user interrupts, the `POP` instruction can be used to restore the previous SR value.

**Note:** Only user interrupts with a priority level of 7 or lower can be disabled. Trap sources (Level 8-Level 15) cannot be disabled.

The `DISI` instruction provides a convenient way to disable interrupts of Priority Levels 1-6 for a fixed period of time. Level 7 interrupt sources are not disabled by the `DISI` instruction.


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## 8.0 OSCILLATOR CONFIGURATION

**Note 1:** This data sheet summarizes the features of the dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 family devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **"Oscillator (Part VI)"** (DS70644) in the *"dsPIC33/PIC24 Family Reference Manual"*, which is available from the Microchip web site (www.microchip.com).

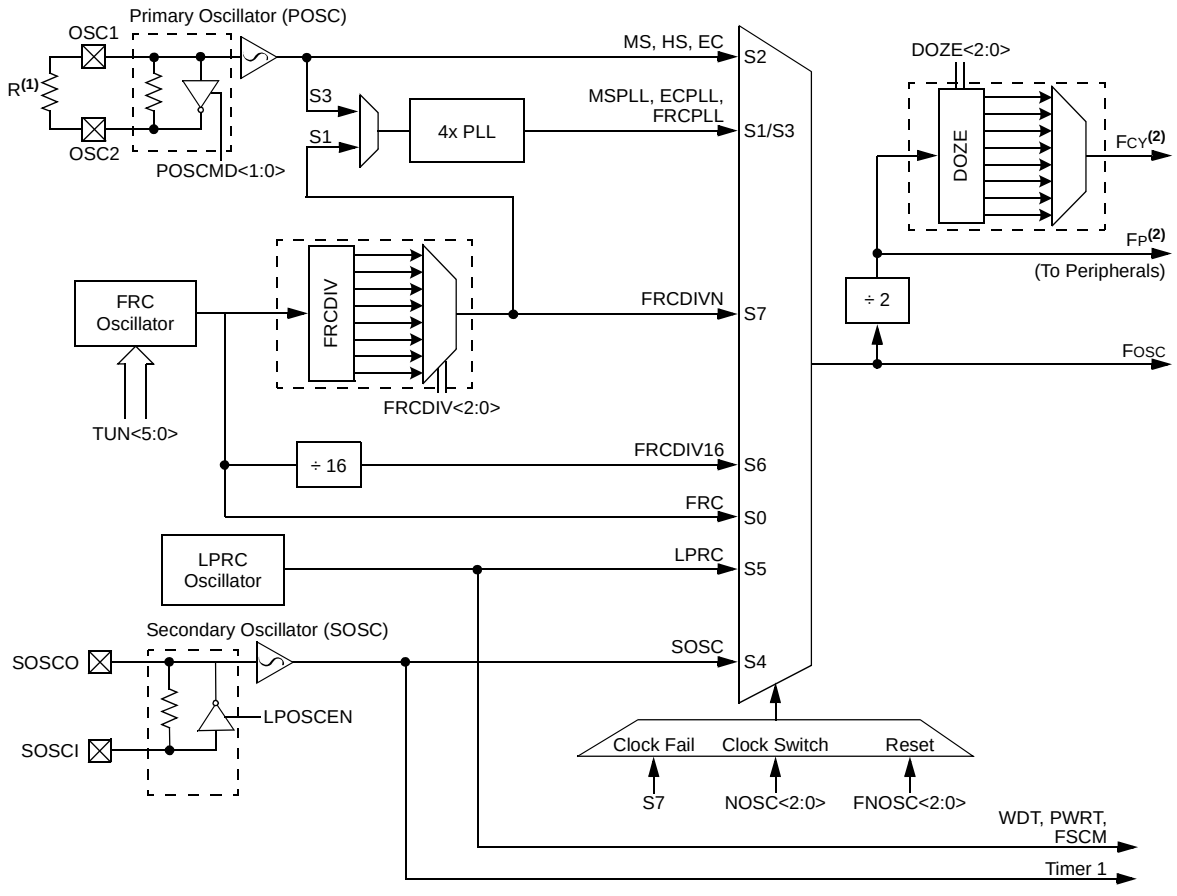
**2:** Some registers and associated bits described in this section may not be available on all devices. Refer to **Section 4.0 "Memory Organization"** in this data sheet for device-specific register and bit information.

The oscillator system for dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 devices provides:

- External and internal oscillator options as clock sources
- An on-chip, 4x Phase Lock Loop (PLL) to scale the internal operating frequency to the required system clock frequency
- An internal FRC oscillator that can also be used with the PLL, thereby allowing full-speed operation without any external clock generation hardware
- Clock switching between various clock sources
- Programmable clock postscaler for system power savings
- A Fail-Safe Clock Monitor (FSCM) that detects clock failure and takes fail-safe measures
- An Oscillator Control register (OSCCON)
- Nonvolatile Configuration bits for main oscillator selection

A simplified diagram of the oscillator system is shown in Figure 8-1.

**FIGURE 8-1: OSCILLATOR SYSTEM DIAGRAM**




**Note 1:** If the oscillator is used with MS or HS modes, an extended parallel resistor with the value of 1 MΩ must be connected.

**2:** The term, FP, refers to the clock source for all peripherals, while FCY refers to the clock source for the CPU. Throughout this document, FCY and FP are used interchangeably, except in the case of Doze mode. FP and FCY will be different when Doze mode is used with a Doze ratio of 1:2 or lower.

## 8.1 CPU Clocking System

The dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 devices provide seven system clock options:

- Fast RC (FRC) Oscillator
- FRC Oscillator with 4x PLL
- Primary (MS, HS or EC) Oscillator
- Primary Oscillator with 4x PLL
- Secondary (LP) Oscillator
- Low-Power RC (LPRC) Oscillator
- FRC Oscillator with postscaler

### 8.1.1 SYSTEM CLOCK SOURCES

#### 8.1.1.1 Fast RC

The Fast RC (FRC) internal oscillator runs at a nominal frequency of 7.37 MHz. User software can tune the FRC frequency. User software can optionally specify a factor (ranging from 1:2 to 1:256) by which the FRC clock frequency is divided. This factor is selected using the FRCDIV<2:0> (CLKDIV<10:8>) bits.

The FRC frequency depends on the FRC accuracy (see Table 26-18) and the value of the FRC Oscillator Tuning register (see Register 8-3).

#### 8.1.1.2 Primary

The primary oscillator can use one of the following as its clock source:

- MS (Crystal): Crystals and ceramic resonators in the range of 4 MHz to 10 MHz. The crystal is connected to the OSC1 and OSC2 pins.
- HS (High-Speed Crystal): Crystals in the range of 10 MHz to 32 MHz. The crystal is connected to the OSC1 and OSC2 pins.
- EC (External Clock): The external clock signal is directly applied to the OSC1 pin.

#### 8.1.1.3 Secondary

The secondary (LP) oscillator is designed for low power and uses a 32.768 kHz crystal or ceramic resonator. The LP oscillator uses the SOSCI and SOSCO pins.

#### 8.1.1.4 Low-Power RC

The Low-Power RC (LPRC) internal oscillator runs at a nominal frequency of 32.768 kHz. It is also used as a reference clock by the Watchdog Timer (WDT) and Fail-Safe Clock Monitor (FSCM).

#### 8.1.1.5 PLL

The clock signals generated by the FRC and primary oscillators can be optionally applied to an on-chip, 4x Phase Lock Loop (PLL) to provide faster output frequencies for device operation. PLL configuration is described in **Section 8.1.3 "PLL Configuration"**.

### 8.1.2 SYSTEM CLOCK SELECTION

The oscillator source used at a device Power-on Reset event is selected using Configuration bit settings. The Oscillator Configuration bit settings are located in the Configuration registers in the program memory. (Refer to **Section 23.1 "Configuration Bits"** for further details.) The initial Oscillator Selection Configuration bits, FNOSC<2:0> (FOSCSEL<2:0>), and the Primary Oscillator Mode Select Configuration bits, POSCMD<1:0> (FOSC<1:0>), select the oscillator source that is used at a Power-on Reset. The FRC primary oscillator is the default (unprogrammed) selection.

The Configuration bits allow users to choose among 12 different clock modes, shown in Table 8-1.

The output of the oscillator (or the output of the PLL if a PLL mode has been selected) FOSC is divided by 2 to generate the device instruction clock (FCY) and the peripheral clock time base (FP). FCY defines the operating speed of the device, and speeds up to 16 MHz are supported by the dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 architecture.

Instruction execution speed or device operating frequency, FCY, is given by:

**EQUATION 8-1: DEVICE OPERATING FREQUENCY**

$$F_{CY} = \frac{F_{OSC}}{2}$$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### 8.1.3 PLL CONFIGURATION

The primary oscillator and internal FRC oscillator can optionally use an on-chip, 4x PLL to obtain higher speeds of operation.

For example, suppose an 8 MHz crystal is being used with the selected oscillator mode of MS with PLL. This provides a FOSC of 8 MHz * 4 = 32 MHz. The resultant device operating speed is 32/2 = 16 MIPS.

**EQUATION 8-2: MS WITH PLL MODE EXAMPLE**

$$F_{CY} = \frac{F_{OSC}}{2} = \frac{1}{2}(8000000 \bullet 4) = 16 \text{ MIPS}$$

**TABLE 8-1: CONFIGURATION BIT VALUES FOR CLOCK SELECTION**

| Oscillator Mode | Oscillator Source | POSCMD<1:0> | FNOSC<2:0> | See Note |
|---|---|---|---|---|
| Fast RC Oscillator with Divide-by-n (FRCDIVN) | Internal | xx | 111 | 1, 2 |
| Fast RC Oscillator with Divide-by-16 (FRCDIV16) | Internal | xx | 110 | 1 |
| Low-Power RC Oscillator (LPRC) | Internal | xx | 101 | 1 |
| Secondary (Timer1) Oscillator (SOSC) | Secondary | xx | 100 | 1 |
| Primary Oscillator (MS) with PLL (MSPLL) | Primary | 01 | 011 | |
| Primary Oscillator (EC) with PLL (ECPLL) | Primary | 00 | 011 | 1 |
| Primary Oscillator (HS) | Primary | 10 | 010 | |
| Primary Oscillator (MS) | Primary | 01 | 010 | |
| Primary Oscillator (EC) | Primary | 00 | 010 | 1 |
| Fast RC Oscillator (FRC) with Divide-by-n and PLL (FRCPLL) | Internal | xx | 001 | 1 |
| Fast RC Oscillator (FRC) | Internal | xx | 000 | 1 |

**Note 1:** OSC2 pin function is determined by the OSCIOFNC Configuration bit.

**2:** This is the default oscillator mode for an unprogrammed (erased) device.

## 8.2 Oscillator Control Registers

**REGISTER 8-1: OSCCON: OSCILLATOR CONTROL REGISTER(1)**

| U-0 | R-0 | R-0 | R-0 | U-0 | R/W-y | R/W-y | R/W-y |
|---|---|---|---|---|---|---|---|
| — | COSC2 | COSC1 | COSC0 | — | NOSC2(2) | NOSC1(2) | NOSC0(2) |
| bit 15 | | | | | | | bit 8 |

| R/W-0 | R/W-0 | R-0 | U-0 | R/C-0 | U-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| CLKLOCK | IOLOCK | LOCK | — | CF | — | LPOSCEN | OSWEN |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | C = Clearable bit | y = Value set from Configuration bits on POR | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15 **Unimplemented:** Read as '0'

bit 14-12 **COSC<2:0>:** Current Oscillator Selection bits (read-only)
111 = Fast RC Oscillator (FRC) with Divide-by-n
110 = Fast RC Oscillator (FRC) with Divide-by-16
101 = Low-Power RC Oscillator (LPRC)
100 = Secondary Oscillator (SOSC)
011 = Primary Oscillator (MS, EC) with PLL
010 = Primary Oscillator (MS, HS, EC)
001 = Fast RC Oscillator (FRC) with Divide-by-n and PLL (FRCPLL)
000 = Fast RC Oscillator (FRC)

bit 11 **Unimplemented:** Read as '0'

bit 10-8 **NOSC<2:0>:** New Oscillator Selection bits(2)
111 = Fast RC Oscillator (FRC) with Divide-by-n
110 = Fast RC Oscillator (FRC) with Divide-by-16
101 = Low-Power RC Oscillator (LPRC)
100 = Secondary Oscillator (SOSC)
011 = Primary Oscillator (MS, EC) with PLL
010 = Primary Oscillator (MS, HS, EC)
001 = Fast RC Oscillator (FRC) with Divide-by-n and PLL (FRCPLL)
000 = Fast RC Oscillator (FRC)

bit 7 **CLKLOCK:** Clock Lock Enable bit
If Clock Switching is Enabled and FSCM is Disabled (FCKSM<1:0> (FOSC<7:6>) = 0b01):
1 = Clock switching is disabled, system clock source is locked
0 = Clock switching is enabled, system clock source can be modified by clock switching

bit 6 **IOLOCK:** Peripheral Pin Select Lock bit
1 = Peripheral Pin Select is locked, a write to Peripheral Pin Select registers is not allowed
0 = Peripheral Pin Select is not locked, a write to Peripheral Pin Select registers is allowed

bit 5 **LOCK:** PLL Lock Status bit (read-only)
1 = Indicates that PLL is in lock or PLL start-up timer is satisfied
0 = Indicates that PLL is out of lock, start-up timer is in progress or PLL is disabled

bit 4 **Unimplemented:** Read as '0'

**Note 1:** Writes to this register require an unlock sequence. Refer to **"Oscillator (Part VI)"** (DS70644) in the *"dsPIC33/PIC24 Family Reference Manual"* for details.

**2:** Direct clock switches between any primary oscillator mode with PLL and FRCPLL mode are not permitted. This applies to clock switches in either direction. In these instances, the application must switch to FRC mode as a transitional clock source between the two PLL modes.


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**REGISTER 8-1: OSCCON: OSCILLATOR CONTROL REGISTER(1) (CONTINUED)**

bit 3 **CF:** Clock Fail Detect bit (read/clear by application)
1 = FSCM has detected a clock failure
0 = FSCM has not detected a clock failure

bit 2 **Unimplemented:** Read as '0'

bit 1 **LPOSCEN:** Secondary (LP) Oscillator Enable bit
1 = Enables secondary oscillator
0 = Disables secondary oscillator

bit 0 **OSWEN:** Oscillator Switch Enable bit
1 = Requests oscillator switch to selection specified by the NOSC<2:0> bits
0 = Oscillator switch is complete

**Note 1:** Writes to this register require an unlock sequence. Refer to **"Oscillator (Part VI)"** (DS70644) in the *"dsPIC33/PIC24 Family Reference Manual"* for details.

**2:** Direct clock switches between any primary oscillator mode with PLL and FRCPLL mode are not permitted. This applies to clock switches in either direction. In these instances, the application must switch to FRC mode as a transitional clock source between the two PLL modes.

**REGISTER 8-2: CLKDIV: CLOCK DIVISOR REGISTER**

| R/W-0 | R/W-0 | R/W-1 | R/W-1 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| ROI | DOZE2(2,3) | DOZE1(2,3) | DOZE0(2,3) | DOZEN(1,2,3) | FRCDIV2 | FRCDIV1 | FRCDIV0 |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | — | — | — |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15 **ROI:** Recover on Interrupt bit
1 = Interrupts will clear the DOZEN bit and the processor clock/peripheral clock ratio is set to 1:1
0 = Interrupts have no effect on the DOZEN bit

bit 14-12 **DOZE<2:0>:** Processor Clock Reduction Select bits(2,3)
111 = FCY/128
110 = FCY/64
101 = FCY/32
100 = FCY/16
011 = FCY/8 (default)
010 = FCY/4
001 = FCY/2
000 = FCY/1

bit 11 **DOZEN:** DOZE Mode Enable bit(1,2,3)
1 = DOZE<2:0> bits field specifies the ratio between the peripheral clocks and the processor clocks
0 = Processor clock/peripheral clock ratio is forced to 1:1

bit 10-8 **FRCDIV<2:0>:** Internal Fast RC Oscillator Postscaler bits
111 = FRC divide-by-256
110 = FRC divide-by-64
101 = FRC divide-by-32
100 = FRC divide-by-16
011 = FRC divide-by-8
010 = FRC divide-by-4
001 = FRC divide-by-2
000 = FRC divide-by-1 (default)

bit 7-0 **Unimplemented:** Read as '0'

**Note 1:** This bit is cleared when the ROI bit is set and an interrupt occurs.
**2:** If DOZEN = 1, writes to DOZE<2:0> are ignored.
**3:** If DOZE<2:0> = 000, the DOZEN bit cannot be set by the user; writes are ignored.


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**REGISTER 8-3: OSCTUN: FRC OSCILLATOR TUNING REGISTER**

| U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | — | — | — |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | TUN<5:0> | | | | | |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15-6 **Unimplemented:** Read as ‘0’

bit 5-0 **TUN<5:0>:** FRC Oscillator Tuning bits

011111 = Maximum frequency deviation of 1.453% (7.477 MHz)
011110 = Center frequency + 1.406% (7.474 MHz)
•
•
•
000001 = Center frequency + 0.047% (7.373 MHz)
000000 = Center frequency (7.37 MHz nominal)
111111 = Center frequency – 0.047% (7.367 MHz)
•
•
•
100001 = Center frequency – 1.453% (7.263 MHz)
100000 = Minimum frequency deviation of -1.5% (7.259 MHz)

## 8.3 Clock Switching Operation

Applications are free to switch among any of the four clock sources (Primary, LP, FRC and LPRC) under software control at any time. To limit the possible side effects of this flexibility, dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 devices have a safeguard lock built into the switch process.

| | |
|---|---|
| **Note:** | Primary Oscillator mode has three different submodes (MS, HS and EC), which are determined by the POSCMD<1:0> Configuration bits. While an application can switch to and from Primary Oscillator mode in software, it cannot switch among the different primary submodes without reprogramming the device. |

### 8.3.1 ENABLING CLOCK SWITCHING

To enable clock switching, the FCKSM1 Configuration bit in the FOSC Configuration register must be programmed to '0'. (Refer to **Section 23.1 "Configuration Bits"** for further details.) If the FCKSM1 Configuration bit is unprogrammed ('1'), the clock switching function and Fail-Safe Clock Monitor function are disabled. This is the default setting.

The NOSCx control bits (OSCCON<10:8>) do not control the clock selection when clock switching is disabled. However, the COSCx bits (OSCCON<14:12>) reflect the clock source selected by the FNOSCx Configuration bits.

The OSWEN control bit (OSCCON<0>) has no effect when clock switching is disabled; it is held at '0' at all times.

### 8.3.2 OSCILLATOR SWITCHING SEQUENCE

Performing a clock switch requires this basic sequence:

1. If desired, read the COSC bits (OSCCON<14:12>) to determine the current oscillator source.
2. Perform the unlock sequence to allow a write to the OSCCON register high byte.
3. Write the appropriate value to the NOSCx control bits (OSCCON<10:8>) for the new oscillator source.
4. Perform the unlock sequence to allow a write to the OSCCON register low byte.
5. Set the OSWEN bit (OSCCON<0>) to initiate the oscillator switch.

Once the basic sequence is completed, the system clock hardware responds automatically as follows:

1. The clock switching hardware compares the COSCx status bits with the new value of the NOSCx control bits. If they are the same, the clock switch is a redundant operation. In this case, the OSWEN bit is cleared automatically and the clock switch is aborted.
2. If a valid clock switch has been initiated, the LOCK and CF (OSCCON<5,3>) status bits are cleared.
3. The new oscillator is turned on by the hardware if it is not currently running. If a crystal oscillator must be turned on, the hardware waits until the Oscillator Start-up Timer (OST) expires. If the new source is using the PLL, the hardware waits until a PLL lock is detected (LOCK = 1).
4. The hardware waits for 10 clock cycles from the new clock source and then performs the clock switch.
5. The hardware clears the OSWEN bit to indicate a successful clock transition. In addition, the NOSCx bit values are transferred to the COSCx status bits.
6. The old clock source is turned off at this time, with the exception of LPRC (if WDT or FSCM is enabled) or LP (if LPOSCEN remains set).

| | |
|---|---|
| **Note 1:** | The processor continues to execute code throughout the clock switching sequence. Timing-sensitive code should not be executed during this time. |
| **2:** | Direct clock switches between any Primary Oscillator mode with PLL and FRCPLL mode are not permitted. This applies to clock switches in either direction. In these instances, the application must switch to FRC mode as a transition clock source between the two PLL modes. |
| **3:** | Refer to **"Oscillator (Part VI)"** (DS70644) in the *"dsPIC33/PIC24 Family Reference Manual"* for details. |

## 8.4 Fail-Safe Clock Monitor (FSCM)

The Fail-Safe Clock Monitor (FSCM) allows the device to continue to operate even in the event of an oscillator failure. The FSCM function is enabled by programming. If the FSCM function is enabled, the LPRC internal oscillator runs at all times (except during Sleep mode) and is not subject to control by the Watchdog Timer.

In the event of an oscillator failure, the FSCM generates a clock failure trap event and switches the system clock over to the FRC oscillator. Then, the application program can either attempt to restart the oscillator or execute a controlled shutdown. The trap can be treated as a Warm Reset by simply loading the Reset address into the oscillator fail trap vector.

If the PLL multiplier is used to scale the system clock, the internal FRC is also multiplied by the same factor on clock failure. Essentially, the device switches to FRC with PLL on a clock failure.


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# 9.0 POWER-SAVING FEATURES

**Note 1:** This data sheet summarizes the features of the dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 family devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **"Watchdog Timer and Power-Saving Modes"** (DS70196) in the *"dsPIC33/PIC24 Family Reference Manual"*, which is available from the Microchip web site (www.microchip.com).

**2:** Some registers and associated bits described in this section may not be available on all devices. Refer to **Section 4.0 "Memory Organization"** in this data sheet for device-specific register and bit information.

The dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 devices provide the ability to manage power consumption by selectively managing clocking to the CPU and the peripherals. In general, a lower clock frequency and a reduction in the number of circuits being clocked constitutes lower consumed power. Devices can manage power consumption in four different ways:

- Clock Frequency
- Instruction-Based Sleep and Idle modes
- Software-Controlled Doze mode
- Selective Peripheral Control in Software

Combinations of these methods can be used to selectively tailor an application's power consumption while still maintaining critical application features, such as timing-sensitive communications.

## 9.1 Clock Frequency and Clock Switching

dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 devices allow a wide range of clock frequencies to be selected under application control. If the system clock configuration is not locked, users can choose low-power or high-precision oscillators by simply changing the NOSC<2:0> bits (OSCCON<10:8>). The process of changing a system clock during operation, as well as limitations to the process, are discussed in more detail in **Section 8.0 "Oscillator Configuration"**.

## 9.2 Instruction-Based Power-Saving Modes

dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 devices have two special power-saving modes that are entered through the execution of a special PWRSAV instruction. Sleep mode stops clock operation and halts all code execution. Idle mode halts the CPU and code execution, but allows peripheral modules to continue operation. The assembler syntax of the PWRSAV instruction is shown in Example 9-1.

**Note:** SLEEP_MODE and IDLE_MODE are constants defined in the assembler include file for the selected device.

Sleep and Idle modes can be exited as a result of an enabled interrupt, WDT time-out or a device Reset. When the device exits these modes, it is said to wake-up.

### 9.2.1 SLEEP MODE

The following occurs in Sleep mode:

- The system clock source is shut down. If an on-chip oscillator is used, it is turned off.
- The device current consumption is reduced to a minimum, provided that no I/O pin is sourcing current
- The Fail-Safe Clock Monitor does not operate, since the system clock source is disabled
- The LPRC clock continues to run in Sleep mode if the WDT is enabled
- The WDT, if enabled, is automatically cleared prior to entering Sleep mode
- Some device features or peripherals may continue to operate. This includes items such as the Input Change Notification (ICN) on the I/O ports or peripherals that use an external clock input.
- Any peripheral that requires the system clock source for its operation is disabled

The device will wake-up from Sleep mode on any of the these events:

- Any interrupt source that is individually enabled
- Any form of device Reset
- A WDT time-out

On wake-up from Sleep mode, the processor restarts with the same clock source that was active when Sleep mode was entered.

**EXAMPLE 9-1: PWRSAV INSTRUCTION SYNTAX**

```
PWRSAV  #SLEEP_MODE    ; Put the device into SLEEP mode
PWRSAV  #IDLE_MODE     ; Put the device into IDLE mode
```

### 9.2.2 IDLE MODE

The following occurs in Idle mode:

- The CPU stops executing instructions.
- The WDT is automatically cleared.
- The system clock source remains active. By default, all peripheral modules continue to operate normally from the system clock source, but can also be selectively disabled (see **Section 9.4 "Peripheral Module Disable"**).
- If the WDT or FSCM is enabled, the LPRC also remains active.

The device will wake from Idle mode on any of these events:

- Any interrupt that is individually enabled
- Any device Reset
- A WDT time-out

On wake-up from Idle mode, the clock is reapplied to the CPU and instruction execution will begin (2-4 clock cycles later), starting with the instruction following the PWRSAV instruction, or the first instruction in the ISR.

### 9.2.3 INTERRUPTS COINCIDENT WITH POWER SAVE INSTRUCTIONS

Any interrupt that coincides with the execution of a PWRSAV instruction is held off until entry into Sleep or Idle mode has completed. The device then wakes up from Sleep or Idle mode.

## 9.3 Doze Mode

The preferred strategies for reducing power consumption are changing clock speed and invoking one of the power-saving modes. In some circumstances, this may not be practical. For example, it may be necessary for an application to maintain uninterrupted synchronous communication, even while it is doing nothing else. Reducing system clock speed can introduce communication errors, while using a power-saving mode can stop communications completely.

Doze mode is a simple and effective alternative method to reduce power consumption while the device is still executing code. In this mode, the system clock continues to operate from the same source and at the same speed. Peripheral modules continue to be clocked at the same speed, while the CPU clock speed is reduced. Synchronization between the two clock domains is maintained, allowing the peripherals to access the SFRs while the CPU executes code at a slower rate.

Doze mode is enabled by setting the DOZEN bit (CLKDIV<11>). The ratio between peripheral and core clock speed is determined by the DOZE<2:0> bits (CLKDIV<14:12>). There are eight possible configurations, from 1:1 to 1:128, with 1:1 being the default setting.

Programs can use Doze mode to selectively reduce power consumption in event-driven applications. This allows clock-sensitive functions, such as synchronous communications, to continue without interruption while the CPU Idles, waiting for something to invoke an interrupt routine. An automatic return to full-speed CPU operation on interrupts can be enabled by setting the ROI bit (CLKDIV<15>). By default, interrupt events have no effect on Doze mode operation.

For example, suppose the device is operating at 20 MIPS and the UART module has been configured for 500 kbps based on this device operating speed. If the device is placed in Doze mode with a clock frequency ratio of 1:4, the UART module continues to communicate at the required bit rate of 500 kbps, but the CPU now starts executing instructions at a frequency of 5 MIPS.

## 9.4 Peripheral Module Disable

The Peripheral Module Disable (PMDx) registers provide a method to disable a peripheral module by stopping all clock sources supplied to that module. When a peripheral is disabled using the appropriate PMDx control bit, the peripheral is in a minimum power consumption state. The control and status registers associated with the peripheral are also disabled, so writes to those registers will have no effect and read values will be invalid.

A peripheral module is enabled only if both the associated bit in the PMDx register is cleared and the peripheral is supported by the specific dsPIC® DSC variant. If the peripheral is present in the device, it is enabled in the PMDx register by default.

| | |
|---|---|
| **Note:** | If a PMDx bit is set, the corresponding module is disabled after a delay of one instruction cycle. Similarly, if a PMDx bit is cleared, the corresponding module is enabled after a delay of one instruction cycle (assuming the module control registers are already configured to enable module operation). |


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## 9.5 PMD Control Registers

**REGISTER 9-1: PMD1: PERIPHERAL MODULE DISABLE CONTROL REGISTER 1**

| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | U-0 | R/W-0 | U-0 |
|---|---|---|---|---|---|---|---|
| T5MD(1) | T4MD(1) | T3MD | T2MD | T1MD | — | PWM1MD | — |
| bit 15 | | | | | | | bit 8 |

| R/W-0 | U-0 | R/W-0 | U-0 | R/W-0 | U-0 | U-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| I2C1MD | — | U1MD | — | SPI1MD | — | — | AD1MD(2) |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15 **T5MD:** Timer5 Module Disable bit(1)
1 = Timer5 module is disabled
0 = Timer5 module is enabled

bit 14 **T4MD:** Timer4 Module Disable bit(1)
1 = Timer4 module is disabled
0 = Timer4 module is enabled

bit 13 **T3MD:** Timer3 Module Disable bit
1 = Timer3 module is disabled
0 = Timer3 module is enabled

bit 12 **T2MD:** Timer2 Module Disable bit
1 = Timer2 module is disabled
0 = Timer2 module is enabled

bit 11 **T1MD:** Timer1 Module Disable bit
1 = Timer1 module is disabled
0 = Timer1 module is enabled

bit 10 **Unimplemented:** Read as '0'

bit 9 **PWM1MD:** PWM1 Module Disable bit
1 = PWM1 module is disabled
0 = PWM1 module is enabled

bit 8 **Unimplemented:** Read as '0'

bit 7 **I2C1MD:** I2C1 Module Disable bit
1 = I2C1 module is disabled
0 = I2C1 module is enabled

bit 6 **Unimplemented:** Read as '0'

bit 5 **U1MD:** UART1 Module Disable bit
1 = UART1 module is disabled
0 = UART1 module is enabled

bit 4 **Unimplemented:** Read as '0'

**Note 1:** These bits are available in dsPIC33FJ32(GP/MC)10X devices only.

**2:** PCFGx bits have no effect if the ADC module is disabled by setting this bit. When the bit is set, all port pins that have been multiplexed with ANx will be in Digital mode.

**REGISTER 9-1: PMD1: PERIPHERAL MODULE DISABLE CONTROL REGISTER 1 (CONTINUED)**

bit 3 **SPI1MD:** SPI1 Module Disable bit
1 = SPI1 module is disabled
0 = SPI1 module is enabled

bit 2-1 **Unimplemented:** Read as '0'

bit 0 **AD1MD:** ADC1 Module Disable bit(2)
1 = ADC1 module is disabled
0 = ADC1 module is enabled

**Note 1:** These bits are available in dsPIC33FJ32(GP/MC)10X devices only.

**2:** PCFGx bits have no effect if the ADC module is disabled by setting this bit. When the bit is set, all port pins that have been multiplexed with ANx will be in Digital mode.

**REGISTER 9-2: PMD2: PERIPHERAL MODULE DISABLE CONTROL REGISTER 2**

| U-0 | U-0 | U-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | IC3MD | IC2MD | IC1MD |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | — | OC2MD | OC1MD |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15-11 **Unimplemented:** Read as '0'

bit 10 **IC3MD:** Input Capture 3 Module Disable bit
1 = Input Capture 3 module is disabled
0 = Input Capture 3 module is enabled

bit 9 **IC2MD:** Input Capture 2 Module Disable bit
1 = Input Capture 2 module is disabled
0 = Input Capture 2 module is enabled

bit 8 **IC1MD:** Input Capture 1 Module Disable bit
1 = Input Capture 1 module is disabled
0 = Input Capture 1 module is enabled

bit 7-2 **Unimplemented:** Read as '0'

bit 1 **OC2MD:** Output Compare 2 Module Disable bit
1 = Output Compare 2 module is disabled
0 = Output Compare 2 module is enabled

bit 0 **OC1MD:** Output Compare 1 Module Disable bit
1 = Output Compare 1 module is disabled
0 = Output Compare 1 module is enabled


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**REGISTER 9-3: PMD3: PERIPHERAL MODULE DISABLE CONTROL REGISTER 3**

| U-0 | U-0 | U-0 | U-0 | U-0 | R/W-0 | R/W-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | CMPMD | RTCCMD | — |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | — | — | — |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15-11 **Unimplemented:** Read as ‘0’

bit 10 **CMPMD:** Comparator Module Disable bit
1 = Comparator module is disabled
0 = Comparator module is enabled

bit 9 **RTCCMD:** RTCC Module Disable bit
1 = RTCC module is disabled
0 = RTCC module is enabled

bit 8-0 **Unimplemented:** Read as ‘0’

**REGISTER 9-4: PMD4: PERIPHERAL MODULE DISABLE CONTROL REGISTER 4**

| U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | — | — | — |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | U-0 | U-0 | R/W-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | CTMUMD | — | — |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15-3 **Unimplemented:** Read as ‘0’

bit 2 **CTMUMD:** CTMU Module Disable bit
1 = CTMU module is disabled
0 = CTMU module is enabled

bit 1-0 **Unimplemented:** Read as ‘0’

**NOTES:**


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## 10.0 I/O PORTS

**Note 1:** This data sheet summarizes the features of the dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 family devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **"I/O Ports"** (DS70193) in the *"dsPIC33/PIC24 Family Reference Manual"*, which is available from the Microchip web site (www.microchip.com).

**2:** Some registers and associated bits described in this section may not be available on all devices. Refer to **Section 4.0 "Memory Organization"** in this data sheet for device-specific register and bit information.

All of the device pins (except VDD, VSS, $\overline{\text{MCLR}}$ and OSC1/CLKI) are shared among the peripherals and the parallel I/O ports. All I/O input ports feature Schmitt Trigger inputs for improved noise immunity.

### 10.1 Parallel I/O (PIO) Ports

Generally a parallel I/O port that shares a pin with a peripheral is subservient to the peripheral. The peripheral's output buffer data and control signals are provided to a pair of multiplexers. The multiplexers select whether the peripheral or the associated port has ownership of the output data and control signals of the I/O pin. The logic also prevents "loop through," in which a port's digital output can drive the input of a peripheral that shares the same pin. Figure 10-1 shows how ports are shared with other peripherals and the associated I/O pin to which they are connected.

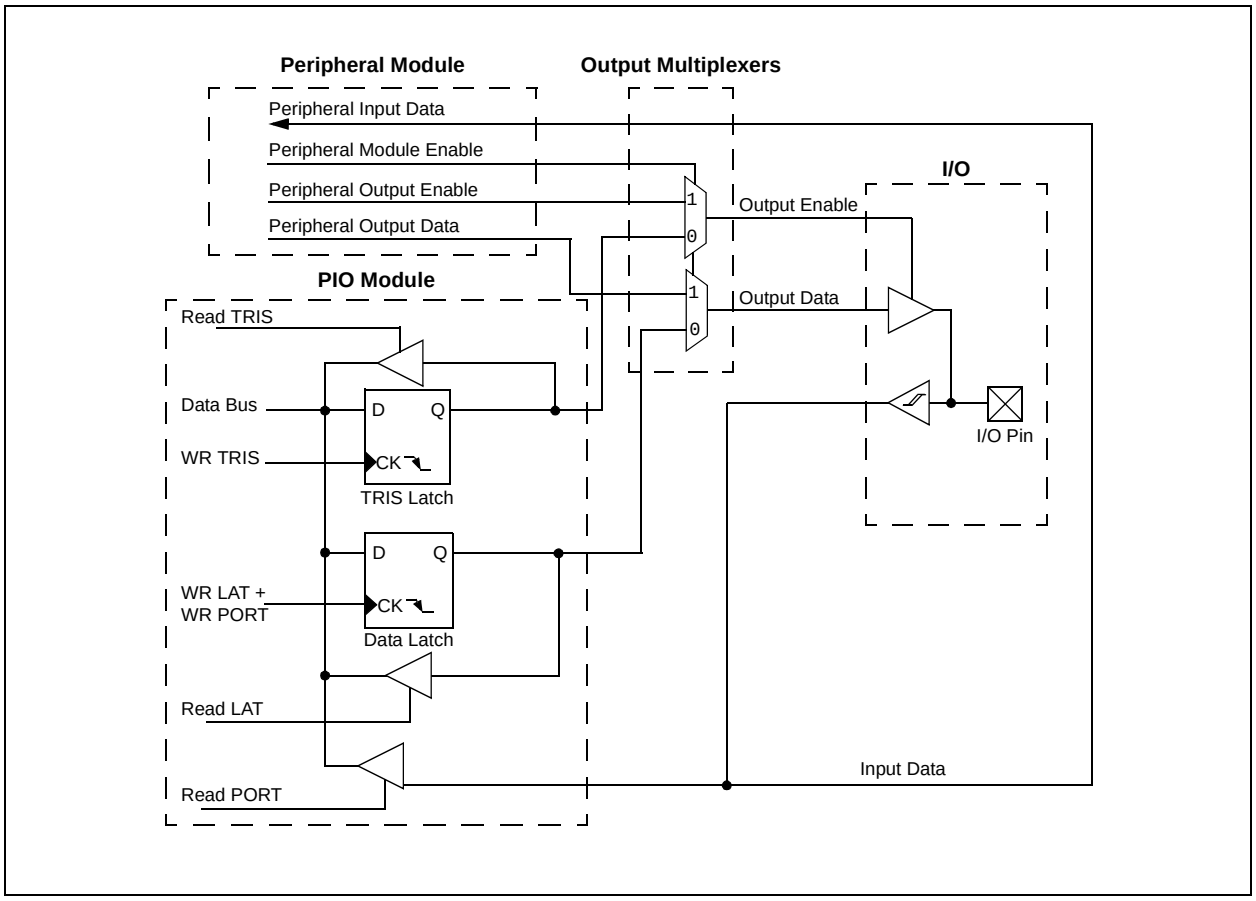
When a peripheral is enabled and the peripheral is actively driving an associated pin, the use of the pin as a general purpose output pin is disabled. The I/O pin can be read, but the output driver for the parallel port bit is disabled. If a peripheral is enabled, but the peripheral is not actively driving a pin, that pin can be driven by a port.

All port pins have three registers directly associated with their operation as digital I/O. The Data Direction register (TRISx) determines whether the pin is an input or an output. If the data direction bit is a '1', the pin is an input. All port pins are defined as inputs after a Reset. Reads from the Output Latch (LATx) register read the latch. Writes to the Output Latch register write the latch. Reads from the port (PORTx) read the port pins, while writes to the port pins write the latch.

Any bit and its associated data and control registers that is not valid for a particular device will be disabled. This means the corresponding LATx and TRISx registers and the port pin will read as zeros.

When a pin is shared with another peripheral or function that is defined as an input only, it is nevertheless regarded as a dedicated port because there is no other competing source of outputs.

**FIGURE 10-1: BLOCK DIAGRAM OF A TYPICAL SHARED PORT STRUCTURE**





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### 10.1.1 OPEN-DRAIN CONFIGURATION

In addition to the PORTx, LATx and TRISx registers for data control, some port pins can also be individually configured for either digital or open-drain output. This is controlled by the Open-Drain Control register, ODCx, associated with each port. Setting any of the bits configures the corresponding pin to act as an open-drain output.

The open-drain feature allows the generation of outputs higher than VDD (e.g., 5V) on any desired 5V tolerant pins by using external pull-up resistors. The maximum open-drain voltage allowed is the same as the maximum VIH specification.

See **"Pin Diagrams"** for the available pins and their functionality.

## 10.2 Configuring Analog Port Pins

The AD1PCFGL and TRISx registers control the operation of the Analog-to-Digital port pins. The port pins that are to function as analog inputs must have their corresponding TRISx bit set (input). If the TRISx bit is cleared (output), the digital output level (VOH or VOL) will be converted.

The AD1PCFGL register has a default value of 0x0000; therefore, all pins that share ANx functions are analog (not digital) by default.

When the PORTx register is read, all pins configured as analog input channels will read as cleared (a low level).

Pins configured as digital inputs will not convert an analog input. Analog levels on any pin defined as a digital input (including the ANx pins) can cause the input buffer to consume current that exceeds the device specifications.

### 10.2.1 I/O PORT WRITE/READ TIMING

One instruction cycle is required between a port direction change or port write operation and a read operation of the same port. Typically this instruction would be a NOP. A demonstration is shown in Example 10-1.

## 10.3 Input Change Notification (ICN)

The Input Change Notification function of the I/O ports allows the dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 devices to generate interrupt requests to the processor in response to a Change-of-State (COS) on selected input pins. This feature can detect input Change-of-States, even in Sleep mode, when the clocks are disabled. Depending on the device pin count, up to 21 external signals (CNx pin) can be selected (enabled) for generating an interrupt request on a Change-of-State.

Four control registers are associated with the CN module. The CNEN1 and CNEN2 registers contain the interrupt enable control bits for each of the CN input pins. Setting any of these bits enables a CN interrupt for the corresponding pins.

Each CN pin also has a weak pull-up connected to it. The pull-ups act as a current source connected to the pin and eliminate the need for external resistors when push button or keypad devices are connected. The pull-ups are enabled separately using the CNPU1 and CNPU2 registers, which contain the control bits for each of the CN pins. Setting any of the control bits enables the weak pull-ups for the corresponding pins.

| **Note:** | Pull-ups on Input Change Notification pins should always be disabled when the port pin is configured as a digital output. |
|---|---|

**EXAMPLE 10-1: PORT WRITE/READ EXAMPLE**

```
MOV   0xFF00, W0          ; Configure PORTB<15:8> as inputs
MOV   W0, TRISBB          ; and PORTB<7:0> as outputs
NOP                       ; Delay 1 cycle
btss  PORTB, #13          ; Next Instruction
```

## 10.4 Peripheral Pin Select (PPS)

Peripheral Pin Select configuration enables peripheral set selection and placement on a wide range of I/O pins. By increasing the pinout options available on a particular device, programmers can better tailor the microcontroller to their entire application, rather than trimming the application to fit the device.

The Peripheral Pin Select configuration feature operates over a fixed subset of digital I/O pins. Programmers can independently map the input and/or output of most digital peripherals to any one of these I/O pins. Peripheral Pin Select is performed in software and generally does not require the device to be reprogrammed. Hardware safeguards are included that prevent accidental or spurious changes to the peripheral mapping, once it has been established.

### 10.4.1 AVAILABLE PINS

The Peripheral Pin Select feature is used with a range of up to 16 pins. The number of available pins depends on the particular device and its pin count. Pins that support the Peripheral Pin Select feature include the designation “RPn” in their full pin designation, where “RP” designates a remappable peripheral and “n” is the remappable pin number.

### 10.4.2 CONTROLLING PERIPHERAL PIN SELECT

Peripheral Pin Select features are controlled through two sets of Special Function Registers: one to map peripheral inputs and one to map outputs. Because they are separately controlled, a particular peripheral’s input and output (if the peripheral has both) can be placed on any selectable function pin without constraint.

The association of a peripheral to a peripheral selectable pin is handled in two different ways, depending on whether an input or output is being mapped.

#### 10.4.2.1 Input Mapping

The inputs of the Peripheral Pin Select options are mapped on the basis of the peripheral. A control register associated with a peripheral dictates the pin it will be mapped to. The RPINRx registers are used to configure peripheral input mapping (see Register 10-1 through Register 10-10). Each register contains sets of 5-bit fields, with each set associated with one of the remappable peripherals. Programming a given peripheral’s bit field with an appropriate 5-bit value maps the RPn pin with that value to that peripheral. For any given device, the valid range of values for any bit field corresponds to the maximum number of Peripheral Pin Selections supported by the device.

Figure 10-2 Illustrates remappable pin selection for U1RX input.

| **Note:** | For input mapping only, the Peripheral Pin Select (PPS) functionality does not have priority over the TRISx settings. Therefore, when configuring the RPx pin for input, the corresponding bit in the TRISx register must also be configured for input (i.e., set to ‘1’). |
|---|---|

**FIGURE 10-2: REMAPPABLE MUX INPUT FOR U1RX**

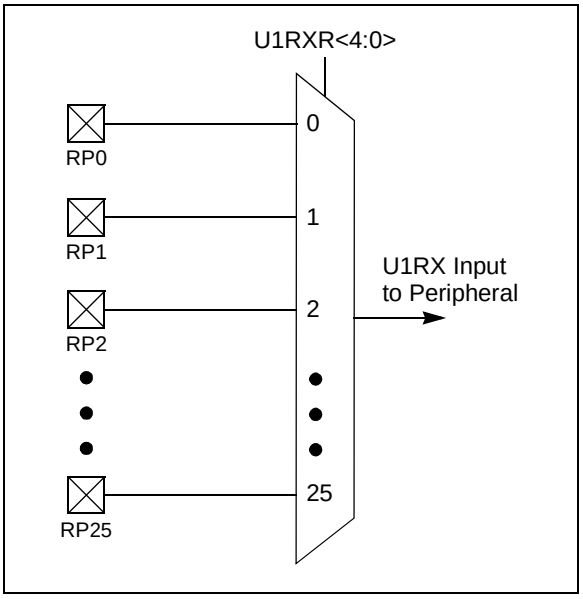



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**TABLE 10-1: SELECTABLE INPUT SOURCES (MAPS INPUT TO FUNCTION)(1)**

| Input Name | Function Name | Register | Configuration Bits |
|---|---|---|---|
| External Interrupt 1 | INT1 | RPINR0 | INT1R<4:0> |
| External Interrupt 2 | INT2 | RPINR1 | INT2R<4:0> |
| Timer2 External Clock | T2CK | RPINR3 | T2CKR<4:0> |
| Timer3 External Clock | T3CK | RPINR3 | T3CKR<4:0> |
| Timer4 External Clock | T4CK | RPINR4 | T4CKR<4:0>(2) |
| Timer5 External Clock | T5CK | RPINR4 | T5CKR<4:0>(2) |
| Input Capture 1 | IC1 | RPINR7 | IC1R<4:0> |
| Input Capture 2 | IC2 | RPINR7 | IC2R<4:0> |
| Input Capture 3 | IC3 | RPINR8 | IC3R<4:0> |
| Output Compare Fault A | OCFA | RPINR11 | OCFAR<4:0> |
| UART1 Receive | U1RX | RPINR18 | U1RXR<4:0> |
| UART1 Clear-to-Send | $\overline{\text{U1CTS}}$ | RPINR18 | U1CTSR<4:0> |
| SDI1 SPI Data Input 1 | SDI1 | RPINR20 | SDI1R<4:0>(2) |
| SCK1 SPI Clock Input 1 | SCK1 | RPINR20 | SCK1R<4:0>(2) |
| SPI1 Slave Select Input | $\overline{\text{SS1}}$ | RPINR21 | SS1R<4:0>(2) |

**Note 1:** Unless otherwise noted, all inputs use the Schmitt input buffers.

**2:** These bits are available in dsPIC33FJ32(GP/MC)10X devices only.

### 10.4.2.2 Output Mapping

In contrast to the inputs, the outputs of the Peripheral Pin Select options are mapped on the basis of the pin. In this case, a control register associated with a particular pin dictates the peripheral output to be mapped. The RPORx registers are used to control output mapping. Like the RPINRx registers, each register contains sets of 5-bit fields, with each set associated with one RPn pin (see Register 10-11 through Register 10-23). The value of the bit field corresponds to one of the peripherals and that peripheral's output is mapped to the pin (see Table 10-2 and Figure 10-3).

The list of peripherals for output mapping also includes a null value of '00000' because of the mapping technique. This permits any given pin to remain unconnected from the output of any of the pin selectable peripherals.

**FIGURE 10-3: MULTIPLEXING OF REMAPPABLE OUTPUT FOR RPn**

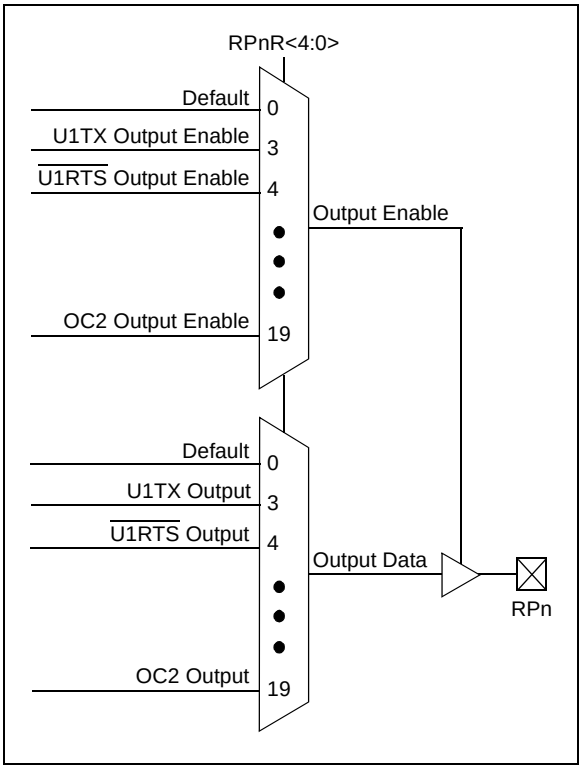


**TABLE 10-2: OUTPUT SELECTION FOR REMAPPABLE PIN (RPn)**

| Function | RPnR<4:0> | Output Name |
|---|---|---|
| NULL | 00000 | RPn tied to Default Port Pin |
| C1OUT | 00001 | RPn tied to Comparator 1 Output |
| C2OUT | 00010 | RPn tied to Comparator 2 Output |
| U1TX | 00011 | RPn tied to UART1 Transmit |
| U1RTS | 00100 | RPn tied to UART1 Ready-to-Send |
| SCK1 | 01000 | RPn tied to SPI Clock(1) |
| SDO1 | 00111 | RPn tied to SPI Data Output(1) |
| SS1 | 01001 | RPn tied to SPI1 Slave Select Output(1) |
| OC1 | 10010 | RPn tied to Output Compare 1 |
| OC2 | 10011 | RPn tied to Output Compare 2 |
| CTPLS | 11101 | RPn tied to CTMU Pulse Output |
| C3OUT | 11110 | RPn tied to Comparator 3 Output |

**Note 1:** This function is available in dsPIC33FJ32(GP/MC)10X devices only.


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### 10.4.3 CONTROLLING CONFIGURATION CHANGES

Because peripheral remapping can be changed during run time, some restrictions on peripheral remapping are needed to prevent accidental configuration changes. dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 devices include three features to prevent alterations to the peripheral map:

- Control register lock sequence
- Continuous state monitoring
- Configuration bit pin select lock

#### 10.4.3.1 Control Register Lock

Under normal operation, writes to the RPINRx and RPORx registers are not allowed. Attempted writes appear to execute normally, but the contents of the registers remain unchanged. To change these registers, they must be unlocked in hardware. The register lock is controlled by the IOLOCK bit (OSCCON<6>). Setting IOLOCK prevents writes to the control registers; clearing IOLOCK allows writes.

To set or clear IOLOCK, a specific command sequence must be executed:

1. Write 0x46 to OSCCON<7:0>.
2. Write 0x57 to OSCCON<7:0>.
3. Clear (or set) IOLOCK as a single operation.

**Note:** MPLAB® C30 provides built-in C language functions for unlocking the OSCCON register:

```
__builtin_write_OSCCONL(value)
__builtin_write_OSCCONH(value)
```

See MPLAB IDE Help for more information.

Unlike the similar sequence with the oscillator's LOCK bit, IOLOCK remains in one state until changed. This allows all of the Peripheral Pin Selects to be configured with a single unlock sequence followed by an update to all control registers, then locked with a second lock sequence.

#### 10.4.3.2 Continuous State Monitoring

In addition to being protected from direct writes, the contents of the RPINRx and RPORx registers are constantly monitored in hardware by shadow registers. If an unexpected change in any of the registers occurs (such as cell disturbances caused by ESD or other external events), a Configuration Mismatch Reset will be triggered.

#### 10.4.3.3 Configuration Bit Pin Select Lock

As an additional level of safety, the device can be configured to prevent more than one write session to the RPINRx and RPORx registers. The IOL1WAY (FOSC<5>) Configuration bit blocks the IOLOCK bit from being cleared after it has been set once. If IOLOCK remains set, the register unlock procedure will not execute and the Peripheral Pin Select Control registers cannot be written to. The only way to clear the bit and re-enable peripheral remapping is to perform a device Reset.

In the default (unprogrammed) state, IOL1WAY is set, restricting users to one write session. Programming IOL1WAY allows user applications unlimited access (with the proper use of the unlock sequence) to the Peripheral Pin Select registers.

## 10.5 I/O Helpful Tips

1. In some cases, certain pins, as defined in **Section 26.0 "Electrical Characteristics"**, Table 26-11 under "Injection Current", have internal protection diodes to VDD and VSS. The term, "Injection Current", is also referred to as "Clamp Current". On designated pins, with sufficient external current limiting precautions by the user, I/O pin input voltages are allowed to be greater or less than the data sheet absolute maximum ratings with nominal VDD, with respect to the VSS and VDD supplies. Note that when the user application forward biases either of the high or low side internal input clamp diodes, that the resulting current being injected into the device, that is clamped internally by the VDD and VSS power rails, may affect the ADC accuracy by four to six counts.
2. I/O pins that are shared with any analog input pin, (i.e., ANx), are always analog pins by default after any Reset. Consequently, any pin(s) configured as an analog input pin, automatically disables the digital input pin buffer. As such, any attempt to read a digital input pin will always return a '0' regardless of the digital logic level on the pin if the analog pin is configured. To use a pin as a digital I/O pin on a shared ANx pin, the user application needs to configure the ADC1 Port Configuration Low (AD1PCFGL) register in the ADC module, by setting the appropriate bit that corresponds to that I/O port pin, to a '1'. On devices with more than one ADC, both analog pin configurations for both ADC modules must be configured as a digital I/O pin for that pin to function as a digital I/O pin.

| **Note:** | Although it is not possible to use a digital input pin when its analog function is enabled, it is possible to use the digital I/O output function, TRISx = 0x0, while the analog function is also enabled. However, this is not recommended, particularly if the analog input is connected to an external analog voltage source, which would create signal contention between the analog signal and the output pin driver. |
|---|---|

3. Most I/O pins have multiple functions. Referring to the device pin diagrams in the data sheet, the priorities of the functions allocated to any pins are indicated by reading the pin name from left-to-right. The left most function name takes precedence over any function to its right in the naming convention. For example: AN16/T2CK/T7CK/RC1. This indicates that AN16 is the highest priority in this example and will supersede all other functions to its right in the list. Those other functions to its right, even if enabled, would not work as long as any other function to its left was enabled. This rule applies to all of the functions listed for a given pin.
4. Each CN pin has a configurable internal weak pull-up resistor. The pull-ups act as a current source connected to the pin and eliminates the need for external resistors in certain applications. The internal pull-up is to ~(VDD – 0.8), not VDD. This is still above the minimum VIH of CMOS and TTL devices.
5. When driving LEDs directly, the I/O pin can source or sink more current than what is specified in the VOH/IOH and VOL/IOL DC characteristic specification. The respective IOH and IOL current rating only applies to maintaining the corresponding output at or above the VOH and at or below the VOL levels. However, for LEDs unlike digital inputs of an externally connected device, they are not governed by the same minimum VIH/VIL levels. An I/O pin output can safely sink or source any current less than that listed in the absolute maximum rating section of the data sheet. For example:

   VOH = 2.4v @ IOH = -6 mA and VDD = 3.3V

   The maximum output current sourced by any 6 mA I/O pin = 15 mA.

   LED source current < 15 mA is technically permitted. Refer to the VOH/IOH specifications in **Section 26.0 "Electrical Characteristics"** for additional information.

## 10.6 I/O Resources

Many useful resources are provided on the main product page of the Microchip web site for the devices listed in this data sheet. This product page, which can be accessed using this link, contains the latest updates and additional information.

| **Note:** | In the event you are not able to access the product page using the link above, enter this URL in your browser: http://www.microchip.com/wwwproducts/Devices.aspx?dDocName=en554109 |
|---|---|

### 10.6.1 KEY RESOURCES

- **"I/O Ports"** (DS70193) in the *"dsPIC33/PIC24 Family Reference Manual"*
- Code Samples
- Application Notes
- Software Libraries
- Webinars
- All related *"dsPIC33/PIC24 Family Reference Manual"* Sections
- Development Tools


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## 10.7 Peripheral Pin Select Registers

The dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 family of devices implements up to 23 registers for remappable peripheral configuration.

**Note:** Input and output register values can only be changed if IOLOCK (OSCCON<6>) = 0. See **Section 10.4.3.1 "Control Register Lock"** for a specific command sequence.

**REGISTER 10-1: RPINR0: PERIPHERAL PIN SELECT INPUT REGISTER 0**

| U-0 | U-0 | U-0 | R/W-1 | R/W-1 | R/W-1 | R/W-1 | R/W-1 |
|---|---|---|---|---|---|---|---|
| — | — | — | INT1R4 | INT1R3 | INT1R2 | INT1R1 | INT1R0 |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | — | — | — |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15-13 **Unimplemented:** Read as '0'

bit 12-8 **INT1R<4:0>:** Assign External Interrupt 1 (INTR1) to the Corresponding RPn Pin bits

11111 = Input tied to Vss
11110 = Reserved
.
.
.
11010 = Reserved
11001 = Input tied to RP25
.
.
.
00001 = Input tied to RP1
00000 = Input tied to RP0

bit 7-0 **Unimplemented:** Read as '0'

**REGISTER 10-2: RPINR1: PERIPHERAL PIN SELECT INPUT REGISTER 1**

| U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | — | — | — |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | R/W-1 | R/W-1 | R/W-1 | R/W-1 | R/W-1 |
|---|---|---|---|---|---|---|---|
| — | — | — | INT2R4 | INT2R3 | INT2R2 | INT2R1 | INT2R0 |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15-5 **Unimplemented:** Read as ‘0’

bit 4-0 **INT2R<4:0>:** Assign External Interrupt 2 (INTR2) to the Corresponding RPn Pin bits

11111 = Input tied to Vss
11110 = Reserved
.
.
.
11010 = Reserved
11001 = Input tied to RP25
.
.
.
00001 = Input tied to RP1
00000 = Input tied to RP0


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**REGISTER 10-3: RPINR3: PERIPHERAL PIN SELECT INPUT REGISTER 3**

| U-0 | U-0 | U-0 | R/W-1 | R/W-1 | R/W-1 | R/W-1 | R/W-1 |
|---|---|---|---|---|---|---|---|
| — | — | — | T3CKR4 | T3CKR3 | T3CKR2 | T3CKR1 | T3CKR0 |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | R/W-1 | R/W-1 | R/W-1 | R/W-1 | R/W-1 |
|---|---|---|---|---|---|---|---|
| — | — | — | T2CKR4 | T2CKR3 | T2CKR2 | T2CKR1 | T2CKR0 |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15-13 **Unimplemented:** Read as ‘0’

bit 12-8 **T3CKR<4:0>:** Assign Timer3 External Clock (T3CK) to the Corresponding RPn Pin bits

11111 = Input tied to Vss
11110 = Reserved
.
.
.
11010 = Reserved
11001 = Input tied to RP25
.
.
.
00001 = Input tied to RP1
00000 = Input tied to RP0

bit 7-5 **Unimplemented:** Read as ‘0’

bit 4-0 **T2CKR<4:0>:** Assign Timer2 External Clock (T2CK) to the Corresponding RPn Pin bits

11111 = Input tied to Vss
11110 = Reserved
.
.
.
11010 = Reserved
11001 = Input tied to RP25
.
.
.
00001 = Input tied to RP1
00000 = Input tied to RP0

**REGISTER 10-4: RPINR4: PERIPHERAL PIN SELECT INPUT REGISTER 4**

| U-0 | U-0 | U-0 | R/W-1 | R/W-1 | R/W-1 | R/W-1 | R/W-1 |
|---|---|---|---|---|---|---|---|
| — | — | — | T5CKR4(1) | T5CKR3(1) | T5CKR2(1) | T5CKR1(1) | T5CKR0(1) |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | R/W-1 | R/W-1 | R/W-1 | R/W-1 | R/W-1 |
|---|---|---|---|---|---|---|---|
| — | — | — | T4CKR4(1) | T4CKR3(1) | T4CKR2(1) | T4CKR1(1) | T4CKR0(1) |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15-13 **Unimplemented:** Read as '0'

bit 12-8 **T5CKR<4:0>:** Assign Timer5 External Clock (T5CK) to the Corresponding RPn Pin bits(1)

11111 = Input tied to Vss
11110 = Reserved
.
.
.
11010 = Reserved
11001 = Input tied to RP25
.
.
.
00001 = Input tied to RP1
00000 = Input tied to RP0

bit 7-5 **Unimplemented:** Read as '0'

bit 4-0 **T4CKR<4:0>:** Assign Timer4 External Clock (T4CK) to the Corresponding RPn Pin bits(1)

11111 = Input tied to Vss
11110 = Reserved
.
.
.
11010 = Reserved
11001 = Input tied to RP25
.
.
.
00001 = Input tied to RP1
00000 = Input tied to RP0

**Note 1:** These bits are available in dsPIC33FJ32(GP/MC)10X devices only.


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**REGISTER 10-5: RPINR7: PERIPHERAL PIN SELECT INPUT REGISTER 7**

| U-0 | U-0 | U-0 | R/W-1 | R/W-1 | R/W-1 | R/W-1 | R/W-1 |
|---|---|---|---|---|---|---|---|
| — | — | — | IC2R4 | IC2R3 | IC2R2 | IC2R1 | IC2R0 |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | R/W-1 | R/W-1 | R/W-1 | R/W-1 | R/W-1 |
|---|---|---|---|---|---|---|---|
| — | — | — | IC1R4 | IC1R3 | IC1R2 | IC1R1 | IC1R0 |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15-13 **Unimplemented:** Read as '0'

bit 12-8 **IC2R<4:0>:** Assign Input Capture 2 (IC2) to the Corresponding RPn Pin bits

11111 = Input tied to Vss
11110 = Reserved
.
.
.
11010 = Reserved
11001 = Input tied to RP25
.
.
.
00001 = Input tied to RP1
00000 = Input tied to RP0

bit 7-5 **Unimplemented:** Read as '0'

bit 4-0 **IC1R<4:0>:** Assign Input Capture 1 (IC1) to the Corresponding RPn Pin bits

11111 = Input tied to Vss
11110 = Reserved
.
.
.
11010 = Reserved
11001 = Input tied to RP25
.
.
.
00001 = Input tied to RP1
00000 = Input tied to RP0

**REGISTER 10-6: RPINR8: PERIPHERAL PIN SELECT INPUT REGISTER 8**

| U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | — | — | — |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | R/W-1 | R/W-1 | R/W-1 | R/W-1 | R/W-1 |
|---|---|---|---|---|---|---|---|
| — | — | — | IC3R4 | IC3R3 | IC3R2 | IC3R1 | IC3R0 |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15-5 **Unimplemented:** Read as ‘0’

bit 4-0 **IC3R<4:0>:** Assign Input Capture 3 (IC3) to the Corresponding RPn Pin bits

11111 = Input tied to Vss
11110 = Reserved
.
.
.
11010 = Reserved
11001 = Input tied to RP25
.
.
.
00001 = Input tied to RP1
00000 = Input tied to RP0


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**REGISTER 10-7: RPINR11: PERIPHERAL PIN SELECT INPUT REGISTER 11**

| U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | — | — | — |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | R/W-1 | R/W-1 | R/W-1 | R/W-1 | R/W-1 |
|---|---|---|---|---|---|---|---|
| — | — | — | OCFAR4 | OCFAR3 | OCFAR2 | OCFAR1 | OCFAR0 |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15-5 **Unimplemented:** Read as ‘0’

bit 4-0 **OCFAR<4:0>:** Assign Output Capture A (OCFA) to the Corresponding RPn Pin bits

11111 = Input tied to Vss
11110 = Reserved
.
.
.
11010 = Reserved
11001 = Input tied to RP25
.
.
.
00001 = Input tied to RP1
00000 = Input tied to RP0

**REGISTER 10-8: RPINR18: PERIPHERAL PIN SELECT INPUT REGISTER 18**

| U-0 | U-0 | U-0 | R/W-1 | R/W-1 | R/W-1 | R/W-1 | R/W-1 |
|---|---|---|---|---|---|---|---|
| — | — | — | U1CTSR4 | U1CTSR3 | U1CTSR2 | U1CTSR1 | U1CTSR0 |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | R/W-1 | R/W-1 | R/W-1 | R/W-1 | R/W-1 |
|---|---|---|---|---|---|---|---|
| — | — | — | U1RXR4 | U1RXR3 | U1RXR2 | U1RXR1 | U1RXR0 |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15-13 **Unimplemented:** Read as '0'

bit 12-8 **U1CTSR<4:0>:** Assign UART1 Clear-to-Send ($\overline{\text{U1CTS}}$) to the Corresponding RPn Pin bits

11111 = Input tied to Vss
11110 = Reserved
.
.
.
11010 = Reserved
11001 = Input tied to RP25
.
.
.
00001 = Input tied to RP1
00000 = Input tied to RP0

bit 7-5 **Unimplemented:** Read as '0'

bit 4-0 **U1RXR<4:0>:** Assign UART1 Receive (U1RX) to the Corresponding RPn Pin bits

11111 = Input tied to Vss
11110 = Reserved
.
.
.
11010 = Reserved
11001 = Input tied to RP25
.
.
.
00001 = Input tied to RP1
00000 = Input tied to RP0


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**REGISTER 10-9: RPINR20: PERIPHERAL PIN SELECT INPUT REGISTER 20**

| U-0 | U-0 | U-0 | R/W-1 | R/W-1 | R/W-1 | R/W-1 | R/W-1 |
|---|---|---|---|---|---|---|---|
| — | — | — | SCK1R4(1) | SCK1R3(1) | SCK1R2(1) | SCK1R1(1) | SCK1R0(1) |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | R/W-1 | R/W-1 | R/W-1 | R/W-1 | R/W-1 |
|---|---|---|---|---|---|---|---|
| — | — | — | SDI1R4(1) | SDI1R3(1) | SDI1R2(1) | SDI1R1(1) | SDI1R0(1) |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15-13 **Unimplemented:** Read as ‘0’

bit 12-8 **SCK1R<4:0>:** Assign SPI1 Clock Input (SCK1IN) to the Corresponding RPn Pin bits(1)

11111 = Input tied to Vss
11110 = Reserved
.
.
.
11010 = Reserved
11001 = Input tied to RP25
.
.
.
00001 = Input tied to RP1
00000 = Input tied to RP0

bit 7-5 **Unimplemented:** Read as ‘0’

bit 4-0 **SDI1R<4:0>:** Assign SPI1 Data Input (SDI1) to the Corresponding RPn Pin bits(1)

11111 = Input tied to Vss
11110 = Reserved
.
.
.
11010 = Reserved
11001 = Input tied to RP25
.
.
.
00001 = Input tied to RP1
00000 = Input tied to RP0

**Note 1:** These bits are available in dsPIC33FJ32(GP/MC)10X devices only.

**REGISTER 10-10: RPINR21: PERIPHERAL PIN SELECT INPUT REGISTER 21**

| U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | — | — | — |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | R/W-1 | R/W-1 | R/W-1 | R/W-1 | R/W-1 |
|---|---|---|---|---|---|---|---|
| — | — | — | SS1R4 | SS1R3 | SS1R2 | SS1R1 | SS1R0 |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15-5 **Unimplemented:** Read as ‘0’

bit 4-0 **SS1R<4:0>:** Assign SPI1 Slave Select Input (SS1IN) to the Corresponding RPn Pin bits

11111 = Input tied to Vss
11110 = Reserved
.
.
.
11010 = Reserved
11001 = Input tied to RP25
.
.
.
00001 = Input tied to RP1
00000 = Input tied to RP0


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**REGISTER 10-11: RPOR0: PERIPHERAL PIN SELECT OUTPUT REGISTER 0**

| U-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | RP1R<4:0> | | | | |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | RP0R<4:0> | | | | |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15-13 **Unimplemented:** Read as ‘0’

bit 12-8 **RP1R<4:0>:** Peripheral Output Function is Assigned to RP1 Output Pin bits
(see Table 10-2 for peripheral function numbers)

bit 7-5 **Unimplemented:** Read as ‘0’

bit 4-0 **RP0R<4:0>:** Peripheral Output Function is Assigned to RP0 Output Pin bits
(see Table 10-2 for peripheral function numbers)

**REGISTER 10-12: RPOR1: PERIPHERAL PIN SELECT OUTPUT REGISTER 1**

| U-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | RP3R<4:0>(1) | | | | |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | RP2R<4:0>(1) | | | | |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15-13 **Unimplemented:** Read as ‘0’

bit 12-8 **RP3R<4:0>:** Peripheral Output Function is Assigned to RP3 Output Pin bits(1)
(see Table 10-2 for peripheral function numbers)

bit 7-5 **Unimplemented:** Read as ‘0’

bit 4-0 **RP2R<4:0>:** Peripheral Output Function is Assigned to RP2 Output Pin bits(1)
(see Table 10-2 for peripheral function numbers)

**Note 1:** These bits are not available in dsPIC33FJXX(GP/MC)101 devices.

**REGISTER 10-13: RPOR2: PERIPHERAL PIN SELECT OUTPUT REGISTER 2**

| U-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | RP5R<4:0>(1) | | | | |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | RP4R<4:0> | | | | |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15-13 **Unimplemented:** Read as '0'

bit 12-8 **RP5R<4:0>:** Peripheral Output Function is Assigned to RP5 Output Pin bits(1)
(see Table 10-2 for peripheral function numbers)

bit 7-5 **Unimplemented:** Read as '0'

bit 4-0 **RP4R<4:0>:** Peripheral Output Function is Assigned to RP4 Output Pin bits
(see Table 10-2 for peripheral function numbers)

**Note 1:** These bits are not available in dsPIC33FJ(16/32)(GP/MC)101 devices.

**REGISTER 10-14: RPOR3: PERIPHERAL PIN SELECT OUTPUT REGISTER 3**

| U-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | RP7R<4:0> | | | | |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | RP6R<4:0>(1) | | | | |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15-13 **Unimplemented:** Read as '0'

bit 12-8 **RP7R<4:0>:** Peripheral Output Function is Assigned to RP7 Output Pin bits
(see Table 10-2 for peripheral function numbers)

bit 7-5 **Unimplemented:** Read as '0'

bit 4-0 **RP6R<4:0>:** Peripheral Output Function is Assigned to RP6 Output Pin bits(1)
(see Table 10-2 for peripheral function numbers)

**Note 1:** These bits are not available in dsPIC33FJ(16/32)(GP/MC)101 devices.


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**REGISTER 10-15: RPOR4: PERIPHERAL PIN SELECT OUTPUT REGISTER 4**

| U-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | RP9R<4:0> | | | | |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | RP8R<4:0> | | | | |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15-13 **Unimplemented:** Read as ‘0’

bit 12-8 **RP9R<4:0>:** Peripheral Output Function is Assigned to RP9 Output Pin bits (see Table 10-2 for peripheral function numbers)

bit 7-5 **Unimplemented:** Read as ‘0’

bit 4-0 **RP8R<4:0>:** Peripheral Output Function is Assigned to RP8 Output Pin bits (see Table 10-2 for peripheral function numbers)

**REGISTER 10-16: RPOR5: PERIPHERAL PIN SELECT OUTPUT REGISTER 5**

| U-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | RP11R<4:0>(1) | | | | |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | RP10R<4:0>(1) | | | | |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15-13 **Unimplemented:** Read as ‘0’

bit 12-8 **RP11R<4:0>:** Peripheral Output Function is Assigned to RP11 Output Pin bits(1) (see Table 10-2 for peripheral function numbers)

bit 7-5 **Unimplemented:** Read as ‘0’

bit 4-0 **RP10R<4:0>:** Peripheral Output Function is Assigned to RP10 Output Pin bits(1) (see Table 10-2 for peripheral function numbers)

**Note 1:** These bits are not available in dsPIC33FJXX(GP/MC)101 devices.

**REGISTER 10-17: RPOR6: PERIPHERAL PIN SELECT OUTPUT REGISTER 6**

| U-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | RP13R<4:0>(1) | | | | |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | RP12R<4:0>(1) | | | | |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15-13 **Unimplemented:** Read as '0'

bit 12-8 **RP13R<4:0>:** Peripheral Output Function is Assigned to RP13 Output Pin bits(1)
(see Table 10-2 for peripheral function numbers)

bit 7-5 **Unimplemented:** Read as '0'

bit 4-0 **RP12R<4:0>:** Peripheral Output Function is Assigned to RP12 Output Pin bits(1)
(see Table 10-2 for peripheral function numbers)

**Note 1:** These bits are not available in dsPIC33FJXXGP101 devices.

**REGISTER 10-18: RPOR7: PERIPHERAL PIN SELECT OUTPUT REGISTER 7**

| U-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | RP15R<4:0> | | | | |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | RP14R<4:0> | | | | |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15-13 **Unimplemented:** Read as '0'

bit 12-8 **RP15R<4:0>:** Peripheral Output Function is Assigned to RP15 Output Pin bits
(see Table 10-2 for peripheral function numbers)

bit 7-5 **Unimplemented:** Read as '0'

bit 4-0 **RP14R<4:0>:** Peripheral Output Function is Assigned to RP14 Output Pin bits
(see Table 10-2 for peripheral function numbers)


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**REGISTER 10-19: RPOR8: PERIPHERAL PIN SELECT OUTPUT REGISTER 8**

| U-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | RP17R<4:0>(1) | | | | |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | RP16R<4:0>(1) | | | | |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15-13 **Unimplemented:** Read as '0'

bit 12-8 **RP17R<4:0>:** Peripheral Output Function is Assigned to RP17 Output Pin bits(1)
(see Table 10-2 for peripheral function numbers)

bit 7-5 **Unimplemented:** Read as '0'

bit 4-0 **RP16R<4:0>:** Peripheral Output Function is Assigned to RP16 Output Pin bits(1)
(see Table 10-2 for peripheral function numbers)

**Note 1:** These bits are available in dsPIC33FJ32(GP/MC)104 devices only.

**REGISTER 10-20: RPOR9: PERIPHERAL PIN SELECT OUTPUT REGISTER 9**

| U-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | RP19R<4:0>(1) | | | | |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | RP18R<4:0>(1) | | | | |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15-13 **Unimplemented:** Read as '0'

bit 12-8 **RP19R<4:0>:** Peripheral Output Function is Assigned to RP19 Output Pin bits(1)
(see Table 10-2 for peripheral function numbers)

bit 7-5 **Unimplemented:** Read as '0'

bit 4-0 **RP18R<4:0>:** Peripheral Output Function is Assigned to RP18 Output Pin bits(1)
(see Table 10-2 for peripheral function numbers)

**Note 1:** These bits are available in dsPIC33FJ32(GP/MC)104 devices only.

**REGISTER 10-21: RPOR10: PERIPHERAL PIN SELECT OUTPUT REGISTER 10**

| U-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | RP21R<4:0>(1) | | | | |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | RP20R<4:0>(1) | | | | |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15-13 **Unimplemented:** Read as '0'

bit 12-8 **RP21R<4:0>:** Peripheral Output Function is Assigned to RP21 Output Pin bits(1)
(see Table 10-2 for peripheral function numbers)

bit 7-5 **Unimplemented:** Read as '0'

bit 4-0 **RP20R<4:0>:** Peripheral Output Function is Assigned to RP20 Output Pin bits(1)
(see Table 10-2 for peripheral function numbers)

**Note 1:** These bits are available in dsPIC33FJ32(GP/MC)104 devices only.

**REGISTER 10-22: RPOR11: PERIPHERAL PIN SELECT OUTPUT REGISTER 11**

| U-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | RP23R<4:0>(1) | | | | |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | RP22R<4:0>(1) | | | | |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15-13 **Unimplemented:** Read as '0'

bit 12-8 **RP23R<4:0>:** Peripheral Output Function is Assigned to RP23 Output Pin bits(1)
(see Table 10-2 for peripheral function numbers)

bit 7-5 **Unimplemented:** Read as '0'

bit 4-0 **RP22R<4:0>:** Peripheral Output Function is Assigned to RP22 Output Pin bits(1)
(see Table 10-2 for peripheral function numbers)

**Note 1:** These bits are available in dsPIC33FJ32(GP/MC)104 devices only.


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**REGISTER 10-23: RPOR12: PERIPHERAL PIN SELECT OUTPUT REGISTER 12**

| U-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | RP25R<4:0>(1) | | | | |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | RP24R<4:0>(1) | | | | |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15-13 **Unimplemented:** Read as '0'

bit 12-8 **RP25R<4:0>:** Peripheral Output Function is Assigned to RP25 Output Pin bits(1)
(see Table 10-2 for peripheral function numbers)

bit 7-5 **Unimplemented:** Read as '0'

bit 4-0 **RP24R<4:0>:** Peripheral Output Function is Assigned to RP24 Output Pin bits(1)
(see Table 10-2 for peripheral function numbers)

**Note 1:** These bits are available in dsPIC33FJ32(GP/MC)104 devices only.

**NOTES:**


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## 11.0 TIMER1

**Note 1:** This data sheet summarizes the features of the dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 family devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **"Timers"** (DS70205) in the *"dsPIC33/PIC24 Family Reference Manual"*, which is available from the Microchip web site (www.microchip.com).

**2:** Some registers and associated bits described in this section may not be available on all devices. Refer to **Section 4.0 "Memory Organization"** in this data sheet for device-specific register and bit information.

The Timer1 module is a 16-bit timer, which can serve as the time counter for the Real-Time Clock (RTC) or operate as a free-running interval timer/counter. Timer1 can operate in three modes:

- 16-Bit Timer
- 16-Bit Synchronous Counter
- 16-Bit Asynchronous Counter

Timer1 also supports these features:

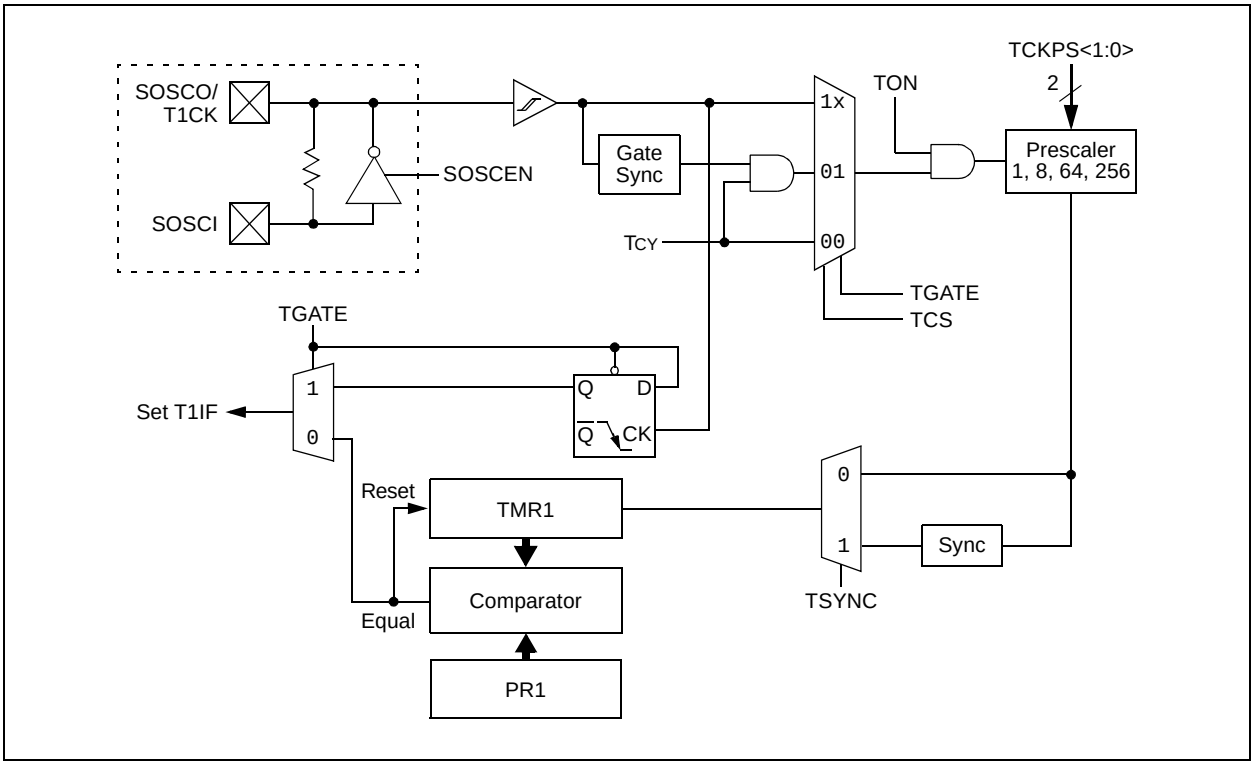
- Timer gate operation
- Selectable prescaler settings
- Timer operation during CPU Idle and Sleep modes
- Interrupt on 16-bit Period register match or falling edge of external gate signal

Figure 11-1 presents a block diagram of the 16-bit timer module.

To configure Timer1 for operation:

1. Load the timer value into the TMR1 register.
2. Load the timer period value into the PR1 register.
3. Select the timer prescaler ratio using the TCKPS<1:0> bits in the T1CON register.
4. Set the Clock and Gating modes using the TCS and TGATE bits in the T1CON register.
5. Set or clear the TSYNC bit in T1CON to select synchronous or asynchronous operation.
6. If interrupts are required, set the Timer1 Interrupt Enable bit, T1IE. Use the Timer1 Interrupt Priority bits, T1IP<2:0>, to set the interrupt priority.
7. Set the TON bit (= 1) in the T1CON register.

**FIGURE 11-1: 16-BIT TIMER1 MODULE BLOCK DIAGRAM**



## 11.1 Timer1 Control Register

**REGISTER 11-1: T1CON: TIMER1 CONTROL REGISTER**

| R/W-0 | U-0 | R/W-0 | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| TON(1) | — | TSIDL | — | — | — | — | — |
| bit 15 | | | | | | | bit 8 |

| U-0 | R/W-0 | R/W-0 | R/W-0 | U-0 | R/W-0 | R/W-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | TGATE | TCKPS1 | TCKPS0 | — | TSYNC | TCS(1) | — |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15 **TON:** Timer1 On bit(1)
1 = Starts 16-bit Timer1
0 = Stops 16-bit Timer1

bit 14 **Unimplemented:** Read as '0'

bit 13 **TSIDL:** Timer1 Stop in Idle Mode bit
1 = Discontinues module operation when device enters Idle mode
0 = Continues module operation in Idle mode

bit 12-7 **Unimplemented:** Read as '0'

bit 6 **TGATE:** Timer1 Gated Time Accumulation Enable bit
When TCS = 1:
This bit is ignored.
When TCS = 0:
1 = Gated time accumulation is enabled
0 = Gated time accumulation is disabled

bit 5-4 **TCKPS<1:0>** Timer1 Input Clock Prescale Select bits
11 = 1:256
10 = 1:64
01 = 1:8
00 = 1:1

bit 3 **Unimplemented:** Read as '0'

bit 2 **TSYNC:** Timer1 External Clock Input Synchronization Select bit
When TCS = 1:
1 = Synchronizes external clock input
0 = Does not synchronize external clock input
When TCS = 0:
This bit is ignored.

bit 1 **TCS:** Timer1 Clock Source Select bit(1)
1 = External clock from pin, T1CK (on the rising edge)
0 = Internal clock (FCY)

bit 0 **Unimplemented:** Read as '0'

**Note 1:** When TCS = 1 and TON = 1, writes to the TMR1 register are inhibited from the CPU.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## 12.0 TIMER2/3 AND TIMER4/5

**Note 1:** This data sheet summarizes the features of the dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 family devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **"Timers"** (DS70205) in the *"dsPIC33/PIC24 Family Reference Manual"*, which is available from the Microchip web site (www.microchip.com).

**2:** Some registers and associated bits described in this section may not be available on all devices. Refer to **Section 4.0 "Memory Organization"** in this data sheet for device-specific register and bit information.

Timer2/3 and Timer4/5 have three 2-bit timers that can also be configured as two independent 16-bit timers with selectable operating modes.

**Note 1:** Timer4 and Timer5 are available in dsPIC33FJ32(GP/MC10X) devices only.

As a 32-bit timer, Timer2/3 and Timer4/5 permit operation in three modes:

- Two independent 16-bit timers (e.g., Timer2 and Timer3 or Timer4 and Timer5) with all 16-bit operating modes (except Asynchronous Counter mode)
- Single 32-bit timer (Timer2/3 and Timer4/5)
- Single 32-bit synchronous counter (Timer2/3 and Timer4/5)

Timer2/3 and Timer4/5 also support:

- Timer gate operation
- Selectable prescaler settings
- Timer operation during Idle and Sleep modes
- Interrupt on a 32-bit Period register match
- Time base for input capture and output compare modules (Timer2 and Timer3 only)
- ADC1 event trigger (Timer2/3 only)

Individually, all eight of the 16-bit timers can function as synchronous timers or counters. They also offer the features listed above, except for the event trigger. The operating modes and enabled features are determined by setting the appropriate bit(s) in the T2CON, T3CON, T4CON and T5CON registers (see Register 12-1 through Register 12-4).

For 32-bit timer/counter operation, Timer2/4 is the least significant word (lsw) and Timer3/5 is the most significant word (msw) of the 32-bit timers.

**Note:** For 32-bit operation, T3CON and T5CON control bits are ignored. Only T2CON and T4CON control bits are used for setup and control. Timer2 and Timer4 clock and gate inputs are used for the 32-bit timer modules, but an interrupt is generated with the Timer3 and Timer5 interrupt flags.

### 12.1 32-Bit Operation

To configure Timer2/3 and Timer4/5 for 32-bit operation:

1. Set the T32 control bit.
2. Select the prescaler ratio for Timer2 or Timer4 using the TCKPS<1:0> bits.
3. Set the Clock and Gating modes using the corresponding TCS and TGATE bits.
4. Load the timer period value. PR3/PR5 contains the msw of the value, while PR2/PR4 contains the least significant word (lsw).
5. If interrupts are required, set the Timer3 (or Timer5) Interrupt Enable bit, T3IE (or T5IE). Use the priority bits, T3IP<2:0> or T5IP<2:0>, to set the interrupt priority. While Timer2/Timer4 controls the timer, the interrupt appears as a Timer3/Timer5 interrupt.
6. Set the corresponding TON bit.

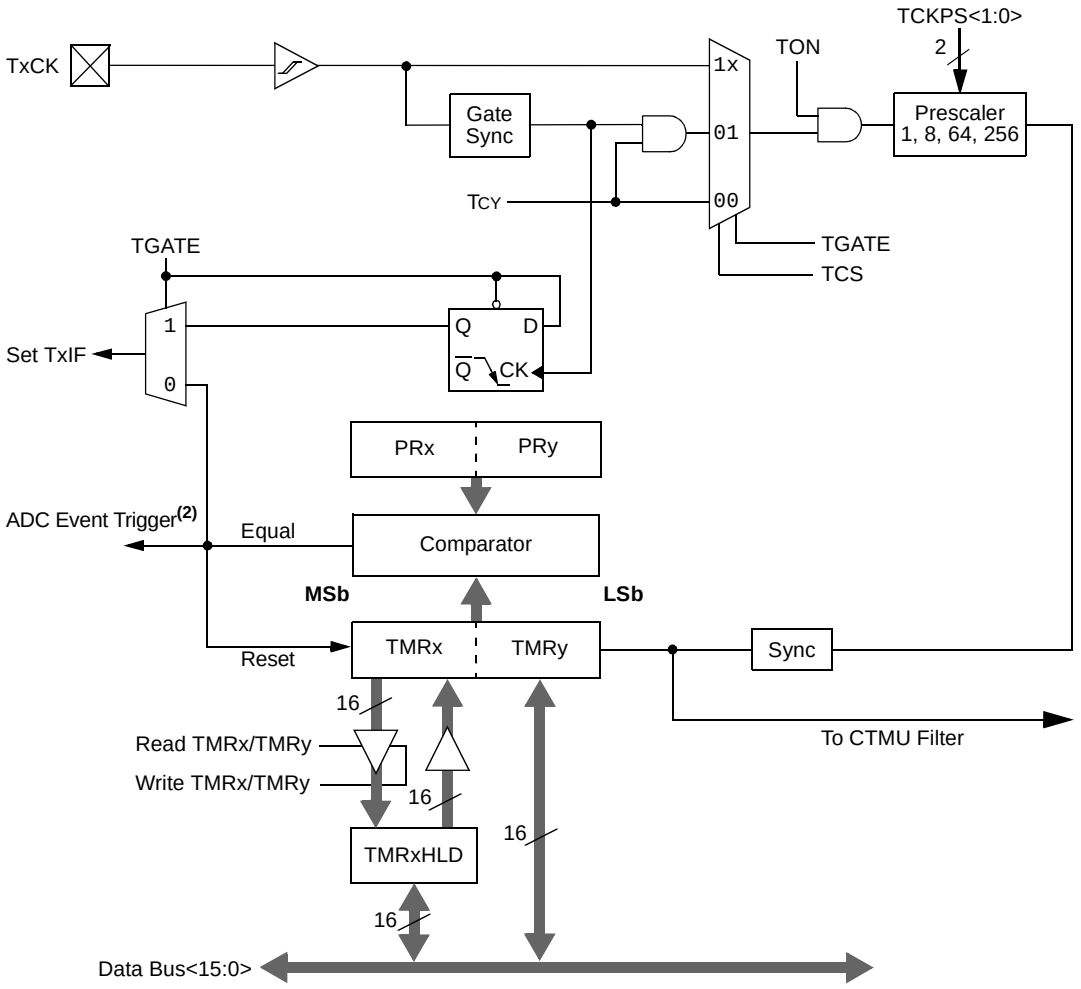
The timer value at any point is stored in the register pair, TMR3:TMR2 or TMR5:TMR4, which always contains the msw of the count, while TMR2 or TMR4 contains the lsw.

### 12.2 16-Bit Operation

To configure any of the timers for individual 16-bit operation:

1. Clear the T32 bit corresponding to that timer.
2. Select the timer prescaler ratio using the TCKPS<1:0> bits.
3. Set the Clock and Gating modes using the TCS and TGATE bits.
4. Load the timer period value into the PRx register.
5. If interrupts are required, set the Timerx Interrupt Enable bit, TxIE. Use the priority bits, TxIP<2:0>, to set the interrupt priority.
6. Set the TON bit.

**FIGURE 12-1: TIMER2/3 AND TIMER4/5 (32-BIT) BLOCK DIAGRAM(1,3,4)**




**Note 1:** The 32-bit timer control bit, T32, must be set for 32-bit timer/counter operation. All control bits are respective to the TxCON register.

**2:** The ADC event trigger is available only on Timer2/3.

**3:** Timer4/5 is available in dsPIC33FJ32(GP/MC)10X devices only.

**4:** Where ‘x’ or ‘y’ is present, x = 2 or 4; y = 3 or 5.


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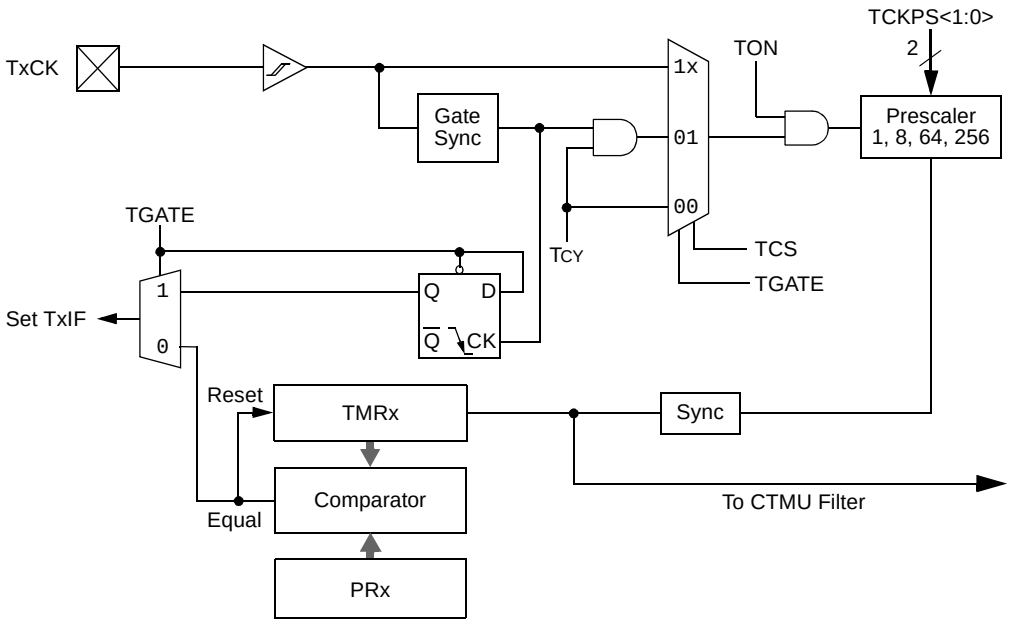
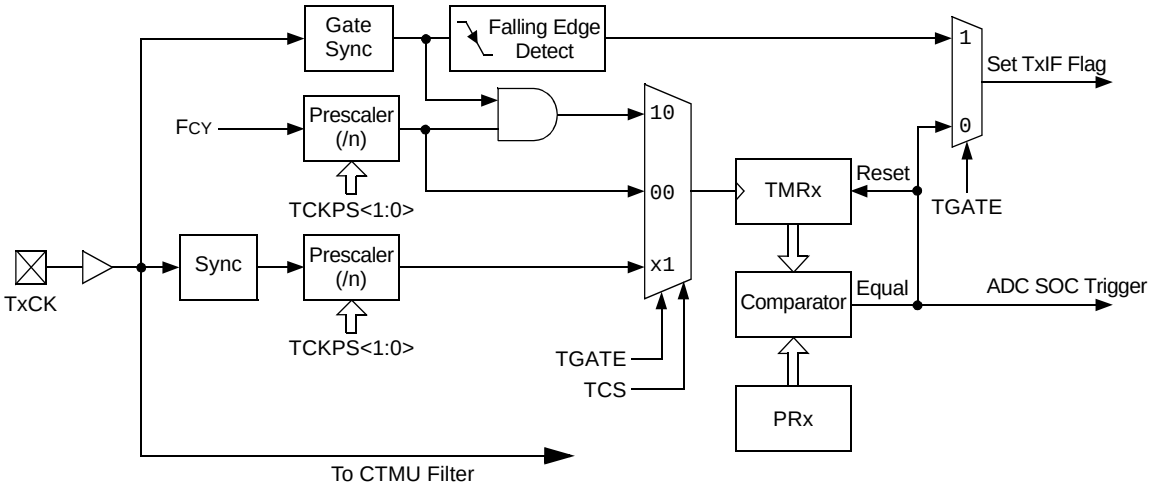
**FIGURE 12-2: TIMER2 AND TIMER4 (16-BIT) BLOCK DIAGRAM(1)**




**Note 1:** Timer4 is available in dsPIC33FJ32(GP/MC)10X devices only.

**FIGURE 12-3: TIMER3 AND TIMER5 (16-BIT) BLOCK DIAGRAM(1)**




**Note 1:** Timer5 is available in dsPIC33FJ32(GP/MC)10X devices only.

## 12.3 Timer2/3 and Timer4/5 Control Registers

**REGISTER 12-1: T2CON: TIMER2 CONTROL REGISTER**

| R/W-0 | U-0 | R/W-0 | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| TON | — | TSIDL | — | — | — | — | — |
| bit 15 | | | | | | | bit 8 |

| U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | U-0 | R/W-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | TGATE | TCKPS1 | TCKPS0 | T32 | — | TCS | — |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15 **TON:** Timer2 On bit
When T32 = 1:
1 = Starts 32-bit Timer2/3
0 = Stops 32-bit Timer2/3
When T32 = 0:
1 = Starts 16-bit Timer2
0 = Stops 16-bit Timer2

bit 14 **Unimplemented:** Read as '0'

bit 13 **TSIDL:** Timer2 Stop in Idle Mode bit
1 = Discontinues module operation when device enters Idle mode
0 = Continues module operation in Idle mode

bit 12-7 **Unimplemented:** Read as '0'

bit 6 **TGATE:** Timer2 Gated Time Accumulation Enable bit
When TCS = 1:
This bit is ignored.
When TCS = 0:
1 = Gated time accumulation is enabled
0 = Gated time accumulation is disabled

bit 5-4 **TCKPS<1:0>:** Timer2 Input Clock Prescale Select bits
11 = 1:256
10 = 1:64
01 = 1:8
00 = 1:1

bit 3 **T32:** 32-Bit Timer Mode Select bit
1 = Timer2 and Timer3 form a single 32-bit timer
0 = Timer2 and Timer3 act as two 16-bit timers

bit 2 **Unimplemented:** Read as '0'

bit 1 **TCS:** Timer2 Clock Source Select bit
1 = External clock from pin, T2CK (on the rising edge)
0 = Internal clock (FCY)

bit 0 **Unimplemented:** Read as '0'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**REGISTER 12-2: T3CON: TIMER3 CONTROL REGISTER**

| R/W-0 | U-0 | R/W-0 | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| TON(2) | — | TSIDL(1) | — | — | — | — | — |
| bit 15 | | | | | | | bit 8 |

| U-0 | R/W-0 | R/W-0 | R/W-0 | U-0 | U-0 | R/W-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | TGATE(2) | TCKPS1(2) | TCKPS0(2) | — | — | TCS(2) | — |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15 **TON:** Timer3 On bit(2)
1 = Starts 16-bit Timer3
0 = Stops 16-bit Timer3

bit 14 **Unimplemented:** Read as '0'

bit 13 **TSIDL:** Timer3 Stop in Idle Mode bit(1)
1 = Discontinues timer operation when device enters Idle mode
0 = Continues timer operation in Idle mode

bit 12-7 **Unimplemented:** Read as '0'

bit 6 **TGATE:** Timer3 Gated Time Accumulation Enable bit(2)
When TCS = 1:
This bit is ignored.
When TCS = 0:
1 = Gated time accumulation is enabled
0 = Gated time accumulation is disabled

bit 5-4 **TCKPS<1:0>:** Timer3 Input Clock Prescale Select bits(2)
11 = 1:256 prescale value
10 = 1:64 prescale value
01 = 1:8 prescale value
00 = 1:1 prescale value

bit 3-2 **Unimplemented:** Read as '0'

bit 1 **TCS:** Timer3 Clock Source Select bit(2)
1 = External clock from T3CK pin
0 = Internal clock (FOSC/2)

bit 0 **Unimplemented:** Read as '0'

**Note 1:** When 32-bit timer operation is enabled (T32 = 1) in the Timer2 Control register (T2CON<3>), the TSIDL bit must be cleared to operate the 32-bit timer in Idle mode.

**2:** When the 32-bit timer operation is enabled (T32 = 1) in the Timer2 Control register (T2CON<3>), these bits have no effect.

**REGISTER 12-3: T4CON: TIMER4 CONTROL REGISTER(1)**

| R/W-0 | U-0 | R/W-0 | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| TON | — | TSIDL | — | — | — | — | — |
| bit 15 | | | | | | | bit 8 |

| U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | U-0 | R/W-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | TGATE | TCKPS1 | TCKPS0 | T32 | — | TCS | — |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15 **TON:** Timer4 On bit
When T32 = 1:
1 = Starts 32-bit Timer4/5
0 = Stops 32-bit Timer4/5
When T32 = 0:
1 = Starts 16-bit Timer4
0 = Stops 16-bit Timer4

bit 14 **Unimplemented:** Read as '0'

bit 13 **TSIDL:** Timer4 Stop in Idle Mode bit
1 = Discontinues module operation when device enters Idle mode
0 = Continues module operation in Idle mode

bit 12-7 **Unimplemented:** Read as '0'

bit 6 **TGATE:** Timer4 Gated Time Accumulation Enable bit
When TCS = 1:
This bit is ignored.
When TCS = 0:
1 = Gated time accumulation is enabled
0 = Gated time accumulation is disabled

bit 5-4 **TCKPS<1:0>:** Timer4 Input Clock Prescale Select bits
11 = 1:256
10 = 1:64
01 = 1:8
00 = 1:1

bit 3 **T32:** 32-Bit Timer Mode Select bit
1 = Timer4 and Timer5 form a single 32-bit timer
0 = Timer4 and Timer5 act as two 16-bit timers

bit 2 **Unimplemented:** Read as '0'

bit 1 **TCS:** Timer4 Clock Source Select bit
1 = External clock from pin, T4CK (on the rising edge)
0 = Internal clock (FCY)

bit 0 **Unimplemented:** Read as '0'

**Note 1:** This register is available in dsPIC33FJ32(GP/MC)10X devices only.


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**REGISTER 12-4: T5CON: TIMER5 CONTROL REGISTER(1)**

| R/W-0 | U-0 | R/W-0 | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| TON(3) | — | TSIDL(2) | — | — | — | — | — |
| bit 15 | | | | | | | bit 8 |

| U-0 | R/W-0 | R/W-0 | R/W-0 | U-0 | U-0 | R/W-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | TGATE(3) | TCKPS1(3) | TCKPS0(3) | — | — | TCS(3) | — |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15 **TON:** Timer5 On bit(3)
1 = Starts 16-bit Timer3
0 = Stops 16-bit Timer3

bit 14 **Unimplemented:** Read as '0'

bit 13 **TSIDL:** Timer5 Stop in Idle Mode bit(2)
1 = Discontinues timer operation when device enters Idle mode
0 = Continues timer operation in Idle mode

bit 12-7 **Unimplemented:** Read as '0'

bit 6 **TGATE:** Timer5 Gated Time Accumulation Enable bit(3)
When TCS = 1:
This bit is ignored.
When TCS = 0:
1 = Gated time accumulation is enabled
0 = Gated time accumulation is disabled

bit 5-4 **TCKPS<1:0>:** Timer5 Input Clock Prescale Select bits(3)
11 = 1:256 prescale value
10 = 1:64 prescale value
01 = 1:8 prescale value
00 = 1:1 prescale value

bit 3-2 **Unimplemented:** Read as '0'

bit 1 **TCS:** Timer5 Clock Source Select bit(3)
1 = External clock from T5CK pin
0 = Internal clock (FOSC/2)

bit 0 **Unimplemented:** Read as '0'

**Note 1:** This register is available in dsPIC33FJ32(GP/MC)10X devices only.

**2:** When 32-bit timer operation is enabled (T32 = 1) in the Timer4 Control register (T4CON<3>), the TSIDL bit must be cleared to operate the 32-bit timer in Idle mode.

**3:** When the 32-bit timer operation is enabled (T32 = 1) in the Timer4 Control register (T4CON<3>), these bits have no effect.

**NOTES:**


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## 13.0 INPUT CAPTURE

**Note 1:** This data sheet summarizes the features of the dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 family devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **"Input Capture"** (DS70198) in the *"dsPIC33/PIC24 Family Reference Manual"*, which is available from the Microchip web site (www.microchip.com).

**2:** Some registers and associated bits described in this section may not be available on all devices. Refer to **Section 4.0 "Memory Organization"** in this data sheet for device-specific register and bit information.

The input capture module is useful in applications requiring frequency (period) and pulse measurement. The dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 devices support up to three input capture channels.

The input capture module captures the 16-bit value of the selected Time Base register when an event occurs on the ICx pin. The events that cause a capture event are listed below in three categories:

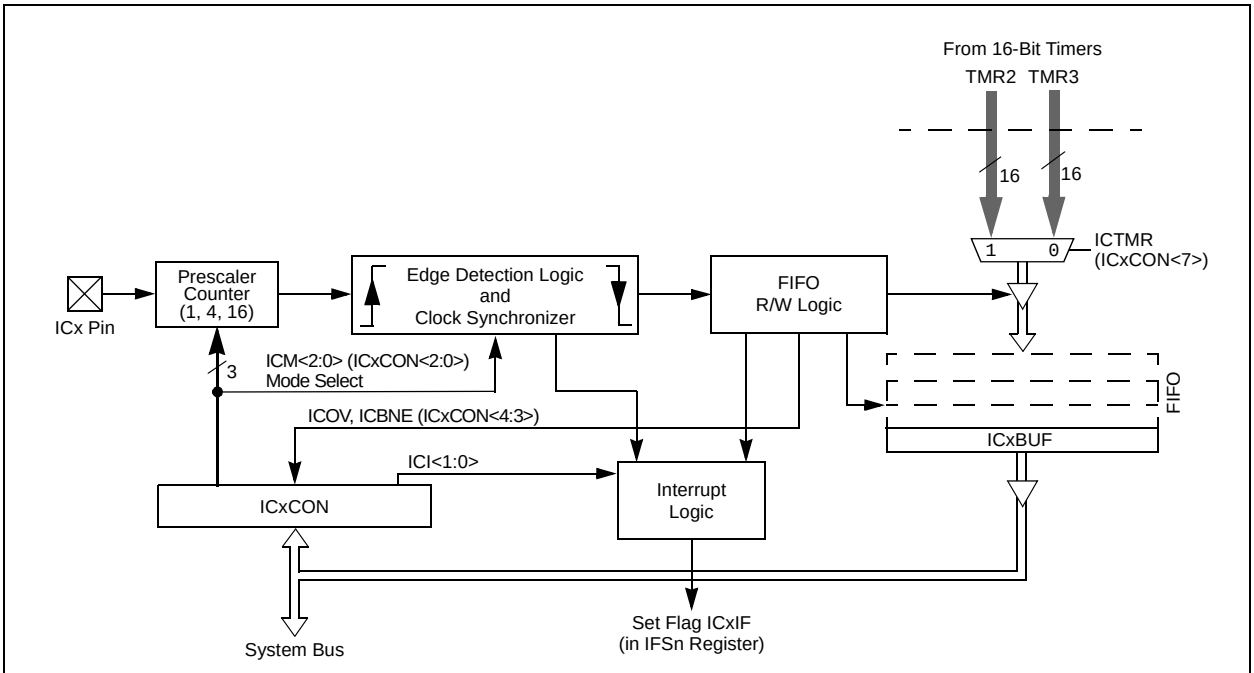
1. Simple Capture Event modes:
   - Capture timer value on every falling edge of input at ICx pin
   - Capture timer value on every rising edge of input at ICx pin
2. Capture timer value on every edge (rising and falling).
3. Prescaler Capture Event modes:
   - Capture timer value on every 4th rising edge of input at ICx pin
   - Capture timer value on every 16th rising edge of input at ICx pin

Each input capture channel can select one of two 16-bit timers (Timer2 or Timer3) for the time base. The selected timer can use either an internal or external clock.

Other operational features include:

- Device wake-up from capture pin during CPU Sleep and Idle modes
- Interrupt on input capture event
- 4-word FIFO buffer for capture values:
  - Interrupt optionally generated after 1, 2, 3 or 4 buffer locations are filled
- Use of input capture to provide additional sources of external interrupts

**FIGURE 13-1: INPUT CAPTURE x BLOCK DIAGRAM**




**Note:** An 'x' in a signal, register or bit name denotes the number of the input capture channel.

## 13.1 Input Capture Control Register

**REGISTER 13-1: ICxCON: INPUT CAPTURE x CONTROL REGISTER**

| U-0 | U-0 | R/W-0 | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | — | ICSIDL | — | — | — | — | — |
| bit 15 | | | | | | | bit 8 |

| R/W-0 | R/W-0 | R/W-0 | R-0, HC | R-0, HC | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| ICTMR | ICI1 | ICI0 | ICOV | ICBNE | ICM2 | ICM1 | ICM0 |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | HC = Hardware Clearable bit | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15-14 **Unimplemented:** Read as '0'

bit 13 **ICSIDL:** Input Capture x Stop in Idle Control bit
1 = Input Capture x module will halt in CPU Idle mode
0 = Input Capture x module will continue to operate in CPU Idle mode

bit 12-8 **Unimplemented:** Read as '0'

bit 7 **ICTMR:** Input Capture x Timer Select bits
1 = TMR2 contents are captured on a capture event
0 = TMR3 contents are captured on a capture event

bit 6-5 **ICI<1:0>:** Select Number of Captures per Interrupt bits
11 = Interrupt on every fourth capture event
10 = Interrupt on every third capture event
01 = Interrupt on every second capture event
00 = Interrupt on every capture event

bit 4 **ICOV:** Input Capture x Overflow Status Flag bit (read-only)
1 = Input Capture x overflow occurred
0 = No Input Capture x overflow occurred

bit 3 **ICBNE:** Input Capture x Buffer Empty Status bit (read-only)
1 = Input Capture x buffer is not empty, at least one more capture value can be read
0 = Input Capture x buffer is empty

bit 2-0 **ICM<2:0>:** Input Capture x Mode Select bits
111 = Input Capture x functions as an interrupt pin only when device is in Sleep or Idle mode (rising edge detect only, all other control bits are not applicable)
110 = Unused (module is disabled)
101 = Capture mode, every 16th rising edge
100 = Capture mode, every 4th rising edge
011 = Capture mode, every rising edge
010 = Capture mode, every falling edge
001 = Capture mode, every edge, rising and falling (ICI<1:0> bits do not control interrupt generation for this mode)
000 = Input Capture x module is turned off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## 14.0 OUTPUT COMPARE

**Note 1:** This data sheet summarizes the features of the dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 family devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **"Output Compare"** (DS70209) in the *"dsPIC33/PIC24 Family Reference Manual"*, which is available from the Microchip web site (www.microchip.com).

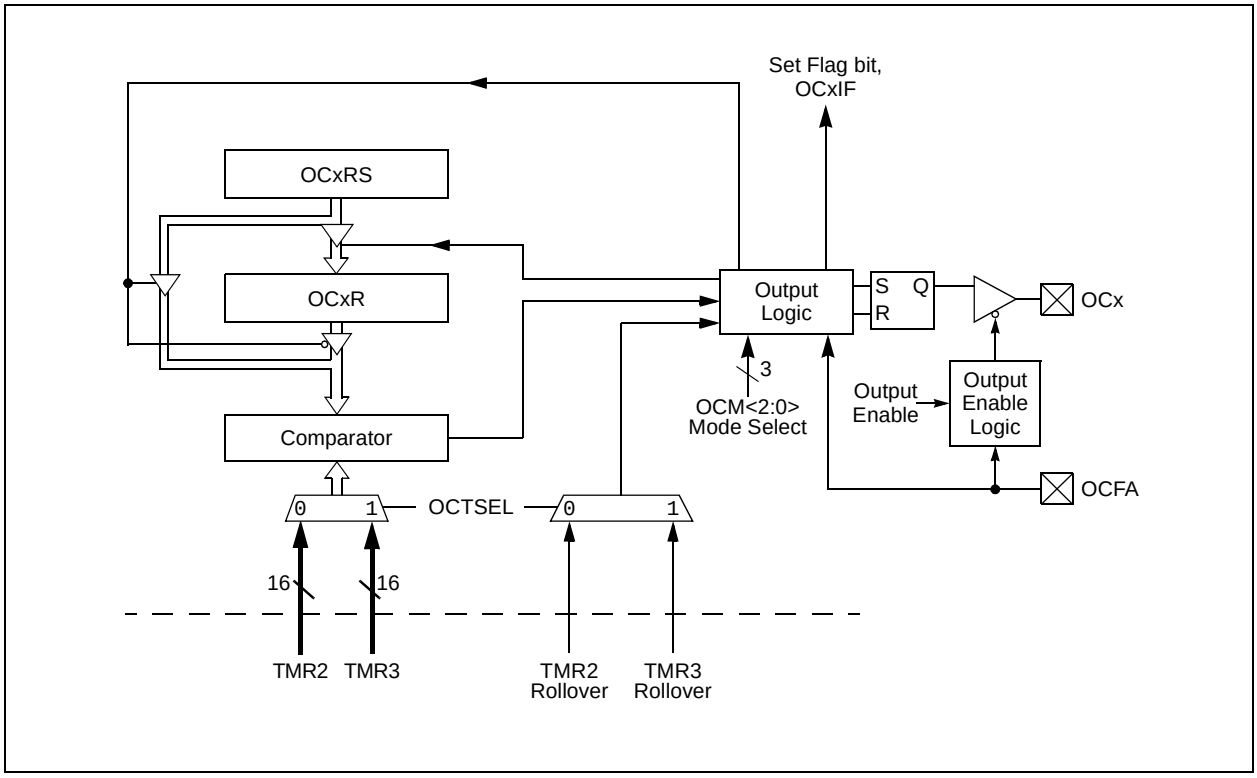
**2:** Some registers and associated bits described in this section may not be available on all devices. Refer to **Section 4.0 "Memory Organization"** in this data sheet for device-specific register and bit information.

The output compare module can select either Timer2 or Timer3 for its time base. The module compares the value of the timer with the value of one or two compare registers depending on the operating mode selected. The state of the output pin changes when the timer value matches the Output Compare Control register value. The output compare module generates either a single output pulse, or a sequence of output pulses, by changing the state of the output pin on the compare match events. The output compare module can also generate interrupts on compare match events.

The output compare module has multiple operating modes:

- Active-Low One-Shot mode
- Active-High One-Shot mode
- Toggle mode
- Delayed One-Shot mode
- Continuous Pulse mode
- PWM mode without Fault Protection
- PWM mode with Fault Protection

**FIGURE 14-1: OUTPUT COMPARE x MODULE BLOCK DIAGRAM**



## 14.1 Output Compare Modes

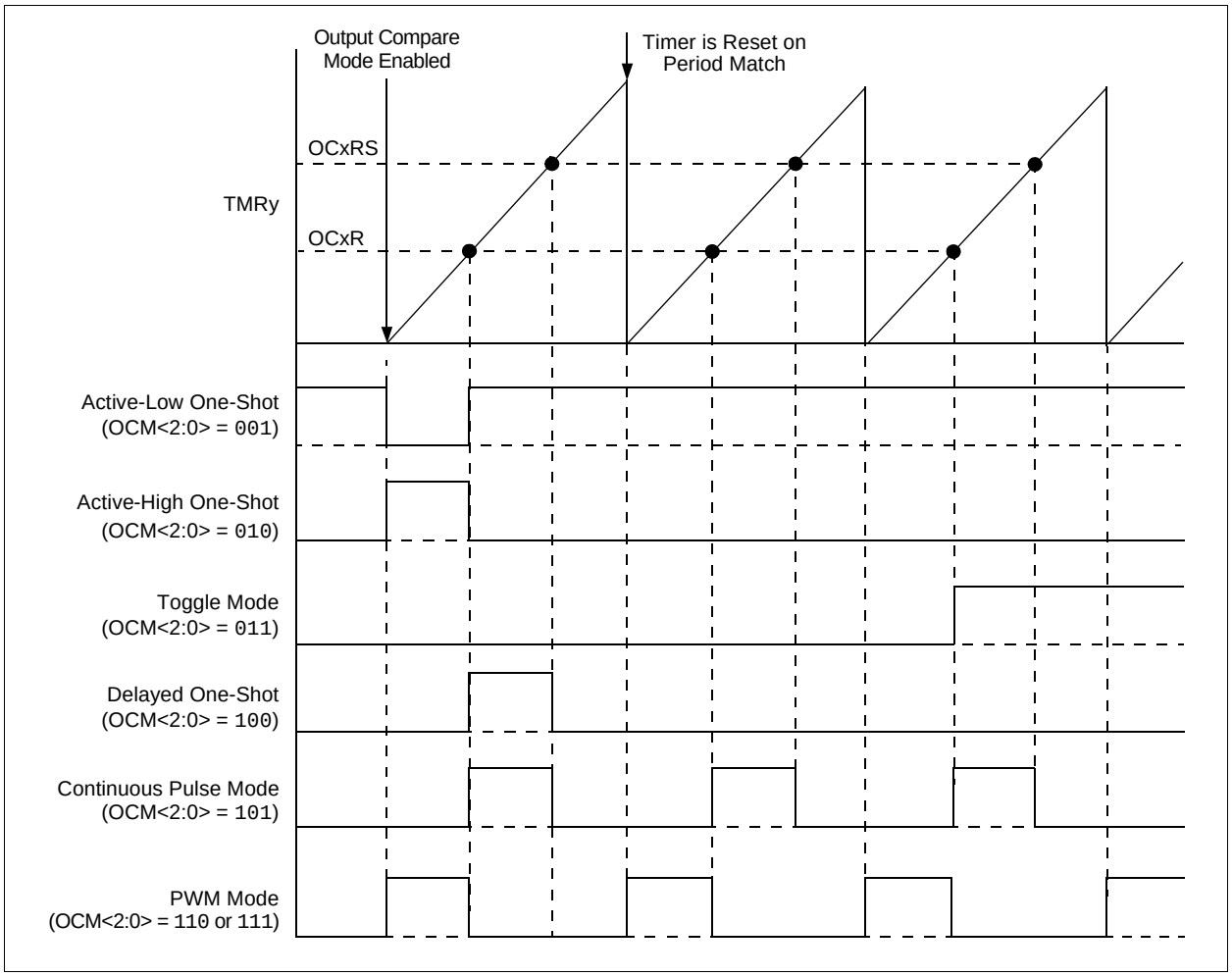
Configure the Output Compare modes by setting the appropriate Output Compare Mode bits (OCM<2:0>) in the Output Compare x Control (OCxCON<2:0>) register. Table 14-1 lists the different bit settings for the Output Compare modes. Figure 14-2 illustrates the output compare operation for various modes. The user application must disable the associated timer when writing to the Output Compare Control registers to avoid malfunctions.

| **Note:** | See **"Output Compare"** in the *"dsPIC33/PIC24 Family Reference Manual"* (DS70209) for OCxR and OCxRS register restrictions. |
|---|---|

**TABLE 14-1: OUTPUT COMPARE x MODES**

| OCM<2:0> | Mode | OCx Pin Initial State | OCx Interrupt Generation |
|---|---|---|---|
| 000 | Module Disabled | Controlled by GPIO register | — |
| 001 | Active-Low One-Shot | 0 | OCx Rising Edge |
| 010 | Active-High One-Shot | 1 | OCx Falling Edge |
| 011 | Toggle | Current output is maintained | OCx Rising and Falling Edge |
| 100 | Delayed One-Shot | 0 | OCx Falling Edge |
| 101 | Continuous Pulse | 0 | OCx Falling Edge |
| 110 | PWM without Fault Protection | 0, if OCxR is zero<br>1, if OCxR is non-zero | No Interrupt |
| 111 | PWM with Fault Protection | 0, if OCxR is zero<br>1, if OCxR is non-zero | OCFA Falling Edge for OC1 to OC4 |

**FIGURE 14-2: OUTPUT COMPARE x OPERATION**





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## 14.2 Output Compare Control Register

**REGISTER 14-1: OCxCON: OUTPUT COMPARE x CONTROL REGISTER**

| U-0 | U-0 | R/W-0 | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | — | OCSIDL | — | — | — | — | — |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | R-0, HC | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | OCFLT | OCTSEL | OCM2 | OCM1 | OCM0 |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | HC = Hardware Clearable bit | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15-14 **Unimplemented:** Read as '0'

bit 13 **OCSIDL:** Output Compare x Stop in Idle Mode Control bit
1 = Output Compare x will halt in CPU Idle mode
0 = Output Compare x will continue to operate in CPU Idle mode

bit 12-5 **Unimplemented:** Read as '0'

bit 4 **OCFLT:** PWM Fault Condition Status bit
1 = PWM Fault condition has occurred (cleared in hardware only)
0 = No PWM Fault condition has occurred
(This bit is only used when OCM<2:0> = 111.)

bit 3 **OCTSEL:** Output Compare x Timer Selection bit
1 = Timer3 is the clock source for Output Compare x
0 = Timer2 is the clock source for Output Compare x

bit 2-0 **OCM<2:0>:** Output Compare x Mode Select bits
111 = PWM mode on OCx, Fault pin is enabled
110 = PWM mode on OCx, Fault pin is disabled
101 = Initializes OCx pin low, generates continuous output pulses on OCx pin
100 = Initializes OCx pin low, generates single output pulse on OCx pin
011 = Compare event toggles OCx pin
010 = Initializes OCx pin high, compare event forces OCx pin low
001 = Initializes OCx pin low, compare event forces OCx pin high
000 = Output Compare x channel is disabled

**NOTES:**


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# 15.0 MOTOR CONTROL PWM MODULE

**Note 1:** This data sheet summarizes the features of the dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 family devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **"Motor Control PWM"** (DS70187) in the "*dsPIC33/PIC24 Family Reference Manual*", which is available on the Microchip web site (www.microchip.com).

**2:** Some registers and associated bits described in this section may not be available on all devices. Refer to **Section 4.0 "Memory Organization"** in this data sheet for device-specific register and bit information.

The dsPIC33FJ16MC10X devices have a 6-channel Pulse-Width Modulation (PWM) module.

The PWM module has the following features:

- Up to 16-bit resolution
- On-the-fly PWM frequency changes
- Edge-Aligned and Center-Aligned Output modes
- Single Pulse Generation mode
- Interrupt support for asymmetrical updates in Center-Aligned mode
- Output override control for Electrically Commutative Motor (ECM) operation or BLDC
- Special event comparator for scheduling other peripheral events
- Fault pins to optionally drive each of the PWM output pins to a defined state
- Duty cycle updates configurable to be immediate or synchronized to the PWM time base

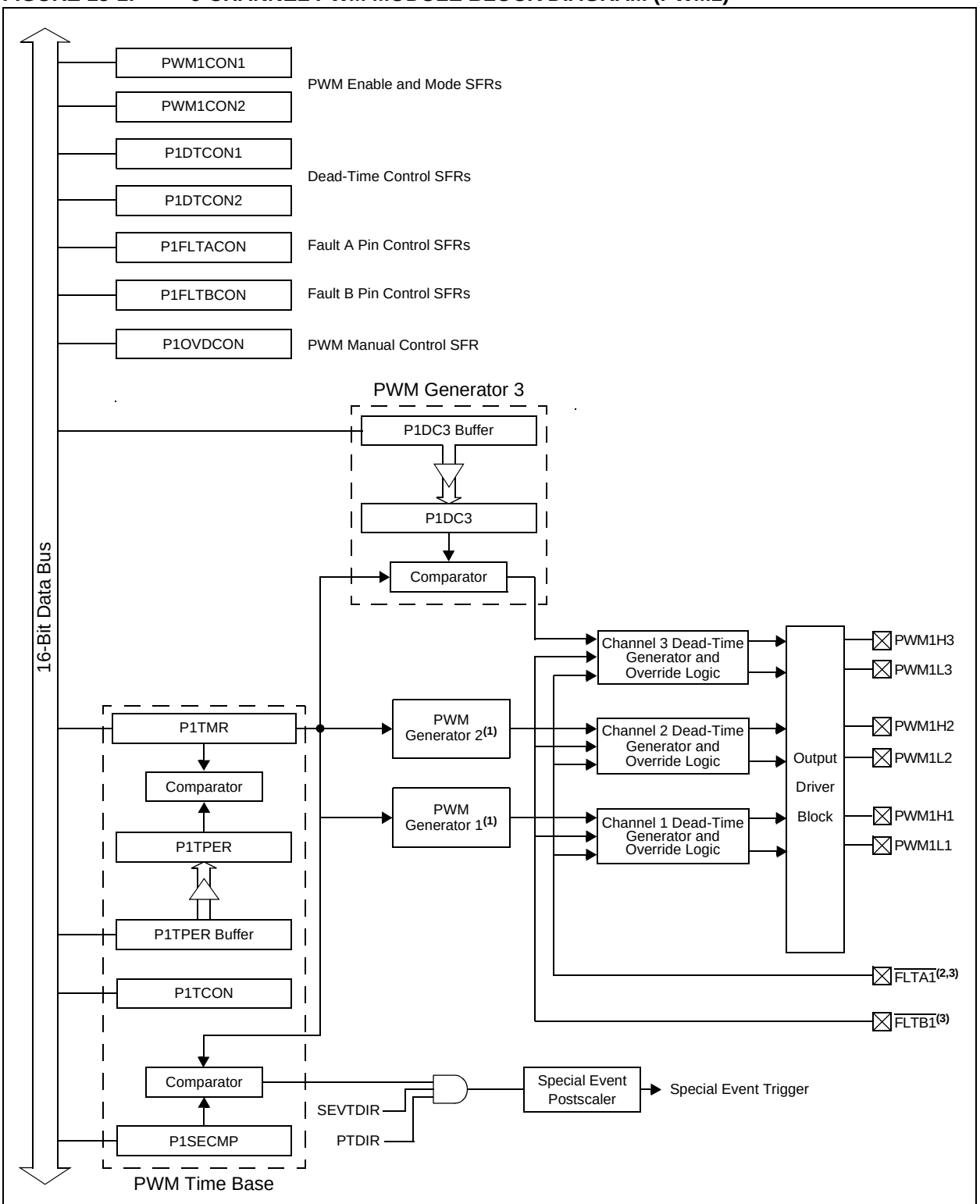
## 15.1 PWM1: 6-Channel PWM Module

This module simplifies the task of generating multiple synchronized PWM outputs. The following power and motion control applications are supported by the PWM module:

- 3-Phase AC Induction Motor
- Switched Reluctance (SR) Motor
- Brushless DC (BLDC) Motor
- Uninterruptible Power Supply (UPS)

This module contains three duty cycle generators, numbered 1 through 3. The module has six PWM output pins, numbered PWM1H1/PWM1L1 through PWM1H3/PWM1L3. The six I/O pins are grouped into high/low numbered pairs, denoted by the suffix H or L, respectively. For complementary loads, the low PWM pins are always the complement of the corresponding high I/O pin.

**FIGURE 15-1: 6-CHANNEL PWM MODULE BLOCK DIAGRAM (PWM1)**




**Note 1:** The details of PWM Generator 1 and 2 are not shown for clarity.

**2:** On dsPIC33FJ16MC101 (20-pin) devices, the $\overline{\text{FLTA1}}$ pin is supported, but requires an external pull-down resistor for correct functionality.

**3:** On dsPIC33FJ16MC102 (28-pin) devices, the $\overline{\text{FLTA1}}$ and $\overline{\text{FLTB1}}$ pins are supported and do not require an external pull-down resistor.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## 15.2 PWM Faults

The Motor Control PWM module incorporates up to two Fault inputs, FLTA1 and FLTB1. These Fault inputs are implemented with Class B safety features. These features ensure that the PWM outputs enter a safe state when either of the Fault inputs is asserted.

The FLTA1 and FLTB1 pins, when enabled and having ownership of a pin, also enable a soft internal pull-down resistor. The soft pull-down provides a safety feature by automatically asserting the Fault should a break occur in the Fault signal connection.

The implementation of internal pull-down resistors is dependent on the device variant. Table 15-1 describes which devices and pins implement the internal pull-down resistors.

**TABLE 15-1: INTERNAL PULL-DOWN RESISTORS ON PWM FAULT PINS**

| Device | Fault Pin | Internal Pull-Down Implemented? |
|---|---|---|
| dsPIC33FJXXMC101 | FLTA1 | No |
| dsPIC33FJXXMC102 | FLTA1 | Yes |
| | FLTB1 | Yes |
| dsPIC33FJ32MC104 | FLTA1 | Yes |
| | FLTB1 | Yes |

On devices without internal pull-downs on the Fault pin, it is recommended to connect an external pull-down resistor for Class B safety features.

### 15.2.1 PWM FAULTS AT RESET

During any Reset event, the PWM module maintains ownership of both PWM Fault pins. At Reset, both Faults are enabled in latched mode to guarantee the fail-safe power-up of the application. The application software must clear both of the PWM Faults before enabling the Motor Control PWM module.

The Fault condition must be cleared by the external circuitry driving the Fault input pin high and clearing the Fault interrupt flag. After the Fault pin condition has been cleared, the PWM module restores the PWM output signals on the next PWM period or half-period boundary.

Refer to **"Motor Control PWM"** (DS70187) in the "*dsPIC33/PIC24 Family Reference Manual*" for more information on the PWM Faults.

| | |
|---|---|
| **Note:** | The number of PWM Faults mapped to the device pins depend on the specific variant. Regardless of the variant, both Faults will be enabled during any Reset event. The application must clear both FLTA1 and FLTB1 before enabling the Motor Control PWM module. Refer to the specific device pin diagrams to see which Fault pins are mapped to the device pins. |

## 15.3 Write-Protected Registers

On dsPIC33FJ(16/32)MC10X devices, write protection is implemented for the PWMxCON1, PxFLTACON and PxFLTBCON registers. The write protection feature prevents any inadvertent writes to these registers. The write protection feature can be controlled by the PWMLOCK Configuration bit in the FOSCSEL Configuration register. The default state of the write protection feature is enabled (PWMLOCK = 1). The write protection feature can be disabled by configuring PWMLOCK (FOSCSEL<6>) = 0.

The user application can gain access to these locked registers either by configuring the PWMLOCK bit (FOSCSEL<6>) = 0 or by performing the unlock sequence. To perform the unlock sequence, the user application must write two consecutive values (0xABCD and 0x4321) to the PWMxKEY register to perform the unlock operation. The write access to the PWMxCON1, PxFLTACON or PxFLTBCON registers must be the next SFR access following the unlock process. There can be no other SFR accesses during the unlock process and subsequent write access.

To write to all registers, the PWMxCON1, PxFLTACON and PxFLTBCON registers require three unlock operations.

The correct unlocking sequence is described in Example 15-1 and Example 15-2.

**EXAMPLE 15-1: ASSEMBLY CODE FOR WRITE-PROTECTED REGISTER UNLOCK AND FAULT CLEARING SEQUENCE**

```
; FLTA1 pin must be pulled high externally in order to clear and disable the Fault
; Writing to P1FLTBCON register requires unlock sequence

mov #0xabcd,w10       ; Load first unlock key to w10 register
mov #0x4321,w11       ; Load second unlock key to w11 register
mov #0x0000,w0        ; Load desired value of P1FLTACON register in w0
mov w10, PWM1KEY      ; Write first unlock key to PWM1KEY register
mov w11, PWM1KEY      ; Write second unlock key to PWM1KEY register
mov w0,P1FLTACON      ; Write desired value to P1FLTACON register

; FLTB1 pin must be pulled high externally in order to clear and disable the Fault
; Writing to P1FLTBCON register requires unlock sequence

mov #0xabcd,w10       ; Load first unlock key to w10 register
mov #0x4321,w11       ; Load second unlock key to w11 register
mov #0x0000,w0        ; Load desired value of P1FLTBCON register in w0
mov w10, PWM1KEY      ; Write first unlock key to PWM1KEY register
mov w11, PWM1KEY      ; Write second unlock key to PWM1KEY register
mov w0,P1FLTBCON      ; Write desired value to P1FLTBCON register

; Enable all PWMs using PWM1CON1 register
; Writing to PWM1CON1 register requires unlock sequence

mov #0xabcd,w10       ; Load first unlock key to w10 register
mov #0x4321,w11       ; Load second unlock key to w11 register
mov #0x0077,w0        ; Load desired value of PWM1CON1 register in w0
mov w10, PWM1KEY      ; Write first unlock key to PWM1KEY register
mov w11, PWM1KEY      ; Write second unlock key to PWM1KEY register
mov w0,PWM1CON1       ; Write desired value to PWM1CON1 register
```

**EXAMPLE 15-2: C CODE FOR WRITE-PROTECTED REGISTER UNLOCK AND FAULT CLEARING SEQUENCE**

```
// FLTA1 pin must be pulled high externally in order to clear and disable the Fault
// Writing to P1FLTACON register requires unlock sequence
// Use builtin function to write 0x0000 to P1FLTACON register
__builtin_write_PWMSFR(&P1FLTACON, 0x0000, &PWM1KEY);

// FLTB1 pin must be pulled high externally in order to clear and disable the Fault
// Writing to P1FLTBCON register requires unlock sequence
// Use builtin function to write 0x0000 to P1FLTBCON register
__builtin_write_PWMSFR(&P1FLTBCON, 0x0000, &PWM1KEY);

// Enable all PWMs using PWM1CON1 register
// Writing to PWM1CON1 register requires unlock sequence
// Use builtin function to write 0x0077 to PWM1CON1 register
__builtin_write_PWMSFR(&PWM1CON1, 0x0077, &PWM1KEY);
```


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## 15.4 PWM Control Registers

**REGISTER 15-1: PxTCON: PWMx TIME BASE CONTROL REGISTER**

| R/W-0 | U-0 | R/W-0 | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| PTEN | — | PTSIDL | — | — | — | — | — |
| bit 15 | | | | | | | bit 8 |

| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| PTOPS3 | PTOPS2 | PTOPS1 | PTOPS0 | PTCKPS1 | PTCKPS0 | PTMOD1 | PTMOD0 |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15 **PTEN:** PWMx Time Base Timer Enable bit
1 = PWMx time base is on
0 = PWMx time base is off

bit 14 **Unimplemented:** Read as ‘0’

bit 13 **PTSIDL:** PWMx Time Base Stop in Idle Mode bit
1 = PWMx time base halts in CPU Idle mode
0 = PWMx time base runs in CPU Idle mode

bit 12-8 **Unimplemented:** Read as ‘0’

bit 7-4 **PTOPS<3:0>:** PWMx Time Base Output Postscale Select bits
1111 = 1:16 postscale
•
•
•
0001 = 1:2 postscale
0000 = 1:1 postscale

bit 3-2 **PTCKPS<1:0>:** PWMx Time Base Input Clock Prescale Select bits
11 = PWMx time base input clock period is 64 TCY (1:64 prescale)
10 = PWMx time base input clock period is 16 TCY (1:16 prescale)
01 = PWMx time base input clock period is 4 TCY (1:4 prescale)
00 = PWMx time base input clock period is TCY (1:1 prescale)

bit 1-0 **PTMOD<1:0>:** PWMx Time Base Mode Select bits
11 = PWMx time base operates in a Continuous Up/Down Count mode with interrupts for double PWM updates
10 = PWMx time base operates in a Continuous Up/Down Count mode
01 = PWMx time base operates in Single Pulse mode
00 = PWMx time base operates in a Free-Running mode

**REGISTER 15-2: PxTMR: PWMx TIMER COUNT VALUE REGISTER**

| R-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| PTDIR | PTMR<14:8> | | | | | | |
| bit 15 | | | | | | | bit 8 |

| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| PTMR<7:0> | | | | | | | |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15 **PTDIR:** PWMx Time Base Count Direction Status bit (read-only)
1 = PWMx time base is counting down
0 = PWMx time base is counting up

bit 14-0 **PTMR <14:0>:** PWMx Time Base Register Count Value bits

**REGISTER 15-3: PxTPER: PWMx TIME BASE PERIOD REGISTER**

| U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | PTPER<14:8> | | | | | | |
| bit 15 | | | | | | | bit 8 |

| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| PTPER<7:0> | | | | | | | |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15 **Unimplemented:** Read as ‘0’

bit 14-0 **PTPER<14:0>:** PWMx Time Base Period Value bits


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**REGISTER 15-4: PxSECMP: PWMx SPECIAL EVENT COMPARE REGISTER**

| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| SEVTDIR(1) | SEVTCMP<14:8>(2) | | | | | | |
| bit 15 | | | | | | | bit 8 |

| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| SEVTCMP<7:0>(2) | | | | | | | |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15 **SEVTDIR:** Special Event Trigger Time Base Direction bit(1)
1 = A Special Event Trigger will occur when the PWMx time base is counting down
0 = A Special Event Trigger will occur when the PWMx time base is counting up

bit 14-0 **SEVTCMP<14:0>:** Special Event Compare Value bits(2)

**Note 1:** SEVTDIR is compared with PTDIR (PxTMR<15>) to generate the Special Event Trigger.
**2:** PxSECMP<14:0> is compared with PxTMR<14:0> to generate the Special Event Trigger.

**REGISTER 15-5: PWMxCON1: PWMx CONTROL REGISTER 1(1)**

| U-0 | U-0 | U-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | PMOD3 | PMOD2 | PMOD1 |
| bit 15 | | | | | | | bit 8 |

| U-0 | R/W-0 | R/W-0 | R/W-0 | U-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | PEN3H(2) | PEN2H(2) | PEN1H(2) | — | PEN3L(2) | PEN2L(2) | PEN1L(2) |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15-11 **Unimplemented:** Read as '0'

bit 10-8 **PMOD<3:1>:** PWMx I/O Pair Mode bits
1 = PWMx I/O pin pair is in the Independent PWM Output mode
0 = PWMx I/O pin pair is in the Complementary Output mode

bit 7 **Unimplemented:** Read as '0'

bit 6-4 **PEN3H:PEN1H:** PWMxH I/O Enable bits(2)
1 = PWMxH pin is enabled for PWMx output
0 = PWMxH pin is disabled, I/O pin becomes a general purpose I/O

bit 3 **Unimplemented:** Read as '0'

bit 2-0 **PEN3L:PEN1L:** PWMxL I/O Enable bits(2)
1 = PWMxL pin is enabled for PWMx output
0 = PWMxL pin is disabled, I/O pin becomes a general purpose I/O

**Note 1:** The PWMxCON1 register is a write-protected register. Refer to **Section 15.3 "Write-Protected Registers"** for more information on the unlock sequence.

**2:** The Reset status for these bits depends on the setting of the PWMPIN Configuration bit (FPOR<7>):
- If PWMPIN = 1 (default), the PWM pins are controlled by the PORT register at Reset, meaning they are initially programmed as inputs (i.e., tri-stated).
- If PWMPIN = 0, the PWM pins are controlled by the PWM module at Reset and are therefore, initially programmed as output pins.


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**REGISTER 15-6: PWMxCON2: PWMx CONTROL REGISTER 2**

| U-0 | U-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | SEVOPS<3:0> | | | |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | IUE | OSYNC | UDIS |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15-12 **Unimplemented:** Read as ‘0’

bit 11-8 **SEVOPS<3:0>:** PWMx Special Event Trigger Output Postscale Select bits

1111 = 1:16 postscale
•
•
•
0001 = 1:2 postscale
0000 = 1:1 postscale

bit 7-3 **Unimplemented:** Read as ‘0’

bit 2 **IUE:** Immediate Update Enable bit

1 = Updates to the active PxDC registers are immediate
0 = Updates to the active PxDC registers are synchronized to the PWMx time base

bit 1 **OSYNC:** Output Override Synchronization bit

1 = Output overrides via the PxOVDCON register are synchronized to the PWMx time base
0 = Output overrides via the PxOVDCON register occur on the next TCY boundary

bit 0 **UDIS:** PWMx Update Disable bit

1 = Updates from Duty Cycle and Period Buffer registers are disabled
0 = Updates from Duty Cycle and Period Buffer registers are enabled

**REGISTER 15-7: PxDTCON1: PWMx DEAD-TIME CONTROL REGISTER 1**

| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| DTBPS1 | DTBPS0 | DTB5 | DTB4 | DTB3 | DTB2 | DTB1 | DTB0 |
| bit 15 | | | | | | | bit 8 |

| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| DTAPS1 | DTAPS0 | DTA5 | DTA4 | DTA3 | DTA2 | DTA1 | DTA0 |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15-14 **DTBPS<1:0>:** Dead-Time Unit B Prescale Select bits
11 = Clock period for Dead-Time Unit B is 8 TCY
10 = Clock period for Dead-Time Unit B is 4 TCY
01 = Clock period for Dead-Time Unit B is 2 TCY
00 = Clock period for Dead-Time Unit B is TCY

bit 13-8 **DTB<5:0>:** Unsigned 6-Bit Dead-Time Value for Dead-Time Unit B bits

bit 7-6 **DTAPS<1:0>:** Dead-Time Unit A Prescale Select bits
11 = Clock period for Dead-Time Unit A is 8 TCY
10 = Clock period for Dead-Time Unit A is 4 TCY
01 = Clock period for Dead-Time Unit A is 2 TCY
00 = Clock period for Dead-Time Unit A is TCY

bit 5-0 **DTA<5:0>:** Unsigned 6-Bit Dead-Time Value for Dead-Time Unit A bits


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**REGISTER 15-8: PxDTCON2: PWMx DEAD-TIME CONTROL REGISTER 2**

| U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | — | — | — |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | DTS3A | DTS3I | DTS2A | DTS2I | DTS1A | DTS1I |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15-6 **Unimplemented:** Read as ‘0’

bit 5 **DTS3A:** Dead-Time Select for PWM3 Signal Going Active bit
1 = Dead time provided from Unit B
0 = Dead time provided from Unit A

bit 4 **DTS3I:** Dead-Time Select for PWM3 Signal Going Inactive bit
1 = Dead time provided from Unit B
0 = Dead time provided from Unit A

bit 3 **DTS2A:** Dead-Time Select for PWM2 Signal Going Active bit
1 = Dead time provided from Unit B
0 = Dead time provided from Unit A

bit 2 **DTS2I:** Dead-Time Select for PWM2 Signal Going Inactive bit
1 = Dead time provided from Unit B
0 = Dead time provided from Unit A

bit 1 **DTS1A:** Dead-Time Select for PWM1 Signal Going Active bit
1 = Dead time provided from Unit B
0 = Dead time provided from Unit A

bit 0 **DTS1I:** Dead-Time Select for PWM1 Signal Going Inactive bit
1 = Dead time provided from Unit B
0 = Dead time provided from Unit A

**REGISTER 15-9: PxFLTACON: PWMx FAULT A CONTROL REGISTER(1,2,3,4)**

| U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | FAOV3H | FAOV3L | FAOV2H | FAOV2L | FAOV1H | FAOV1L |
| bit 15 | | | | | | | bit 8 |

| R/W-0 | U-0 | U-0 | U-0 | U-0 | R/W-1 | R/W-1 | R/W-1 |
|---|---|---|---|---|---|---|---|
| FLTAM | — | — | — | — | FAEN3 | FAEN2 | FAEN1 |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15-14 **Unimplemented:** Read as '0'

bit 13-8 **FAOV<3:1>H:FAOV<3:1>L:** Fault Input A PWMx Override Value bits
1 = The PWMx output pin is driven active on an external Fault input event
0 = The PWMx output pin is driven inactive on an external Fault input event

bit 7 **FLTAM:** Fault A Mode bit
1 = The Fault A input pin functions in the Cycle-by-Cycle mode
0 = The Fault A input pin latches all control pins to the programmed states in PxFLTACON<13:8>

bit 6-3 **Unimplemented:** Read as '0'

bit 2 **FAEN3:** Fault Input A Enable bit
1 = PWMxH3/PWMxL3 pin pair is controlled by Fault Input A
0 = PWMxH3/PWMxL3 pin pair is not controlled by Fault Input A

bit 1 **FAEN2:** Fault Input A Enable bit
1 = PWMxH2/PWMxL2 pin pair is controlled by Fault Input A
0 = PWMxH2/PWMxL2 pin pair is not controlled by Fault Input A

bit 0 **FAEN1:** Fault Input A Enable bit
1 = PWMxH1/PWMxL1 pin pair is controlled by Fault Input A
0 = PWMxH1/PWMxL1 pin pair is not controlled by Fault Input A

**Note 1:** Comparator outputs are not internally connected to the PWM Fault control logic. If using the comparator modules for Fault generation, the user must externally connect the desired comparator output pin to the dedicated $\overline{\text{FLTA1}}$ or $\overline{\text{FLTB1}}$ input pin.

**2:** Refer to Table 15-1 for $\overline{\text{FLTA1}}$ implementation details.

**3:** The PxFLTACON register is a write-protected register. Refer to **Section 15.3 "Write-Protected Registers"** for more information on the unlock sequence.

**4:** During any Reset event, $\overline{\text{FLTA1}}$ is enabled by default and must be cleared as described in **Section 15.2 "PWM Faults"**.


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**REGISTER 15-10: PxFLTBCON: PWMx FAULT B CONTROL REGISTER(1,2,3,4)**

| U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | FBOV3H | FBOV3L | FBOV2H | FBOV2L | FBOV1H | FBOV1L |
| bit 15 | | | | | | | bit 8 |

| R/W-0 | U-0 | U-0 | U-0 | U-0 | R/W-1 | R/W-1 | R/W-1 |
|---|---|---|---|---|---|---|---|
| FLTBM | — | — | — | — | FBEN3 | FBEN2 | FBEN1 |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15-14 **Unimplemented:** Read as '0'

bit 13-8 **FBOV<3:1>H:FBOV<3:1>L:** Fault Input B PWMx Override Value bits
1 = The PWMx output pin is driven active on an external Fault input event
0 = The PWMx output pin is driven inactive on an external Fault input event

bit 7 **FLTBM:** Fault B Mode bit
1 = The Fault B input pin functions in the Cycle-by-Cycle mode
0 = The Fault B input pin latches all control pins to the programmed states in PxFLTBCON<13:8>

bit 6-3 **Unimplemented:** Read as '0'

bit 2 **FBEN3:** Fault Input B Enable bit
1 = PWMxH3/PWMxL3 pin pair is controlled by Fault Input B
0 = PWMxH3/PWMxL3 pin pair is not controlled by Fault Input B

bit 1 **FBEN2:** Fault Input B Enable bit
1 = PWMxH2/PWMxL2 pin pair is controlled by Fault Input B
0 = PWMxH2/PWMxL2 pin pair is not controlled by Fault Input B

bit 0 **FBEN1:** Fault Input B Enable bit
1 = PWMxH1/PWMxL1 pin pair is controlled by Fault Input B
0 = PWMxH1/PWMxL1 pin pair is not controlled by Fault Input B

**Note 1:** Comparator outputs are not internally connected to the PWM Fault control logic. If using the comparator modules for Fault generation, the user must externally connect the desired comparator output pin to the dedicated $\overline{FLTA1}$ or $\overline{FLTB1}$ input pin.

**2:** Refer to Table 15-1 for $\overline{FLTB1}$ implementation details.

**3:** The PxFLTACON register is a write-protected register. Refer to **Section 15.3 "Write-Protected Registers"** for more information on the unlock sequence.

**4:** During any Reset event, $\overline{FLTB1}$ is enabled by default and must be cleared as described in **Section 15.2 "PWM Faults"**.

**REGISTER 15-11: PxOVDCON: PWMx OVERRIDE CONTROL REGISTER**

| U-0 | U-0 | R/W-1 | R/W-1 | R/W-1 | R/W-1 | R/W-1 | R/W-1 |
|---|---|---|---|---|---|---|---|
| — | — | POVD3H | POVD3L | POVD2H | POVD2L | POVD1H | POVD1L |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | POUT3H | POUT3L | POUT2H | POUT2L | POUT1H | POUT1L |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15-14 **Unimplemented:** Read as ‘0’

bit 13-8 **POVD<3:1>H:POVD<3:1>L:** PWMx Output Override bits

1 = Output on PWMx I/O pin is controlled by the PWMx generator
0 = Output on PWMx I/O pin is controlled by the value in the corresponding POUTxH:POUTxL bits

bit 7-6 **Unimplemented:** Read as ‘0’

bit 5-0 **POUT<3:1>H:POUT<3:1>L:** PWM Manual Output bits

1 = PWMx I/O pin is driven active when the corresponding POVDxH:POVDxL bits are cleared
0 = PWMx I/O pin is driven inactive when the corresponding POVDxH:POVDxL bits are cleared


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**REGISTER 15-12: PxDC1: PWMx DUTY CYCLE 1 REGISTER**

| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| PDC1<15:8> | | | | | | | |
| bit 15 | | | | | | | bit 8 |

| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| PDC1<7:0> | | | | | | | |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15-0 **PDC1<15:0>:** PWMx Duty Cycle 1 Value bits

**REGISTER 15-13: PxDC2: PWMx DUTY CYCLE 2 REGISTER**

| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| PDC2<15:8> | | | | | | | |
| bit 15 | | | | | | | bit 8 |

| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| PDC2<7:0> | | | | | | | |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15-0 **PDC2<15:0>:** PWMx Duty Cycle 2 Value bits

**REGISTER 15-14: PxDC3: PWMx DUTY CYCLE 3 REGISTER**

| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| PDC3<15:8> | | | | | | | |
| bit 15 | | | | | | | bit 8 |

| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| PDC3<7:0> | | | | | | | |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15-0 **PDC3<15:0>:** PWMx Duty Cycle 3 Value bits

**REGISTER 15-15: PWMxKEY: PWMx UNLOCK REGISTER**

| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| PWMKEY<15:8> | | | | | | | |
| bit 15 | | | | | | | bit 8 |

| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| PWMKEY<7:0> | | | | | | | |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15-0 **PWMKEY<15:0>:** PWMx Unlock bits

If the PWMLOCK Configuration bit is asserted (PWMLOCK = 1), the PWMxCON1, PxFLTACON and PxFLTBCON registers are writable only after the proper sequence is written to the PWMxKEY register. If the PWMLOCK Configuration bit is deasserted (PWMLOCK = 0), the PWMxCON1, PxFLTACON and PxFLTBCON registers are writable at all times. Refer to **“Motor Control PWM”** (DS70187) in the “*dsPIC33/PIC24 Family Reference Manual*” for details on the unlock sequence.


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## 16.0 SERIAL PERIPHERAL INTERFACE (SPI)

**Note 1:** This data sheet summarizes the features of the dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 family devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **"Serial Peripheral Interface (SPI)"** (DS70206) in the *"dsPIC33/PIC24 Family Reference Manual"*, which is available from the Microchip web site (www.microchip.com).

**2:** Some registers and associated bits described in this section may not be available on all devices. Refer to **Section 4.0 "Memory Organization"** in this data sheet for device-specific register and bit information.

The Serial Peripheral Interface (SPI) module is a synchronous serial interface useful for communicating with other peripheral or microcontroller devices. These peripheral devices can be serial EEPROMs, shift registers, display drivers, Analog-to-Digital Converters, etc. The SPI module is compatible with SPI and SIOP from Motorola®.

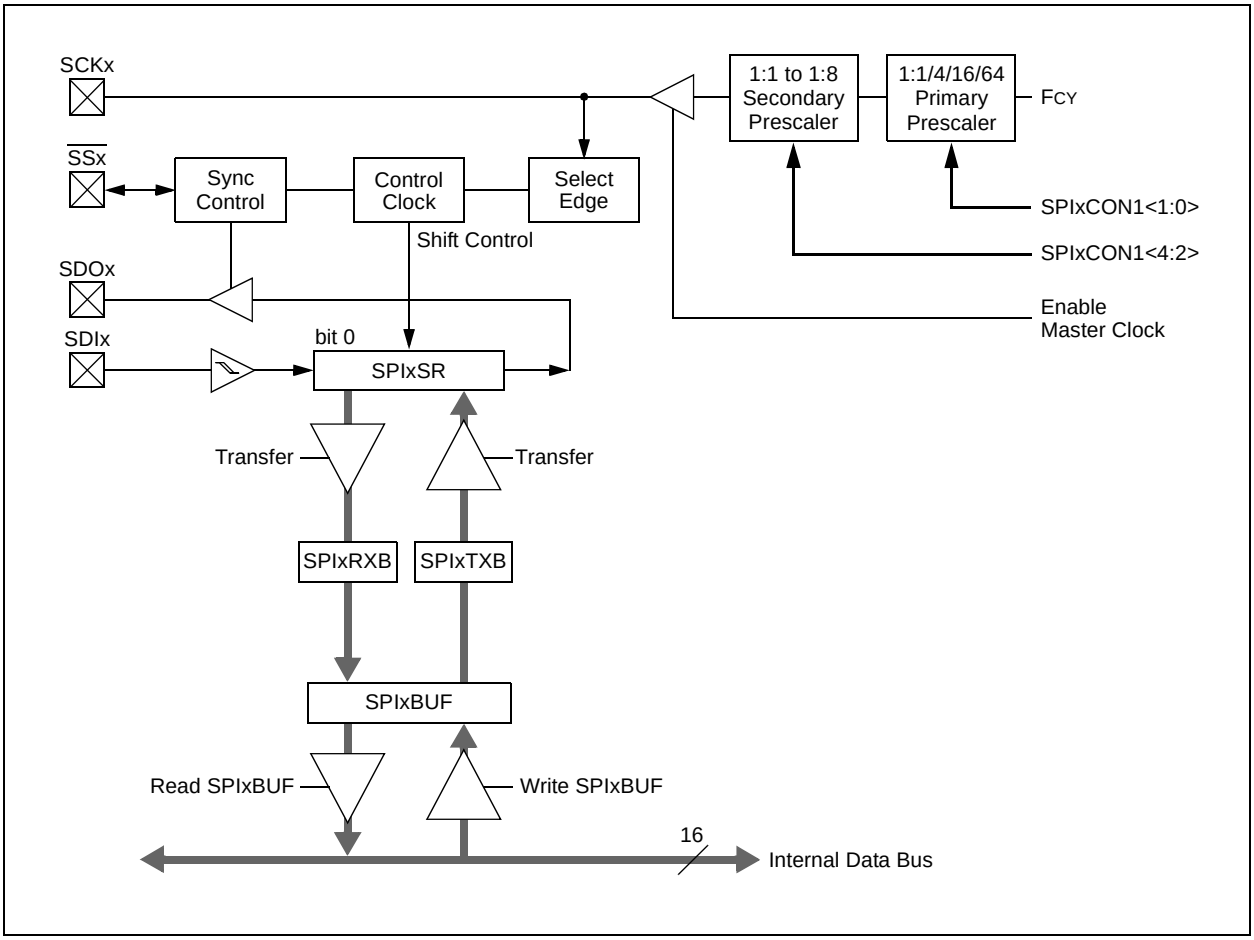
Each SPI module consists of a 16-bit shift register, SPIxSR (where x = 1 or 2), used for shifting data in and out, and a buffer register, SPIxBUF. A control register, SPIxCON, configures the module. Additionally, a status register, SPIxSTAT, indicates status conditions.

The serial interface consists of four pins:

- SDIx (serial data input)
- SDOx (serial data output)
- SCKx (shift clock input or output)
- $\overline{SSx}$ (active-low slave select).

In Master mode operation, SCKx is a clock output. In Slave mode, it is a clock input.

**FIGURE 16-1: SPIx MODULE BLOCK DIAGRAM**



## 16.1 SPI Helpful Tips

1. In Frame mode, if there is a possibility that the master may not be initialized before the slave:
   a) If FRMPOL (SPIxCON2<13>) = 1, use a pull-down resistor on $\overline{SSx}$.
   b) If FRMPOL = 0, use a pull-up resistor on $\overline{SSx}$.

| **Note:** | This insures that the first frame transmission after initialization is not shifted or corrupted. |
|---|---|

2. In Non-Framed 3-Wire mode (i.e., not using $\overline{SSx}$ from a master):
   a) If CKP (SPIxCON1<6>) = 1, always place a pull-up resistor on $\overline{SSx}$.
   b) If CKP = 0, always place a pull-down resistor on $\overline{SSx}$.

| **Note:** | This will insure that during power-up and initialization, the master/slave will not lose sync due to an errant SCK transition that would cause the slave to accumulate data shift errors for both transmit and receive, appearing as corrupted data. |
|---|---|

3. FRMEN (SPIxCON2<15>) = 1 and SSEN (SPIxCON1<7>) = 1 are exclusive and invalid. In Frame mode, SCKx is continuous and the Frame Sync pulse is active on the $\overline{SSx}$ pin, which indicates the start of a data frame.

| **Note:** | Not all third-party devices support Frame mode timing. Refer to the SPI electrical characteristics for details. |
|---|---|

4. In Master mode only, set the SMP bit (SPIxCON1<9>) to a '1' for the fastest SPI data rate possible. The SMP bit can only be set at the same time or after the MSTEN bit (SPIxCON1<5>) is set.
5. To avoid invalid slave read data to the master, the user's master software must ensure enough time for slave software to fill its write buffer before the user application initiates a master write/read cycle. It is always advisable to pre-load the SPIxBUF Transmit register in advance of the next master transaction cycle. SPIxBUF is transferred to the SPIx Shift register and is empty once the data transmission begins.
6. The SPI related pins (SDI1, SDO1, SCK1) are located at fixed positions in the dsPIC33FJ16(GP/MC)10X devices. The same pins are remappable in the dsPIC33FJ32(GP/MC)10X devices.

## 16.2 SPI Resources

Many useful resources are provided on the main product page of the Microchip web site for the devices listed in this data sheet. This product page, which can be accessed using this link, contains the latest updates and additional information.

| **Note:** | In the event you are not able to access the product page using the link above, enter this URL in your browser: http://www.microchip.com/wwwproducts/Devices.aspx?dDocName=en554109 |
|---|---|

### 16.2.1 KEY RESOURCES

- **"Serial Peripheral Interface (SPI)"** (DS70206) in the "*dsPIC33/PIC24 Family Reference Manual*".
- Code Samples
- Application Notes
- Software Libraries
- Webinars
- All related "*dsPIC33/PIC24 Family Reference Manual*" sections
- Development Tools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## 16.3 SPI Control Registers

**REGISTER 16-1: SPIxSTAT: SPIx STATUS AND CONTROL REGISTER**

| R/W-0 | U-0 | R/W-0 | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| SPIEN | — | SPISIDL | — | — | — | — | — |
| bit 15 | | | | | | | bit 8 |

| U-0 | R/C-0 | U-0 | U-0 | U-0 | U-0 | R-0 | R-0 |
|---|---|---|---|---|---|---|---|
| — | SPIROV | — | — | — | — | SPITBF | SPIRBF |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | C = Clearable bit | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15 **SPIEN:** SPIx Enable bit
1 = Enables module and configures SCKx, SDOx, SDIx and $\overline{SSx}$ as serial port pins
0 = Disables module

bit 14 **Unimplemented:** Read as '0'

bit 13 **SPISIDL:** SPIx Stop in Idle Mode bit
1 = Discontinues module operation when device enters Idle mode
0 = Continues module operation in Idle mode

bit 12-7 **Unimplemented:** Read as '0'

bit 6 **SPIROV:** SPIx Receive Overflow Flag bit
1 = A new byte/word is completely received and discarded; the user software has not read the previous data in the SPIxBUF register
0 = No overflow has occurred.

bit 5-2 **Unimplemented:** Read as '0'

bit 1 **SPITBF:** SPIx Transmit Buffer Full Status bit
1 = Transmit has not yet started, SPIxTXB is full
0 = Transmit has started, SPIxTXB is empty
Automatically set in hardware when the CPU writes the SPIxBUF location, loading SPIxTXB. Automatically cleared in hardware when the SPIx module transfers data from SPIxTXB to SPIxSR.

bit 0 **SPIRBF:** SPIx Receive Buffer Full Status bit
1 = Receive complete, SPIxRXB is full
0 = Receive is not complete, SPIxRXB is empty
Automatically set in hardware when SPIx transfers data from SPIxSR to SPIxRXB. Automatically cleared in hardware when the core reads the SPIxBUF location, reading SPIxRXB.

**REGISTER 16-2: SPIxCON1: SPIx CONTROL REGISTER 1**

| U-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | DISSCK | DISSDO | MODE16 | SMP | CKE(1) |
| bit 15 | | | | | | | bit 8 |

| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| SSEN(2) | CKP | MSTEN | SPRE2(3) | SPRE1(3) | SPRE0(3) | PPRE1(3) | PPRE0(3) |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15-13 **Unimplemented:** Read as '0'

bit 12 **DISSCK:** Disable SCKx pin bit (SPI Master modes only)
1 = Internal SPI clock is disabled, pin functions as I/O
0 = Internal SPI clock is enabled

bit 11 **DISSDO:** Disable SDOx pin bit
1 = SDOx pin is not used by the module; pin functions as I/O
0 = SDOx pin is controlled by the module

bit 10 **MODE16:** Word/Byte Communication Select bit
1 = Communication is word-wide (16 bits)
0 = Communication is byte-wide (8 bits)

bit 9 **SMP:** SPIx Data Input Sample Phase bit
Master mode:
1 = Input data sampled at end of data output time
0 = Input data sampled at middle of data output time
Slave mode:
SMP must be cleared when SPIx is used in Slave mode.

bit 8 **CKE:** Clock Edge Select bit(1)
1 = Serial output data changes on transition from active clock state to Idle clock state (see bit 6)
0 = Serial output data changes on transition from Idle clock state to active clock state (see bit 6)

bit 7 **SSEN:** SPIx Slave Select Enable bit (Slave mode)(2)
1 = $\overline{SSx}$ pin is used for Slave mode
0 = $\overline{SSx}$ pin is not used by the module, pin is controlled by port function

bit 6 **CKP:** Clock Polarity Select bit
1 = Idle state for clock is a high level; active state is a low level
0 = Idle state for clock is a low level; active state is a high level

bit 5 **MSTEN:** Master Mode Enable bit
1 = Master mode
0 = Slave mode

**Note 1:** The CKE bit is not used in the Framed SPI modes. Program this bit to '0' for the Framed SPI modes (FRMEN = 1).
**2:** This bit must be cleared when FRMEN = 1.
**3:** Do not set both primary and secondary prescalers to a value of 1:1.


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**REGISTER 16-2: SPIxCON1: SPIx CONTROL REGISTER 1 (CONTINUED)**

bit 4-2 **SPRE<2:0>:** Secondary Prescale bits (Master mode)(3)
111 = Secondary prescale 1:1
110 = Secondary prescale 2:1
.
.
.
000 = Secondary prescale 8:1

bit 1-0 **PPRE<1:0>:** Primary Prescale bits (Master mode)(3)
11 = Primary prescale 1:1
10 = Primary prescale 4:1
01 = Primary prescale 16:1
00 = Primary prescale 64:1

**Note 1:** The CKE bit is not used in the Framed SPI modes. Program this bit to '0' for the Framed SPI modes (FRMEN = 1).

**2:** This bit must be cleared when FRMEN = 1.

**3:** Do not set both primary and secondary prescalers to a value of 1:1.

**REGISTER 16-3: SPIxCON2: SPIx CONTROL REGISTER 2**

| R/W-0 | R/W-0 | R/W-0 | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| FRMEN | SPIFSD | FRMPOL | — | — | — | — | — |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | R/W-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | — | FRMDLY | — |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15 **FRMEN:** Framed SPIx Support bit
1 = Framed SPIx support is enabled ($\overline{SS}$x pin is used as Frame Sync pulse input/output)
0 = Framed SPIx support is disabled

bit 14 **SPIFSD:** Frame Sync Pulse Direction Control bit
1 = Frame Sync pulse input (slave)
0 = Frame Sync pulse output (master)

bit 13 **FRMPOL:** Frame Sync Pulse Polarity bit
1 = Frame Sync pulse is active-high
0 = Frame Sync pulse is active-low

bit 12-2 **Unimplemented:** Read as ‘0’

bit 1 **FRMDLY:** Frame Sync Pulse Edge Select bit
1 = Frame Sync pulse coincides with first bit clock
0 = Frame Sync pulse precedes first bit clock

bit 0 **Unimplemented:** This bit must not be set to ‘1’ by the user application


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# 17.0 INTER-INTEGRATED CIRCUIT™ ($I^2C$™)

**Note 1:** This data sheet summarizes the features of the dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 family devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **"Inter-Integrated Circuit™ ($I^2C$™)"** (DS70195) in the *"dsPIC33/PIC24 Family Reference Manual"*, which is available from the Microchip web site (www.microchip.com).

**2:** Some registers and associated bits described in this section may not be available on all devices. Refer to **Section 4.0 "Memory Organization"** in this data sheet for device-specific register and bit information.

The Inter-Integrated Circuit™ ($I^2C$™) module provides complete hardware support for both Slave and Multi-Master modes of the $I^2C$ serial communication standard, with a 16-bit interface.

The $I^2C$ module has a 2-pin interface:

- The SCLx pin is clock
- The SDAx pin is data

The $I^2C$ module offers the following key features:

- $I^2C$ interface supporting both Master and Slave modes of operation
- $I^2C$ Slave mode supports 7-bit and 10-bit addresses
- $I^2C$ Master mode supports 7-bit and 10-bit addresses
- $I^2C$ port allows bidirectional transfers between master and slaves
- Serial clock synchronization for $I^2C$ port can be used as a handshake mechanism to suspend and resume serial transfer (SCLREL control)
- $I^2C$ supports multi-master operation, detects bus collision and arbitrates accordingly

## 17.1 Operating Modes

The hardware fully implements all the master and slave functions of the $I^2C$ Standard and Fast mode specifications, as well as 7-Bit and 10-Bit Addressing.

The $I^2C$ module can operate either as a slave or a master on an $I^2C$ bus.

The following types of $I^2C$ operation are supported:

- $I^2C$ slave operation with 7-Bit Addressing
- $I^2C$ slave operation with 10-Bit Addressing
- $I^2C$ master operation with 7-Bit or 10-Bit Addressing

For details about the communication sequence in each of these modes, refer to the Microchip web site (www.microchip.com) for the latest *"dsPIC33/PIC24 Family Reference Manual"* sections.

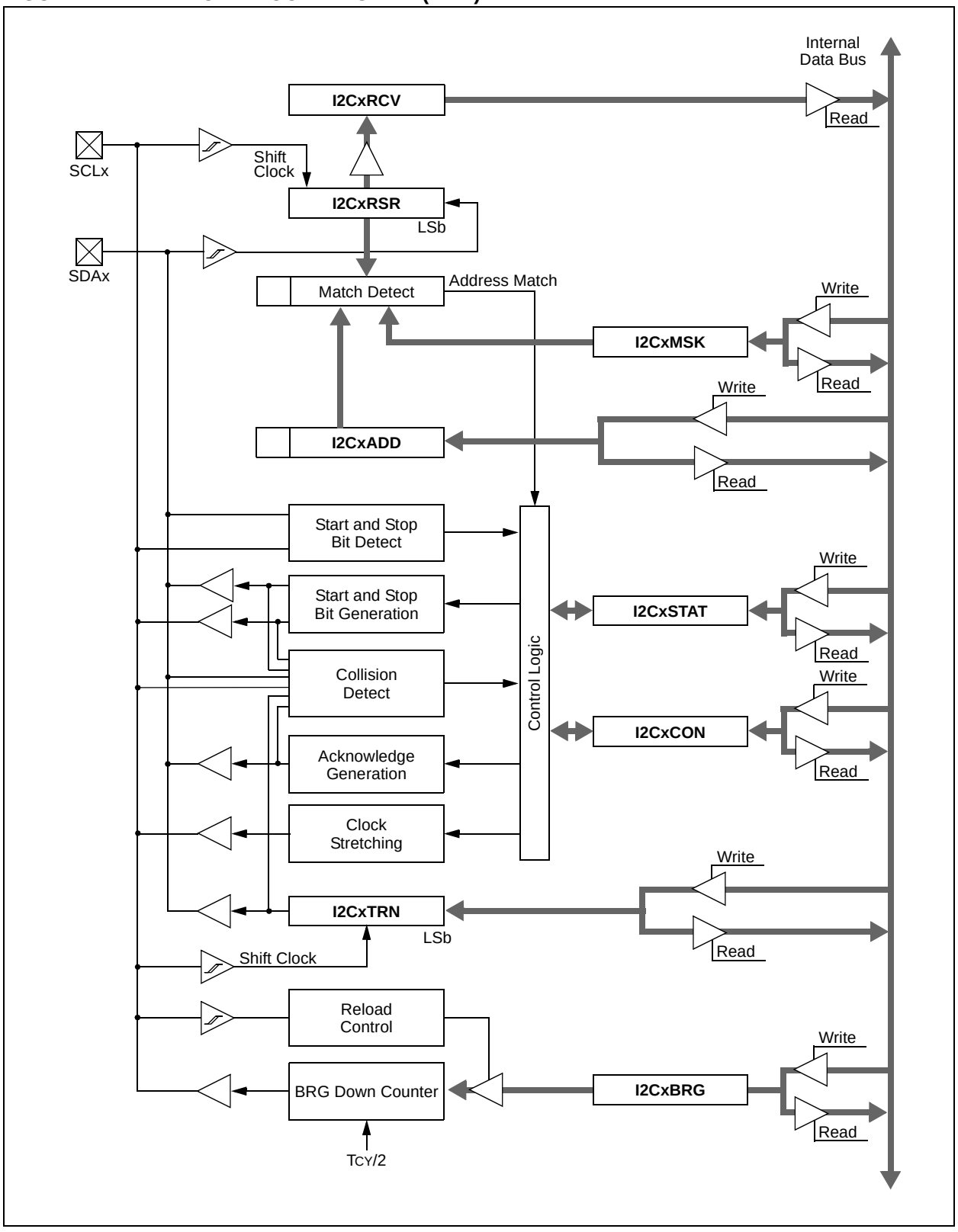
## 17.2 $I^2C$ Registers

I2CxCON and I2CxSTAT are control and status registers, respectively. The I2CxCON register is readable and writable. The lower six bits of I2CxSTAT are read-only. The remaining bits of the I2CxSTAT are read/write.

- I2CxRSR is the shift register used for shifting data
- I2CxRCV is the receive buffer and the register to which data bytes are written or from which data bytes are read
- I2CxTRN is the transmit register to which bytes are written during a transmit operation
- I2CxADD register holds the slave address
- ADD10 status bit indicates 10-Bit Addressing mode
- I2CxBRG acts as the Baud Rate Generator (BRG) reload value

In receive operations, I2CxRSR and I2CxRCV together form a double-buffered receiver. When I2CxRSR receives a complete byte, it is transferred to I2CxRCV and an interrupt pulse is generated.

**FIGURE 17-1: I²C™ BLOCK DIAGRAM (x = 1)**





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## 17.3 I²C Control Registers

**REGISTER 17-1: I2CxCON: I2Cx CONTROL REGISTER**

| R/W-0 | U-0 | R/W-0 | R/W-1, HC | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| I2CEN | — | I2CSIDL | SCLREL | IPMIEN | A10M | DISSLW | SMEN |
| bit 15 | | | | | | | bit 8 |

| R/W-0 | R/W-0 | R/W-0 | R/W-0, HC | R/W-0, HC | R/W-0, HC | R/W-0, HC | R/W-0, HC |
|---|---|---|---|---|---|---|---|
| GCEN | STREN | ACKDT | ACKEN | RCEN | PEN | RSEN | SEN |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | HC = Hardware Clearable bit | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15 **I2CEN:** I2Cx Enable bit
1 = Enables the I2Cx module, and configures the SDAx and SCLx pins as serial port pins
0 = Disables the I2Cx module; all I²C™ pins are controlled by port functions

bit 14 **Unimplemented:** Read as '0'

bit 13 **I2CSIDL:** I2Cx Stop in Idle Mode bit
1 = Discontinues module operation when device enters an Idle mode
0 = Continues module operation in Idle mode

bit 12 **SCLREL:** SCLx Release Control bit (when operating as I²C slave)
1 = Releases SCLx clock
0 = Holds SCLx clock low (clock stretch)
If STREN = 1:
Bit is R/W (i.e., software can write '0' to initiate stretch and write '1' to release clock). Hardware clears at beginning of every slave data byte transmission. Hardware clears at end of every slave address byte reception. Hardware clears at every slave data byte reception.
If STREN = 0:
Bit is R/S (i.e., software can only write '1' to release clock). Hardware clears at beginning of every slave data byte transmission. Hardware clears at end of every slave address byte reception.

bit 11 **IPMIEN:** Intelligent Peripheral Management Interface (IPMI) Enable bit
1 = IPMI mode is enabled; all addresses are Acknowledged
0 = IPMI mode is disabled

bit 10 **A10M:** I2Cx 10-Bit Slave Address bit
1 = I2CxADD is a 10-bit slave address
0 = I2CxADD is a 7-bit slave address

bit 9 **DISSLW:** Disable Slew Rate Control bit
1 = Slew rate control is disabled
0 = Slew rate control is enabled

bit 8 **SMEN:** SMBus Input Levels bit
1 = Enables I/O pin thresholds compliant with SMBus specification
0 = Disables SMBus input thresholds

bit 7 **GCEN:** General Call Enable bit (when operating as I²C slave)
1 = Enables interrupt when a general call address is received in the I2CxRSR (module is enabled for reception)
0 = General call address is disabled

**REGISTER 17-1: I2CxCON: I2Cx CONTROL REGISTER (CONTINUED)**

bit 6 **STREN:** SCLx Clock Stretch Enable bit (when operating as $I^2C$ slave)
Used in conjunction with the SCLREL bit.
1 = Enables software or receives clock stretching
0 = Disables software or receives clock stretching

bit 5 **ACKDT:** Acknowledge Data bit (when operating as $I^2C$ master, applicable during master receive)
Value that will be transmitted when the software initiates an Acknowledge sequence.
1 = Sends NACK during Acknowledge
0 = Sends ACK during Acknowledge

bit 4 **ACKEN:** Acknowledge Sequence Enable bit (when operating as $I^2C$ master, applicable during master receive)
1 = Initiates Acknowledge sequence on SDAx and SCLx pins and transmits ACKDT data bit; hardware clears at end of master Acknowledge sequence
0 = Acknowledge sequence is not in progress

bit 3 **RCEN:** Receive Enable bit (when operating as $I^2C$ master)
1 = Enables Receive mode for $I^2C$; hardware clears at end of eighth bit of the master receive data byte
0 = Receive sequence is not in progress

bit 2 **PEN:** Stop Condition Enable bit (when operating as $I^2C$ master)
1 = Initiates Stop condition on SDAx and SCLx pins; hardware clears at end of the master Stop sequence
0 = Stop condition not in progress

bit 1 **RSEN:** Repeated Start Condition Enable bit (when operating as $I^2C$ master)
1 = Initiates Repeated Start condition on SDAx and SCLx pins; hardware clears at end of the master Repeated Start sequence
0 = Repeated Start condition is not in progress

bit 0 **SEN:** Start Condition Enable bit (when operating as $I^2C$ master)
1 = Initiates Start condition on SDAx and SCLx pins; hardware clears at end of master Start sequence
0 = Start condition is not in progress


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**REGISTER 17-2: I2CxSTAT: I2Cx STATUS REGISTER**

| R-0, HSC | R-0, HSC | U-0 | U-0 | U-0 | R/C-0, HS | R-0, HSC | R-0, HSC |
|---|---|---|---|---|---|---|---|
| ACKSTAT | TRSTAT | — | — | — | BCL | GCSTAT | ADD10 |
| bit 15 | | | | | | | bit 8 |

| R/C-0, HS | R/C-0, HS | R-0, HSC | R/C-0, HSC | R/C-0, HSC | R-0, HSC | R-0, HSC | R-0, HSC |
|---|---|---|---|---|---|---|---|
| IWCOL | I2COV | D_A | P | S | R_W | RBF | TBF |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | C = Clearable bit | HSC = Hardware Settable/Clearable bit | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |
| HS = Hardware Settable bit | | | |

bit 15 **ACKSTAT:** Acknowledge Status bit
(when operating as $I^2C$™ master, applicable to master transmit operation)
1 = NACK received from slave
0 = ACK received from slave
Hardware sets or clears at end of slave Acknowledge.

bit 14 **TRSTAT:** Transmit Status bit (when operating as $I^2C$ master, applicable to master transmit operation)
1 = Master transmit is in progress (8 bits + ACK)
0 = Master transmit is not in progress
Hardware sets at beginning of master transmission. Hardware clears at end of slave Acknowledge.

bit 13-11 **Unimplemented:** Read as '0'

bit 10 **BCL:** Master Bus Collision Detect bit
1 = A bus collision has been detected during a master operation
0 = No collision
Hardware sets at detection of bus collision.

bit 9 **GCSTAT:** General Call Status bit
1 = General call address was received
0 = General call address was not received
Hardware sets when address matches general call address. Hardware clears at Stop detection.

bit 8 **ADD10:** 10-Bit Address Status bit
1 = 10-bit address was matched
0 = 10-bit address was not matched
Hardware sets at match of 2nd byte of matched 10-bit address. Hardware clears at Stop detection.

bit 7 **IWCOL:** Write Collision Detect bit
1 = An attempt to write to the I2CxTRN register failed because the $I^2C$ module is busy
0 = No collision
Hardware sets at occurrence of a write to I2CxTRN while busy (cleared by software).

bit 6 **I2COV:** Receive Overflow Flag bit
1 = A byte was received while the I2CxRCV register is still holding the previous byte
0 = No overflow
Hardware sets at attempt to transfer I2CxRSR to I2CxRCV (cleared by software).

bit 5 **D_A:** Data/Address bit (when operating as $I^2C$ slave)
1 = Indicates that the last byte received was data
0 = Indicates that the last byte received was a device address
Hardware clears at device address match. Hardware sets by reception of a slave byte.

**REGISTER 17-2: I2CxSTAT: I2Cx STATUS REGISTER (CONTINUED)**

bit 4 **P:** Stop bit
1 = Indicates that a Stop bit has been detected last
0 = Stop bit was not detected last
Hardware sets or clears when Start, Repeated Start or Stop is detected.

bit 3 **S:** Start bit
1 = Indicates that a Start (or Repeated Start) bit has been detected last
0 = Start bit was not detected last
Hardware sets or clears when Start, Repeated Start or Stop is detected.

bit 2 **R_W:** Read/Write Information bit (when operating as $I^2C$ slave)
1 = Read – Indicates data transfer is output from slave
0 = Write – Indicates data transfer is input to slave
Hardware sets or clears after reception of an $I^2C$ device address byte.

bit 1 **RBF:** Receive Buffer Full Status bit
1 = Receive is complete, I2CxRCV is full
0 = Receive is not complete, I2CxRCV is empty
Hardware sets when I2CxRCV is written with received byte. Hardware clears when software reads I2CxRCV.

bit 0 **TBF:** Transmit Buffer Full Status bit
1 = Transmit in progress, I2CxTRN is full
0 = Transmit complete, I2CxTRN is empty
Hardware sets when software writes to I2CxTRN. Hardware clears at completion of data transmission.


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**REGISTER 17-3: I2CxMSK: I2Cx SLAVE MODE ADDRESS MASK REGISTER**

| U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | — | AMSK<9:8> | |
| bit 15 | | | | | | | bit 8 |

| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| AMSK<7:0> | | | | | | | |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15-10 **Unimplemented:** Read as ‘0’

bit 9-0 **AMSK<9:0>:** Mask for Address Bit x Select bits

1 = Enables masking for Bit x of incoming message address; bit match not required in this position
0 = Disables masking for Bit x; bit match required in this position

**NOTES:**


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## 18.0 UNIVERSAL ASYNCHRONOUS RECEIVER TRANSMITTER (UART)

**Note 1:** This data sheet summarizes the features of the dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 family devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **"UART"** (DS70188) in the *"dsPIC33/PIC24 Family Reference Manual"*, which is available from the Microchip web site (www.microchip.com).

**2:** Some registers and associated bits described in this section may not be available on all devices. Refer to **Section 4.0 "Memory Organization"** in this data sheet for device-specific register and bit information.

The Universal Asynchronous Receiver Transmitter (UART) module is one of the serial I/O modules available in the dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 device family. The UART is a full-duplex asynchronous system that can communicate with peripheral devices, such as personal computers, LIN/J2602, RS-232 and RS-485 interfaces. The module also supports a hardware flow control option with the $\overline{\text{UxCTS}}$ and $\overline{\text{UxRTS}}$ pins, and also includes an IrDA® encoder and decoder.

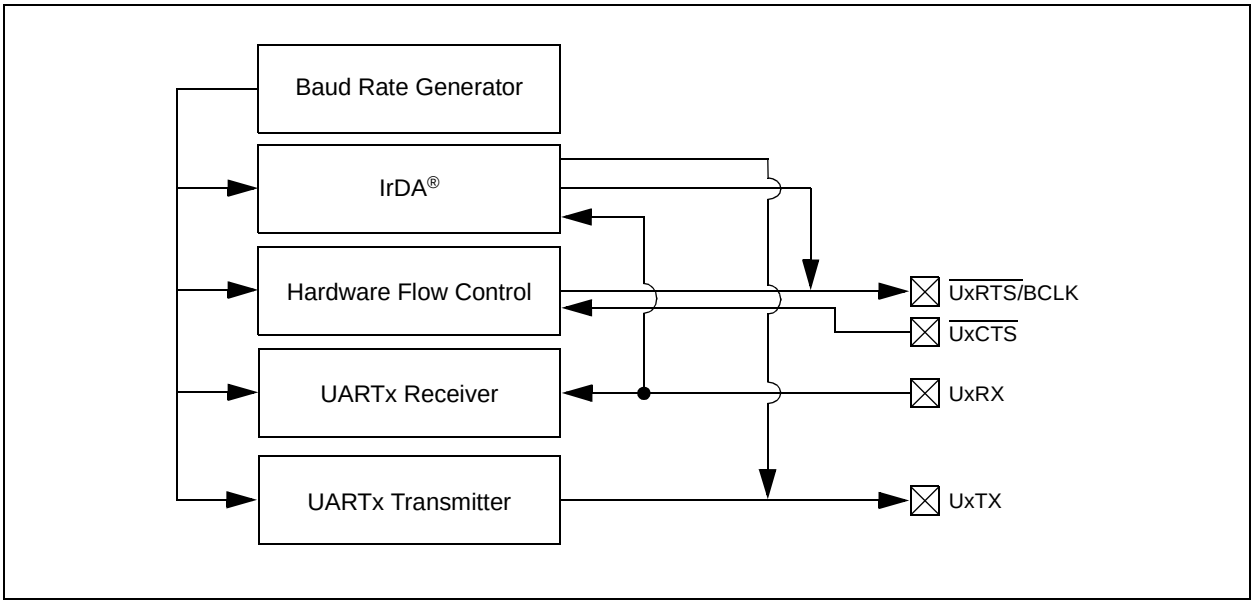
The primary features of the UART module are:

- Full-Duplex, 8-Bit or 9-Bit Data Transmission through the UxTX and UxRX Pins
- Even, Odd or No Parity options (for 8-bit data)
- One or Two Stop bits
- Hardware Flow Control Option with $\overline{\text{UxCTS}}$ and $\overline{\text{UxRTS}}$ Pins
- Fully Integrated Baud Rate Generator with 16-Bit Prescaler
- Baud Rates Ranging from 1 Mbps to 6 bps at 16x mode at 16 MIPS
- Baud Rates Ranging from 4 Mbps to 24.4 bps at 4x mode at 16 MIPS
- 4-Deep First-In First-Out (FIFO) Transmit Data Buffer
- 4-Deep FIFO Receive Data Buffer
- Parity, Framing and Buffer Overrun Error Detection
- Support for 9-bit mode with Address Detect (9th bit = 1)
- Transmit and Receive Interrupts
- A Separate Interrupt for all UART Error Conditions
- Loopback mode for Diagnostic Support
- Support for Sync and Break Characters
- Support for Automatic Baud Rate Detection
- IrDA® Encoder and Decoder Logic
- 16x Baud Clock Output for IrDA® Support

A simplified block diagram of the UART module is shown in Figure 18-1. The UART module consists of these key hardware elements:

- Baud Rate Generator
- Asynchronous Transmitter
- Asynchronous Receiver

**FIGURE 18-1: UARTx SIMPLIFIED BLOCK DIAGRAM**



## 18.1 UART Helpful Tips

1. In multi-node, direct connect UART networks, UART receive inputs react to the complementary logic level defined by the URXINV bit (UxMODE<4>), which defines the Idle state, the default of which is logic high (i.e., URXINV = 0). Because remote devices do not initialize at the same time, it is likely that one of the devices, because the RX line is floating, will trigger a Start bit detection and will cause the first byte received after the device has been initialized to be invalid. To avoid this situation, the user should use a pull-up or pull-down resistor on the RX pin depending on the value of the URXINV bit.
   a) If URXINV = 0, use a pull-up resistor on the RX pin.
   b) If URXINV = 1, use a pull-down resistor on the RX pin.
2. The first character received on a wake-up from Sleep mode caused by activity on the UxRX pin of the UART module will be invalid. In Sleep mode, peripheral clocks are disabled. By the time the oscillator system has restarted and stabilized from Sleep mode, the baud rate bit sampling clock, relative to the incoming UxRX bit timing, is no longer synchronized, resulting in the first character being invalid; this is to be expected.

## 18.2 UART Resources

Many useful resources are provided on the main product page of the Microchip web site for the devices listed in this data sheet. This product page, which can be accessed using this link, contains the latest updates and additional information.

| **Note:** | In the event you are not able to access the product page using the link above, enter this URL in your browser: http://www.microchip.com/wwwproducts/Devices.aspx?dDocName=en554109 |
|---|---|

### 18.2.1 KEY RESOURCES

- **"UART"** (DS70188) in the *"dsPIC33/PIC24 Family Reference Manual"*
- Code Samples
- Application Notes
- Software Libraries
- Webinars
- All related *"dsPIC33/PIC24 Family Reference Manual"* sections
- Development Tools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## 18.3 UART Control Registers

**REGISTER 18-1: UxMODE: UARTx MODE REGISTER**

| R/W-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | U-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| UARTEN(1) | — | USIDL | IREN(2) | RTSMD | — | UEN1 | UEN0 |
| bit 15 | | | | | | | bit 8 |

| R/W-0, HC | R/W-0 | R/W-0, HC | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| WAKE | LPBACK | ABAUD | URXINV | BRGH | PDSEL1 | PDSEL0 | STSEL |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | HC = Hardware Clearable bit | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15 **UARTEN:** UARTx Enable bit(1)
- 1 = UARTx is enabled; all UARTx pins are controlled by UARTx as defined by the UEN<1:0> bits
- 0 = UARTx is disabled; all UARTx pins are controlled by port latches; UARTx power consumption is minimal

bit 14 **Unimplemented:** Read as '0'

bit 13 **USIDL:** UARTx Stop in Idle Mode bit
- 1 = Discontinues module operation when device enters Idle mode
- 0 = Continues module operation in Idle mode

bit 12 **IREN:** IrDA® Encoder and Decoder Enable bit(2)
- 1 = IrDA encoder and decoder are enabled
- 0 = IrDA encoder and decoder are disabled

bit 11 **RTSMD:** UARTx Mode Selection for $\overline{\text{UxRTS}}$ Pin bit
- 1 = $\overline{\text{UxRTS}}$ pin is in Simplex mode
- 0 = $\overline{\text{UxRTS}}$ pin is in Flow Control mode

bit 10 **Unimplemented:** Read as '0'

bit 9-8 **UEN<1:0>:** UARTx Pin Enable bits
- 11 = UxTX, UxRX and BCLK pins are enabled and used; $\overline{\text{UxCTS}}$ pin is controlled by port latches
- 10 = UxTX, UxRX, $\overline{\text{UxCTS}}$ and $\overline{\text{UxRTS}}$ pins are enabled and used
- 01 = UxTX, UxRX and $\overline{\text{UxRTS}}$ pins are enabled and used; $\overline{\text{UxCTS}}$ pin is controlled by port latches
- 00 = UxTX and UxRX pins are enabled and used; $\overline{\text{UxCTS}}$ and $\overline{\text{UxRTS}}$/BCLK pins are controlled by port latches

bit 7 **WAKE:** Wake-up on Start bit Detect During Sleep Mode Enable bit
- 1 = UARTx will continue to sample the UxRX pin; interrupt is generated on falling edge, bit is cleared in hardware on following rising edge
- 0 = No wake-up is enabled

bit 6 **LPBACK:** UARTx Loopback Mode Select bit
- 1 = Enables Loopback mode
- 0 = Loopback mode is disabled

bit 5 **ABAUD:** Auto-Baud Enable bit
- 1 = Enables baud rate measurement on the next character – requires reception of a Sync field (55h) before other data; cleared in hardware upon completion
- 0 = Baud rate measurement is disabled or completed

**Note 1:** Refer to **"UART"** (DS70188) in the *"dsPIC33/PIC24 Family Reference Manual"* for information on enabling the UART module for receive or transmit operation.

**2:** This feature is available for 16x BRG mode (BRGH = 0) only.

**REGISTER 18-1: UxMODE: UARTx MODE REGISTER (CONTINUED)**

bit 4 **URXINV:** UARTx Receive Polarity Inversion bit
1 = UxRX Idle state is '0'
0 = UxRX Idle state is '1'

bit 3 **BRGH:** High Baud Rate Enable bit
1 = BRG generates 4 clocks per bit period (4x baud clock, High-Speed mode)
0 = BRG generates 16 clocks per bit period (16x baud clock, Standard mode)

bit 2-1 **PDSEL<1:0>:** Parity and Data Selection bits
11 = 9-bit data, no parity
10 = 8-bit data, odd parity
01 = 8-bit data, even parity
00 = 8-bit data, no parity

bit 0 **STSEL:** Stop Bit Selection bit
1 = Two Stop bits
0 = One Stop bit

**Note 1:** Refer to **"UART"** (DS70188) in the *"dsPIC33/PIC24 Family Reference Manual"* for information on enabling the UART module for receive or transmit operation.

**2:** This feature is available for 16x BRG mode (BRGH = 0) only.


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**REGISTER 18-2: UxSTA: UARTx STATUS AND CONTROL REGISTER**

| R/W-0 | R/W-0 | R/W-0 | U-0 | R/W-0, HC | R/W-0 | R-0 | R-1 |
|---|---|---|---|---|---|---|---|
| UTXISEL1 | UTXINV | UTXISEL0 | — | UTXBRK | UTXEN(1) | UTXBF | TRMT |
| bit 15 | | | | | | | bit 8 |

| R/W-0 | R/W-0 | R/W-0 | R-1 | R-0 | R-0 | R/C-0 | R-0 |
|---|---|---|---|---|---|---|---|
| URXISEL1 | URXISEL0 | ADDEN | RIDLE | PERR | FERR | OERR | URXDA |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | C = Clearable bit | HC = Hardware Clearable bit | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15,13 **UTXISEL<1:0>:** UARTx Transmission Interrupt Mode Selection bits
- 11 = Reserved; do not use
- 10 = Interrupt when a character is transferred to the Transmit Shift Register (TSR) and as a result, the transmit buffer becomes empty
- 01 = Interrupt when the last character is shifted out of the Transmit Shift Register; all transmit operations are completed
- 00 = Interrupt when a character is transferred to the Transmit Shift Register (this implies there is at least one character open in the transmit buffer)

bit 14 **UTXINV:** UARTx Transmit Polarity Inversion bit

If IREN = 0:
- 1 = UxTX Idle state is '0'
- 0 = UxTX Idle state is '1'

If IREN = 1:
- 1 = IrDA encoded, UxTX Idle state is '1'
- 0 = IrDA encoded, UxTX Idle state is '0'

bit 12 **Unimplemented:** Read as '0'

bit 11 **UTXBRK:** UARTx Transmit Break bit
- 1 = Sends Sync Break on next transmission – Start bit, followed by twelve '0' bits, followed by Stop bit; cleared by hardware upon completion
- 0 = Sync Break transmission is disabled or completed

bit 10 **UTXEN:** UARTx Transmit Enable bit(1)
- 1 = Transmit is enabled, UxTX pin is controlled by UARTx
- 0 = Transmit is disabled, any pending transmission is aborted and the buffer is reset; UxTX pin is controlled by port

bit 9 **UTXBF:** UARTx Transmit Buffer Full Status bit (read-only)
- 1 = Transmit buffer is full
- 0 = Transmit buffer is not full, at least one more character can be written

bit 8 **TRMT:** Transmit Shift Register Empty bit (read-only)
- 1 = Transmit Shift Register is empty and transmit buffer is empty (the last transmission has completed)
- 0 = Transmit Shift Register is not empty, a transmission is in progress or queued

bit 7-6 **URXISEL<1:0>:** UARTx Receive Interrupt Mode Selection bits
- 11 = Interrupt is set on UxRSR transfer, making the receive buffer full (i.e., has 4 data characters)
- 10 = Interrupt is set on UxRSR transfer, making the receive buffer 3/4 full (i.e., has 3 data characters)
- 0x = Interrupt is set when any character is received and transferred from the UxRSR to the receive buffer; receive buffer has one or more characters

**Note 1:** Refer to **"UART"** (DS70188) in the *"dsPIC33/PIC24 Family Reference Manual"* for information on enabling the UART module for transmit operation.

**REGISTER 18-2: UxSTA: UARTx STATUS AND CONTROL REGISTER (CONTINUED)**

bit 5 **ADDEN:** Address Character Detect bit (Bit 8 of received data = 1)
1 = Address Detect mode is enabled; if 9-bit mode is not selected, this does not take effect
0 = Address Detect mode is disabled

bit 4 **RIDLE:** Receiver Idle bit (read-only)
1 = Receiver is Idle
0 = Receiver is active

bit 3 **PERR:** Parity Error Status bit (read-only)
1 = Parity error has been detected for the current character (character at the top of the receive FIFO)
0 = Parity error has not been detected

bit 2 **FERR:** Framing Error Status bit (read-only)
1 = Framing error has been detected for the current character (character at the top of the receive FIFO)
0 = Framing error has not been detected

bit 1 **OERR:** Receive Buffer Overrun Error Status bit (read-only/clear only)
1 = Receive buffer has overflowed
0 = Receive buffer has not overflowed; clearing a previously set OERR bit (1 → 0 transition) will reset the receiver buffer and the UxRSR to the empty state

bit 0 **URXDA:** UARTx Receive Buffer Data Available bit (read-only)
1 = Receive buffer has data, at least one more character can be read
0 = Receive buffer is empty

**Note 1:** Refer to **"UART"** (DS70188) in the *"dsPIC33/PIC24 Family Reference Manual"* for information on enabling the UART module for transmit operation.


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# 19.0 10-BIT ANALOG-TO-DIGITAL CONVERTER (ADC)

**Note 1:** This data sheet summarizes the features of the dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 family devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **"Analog-to-Digital Converter (ADC)"** (DS70183) in the *"dsPIC33/PIC24 Family Reference Manual"*, which is available from the Microchip web site (www.microchip.com).

**2:** Some registers and associated bits described in this section may not be available on all devices. Refer to **Section 4.0 "Memory Organization"** in this data sheet for device-specific register and bit information.

The dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 devices have up to 14 ADC module input channels.

## 19.1 Key Features

The 10-bit ADC configuration has the following key features:

- Successive Approximation (SAR) conversion
- Conversion speeds of up to 1.1 Msps
- Up to 14 analog input pins
- Four Sample-and-Hold (S&H) circuits for simultaneous sampling of up to four analog input pins
- Automatic Channel Scan mode
- Selectable conversion trigger source
- Selectable Buffer Fill modes
- Four result alignment options (signed/unsigned, fractional/integer)
- Operation during CPU Sleep and Idle modes
- 16-word conversion result buffer

Depending on the particular device pinout, the ADC can have up to 14 analog input pins.

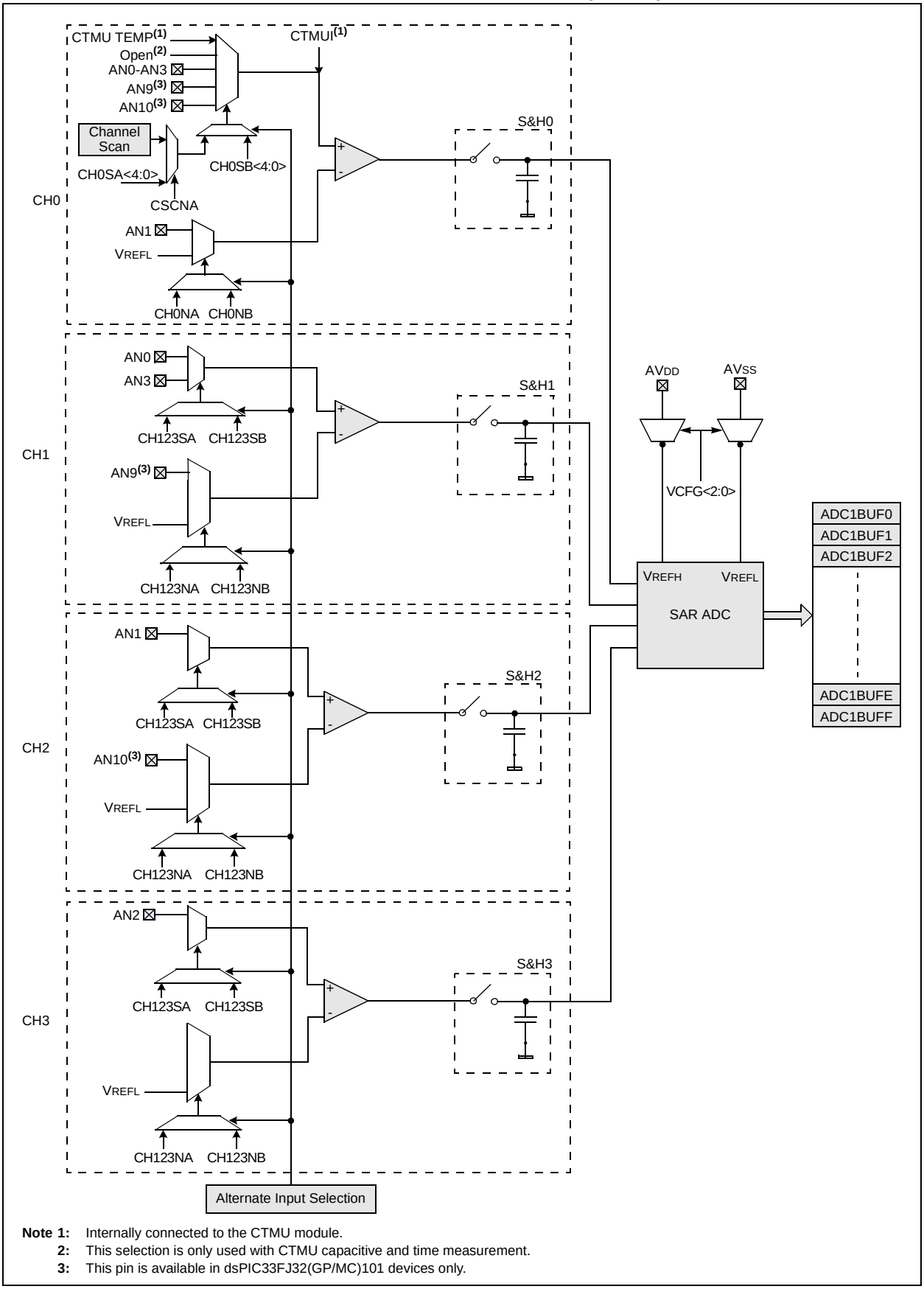
Block diagrams of the ADC module are shown in Figure 19-1 through Figure 19-3.

## 19.2 ADC Initialization

To configure the ADC module:

1. Select port pins as analog inputs (AD1PCFGL<15:0>).
2. Select the analog conversion clock to match the desired data rate with the processor clock (ADxCON3<7:0>).
3. Determine how many Sample-and-Hold channels will be used (ADxCON2<9:8>).
4. Select the appropriate sample and conversion sequence (ADxCON1<7:5> and ADxCON3<12:8>).
5. Select the way conversion results are presented in the buffer (ADxCON1<9:8>).
6. Turn on the ADC module (ADxCON1<15>).
7. Configure the ADC interrupt (if required):
   a) Clear the ADxIF bit.
   b) Select the ADC interrupt priority.

**FIGURE 19-1: ADC1 BLOCK DIAGRAM FOR dsPIC33FJXX(GP/MC)101 DEVICES**




**Note 1:** Internally connected to the CTMU module.
**2:** This selection is only used with CTMU capacitive and time measurement.
**3:** This pin is available in dsPIC33FJ32(GP/MC)101 devices only.


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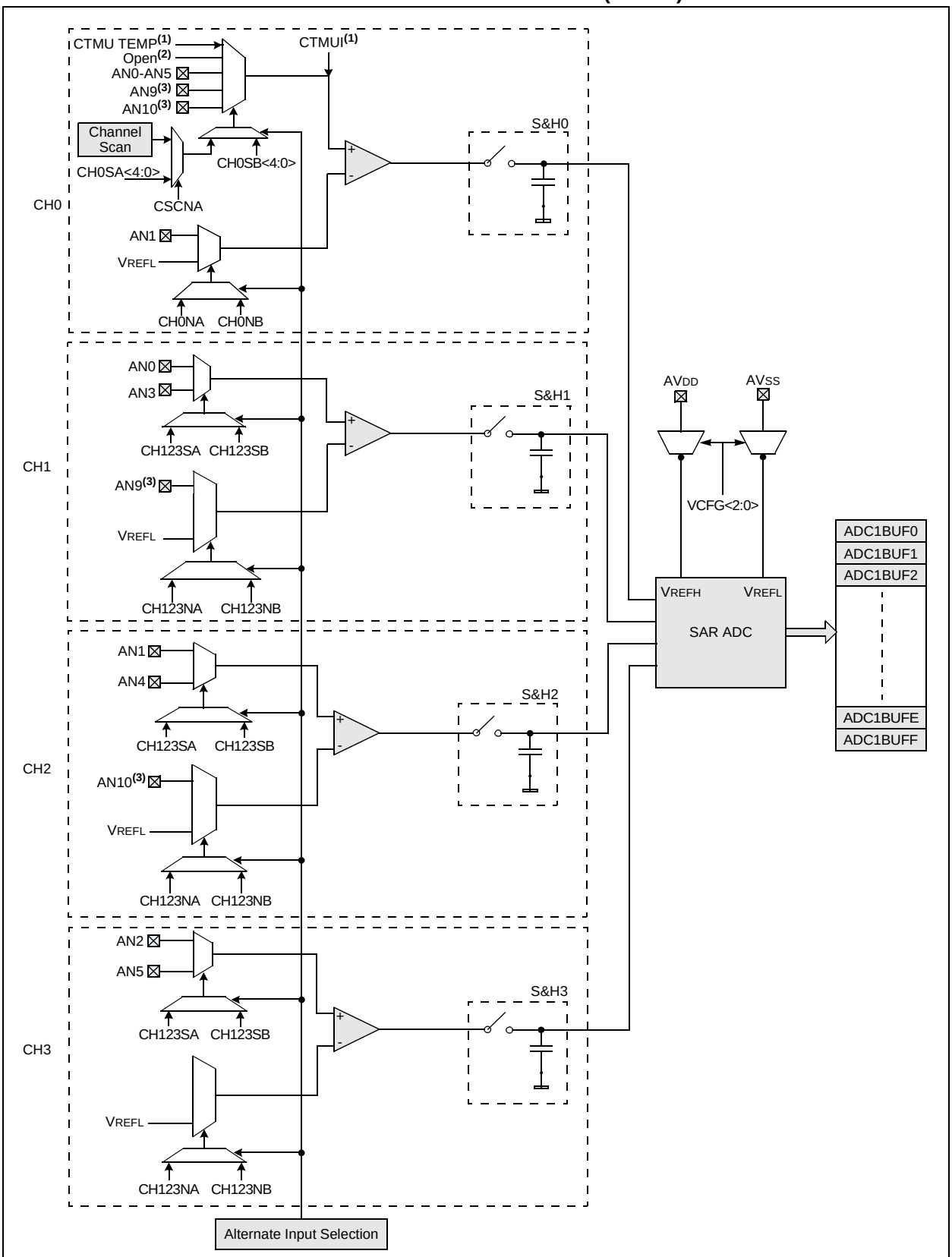
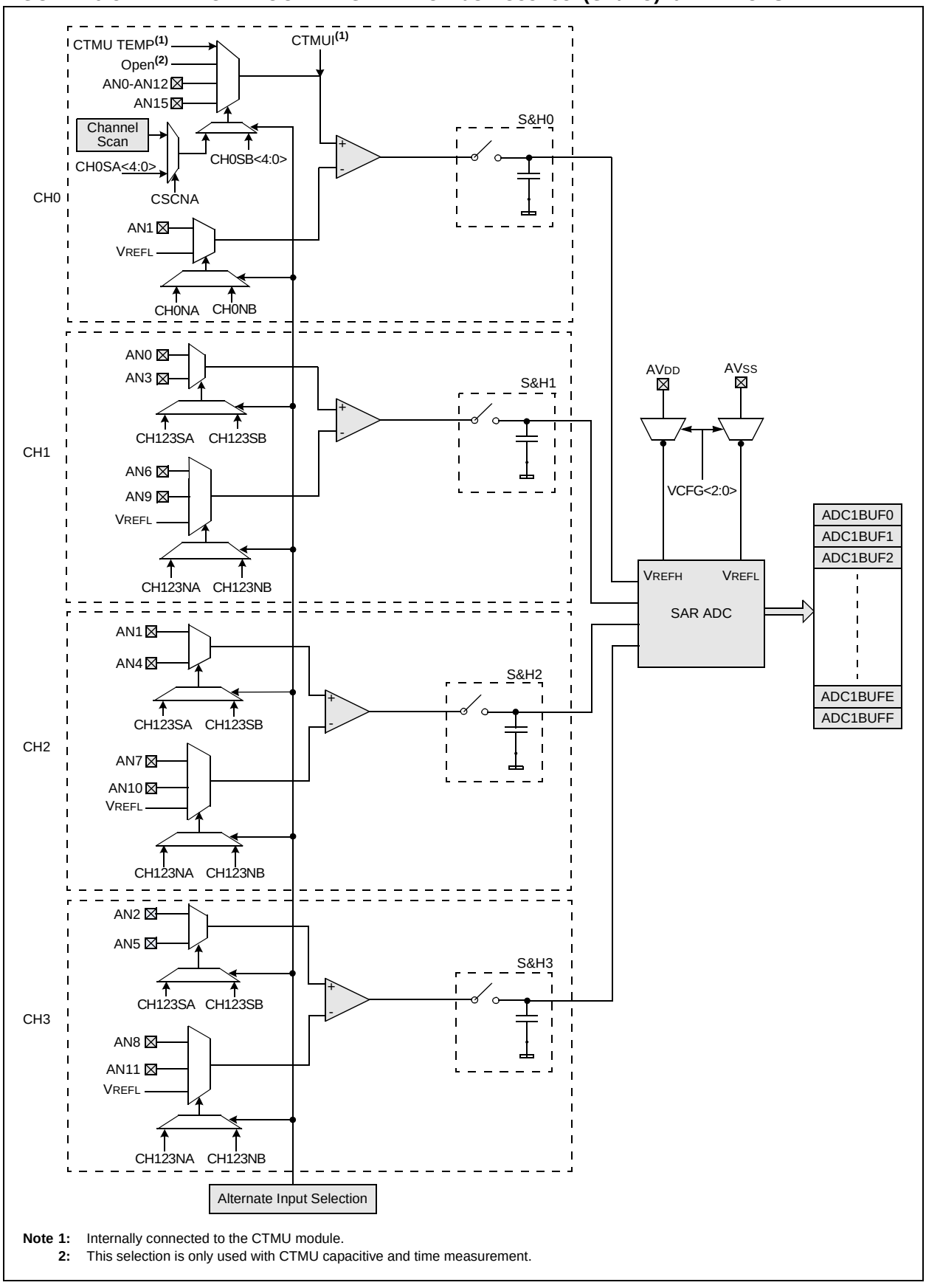
**FIGURE 19-2: ADC1 BLOCK DIAGRAM FOR dsPIC33FJXX(GP/MC)102 DEVICES**




**Note 1:** Internally connected to the CTMU module.
**2:** This selection is only used with CTMU capacitive and time measurement.
**3:** This pin is available in dsPIC33FJ32(GP/MC)101 devices only.

**FIGURE 19-3: ADC1 BLOCK DIAGRAM FOR dsPIC33FJ32(GP/MC)104 DEVICES**




**Note 1:** Internally connected to the CTMU module.
**2:** This selection is only used with CTMU capacitive and time measurement.


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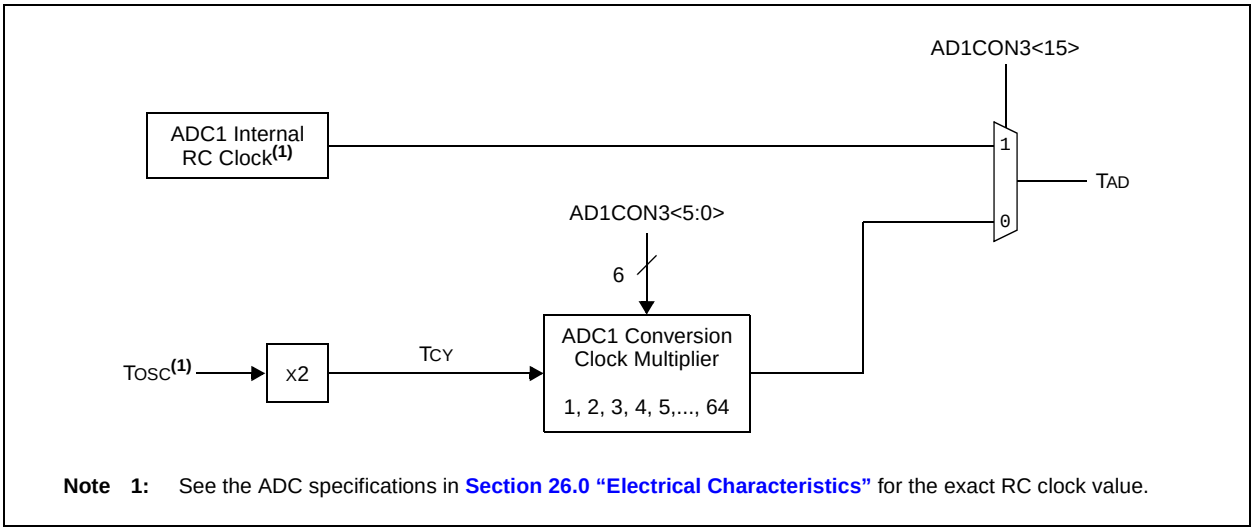
**FIGURE 19-4: ADC1 CONVERSION CLOCK PERIOD BLOCK DIAGRAM**




**Note 1:** See the ADC specifications in **Section 26.0 "Electrical Characteristics"** for the exact RC clock value.

## 19.3 ADC Helpful Tips

1. The SMPI<3:0> (AD1CON2<5:2>) control bits:
   a) Determine when the ADC interrupt flag is set and an interrupt is generated if enabled.
   b) When the CSCNA bit (AD1CON2<10>) is set to '1', determine when the ADC analog scan channel list, defined in the AD1CSSL register, starts over from the beginning.
2. The ADC has 16 result buffers. ADC conversion results are stored sequentially in ADC1BUF0-ADC1BUFF, regardless of which analog inputs are being used, subject to the SMPI<3:0> bits (AD1CON2<5:2>). There is no relationship between the ANx input being measured and which ADC buffer (ADC1BUF0-ADC1BUFF) that the conversion results will be placed in.
3. The DONE bit (AD1CON1<0>) is only cleared at the start of each conversion and is set at the completion of the conversion, but remains set indefinitely, even through the next sample phase until the next conversion begins. If application code is monitoring the DONE bit in any kind of software loop, the user must consider this behavior because the CPU code execution is faster than the ADC. As a result, in Manual Sample mode, particularly where the user's code is setting the SAMP bit (AD1CON1<1>), the DONE bit should also be cleared by the user application just before setting the SAMP bit.

## 19.4 ADC Resources

Many useful resources are provided on the main product page of the Microchip web site for the devices listed in this data sheet. This product page, which can be accessed using this link, contains the latest updates and additional information.

| **Note:** | In the event you are not able to access the product page using the link above, enter this URL in your browser: http://www.microchip.com/wwwproducts/Devices.aspx?dDocName=en554109 |
|---|---|

### 19.4.1 KEY RESOURCES

- **"Analog-to-Digital Converter (ADC)"** (DS70183) in the *"dsPIC33/PIC24 Family Reference Manual"*
- Code Samples
- Application Notes
- Software Libraries
- Webinars
- All related *"dsPIC33/PIC24 Family Reference Manual"* sections
- Development Tools

## 19.5 ADC Control Registers

**REGISTER 19-1: AD1CON1: ADC1 CONTROL REGISTER 1**

| R/W-0 | U-0 | R/W-0 | U-0 | U-0 | U-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| ADON | — | ADSIDL | — | — | — | FORM1 | FORM0 |
| bit 15 | | | | | | | bit 8 |

| R/W-0 | R/W-0 | R/W-0 | U-0 | R/W-0 | R/W-0 | R/W-0, HC, HS | R/C-0, HC, HS |
|---|---|---|---|---|---|---|---|
| SSRC2 | SSRC1 | SSRC0 | — | SIMSAM | ASAM | SAMP | DONE |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | C = Clearable bit | HS = Hardware Settable bit | HC = Hardware Clearable bit |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15 **ADON:** ADC1 Operating Mode bit
1 = ADC1 module is operating
0 = ADC1 is off

bit 14 **Unimplemented:** Read as '0'

bit 13 **ADSIDL:** ADC1 Stop in Idle Mode bit
1 = Discontinues module operation when device enters Idle mode
0 = Continues module operation in Idle mode

bit 12-10 **Unimplemented:** Read as '0'

bit 9-8 **FORM<1:0>:** Data Output Format bits
11 = Signed fractional (DOUT = sddd dddd dd00 0000, where s = .NOT.d<9>)
10 = Fractional (DOUT = dddd dddd dd00 0000)
01 = Signed integer (DOUT = ssss sssd dddd dddd, where s = .NOT.d<9>)
00 = Integer (DOUT = 0000 00dd dddd dddd)

bit 7-5 **SSRC<2:0>:** Sample Clock Source Select bits
111 = Internal counter ends sampling and starts conversion (auto-convert)
110 = CTMU
101 = Reserved
100 = Reserved
011 = Motor control PWM interval ends sampling and starts conversion(1)
010 = GP Timer3 compare ends sampling and starts conversion
001 = Active transition on INT0 pin ends sampling and starts conversion
000 = Clearing SAMP bit ends sampling and starts conversion

bit 4 **Unimplemented:** Read as '0'

bit 3 **SIMSAM:** Simultaneous Sample Select bit (applicable only when CHPS<1:0> = 01 or 1x)
1 = Samples CH0, CH1, CH2, CH3 simultaneously (when CHPS<1:0> = 1x) or samples CH0 and CH1 simultaneously (when CHPS<1:0> = 01)
0 = Samples multiple channels individually in sequence

bit 2 **ASAM:** ADC1 Sample Auto-Start bit
1 = Sampling begins immediately after last conversion; SAMP bit is auto-set
0 = Sampling begins when the SAMP bit is set

**Note 1:** This feature is available in dsPIC33FJ(16/32)MC10X devices only.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**REGISTER 19-1: AD1CON1: ADC1 CONTROL REGISTER 1 (CONTINUED)**

bit 1 **SAMP:** ADC1 Sample Enable bit

1 = ADC1 Sample-and-Hold amplifiers are sampling
0 = ADC1 Sample-and-Hold amplifiers are holding
If ASAM = 0, software can write '1' to begin sampling; automatically set by hardware if ASAM = 1. If SSRC<2:0> = 000, software can write '0' to end sampling and start conversion. If SSRC<2:0> ≠ 000, automatically cleared by hardware to end sampling and start conversion.

bit 0 **DONE:** ADC1 Conversion Status bit

1 = ADC1 conversion cycle is completed
0 = ADC1 conversion has not started or is in progress
Automatically set by hardware when ADC conversion is complete. Software can write '0' to clear the DONE bit status (software not allowed to write '1'). Clearing this bit will NOT affect any operation in progress. Automatically cleared by hardware at start of a new conversion.

**Note 1:** This feature is available in dsPIC33FJ(16/32)MC10X devices only.

**REGISTER 19-2: AD1CON2: ADC1 CONTROL REGISTER 2**

| R/W-0 | R/W-0 | R/W-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| VCFG2 | VCFG1 | VCFG0 | — | — | CSCNA | CHPS1 | CHPS0 |
| bit 15 | | | | | | | bit 8 |

| R-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| BUFS | — | SMPI3 | SMPI2 | SMPI1 | SMPI0 | BUFM | ALTS |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15-13 **VCFG<2:0>:** Converter Voltage Reference Configuration bits

| | **ADREF+** | **ADREF-** |
|---|---|---|
| xxx | AVDD | AVSS |

bit 12-11 **Unimplemented:** Read as ‘0’

bit 10 **CSCNA:** Scan Input Selections for CH0+ During Sample A bit
1 = Scans inputs
0 = Does not scan inputs

bit 9-8 **CHPS<1:0>:** Select Channels Utilized bits
1x = Converts CH0, CH1, CH2 and CH3
01 = Converts CH0 and CH1
00 = Converts CH0

bit 7 **BUFS:** Buffer Fill Status bit (valid only when BUFM = 1)
1 = ADC1 is currently filling second half of buffer, user should access data in the first half
0 = ADC1 is currently filling first half of buffer, user application should access data in the second half

bit 6 **Unimplemented:** Read as ‘0’

bit 5-2 **SMPI<3:0>:** Sample/Convert Sequences Per Interrupt Selection bits
1111 = Interrupts at the completion of conversion for each 16th sample/convert sequence
1110 = Interrupts at the completion of conversion for each 15th sample/convert sequence
•
•
•
0001 = Interrupts at the completion of conversion for each 2nd sample/convert sequence
0000 = Interrupts at the completion of conversion for each sample/convert sequence

bit 1 **BUFM:** Buffer Fill Mode Select bit
1 = Starts filling first half of buffer on first interrupt and the second half of buffer on next interrupt
0 = Always starts filling buffer from the beginning

bit 0 **ALTS:** Alternate Input Sample Mode Select bit
1 = Uses channel input selects for Sample A on first sample and Sample B on next sample
0 = Always uses channel input selects for Sample A


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**REGISTER 19-3: AD1CON3: ADC1 CONTROL REGISTER 3**

| R/W-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| ADRC | — | — | SAMC4(1) | SAMC3(1) | SAMC2(1) | SAMC1(1) | SAMC0(1) |
| bit 15 | | | | | | | bit 8 |

| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| ADCS7(2) | ADCS6(2) | ADCS5(2) | ADCS4(2) | ADCS3(2) | ADCS2(2) | ADCS1(2) | ADCS0(2) |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15 **ADRC:** ADC1 Conversion Clock Source bit
1 = ADC1 internal RC clock
0 = Clock derived from system clock

bit 14-13 **Unimplemented:** Read as '0'

bit 12-8 **SAMC<4:0>:** Auto-Sample Time bits(1)
11111 = 31 TAD
•
•
•
00001 = 1 TAD
00000 = 0 TAD

bit 7-0 **ADCS<7:0>:** ADC1 Conversion Clock Select bits(2)
11111111 = Reserved
•
•
•
•
01000000 = Reserved
00111111 = TCY • (ADCS<7:0> + 1) = 64 • TCY = TAD
•
•
•
00000010 = TCY • (ADCS<7:0> + 1) = 3 • TCY = TAD
00000001 = TCY • (ADCS<7:0> + 1) = 2 • TCY = TAD
00000000 = TCY • (ADCS<7:0> + 1) = 1 • TCY = TAD

**Note 1:** This bit is only used if SSRC<2:0> (AD1CON1<7:5>) = 1.
**2:** This bit is not used if ADRC (AD1CON3<15>) = 1.

**REGISTER 19-4: AD1CHS123: ADC1 INPUT CHANNEL 1, 2, 3 SELECT REGISTER**

| U-0 | U-0 | U-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | CH123NB1 | CH123NB0 | CH123SB |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | CH123NA1 | CH123NA0 | CH123SA |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15-11 **Unimplemented:** Read as '0'

bit 10-9 **CH123NB<1:0>:** Channel 1, 2, 3 Negative Input Select for Sample B bits

**dsPIC33FJ16(GP/MC)101/102 Devices Only:**
11 = Reserved
10 = Reserved
0x = CH1, CH2, CH3 negative inputs are AVSS

**dsPIC33FJ32(GP/MC)101/102 Devices Only:**
11 = CH1 negative input is AN9, CH2 negative input is AN10, CH3 negative input is not connected
10 = Reserved
0x = CH1, CH2, CH3 negative inputs are AVSS

**dsPIC33FJ32(GP/MC)104 Devices Only:**
11 = CH1 negative input is AN9, CH2 negative input is AN10, CH3 negative input is AN11
10 = CH1 negative input is AN6, CH2 negative input is AN7, CH3 negative input is AN8
0x = CH1, CH2, CH3 negative inputs are AVSS

bit 8 **CH123SB:** Channel 1, 2, 3 Positive Input Select for Sample B bit

**dsPIC33FJXX(GP/MC)101 Devices Only:**
1 = CH1 positive input is AN3, CH2 and CH3 positive inputs are not connected
0 = CH1 positive input is AN0, CH2 positive input is AN1, CH3 positive input is AN2

**All Other Devices:**
1 = CH1 positive input is AN3, CH2 positive input is AN4, CH3 positive input is AN5
0 = CH1 positive input is AN0, CH2 positive input is AN1, CH3 positive input is AN2

bit 7-3 **Unimplemented:** Read as '0'

bit 2-1 **CH123NA<1:0>:** Channel 1, 2, 3 Negative Input Select for Sample A bits
Refer to bits<10-9> for the available settings.

bit 0 **CH123SA:** Channel 1, 2, 3 Positive Input Select for Sample A bit
Refer to bit 8 for the available settings.


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**REGISTER 19-5: AD1CHS0: ADC1 INPUT CHANNEL 0 SELECT REGISTER**

| R/W-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| CH0NB | — | — | CH0SB4 | CH0SB3 | CH0SB2 | CH0SB1 | CH0SB0 |
| bit 15 | | | | | | | bit 8 |

| R/W-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| CH0NA | — | — | CH0SA4 | CH0SA3 | CH0SA2 | CH0SA1 | CH0SA0 |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15 **CH0NB:** Channel 0 Negative Input Select for Sample B bit
1 = Channel 0 negative input is AN1
0 = Channel 0 negative input is AVSS

bit 14-13 **Unimplemented:** Read as '0'

bit 12-8 **CH0SB<4:0>:** Channel 0 Positive Input Select for Sample B bits
11111-10000 = Reserved; do not use
01111 = Channel 0 positive input is AN15(2)
01110 = No channels connected, all inputs are floating (used for CTMU)
01101 = Channel 0 positive input is connected to CTMU temperature sensor
01100 = Channel 0 positive input is AN12(2)
01011 = Channel 0 positive input is AN11(2)
01010 = Channel 0 positive input is AN10(3)
01001 = Channel 0 positive input is AN9(3)
01000 = Channel 0 positive input is AN8(2)
00111 = Channel 0 positive input is AN7(2)
00110 = Channel 0 positive input is AN6(2)
00101 = Channel 0 positive input is AN5(1)
00100 = Channel 0 positive input is AN4(1)
00011 = Channel 0 positive input is AN3
00010 = Channel 0 positive input is AN2
00001 = Channel 0 positive input is AN1
00000 = Channel 0 positive input is AN0

bit 7 **CH0NA:** Channel 0 Negative Input Select for Sample A bit
1 = Channel 0 negative input is AN1
0 = Channel 0 negative input is AVSS

bit 6-5 **Unimplemented:** Read as '0'

bit 4-0 **CH0SA<4:0>:** Channel 0 Positive Input Select for Sample A bits
Refer to bits<12-8> for the available settings.

**Note 1:** This setting is available in all devices, excluding the dsPIC33FJXX(GP/MC)101, where it is reserved.
**2:** This setting is available in the dsPIC33FJ32(GP/MC)104 devices only and is reserved in all other devices.
**3:** This setting is available in all devices, excluding the dsPIC33FJ16(GP/MC)101/102, where it is reserved.

**REGISTER 19-6: AD1CSSL: ADC1 INPUT SCAN SELECT REGISTER LOW(1,2,3)**

| R/W-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| CSS15(4) | — | — | CSS<12:8>(4,6) | | | | |
| bit 15 | | | | | | | bit 8 |

| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| CSS<7:0>(4,5) | | | | | | | |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15 **CSS15:** ADC1 Input Scan Selection bit(4)
1 = Selects ANx for input scan
0 = Skips ANx for input scan

bit 14-13 **Unimplemented:** Read as '0'

bit 12-0 **CSS<12:0>:** ADC1 Input Scan Selection bits(4,5,6)
1 = Selects ANx for input scan
0 = Skips ANx for input scan

**Note 1:** On devices without 14 analog inputs, all AD1CSSL bits can be selected by the user application. However, inputs selected for scan without a corresponding input on the device converts VREFL.

**2:** CSSx = ANx, where x = 0 through 12 and 15.

**3:** CTMU temperature sensor input cannot be scanned.

**4:** The CSS<15,12:11,8:6> bits are available in the dsPIC33FJ32(GP/MC)104 devices only and are reserved in all other devices.

**5:** The CSS<5:4> bits are available on all devices, excluding the dsPIC33FJXX(GP/MC)101 devices, where they are reserved.

**6:** The CSS<10:9> bits are available on all devices, excluding the dsPIC33FJ16(GP/MC)101/102 devices, where they are reserved.


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**REGISTER 19-7: AD1PCFGL: ADC1 PORT CONFIGURATION REGISTER LOW(1,2,3)**

| R/W-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| PCFG15(4,5) | — | — | PCFG<12:0>(4,5,7) | | | | |
| bit 15 | | | | | | | bit 8 |

| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| PCFG<7:0>(4,5,6) | | | | | | | |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15 **PCFG15:** ADC1 Port Configuration Control bit(4,5)
1 = Port pin is in Digital mode, port read input is enabled, ADC1 input multiplexer is connected to AVSS
0 = Port pin is in Analog mode, port read input is disabled, ADC1 samples pin voltage

bit 14-13 **Unimplemented:** Read as '0'

bit 12-0 **PCFG<12:0>:** ADC1 Port Configuration Control bits(4,5,6,7)
1 = Port pin is in Digital mode, port read input is enabled, ADC1 input multiplexer is connected to AVSS
0 = Port pin is in Analog mode, port read input is disabled, ADC1 samples pin voltage

**Note 1:** On devices without 14 analog inputs, all PCFGx bits are R/W by user. However, PCFGx bits are ignored on ports without a corresponding input on the device.

**2:** PCFGx = ANx, where x = 0 through 12 and 15.

**3:** The PCFGx bits have no effect if the ADC module is disabled by setting the AD1MD bit in the PMD1 register. When the bit is set, all port pins that have been multiplexed with ANx will be in Digital mode.

**4:** Pins shared with analog functions (i.e., ANx) are analog by default and therefore, must be set by the user to enable any digital function on that pin. Reading any port pin with the analog function enabled will return a '0', regardless of the signal input level.

**5:** The PCFG<15,12:11,8:6> bits are available in the dsPIC33FJ32(GP/MC)104 devices only and are reserved in all other devices.

**6:** The PCFG<5:4> bits are available on all devices, excluding the dsPIC33FJXX(GP/MC)101 devices, where they are reserved.

**7:** The PCFG<10:9> bits are available on all devices, excluding the dsPIC33FJ16(GP/MC)101/102 devices, where they are reserved.

**NOTES:**


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## 20.0 COMPARATOR MODULE

**Note 1:** This data sheet summarizes the features of the dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 device families. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **"Comparator with Blanking"** (DS70647) in the "*dsPIC33/PIC24 Family Reference Manual*", which is available from the Microchip web site (www.microchip.com).

**2:** Some registers and associated bits described in this section may not be available on all devices. Refer to **Section 4.0 "Memory Organization"** in this data sheet for device-specific register and bit information.

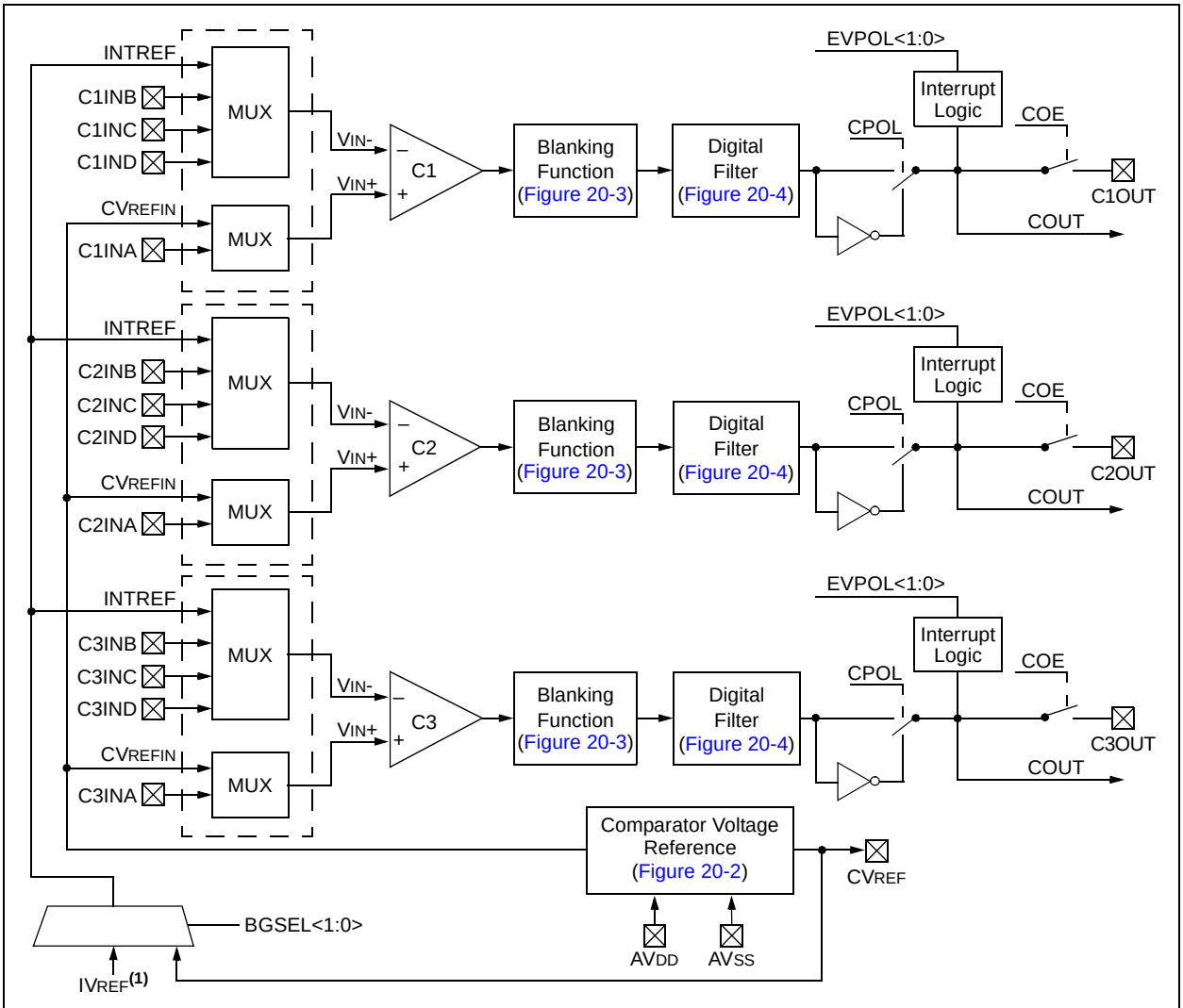
The comparator module provides three comparators that can be configured in different ways. As shown in Figure 20-1, individual comparator options are specified by the comparator module's Special Function Register (SFR) control bits.

These options allow users to:

- Select the edge for trigger and interrupt generation
- Select low-power control
- Configure the comparator voltage reference and band gap
- Configure output blanking and masking

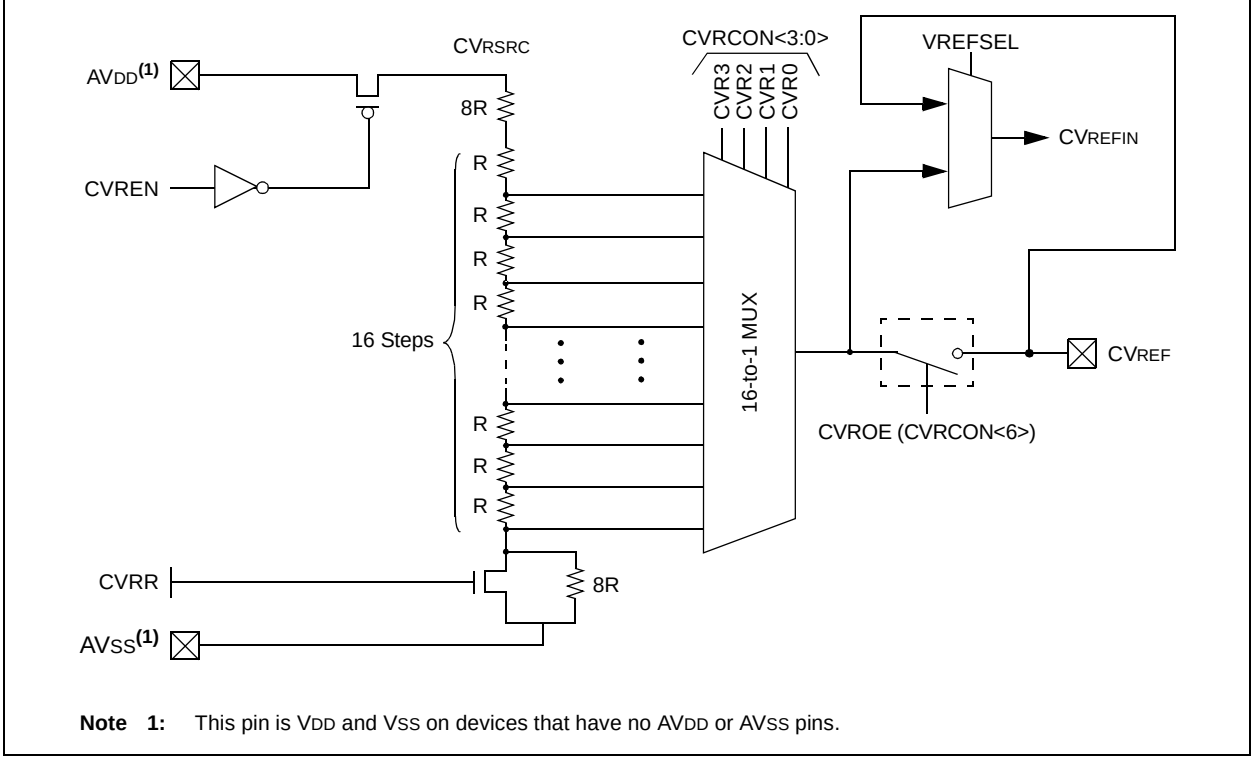
The comparator operating mode is determined by the input selections (i.e., whether the input voltage is compared to a second input voltage) to an internal voltage reference.

**FIGURE 20-1: COMPARATOR I/O OPERATING MODES**




**Note 1:** This reference voltage is generated internally on the device. Refer to **Section 26.0 "Electrical Characteristics"** for the specified voltage range.

**FIGURE 20-2: COMPARATOR VOLTAGE REFERENCE BLOCK DIAGRAM**




**Note 1:** This pin is VDD and VSS on devices that have no AVDD or AVSS pins.

**FIGURE 20-3: USER-PROGRAMMABLE BLANKING FUNCTION BLOCK DIAGRAM**

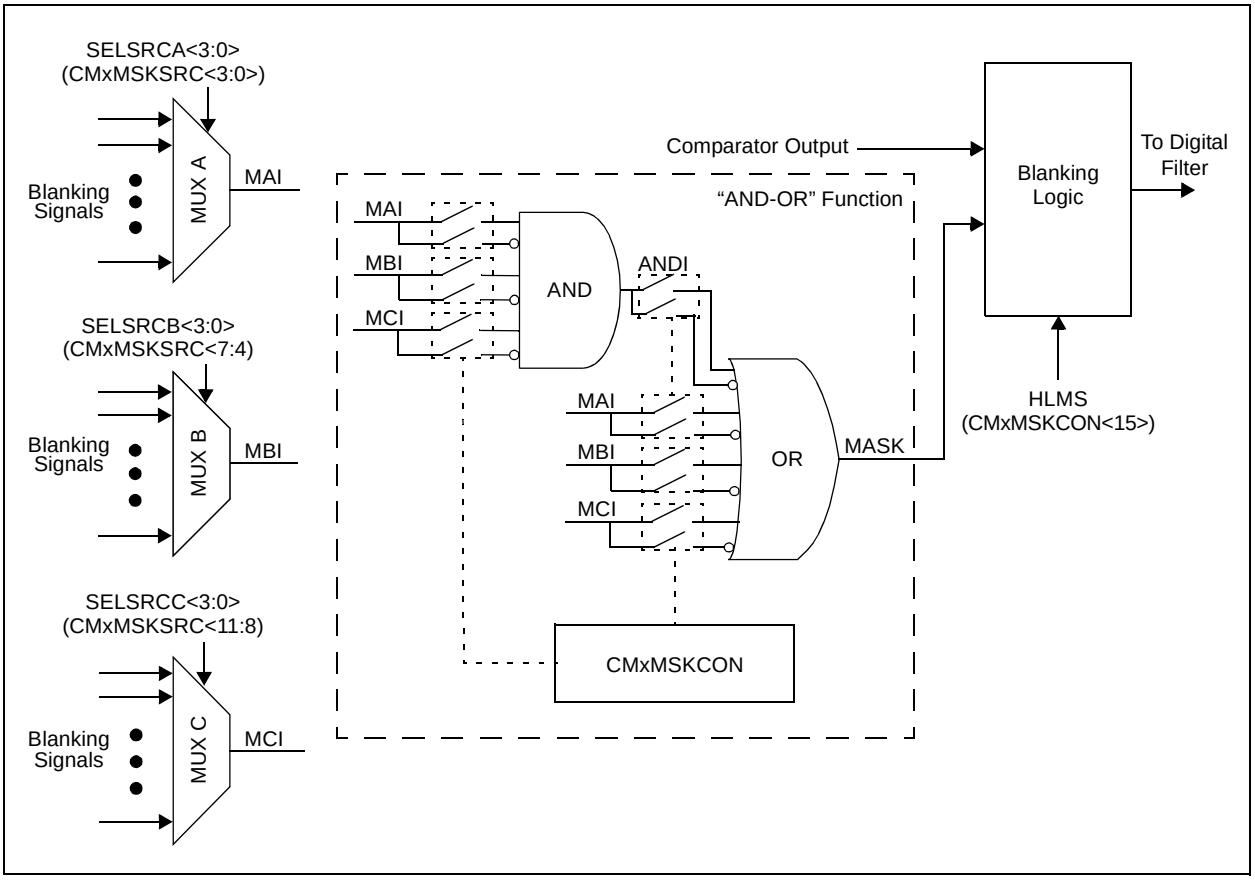




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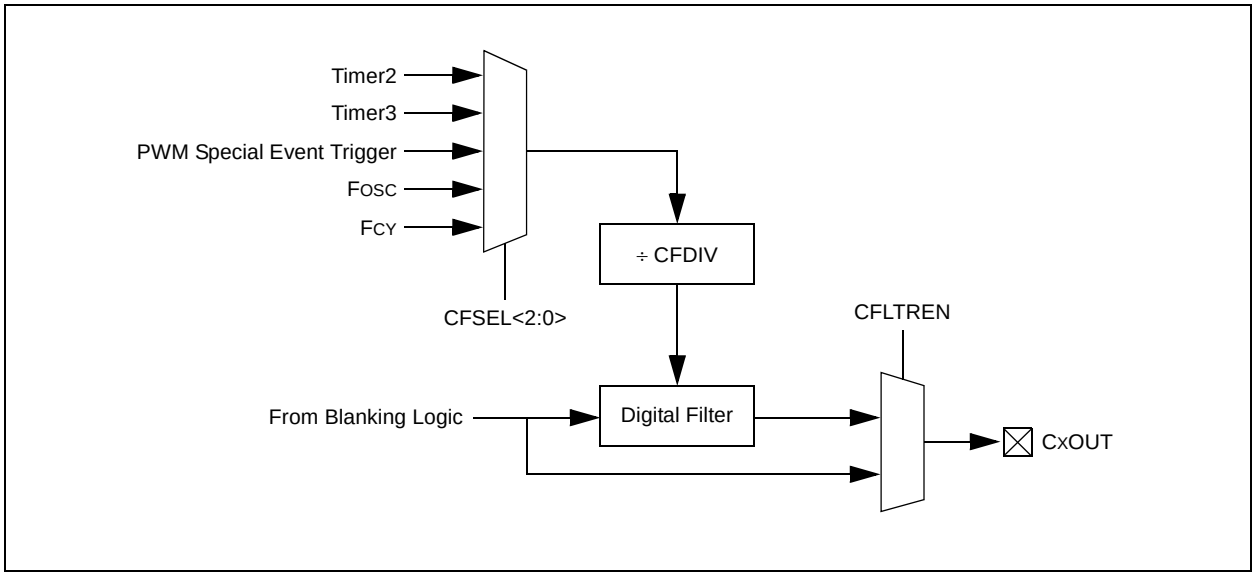
**FIGURE 20-4: DIGITAL FILTER INTERCONNECT BLOCK DIAGRAM**



## 20.1 Comparator Control Registers

**REGISTER 20-1: CMSTAT: COMPARATOR STATUS REGISTER**

| R/W-0 | U-0 | U-0 | U-0 | U-0 | R-0 | R-0 | R-0 |
|---|---|---|---|---|---|---|---|
| CMSIDL | — | — | — | — | C3EVT | C2EVT | C1EVT |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | U-0 | U-0 | R-0 | R-0 | R-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | C3OUT | C2OUT | C1OUT |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15 **CMSIDL:** Comparator Stop in Idle Mode bit
1 = Discontinues operation of all comparators when device enters Idle mode
0 = Continues operation of all comparators in Idle mode

bit 14-11 **Unimplemented:** Read as '0'

bit 10 **C3EVT:** Comparator 3 Event Status bit
1 = Comparator event occurred
0 = Comparator event did not occur

bit 9 **C2EVT:** Comparator 2 Event Status bit
1 = Comparator event occurred
0 = Comparator event did not occur

bit 8 **C1EVT:** Comparator 1 Event Status bit
1 = Comparator event occurred
0 = Comparator event did not occur

bit 7-3 **Unimplemented:** Read as '0'

bit 2 **C3OUT:** Comparator 3 Output Status bit
When CPOL = 0:
1 = $V_{IN+} > V_{IN-}$
0 = $V_{IN+} < V_{IN-}$
When CPOL = 1:
1 = $V_{IN+} < V_{IN-}$
0 = $V_{IN+} > V_{IN-}$

bit 1 **C2OUT:** Comparator 2 Output Status bit
When CPOL = 0:
1 = $V_{IN+} > V_{IN-}$
0 = $V_{IN+} < V_{IN-}$
When CPOL = 1:
1 = $V_{IN+} < V_{IN-}$
0 = $V_{IN+} > V_{IN-}$

bit 0 **C1OUT:** Comparator 1 Output Status bit
When CPOL = 0:
1 = $V_{IN+} > V_{IN-}$
0 = $V_{IN+} < V_{IN-}$
When CPOL = 1:
1 = $V_{IN+} < V_{IN-}$
0 = $V_{IN+} > V_{IN-}$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**REGISTER 20-2: CMxCON: COMPARATOR x CONTROL REGISTER**

| R/W-0 | R/W-0 | R/W-0 | U-0 | U-0 | U-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| CON | COE | CPOL | — | — | — | CEVT | COUT |
| bit 15 | | | | | | | bit 8 |

| R/W-0 | R/W-0 | U-0 | R/W-0 | U-0 | U-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| EVPOL1 | EVPOL0 | — | CREF | — | — | CCH1 | CCH0 |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15 **CON:** Comparator x Enable bit
1 = Comparator x is enabled
0 = Comparator x is disabled

bit 14 **COE:** Comparator x Output Enable bit
1 = Comparator output is present on the CxOUT pin
0 = Comparator output is internal only

bit 13 **CPOL:** Comparator x Output Polarity Select bit
1 = Comparator x output is inverted
0 = Comparator x output is not inverted

bit 12-10 **Unimplemented:** Read as '0'

bit 9 **CEVT:** Comparator x Event bit
1 = Comparator x event according to EVPOL<1:0> settings occurred; disables future triggers and interrupts until the bit is cleared
0 = Comparator x event did not occur

bit 8 **COUT:** Comparator x Output bit
When CPOL = 0 (non-inverted polarity):
1 = $V_{IN+} > V_{IN-}$
0 = $V_{IN+} < V_{IN-}$
When CPOL = 1 (inverted polarity):
1 = $V_{IN+} < V_{IN-}$
0 = $V_{IN+} > V_{IN-}$

bit 7-6 **EVPOL<1:0>:** Trigger/Event/Interrupt Polarity Select bits
11 = Trigger/event/interrupt is generated on any change of the comparator output (while CEVT = 0)
10 = Trigger/event/interrupt is generated only on high-to-low transition of the polarity selected comparator output (while CEVT = 0)
If CPOL = 1 (inverted polarity):
Low-to-high transition of the comparator output.
If CPOL = 0 (non-inverted polarity):
High-to-low transition of the comparator output.
01 = Trigger/event/interrupt is generated only on low-to-high transition of the polarity selected comparator output (while CEVT = 0)
If CPOL = 1 (inverted polarity):
High-to-low transition of the comparator output.
If CPOL = 0 (non-inverted polarity):
Low-to-high transition of the comparator output.
00 = Trigger/event/interrupt generation is disabled

bit 5 **Unimplemented:** Read as '0'

**REGISTER 20-2: CMxCON: COMPARATOR x CONTROL REGISTER (CONTINUED)**

bit 4 **CREF:** Comparator x Reference Select bit ($V_{IN}$+ input)
1 = $V_{IN}$+ input connects to internal $CV_{REFIN}$ voltage
0 = $V_{IN}$+ input connects to CxINA pin

bit 3-2 **Unimplemented:** Read as '0'

bit 1-0 **CCH<1:0>:** Comparator x Channel Select bits
11 = $V_{IN}$- input of comparator connects to INTREF
10 = $V_{IN}$- input of comparator connects to CxIND pin
01 = $V_{IN}$- input of comparator connects to CxINC pin
00 = $V_{IN}$- input of comparator connects to CxINB pin


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**REGISTER 20-3: CMxMSKSRC: COMPARATOR x MASK SOURCE SELECT REGISTER**

| U-0 | U-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | RW-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | SELSRCC3 | SELSRCC2 | SELSRCC1 | SELSRCC0 |
| bit 15 | | | | | | | bit 8 |

| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| SELSRCB3 | SELSRCB2 | SELSRCB1 | SELSRCB0 | SELSRCA3 | SELSRCA2 | SELSRCA1 | SELSRCA0 |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15-12 **Unimplemented:** Read as ‘0’

bit 11-8 **SELSRCC<3:0>:** Mask C Input Select bits

1111 = Reserved
1110 = Reserved
1101 = Reserved
1100 = Reserved
1011 = Reserved
1010 = Reserved
1001 = Reserved
1000 = Reserved
0111 = Reserved
0110 = Reserved
0101 = PWM1H3
0100 = PWM1L3
0011 = PWM1H2
0010 = PWM1L2
0001 = PWM1H1
0000 = PWM1L1

bit 7-4 **SELSRCB<3:0>:** Mask B Input Select bits

1111 = Reserved
1110 = Reserved
1101 = Reserved
1100 = Reserved
1011 = Reserved
1010 = Reserved
1001 = Reserved
1000 = Reserved
0111 = Reserved
0110 = Reserved
0101 = PWM1H3
0100 = PWM1L3
0011 = PWM1H2
0010 = PWM1L2
0001 = PWM1H1
0000 = PWM1L1

**REGISTER 20-3: CMxMSKSRC: COMPARATOR x MASK SOURCE SELECT REGISTER (CONTINUED)**

bit 3-0 **SELSRCA<3:0>:** Mask A Input Select bits

1111 = Reserved
1110 = Reserved
1101 = Reserved
1100 = Reserved
1011 = Reserved
1010 = Reserved
1001 = Reserved
1000 = Reserved
0111 = Reserved
0110 = Reserved
0101 = PWM1H3
0100 = PWM1L3
0011 = PWM1H2
0010 = PWM1L2
0001 = PWM1H1
0000 = PWM1L1


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**REGISTER 20-4: CMxMSKCON: COMPARATOR x MASK GATING CONTROL REGISTER**

| R/W-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| HLMS | — | OCEN | OCNEN | OBEN | OBNEN | OAEN | OANEN |
| bit 15 | | | | | | | bit 8 |

| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| NAGS | PAGS | ACEN | ACNEN | ABEN | ABNEN | AAEN | AANEN |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15 **HLMS:** High or Low Level Masking Select bits
1 = The masking (blanking) function will prevent any asserted ('0') comparator signal from propagating
0 = The masking (blanking) function will prevent any asserted ('1') comparator signal from propagating

bit 14 **Unimplemented:** Read as '0'

bit 13 **OCEN:** OR Gate C Input Inverted Enable bit
1 = MCI is connected to OR gate
0 = MCI is not connected to OR gate

bit 12 **OCNEN:** OR Gate C Input Inverted Enable bit
1 = Inverted MCI is connected to OR gate
0 = Inverted MCI is not connected to OR gate

bit 11 **OBEN:** OR Gate B Input Inverted Enable bit
1 = MBI is connected to OR gate
0 = MBI is not connected to OR gate

bit 10 **OBNEN:** OR Gate B Input Inverted Enable bit
1 = Inverted MBI is connected to OR gate
0 = Inverted MBI is not connected to OR gate

bit 9 **OAEN:** OR Gate A Input Enable bit
1 = MAI is connected to OR gate
0 = MAI is not connected to OR gate

bit 8 **OANEN:** OR Gate A Input Inverted Enable bit
1 = Inverted MAI is connected to OR gate
0 = Inverted MAI is not connected to OR gate

bit 7 **NAGS:** Negative AND Gate Output Select
1 = Inverted ANDI is connected to OR gate
0 = Inverted ANDI is not connected to OR gate

bit 6 **PAGS:** Positive AND Gate Output Select
1 = ANDI is connected to OR gate
0 = ANDI is not connected to OR gate

bit 5 **ACEN:** AND Gate A1 C Input Inverted Enable bit
1 = MCI is connected to AND gate
0 = MCI is not connected to AND gate

bit 4 **ACNEN:** AND Gate A1 C Input Inverted Enable bit
1 = Inverted MCI is connected to AND gate
0 = Inverted MCI is not connected to AND gate

**REGISTER 20-4: CMxMSKCON: COMPARATOR x MASK GATING CONTROL REGISTER (CONTINUED)**

bit 3 **ABEN:** AND Gate A1 B Input Inverted Enable bit
1 = MBI is connected to AND gate
0 = MBI is not connected to AND gate

bit 2 **ABNEN:** AND Gate A1 B Input Inverted Enable bit
1 = Inverted MBI is connected to AND gate
0 = Inverted MBI is not connected to AND gate

bit 1 **AAEN:** AND Gate A1 A Input Enable bit
1 = MAI is connected to AND gate
0 = MAI is not connected to AND gate

bit 0 **AANEN:** AND Gate A1 A Input Inverted Enable bit
1 = Inverted MAI is connected to AND gate
0 = Inverted MAI is not connected to AND gate


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**REGISTER 20-5: CMxFLTR: COMPARATOR x FILTER CONTROL REGISTER**

| U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | — | — | — |
| bit 15 | | | | | | | bit 8 |

| U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | CFSEL2 | CFSEL1 | CFSEL0 | CFLTREN | CFDIV2 | CFDIV1 | CFDIV0 |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15-7 **Unimplemented:** Read as ‘0’

bit 6-4 **CFSEL<2:0>:** Comparator Filter Input Clock Select bits
111 = Reserved
110 = Reserved
101 = Timer3
100 = Timer2
011 = Reserved
010 = PWM Special Event Trigger
001 = FOSC
000 = FCY

bit 3 **CFLTREN:** Comparator Filter Enable bit
1 = Digital filter is enabled
0 = Digital filter is disabled

bit 2-0 **CFDIV<2:0>:** Comparator Filter Clock Divide Select bits
111 = Clock Divide 1:128
110 = Clock Divide 1:64
101 = Clock Divide 1:32
100 = Clock Divide 1:16
011 = Clock Divide 1:8
010 = Clock Divide 1:4
001 = Clock Divide 1:2
000 = Clock Divide 1:1

**REGISTER 20-6: CVRCON: COMPARATOR VOLTAGE REFERENCE CONTROL REGISTER**

| U-0 | U-0 | U-0 | U-0 | U-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | VREFSEL | BGSEL1 | BGSEL0 |
| bit 15 | | | | | | | bit 8 |

| R/W-0 | R/W-0 | R/W-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| CVREN | CVROE(1) | CVRR | — | CVR3 | CVR2 | CVR1 | CVR0 |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15-11 **Unimplemented:** Read as '0'

bit 10 **VREFSEL:** Voltage Reference Select bit
1 = CVREFIN = CVREF pin
0 = CVREFIN is generated by the resistor network

bit 9-8 **BGSEL<1:0>:** Band Gap Reference Source Select bits
11 = INTREF = CVREF pin
10 = INTREF = 1.2V (nominal)(2)
0x = Reserved

bit 7 **CVREN:** Comparator Voltage Reference Enable bit
1 = Comparator voltage reference circuit is powered on
0 = Comparator voltage reference circuit is powered down

bit 6 **CVROE:** Comparator Voltage Reference Output Enable bit(1)
1 = Voltage level is output on CVREF pin
0 = Voltage level is disconnected from CVREF pin

bit 5 **CVRR:** Comparator Voltage Reference Range Selection bit
1 = CVRSRC/24 step-size
0 = CVRSRC/32 step-size

bit 4 **Unimplemented:** Read as '0'

bit 3-0 **CVR<3:0>:** Comparator Voltage Reference Value Selection 0 ≤ CVR<3:0> ≤ 15 bits
When CVRR = 1:
CVREFIN = (CVR<3:0>/24) • (CVRSRC)
When CVRR = 0:
CVREFIN = 1/4 • (CVRSRC) + (CVR<3:0>/32) • (CVRSRC)

**Note 1:** CVROE overrides the TRISx bit setting.

**2:** This reference voltage is generated internally on the device. Refer to **Section 26.0 "Electrical Characteristics"** for the specified voltage range.


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## 21.0 REAL-TIME CLOCK AND CALENDAR (RTCC)

**Note 1:** This data sheet summarizes the features of the dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 device families of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **"Real-Time Clock and Calendar (RTCC)"** (DS70310) in the "*dsPIC33/PIC24 Family Reference Manual*", which is available on the Microchip web site (www.microchip.com).

**2:** Some registers and associated bits described in this section may not be available on all devices. Refer to **Section 4.0 "Memory Organization"** in this data sheet for device-specific register and bit information.

This chapter discusses the Real-Time Clock and Calendar (RTCC) module, available on dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 devices, and its operation.

Some of the key features of the RTCC module are:

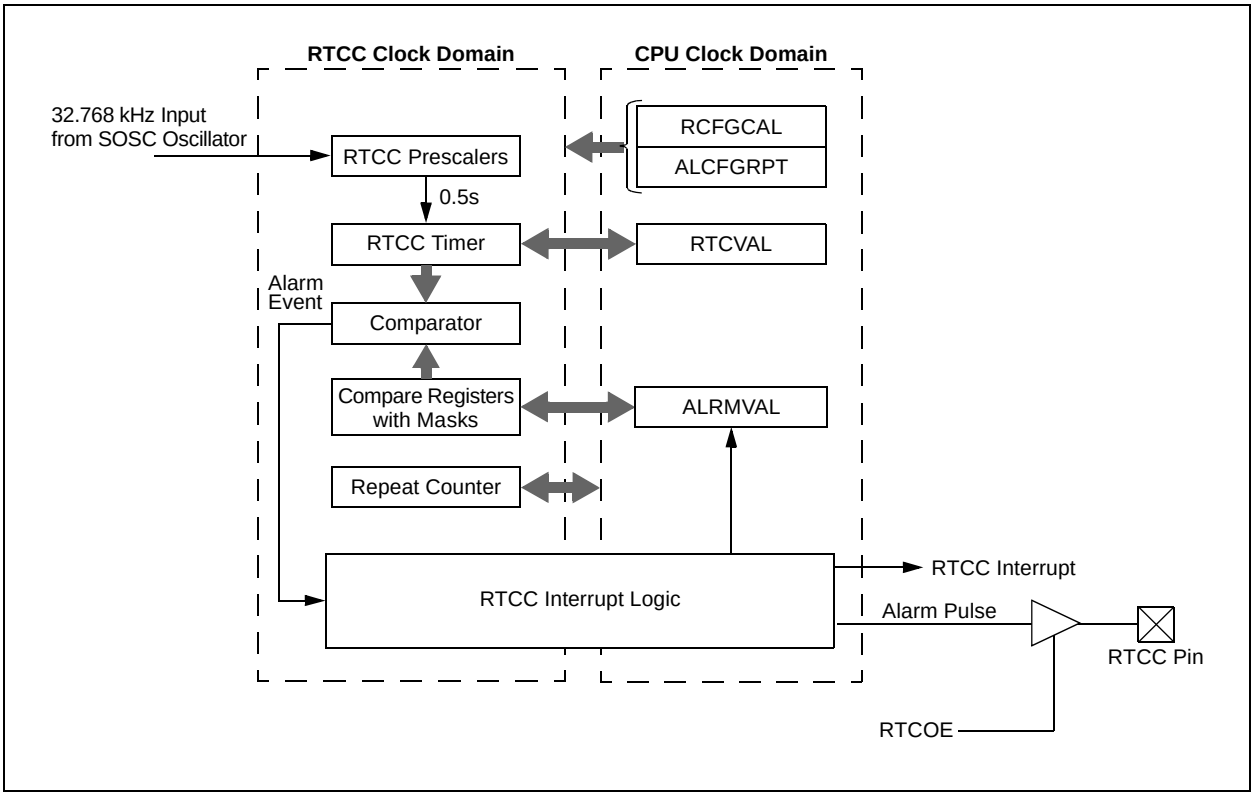
- Time: hours, minutes and seconds
- 24-hour format (military time)
- Calendar: weekday, date, month and year
- Alarm configurable
- Year range: 2000 to 2099
- Leap year correction
- BCD format for compact firmware
- Optimized for low-power operation
- User calibration with auto-adjust
- Calibration range: ±2.64 seconds error per month
- Requirements: external 32.768 kHz clock crystal
- Alarm pulse or seconds clock output on RTCC pin

The RTCC module is intended for applications where accurate time must be maintained for extended periods of time with minimum to no intervention from the CPU. The RTCC module is optimized for low-power usage to provide extended battery lifetime while keeping track of time.

The RTCC module is a 100-year clock and calendar with automatic leap year detection. The range of the clock is from 00:00:00 (midnight) on January 1, 2000 to 23:59:59 on December 31, 2099.

The hours are available in 24-hour (military time) format. The clock provides a granularity of one second with half-second visibility to the user.

**FIGURE 21-1: RTCC BLOCK DIAGRAM**



## 21.1 RTCC Module Registers

The RTCC module registers are organized into three categories:

- RTCC Control Registers
- RTCC Value Registers
- Alarm Value Registers

### 21.1.1 REGISTER MAPPING

To limit the register interface, the RTCC Timer and Alarm Time registers are accessed through corresponding register pointers. The RTCC Value register window (RTCVALH and RTCVALL) uses the RTCPTR bits (RCFGCAL<9:8>) to select the desired Timer register pair (see Table 21-1).

By writing the RTCVALH byte, the RTCC Pointer value (RTCPTR<1:0> bits) decrements by one until it reaches '00'. Once it reaches '00', the MINUTES and SECONDS value will be accessible through RTCVALH and RTCVALL until the pointer value is manually changed.

**TABLE 21-1: RTCVAL REGISTER MAPPING**

| RTCPTR <1:0> | RTCC Value Register Window | |
|---|---|---|
| | RTCVAL<15:8> | RTCVAL<7:0> |
| 00 | MINUTES | SECONDS |
| 01 | WEEKDAY | HOURS |
| 10 | MONTH | DAY |
| 11 | — | YEAR |

The Alarm Value register window (ALRMVALH and ALRMVALL) uses the ALRMPTR bits (ALCFGRPT<9:8>) to select the desired Alarm register pair (see Table 21-2).

By writing the ALRMVALH byte, the Alarm Pointer value (ALRMPTR<1:0> bits) decrements by one until it reaches '00'. Once it reaches '00', the ALRMMIN and ALRMSEC value will be accessible through ALRMVALH and ALRMVALL until the pointer value is manually changed.

**TABLE 21-2: ALRMVAL REGISTER MAPPING**

| ALRMPTR <1:0> | Alarm Value Register Window | |
|---|---|---|
| | ALRMVAL<15:8> | ALRMVAL<7:0> |
| 00 | ALRMMIN | ALRMSEC |
| 01 | ALRMWD | ALRMHR |
| 10 | ALRMMNTH | ALRMDAY |
| 11 | — | — |

Considering that the 16-bit core does not distinguish between 8-bit and 16-bit read operations, the user must be aware that when reading either the ALRMVALH or ALRMVALL, bytes will decrement the ALRMPTR<1:0> value. The same applies to the RTCVALH or RTCVALL bytes with the RTCPTR<1:0> being decremented.

| | |
|---|---|
| **Note:** | This only applies to read operations and not write operations. |

### 21.1.2 WRITE LOCK

In order to perform a write to any of the RTCC Timer registers, the RTCWREN bit (RCFGCAL<13>) must be set (refer to Example 21-1).

| | |
|---|---|
| **Note:** | To avoid accidental writes to the timer, it is recommended that the RTCWREN bit (RCFGCAL<13>) is kept clear at any other time. For the RTCWREN bit to be set, there is only 1 instruction cycle time window allowed between the 55h/AA sequence and the setting of RTCWREN; therefore, it is recommended that code follow the procedure in Example 21-1. |

**EXAMPLE 21-1: SETTING THE RTCWREN BIT**

```
MOV     #NVMKEY, W1        ;move the address of NVMKEY into W1
MOV     #0x55, W2
MOV     #0xAA, W3
MOV     W2, [W1]           ;start 55/AA sequence
MOV     W3, [W1]
BSET    RCFGCAL, #13       ;set the RTCWREN bit
```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## 21.2 RTCC Control Registers

**REGISTER 21-1: RCFGCAL: RTCC CALIBRATION AND CONFIGURATION REGISTER(1)**

| R/W-0 | U-0 | R/W-0 | R-0 | R-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| RTCEN(2) | — | RTCWREN | RTCSYNC | HALFSEC(3) | RTCOE | RTCPTR1 | RTCPTR0 |
| bit 15 | | | | | | | bit 8 |

| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| CAL7 | CAL6 | CAL5 | CAL4 | CAL3 | CAL2 | CAL1 | CAL0 |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15 **RTCEN:** RTCC Enable bit(2)
1 = RTCC module is enabled
0 = RTCC module is disabled

bit 14 **Unimplemented:** Read as '0'

bit 13 **RTCWREN:** RTCC Value Registers Write Enable bit
1 = RTCVALH and RTCVALL registers can be written to by the user
0 = RTCVALH and RTCVALL registers are locked out from being written to by the user

bit 12 **RTCSYNC:** RTCC Value Registers Read Synchronization bit
1 = RTCVALH, RTCVALL and ALCFGRPT registers can change while reading, due to a rollover ripple, resulting in an invalid data read. If the register is read twice and the results are the same data, the data can be assumed to be valid.
0 = RTCVALH, RTCVALL or ALCFGRPT registers can be read without concern over a rollover ripple

bit 11 **HALFSEC:** Half-Second Status bit(3)
1 = Second half period of a second
0 = First half period of a second

bit 10 **RTCOE:** RTCC Output Enable bit
1 = RTCC output is enabled
0 = RTCC output is disabled

bit 9-8 **RTCPTR<1:0>:** RTCC Value Register Window Pointer bits
Points to the corresponding RTCC Value registers when reading RTCVALH and RTCVALL registers; the RTCPTR<1:0> value decrements on every read or write of RTCVALH until it reaches '00'.
RTCVAL<15:8>:
00 = MINUTES
01 = WEEKDAY
10 = MONTH
11 = Reserved
RTCVAL<7:0>:
00 = SECONDS
01 = HOURS
10 = DAY
11 = YEAR

**Note 1:** The RCFGCAL register is only affected by a POR.
**2:** A write to the RTCEN bit is only allowed when RTCWREN = 1.
**3:** This bit is read-only; it is cleared to '0' on a write to the lower half of the MINSEC register.

**REGISTER 21-1: RCFGCAL: RTCC CALIBRATION AND CONFIGURATION REGISTER(1) (CONTINUED)**

bit 7-0 **CAL<7:0>:** RTC Drift Calibration bits

01111111 = Maximum positive adjustment; adds 508 RTC clock pulses every one minute
•
•
•
00000001 = Minimum positive adjustment; adds 4 RTC clock pulses every one minute
00000000 = No adjustment
11111111 = Minimum negative adjustment; subtracts 4 RTC clock pulses every one minute
•
•
•
10000000 = Maximum negative adjustment; subtracts 512 RTC clock pulses every one minute

**Note 1:** The RCFGCAL register is only affected by a POR.

**2:** A write to the RTCEN bit is only allowed when RTCWREN = 1.

**3:** This bit is read-only; it is cleared to '0' on a write to the lower half of the MINSEC register.


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**REGISTER 21-2: PADCFG1: PAD CONFIGURATION CONTROL REGISTER**

| U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | — | — | — |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | R/W-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | — | RTSECSEL(1) | — |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15-2 **Unimplemented:** Read as ‘0’

bit 1 **RTSECSEL:** RTCC Seconds Clock Output Select bit(1)
1 = RTCC seconds clock is selected for the RTCC pin
0 = RTCC alarm pulse is selected for the RTCC pin

bit 0 **Unimplemented:** Read as ‘0’

**Note 1:** To enable the actual RTCC output, the RTCOE (RCFGCAL<10>) bit needs to be set.

**REGISTER 21-3: ALCFGRPT: ALARM CONFIGURATION REGISTER**

| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| ALRMEN | CHIME | AMASK3 | AMASK2 | AMASK1 | AMASK0 | ALRMPTR1 | ALRMPTR0 |
| bit 15 | | | | | | | bit 8 |

| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| ARPT7 | ARPT6 | ARPT5 | ARPT4 | ARPT3 | ARPT2 | ARPT1 | ARPT0 |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15 **ALRMEN:** Alarm Enable bit

1 = Alarm is enabled (cleared automatically after an alarm event whenever ARPT<7:0> = 0x00 and CHIME = 0)

0 = Alarm is disabled

bit 14 **CHIME:** Chime Enable bit

1 = Chime is enabled; ARPT<7:0> bits are allowed to roll over from 0x00 to 0xFF

0 = Chime is disabled; ARPT<7:0> bits stop once they reach 0x00

bit 13-10 **AMASK<3:0>:** Alarm Mask Configuration bits

0000 = Every half second
0001 = Every second
0010 = Every 10 seconds
0011 = Every minute
0100 = Every 10 minutes
0101 = Every hour
0110 = Once a day
0111 = Once a week
1000 = Once a month
1001 = Once a year (except when configured for February 29th, once every 4 years)
101x = Reserved – do not use
11xx = Reserved – do not use

bit 9-8 **ALRMPTR<1:0>:** Alarm Value Register Window Pointer bits

Points to the corresponding Alarm Value registers when reading ALRMVALH and ALRMVALL registers; the ALRMPTR<1:0> value decrements on every read or write of ALRMVALH until it reaches '00'.

ALRMVAL<15:8>:
00 = ALRMMIN
01 = ALRMWD
10 = ALRMMNTH
11 = Unimplemented

ALRMVAL<7:0>:
00 = ALRMSEC
01 = ALRMHR
10 = ALRMDAY
11 = Unimplemented

bit 7-0 **ARPT<7:0>:** Alarm Repeat Counter Value bits

11111111 = Alarm will repeat 255 more times
•
•
•
00000000 = Alarm will not repeat

The counter decrements on any alarm event. The counter is prevented from rolling over from 0x00 to 0xFF unless CHIME = 1.


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**REGISTER 21-4: RTCVAL (WHEN RTCPTR<1:0> = 11): RTCC YEAR VALUE REGISTER(1)**

| U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | — | — | — |
| bit 15 | | | | | | | bit 8 |

| R/W-x | R/W-x | R/W-x | R/W-x | R/W-x | R/W-x | R/W-x | R/W-x |
|---|---|---|---|---|---|---|---|
| YRTEN3 | YRTEN2 | YRTEN1 | YRTEN0 | YRONE3 | YRONE2 | YRONE1 | YRONE0 |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15-8 **Unimplemented:** Read as '0'

bit 7-4 **YRTEN<3:0>:** Binary Coded Decimal Value of Year's Tens Digit bits
Contains a value from 0 to 9.

bit 3-0 **YRONE<3:0>:** Binary Coded Decimal Value of Year's Ones Digit bits
Contains a value from 0 to 9.

**Note 1:** A write to this register is only allowed when RTCWREN = 1.

**REGISTER 21-5: RTCVAL (WHEN RTCPTR<1:0> = 10): RTCC MONTH AND DAY VALUE REGISTER(1)**

| U-0 | U-0 | U-0 | R-x | R-x | R-x | R-x | R-x |
|---|---|---|---|---|---|---|---|
| — | — | — | MTHTEN0 | MTHONE3 | MTHONE2 | MTHONE1 | MTHONE0 |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | R/W-x | R/W-x | R/W-x | R/W-x | R/W-x | R/W-x |
|---|---|---|---|---|---|---|---|
| — | — | DAYTEN1 | DAYTEN0 | DAYONE3 | DAYONE2 | DAYONE1 | DAYONE0 |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15-13 **Unimplemented:** Read as '0'

bit 12 **MTHTEN0:** Binary Coded Decimal Value of Month's Tens Digit bit
Contains a value of 0 or 1.

bit 11-8 **MTHONE<3:0>:** Binary Coded Decimal Value of Month's Ones Digit bits
Contains a value from 0 to 9.

bit 7-6 **Unimplemented:** Read as '0'

bit 5-4 **DAYTEN<1:0>:** Binary Coded Decimal Value of Day's Tens Digit bits
Contains a value from 0 to 3.

bit 3-0 **DAYONE<3:0>:** Binary Coded Decimal Value of Day's Ones Digit bits
Contains a value from 0 to 9.

**Note 1:** A write to this register is only allowed when RTCWREN = 1.

**REGISTER 21-6: RTCVAL (WHEN RTCPTR<1:0> = 01): RTCC WEEKDAY AND HOURS VALUE REGISTER(1)**

| U-0 | U-0 | U-0 | U-0 | U-0 | R/W-x | R/W-x | R/W-x |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | WDAY2 | WDAY1 | WDAY0 |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | R/W-x | R/W-x | R/W-x | R/W-x | R/W-x | R/W-x |
|---|---|---|---|---|---|---|---|
| — | — | HRTEN1 | HRTEN0 | HRONE3 | HRONE2 | HRONE1 | HRONE0 |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15-11 **Unimplemented:** Read as '0'

bit 10-8 **WDAY<2:0>:** Binary Coded Decimal Value of Weekday Digit bits
Contains a value from 0 to 6.

bit 7-6 **Unimplemented:** Read as '0'

bit 5-4 **HRTEN<1:0>:** Binary Coded Decimal Value of Hour's Tens Digit bits
Contains a value from 0 to 2.

bit 3-0 **HRONE<3:0>:** Binary Coded Decimal Value of Hour's Ones Digit bits
Contains a value from 0 to 9.

**Note 1:** A write to this register is only allowed when RTCWREN = 1.


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**REGISTER 21-7: RTCVAL (WHEN RTCPTR<1:0> = 00): RTCC MINUTES AND SECONDS VALUE REGISTER**

| U-0 | R/W-x | R/W-x | R/W-x | R/W-x | R/W-x | R/W-x | R/W-x |
|---|---|---|---|---|---|---|---|
| — | MINTEN2 | MINTEN1 | MINTEN0 | MINONE3 | MINONE2 | MINONE1 | MINONE0 |
| bit 15 | | | | | | | bit 8 |

| U-0 | R/W-x | R/W-x | R/W-x | R/W-x | R/W-x | R/W-x | R/W-x |
|---|---|---|---|---|---|---|---|
| — | SECTEN2 | SECTEN1 | SECTEN0 | SECONE3 | SECONE2 | SECONE1 | SECONE0 |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15 **Unimplemented:** Read as ‘0’

bit 14-12 **MINTEN<2:0>:** Binary Coded Decimal Value of Minute’s Tens Digit bits
Contains a value from 0 to 5.

bit 11-8 **MINONE<3:0>:** Binary Coded Decimal Value of Minute’s Ones Digit bits
Contains a value from 0 to 9.

bit 7 **Unimplemented:** Read as ‘0’

bit 6-4 **SECTEN<2:0>:** Binary Coded Decimal Value of Second’s Tens Digit bits
Contains a value from 0 to 5.

bit 3-0 **SECONE<3:0>:** Binary Coded Decimal Value of Second’s Ones Digit bits
Contains a value from 0 to 9.

**REGISTER 21-8: ALRMVAL (WHEN ALRMPTR<1:0> = 10): ALARM MONTH AND DAY VALUE REGISTER(1)**

| U-0 | U-0 | U-0 | R/W-x | R/W-x | R/W-x | R/W-x | R/W-x |
|---|---|---|---|---|---|---|---|
| — | — | — | MTHTEN0 | MTHONE3 | MTHONE2 | MTHONE1 | MTHONE0 |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | R/W-x | R/W-x | R/W-x | R/W-x | R/W-x | R/W-x |
|---|---|---|---|---|---|---|---|
| — | — | DAYTEN1 | DAYTEN0 | DAYONE3 | DAYONE2 | DAYONE1 | DAYONE0 |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15-13 **Unimplemented:** Read as '0'

bit 12 **MTHTEN0:** Binary Coded Decimal Value of Month's Tens Digit bit
Contains a value of 0 or 1.

bit 11-8 **MTHONE<3:0>:** Binary Coded Decimal Value of Month's Ones Digit bits
Contains a value from 0 to 9.

bit 7-6 **Unimplemented:** Read as '0'

bit 5-4 **DAYTEN<1:0>:** Binary Coded Decimal Value of Day's Tens Digit bits
Contains a value from 0 to 3.

bit 3-0 **DAYONE<3:0>:** Binary Coded Decimal Value of Day's Ones Digit bits
Contains a value from 0 to 9.

**Note 1:** A write to this register is only allowed when RTCWREN = 1.


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**REGISTER 21-9: ALRMVAL (WHEN ALRMPTR<1:0> = 01): ALARM WEEKDAY AND HOURS VALUE REGISTER(1)**

| U-0 | U-0 | U-0 | U-0 | U-0 | R/W-x | R/W-x | R/W-x |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | WDAY2 | WDAY1 | WDAY0 |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | R/W-x | R/W-x | R/W-x | R/W-x | R/W-x | R/W-x |
|---|---|---|---|---|---|---|---|
| — | — | HRTEN1 | HRTEN0 | HRONE3 | HRONE2 | HRONE1 | HRONE0 |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15-11 **Unimplemented:** Read as ‘0’

bit 10-8 **WDAY<2:0>:** Binary Coded Decimal Value of Weekday Digit bits
Contains a value from 0 to 6.

bit 7-6 **Unimplemented:** Read as ‘0’

bit 5-4 **HRTEN<1:0>:** Binary Coded Decimal Value of Hour’s Tens Digit bits
Contains a value from 0 to 2.

bit 3-0 **HRONE<3:0>:** Binary Coded Decimal Value of Hour’s Ones Digit bits
Contains a value from 0 to 9.

**Note 1:** A write to this register is only allowed when RTCWREN = 1.

**REGISTER 21-10: ALRMVAL (WHEN ALRMPTR<1:0> = 00): ALARM MINUTES AND SECONDS VALUE REGISTER**

| U-0 | R/W-x | R/W-x | R/W-x | R/W-x | R/W-x | R/W-x | R/W-x |
|---|---|---|---|---|---|---|---|
| — | MINTEN2 | MINTEN1 | MINTEN0 | MINONE3 | MINONE2 | MINONE1 | MINONE0 |
| bit 15 | | | | | | | bit 8 |

| U-0 | R/W-x | R/W-x | R/W-x | R/W-x | R/W-x | R/W-x | R/W-x |
|---|---|---|---|---|---|---|---|
| — | SECTEN2 | SECTEN1 | SECTEN0 | SECONE3 | SECONE2 | SECONE1 | SECONE0 |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' | |
| -n = Value at POR | '1' = Bit is set | '0' = Bit is cleared | x = Bit is unknown |

bit 15 **Unimplemented:** Read as '0'

bit 14-12 **MINTEN<2:0>:** Binary Coded Decimal Value of Minute's Tens Digit bits
Contains a value from 0 to 5.

bit 11-8 **MINONE<3:0>:** Binary Coded Decimal Value of Minute's Ones Digit bits
Contains a value from 0 to 9.

bit 7 **Unimplemented:** Read as '0'

bit 6-4 **SECTEN<2:0>:** Binary Coded Decimal Value of Second's Tens Digit bits
Contains a value from 0 to 5.

bit 3-0 **SECONE<3:0>:** Binary Coded Decimal Value of Second's Ones Digit bits
Contains a value from 0 to 9.


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## 22.0 CHARGE TIME MEASUREMENT UNIT (CTMU)

**Note 1:** This data sheet summarizes the features of the dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 device families of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **"Charge Time Measurement Unit (CTMU)"** (DS70635) in the "*dsPIC33/PIC24 Family Reference Manual*", which is available on the Microchip web site (www.microchip.com).

**2:** Some registers and associated bits described in this section may not be available on all devices. Refer to **Section 4.0 "Memory Organization"** in this data sheet for device-specific register and bit information.

The Charge Time Measurement Unit (CTMU) is a flexible analog module that provides accurate differential time measurement between pulse sources, as well as asynchronous pulse generation. Its key features include:

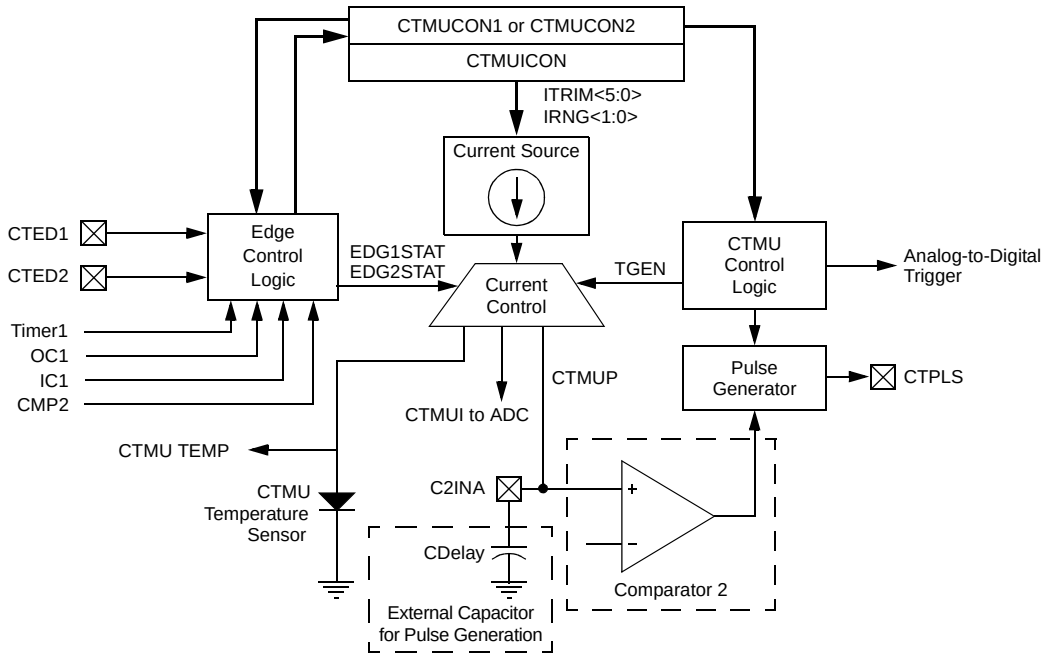
- Four edge input trigger sources
- Polarity control for each edge source
- Control of edge sequence
- Control of response to edges
- Precise time measurement resolution of 200 ps
- Accurate current source suitable for capacitive measurement
- On-chip temperature measurement using a built-in diode

Together with other on-chip analog modules, the CTMU can be used to precisely measure time, measure capacitance, measure relative changes in capacitance or generate output pulses that are independent of the system clock.

The CTMU module is ideal for interfacing with capacitive-based sensors. The CTMU is controlled through three registers: CTMUCON1, CTMUCON2 and CTMUICON. CTMUCON1 enables the module, the edge delay generation, sequencing of edges, and controls the current source and the output trigger. CTMUCON2 controls the edge source selection, edge source polarity selection and edge sampling mode. The CTMUICON register controls the selection and trim of the current source.

Figure 22-1 shows the CTMU block diagram.

**FIGURE 22-1: CTMU BLOCK DIAGRAM**




| Current Control Selection | TGEN | EDG1STAT, EDG2STAT |
|---|---|---|
| CTMU TEMP | 0 | EDG1STAT = EDG2STAT |
| CTMUI | 0 | EDG1STAT ≠ EDG2STAT |
| CTMUP | 1 | EDG1STAT ≠ EDG2STAT |
| No Connect | 1 | EDG1STAT = EDG2STAT |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## 22.1 CTMU Control Registers

**REGISTER 22-1: CTMUCON1: CTMU CONTROL REGISTER 1**

| R/W-0 | U-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| CTMUEN | — | CTMUSIDL | TGEN(1) | EDGEN | EDGSEQEN | IDISSEN(2) | CTTRIG |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | — | — | — |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15 **CTMUEN:** CTMU Enable bit
1 = Module is enabled
0 = Module is disabled

bit 14 **Unimplemented:** Read as ‘0’

bit 13 **CTMUSIDL:** CTMU Stop in Idle Mode bit
1 = Discontinues module operation when device enters Idle mode
0 = Continues module operation in Idle mode

bit 12 **TGEN:** Time Generation Enable bit(1)
1 = Enables edge delay generation
0 = Disables edge delay generation

bit 11 **EDGEN:** Edge Enable bit
1 = Edges are not blocked
0 = Edges are blocked

bit 10 **EDGSEQEN:** Edge Sequence Enable bit
1 = Edge 1 event must occur before Edge 2 event can occur
0 = No edge sequence is needed

bit 9 **IDISSEN:** Analog Current Source Control bit(2)
1 = Analog current source output is grounded
0 = Analog current source output is not grounded

bit 8 **CTTRIG:** CTMU Trigger Control bit
1 = Trigger output is enabled
0 = Trigger output is disabled

bit 7-0 **Unimplemented:** Read as ‘0’

**Note 1:** If TGEN = 1, the peripheral inputs and outputs must be configured to an available RPn pin. For more information, see **Section 10.4 “Peripheral Pin Select (PPS)”**.

**2:** The ADC module S&H capacitor is not automatically discharged between sample/conversion cycles. Software using the ADC as part of a capacitance measurement must discharge the ADC capacitor before conducting the measurement. The IDISSEN bit, when set to ‘1’, performs this function. The ADC must be sampling while the IDISSEN bit is active to connect the discharge sink to the capacitor array.

**REGISTER 22-2: CTMUCON2: CTMU CONTROL REGISTER 2**

| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| EDG1MOD | EDG1POL | EDG1SEL3 | EDG1SEL2 | EDG1SEL1 | EDG1SEL0 | EDG2STAT | EDG1STAT |
| bit 15 | | | | | | | bit 8 |

| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| EDG2MOD | EDG2POL | EDG2SEL3 | EDG2SEL2 | EDG2SEL1 | EDG2SEL0 | — | — |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15 **EDG1MOD:** Edge 1 Edge Sampling Selection bit
1 = Edge 1 is edge-sensitive
0 = Edge 1 is level-sensitive

bit 14 **EDG1POL:** Edge 1 Polarity Select bit
1 = Edge 1 is programmed for a positive edge response
0 = Edge 1 is programmed for a negative edge response

bit 13-10 **EDG1SEL<3:0>:** Edge 1 Source Select bits
1xxx = Reserved
01xx = Reserved
0011 = CTED1 pin
0010 = CTED2 pin
0001 = OC1 module
0000 = Timer1 module

bit 9 **EDG2STAT:** Edge 2 Status bit
Indicates the status of Edge 2 and can be written to control the edge source.
1 = Edge 2 has occurred
0 = Edge 2 has not occurred

bit 8 **EDG1STAT:** Edge 1 Status bit
Indicates the status of Edge 1 and can be written to control the edge source.
1 = Edge 1 has occurred
0 = Edge 1 has not occurred

bit 7 **EDG2MOD:** Edge 2 Edge Sampling Selection bit
1 = Edge 2 is edge-sensitive
0 = Edge 2 is level-sensitive

bit 6 **EDG2POL:** Edge 2 Polarity Select bit
1 = Edge 2 is programmed for a positive edge response
0 = Edge 2 is programmed for a negative edge response

bit 5-2 **EDG2SEL<3:0>:** Edge 2 Source Select bits
1xxx = Reserved
01xx = Reserved
0011 = CTED2 pin
0010 = CTED1 pin
0001 = Comparator 2 module
0000 = IC1 module

bit 1-0 **Unimplemented:** Read as ‘0’


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**REGISTER 22-3: CTMUICON: CTMU CURRENT CONTROL REGISTER**

| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|---|---|---|---|---|---|---|---|
| ITRIM5 | ITRIM4 | ITRIM3 | ITRIM2 | ITRIM1 | ITRIM0 | IRNG1 | IRNG0 |
| bit 15 | | | | | | | bit 8 |

| U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 |
|---|---|---|---|---|---|---|---|
| — | — | — | — | — | — | — | — |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | | | |
|---|---|---|---|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as ‘0’ | |
| -n = Value at POR | ‘1’ = Bit is set | ‘0’ = Bit is cleared | x = Bit is unknown |

bit 15-10 **ITRIM<5:0>:** Current Source Trim bits

011111 = Nominal current output specified by IRNG<1:0> + 62%
011110 = Nominal current output specified by IRNG<1:0> + 60%
•
•
•
000001 = Nominal current output specified by IRNG<1:0> + 2%
000000 = Nominal current output specified by IRNG<1:0>
111111 = Nominal current output specified by IRNG<1:0> – 2%
•
•
•
100010 = Nominal current output specified by IRNG<1:0> – 62%
100001 = Nominal current output specified by IRNG<1:0> – 64%

bit 9-8 **IRNG<1:0>:** Current Source Range Select bits

11 = 100 × Base Current(1)
10 = 10 × Base Current
01 = Base current level (0.55 μA nominal)
00 = Reserved

bit 7-0 **Unimplemented:** Read as ‘0’

**Note 1:** This setting must be used for the CTMU temperature sensor.

**NOTES:**


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## 23.0 SPECIAL FEATURES

**Note 1:** This data sheet summarizes the features of the dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **"Programming and Diagnostics"** (DS70207) and **"Device Configuration"** (DS70194) in the *"dsPIC33/PIC24 Family Reference Manual"*, which are available from the Microchip web site (www.microchip.com).

**2:** Some registers and associated bits described in this section may not be available on all devices. Refer to **Section 4.0 "Memory Organization"** in this data sheet for device-specific register and bit information.

dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 devices include several features intended to maximize application flexibility and reliability, and minimize cost through elimination of external components. These are:

- Flexible Configuration
- Watchdog Timer (WDT)
- Code Protection
- In-Circuit Serial Programming™ (ICSP™)
- In-Circuit Emulation

### 23.1 Configuration Bits

The Configuration Shadow register bits can be configured (read as '0') or left unprogrammed (read as '1') to select various device configurations. These read-only bits are mapped starting at program memory location, 0xF80000. A detailed explanation of the various bit functions is provided in Table 23-4.

Note that address, 0xF80000, is beyond the user program memory space and belongs to the configuration memory space (0x800000-0xFFFFFF), which can only be accessed using Table Reads.

In dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 devices, the Configuration bytes are implemented as volatile memory. This means that configuration data must be programmed each time the device is powered up. Configuration data is stored in the two words at the top of the on-chip program memory space, known as the Flash Configuration Words. Their specific locations are shown in Table 23-2. These are packed representations of the actual device Configuration bits, whose actual locations are distributed among several locations in configuration space. The configuration data is automatically loaded from the Flash Configuration Words to the proper Configuration registers during device Resets.

**Note:** Configuration data is reloaded on all types of device Resets.

When creating applications for these devices, users should always specifically allocate the location of the Flash Configuration Word for configuration data. This is to make certain that program code is not stored in this address when the code is compiled.

The upper byte of all Flash Configuration Words in program memory should always be '1111 1111'. This makes them appear to be NOP instructions in the remote event that their locations are ever executed by accident. Since Configuration bits are not implemented in the corresponding locations, writing '1's to these locations has no effect on device operation.

**Note:** Performing a page erase operation on the last page of program memory clears the Flash Configuration Words, enabling code protection as a result. Therefore, users should avoid performing page erase operations on the last page of program memory.

The Configuration Shadow register map is shown in Table 23-1.

**TABLE 23-1: CONFIGURATION SHADOW REGISTER MAP**

| File Name | Addr. | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|---|---|---|---|---|---|---|---|---|---|
| FGS | F80004 | — | — | — | — | — | — | GCP | GWRP |
| FOSCSEL | F80006 | IESO | PWMLOCK(1) | — | WDTWIN1 | WDTWIN0 | FNOSC2 | FNOSC1 | FNOSC0 |
| FOSC | F80008 | FCKSM1 | FCKSM0 | IOL1WAY | — | — | OSCIOFNC | POSCMD1 | POSCMD0 |
| FWDT | F8000A | FWDTEN | WINDIS | PLLKEN | WDTPRE | WDTPOST3 | WDTPOST2 | WDTPOST1 | WDTPOST0 |
| FPOR | F8000C | PWMPIN(1) | HPOL(1) | LPOL(1) | ALTI2C1 | — | — | — | — |
| FICD | F8000E | Reserved(2) | — | Reserved(3) | Reserved(3) | — | — | ICS1 | ICS0 |

**Legend:** — = unimplemented, read as '1'.
**Note 1:** These bits are available in dsPIC33FJ(16/32)MC10X devices only.
**2:** This bit is reserved for use by development tools.
**3:** These bits are reserved, program as '0'.

The Configuration Flash Word maps are shown in Table 23-2 and Table 23-3.

**TABLE 23-2: CONFIGURATION FLASH WORDS FOR dsPIC33FJ16(GP/MC)10X DEVICES(1)**

| File Name | Addr. | Bits 23-16 | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| CONFIG2 | 002BFC | — | IESO | PWMLOCK(2) | PWMPIN(2) | WDTWIN1 | WDTWIN0 | FNOSC2 | FNOSC1 | FNOSC0 | FCKSM1 | FCKSM0 | OSCIOFNC(5) | IOL1WAY | LPOL(2) | ALTI2C1 | POSCMD1 | POSCMD0 |
| CONFIG1 | 002BFE | — | Reserved(3) | Reserved(3) | GCP | GWRP | Reserved(4) | HPOL(2) | ICS1 | ICS0 | FWDTEN | WINDIS | PLLKEN | WDTPRE | WDTPOST3 | WDTPOST2 | WDTPOST1 | WDTPOST0 |

**Legend:** — = unimplemented, read as '1'.
**Note 1:** During a Power-on Reset (POR), the contents of these Flash locations are transferred to the Configuration Shadow registers.
**2:** These bits are reserved in dsPIC33FJ16GP10X devices and read as '1'.
**3:** These bits are reserved, program as '0'.
**4:** This bit is reserved for use by development tools and must be programmed as '1'.
**5:** This bit is programmed to '0' during final tests in the factory.

**TABLE 23-3: CONFIGURATION FLASH WORDS FOR dsPIC33FJ32(GP/MC)10X DEVICES(1)**

| File Name | Addr. | Bits 23-16 | Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| CONFIG2 | 0057FC | — | IESO | PWMLOCK(2) | PWMPIN(2) | WDTWIN1 | WDTWIN0 | FNOSC2 | FNOSC1 | FNOSC0 | FCKSM1 | FCKSM0 | OSCIOFNC(5) | IOL1WAY | LPOL(2) | ALTI2C1 | POSCMD1 | POSCMD0 |
| CONFIG1 | 0057FE | — | Reserved(3) | Reserved(3) | GCP | GWRP | Reserved(4) | HPOL(2) | ICS1 | ICS0 | FWDTEN | WINDIS | PLLKEN | WDTPRE | WDTPOST3 | WDTPOST2 | WDTPOST1 | WDTPOST0 |

**Legend:** — = unimplemented, read as '1'.
**Note 1:** During a Power-on Reset (POR), the contents of these Flash locations are transferred to the Configuration Shadow registers.
**2:** These bits are reserved in dsPIC33FJ32GP10X devices and read as '1'.
**3:** These bits are reserved, program as '0'.
**4:** This bit is reserved for use by development tools and must be programmed as '1'.
**5:** This bit is programmed to '0' during final tests in the factory.


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**TABLE 23-4: dsPIC33F CONFIGURATION BITS DESCRIPTION**

| Bit Field | Description |
|---|---|
| GCP | General Segment Code-Protect bit<br>1 = User program memory is not code-protected<br>0 = Code protection is enabled for the entire program memory space |
| GWRP | General Segment Write-Protect bit<br>1 = User program memory is not write-protected<br>0 = User program memory is write-protected |
| IESO | Two-Speed Oscillator Start-up Enable bit<br>1 = Starts up device with FRC, then automatically switches to the user-selected oscillator source when ready<br>0 = Starts up device with user-selected oscillator source |
| PWMLOCK | PWM Lock Enable bit<br>1 = Certain PWM registers may only be written after a key sequence<br>0 = PWM registers may be written without a key sequence |
| WDTWIN<1:0> | Watchdog Timer Window Select bits<br>11 = WDT window is 24% of WDT period<br>10 = WDT window is 37.5% of WDT period<br>01 = WDT window is 50% of WDT period<br>00 = WDT window is 75% of WDT period |
| FNOSC<2:0> | Oscillator Selection bits<br>111 = Fast RC Oscillator with Divide-by-N (FRCDIVN)<br>110 = Reserved; do not use<br>101 = Low-Power RC Oscillator (LPRC)<br>100 = Secondary Oscillator (SOSC)<br>011 = Primary Oscillator with PLL module (MS + PLL, EC + PLL)<br>010 = Primary Oscillator (MS, HS, EC)<br>001 = Fast RC Oscillator with Divide-by-N and PLL module (FRCDIVN + PLL)<br>000 = Fast RC Oscillator (FRC) |
| FCKSM<1:0> | Clock Switching Mode bits<br>1x = Clock switching is disabled, Fail-Safe Clock Monitor is disabled<br>01 = Clock switching is enabled, Fail-Safe Clock Monitor is disabled<br>00 = Clock switching is enabled, Fail-Safe Clock Monitor is enabled |
| IOL1WAY | Peripheral Pin Select Configuration bit<br>1 = Allow only one reconfiguration<br>0 = Allow multiple reconfigurations |
| OSCIOFNC | OSC2 Pin Function bit (except in MS and HS modes)<br>1 = OSC2 is a clock output<br>0 = OSC2 is a general purpose digital I/O pin |
| POSCMD<1:0> | Primary Oscillator Mode Select bits<br>11 = Primary Oscillator is disabled<br>10 = HS Crystal Oscillator mode (10 MHz-32 MHz)<br>01 = MS Crystal Oscillator mode (3 MHz-10 MHz)<br>00 = EC (External Clock) mode (DC-32 MHz) |
| FWDTEN | Watchdog Timer Enable bit<br>1 = Watchdog Timer is always enabled (LPRC oscillator cannot be disabled; clearing the SWDTEN bit in the RCON register will have no effect)<br>0 = Watchdog Timer is enabled/disabled by user software (LPRC can be disabled by clearing the SWDTEN bit in the RCON register) |
| WINDIS | Watchdog Timer Window Enable bit<br>1 = Watchdog Timer in Non-Window mode<br>0 = Watchdog Timer in Window mode |

**TABLE 23-4: dsPIC33F CONFIGURATION BITS DESCRIPTION (CONTINUED)**

| Bit Field | Description |
|---|---|
| WDTPRE | Watchdog Timer Prescaler bit<br>1 = 1:128<br>0 = 1:32 |
| WDTPOST<3:0> | Watchdog Timer Postscaler bits<br>1111 = 1:32,768<br>1110 = 1:16,384<br>•<br>•<br>•<br>0001 = 1:2<br>0000 = 1:1 |
| PLLKEN | PLL Lock Enable bit<br>1 = Clock switch to PLL will wait until the PLL lock signal is valid<br>0 = Clock switch will not wait for the PLL lock signal |
| ALTI2C | Alternate $I^2C$™ Pins bit<br>1 = $I^2C$ is mapped to SDA1/SCL1 pins<br>0 = $I^2C$ is mapped to ASDA1/ASCL1 pins |
| ICS<1:0> | ICD Communication Channel Select bits<br>11 = Communicate on PGEC1 and PGED1<br>10 = Communicate on PGEC2 and PGED2<br>01 = Communicate on PGEC3 and PGED3<br>00 = Reserved, do not use |
| PWMPIN | Motor Control PWM Module Pin Mode bit<br>1 = PWM module pins controlled by PORT register at device Reset (tri-stated)<br>0 = PWM module pins controlled by PWM module at device Reset (configured as output pins) |
| HPOL | Motor Control PWM High Side Polarity bit<br>1 = PWM module high side output pins have active-high output polarity<br>0 = PWM module high side output pins have active-low output polarity |
| LPOL | Motor Control PWM Low Side Polarity bit<br>1 = PWM module low side output pins have active-high output polarity<br>0 = PWM module low side output pins have active-low output polarity |


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**REGISTER 23-1: DEVID: DEVICE ID REGISTER**

| R | R | R | R | R | R | R | R |
|---|---|---|---|---|---|---|---|
| DEVID<23:16>(1) | | | | | | | |
| bit 23 | | | | | | | bit 16 |

| R | R | R | R | R | R | R | R |
|---|---|---|---|---|---|---|---|
| DEVID<15:8>(1) | | | | | | | |
| bit 15 | | | | | | | bit 8 |

| R | R | R | R | R | R | R | R |
|---|---|---|---|---|---|---|---|
| DEVID<7:0>(1) | | | | | | | |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | R = Read-Only bit | U = Unimplemented bit |
|---|---|---|

bit 23-0 **DEIDV<23:0>:** Device Identifier bits(1)

**Note 1:** Refer to the *"dsPIC33F Flash Programming Specification for Devices with Volatile Configuration Bits"* (DS70659) for the list of device ID values.

**REGISTER 23-2: DEVREV: DEVICE REVISION REGISTER**

| R | R | R | R | R | R | R | R |
|---|---|---|---|---|---|---|---|
| DEVREV<23:16>(1) | | | | | | | |
| bit 23 | | | | | | | bit 16 |

| R | R | R | R | R | R | R | R |
|---|---|---|---|---|---|---|---|
| DEVREV<15:8>(1) | | | | | | | |
| bit 15 | | | | | | | bit 8 |

| R | R | R | R | R | R | R | R |
|---|---|---|---|---|---|---|---|
| DEVREV<7:0>(1) | | | | | | | |
| bit 7 | | | | | | | bit 0 |

| **Legend:** | R = Read-only bit | U = Unimplemented bit |
|---|---|---|

bit 23-0 **DEVREV<23:0>:** Device Revision bits(1)

**Note 1:** Refer to the *"dsPIC33F Flash Programming Specification for Devices with Volatile Configuration Bits"* (DS70659) for the list of device revision values.

## 23.2 On-Chip Voltage Regulator

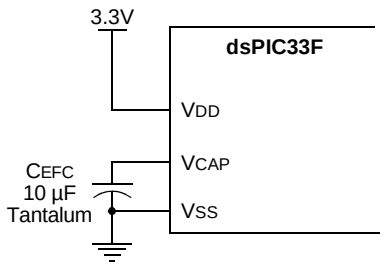
All of the dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 devices power their core digital logic at a nominal 2.5V. This can create a conflict for designs that are required to operate at a higher typical voltage, such as 3.3V. To simplify system design, all devices in the dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 family incorporate an on-chip regulator that allows the device to run its core logic from VDD.

The regulator provides power to the core from the other VDD pins. When the regulator is enabled, a low-ESR (less than 5 ohms) capacitor (such as tantalum or ceramic) must be connected to the VCAP pin (Figure 23-1). This helps to maintain the stability of the regulator. The recommended value for the filter capacitor is provided in Table 26-14 located in **Section 26.1 "DC Characteristics"**.

| **Note:** | It is important for low-ESR capacitors to be placed as close as possible to the VCAP pin. |
|---|---|

On a POR, it takes approximately 20 µs for the on-chip voltage regulator to generate an output voltage. During this time, designated as TSTARTUP, code execution is disabled. TSTARTUP is applied every time the device resumes operation after any power-down.

**FIGURE 23-1: CONNECTIONS FOR THE ON-CHIP VOLTAGE REGULATOR(1,2,3)**




**Note 1:** These are typical operating voltages. Refer to Table 26-14 located in **Section 26.1 "DC Characteristics"** for the full operating ranges of VDD and VCAP.

**2:** It is important for low-ESR capacitors to be placed as close as possible to the VCAP pin.

**3:** Typical VCAP pin voltage = 2.5V when VDD ≥ VDDMIN.

## 23.3 BOR: Brown-out Reset

The Brown-out Reset (BOR) module is based on an internal voltage reference circuit that monitors the regulated supply voltage, VCAP. The main purpose of the BOR module is to generate a device Reset when a brown-out condition occurs. Brown-out conditions are generally caused by glitches on the AC mains (for example, missing portions of the AC cycle waveform due to bad power transmission lines or voltage sags due to excessive current draw when a large inductive load is turned on).

A BOR generates a Reset pulse, which resets the device. The BOR selects the clock source, based on the device Configuration bit values (FNOSC<2:0> and POSCMD<1:0>).

If an Oscillator mode is selected, the BOR activates the Oscillator Start-up Timer (OST). The system clock is held until OST expires. If the PLL is used, the clock is held until the LOCK bit (OSCCON<5>) is '1'.

Concurrently, the PWRT Time-out (TPWRT) is applied before the internal Reset is released. If TPWRT = 0 and a crystal oscillator is being used, then a nominal delay of TFSCM = 100 is applied. The total delay in this case is TFSCM.

The BOR status bit (RCON<1>) is set to indicate that a BOR has occurred. The BOR circuit continues to operate while in Sleep or Idle modes and resets the device should VDD fall below the BOR threshold voltage.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## 23.4 Watchdog Timer (WDT)

For dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 devices, the WDT is driven by the LPRC oscillator. When the WDT is enabled, the clock source is also enabled.

### 23.4.1 PRESCALER/POSTSCALER

The nominal WDT clock source from LPRC is 32 kHz. This feeds a prescaler than can be configured for either 5-bit (divide-by-32) or 7-bit (divide-by-128) operation. The prescaler is set by the WDTPRE Configuration bit. With a 32 kHz input, the prescaler yields a nominal WDT Time-out (TWDT) period of 1 ms in 5-bit mode or 4 ms in 7-bit mode.

A variable postscaler divides down the WDT prescaler output and allows for a wide range of time-out periods. The postscaler is controlled by the WDTPOST<3:0> Configuration bits (FWDT<3:0>), which allow the selection of 16 settings, from 1:1 to 1:32,768. Using the prescaler and postscaler, time-out periods, ranging from 1 ms to 131 seconds, can be achieved.

The WDT, prescaler and postscaler are reset:

- On any device Reset
- On the completion of a clock switch, whether invoked by software (i.e., setting the OSWEN bit after changing the NOSCx bits) or by hardware (i.e., Fail-Safe Clock Monitor)
- When a PWRSAV instruction is executed (i.e., Sleep or Idle mode is entered)
- When the device exits Sleep or Idle mode to resume normal operation
- By a CLRWDT instruction during normal execution

| **Note:** | The CLRWDT and PWRSAV instructions clear the prescaler and postscaler counts when executed. |
|---|---|

### 23.4.2 SLEEP AND IDLE MODES

If the WDT is enabled, it will continue to run during Sleep or Idle modes. When the WDT time-out occurs, the device will wake the device and code execution will continue from where the PWRSAV instruction was executed. The corresponding SLEEP or IDLE bits (RCON<3:2>) will need to be cleared in software after the device wakes up.

### 23.4.3 ENABLING WDT

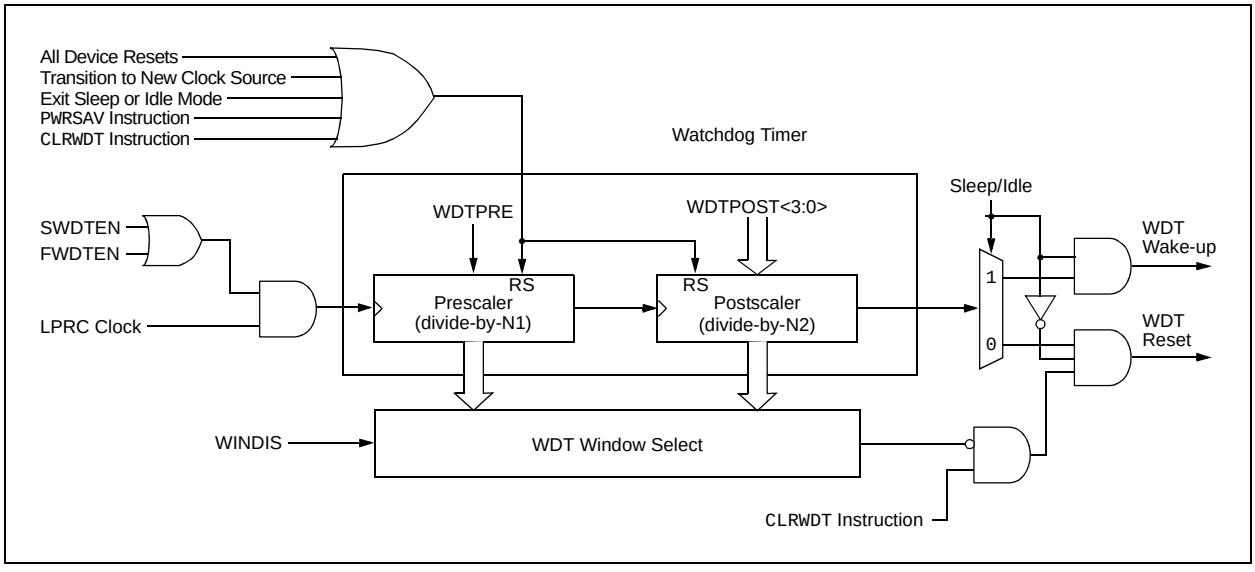
The WDT is enabled or disabled by the FWDTEN Configuration bit in the FWDT Configuration register. When the FWDTEN Configuration bit is set, the WDT is always enabled.

The WDT can be optionally controlled in software when the FWDTEN Configuration bit has been programmed to '0'. The WDT is enabled in software by setting the SWDTEN control bit (RCON<5>). The SWDTEN control bit is cleared on any device Reset. The software WDT option allows the user application to enable the WDT for critical code segments and disables the WDT during non-critical segments for maximum power savings.

| **Note:** | If the WINDIS bit (FWDT<6>) is cleared, the CLRWDT instruction should be executed by the application software only during the last 1/4 of the WDT period. This CLRWDT window can be determined by using a timer. If a CLRWDT instruction is executed before this window, a WDT Reset occurs. |
|---|---|

The WDT flag bit, WDTO (RCON<4>), is not automatically cleared following a WDT time-out. To detect subsequent WDT events, the flag must be cleared in software.

**FIGURE 23-2: WDT BLOCK DIAGRAM**



## 23.5 In-Circuit Serial Programming™ (ICSP™)

Devices can be serially programmed while in the end application circuit. This is done with two lines for clock and data and three other lines for power, ground and the programming sequence. Serial programming allows customers to manufacture boards with unprogrammed devices and then program the Digital Signal Controller just before shipping the product. Serial programming also allows the most recent firmware or a custom firmware to be programmed. Refer to the *"dsPIC33F Flash Programming Specification for Devices with Volatile Configuration Bits"* (DS70659) for details about In-Circuit Serial Programming (ICSP).

Any of the three pairs of programming clock/data pins can be used:

- PGEC1 and PGED1
- PGEC2 and PGED2
- PGEC3 and PGED3

## 23.6 In-Circuit Debugger

When MPLAB® ICD 3 is selected as a debugger, the in-circuit debugging functionality is enabled. This function allows simple debugging functions when used with MPLAB IDE. Debugging functionality is controlled through the PGECx (Emulation/Debug Clock) and PGEDx (Emulation/Debug Data) pin functions.

Any of the three pairs of debugging clock/data pins can be used:

- PGEC1 and PGED1
- PGEC2 and PGED2
- PGEC3 and PGED3

To use the in-circuit debugger function of the device, the design must implement ICSP connections to $\overline{MCLR}$, $V_{DD}$, $V_{SS}$ and the PGECx/PGEDx pin pair. In addition, when the feature is enabled, some of the resources are not available for general use. These resources include the first 80 bytes of data RAM and two I/O pins.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## 24.0 INSTRUCTION SET SUMMARY

**Note:** This data sheet summarizes the features of the dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 devices. However, it is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to the latest family reference sections of the *"dsPIC33/PIC24 Family Reference Manual"*, which are available from the Microchip web site (www.microchip.com).

The dsPIC33F instruction set is identical to that of the dsPIC30F.

Most instructions are a single program memory word (24 bits). Only three instructions require two program memory locations.

Each single-word instruction is a 24-bit word, divided into an 8-bit opcode, which specifies the instruction type and one or more operands, which further specify the operation of the instruction.

The instruction set is highly orthogonal and is grouped into five basic categories:

- Word or byte-oriented operations
- Bit-oriented operations
- Literal operations
- DSP operations
- Control operations

Table 24-1 shows the general symbols used in describing the instructions.

The dsPIC33F instruction set summary in Table 24-2 lists all the instructions, along with the status flags affected by each instruction.

Most word or byte-oriented W register instructions (including barrel shift instructions) have three operands:

- The first source operand, which is typically a register 'Wb' without any address modifier
- The second source operand, which is typically a register 'Ws' with or without an address modifier
- The destination of the result, which is typically a register 'Wd' with or without an address modifier

However, word or byte-oriented file register instructions have two operands:

- The file register specified by the value 'f'
- The destination, which could be either the file register 'f' or the W0 register, which is denoted as 'WREG'

Most bit-oriented instructions (including simple rotate/shift instructions) have two operands:

- The W register (with or without an address modifier) or file register (specified by the value of 'Ws' or 'f')
- The bit in the W register or file register (specified by a literal value or indirectly by the contents of register 'Wb')

The literal instructions that involve data movement can use some of the following operands:

- A literal value to be loaded into a W register or file register (specified by 'k')
- The W register or file register where the literal value is to be loaded (specified by 'Wb' or 'f')

However, literal instructions that involve arithmetic or logical operations use some of the following operands:

- The first source operand, which is a register 'Wb' without any address modifier
- The second source operand, which is a literal value
- The destination of the result (only if not the same as the first source operand), which is typically a register 'Wd' with or without an address modifier

The MAC class of DSP instructions can use some of the following operands:

- The accumulator (A or B) to be used (required operand)
- The W registers to be used as the two operands
- The X and Y address space prefetch operations
- The X and Y address space prefetch destinations
- The accumulator write-back destination

The other DSP instructions do not involve any multiplication and can include:

- The accumulator to be used (required)
- The source or destination operand (designated as Wso or Wdo, respectively) with or without an address modifier
- The amount of shift specified by a W register 'Wn' or a literal value

The control instructions can use some of the following operands:

- A program memory address
- The mode of the Table Read and Table Write instructions

Most instructions are a single word. Certain double-word instructions are designed to provide all the required information in these 48 bits. In the second word, the 8 MSbs are '0's. If this second word is executed as an instruction (by itself), it will execute as a NOP.

The double-word instructions execute in two instruction cycles.

Most single-word instructions are executed in a single instruction cycle, unless a conditional test is true, or the Program Counter is changed as a result of the instruction. In these cases, the execution takes two instruction cycles with the additional instruction cycle(s) executed as a NOP. Notable exceptions are the BRA (unconditional/computed branch), indirect CALL/GOTO, all Table Reads and Writes and RETURN/RETFIE instructions, which are single-word instructions but take two or three cycles. Certain instructions that involve skipping over the subsequent instruction require either two or three cycles if the skip is performed, depending on whether the instruction being skipped is a single-word or two-word instruction. Moreover, double-word moves require two cycles.

**Note:** For more details on the instruction set, refer to the *"16-Bit MCU and DSC Programmer's Reference Manual"* (DS70157).

**TABLE 24-1: SYMBOLS USED IN OPCODE DESCRIPTIONS**

| Field | Description |
|---|---|
| #text | Means literal defined by "text" |
| (text) | Means "content of text" |
| [text] | Means "the location addressed by text" |
| { } | Optional field or operation |
| <n:m> | Register bit field |
| .b | Byte mode selection |
| .d | Double-Word mode selection |
| .S | Shadow register select |
| .w | Word mode selection (default) |
| Acc | One of two accumulators {A, B} |
| AWB | Accumulator write-back destination address register ∈ {W13, [W13]+ = 2} |
| bit4 | 4-bit bit selection field (used in word addressed instructions) ∈ {0...15} |
| C, DC, N, OV, Z | MCU Status bits: Carry, Digit Carry, Negative, Overflow, Sticky Zero |
| Expr | Absolute address, label or expression (resolved by the linker) |
| f | File register address ∈ {0x0000...0x1FFF} |
| lit1 | 1-bit unsigned literal ∈ {0,1} |
| lit4 | 4-bit unsigned literal ∈ {0...15} |
| lit5 | 5-bit unsigned literal ∈ {0...31} |
| lit8 | 8-bit unsigned literal ∈ {0...255} |
| lit10 | 10-bit unsigned literal ∈ {0...255} for Byte mode, {0:1023} for Word mode |
| lit14 | 14-bit unsigned literal ∈ {0...16384} |
| lit16 | 16-bit unsigned literal ∈ {0...65535} |
| lit23 | 23-bit unsigned literal ∈ {0...8388608}; LSb must be '0' |
| None | Field does not require an entry, can be blank |
| OA, OB, SA, SB | DSP Status bits: ACCA Overflow, ACCB Overflow, ACCA Saturate, ACCB Saturate |
| PC | Program Counter |
| Slit10 | 10-bit signed literal ∈ {-512...511} |
| Slit16 | 16-bit signed literal ∈ {-32768...32767} |
| Slit6 | 6-bit signed literal ∈ {-16...16} |
| Wb | Base W register ∈ {W0..W15} |
| Wd | Destination W register ∈ { Wd, [Wd], [Wd++], [Wd--], [++Wd], [--Wd] } |
| Wdo | Destination W register ∈<br>{ Wnd, [Wnd], [Wnd++], [Wnd--], [++Wnd], [--Wnd], [Wnd+Wb] } |
| Wm, Wn | Dividend, Divisor Working register pair (direct addressing) |


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**TABLE 24-1: SYMBOLS USED IN OPCODE DESCRIPTIONS (CONTINUED)**

| Field | Description |
|---|---|
| Wm*Wm | Multiplicand and Multiplier Working register pair for Square instructions ∈ {W4 * W4,W5 * W5,W6 * W6,W7 * W7} |
| Wm*Wn | Multiplicand and Multiplier Working register pair for DSP instructions ∈ {W4 * W5,W4 * W6,W4 * W7,W5 * W6,W5 * W7,W6 * W7} |
| Wn | One of 16 Working registers ∈ {W0..W15} |
| Wnd | One of 16 destination Working registers ∈ {W0..W15} |
| Wns | One of 16 source Working registers ∈ {W0..W15} |
| WREG | W0 (Working register used in file register instructions) |
| Ws | Source W register ∈ { Ws, [Ws], [Ws++], [Ws--], [++Ws], [--Ws] } |
| Wso | Source W register ∈ { Wns, [Wns], [Wns++], [Wns--], [++Wns], [--Wns], [Wns+Wb] } |
| Wx | X data space prefetch address register for DSP instructions ∈ {[W8] + = 6, [W8] + = 4, [W8] + = 2, [W8], [W8] - = 6, [W8] - = 4, [W8] - = 2, [W9] + = 6, [W9] + = 4, [W9] + = 2, [W9], [W9] - = 6, [W9] - = 4, [W9] - = 2, [W9 + W12], none} |
| Wxd | X data space prefetch destination register for DSP instructions ∈ {W4..W7} |
| Wy | Y data space prefetch address register for DSP instructions ∈ {[W10] + = 6, [W10] + = 4, [W10] + = 2, [W10], [W10] - = 6, [W10] - = 4, [W10] - = 2, [W11] + = 6, [W11] + = 4, [W11] + = 2, [W11], [W11] - = 6, [W11] - = 4, [W11] - = 2, [W11 + W12], none} |
| Wyd | Y data space prefetch destination register for DSP instructions ∈ {W4..W7} |

**TABLE 24-2: INSTRUCTION SET OVERVIEW**

| Base Instr # | Assembly Mnemonic | Assembly Syntax | | Description | # of Words | # of Cycles | Status Flags Affected |
|---|---|---|---|---|---|---|---|
| 1 | ADD | ADD | Acc | Add Accumulators | 1 | 1 | OA,OB,SA,SB |
| | | ADD | f | f = f + WREG | 1 | 1 | C,DC,N,OV,Z |
| | | ADD | f,WREG | WREG = f + WREG | 1 | 1 | C,DC,N,OV,Z |
| | | ADD | #lit10,Wn | Wd = lit10 + Wd | 1 | 1 | C,DC,N,OV,Z |
| | | ADD | Wb,Ws,Wd | Wd = Wb + Ws | 1 | 1 | C,DC,N,OV,Z |
| | | ADD | Wb,#lit5,Wd | Wd = Wb + lit5 | 1 | 1 | C,DC,N,OV,Z |
| | | ADD | Wso,#Slit4,Acc | 16-bit Signed Add to Accumulator | 1 | 1 | OA,OB,SA,SB |
| 2 | ADDC | ADDC | f | f = f + WREG + (C) | 1 | 1 | C,DC,N,OV,Z |
| | | ADDC | f,WREG | WREG = f + WREG + (C) | 1 | 1 | C,DC,N,OV,Z |
| | | ADDC | #lit10,Wn | Wd = lit10 + Wd + (C) | 1 | 1 | C,DC,N,OV,Z |
| | | ADDC | Wb,Ws,Wd | Wd = Wb + Ws + (C) | 1 | 1 | C,DC,N,OV,Z |
| | | ADDC | Wb,#lit5,Wd | Wd = Wb + lit5 + (C) | 1 | 1 | C,DC,N,OV,Z |
| 3 | AND | AND | f | f = f .AND. WREG | 1 | 1 | N,Z |
| | | AND | f,WREG | WREG = f .AND. WREG | 1 | 1 | N,Z |
| | | AND | #lit10,Wn | Wd = lit10 .AND. Wd | 1 | 1 | N,Z |
| | | AND | Wb,Ws,Wd | Wd = Wb .AND. Ws | 1 | 1 | N,Z |
| | | AND | Wb,#lit5,Wd | Wd = Wb .AND. lit5 | 1 | 1 | N,Z |
| 4 | ASR | ASR | f | f = Arithmetic Right Shift f | 1 | 1 | C,N,OV,Z |
| | | ASR | f,WREG | WREG = Arithmetic Right Shift f | 1 | 1 | C,N,OV,Z |
| | | ASR | Ws,Wd | Wd = Arithmetic Right Shift Ws | 1 | 1 | C,N,OV,Z |
| | | ASR | Wb,Wns,Wnd | Wnd = Arithmetic Right Shift Wb by Wns | 1 | 1 | N,Z |
| | | ASR | Wb,#lit5,Wnd | Wnd = Arithmetic Right Shift Wb by lit5 | 1 | 1 | N,Z |
| 5 | BCLR | BCLR | f,#bit4 | Bit Clear f | 1 | 1 | None |
| | | BCLR | Ws,#bit4 | Bit Clear Ws | 1 | 1 | None |
| 6 | BRA | BRA | C,Expr | Branch if Carry | 1 | 1 (2) | None |
| | | BRA | GE,Expr | Branch if greater than or equal | 1 | 1 (2) | None |
| | | BRA | GEU,Expr | Branch if unsigned greater than or equal | 1 | 1 (2) | None |
| | | BRA | GT,Expr | Branch if greater than | 1 | 1 (2) | None |
| | | BRA | GTU,Expr | Branch if unsigned greater than | 1 | 1 (2) | None |
| | | BRA | LE,Expr | Branch if less than or equal | 1 | 1 (2) | None |
| | | BRA | LEU,Expr | Branch if unsigned less than or equal | 1 | 1 (2) | None |
| | | BRA | LT,Expr | Branch if less than | 1 | 1 (2) | None |
| | | BRA | LTU,Expr | Branch if unsigned less than | 1 | 1 (2) | None |
| | | BRA | N,Expr | Branch if Negative | 1 | 1 (2) | None |
| | | BRA | NC,Expr | Branch if Not Carry | 1 | 1 (2) | None |
| | | BRA | NN,Expr | Branch if Not Negative | 1 | 1 (2) | None |
| | | BRA | NOV,Expr | Branch if Not Overflow | 1 | 1 (2) | None |
| | | BRA | NZ,Expr | Branch if Not Zero | 1 | 1 (2) | None |
| | | BRA | OA,Expr | Branch if Accumulator A overflow | 1 | 1 (2) | None |
| | | BRA | OB,Expr | Branch if Accumulator B overflow | 1 | 1 (2) | None |
| | | BRA | OV,Expr | Branch if Overflow | 1 | 1 (2) | None |
| | | BRA | SA,Expr | Branch if Accumulator A saturated | 1 | 1 (2) | None |
| | | BRA | SB,Expr | Branch if Accumulator B saturated | 1 | 1 (2) | None |
| | | BRA | Expr | Branch Unconditionally | 1 | 2 | None |
| | | BRA | Z,Expr | Branch if Zero | 1 | 1 (2) | None |
| | | BRA | Wn | Computed Branch | 1 | 2 | None |
| 7 | BSET | BSET | f,#bit4 | Bit Set f | 1 | 1 | None |
| | | BSET | Ws,#bit4 | Bit Set Ws | 1 | 1 | None |
| 8 | BSW | BSW.C | Ws,Wb | Write C bit to Ws<Wb> | 1 | 1 | None |
| | | BSW.Z | Ws,Wb | Write Z bit to Ws<Wb> | 1 | 1 | None |


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**TABLE 24-2: INSTRUCTION SET OVERVIEW (CONTINUED)**

| Base Instr # | Assembly Mnemonic | Assembly Syntax | | Description | # of Words | # of Cycles | Status Flags Affected |
|---|---|---|---|---|---|---|---|
| 9 | BTG | BTG | f,#bit4 | Bit Toggle f | 1 | 1 | None |
| | | BTG | Ws,#bit4 | Bit Toggle Ws | 1 | 1 | None |
| 10 | BTSC | BTSC | f,#bit4 | Bit Test f, Skip if Clear | 1 | 1 (2 or 3) | None |
| | | BTSC | Ws,#bit4 | Bit Test Ws, Skip if Clear | 1 | 1 (2 or 3) | None |
| 11 | BTSS | BTSS | f,#bit4 | Bit Test f, Skip if Set | 1 | 1 (2 or 3) | None |
| | | BTSS | Ws,#bit4 | Bit Test Ws, Skip if Set | 1 | 1 (2 or 3) | None |
| 12 | BTST | BTST | f,#bit4 | Bit Test f | 1 | 1 | Z |
| | | BTST.C | Ws,#bit4 | Bit Test Ws to C | 1 | 1 | C |
| | | BTST.Z | Ws,#bit4 | Bit Test Ws to Z | 1 | 1 | Z |
| | | BTST.C | Ws,Wb | Bit Test Ws<Wb> to C | 1 | 1 | C |
| | | BTST.Z | Ws,Wb | Bit Test Ws<Wb> to Z | 1 | 1 | Z |
| 13 | BTSTS | BTSTS | f,#bit4 | Bit Test then Set f | 1 | 1 | Z |
| | | BTSTS.C | Ws,#bit4 | Bit Test Ws to C, then Set | 1 | 1 | C |
| | | BTSTS.Z | Ws,#bit4 | Bit Test Ws to Z, then Set | 1 | 1 | Z |
| 14 | CALL | CALL | lit23 | Call subroutine | 2 | 2 | None |
| | | CALL | Wn | Call indirect subroutine | 1 | 2 | None |
| 15 | CLR | CLR | f | f = 0x0000 | 1 | 1 | None |
| | | CLR | WREG | WREG = 0x0000 | 1 | 1 | None |
| | | CLR | Ws | Ws = 0x0000 | 1 | 1 | None |
| | | CLR | Acc,Wx,Wxd,Wy,Wyd,AWB | Clear Accumulator | 1 | 1 | OA,OB,SA,SB |
| 16 | CLRWDT | CLRWDT | | Clear Watchdog Timer | 1 | 1 | WDTO,Sleep |
| 17 | COM | COM | f | $f = \overline{f}$ | 1 | 1 | N,Z |
| | | COM | f,WREG | $WREG = \overline{f}$ | 1 | 1 | N,Z |
| | | COM | Ws,Wd | $Wd = \overline{Ws}$ | 1 | 1 | N,Z |
| 18 | CP | CP | f | Compare f with WREG | 1 | 1 | C,DC,N,OV,Z |
| | | CP | Wb,#lit5 | Compare Wb with lit5 | 1 | 1 | C,DC,N,OV,Z |
| | | CP | Wb,Ws | Compare Wb with Ws (Wb – Ws) | 1 | 1 | C,DC,N,OV,Z |
| 19 | CP0 | CP0 | f | Compare f with 0x0000 | 1 | 1 | C,DC,N,OV,Z |
| | | CP0 | Ws | Compare Ws with 0x0000 | 1 | 1 | C,DC,N,OV,Z |
| 20 | CPB | CPB | f | Compare f with WREG, with Borrow | 1 | 1 | C,DC,N,OV,Z |
| | | CPB | Wb,#lit5 | Compare Wb with lit5, with Borrow | 1 | 1 | C,DC,N,OV,Z |
| | | CPB | Wb,Ws | Compare Wb with Ws, with Borrow ($Wb – Ws – \overline{C}$) | 1 | 1 | C,DC,N,OV,Z |
| 21 | CPSEQ | CPSEQ | Wb, Wn | Compare Wb with Wn, skip if = | 1 | 1 (2 or 3) | None |
| 22 | CPSGT | CPSGT | Wb, Wn | Compare Wb with Wn, skip if > | 1 | 1 (2 or 3) | None |
| 23 | CPSLT | CPSLT | Wb, Wn | Compare Wb with Wn, skip if < | 1 | 1 (2 or 3) | None |
| 24 | CPSNE | CPSNE | Wb, Wn | Compare Wb with Wn, skip if ≠ | 1 | 1 (2 or 3) | None |
| 25 | DAW | DAW | Wn | Wn = decimal adjust Wn | 1 | 1 | C |
| 26 | DEC | DEC | f | f = f – 1 | 1 | 1 | C,DC,N,OV,Z |
| | | DEC | f,WREG | WREG = f – 1 | 1 | 1 | C,DC,N,OV,Z |
| | | DEC | Ws,Wd | Wd = Ws – 1 | 1 | 1 | C,DC,N,OV,Z |
| 27 | DEC2 | DEC2 | f | f = f – 2 | 1 | 1 | C,DC,N,OV,Z |
| | | DEC2 | f,WREG | WREG = f – 2 | 1 | 1 | C,DC,N,OV,Z |
| | | DEC2 | Ws,Wd | Wd = Ws – 2 | 1 | 1 | C,DC,N,OV,Z |
| 28 | DISI | DISI | #lit14 | Disable Interrupts for k instruction cycles | 1 | 1 | None |

**TABLE 24-2: INSTRUCTION SET OVERVIEW (CONTINUED)**

| Base Instr # | Assembly Mnemonic | Assembly Syntax | | Description | # of Words | # of Cycles | Status Flags Affected |
|---|---|---|---|---|---|---|---|
| 29 | DIV | DIV.S | Wm,Wn | Signed 16/16-bit Integer Divide | 1 | 18 | N,Z,C,OV |
| | | DIV.SD | Wm,Wn | Signed 32/16-bit Integer Divide | 1 | 18 | N,Z,C,OV |
| | | DIV.U | Wm,Wn | Unsigned 16/16-bit Integer Divide | 1 | 18 | N,Z,C,OV |
| | | DIV.UD | Wm,Wn | Unsigned 32/16-bit Integer Divide | 1 | 18 | N,Z,C,OV |
| 30 | DIVF | DIVF | Wm,Wn | Signed 16/16-bit Fractional Divide | 1 | 18 | N,Z,C,OV |
| 31 | DO | DO | #lit14,Expr | Do code to PC + Expr, lit14 + 1 times | 2 | 2 | None |
| | | DO | Wn,Expr | Do code to PC + Expr, (Wn) + 1 times | 2 | 2 | None |
| 32 | ED | ED | Wm*Wm,Acc,Wx,Wy,Wxd | Euclidean Distance (no accumulate) | 1 | 1 | OA,OB,OAB, SA,SB,SAB |
| 33 | EDAC | EDAC | Wm*Wm,Acc,Wx,Wy,Wxd | Euclidean Distance | 1 | 1 | OA,OB,OAB, SA,SB,SAB |
| 34 | EXCH | EXCH | Wns,Wnd | Swap Wns with Wnd | 1 | 1 | None |
| 35 | FBCL | FBCL | Ws,Wnd | Find Bit Change from Left (MSb) Side | 1 | 1 | C |
| 36 | FF1L | FF1L | Ws,Wnd | Find First One from Left (MSb) Side | 1 | 1 | C |
| 37 | FF1R | FF1R | Ws,Wnd | Find First One from Right (LSb) Side | 1 | 1 | C |
| 38 | GOTO | GOTO | Expr | Go to address | 2 | 2 | None |
| | | GOTO | Wn | Go to indirect | 1 | 2 | None |
| 39 | INC | INC | f | f = f + 1 | 1 | 1 | C,DC,N,OV,Z |
| | | INC | f,WREG | WREG = f + 1 | 1 | 1 | C,DC,N,OV,Z |
| | | INC | Ws,Wd | Wd = Ws + 1 | 1 | 1 | C,DC,N,OV,Z |
| 40 | INC2 | INC2 | f | f = f + 2 | 1 | 1 | C,DC,N,OV,Z |
| | | INC2 | f,WREG | WREG = f + 2 | 1 | 1 | C,DC,N,OV,Z |
| | | INC2 | Ws,Wd | Wd = Ws + 2 | 1 | 1 | C,DC,N,OV,Z |
| 41 | IOR | IOR | f | f = f .IOR. WREG | 1 | 1 | N,Z |
| | | IOR | f,WREG | WREG = f .IOR. WREG | 1 | 1 | N,Z |
| | | IOR | #lit10,Wn | Wd = lit10 .IOR. Wd | 1 | 1 | N,Z |
| | | IOR | Wb,Ws,Wd | Wd = Wb .IOR. Ws | 1 | 1 | N,Z |
| | | IOR | Wb,#lit5,Wd | Wd = Wb .IOR. lit5 | 1 | 1 | N,Z |
| 42 | LAC | LAC | Wso,#Slit4,Acc | Load Accumulator | 1 | 1 | OA,OB,OAB, SA,SB,SAB |
| 43 | LNK | LNK | #lit14 | Link Frame Pointer | 1 | 1 | None |
| 44 | LSR | LSR | f | f = Logical Right Shift f | 1 | 1 | C,N,OV,Z |
| | | LSR | f,WREG | WREG = Logical Right Shift f | 1 | 1 | C,N,OV,Z |
| | | LSR | Ws,Wd | Wd = Logical Right Shift Ws | 1 | 1 | C,N,OV,Z |
| | | LSR | Wb,Wns,Wnd | Wnd = Logical Right Shift Wb by Wns | 1 | 1 | N,Z |
| | | LSR | Wb,#lit5,Wnd | Wnd = Logical Right Shift Wb by lit5 | 1 | 1 | N,Z |
| 45 | MAC | MAC | Wm*Wn,Acc,Wx,Wxd,Wy,Wyd, AWB | Multiply and Accumulate | 1 | 1 | OA,OB,OAB, SA,SB,SAB |
| | | MAC | Wm*Wm,Acc,Wx,Wxd,Wy,Wyd | Square and Accumulate | 1 | 1 | OA,OB,OAB, SA,SB,SAB |
| 46 | MOV | MOV | f,Wn | Move f to Wn | 1 | 1 | None |
| | | MOV | f | Move f to f | 1 | 1 | N,Z |
| | | MOV | f,WREG | Move f to WREG | 1 | 1 | None |
| | | MOV | #lit16,Wn | Move 16-bit literal to Wn | 1 | 1 | None |
| | | MOV.b | #lit8,Wn | Move 8-bit literal to Wn | 1 | 1 | None |
| | | MOV | Wn,f | Move Wn to f | 1 | 1 | None |
| | | MOV | Wso,Wdo | Move Ws to Wd | 1 | 1 | None |
| | | MOV | WREG,f | Move WREG to f | 1 | 1 | None |
| | | MOV.D | Wns,Wd | Move Double from W(ns):W(ns + 1) to Wd | 1 | 2 | None |
| | | MOV.D | Ws,Wnd | Move Double from Ws to W(nd + 1):W(nd) | 1 | 2 | None |
| 47 | MOVSAC | MOVSAC | Acc,Wx,Wxd,Wy,Wyd,AWB | Prefetch and store accumulator | 1 | 1 | None |


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**TABLE 24-2: INSTRUCTION SET OVERVIEW (CONTINUED)**

| Base Instr # | Assembly Mnemonic | Assembly Syntax | Description | # of Words | # of Cycles | Status Flags Affected |
|---|---|---|---|---|---|---|
| 48 | MPY | MPY Wm*Wn,Acc,Wx,Wxd,Wy,Wyd | Multiply Wm by Wn to Accumulator | 1 | 1 | OA,OB,OAB, SA,SB,SAB |
| | | MPY Wm*Wm,Acc,Wx,Wxd,Wy,Wyd | Square Wm to Accumulator | 1 | 1 | OA,OB,OAB, SA,SB,SAB |
| 49 | MPY.N | MPY.N Wm*Wn,Acc,Wx,Wxd,Wy,Wyd | (Multiply Wm by Wn) to Accumulator | 1 | 1 | None |
| 50 | MSC | MSC Wm*Wm,Acc,Wx,Wxd,Wy,Wyd, AWB | Multiply and Subtract from Accumulator | 1 | 1 | OA,OB,OAB, SA,SB,SAB |
| 51 | MUL | MUL.SS Wb,Ws,Wnd | {Wnd + 1, Wnd} = signed(Wb) * signed(Ws) | 1 | 1 | None |
| | | MUL.SU Wb,Ws,Wnd | {Wnd + 1, Wnd} = signed(Wb) * unsigned(Ws) | 1 | 1 | None |
| | | MUL.US Wb,Ws,Wnd | {Wnd + 1, Wnd} = unsigned(Wb) * signed(Ws) | 1 | 1 | None |
| | | MUL.UU Wb,Ws,Wnd | {Wnd + 1, Wnd} = unsigned(Wb) * unsigned(Ws) | 1 | 1 | None |
| | | MUL.SU Wb,#lit5,Wnd | {Wnd + 1, Wnd} = signed(Wb) * unsigned(lit5) | 1 | 1 | None |
| | | MUL.UU Wb,#lit5,Wnd | {Wnd + 1, Wnd} = unsigned(Wb) * unsigned(lit5) | 1 | 1 | None |
| | | MUL f | W3:W2 = f * WREG | 1 | 1 | None |
| 52 | NEG | NEG Acc | Negate Accumulator | 1 | 1 | OA,OB,OAB, SA,SB,SAB |
| | | NEG f | f = $\bar{f}$ + 1 | 1 | 1 | C,DC,N,OV,Z |
| | | NEG f,WREG | WREG = $\bar{f}$ + 1 | 1 | 1 | C,DC,N,OV,Z |
| | | NEG Ws,Wd | Wd = $\overline{Ws}$ + 1 | 1 | 1 | C,DC,N,OV,Z |
| 53 | NOP | NOP | No Operation | 1 | 1 | None |
| | | NOPR | No Operation | 1 | 1 | None |
| 54 | POP | POP f | Pop f from Top-of-Stack (TOS) | 1 | 1 | None |
| | | POP Wdo | Pop from Top-of-Stack (TOS) to Wdo | 1 | 1 | None |
| | | POP.D Wnd | Pop from Top-of-Stack (TOS) to W(nd):W(nd + 1) | 1 | 2 | None |
| | | POP.S | Pop Shadow Registers | 1 | 1 | All |
| 55 | PUSH | PUSH f | Push f to Top-of-Stack (TOS) | 1 | 1 | None |
| | | PUSH Wso | Push Wso to Top-of-Stack (TOS) | 1 | 1 | None |
| | | PUSH.D Wns | Push W(ns):W(ns + 1) to Top-of-Stack (TOS) | 1 | 2 | None |
| | | PUSH.S | Push Shadow Registers | 1 | 1 | None |
| 56 | PWRSAV | PWRSAV #lit1 | Go into Sleep or Idle mode | 1 | 1 | WDTO,Sleep |
| 57 | RCALL | RCALL Expr | Relative Call | 1 | 2 | None |
| | | RCALL Wn | Computed Call | 1 | 2 | None |
| 58 | REPEAT | REPEAT #lit14 | Repeat Next Instruction lit14 + 1 times | 1 | 1 | None |
| | | REPEAT Wn | Repeat Next Instruction (Wn) + 1 times | 1 | 1 | None |
| 59 | RESET | RESET | Software device Reset | 1 | 1 | None |
| 60 | RETFIE | RETFIE | Return from interrupt | 1 | 3 (2) | None |
| 61 | RETLW | RETLW #lit10,Wn | Return with literal in Wn | 1 | 3 (2) | None |
| 62 | RETURN | RETURN | Return from Subroutine | 1 | 3 (2) | None |
| 63 | RLC | RLC f | f = Rotate Left through Carry f | 1 | 1 | C,N,Z |
| | | RLC f,WREG | WREG = Rotate Left through Carry f | 1 | 1 | C,N,Z |
| | | RLC Ws,Wd | Wd = Rotate Left through Carry Ws | 1 | 1 | C,N,Z |
| 64 | RLNC | RLNC f | f = Rotate Left (No Carry) f | 1 | 1 | N,Z |
| | | RLNC f,WREG | WREG = Rotate Left (No Carry) f | 1 | 1 | N,Z |
| | | RLNC Ws,Wd | Wd = Rotate Left (No Carry) Ws | 1 | 1 | N,Z |
| 65 | RRC | RRC f | f = Rotate Right through Carry f | 1 | 1 | C,N,Z |
| | | RRC f,WREG | WREG = Rotate Right through Carry f | 1 | 1 | C,N,Z |
| | | RRC Ws,Wd | Wd = Rotate Right through Carry Ws | 1 | 1 | C,N,Z |

**TABLE 24-2: INSTRUCTION SET OVERVIEW (CONTINUED)**

| Base Instr # | Assembly Mnemonic | Assembly Syntax | | Description | # of Words | # of Cycles | Status Flags Affected |
|---|---|---|---|---|---|---|---|
| 66 | RRNC | RRNC | f | f = Rotate Right (No Carry) f | 1 | 1 | N,Z |
| | | RRNC | f,WREG | WREG = Rotate Right (No Carry) f | 1 | 1 | N,Z |
| | | RRNC | Ws,Wd | Wd = Rotate Right (No Carry) Ws | 1 | 1 | N,Z |
| 67 | SAC | SAC | Acc,#Slit4,Wdo | Store Accumulator | 1 | 1 | None |
| | | SAC.R | Acc,#Slit4,Wdo | Store Rounded Accumulator | 1 | 1 | None |
| 68 | SE | SE | Ws,Wnd | Wnd = sign-extended Ws | 1 | 1 | C,N,Z |
| 69 | SETM | SETM | f | f = 0xFFFF | 1 | 1 | None |
| | | SETM | WREG | WREG = 0xFFFF | 1 | 1 | None |
| | | SETM | Ws | Ws = 0xFFFF | 1 | 1 | None |
| 70 | SFTAC | SFTAC | Acc,Wn | Arithmetic Shift Accumulator by (Wn) | 1 | 1 | OA,OB,OAB, SA,SB,SAB |
| | | SFTAC | Acc,#Slit6 | Arithmetic Shift Accumulator by Slit6 | 1 | 1 | OA,OB,OAB, SA,SB,SAB |
| 71 | SL | SL | f | f = Left Shift f | 1 | 1 | C,N,OV,Z |
| | | SL | f,WREG | WREG = Left Shift f | 1 | 1 | C,N,OV,Z |
| | | SL | Ws,Wd | Wd = Left Shift Ws | 1 | 1 | C,N,OV,Z |
| | | SL | Wb,Wns,Wnd | Wnd = Left Shift Wb by Wns | 1 | 1 | N,Z |
| | | SL | Wb,#lit5,Wnd | Wnd = Left Shift Wb by lit5 | 1 | 1 | N,Z |
| 72 | SUB | SUB | Acc | Subtract Accumulators | 1 | 1 | OA,OB,OAB, SA,SB,SAB |
| | | SUB | f | f = f – WREG | 1 | 1 | C,DC,N,OV,Z |
| | | SUB | f,WREG | WREG = f – WREG | 1 | 1 | C,DC,N,OV,Z |
| | | SUB | #lit10,Wn | Wn = Wn – lit10 | 1 | 1 | C,DC,N,OV,Z |
| | | SUB | Wb,Ws,Wd | Wd = Wb – Ws | 1 | 1 | C,DC,N,OV,Z |
| | | SUB | Wb,#lit5,Wd | Wd = Wb – lit5 | 1 | 1 | C,DC,N,OV,Z |
| 73 | SUBB | SUBB | f | f = f – WREG – ($\overline{C}$) | 1 | 1 | C,DC,N,OV,Z |
| | | SUBB | f,WREG | WREG = f – WREG – ($\overline{C}$) | 1 | 1 | C,DC,N,OV,Z |
| | | SUBB | #lit10,Wn | Wn = Wn – lit10 – ($\overline{C}$) | 1 | 1 | C,DC,N,OV,Z |
| | | SUBB | Wb,Ws,Wd | Wd = Wb – Ws – ($\overline{C}$) | 1 | 1 | C,DC,N,OV,Z |
| | | SUBB | Wb,#lit5,Wd | Wd = Wb – lit5 – ($\overline{C}$) | 1 | 1 | C,DC,N,OV,Z |
| 74 | SUBR | SUBR | f | f = WREG – f | 1 | 1 | C,DC,N,OV,Z |
| | | SUBR | f,WREG | WREG = WREG – f | 1 | 1 | C,DC,N,OV,Z |
| | | SUBR | Wb,Ws,Wd | Wd = Ws – Wb | 1 | 1 | C,DC,N,OV,Z |
| | | SUBR | Wb,#lit5,Wd | Wd = lit5 – Wb | 1 | 1 | C,DC,N,OV,Z |
| 75 | SUBBR | SUBBR | f | f = WREG – f – ($\overline{C}$) | 1 | 1 | C,DC,N,OV,Z |
| | | SUBBR | f,WREG | WREG = WREG – f – ($\overline{C}$) | 1 | 1 | C,DC,N,OV,Z |
| | | SUBBR | Wb,Ws,Wd | Wd = Ws – Wb – ($\overline{C}$) | 1 | 1 | C,DC,N,OV,Z |
| | | SUBBR | Wb,#lit5,Wd | Wd = lit5 – Wb – ($\overline{C}$) | 1 | 1 | C,DC,N,OV,Z |
| 76 | SWAP | SWAP.b | Wn | Wn = nibble swap Wn | 1 | 1 | None |
| | | SWAP | Wn | Wn = byte swap Wn | 1 | 1 | None |
| 77 | TBLRDH | TBLRDH | Ws,Wd | Read Prog<23:16> to Wd<7:0> | 1 | 2 | None |
| 78 | TBLRDL | TBLRDL | Ws,Wd | Read Prog<15:0> to Wd | 1 | 2 | None |
| 79 | TBLWTH | TBLWTH | Ws,Wd | Write Ws<7:0> to Prog<23:16> | 1 | 2 | None |
| 80 | TBLWTL | TBLWTL | Ws,Wd | Write Ws to Prog<15:0> | 1 | 2 | None |
| 81 | ULNK | ULNK | | Unlink Frame Pointer | 1 | 1 | None |
| 82 | XOR | XOR | f | f = f .XOR. WREG | 1 | 1 | N,Z |
| | | XOR | f,WREG | WREG = f .XOR. WREG | 1 | 1 | N,Z |
| | | XOR | #lit10,Wn | Wd = lit10 .XOR. Wd | 1 | 1 | N,Z |
| | | XOR | Wb,Ws,Wd | Wd = Wb .XOR. Ws | 1 | 1 | N,Z |
| | | XOR | Wb,#lit5,Wd | Wd = Wb .XOR. lit5 | 1 | 1 | N,Z |
| 83 | ZE | ZE | Ws,Wnd | Wnd = Zero-extend Ws | 1 | 1 | C,Z,N |


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# 25.0 DEVELOPMENT SUPPORT

The PIC® microcontrollers (MCU) and dsPIC® digital signal controllers (DSC) are supported with a full range of software and hardware development tools:

- Integrated Development Environment
  - MPLAB® X IDE Software
- Compilers/Assemblers/Linkers
  - MPLAB XC Compiler
  - MPASM™ Assembler
  - MPLINK™ Object Linker/ MPLIB™ Object Librarian
  - MPLAB Assembler/Linker/Librarian for Various Device Families
- Simulators
  - MPLAB X SIM Software Simulator
- Emulators
  - MPLAB REAL ICE™ In-Circuit Emulator
- In-Circuit Debuggers/Programmers
  - MPLAB ICD 3
  - PICkit™ 3
- Device Programmers
  - MPLAB PM3 Device Programmer
- Low-Cost Demonstration/Development Boards, Evaluation Kits and Starter Kits
- Third-party development tools

## 25.1 MPLAB X Integrated Development Environment Software

The MPLAB X IDE is a single, unified graphical user interface for Microchip and third-party software, and hardware development tool that runs on Windows®, Linux and Mac OS® X. Based on the NetBeans IDE, MPLAB X IDE is an entirely new IDE with a host of free software components and plug-ins for high-performance application development and debugging. Moving between tools and upgrading from software simulators to hardware debugging and programming tools is simple with the seamless user interface.

With complete project management, visual call graphs, a configurable watch window and a feature-rich editor that includes code completion and context menus, MPLAB X IDE is flexible and friendly enough for new users. With the ability to support multiple tools on multiple projects with simultaneous debugging, MPLAB X IDE is also suitable for the needs of experienced users.

Feature-Rich Editor:

- Color syntax highlighting
- Smart code completion makes suggestions and provides hints as you type
- Automatic code formatting based on user-defined rules
- Live parsing

User-Friendly, Customizable Interface:

- Fully customizable interface: toolbars, toolbar buttons, windows, window placement, etc.
- Call graph window

Project-Based Workspaces:

- Multiple projects
- Multiple tools
- Multiple configurations
- Simultaneous debugging sessions

File History and Bug Tracking:

- Local file history feature
- Built-in support for Bugzilla issue tracker

## 25.2 MPLAB XC Compilers

The MPLAB XC Compilers are complete ANSI C compilers for all of Microchip's 8, 16, and 32-bit MCU and DSC devices. These compilers provide powerful integration capabilities, superior code optimization and ease of use. MPLAB XC Compilers run on Windows, Linux or MAC OS X.

For easy source level debugging, the compilers provide debug information that is optimized to the MPLAB X IDE.

The free MPLAB XC Compiler editions support all devices and commands, with no time or memory restrictions, and offer sufficient code optimization for most applications.

MPLAB XC Compilers include an assembler, linker and utilities. The assembler generates relocatable object files that can then be archived or linked with other relocatable object files and archives to create an executable file. MPLAB XC Compiler uses the assembler to produce its object file. Notable features of the assembler include:

- Support for the entire device instruction set
- Support for fixed-point and floating-point data
- Command-line interface
- Rich directive set
- Flexible macro language
- MPLAB X IDE compatibility

## 25.3 MPASM Assembler

The MPASM Assembler is a full-featured, universal macro assembler for PIC10/12/16/18 MCUs.

The MPASM Assembler generates relocatable object files for the MPLINK Object Linker, Intel® standard HEX files, MAP files to detail memory usage and symbol reference, absolute LST files that contain source lines and generated machine code, and COFF files for debugging.

The MPASM Assembler features include:

- Integration into MPLAB X IDE projects
- User-defined macros to streamline assembly code
- Conditional assembly for multipurpose source files
- Directives that allow complete control over the assembly process

## 25.4 MPLINK Object Linker/ MPLIB Object Librarian

The MPLINK Object Linker combines relocatable objects created by the MPASM Assembler. It can link relocatable objects from precompiled libraries, using directives from a linker script.

The MPLIB Object Librarian manages the creation and modification of library files of precompiled code. When a routine from a library is called from a source file, only the modules that contain that routine will be linked in with the application. This allows large libraries to be used efficiently in many different applications.

The object linker/library features include:

- Efficient linking of single libraries instead of many smaller files
- Enhanced code maintainability by grouping related modules together
- Flexible creation of libraries with easy module listing, replacement, deletion and extraction

## 25.5 MPLAB Assembler, Linker and Librarian for Various Device Families

MPLAB Assembler produces relocatable machine code from symbolic assembly language for PIC24, PIC32 and dsPIC DSC devices. MPLAB XC Compiler uses the assembler to produce its object file. The assembler generates relocatable object files that can then be archived or linked with other relocatable object files and archives to create an executable file. Notable features of the assembler include:

- Support for the entire device instruction set
- Support for fixed-point and floating-point data
- Command-line interface
- Rich directive set
- Flexible macro language
- MPLAB X IDE compatibility


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## 25.6 MPLAB X SIM Software Simulator

The MPLAB X SIM Software Simulator allows code development in a PC-hosted environment by simulating the PIC MCUs and dsPIC DSCs on an instruction level. On any given instruction, the data areas can be examined or modified and stimuli can be applied from a comprehensive stimulus controller. Registers can be logged to files for further run-time analysis. The trace buffer and logic analyzer display extend the power of the simulator to record and track program execution, actions on I/O, most peripherals and internal registers.

The MPLAB X SIM Software Simulator fully supports symbolic debugging using the MPLAB XC Compilers, and the MPASM and MPLAB Assemblers. The software simulator offers the flexibility to develop and debug code outside of the hardware laboratory environment, making it an excellent, economical software development tool.

## 25.7 MPLAB REAL ICE In-Circuit Emulator System

The MPLAB REAL ICE In-Circuit Emulator System is Microchip's next generation high-speed emulator for Microchip Flash DSC and MCU devices. It debugs and programs all 8, 16 and 32-bit MCU, and DSC devices with the easy-to-use, powerful graphical user interface of the MPLAB X IDE.

The emulator is connected to the design engineer's PC using a high-speed USB 2.0 interface and is connected to the target with either a connector compatible with in-circuit debugger systems (RJ-11) or with the new high-speed, noise tolerant, Low-Voltage Differential Signal (LVDS) interconnection (CAT5).

The emulator is field upgradable through future firmware downloads in MPLAB X IDE. MPLAB REAL ICE offers significant advantages over competitive emulators including full-speed emulation, run-time variable watches, trace analysis, complex breakpoints, logic probes, a ruggedized probe interface and long (up to three meters) interconnection cables.

## 25.8 MPLAB ICD 3 In-Circuit Debugger System

The MPLAB ICD 3 In-Circuit Debugger System is Microchip's most cost-effective, high-speed hardware debugger/programmer for Microchip Flash DSC and MCU devices. It debugs and programs PIC Flash microcontrollers and dsPIC DSCs with the powerful, yet easy-to-use graphical user interface of the MPLAB IDE.

The MPLAB ICD 3 In-Circuit Debugger probe is connected to the design engineer's PC using a high-speed USB 2.0 interface and is connected to the target with a connector compatible with the MPLAB ICD 2 or MPLAB REAL ICE systems (RJ-11). MPLAB ICD 3 supports all MPLAB ICD 2 headers.

## 25.9 PICkit 3 In-Circuit Debugger/ Programmer

The MPLAB PICkit 3 allows debugging and programming of PIC and dsPIC Flash microcontrollers at a most affordable price point using the powerful graphical user interface of the MPLAB IDE. The MPLAB PICkit 3 is connected to the design engineer's PC using a full-speed USB interface and can be connected to the target via a Microchip debug (RJ-11) connector (compatible with MPLAB ICD 3 and MPLAB REAL ICE). The connector uses two device I/O pins and the Reset line to implement in-circuit debugging and In-Circuit Serial Programming™ (ICSP™).

## 25.10 MPLAB PM3 Device Programmer

The MPLAB PM3 Device Programmer is a universal, CE compliant device programmer with programmable voltage verification at $V_{DDMIN}$ and $V_{DDMAX}$ for maximum reliability. It features a large LCD display (128 x 64) for menus and error messages, and a modular, detachable socket assembly to support various package types. The ICSP cable assembly is included as a standard item. In Stand-Alone mode, the MPLAB PM3 Device Programmer can read, verify and program PIC devices without a PC connection. It can also set code protection in this mode. The MPLAB PM3 connects to the host PC via an RS-232 or USB cable. The MPLAB PM3 has high-speed communications and optimized algorithms for quick programming of large memory devices, and incorporates an MMC card for file storage and data applications.

## 25.11 Demonstration/Development Boards, Evaluation Kits and Starter Kits

A wide variety of demonstration, development and evaluation boards for various PIC MCUs and dsPIC DSCs allows quick application development on fully functional systems. Most boards include prototyping areas for adding custom circuitry and provide application firmware and source code for examination and modification.

The boards support a variety of features, including LEDs, temperature sensors, switches, speakers, RS-232 interfaces, LCD displays, potentiometers and additional EEPROM memory.

The demonstration and development boards can be used in teaching environments, for prototyping custom circuits and for learning about various microcontroller applications.

In addition to the PICDEM™ and dsPICDEM™ demonstration/development board series of circuits, Microchip has a line of evaluation kits and demonstration software for analog filter design, KEELOQ® security ICs, CAN, IrDA®, PowerSmart battery management, SEEVAL® evaluation system, Sigma-Delta ADC, flow rate sensing, plus many more.

Also available are starter kits that contain everything needed to experience the specified device. This usually includes a single application and debug capability, all on one board.

Check the Microchip web page (www.microchip.com) for the complete list of demonstration, development and evaluation kits.

## 25.12 Third-Party Development Tools

Microchip also offers a great collection of tools from third-party vendors. These tools are carefully selected to offer good value and unique functionality.

- Device Programmers and Gang Programmers from companies, such as SoftLog and CCS
- Software Tools from companies, such as Gimpel and Trace Systems
- Protocol Analyzers from companies, such as Saleae and Total Phase
- Demonstration Boards from companies, such as MikroElektronika, Digilent® and Olimex
- Embedded Ethernet Solutions from companies, such as EZ Web Lynx, WIZnet and IPLogika®


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# 26.0 ELECTRICAL CHARACTERISTICS

This section provides an overview of the dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 family electrical characteristics. Additional information will be provided in future revisions of this document as it becomes available.

Absolute maximum ratings for the dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 family are listed below. Exposure to these maximum rating conditions for extended periods may affect device reliability. Functional operation of the device at these, or any other conditions above the parameters indicated in the operation listings of this specification, is not implied.

## Absolute Maximum Ratings(1)

Ambient temperature under bias ..... -40°C to +125°C
Storage temperature ..... -65°C to +150°C
Voltage on $V_{DD}$ with respect to $V_{SS}$ ..... -0.3V to +4.0V
Voltage on any pin that is not 5V tolerant with respect to $V_{SS}$(3) ..... -0.3V to ($V_{DD}$ + 0.3V)
Voltage on any 5V tolerant pin with respect to $V_{SS}$ when $V_{DD} \geq 3.0V$(3) ..... -0.3V to +5.6V
Voltage on any 5V tolerant pin with respect to $V_{SS}$ when $V_{DD} < 3.0V$(3) ..... -0.3V to ($V_{DD}$ + 0.3V)
Maximum current out of $V_{SS}$ pin ..... 300 mA
Maximum current into $V_{DD}$ pin(2) ..... 250 mA
Maximum output current sourced and sunk by any I/O pin excluding OSCO ..... 15 mA
Maximum output current sourced and sunk by OSCO ..... 25 mA
Maximum current sunk by all ports ..... 200 mA
Maximum current sourced by all ports(2) ..... 200 mA

**Note 1:** Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those, or any other conditions above those indicated in the operation listings of this specification, is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

**2:** Maximum allowable current is a function of the device maximum power dissipation (see Table 26-2).

**3:** See the **“Pin Diagrams”** section for 5V tolerant pins.

## 26.1 DC Characteristics

**TABLE 26-1: OPERATING MIPS vs. VOLTAGE**

| Characteristic | VDD Range (in Volts) | Temp Range (in °C) | Max MIPS |
|---|---|---|---|
| | | | dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 |
| DC5 | VBOR-3.6V(1) | -40°C to +85°C | 16 |
| | VBOR-3.6V(1) | -40°C to +125°C | 16 |

**Note 1:** Overall functional device operation at VBOR < VDD < VDDMIN is ensured but not characterized. All device analog modules, such as the ADC, etc., will function but with degraded performance below VDDMIN.

**TABLE 26-2: THERMAL OPERATING CONDITIONS**

| Rating | Symbol | Min | Typ | Max | Unit |
|---|---|---|---|---|---|
| Industrial Temperature Devices | | | | | |
| Operating Junction Temperature Range | TJ | -40 | — | +125 | °C |
| Operating Ambient Temperature Range | TA | -40 | — | +85 | °C |
| Extended Temperature Devices | | | | | |
| Operating Junction Temperature Range | TJ | -40 | — | +140 | °C |
| Operating Ambient Temperature Range | TA | -40 | — | +125 | °C |
| Power Dissipation:<br>Internal Chip Power Dissipation:<br>PINT = VDD x (IDD – Σ IOH)<br>I/O Pin Power Dissipation:<br>I/O = Σ ({VDD – VOH} x IOH) + Σ (VOL x IOL) | PD | PINT + PIO | | | W |
| Maximum Allowed Power Dissipation | PDMAX | (TJ – TA)/θJA | | | W |

**TABLE 26-3: THERMAL PACKAGING CHARACTERISTICS**

| Characteristic | Symbol | Typ | Max | Unit | Notes |
|---|---|---|---|---|---|
| Package Thermal Resistance, 18-pin PDIP | θJA | 50 | — | °C/W | 1 |
| Package Thermal Resistance, 20-pin PDIP | θJA | 50 | — | °C/W | 1 |
| Package Thermal Resistance, 28-pin SPDIP | θJA | 50 | — | °C/W | 1 |
| Package Thermal Resistance, 18-pin SOIC | θJA | 63 | — | °C/W | 1 |
| Package Thermal Resistance, 20-pin SOIC | θJA | 63 | — | °C/W | 1 |
| Package Thermal Resistance, 28-pin SOIC | θJA | 55 | — | °C/W | 1 |
| Package Thermal Resistance, 20-pin SSOP | θJA | 90 | — | °C/W | 1 |
| Package Thermal Resistance, 28-pin SSOP | θJA | 71 | — | °C/W | 1 |
| Package Thermal Resistance, 28-pin QFN (6x6 mm) | θJA | 37 | — | °C/W | 1 |
| Package Thermal Resistance, 36-pin VTLA (5x5 mm) | θJA | 31.1 | — | °C/W | 1 |
| Package Thermal Resistance, 44-pin TQFP | θJA | 45 | — | °C/W | 1, 2 |
| Package Thermal Resistance, 44-pin QFN | θJA | 32 | — | °C/W | 1, 2 |
| Package Thermal Resistance, 44-pin VTLA | θJA | 30 | — | °C/W | 1, 2 |

**Note 1:** Junction to ambient thermal resistance; Theta-JA (θJA) numbers are achieved by package simulations.

**2:** This package is available in dsPIC33FJ32(GP/MC)104 devices only.


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**TABLE 26-4: DC TEMPERATURE AND VOLTAGE SPECIFICATIONS**

| DC CHARACTERISTICS | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | | |
|---|---|---|---|---|---|---|---|
| **Param No.** | **Symbol** | **Characteristic** | **Min** | **Typ(1)** | **Max** | **Units** | **Conditions** |
| **Operating Voltage** | | | | | | | |
| DC10 | **Supply Voltage(3)** | | | | | | |
| | VDD | — | VBOR | — | 3.6 | V | Industrial and Extended |
| DC12 | VDR | **RAM Data Retention Voltage(2)** | 1.8 | — | — | V | |
| DC16 | VPOR | **VDD Start Voltage** to Ensure Internal Power-on Reset Signal | — | 1.75 | VSS | V | |
| DC17 | SVDD | **VDD Rise Rate** to Ensure Internal Power-on Reset Signal | 0.024 | — | — | V/ms | 0-2.4V in 0.1s |

**Note 1:** Data in "Typ" column is at 3.3V, +25°C unless otherwise stated.

**2:** This is the limit to which VDD may be lowered without losing RAM data.

**3:** Overall functional device operation at VBOR < VDD < VDDMIN is ensured but not characterized. All device analog modules, such as the ADC, etc., will function but with degraded performance below VDDMIN.

**TABLE 26-5: ELECTRICAL CHARACTERISTICS: BROWN-OUT RESET (BOR)**

| DC CHARACTERISTICS | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | | |
|---|---|---|---|---|---|---|---|
| **Param No.** | **Symbol** | **Characteristic** | **Min(1)** | **Typ** | **Max** | **Units** | **Conditions** |
| BO10 | VBOR | BOR Event on VDD Transition High-to-Low | 2.40 | 2.48 | 2.55 | V | See **Note 2** |

**Note 1:** Parameters are for design guidance only and are not tested in manufacturing.

**2:** Overall functional device operation at VBOR < VDD < VDDMIN is ensured but not characterized. All device analog modules, such as the ADC, etc., will function but with degraded performance below VDDMIN.

**TABLE 26-6: DC CHARACTERISTICS: OPERATING CURRENT (IDD)**

| DC CHARACTERISTICS | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | |
|---|---|---|---|---|---|---|
| **Parameter No.** | **Typical(1)** | **Max** | **Units** | **Conditions** | | |
| **Operating Current (IDD)(2) – dsPIC33FJ16(GP/MC)10X Devices** | | | | | | |
| DC20d | 0.7 | 1.7 | mA | -40°C | 3.3V | LPRC (32.768 kHz)(3) |
| DC20a | 0.7 | 1.7 | mA | +25°C | | |
| DC20b | 1.0 | 1.7 | mA | +85°C | | |
| DC20c | 1.3 | 1.7 | mA | +125°C | | |
| DC21d | 1.9 | 2.6 | mA | -40°C | 3.3V | 1 MIPS(3) |
| DC21a | 1.9 | 2.6 | mA | +25°C | | |
| DC21b | 1.9 | 2.6 | mA | +85°C | | |
| DC21c | 2.0 | 2.6 | mA | +125°C | | |
| DC22d | 6.5 | 8.5 | mA | -40°C | 3.3V | 4 MIPS(3) |
| DC22a | 6.5 | 8.5 | mA | +25°C | | |
| DC22b | 6.5 | 8.5 | mA | +85°C | | |
| DC22c | 6.5 | 8.5 | mA | +125°C | | |
| DC23d | 12.2 | 16 | mA | -40°C | 3.3V | 10 MIPS(3) |
| DC23a | 12.2 | 16 | mA | +25°C | | |
| DC23b | 12.2 | 16 | mA | +85°C | | |
| DC23c | 12.2 | 16 | mA | +125°C | | |
| DC24d | 16 | 21 | mA | -40°C | 3.3V | 16 MIPS |
| DC24a | 16 | 21 | mA | +25°C | | |
| DC24b | 16 | 21 | mA | +85°C | | |
| DC24c | 16 | 21 | mA | +125°C | | |

**Note 1:** Data in "Typical" column is at 3.3V, +25°C unless otherwise stated.

**2:** IDD is primarily a function of the operating voltage and frequency. Other factors, such as I/O pin loading and switching rate, oscillator type, internal code execution pattern and temperature, also have an impact on the current consumption. The test conditions for all IDD measurements are as follows:

- Oscillator is configured in EC mode, OSC1 is driven with external square wave from rail-to-rail
- CLKO is configured as an I/O input pin in the Configuration Word
- All I/O pins are configured as inputs and pulled to VSS
- $\overline{MCLR}$ = VDD, WDT and FSCM are disabled
- CPU, SRAM, program memory and data memory are operational
- No peripheral modules are operating; however, every peripheral is being clocked (PMDx bits are all zeroed)
- CPU executing `while(1)` statement

**3:** These parameters are characterized, but not tested in manufacturing.


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**TABLE 26-6: DC CHARACTERISTICS: OPERATING CURRENT (IDD) (CONTINUED)**

| DC CHARACTERISTICS | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | |
|---|---|---|---|---|---|---|
| **Parameter No.** | **Typical(1)** | **Max** | **Units** | **Conditions** | | |
| **Operating Current (IDD)(2) – dsPIC33FJ32(GP/MC)10X Devices** | | | | | | |
| DC20d | 1 | 2 | mA | -40°C | 3.3V | LPRC (32.768 kHz)(3) |
| DC20a | 1 | 2 | mA | +25°C | | |
| DC20b | 1.1 | 2 | mA | +85°C | | |
| DC20c | 1.3 | 2 | mA | +125°C | | |
| DC21d | 1.7 | 3 | mA | -40°C | 3.3V | 1 MIPS(3) |
| DC21a | 2.3 | 3 | mA | +25°C | | |
| DC21b | 2.3 | 3 | mA | +85°C | | |
| DC21c | 2.4 | 3 | mA | +125°C | | |
| DC22d | 7 | 8.5 | mA | -40°C | 3.3V | 4 MIPS(3) |
| DC22a | 7 | 8.5 | mA | +25°C | | |
| DC22b | 7 | 8.5 | mA | +85°C | | |
| DC22c | 7 | 8.5 | mA | +125°C | | |
| DC23d | 13.2 | 17 | mA | -40°C | 3.3V | 10 MIPS(3) |
| DC23a | 13.2 | 17 | mA | +25°C | | |
| DC23b | 13.2 | 17 | mA | +85°C | | |
| DC23c | 13.2 | 17 | mA | +125°C | | |
| DC24d | 17 | 22 | mA | -40°C | 3.3V | 16 MIPS |
| DC24a | 17 | 22 | mA | +25°C | | |
| DC24b | 17 | 22 | mA | +85°C | | |
| DC24c | 17 | 22 | mA | +125°C | | |

**Note 1:** Data in "Typical" column is at 3.3V, +25°C unless otherwise stated.

**2:** IDD is primarily a function of the operating voltage and frequency. Other factors, such as I/O pin loading and switching rate, oscillator type, internal code execution pattern and temperature, also have an impact on the current consumption. The test conditions for all IDD measurements are as follows:

- Oscillator is configured in EC mode, OSC1 is driven with external square wave from rail-to-rail
- CLKO is configured as an I/O input pin in the Configuration Word
- All I/O pins are configured as inputs and pulled to VSS
- $\overline{\text{MCLR}}$ = VDD, WDT and FSCM are disabled
- CPU, SRAM, program memory and data memory are operational
- No peripheral modules are operating; however, every peripheral is being clocked (PMDx bits are all zeroed)
- CPU executing `while(1)` statement

**3:** These parameters are characterized, but not tested in manufacturing.

**TABLE 26-7: DC CHARACTERISTICS: IDLE CURRENT (IIDLE)**

| DC CHARACTERISTICS | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | |
|---|---|---|---|---|---|---|
| **Parameter No.** | **Typical(1)** | **Max** | **Units** | **Conditions** | | |
| **Idle Current (IIDLE): Core Off, Clock On Base Current(2) – dsPIC33FJ16(GP/MC)10X Devices** | | | | | | |
| DC40d | 0.4 | 1.0 | mA | -40°C | 3.3V | LPRC (32.768 kHz)(3) |
| DC40a | 0.4 | 1.0 | mA | +25°C | | |
| DC40b | 0.4 | 1.0 | mA | +85°C | | |
| DC40c | 0.5 | 1.0 | mA | +125°C | | |
| DC41d | 0.5 | 1.1 | mA | -40°C | 3.3V | 1 MIPS(3) |
| DC41a | 0.5 | 1.1 | mA | +25°C | | |
| DC41b | 0.5 | 1.1 | mA | +85°C | | |
| DC41c | 0.8 | 1.1 | mA | +125°C | | |
| DC42d | 0.9 | 1.6 | mA | -40°C | 3.3V | 4 MIPS(3) |
| DC42a | 0.9 | 1.6 | mA | +25°C | | |
| DC42b | 1.0 | 1.6 | mA | +85°C | | |
| DC42c | 1.2 | 1.6 | mA | +125°C | | |
| DC43a | 1.6 | 2.6 | mA | +25°C | 3.3V | 10 MIPS(3) |
| DC43d | 1.6 | 2.6 | mA | -40°C | | |
| DC43b | 1.7 | 2.6 | mA | +85°C | | |
| DC43c | 2 | 2.6 | mA | +125°C | | |
| DC44d | 2.4 | 3.8 | mA | -40°C | 3.3V | 16 MIPS(3) |
| DC44a | 2.4 | 3.8 | mA | +25°C | | |
| DC44b | 2.6 | 3.8 | mA | +85°C | | |
| DC44c | 2.9 | 3.8 | mA | +125°C | | |

**Note 1:** Data in “Typical” column is at 3.3V, +25°C unless otherwise stated.

**2:** Base Idle current is measured as follows:

- CPU core is off, oscillator is configured in EC mode, OSC1 is driven with external square wave from rail-to-rail
- CLKO is configured as an I/O input pin in the Configuration Word
- External Secondary Oscillator (SOSC) is disabled (i.e., SOSCO and SOSCI pins are configured as digital I/O inputs)
- All I/O pins are configured as inputs and pulled to VSS
- $\overline{\text{MCLR}}$ = VDD, WDT and FSCM are disabled
- No peripheral modules are operating; however, every peripheral is being clocked (PMDx bits are all zeroed)

**3:** These parameters are characterized, but not tested in manufacturing.


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**TABLE 26-7: DC CHARACTERISTICS: IDLE CURRENT (IIDLE) (CONTINUED)**

| DC CHARACTERISTICS | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | |
|---|---|---|---|---|---|---|
| **Parameter No.** | **Typical(1)** | **Max** | **Units** | **Conditions** | | |
| **Idle Current (IIDLE): Core Off, Clock On Base Current(2) – dsPIC33FJ32(GP/MC)10X Devices** | | | | | | |
| DC40d | 0.4 | 1.0 | mA | -40°C | 3.3V | LPRC (32.768 kHz)(3) |
| DC40a | 0.4 | 1.0 | mA | +25°C | | |
| DC40b | 0.4 | 1.0 | mA | +85°C | | |
| DC40c | 0.5 | 1.0 | mA | +125°C | | |
| DC41d | 0.5 | 1.1 | mA | -40°C | 3.3V | 1 MIPS(3) |
| DC41a | 0.5 | 1.1 | mA | +25°C | | |
| DC41b | 0.5 | 1.1 | mA | +85°C | | |
| DC41c | 0.8 | 1.1 | mA | +125°C | | |
| DC42d | 0.9 | 1.6 | mA | -40°C | 3.3V | 4 MIPS(3) |
| DC42a | 0.9 | 1.6 | mA | +25°C | | |
| DC42b | 1.0 | 1.6 | mA | +85°C | | |
| DC42c | 1.2 | 1.6 | mA | +125°C | | |
| DC43a | 1.6 | 2.6 | mA | +25°C | 3.3V | 10 MIPS(3) |
| DC43d | 1.6 | 2.6 | mA | -40°C | | |
| DC43b | 1.7 | 2.6 | mA | +85°C | | |
| DC43c | 2.0 | 2.6 | mA | +125°C | | |
| DC44d | 2.4 | 3.8 | mA | -40°C | 3.3V | 16 MIPS(3) |
| DC44a | 2.4 | 3.8 | mA | +25°C | | |
| DC44b | 2.6 | 3.8 | mA | +85°C | | |
| DC44c | 2.9 | 3.8 | mA | +125°C | | |

**Note 1:** Data in “Typical” column is at 3.3V, +25°C unless otherwise stated.

**2:** Base Idle current is measured as follows:

- CPU core is off, oscillator is configured in EC mode, OSC1 is driven with external square wave from rail-to-rail
- CLKO is configured as an I/O input pin in the Configuration Word
- External Secondary Oscillator (SOSC) is disabled (i.e., SOSCO and SOSCI pins are configured as digital I/O inputs)
- All I/O pins are configured as inputs and pulled to VSS
- $\overline{\text{MCLR}}$ = VDD, WDT and FSCM are disabled
- No peripheral modules are operating; however, every peripheral is being clocked (PMDx bits are all zeroed)

**3:** These parameters are characterized, but not tested in manufacturing.

**TABLE 26-8: DC CHARACTERISTICS: POWER-DOWN CURRENT (IPD)**

| DC CHARACTERISTICS | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | |
|---|---|---|---|---|---|---|
| **Parameter No.** | **Typical(1)** | **Max** | **Units** | **Conditions** | | |
| **Power-Down Current (IPD)(2) – dsPIC33FJ16(GP/MC)10X Devices** | | | | | | |
| DC60d | 27 | 250 | µA | -40°C | 3.3V | Base Power-Down Current(3,4) |
| DC60a | 32 | 250 | µA | +25°C | | |
| DC60b | 43 | 250 | µA | +85°C | | |
| DC60c | 150 | 500 | µA | +125°C | | |
| DC61d | 420 | 600 | µA | -40°C | 3.3V | Watchdog Timer Current: ΔIWDT(3,5) |
| DC61a | 420 | 600 | µA | +25°C | | |
| DC61b | 530 | 750 | µA | +85°C | | |
| DC61c | 620 | 900 | µA | +125°C | | |
| **Power-Down Current (IPD)(2) – dsPIC33FJ32(GP/MC)10X Devices** | | | | | | |
| DC60d | 27 | 250 | µA | -40°C | 3.3V | Base Power-Down Current(3,4) |
| DC60a | 32 | 250 | µA | +25°C | | |
| DC60b | 43 | 250 | µA | +85°C | | |
| DC60c | 150 | 500 | µA | +125°C | | |
| DC61d | 420 | 600 | µA | -40°C | 3.3V | Watchdog Timer Current: ΔIWDT(3,5) |
| DC61a | 420 | 600 | µA | +25°C | | |
| DC61b | 530 | 750 | µA | +85°C | | |
| DC61c | 620 | 900 | µA | +125°C | | |

**Note 1:** Data in the Typical column is at 3.3V, +25°C unless otherwise stated.

**2:** IPD (Sleep) current is measured as follows:

- CPU core is off, oscillator is configured in EC mode, OSC1 is driven with external square wave from rail-to-rail
- CLKO is configured as an I/O input pin in the Configuration Word
- External Secondary Oscillator (SOSC) is disabled (i.e., SOSCO and SOSCI pins are configured as digital I/O inputs)
- All I/O pins are configured as inputs and pulled to VSS
- $\overline{MCLR}$ = VDD, WDT and FSCM are disabled
- All peripheral modules are disabled (PMDx bits are all ones)
- VREGS bit (RCON<8>) = 1 (i.e., core regulator is set to stand-by while the device is in Sleep mode)
- On applicable devices, RTCC is disabled, plus the VREGS bit (RCON<8>) = 1

**3:** The Δ current is the additional current consumed when the module is enabled. This current should be added to the base IPD current.

**4:** These currents are measured on the device containing the most memory in this family.

**5:** These parameters are characterized, but not tested in manufacturing.


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**TABLE 26-9: DC CHARACTERISTICS: DOZE CURRENT (IDOZE)**

| DC CHARACTERISTICS | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | | |
|---|---|---|---|---|---|---|---|
| **Parameter No.** | **Typical(1)** | **Max** | **Doze Ratio(2)** | **Units** | **Conditions** | | |
| **Doze Current (IDOZE)(2) – dsPIC33FJ16(GP/MC)10X Devices** | | | | | | | |
| DC73a | 13.2 | 17.2 | 1:2 | mA | -40°C | 3.3V | 16 MIPS |
| DC73f | 4.7 | 6.2 | 1:64 | mA | | | |
| DC73g | 4.7 | 6.2 | 1:128 | mA | | | |
| DC70a | 13.2 | 17.2 | 1:2 | mA | +25°C | 3.3V | 16 MIPS |
| DC70f | 4.7 | 6.2 | 1:64 | mA | | | |
| DC70g | 4.7 | 6.2 | 1:128 | mA | | | |
| DC71a | 13.2 | 17.2 | 1:2 | mA | +85°C | 3.3V | 16 MIPS |
| DC71f | 4.7 | 6.2 | 1:64 | mA | | | |
| DC71g | 4.7 | 6.2 | 1:128 | mA | | | |
| DC72a | 13.2 | 17.2 | 1:2 | mA | +125°C | 3.3V | 16 MIPS |
| DC72f | 4.7 | 6.2 | 1:64 | mA | | | |
| DC72g | 4.7 | 6.2 | 1:128 | mA | | | |
| **Doze Current (IDOZE)(2) – dsPIC33FJ32(GP/MC)10X Devices** | | | | | | | |
| DC73a | 13.2 | 17.2 | 1:2 | mA | -40°C | 3.3V | 16 MIPS |
| DC73f | 4.7 | 6.2 | 1:64 | mA | | | |
| DC73g | 4.7 | 6.2 | 1:128 | mA | | | |
| DC70a | 13.2 | 17.2 | 1:2 | mA | +25°C | 3.3V | 16 MIPS |
| DC70f | 4.7 | 6.2 | 1:64 | mA | | | |
| DC70g | 4.7 | 6.2 | 1:128 | mA | | | |
| DC71a | 13.2 | 17.2 | 1:2 | mA | +85°C | 3.3V | 16 MIPS |
| DC71f | 4.7 | 6.2 | 1:64 | mA | | | |
| DC71g | 4.7 | 6.2 | 1:128 | mA | | | |
| DC72a | 13.2 | 17.2 | 1:2 | mA | +125°C | 3.3V | 16 MIPS |
| DC72f | 4.7 | 6.2 | 1:64 | mA | | | |
| DC72g | 4.7 | 6.2 | 1:128 | mA | | | |

**Note 1:** Data in the Typical column is at 3.3V, +25°C unless otherwise stated.

**2:** IDOZE is primarily a function of the operating voltage and frequency. Other factors, such as I/O pin loading and switching rate, oscillator type, internal code execution pattern and temperature, also have an impact on the current consumption. The test conditions for all IDOZE measurements are as follows:

- Oscillator is configured in EC mode, OSC1 is driven with external square wave from rail-to-rail
- CLKO is configured as an I/O input pin in the Configuration Word
- All I/O pins are configured as inputs and pulled to VSS
- $\overline{\text{MCLR}}$ = VDD, WDT and FSCM are disabled
- CPU, SRAM, program memory and data memory are operational
- No peripheral modules are operating; however, every peripheral is being clocked (PMDx bits are all zeros)
- CPU executing `while(1)` statement

**TABLE 26-10: DC CHARACTERISTICS: I/O PIN INPUT SPECIFICATIONS**

| DC CHARACTERISTICS | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | | |
|---|---|---|---|---|---|---|---|
| **Param No.** | **Symbol** | **Characteristic** | **Min** | **Typ(1)** | **Max** | **Units** | **Conditions** |
| | VIL | **Input Low Voltage** | | | | | |
| DI10 | | I/O Pins | VSS | — | 0.2 VDD | V | |
| DI15 | | $\overline{\text{MCLR}}$ | VSS | — | 0.2 VDD | V | |
| DI18 | | I/O Pins with SDAx, SCLx | VSS | — | 0.3 VDD | V | SMBus disabled |
| DI19 | | I/O Pins with SDAx, SCLx | VSS | — | 0.8 | V | SMBus enabled |
| | VIH | **Input High Voltage** | | | | | |
| DI20 | | I/O Pins Not 5V Tolerant(4)<br>I/O Pins 5V Tolerant(4) | 0.7 VDD<br>0.7 VDD | —<br>— | VDD<br>5.5 | V<br>V | |
| DI28 | | SDAx, SCLx | 0.7 VDD | — | 5.5 | V | SMBus disabled |
| DI29 | | SDAx, SCLx | 2.1 | — | 5.5 | V | SMBus enabled |
| | ICNPU | **CNx Pull-up Current** | | | | | |
| DI30 | | | 50 | 250 | 450 | µA | VDD = 3.3V, VPIN = VSS |
| | IIL | **Input Leakage Current(2,3)** | | | | | |
| DI50 | | I/O Pins 5V Tolerant(4) | — | — | ±2 | µA | VSS ≤ VPIN ≤ VDD, Pin at high-impedance |
| DI51 | | I/O Pins Not 5V Tolerant(4) | — | — | ±1 | µA | VSS ≤ VPIN ≤ VDD, Pin at high-impedance, -40°C ≤ TA ≤ +85°C |
| DI51a | | I/O Pins Not 5V Tolerant(4) | — | — | ±2 | µA | Shared with external reference pins, -40°C ≤ TA ≤ +85°C |
| DI51b | | I/O Pins Not 5V Tolerant(4) | — | — | ±3.5 | µA | VSS ≤ VPIN ≤ VDD, Pin at high-impedance, -40°C ≤ TA ≤ +125°C |
| DI51c | | I/O Pins Not 5V Tolerant(4) | — | — | ±8 | µA | Analog pins shared with external reference pins, -40°C ≤ TA ≤ +125°C |
| DI55 | | $\overline{\text{MCLR}}$ | — | — | ±2 | µA | VSS ≤ VPIN ≤ VDD |
| DI56 | | OSC1 | — | — | ±2 | µA | VSS ≤ VPIN ≤ VDD, XT and HS modes |

**Note 1:** Data in “Typ” column is at 3.3V, +25°C unless otherwise stated.

**2:** The leakage current on the $\overline{\text{MCLR}}$ pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current can be measured at different input voltages.

**3:** Negative current is defined as current sourced by the pin.

**4:** See the **“Pin Diagrams”** section for the 5V tolerant I/O pins.

**5:** VIL source < (VSS – 0.3). Characterized but not tested.

**6:** Non-5V tolerant pins, VIH source > (VDD + 0.3), 5V tolerant pins, VIH source > 5.5V. Characterized but not tested.

**7:** Digital 5V tolerant pins cannot tolerate any “positive” input injection current from input sources > 5.5V.

**8:** Injection currents > | 0 | can affect the ADC results by approximately 4-6 counts.

**9:** Any number and/or combination of I/O pins, not excluded under IICL or IICH conditions, are permitted provided the mathematical “absolute instantaneous” sum of the input injection currents from all pins do not exceed the specified limit. Characterized but not tested.


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**TABLE 26-10: DC CHARACTERISTICS: I/O PIN INPUT SPECIFICATIONS (CONTINUED)**

| DC CHARACTERISTICS | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | | |
|---|---|---|---|---|---|---|---|
| **Param No.** | **Symbol** | **Characteristic** | **Min** | **Typ(1)** | **Max** | **Units** | **Conditions** |
| DI60a | IICL | **Input Low Injection Current** | 0 | -5(5,8) | — | mA | All pins except VDD, VSS, AVDD, AVSS, MCLR, VCAP, SOSCI, SOSCO and RB14 |
| DI60b | IICH | **Input High Injection Current** | 0 | — | +5(6,7,8) | mA | All pins except VDD, VSS, AVDD, AVSS, MCLR, VCAP, SOSCI, SOSCO, RB14 and digital 5V tolerant designated pins |
| DI60c | ∑ IICT | **Total Input Injection Current** (sum of all I/O and control pins) | -20(9) | — | +20(9) | mA | Absolute instantaneous sum of all ± input injection currents from all I/O pins ( \| IICL + \| IICH \| ) ≤ ∑ IICT |

**Note 1:** Data in "Typ" column is at 3.3V, +25°C unless otherwise stated.

**2:** The leakage current on the MCLR pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current can be measured at different input voltages.

**3:** Negative current is defined as current sourced by the pin.

**4:** See the **"Pin Diagrams"** section for the 5V tolerant I/O pins.

**5:** VIL source < (VSS – 0.3). Characterized but not tested.

**6:** Non-5V tolerant pins, VIH source > (VDD + 0.3), 5V tolerant pins, VIH source > 5.5V. Characterized but not tested.

**7:** Digital 5V tolerant pins cannot tolerate any "positive" input injection current from input sources > 5.5V.

**8:** Injection currents > | 0 | can affect the ADC results by approximately 4-6 counts.

**9:** Any number and/or combination of I/O pins, not excluded under IICL or IICH conditions, are permitted provided the mathematical "absolute instantaneous" sum of the input injection currents from all pins do not exceed the specified limit. Characterized but not tested.

**TABLE 26-11: DC CHARACTERISTICS: I/O PIN OUTPUT SPECIFICATIONS**

| DC CHARACTERISTICS | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | | |
|---|---|---|---|---|---|---|---|
| **Param No.** | **Symbol** | **Characteristic** | **Min** | **Typ(1)** | **Max** | **Units** | **Conditions** |
| DO10 | VOL | **Output Low Voltage**<br>I/O Pins:<br>4x Sink Driver Pins – All Pins excluding OSCO | — | — | 0.4 | V | IOL ≤ 6 mA, VDD = 3.3V,<br>See **Note 1** |
| | | **Output Low Voltage**<br>I/O Pins:<br>8x Sink Driver Pins – OSCO | — | — | 0.4 | V | IOL ≤ 10 mA, VDD = 3.3V,<br>See **Note 1** |
| DO20 | VOH | **Output High Voltage**<br>I/O Pins:<br>4x Source Driver Pins – All Pins excluding OSCO | 2.4 | — | — | V | IOL ≥ -6 mA, VDD = 3.3V,<br>See **Note 1** |
| | | **Output High Voltage**<br>I/O Pins:<br>8x Source Driver Pins – OSCO | 2.4 | — | — | V | IOL ≥ -10 mA, VDD = 3.3V,<br>See **Note 1** |
| DO20A | VOH1 | **Output High Voltage**<br>I/O Pins:<br>4x Source Driver Pins – All Pins excluding OSCO | 1.5 | — | — | V | IOH ≥ -12 mA, VDD = 3.3V,<br>See **Note 1** |
| | | | 2.0 | — | — | | IOH ≥ -11 mA, VDD = 3.3V,<br>See **Note 1** |
| | | | 3.0 | — | — | | IOH ≥ -3 mA, VDD = 3.3V,<br>See **Note 1** |
| | | **Output High Voltage**<br>I/O Pins:<br>8x Source Driver Pins – OSCO | 1.5 | — | — | V | IOH ≥ -16 mA, VDD = 3.3V,<br>See **Note 1** |
| | | | 2.0 | — | — | | IOH ≥ -12 mA, VDD = 3.3V,<br>See **Note 1** |
| | | | 3.0 | — | — | | IOH ≥ -4 mA, VDD = 3.3V,<br>See **Note 1** |

**Note 1:** Data in “Typ” column is at 3.3V, +25°C unless otherwise stated.


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**TABLE 26-12: DC CHARACTERISTICS: PROGRAM MEMORY**

| DC CHARACTERISTICS | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | | |
|---|---|---|---|---|---|---|---|
| **Param No.** | **Symbol** | **Characteristic(3)** | **Min** | **Typ(1)** | **Max** | **Units** | **Conditions** |
| | | **Program Flash Memory** | | | | | |
| D130a | EP | Cell Endurance | 10,000 | — | — | E/W | -40°C to +125°C |
| D131 | VPR | VDD for Read | VMIN | — | 3.6 | V | VMIN = Minimum operating voltage |
| D132b | VPEW | VDD for Self-Timed Write | VMIN | — | 3.6 | V | VMIN = Minimum operating voltage |
| D134 | TRETD | Characteristic Retention | 20 | — | — | Year | Provided no other specifications are violated |
| D135 | IDDP | Supply Current during Programming | — | 10 | — | mA | |
| D137a | TPE | Page Erase Time | 20.1 | — | 26.5 | ms | TPE = 168517 FRC cycles, TA = +85°C, See **Note 2** |
| D137b | TPE | Page Erase Time | 19.5 | — | 27.3 | ms | TPE = 168517 FRC cycles, TA = +125°C, See **Note 2** |
| D138a | TWW | Word Write Cycle Time | 47.4 | — | 49.3 | µs | TWW = 355 FRC cycles, TA = +85°C, See **Note 2** |
| D138b | TWW | Word Write Cycle Time | 47.4 | — | 49.3 | µs | TWW = 355 FRC cycles, TA = +125°C, See **Note 2** |

**Note 1:** Data in "Typ" column is at 3.3V, +25°C unless otherwise stated.

**2:** Other conditions: FRC = 7.37 MHz, TUN<5:0> = b'011111 (for Min), TUN<5:0> = b'100000 (for Max). This parameter depends on the FRC accuracy (see Table 26-18) and the value of the FRC Oscillator Tuning register (see Register 8-3). For complete details on calculating the Minimum and Maximum time, see **Section 5.3 "Programming Operations"**.

**3:** These parameters are ensured by design, but are not characterized or tested in manufacturing.

**TABLE 26-13: INTERNAL VOLTAGE REGULATOR SPECIFICATIONS**

| DC CHARACTERISTICS | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | | |
|---|---|---|---|---|---|---|---|
| **Param No.** | **Symbol** | **Characteristics** | **Min** | **Typ** | **Max** | **Units** | **Comments** |
| — | CEFC | External Filter Capacitor Value(1) | 4.7 | 10 | — | µF | Capacitor must be low series resistance (< 5 ohms) |

**Note 1:** Typical VCAP voltage = 2.5V when VDD ≥ VDDMIN.

## 26.2 AC Characteristics and Timing Parameters

This section defines dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 family AC characteristics and timing parameters.

**TABLE 26-14: TEMPERATURE AND VOLTAGE SPECIFICATIONS – AC**

| | |
|---|---|
| **AC CHARACTERISTICS** | **Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)**<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended<br>Operating voltage VDD range as described in **Section 26.1 "DC Characteristics"**. |

**FIGURE 26-1: LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS**

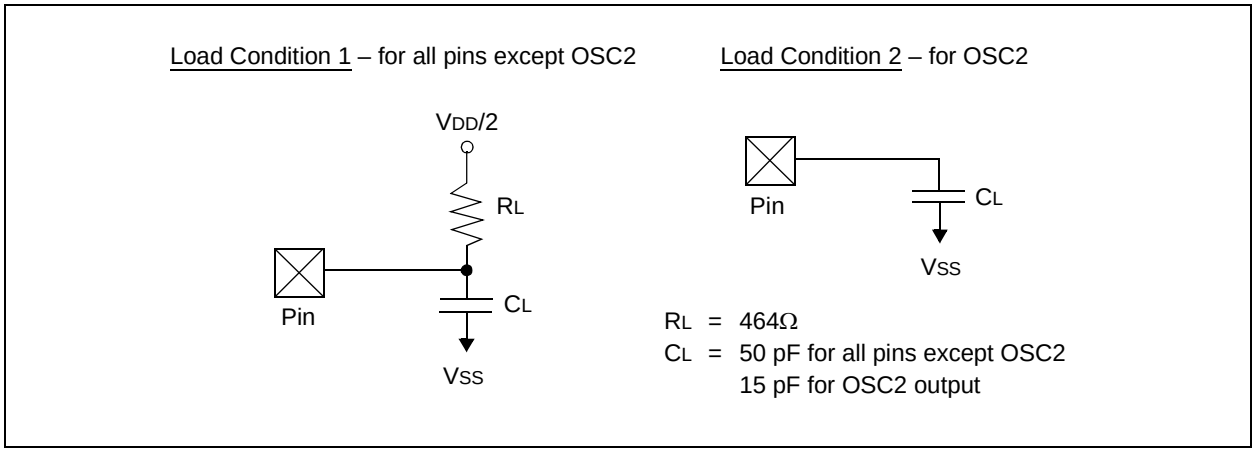


**TABLE 26-15: CAPACITIVE LOADING REQUIREMENTS ON OUTPUT PINS**

| Param No. | Symbol | Characteristic | Min | Typ | Max | Units | Conditions |
|---|---|---|---|---|---|---|---|
| DO50 | COSC2 | OSC2/SOSC2 Pin | — | — | 15 | pF | In MS and HS modes when external clock is used to drive OSC1 |
| DO56 | CIO | All I/O Pins and OSC2 | — | — | 50 | pF | EC mode |
| DO58 | CB | SCLx, SDAx | — | — | 400 | pF | In $I^2C$™ mode |


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**FIGURE 26-2: EXTERNAL CLOCK TIMING**

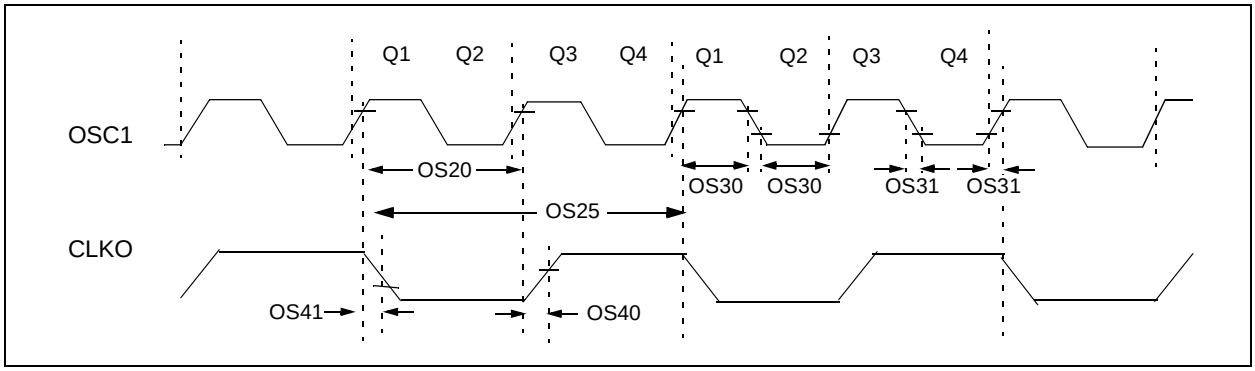


**TABLE 26-16: EXTERNAL CLOCK TIMING REQUIREMENTS**

| AC CHARACTERISTICS | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | | |
|---|---|---|---|---|---|---|---|
| **Param No.** | **Symb** | **Characteristic** | **Min** | **Typ(1)** | **Max** | **Units** | **Conditions** |
| OS10 | FIN | External CLKI Frequency (External clocks allowed only in EC and ECPLL modes) | DC | — | 32 | MHz | EC |
| | | Oscillator Crystal Frequency | 3.0<br>10<br>31 | —<br>—<br>— | 10<br>32<br>33 | MHz<br>MHz<br>kHz | MS<br>HS<br>SOSC |
| OS20 | TOSC | TOSC = 1/FOSC | 31.25 | — | DC | ns | |
| OS25 | TCY | Instruction Cycle Time(2,4) | 62.5 | — | DC | ns | |
| OS30 | TosL, TosH | External Clock in (OSC1)(5) High or Low Time | 0.45 x TOSC | — | — | ns | EC |
| OS31 | TosR, TosF | External Clock in (OSC1)(5) Rise or Fall Time | — | — | 20 | ns | EC |
| OS40 | TckR | CLKO Rise Time(3,5) | — | 6 | 10 | ns | |
| OS41 | TckF | CLKO Fall Time(3,5) | — | 6 | 10 | ns | |
| OS42 | GM | External Oscillator Transconductance(4) | 14 | 16 | 18 | mA/V | VDD = 3.3V, TA = +25°C |

**Note 1:** Data in "Typ" column is at 3.3V, +25°C unless otherwise stated.

**2:** Instruction cycle period (TCY) equals two times the input oscillator time base period. All specified values are based on characterization data for that particular oscillator type, under standard operating conditions, with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "min." values with an external clock applied to the OSC1/CLKI pin. When an external clock input is used, the "max." cycle time limit is "DC" (no clock) for all devices.

**3:** Measurements are taken in EC mode. The CLKO signal is measured on the OSC2 pin.

**4:** These parameters are characterized by similarity, but are tested in manufacturing at FIN = 32 MHz only.

**5:** These parameters are characterized by similarity, but are not tested in manufacturing.

**TABLE 26-17: PLL CLOCK TIMING SPECIFICATIONS**

| AC CHARACTERISTICS | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | | |
|---|---|---|---|---|---|---|---|
| **Param No.** | **Symbol** | **Characteristic** | **Min** | **Typ(1)** | **Max** | **Units** | **Conditions** |
| OS50 | FPLLI | PLL Voltage Controlled Oscillator (VCO) Input Frequency Range(2) | 3.0 | — | 8 | MHz | ECPLL and MSPLL modes |
| OS51 | FSYS | On-Chip VCO System Frequency(3) | 12 | — | 32 | MHz | |
| OS52 | TLOCK | PLL Start-up Time (Lock Time)(3) | — | — | 2 | mS | |
| OS53 | DCLK | CLKO Stability (Jitter)(3) | -2 | 1 | +2 | % | |

**Note 1:** Data in "Typ" column is at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

**2:** These parameters are characterized by similarity, but are tested in manufacturing at 7.7 MHz input only.

**3:** These parameters are characterized by similarity, but are not tested in manufacturing. This specification is based on clock cycle by clock cycle measurements. The effective jitter for individual time bases, or communication clocks used by the user application, are derived from dividing the CLKO stability specification by the square root of "N" (where "N" is equal to FOSC, divided by the peripheral data rate clock). For example, if FOSC = 32 MHz and the SPI bit rate is 5 MHz, the effective jitter of the SPI clock is equal to:

$$\frac{DCLK}{\sqrt{\frac{32}{5}}} = \frac{2\%}{2.53} = 0.79\%$$

**TABLE 26-18: AC CHARACTERISTICS: INTERNAL FAST RC (FRC) ACCURACY**

| AC CHARACTERISTICS | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | | | |
|---|---|---|---|---|---|---|---|---|
| **Param No.** | **Characteristic** | **Min** | **Typ** | **Max** | **Units** | **Conditions** | |
| | **Internal FRC Accuracy @ 7.37 MHz(1)** | | | | | | |
| F20a | FRC | -2 | ±0.25 | +2 | % | -40°C ≤ TA ≤ -10°C | VDD 3.0-3.6V |
| F20b | FRC | -1 | ±0.25 | +1 | % | -10°C ≤ TA ≤ +85°C | VDD 3.0-3.6V |
| F20c | FRC | -5 | ±0.25 | +5 | % | +85°C ≤ TA ≤ +125°C | VDD 3.0-3.6V |

**Note 1:** Frequency is calibrated at +25°C and 3.3V. TUNx bits may be used to compensate for temperature drift.

**TABLE 26-19: INTERNAL LOW-POWER RC (LPRC) ACCURACY**

| AC CHARACTERISTICS | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | | | |
|---|---|---|---|---|---|---|---|---|
| **Param No.** | **Characteristic** | **Min** | **Typ** | **Max** | **Units** | **Conditions** | |
| | **LPRC @ 32.768 kHz(1,2)** | | | | | | |
| F21a | LPRC | -30 | ±10 | +20 | % | -40°C ≤ TA ≤ -10°C | VDD 3.0-3.6V |
| F21b | LPRC | -20 | ±10 | +30 | % | -10°C ≤ TA ≤ +85°C | VDD 3.0-3.6V |
| F21c | LPRC | -35 | ±10 | +35 | % | +85°C ≤ TA ≤ +125°C | VDD 3.0-3.6V |

**Note 1:** Change of LPRC frequency as VDD changes.

**2:** LPRC accuracy impacts the Watchdog Timer Time-out Period (TWDT1). See **Section 23.4 "Watchdog Timer (WDT)"** for more information.


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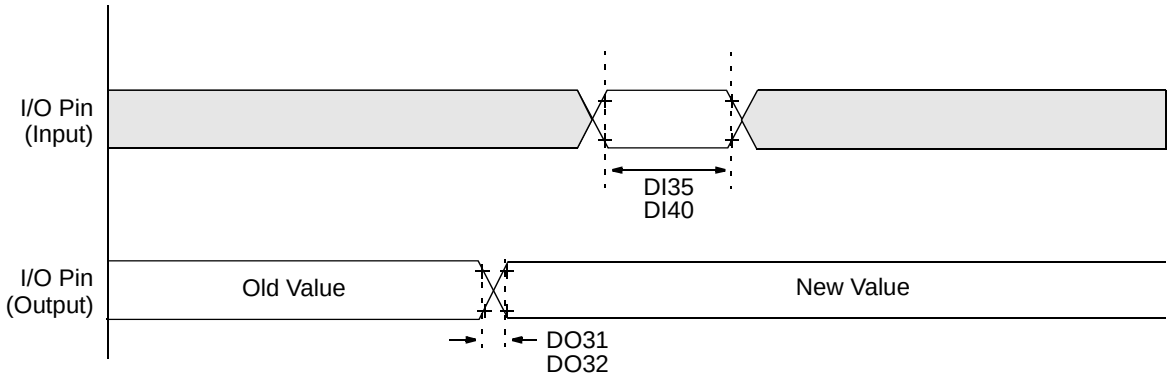
**FIGURE 26-3: CLKO AND I/O TIMING CHARACTERISTICS**




**Note:** Refer to Figure 26-1 for load conditions.

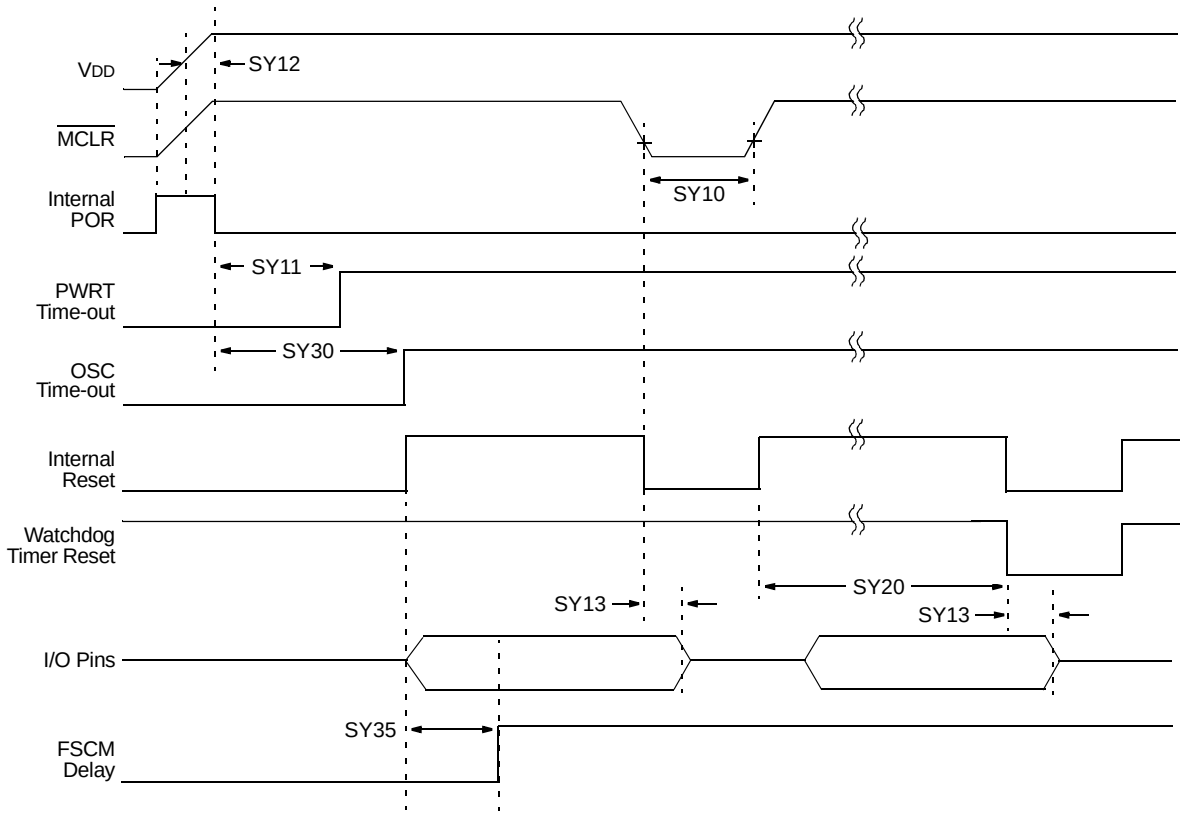
**TABLE 26-20: I/O TIMING REQUIREMENTS**

| AC CHARACTERISTICS | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | | | |
|---|---|---|---|---|---|---|---|
| **Param No.** | **Symbol** | **Characteristic(2)** | **Min** | **Typ(1)** | **Max** | **Units** | **Conditions** |
| DO31 | TIOR | Port Output Rise Time | — | 10 | 25 | ns | |
| DO32 | TIOF | Port Output Fall Time | — | 10 | 25 | ns | |
| DI35 | TINP | INTx Pin High or Low Time (input) | 25 | — | — | ns | |
| DI40 | TRBP | CNx High or Low Time (input) | 2 | — | — | TCY | |

**Note 1:** Data in "Typ" column is at 3.3V, +25°C unless otherwise stated.

**2:** These parameters are characterized, but are not tested in manufacturing.

**FIGURE 26-4: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP TIMER TIMING CHARACTERISTICS**




**Note:** Refer to Figure 26-1 for load conditions.

**TABLE 26-21: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER, POWER-UP TIMER AND BROWN-OUT RESET TIMING REQUIREMENTS**

| AC CHARACTERISTICS | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | | |
|---|---|---|---|---|---|---|---|
| **Param No.** | **Symb** | **Characteristic(1)** | **Min** | **Typ(2)** | **Max** | **Units** | **Conditions** |
| SY10 | TMCL | $\overline{\text{MCLR}}$ Pulse Width (low) | 2 | — | — | µs | |
| SY11 | TPWRT | Power-up Timer Period | — | 64 | — | ms | |
| SY12 | TPOR | Power-on Reset Delay | 3 | 10 | 30 | µs | |
| SY13 | TIOZ | I/O High-Impedance from $\overline{\text{MCLR}}$ Low or Watchdog Timer Reset | — | — | 1.2 | µs | |
| SY20 | TWDT1 | Watchdog Timer Time-out Period | — | — | — | ms | See **Section 23.4 "Watchdog Timer (WDT)"** and LPRC Parameter F21a (Table 26-19). |
| SY30 | TOST | Oscillator Start-up Time | — | 1024 * TOSC | — | — | TOSC = OSC1 period |
| SY35 | TFSCM | Fail-Safe Clock Monitor Delay | — | 500 | 900 | µs | |

**Note 1:** These parameters are characterized but are not tested in manufacturing.

**2:** Data in "Typ" column is at 3.3V, +25°C unless otherwise stated.


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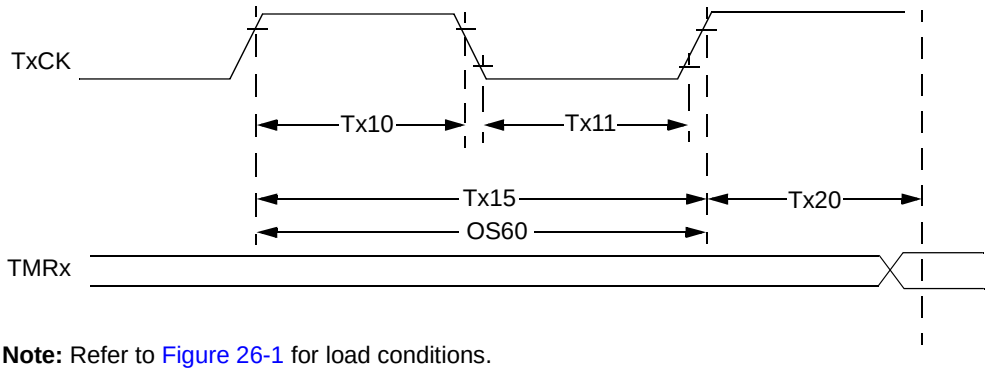
**FIGURE 26-5: TIMER1/2/3 EXTERNAL CLOCK TIMING CHARACTERISTICS**




**Note:** Refer to Figure 26-1 for load conditions.

**TABLE 26-22: TIMER1 EXTERNAL CLOCK TIMING REQUIREMENTS(1)**

| AC CHARACTERISTICS | | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | | |
|---|---|---|---|---|---|---|---|---|
| **Param No.** | **Symbol** | **Characteristic(2)** | | **Min** | **Typ** | **Max** | **Units** | **Conditions** |
| TA10 | TTXH | T1CK High Time | Synchronous mode | Greater of: 20 or (TCY + 20)/N | — | — | ns | Must also meet Parameter TA15, N = prescale value (1, 8, 64, 256) |
| | | | Asynchronous | 35 | — | — | ns | |
| TA11 | TTXL | T1CK Low Time | Synchronous mode | Greater of: 20 ns or (TCY + 20)/N | — | — | ns | Must also meet Parameter TA15, N = prescale value (1, 8, 64, 256) |
| | | | Asynchronous | 10 | — | — | ns | |
| TA15 | TTXP | T1CK Input Period | Synchronous mode | Greater of: 40 or (2 TCY + 40)/N | — | — | ns | N = prescale value (1, 8, 64, 256) |
| OS60 | Ft1 | SOSC1/T1CK Oscillator Input Frequency Range (oscillator enabled by setting the TCS (T1CON<1>) bit) | | DC | — | 50 | kHz | |
| TA20 | TCKEXTMRL | Delay from External T1CK Clock Edge to Timer Increment | | 0.75 TCY + 40 | — | 1.75 TCY + 40 | ns | |

**Note 1:** Timer1 is a Type A.

**2:** These parameters are characterized by similarity, but are not tested in manufacturing.

**TABLE 26-23: TIMER2/4 EXTERNAL CLOCK TIMING REQUIREMENTS**

| AC CHARACTERISTICS | | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | | |
|---|---|---|---|---|---|---|---|---|
| **Param No.** | **Symbol** | **Characteristic(1)** | | **Min** | **Typ** | **Max** | **Units** | **Conditions** |
| TB10 | TtxH | TxCK High Time | Synchronous mode | Greater of: 20 or (TCY + 20)/N | — | — | ns | Must also meet Parameter TB15, N = prescale value (1, 8, 64, 256) |
| TB11 | TtxL | TxCK Low Time | Synchronous mode | Greater of: 20 or (TCY + 20)/N | — | — | ns | Must also meet Parameter TB15, N = prescale value (1, 8, 64, 256) |
| TB15 | TtxP | TxCK Input Period | Synchronous mode | Greater of: 40 or (2 TCY + 40)/N | — | — | ns | N = prescale value (1, 8, 64, 256) |
| TB20 | TCKEXTMRL | Delay from External TxCK Clock Edge to Timer Increment | | 0.75 TCY + 40 | — | 1.75 TCY + 40 | ns | |

**Note 1:** These parameters are characterized, but are not tested in manufacturing.

**TABLE 26-24: TIMER3/5 EXTERNAL CLOCK TIMING REQUIREMENTS**

| AC CHARACTERISTICS | | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | | |
|---|---|---|---|---|---|---|---|---|
| **Param No.** | **Symbol** | **Characteristic(1)** | | **Min** | **Typ** | **Max** | **Units** | **Conditions** |
| TC10 | TtxH | TxCK High Time | Synchronous | TCY + 20 | — | — | ns | Must also meet Parameter TC15 |
| TC11 | TtxL | TxCK Low Time | Synchronous | TCY + 20 | — | — | ns | Must also meet Parameter TC15 |
| TC15 | TtxP | TxCK Input Period | Synchronous, with Prescaler | 2 TCY + 40 | — | — | ns | N = prescale value (1, 8, 64, 256) |
| TC20 | TCKEXTMRL | Delay from External TxCK Clock Edge to Timer Increment | | 0.75 TCY + 40 | — | 1.75 TCY + 40 | ns | |

**Note 1:** These parameters are characterized, but are not tested in manufacturing.


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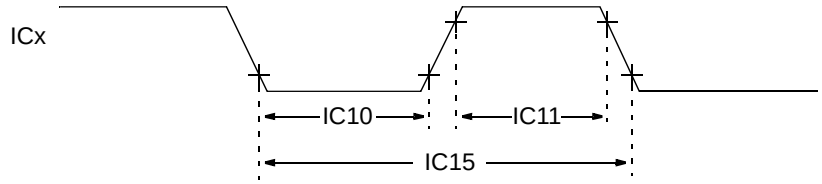
**FIGURE 26-6: INPUT CAPTURE x (ICx) TIMING CHARACTERISTICS**



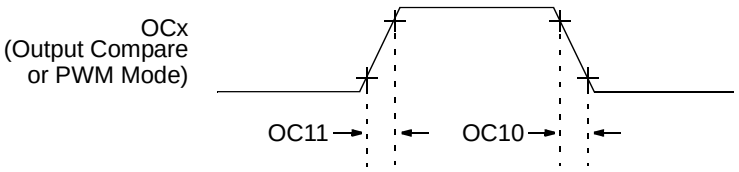

**Note:** Refer to Figure 26-1 for load conditions.

**TABLE 26-25: INPUT CAPTURE x (ICx) TIMING REQUIREMENTS**

| AC CHARACTERISTICS | | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | |
|---|---|---|---|---|---|---|---|
| **Param No.** | **Symbol** | **Characteristic(1)** | | **Min** | **Max** | **Units** | **Conditions** |
| IC10 | TccL | ICx Input Low Time | No Prescaler | 0.5 TCY + 20 | — | ns | |
| | | | With Prescaler | 10 | — | ns | |
| IC11 | TccH | ICx Input High Time | No Prescaler | 0.5 TCY + 20 | — | ns | |
| | | | With Prescaler | 10 | — | ns | |
| IC15 | TccP | ICx Input Period | | (TCY + 40)/N | — | ns | N = prescale value (1, 4, 16) |

**Note 1:** These parameters are characterized by similarity, but are not tested in manufacturing.

**FIGURE 26-7: OUTPUT COMPARE x (OCx) TIMING CHARACTERISTICS**




**Note:** Refer to Figure 26-1 for load conditions.

**TABLE 26-26: OUTPUT COMPARE x (OCx) MODULE TIMING REQUIREMENTS**

| AC CHARACTERISTICS | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | | |
|---|---|---|---|---|---|---|---|
| **Param No.** | **Symbol** | **Characteristic(1)** | **Min** | **Typ** | **Max** | **Units** | **Conditions** |
| OC10 | TccF | OCx Output Fall Time | — | — | — | ns | See Parameter DO32 |
| OC11 | TccR | OCx Output Rise Time | — | — | — | ns | See Parameter DO31 |

**Note 1:** These parameters are characterized by similarity, but are not tested in manufacturing.

**FIGURE 26-8: OCx/PWMx MODULE TIMING CHARACTERISTICS**

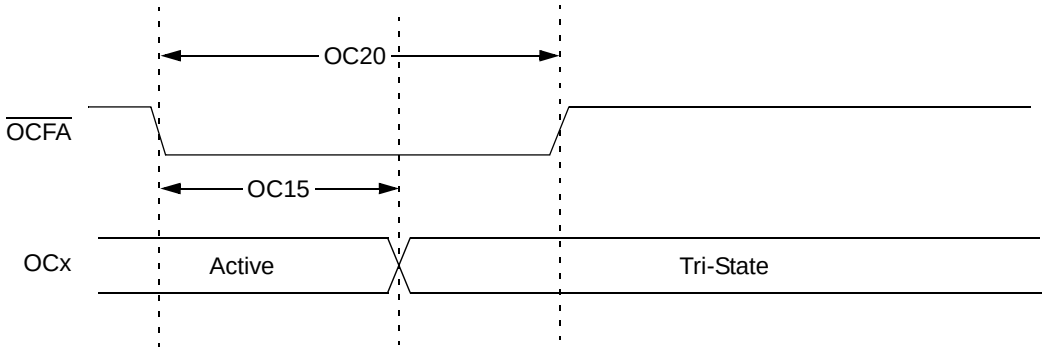



**TABLE 26-27: SIMPLE OCx/PWMx MODE TIMING REQUIREMENTS**

| AC CHARACTERISTICS | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | | |
|---|---|---|---|---|---|---|---|
| **Param No.** | **Symbol** | **Characteristic(1)** | **Min** | **Typ** | **Max** | **Units** | **Conditions** |
| OC15 | TFD | Fault Input to PWMx I/O Change | — | — | TCY + 20 ns | ns | |
| OC20 | TFLT | Fault Input Pulse Width | TCY + 20 ns | — | — | ns | |

**Note 1:** These parameters are characterized by similarity, but are not tested in manufacturing.


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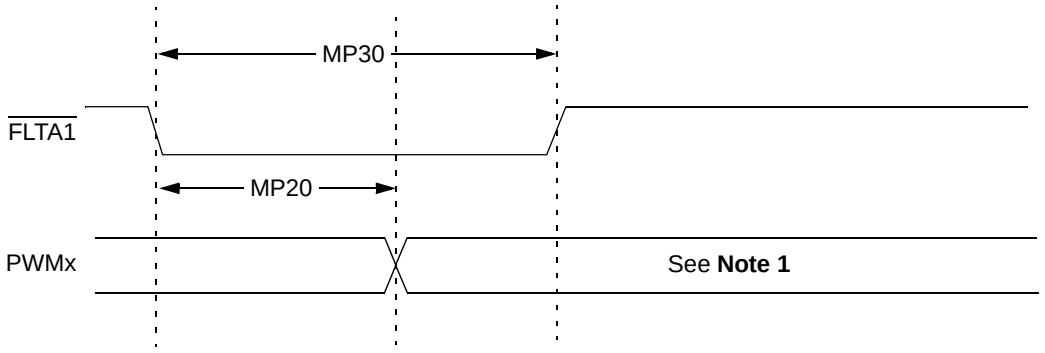
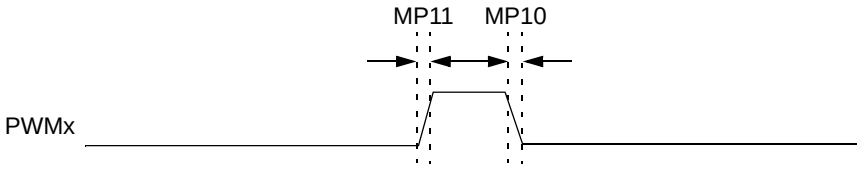
**FIGURE 26-9: MOTOR CONTROL PWMx MODULE FAULT TIMING CHARACTERISTICS**




**Note 1:** For the logic state after a Fault, refer to the FAOVxH:FAOVxL bits in the PxFLTACON register.

**FIGURE 26-10: MOTOR CONTROL PWMx MODULE TIMING CHARACTERISTICS**




**Note:** Refer to Figure 26-1 for load conditions.

**TABLE 26-28: MOTOR CONTROL PWMx MODULE TIMING REQUIREMENTS**

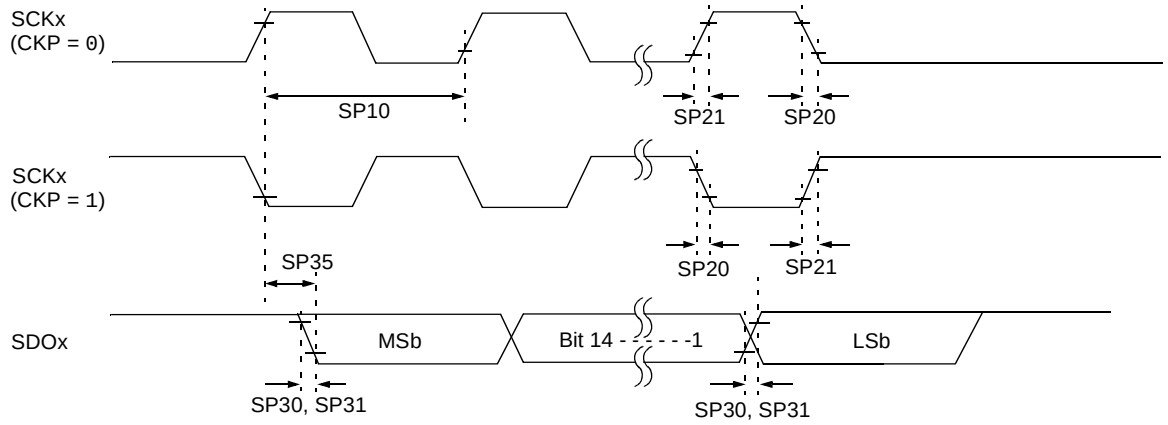
| AC CHARACTERISTICS | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | | |
|---|---|---|---|---|---|---|---|
| **Param No.** | **Symbol** | **Characteristic(1)** | **Min** | **Typ** | **Max** | **Units** | **Conditions** |
| MP10 | TFPWM | PWM Output Fall Time | — | — | — | ns | See Parameter DO32 |
| MP11 | TRPWM | PWM Output Rise Time | — | — | — | ns | See Parameter DO31 |
| MP20 | TFD | Fault Input ↓ to PWM I/O Change | — | — | 50 | ns | |
| MP30 | TFH | Minimum Pulse Width | 50 | — | — | ns | |

**Note 1:** These parameters are characterized by similarity, but are not tested in manufacturing.

**TABLE 26-29: SPIx MAXIMUM DATA/CLOCK RATE SUMMARY FOR dsPIC33FJ16(GP/MC)10X**

| AC CHARACTERISTICS | | | Standard Operating Conditions: 2.4V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | |
|---|---|---|---|---|---|---|
| **Maximum Data Rate** | **Master Transmit Only (Half-Duplex)** | **Master Transmit/Receive (Full-Duplex)** | **Slave Transmit/Receive (Full-Duplex)** | **CKE** | **CKP** | **SMP** |
| 15 MHz | Table 26-30 | — | — | 0,1 | 0,1 | 0,1 |
| 10 MHz | — | Table 26-31 | — | 1 | 0,1 | 1 |
| 10 MHz | — | Table 26-32 | — | 0 | 0,1 | 1 |
| 15 MHz | — | — | Table 26-33 | 1 | 0 | 0 |
| 11 MHz | — | — | Table 26-34 | 1 | 1 | 0 |
| 15 MHz | — | — | Table 26-35 | 0 | 1 | 0 |
| 11 MHz | — | — | Table 26-36 | 0 | 0 | 0 |

**FIGURE 26-11: SPIx MASTER MODE (HALF-DUPLEX, TRANSMIT ONLY, CKE = 0) TIMING CHARACTERISTICS FOR dsPIC33FJ16(GP/MC)10X**




**Note:** Refer to Figure 26-1 for load conditions.


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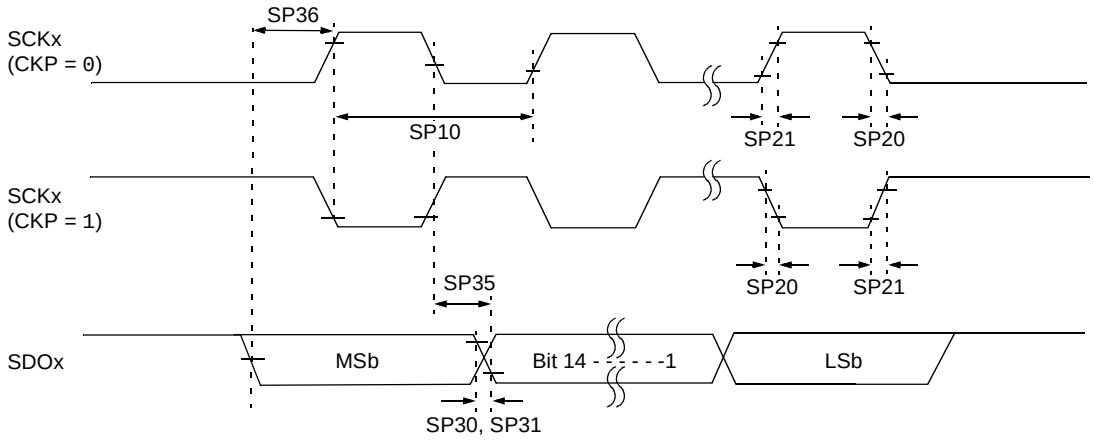
**FIGURE 26-12: SPIx MASTER MODE (HALF-DUPLEX, TRANSMIT ONLY, CKE = 1) TIMING CHARACTERISTICS FOR dsPIC33FJ16(GP/MC)10X**




**Note:** Refer to Figure 26-1 for load conditions.

**TABLE 26-30: SPIx MASTER MODE (HALF-DUPLEX, TRANSMIT ONLY) TIMING REQUIREMENTS FOR dsPIC33FJ16(GP/MC)10X**

| AC CHARACTERISTICS | | | Standard Operating Conditions: 2.4V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | | |
|---|---|---|---|---|---|---|---|
| **Param No.** | **Symbol** | **Characteristic(1)** | **Min** | **Typ(2)** | **Max** | **Units** | **Conditions** |
| SP10 | TscP | Maximum SCKx Frequency | — | — | 15 | MHz | See **Note 3** |
| SP20 | TscF | SCKx Output Fall Time | — | — | — | ns | See Parameter DO32 and **Note 4** |
| SP21 | TscR | SCKx Output Rise Time | — | — | — | ns | See Parameter DO31 and **Note 4** |
| SP30 | TdoF | SDOx Data Output Fall Time | — | — | — | ns | See Parameter DO32 and **Note 4** |
| SP31 | TdoR | SDOx Data Output Rise Time | — | — | — | ns | See Parameter DO31 and **Note 4** |
| SP35 | TscH2doV, TscL2doV | SDOx Data Output Valid after SCKx Edge | — | 6 | 20 | ns | |
| SP36 | TdiV2scH, TdiV2scL | SDOx Data Output Setup to First SCKx Edge | 30 | — | — | ns | |

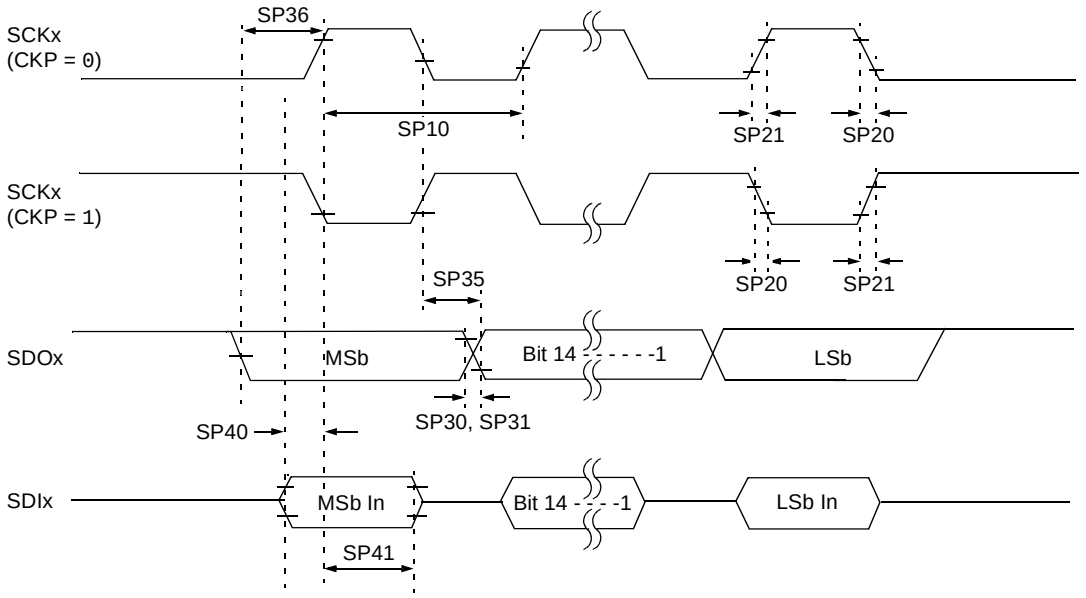
**Note 1:** These parameters are characterized, but are not tested in manufacturing.

**2:** Data in “Typ” column is at 3.3V, +25°C unless otherwise stated.

**3:** The minimum clock period for SCKx is 66.7 ns. Therefore, the clock generated in Master mode must not violate this specification.

**4:** Assumes 50 pF load on all SPIx pins.

**FIGURE 26-13: SPIx MASTER MODE (FULL-DUPLEX, CKE = 1, CKP = x, SMP = 1) TIMING CHARACTERISTICS FOR dsPIC33FJ16(GP/MC)10X**




**Note:** Refer to Figure 26-1 for load conditions.

**TABLE 26-31: SPIx MASTER MODE (FULL-DUPLEX, CKE = 1, CKP = x, SMP = 1) TIMING REQUIREMENTS FOR dsPIC33FJ16(GP/MC)10X**

| AC CHARACTERISTICS | | | Standard Operating Conditions: 2.4V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | | |
|---|---|---|---|---|---|---|---|
| **Param No.** | **Symbol** | **Characteristic(1)** | **Min** | **Typ(2)** | **Max** | **Units** | **Conditions** |
| SP10 | TscP | Maximum SCKx Frequency | — | — | 10 | MHz | See **Note 3** |
| SP20 | TscF | SCKx Output Fall Time | — | — | — | ns | See Parameter DO32 and **Note 4** |
| SP21 | TscR | SCKx Output Rise Time | — | — | — | ns | See Parameter DO31 and **Note 4** |
| SP30 | TdoF | SDOx Data Output Fall Time | — | — | — | ns | See Parameter DO32 and **Note 4** |
| SP31 | TdoR | SDOx Data Output Rise Time | — | — | — | ns | See Parameter DO31 and **Note 4** |
| SP35 | TscH2doV, TscL2doV | SDOx Data Output Valid after SCKx Edge | — | 6 | 20 | ns | |
| SP36 | TdoV2sc, TdoV2scL | SDOx Data Output Setup to First SCKx Edge | 30 | — | — | ns | |
| SP40 | TdiV2scH, TdiV2scL | Setup Time of SDIx Data Input to SCKx Edge | 30 | — | — | ns | |
| SP41 | TscH2diL, TscL2diL | Hold Time of SDIx Data Input to SCKx Edge | 30 | — | — | ns | |

**Note 1:** These parameters are characterized, but are not tested in manufacturing.

**2:** Data in "Typ" column is at 3.3V, +25°C unless otherwise stated.

**3:** The minimum clock period for SCKx is 100 ns. The clock generated in Master mode must not violate this specification.

**4:** Assumes 50 pF load on all SPIx pins.


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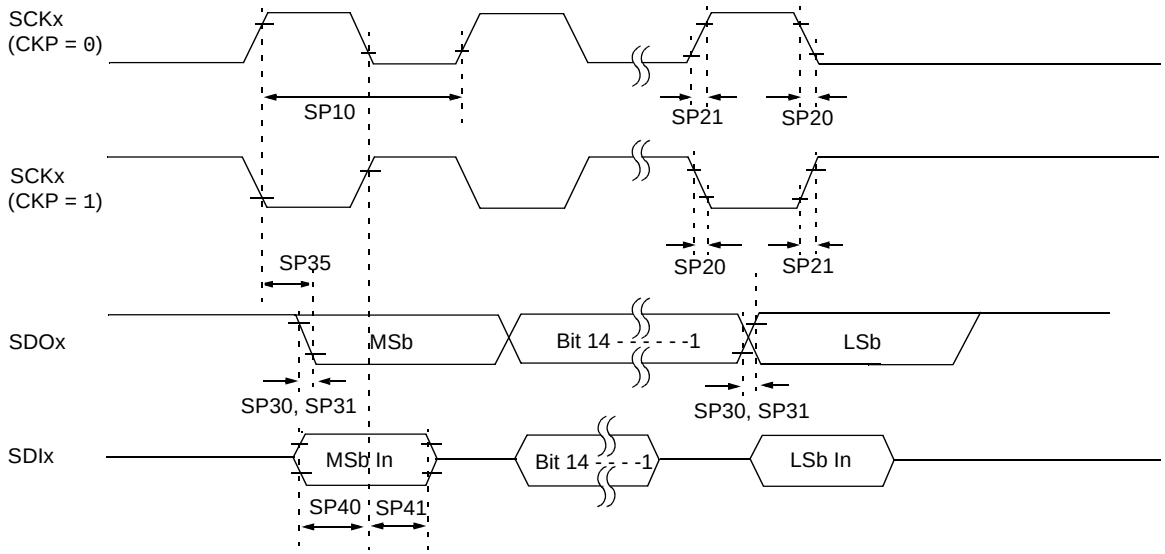
**FIGURE 26-14: SPIx MASTER MODE (FULL-DUPLEX, CKE = 0, CKP = x, SMP = 1) TIMING CHARACTERISTICS FOR dsPIC33FJ16(GP/MC)10X**




**Note:** Refer to Figure 26-1 for load conditions.

**TABLE 26-32: SPIx MASTER MODE (FULL-DUPLEX, CKE = 0, CKP = x, SMP = 1) TIMING REQUIREMENTS FOR dsPIC33FJ16(GP/MC)10X**

| AC CHARACTERISTICS | | | Standard Operating Conditions: 2.4V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | | |
|---|---|---|---|---|---|---|---|
| **Param No.** | **Symbol** | **Characteristic(1)** | **Min** | **Typ(2)** | **Max** | **Units** | **Conditions** |
| SP10 | TscP | Maximum SCKx Frequency | — | — | 10 | MHz | -40°C to +125°C, see **Note 3** |
| SP20 | TscF | SCKx Output Fall Time | — | — | — | ns | See Parameter DO32 and **Note 4** |
| SP21 | TscR | SCKx Output Rise Time | — | — | — | ns | See Parameter DO31 and **Note 4** |
| SP30 | TdoF | SDOx Data Output Fall Time | — | — | — | ns | See Parameter DO32 and **Note 4** |
| SP31 | TdoR | SDOx Data Output Rise Time | — | — | — | ns | See Parameter DO31 and **Note 4** |
| SP35 | TscH2doV, TscL2doV | SDOx Data Output Valid after SCKx Edge | — | 6 | 20 | ns | |
| SP36 | TdoV2scH, TdoV2scL | SDOx Data Output Setup to First SCKx Edge | 30 | — | — | ns | |
| SP40 | TdiV2scH, TdiV2scL | Setup Time of SDIx Data Input to SCKx Edge | 30 | — | — | ns | |
| SP41 | TscH2diL, TscL2diL | Hold Time of SDIx Data Input to SCKx Edge | 30 | — | — | ns | |

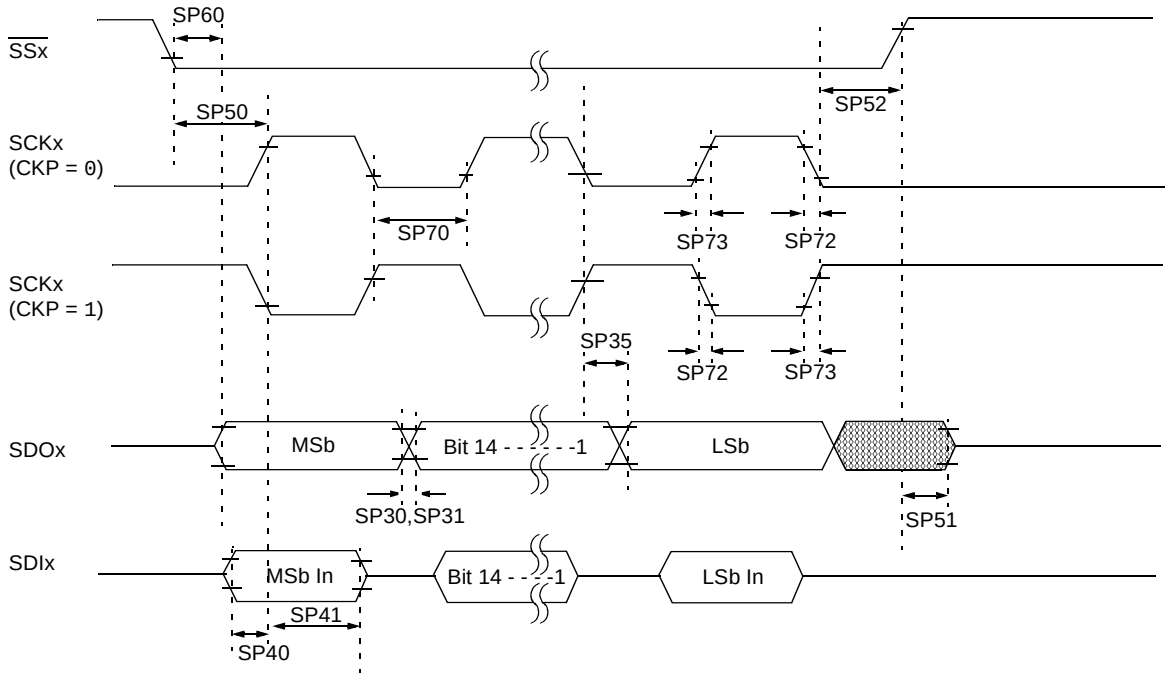
**Note 1:** These parameters are characterized, but are not tested in manufacturing.

**2:** Data in "Typ" column is at 3.3V, +25°C unless otherwise stated.

**3:** The minimum clock period for SCKx is 100 ns. The clock generated in Master mode must not violate this specification.

**4:** Assumes 50 pF load on all SPIx pins.

**FIGURE 26-15: SPIx SLAVE MODE (FULL-DUPLEX, CKE = 1, CKP = 0, SMP = 0) TIMING CHARACTERISTICS FOR dsPIC33FJ16(GP/MC)10X**




**Note:** Refer to Figure 26-1 for load conditions.


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**TABLE 26-33: SPIx SLAVE MODE (FULL-DUPLEX, CKE = 1, CKP = 0, SMP = 0) TIMING REQUIREMENTS FOR dsPIC33FJ16(GP/MC)10X**

| AC CHARACTERISTICS | | | Standard Operating Conditions: 2.4V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | | |
|---|---|---|---|---|---|---|---|
| **Param No.** | **Symbol** | **Characteristic(1)** | **Min** | **Typ(2)** | **Max** | **Units** | **Conditions** |
| SP70 | TscP | Maximum SCKx Input Frequency | — | — | 15 | MHz | See **Note 3** |
| SP72 | TscF | SCKx Input Fall Time | — | — | — | ns | See Parameter DO32 and **Note 4** |
| SP73 | TscR | SCKx Input Rise Time | — | — | — | ns | See Parameter DO31 and **Note 4** |
| SP30 | TdoF | SDOx Data Output Fall Time | — | — | — | ns | See Parameter DO32 and **Note 4** |
| SP31 | TdoR | SDOx Data Output Rise Time | — | — | — | ns | See Parameter DO31 and **Note 4** |
| SP35 | TscH2doV, TscL2doV | SDOx Data Output Valid after SCKx Edge | — | 6 | 20 | ns | |
| SP36 | TdoV2scH, TdoV2scL | SDOx Data Output Setup to First SCKx Edge | 30 | — | — | ns | |
| SP40 | TdiV2scH, TdiV2scL | Setup Time of SDIx Data Input to SCKx Edge | 30 | — | — | ns | |
| SP41 | TscH2diL, TscL2diL | Hold Time of SDIx Data Input to SCKx Edge | 30 | — | — | ns | |
| SP50 | TssL2scH, TssL2scL | $\overline{SSx}$ ↓ to SCKx ↑ or SCKx Input | 120 | — | — | ns | |
| SP51 | TssH2doZ | $\overline{SSx}$ ↑ to SDOx Output High-Impedance | 10 | — | 50 | ns | See **Note 4** |
| SP52 | TscH2ssH TscL2ssH | $\overline{SSx}$ after SCKx Edge | 1.5 TCY + 40 | — | — | ns | See **Note 4** |
| SP60 | TssL2doV | $\overline{SDOx}$ Data Output Valid after $\overline{SSx}$ Edge | — | — | 50 | ns | |

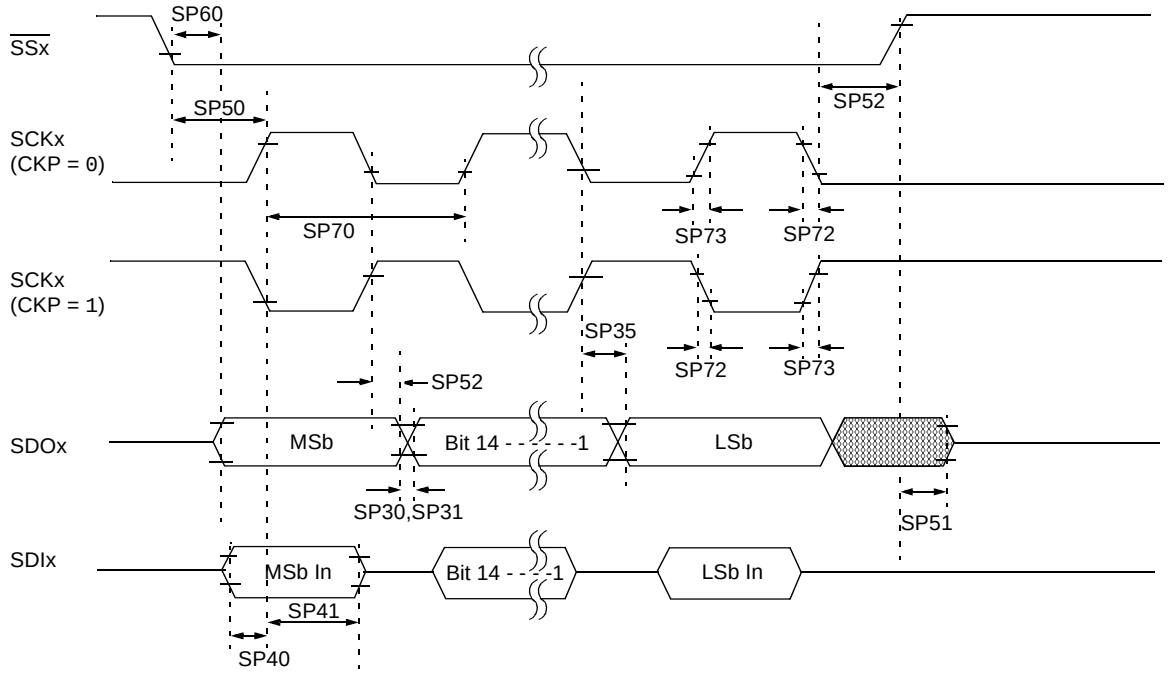
**Note 1:** These parameters are characterized, but are not tested in manufacturing.

**2:** Data in "Typ" column is at 3.3V, +25°C unless otherwise stated.

**3:** The minimum clock period for SCKx is 66.7 ns. Therefore, the SCKx clock generated by the master must not violate this specification.

**4:** Assumes 50 pF load on all SPIx pins.

**FIGURE 26-16: SPIx SLAVE MODE (FULL-DUPLEX, CKE = 1, CKP = 1, SMP = 0) TIMING CHARACTERISTICS FOR dsPIC33FJ16(GP/MC)10X**




**Note:** Refer to Figure 26-1 for load conditions.


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**TABLE 26-34: SPIx SLAVE MODE (FULL-DUPLEX, CKE = 1, CKP = 1, SMP = 0) TIMING REQUIREMENTS FOR dsPIC33FJ16(GP/MC)10X**

| AC CHARACTERISTICS | | | Standard Operating Conditions: 2.4V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | | |
|---|---|---|---|---|---|---|---|
| **Param No.** | **Symbol** | **Characteristic(1)** | **Min** | **Typ(2)** | **Max** | **Units** | **Conditions** |
| SP70 | TscP | Maximum SCKx Input Frequency | — | — | 11 | MHz | See **Note 3** |
| SP72 | TscF | SCKx Input Fall Time | — | — | — | ns | See Parameter DO32 and **Note 4** |
| SP73 | TscR | SCKx Input Rise Time | — | — | — | ns | See Parameter DO31 and **Note 4** |
| SP30 | TdoF | SDOx Data Output Fall Time | — | — | — | ns | See Parameter DO32 and **Note 4** |
| SP31 | TdoR | SDOx Data Output Rise Time | — | — | — | ns | See Parameter DO31 and **Note 4** |
| SP35 | TscH2doV, TscL2doV | SDOx Data Output Valid after SCKx Edge | — | 6 | 20 | ns | |
| SP36 | TdoV2scH, TdoV2scL | SDOx Data Output Setup to First SCKx Edge | 30 | — | — | ns | |
| SP40 | TdiV2scH, TdiV2scL | Setup Time of SDIx Data Input to SCKx Edge | 30 | — | — | ns | |
| SP41 | TscH2diL, TscL2diL | Hold Time of SDIx Data Input to SCKx Edge | 30 | — | — | ns | |
| SP50 | TssL2scH, TssL2scL | $\overline{SSx}$ ↓ to SCKx ↑ or SCKx Input | 120 | — | — | ns | |
| SP51 | TssH2doZ | $\overline{SSx}$ ↑ to SDOx Output High-Impedance | 10 | — | 50 | ns | See **Note 4** |
| SP52 | TscH2ssH TscL2ssH | $\overline{SSx}$ after SCKx Edge | 1.5 TCY + 40 | — | — | ns | See **Note 4** |
| SP60 | TssL2doV | $\overline{SDO}$x Data Output Valid after $\overline{SSx}$ Edge | — | — | 50 | ns | |

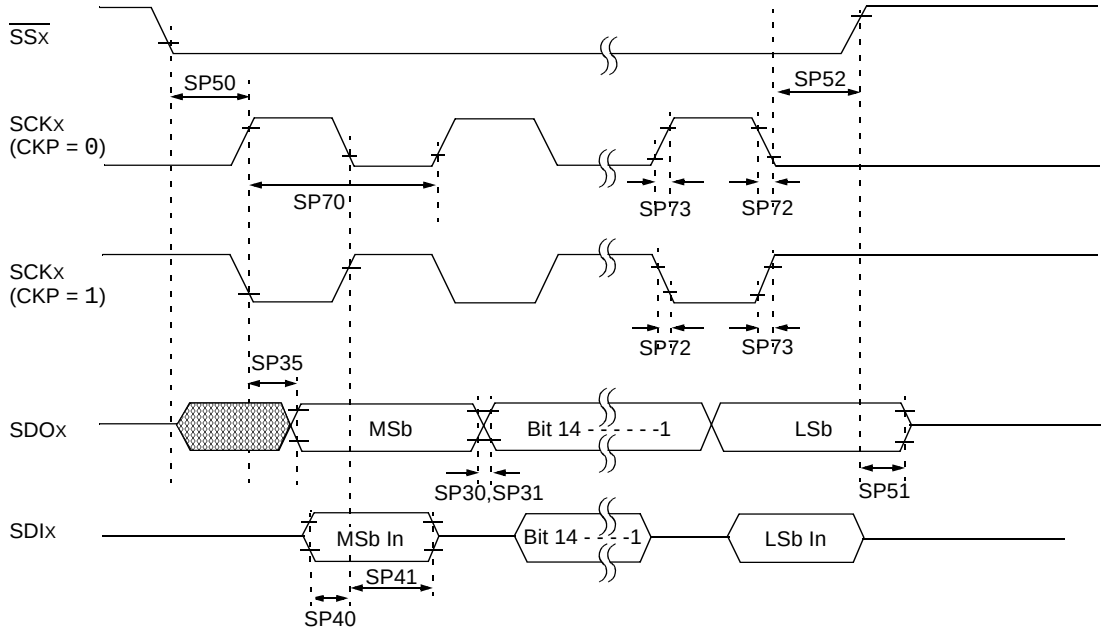
**Note 1:** These parameters are characterized, but are not tested in manufacturing.

**2:** Data in "Typ" column is at 3.3V, +25°C unless otherwise stated.

**3:** The minimum clock period for SCKx is 91 ns. Therefore, the SCKx clock generated by the Master must not violate this specification.

**4:** Assumes 50 pF load on all SPIx pins.

**FIGURE 26-17: SPIx SLAVE MODE (FULL-DUPLEX, CKE = 0, CKP = 1, SMP = 0) TIMING CHARACTERISTICS FOR dsPIC33FJ16(GP/MC)10X**




**Note:** Refer to Figure 26-1 for load conditions.


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**TABLE 26-35: SPIx SLAVE MODE (FULL-DUPLEX, CKE = 0, CKP = 1, SMP = 0) TIMING REQUIREMENTS FOR dsPIC33FJ16(GP/MC)10X**

| AC CHARACTERISTICS | | | Standard Operating Conditions: 2.4V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | | |
|---|---|---|---|---|---|---|---|
| **Param No.** | **Symbol** | **Characteristic(1)** | **Min** | **Typ(2)** | **Max** | **Units** | **Conditions** |
| SP70 | TscP | Maximum SCKx Input Frequency | — | — | 15 | MHz | See **Note 3** |
| SP72 | TscF | SCKx Input Fall Time | — | — | — | ns | See Parameter DO32 and **Note 4** |
| SP73 | TscR | SCKx Input Rise Time | — | — | — | ns | See Parameter DO31 and **Note 4** |
| SP30 | TdoF | SDOx Data Output Fall Time | — | — | — | ns | See Parameter DO32 and **Note 4** |
| SP31 | TdoR | SDOx Data Output Rise Time | — | — | — | ns | See Parameter DO31 and **Note 4** |
| SP35 | TscH2doV, TscL2doV | SDOx Data Output Valid after SCKx Edge | — | 6 | 20 | ns | |
| SP36 | TdoV2scH, TdoV2scL | SDOx Data Output Setup to First SCKx Edge | 30 | — | — | ns | |
| SP40 | TdiV2scH, TdiV2scL | Setup Time of SDIx Data Input to SCKx Edge | 30 | — | — | ns | |
| SP41 | TscH2diL, TscL2diL | Hold Time of SDIx Data Input to SCKx Edge | 30 | — | — | ns | |
| SP50 | TssL2scH, TssL2scL | $\overline{SSx}$ ↓ to SCKx ↑ or SCKx Input | 120 | — | — | ns | |
| SP51 | TssH2doZ | $\overline{SSx}$ ↑ to SDOx Output High-Impedance | 10 | — | 50 | ns | See **Note 4** |
| SP52 | TscH2ssH TscL2ssH | $\overline{SSx}$ after SCKx Edge | 1.5 TCY + 40 | — | — | ns | See **Note 4** |

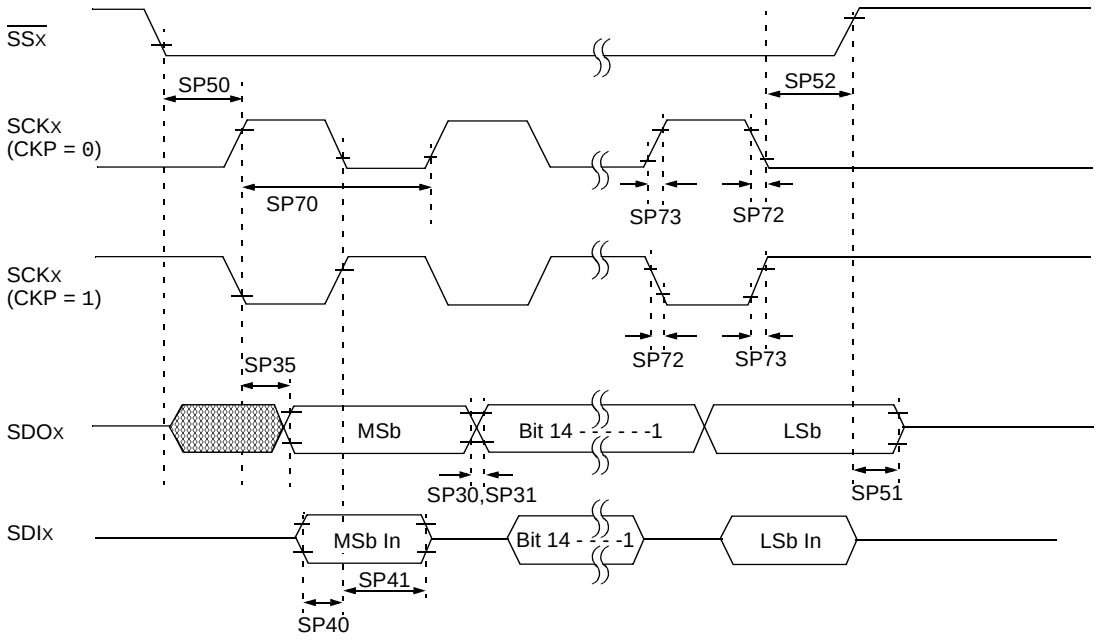
**Note 1:** These parameters are characterized, but are not tested in manufacturing.

**2:** Data in "Typ" column is at 3.3V, +25°C unless otherwise stated.

**3:** The minimum clock period for SCKx is 66.7 ns. Therefore, the SCKx clock generated by the Master must not violate this specification.

**4:** Assumes 50 pF load on all SPIx pins.

**FIGURE 26-18: SPIx SLAVE MODE (FULL-DUPLEX, CKE = 0, CKP = 0, SMP = 0) TIMING CHARACTERISTICS FOR dsPIC33FJ16(GP/MC)10X**




**Note:** Refer to Figure 26-1 for load conditions.


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**TABLE 26-36: SPIx SLAVE MODE (FULL-DUPLEX, CKE = 0, CKP = 0, SMP = 0) TIMING REQUIREMENTS FOR dsPIC33FJ16(GP/MC)10X**

| AC CHARACTERISTICS | | | Standard Operating Conditions: 2.4V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | | |
|---|---|---|---|---|---|---|---|
| **Param No.** | **Symbol** | **Characteristic(1)** | **Min** | **Typ(2)** | **Max** | **Units** | **Conditions** |
| SP70 | TscP | Maximum SCKx Input Frequency | — | — | 11 | MHz | See **Note 3** |
| SP72 | TscF | SCKx Input Fall Time | — | — | — | ns | See Parameter DO32 and **Note 4** |
| SP73 | TscR | SCKx Input Rise Time | — | — | — | ns | See Parameter DO31 and **Note 4** |
| SP30 | TdoF | SDOx Data Output Fall Time | — | — | — | ns | See Parameter DO32 and **Note 4** |
| SP31 | TdoR | SDOx Data Output Rise Time | — | — | — | ns | See Parameter DO31 and **Note 4** |
| SP35 | TscH2doV, TscL2doV | SDOx Data Output Valid after SCKx Edge | — | 6 | 20 | ns | |
| SP36 | TdoV2scH, TdoV2scL | SDOx Data Output Setup to First SCKx Edge | 30 | — | — | ns | |
| SP40 | TdiV2scH, TdiV2scL | Setup Time of SDIx Data Input to SCKx Edge | 30 | — | — | ns | |
| SP41 | TscH2diL, TscL2diL | Hold Time of SDIx Data Input to SCKx Edge | 30 | — | — | ns | |
| SP50 | TssL2scH, TssL2scL | $\overline{SSx}$ ↓ to SCKx ↑ or SCKx Input | 120 | — | — | ns | |
| SP51 | TssH2doZ | $\overline{SSx}$ ↑ to SDOx Output High-Impedance | 10 | — | 50 | ns | See **Note 4** |
| SP52 | TscH2ssH TscL2ssH | $\overline{SSx}$ after SCKx Edge | 1.5 TCY + 40 | — | — | ns | See **Note 4** |

**Note 1:** These parameters are characterized, but are not tested in manufacturing.

**2:** Data in "Typ" column is at 3.3V, +25°C unless otherwise stated.

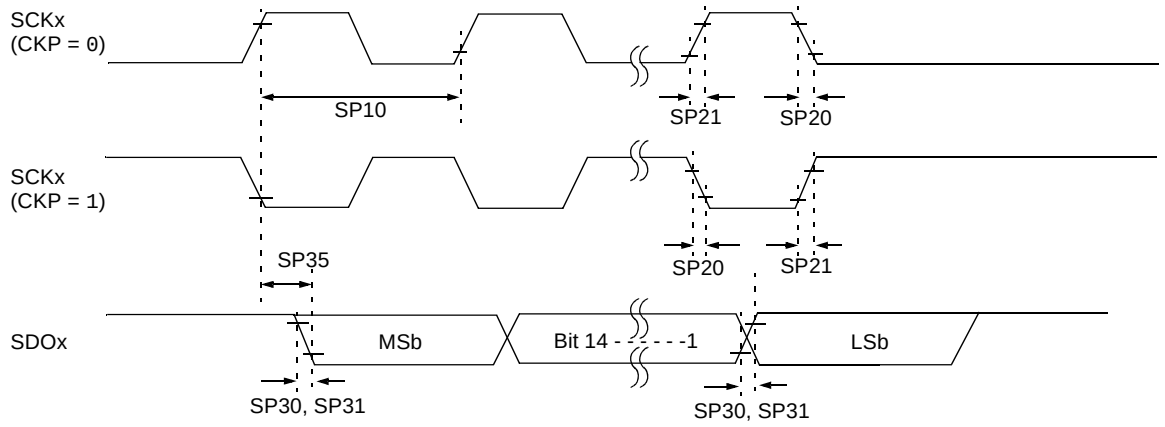
**3:** The minimum clock period for SCKx is 91 ns. Therefore, the SCKx clock generated by the Master must not violate this specification.

**4:** Assumes 50 pF load on all SPIx pins.

**TABLE 26-37: SPIx MAXIMUM DATA/CLOCK RATE SUMMARY FOR dsPIC33FJ32(GP/MC)10X**

| AC CHARACTERISTICS | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | |
|---|---|---|---|---|---|---|
| **Maximum Data Rate** | **Master Transmit Only (Half-Duplex)** | **Master Transmit/Receive (Full-Duplex)** | **Slave Transmit/Receive (Full-Duplex)** | **CKE** | **CKP** | **SMP** |
| 15 MHz | Table 26-30 | — | — | 0,1 | 0,1 | 0,1 |
| 9 MHz | — | Table 26-31 | — | 1 | 0,1 | 1 |
| 9 MHz | — | Table 26-32 | — | 0 | 0,1 | 1 |
| 15 MHz | — | — | Table 26-33 | 1 | 0 | 0 |
| 11 Mhz | — | — | Table 26-34 | 1 | 1 | 0 |
| 15 MHz | — | — | Table 26-35 | 0 | 1 | 0 |
| 11 MHz | — | — | Table 26-36 | 0 | 0 | 0 |

**FIGURE 26-19: SPIx MASTER MODE (HALF-DUPLEX, TRANSMIT ONLY, CKE = 0) TIMING CHARACTERISTICS FOR dsPIC33FJ32(GP/MC)10X**




**Note:** Refer to Figure 26-1 for load conditions.


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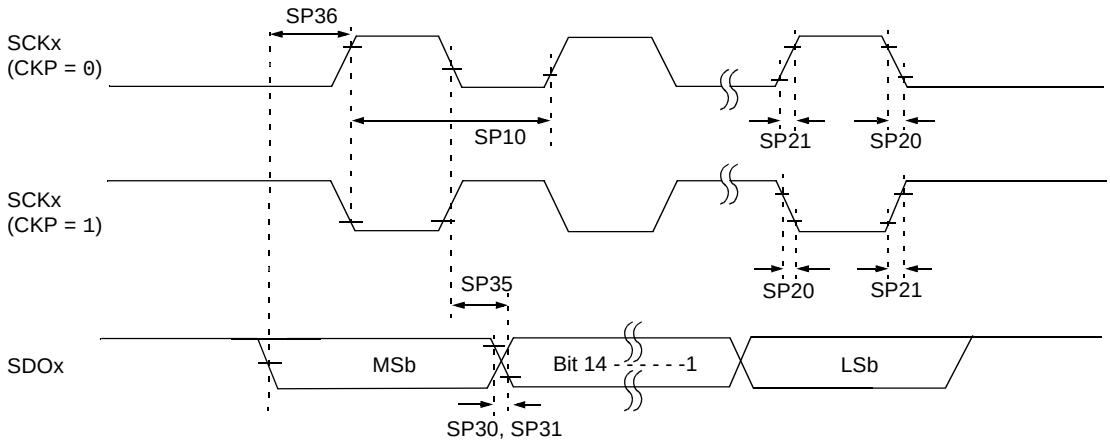
**FIGURE 26-20: SPIx MASTER MODE (HALF-DUPLEX, TRANSMIT ONLY, CKE = 1) TIMING CHARACTERISTICS FOR dsPIC33FJ32(GP/MC)10X**




**Note:** Refer to Figure 26-1 for load conditions.

**TABLE 26-38: SPIx MASTER MODE (HALF-DUPLEX, TRANSMIT ONLY) TIMING REQUIREMENTS FOR dsPIC33FJ32(GP/MC)10X**

| AC CHARACTERISTICS | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | | |
|---|---|---|---|---|---|---|---|
| **Param No.** | **Symbol** | **Characteristic(1)** | **Min** | **Typ(2)** | **Max** | **Units** | **Conditions** |
| SP10 | TscP | Maximum SCKx Frequency | — | — | 15 | MHz | See **Note 3** |
| SP20 | TscF | SCKx Output Fall Time | — | — | — | ns | See Parameter DO32 and **Note 4** |
| SP21 | TscR | SCKx Output Rise Time | — | — | — | ns | See Parameter DO31 and **Note 4** |
| SP30 | TdoF | SDOx Data Output Fall Time | — | — | — | ns | See Parameter DO32 and **Note 4** |
| SP31 | TdoR | SDOx Data Output Rise Time | — | — | — | ns | See Parameter DO31 and **Note 4** |
| SP35 | TscH2doV, TscL2doV | SDOx Data Output Valid after SCKx Edge | — | 6 | 20 | ns | |
| SP36 | TdiV2scH, TdiV2scL | SDOx Data Output Setup to First SCKx Edge | 30 | — | — | ns | |

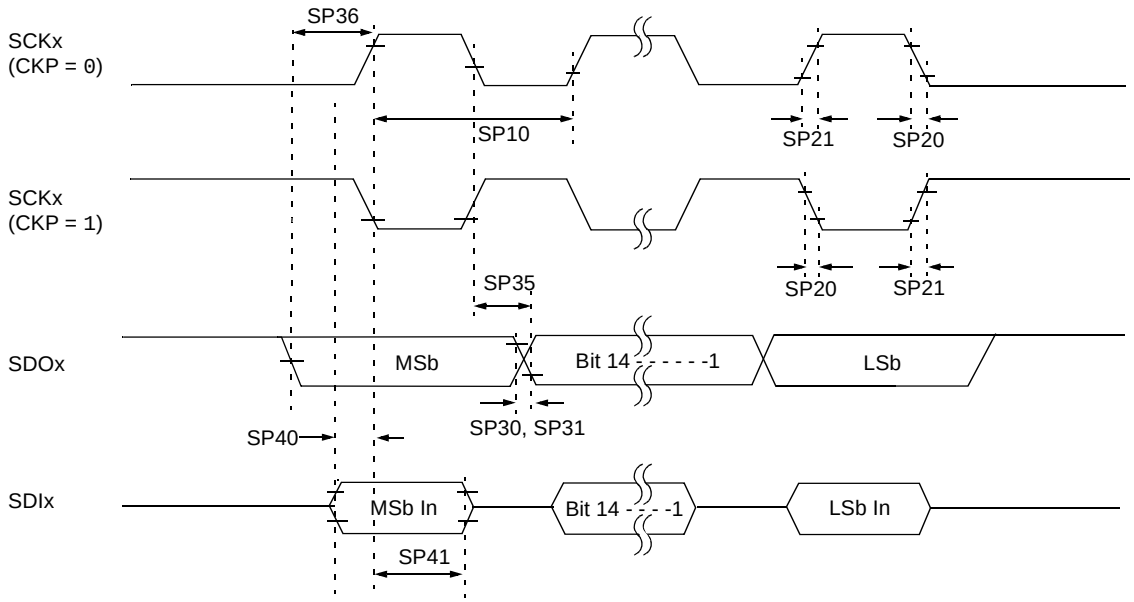
**Note 1:** These parameters are characterized, but are not tested in manufacturing.

**2:** Data in "Typ" column is at 3.3V, +25°C unless otherwise stated.

**3:** The minimum clock period for SCKx is 66.7 ns. Therefore, the clock generated in Master mode must not violate this specification.

**4:** Assumes 50 pF load on all SPIx pins.

**FIGURE 26-21: SPIx MASTER MODE (FULL-DUPLEX, CKE = 1, CKP = x, SMP = 1) TIMING CHARACTERISTICS FOR dsPIC33FJ32(GP/MC)10X**




**Note:** Refer to Figure 26-1 for load conditions.

**TABLE 26-39: SPIx MASTER MODE (FULL-DUPLEX, CKE = 1, CKP = x, SMP = 1) TIMING REQUIREMENTS FOR dsPIC33FJ32(GP/MC)10X**

| AC CHARACTERISTICS | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | | |
|---|---|---|---|---|---|---|---|
| **Param No.** | **Symbol** | **Characteristic(1)** | **Min** | **Typ(2)** | **Max** | **Units** | **Conditions** |
| SP10 | TscP | Maximum SCKx Frequency | — | — | 9 | MHz | See **Note 3** |
| SP20 | TscF | SCKx Output Fall Time | — | — | — | ns | See Parameter DO32 and **Note 4** |
| SP21 | TscR | SCKx Output Rise Time | — | — | — | ns | See Parameter DO31 and **Note 4** |
| SP30 | TdoF | SDOx Data Output Fall Time | — | — | — | ns | See Parameter DO32 and **Note 4** |
| SP31 | TdoR | SDOx Data Output Rise Time | — | — | — | ns | See Parameter DO31 and **Note 4** |
| SP35 | TscH2doV, TscL2doV | SDOx Data Output Valid after SCKx Edge | — | 6 | 20 | ns | |
| SP36 | TdoV2sc, TdoV2scL | SDOx Data Output Setup to First SCKx Edge | 30 | — | — | ns | |
| SP40 | TdiV2scH, TdiV2scL | Setup Time of SDIx Data Input to SCKx Edge | 30 | — | — | ns | |
| SP41 | TscH2diL, TscL2diL | Hold Time of SDIx Data Input to SCKx Edge | 30 | — | — | ns | |

**Note 1:** These parameters are characterized, but are not tested in manufacturing.

**2:** Data in "Typ" column is at 3.3V, +25°C unless otherwise stated.

**3:** The minimum clock period for SCKx is 111 ns. The clock generated in Master mode must not violate this specification.

**4:** Assumes 50 pF load on all SPIx pins.


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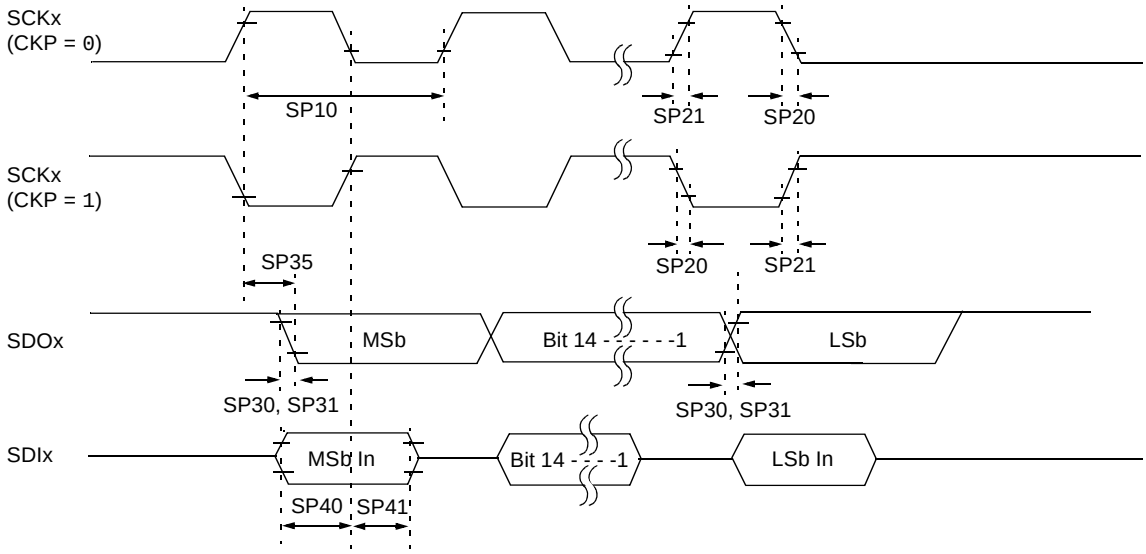
**FIGURE 26-22: SPIx MASTER MODE (FULL-DUPLEX, CKE = 0, CKP = x, SMP = 1) TIMING CHARACTERISTICS FOR dsPIC33FJ32(GP/MC)10X**




**Note:** Refer to Figure 26-1 for load conditions.

**TABLE 26-40: SPIx MASTER MODE (FULL-DUPLEX, CKE = 0, CKP = x, SMP = 1) TIMING REQUIREMENTS FOR dsPIC33FJ32(GP/MC)10X**

| AC CHARACTERISTICS | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | | |
|---|---|---|---|---|---|---|---|
| **Param No.** | **Symbol** | **Characteristic(1)** | **Min** | **Typ(2)** | **Max** | **Units** | **Conditions** |
| SP10 | TscP | Maximum SCKx Frequency | — | — | 9 | MHz | -40°C to +125°C, see **Note 3** |
| SP20 | TscF | SCKx Output Fall Time | — | — | — | ns | See Parameter DO32 and **Note 4** |
| SP21 | TscR | SCKx Output Rise Time | — | — | — | ns | See Parameter DO31 and **Note 4** |
| SP30 | TdoF | SDOx Data Output Fall Time | — | — | — | ns | See Parameter DO32 and **Note 4** |
| SP31 | TdoR | SDOx Data Output Rise Time | — | — | — | ns | See Parameter DO31 and **Note 4** |
| SP35 | TscH2doV, TscL2doV | SDOx Data Output Valid after SCKx Edge | — | 6 | 20 | ns | |
| SP36 | TdoV2scH, TdoV2scL | SDOx Data Output Setup to First SCKx Edge | 30 | — | — | ns | |
| SP40 | TdiV2scH, TdiV2scL | Setup Time of SDIx Data Input to SCKx Edge | 30 | — | — | ns | |
| SP41 | TscH2diL, TscL2diL | Hold Time of SDIx Data Input to SCKx Edge | 30 | — | — | ns | |

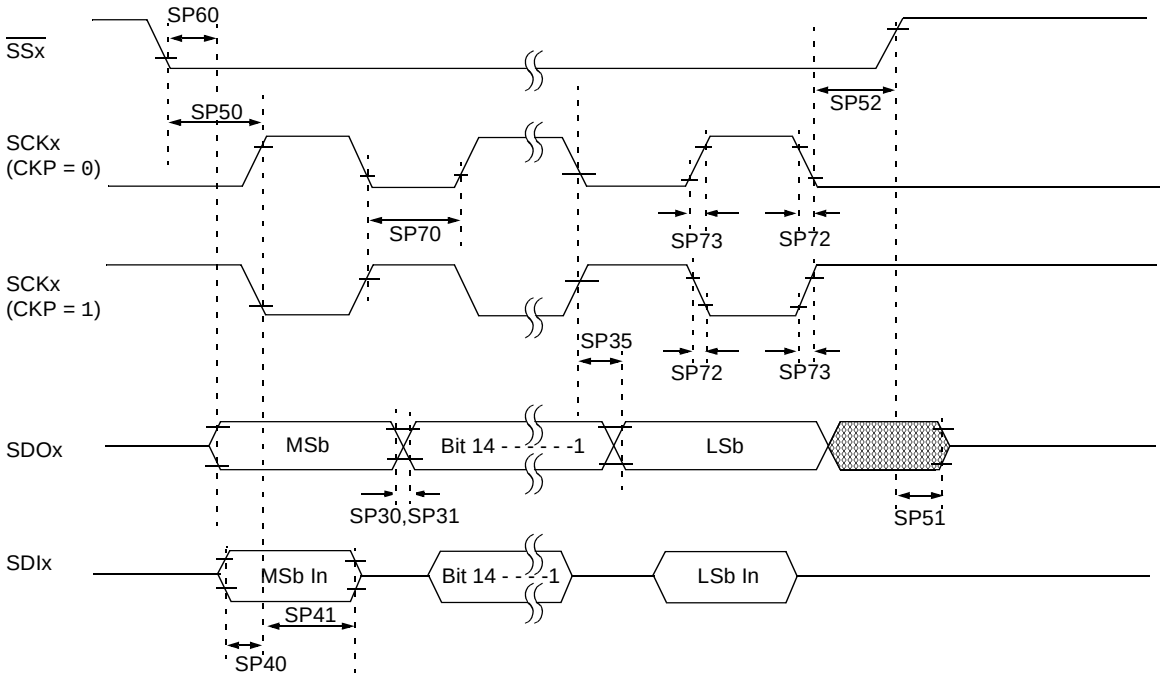
**Note 1:** These parameters are characterized, but are not tested in manufacturing.

**2:** Data in "Typ" column is at 3.3V, +25°C unless otherwise stated.

**3:** The minimum clock period for SCKx is 111 ns. The clock generated in Master mode must not violate this specification.

**4:** Assumes 50 pF load on all SPIx pins.

**FIGURE 26-23: SPIx SLAVE MODE (FULL-DUPLEX, CKE = 1, CKP = 0, SMP = 0) TIMING CHARACTERISTICS FOR dsPIC33FJ32(GP/MC)10X**




**Note:** Refer to Figure 26-1 for load conditions.


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**TABLE 26-41: SPIx SLAVE MODE (FULL-DUPLEX, CKE = 1, CKP = 0, SMP = 0) TIMING REQUIREMENTS FOR dsPIC33FJ32(GP/MC)10X**

| AC CHARACTERISTICS | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | | |
|---|---|---|---|---|---|---|---|
| **Param No.** | **Symbol** | **Characteristic(1)** | **Min** | **Typ(2)** | **Max** | **Units** | **Conditions** |
| SP70 | TscP | Maximum SCKx Input Frequency | — | — | 15 | MHz | See **Note 3** |
| SP72 | TscF | SCKx Input Fall Time | — | — | — | ns | See Parameter DO32 and **Note 4** |
| SP73 | TscR | SCKx Input Rise Time | — | — | — | ns | See Parameter DO31 and **Note 4** |
| SP30 | TdoF | SDOx Data Output Fall Time | — | — | — | ns | See Parameter DO32 and **Note 4** |
| SP31 | TdoR | SDOx Data Output Rise Time | — | — | — | ns | See Parameter DO31 and **Note 4** |
| SP35 | TscH2doV, TscL2doV | SDOx Data Output Valid after SCKx Edge | — | 6 | 20 | ns | |
| SP36 | TdoV2scH, TdoV2scL | SDOx Data Output Setup to First SCKx Edge | 30 | — | — | ns | |
| SP40 | TdiV2scH, TdiV2scL | Setup Time of SDIx Data Input to SCKx Edge | 30 | — | — | ns | |
| SP41 | TscH2diL, TscL2diL | Hold Time of SDIx Data Input to SCKx Edge | 30 | — | — | ns | |
| SP50 | TssL2scH, TssL2scL | $\overline{SSx}$ ↓ to SCKx ↑ or SCKx Input | 120 | — | — | ns | |
| SP51 | TssH2doZ | $\overline{SSx}$ ↑ to SDOx Output High-Impedance | 10 | — | 50 | ns | See **Note 4** |
| SP52 | TscH2ssH TscL2ssH | $\overline{SSx}$ after SCKx Edge | 1.5 TCY + 40 | — | — | ns | See **Note 4** |
| SP60 | TssL2doV | $\overline{SDO}$x Data Output Valid after $\overline{SSx}$ Edge | — | — | 50 | ns | |

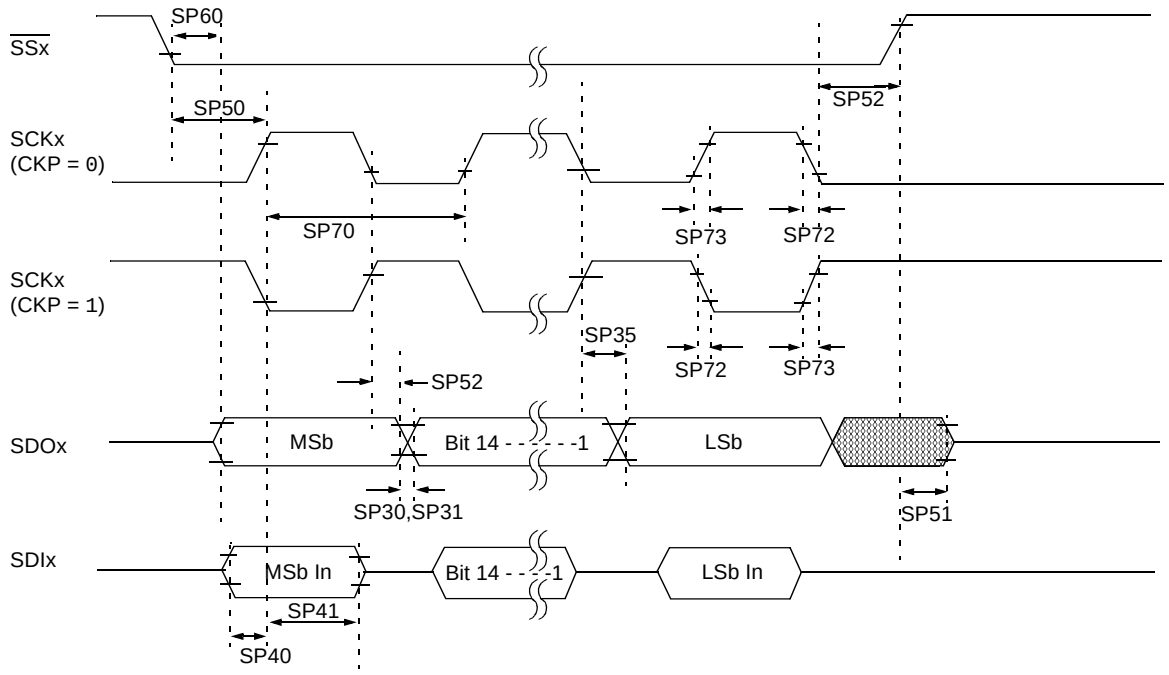
**Note 1:** These parameters are characterized, but are not tested in manufacturing.

**2:** Data in "Typ" column is at 3.3V, +25°C unless otherwise stated.

**3:** The minimum clock period for SCKx is 66.7 ns. Therefore, the SCKx clock generated by the Master must not violate this specification.

**4:** Assumes 50 pF load on all SPIx pins.

**FIGURE 26-24: SPIx SLAVE MODE (FULL-DUPLEX, CKE = 1, CKP = 1, SMP = 0) TIMING CHARACTERISTICS FOR dsPIC33FJ32(GP/MC)10X**




**Note:** Refer to Figure 26-1 for load conditions.


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**TABLE 26-42: SPIx SLAVE MODE (FULL-DUPLEX, CKE = 1, CKP = 1, SMP = 0) TIMING REQUIREMENTS FOR dsPIC33FJ32(GP/MC)10X**

| AC CHARACTERISTICS | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | | |
|---|---|---|---|---|---|---|---|
| **Param No.** | **Symbol** | **Characteristic(1)** | **Min** | **Typ(2)** | **Max** | **Units** | **Conditions** |
| SP70 | TscP | Maximum SCKx Input Frequency | — | — | 11 | MHz | See **Note 3** |
| SP72 | TscF | SCKx Input Fall Time | — | — | — | ns | See Parameter DO32 and **Note 4** |
| SP73 | TscR | SCKx Input Rise Time | — | — | — | ns | See Parameter DO31 and **Note 4** |
| SP30 | TdoF | SDOx Data Output Fall Time | — | — | — | ns | See Parameter DO32 and **Note 4** |
| SP31 | TdoR | SDOx Data Output Rise Time | — | — | — | ns | See Parameter DO31 and **Note 4** |
| SP35 | TscH2doV, TscL2doV | SDOx Data Output Valid after SCKx Edge | — | 6 | 20 | ns | |
| SP36 | TdoV2scH, TdoV2scL | SDOx Data Output Setup to First SCKx Edge | 30 | — | — | ns | |
| SP40 | TdiV2scH, TdiV2scL | Setup Time of SDIx Data Input to SCKx Edge | 30 | — | — | ns | |
| SP41 | TscH2diL, TscL2diL | Hold Time of SDIx Data Input to SCKx Edge | 30 | — | — | ns | |
| SP50 | TssL2scH, TssL2scL | $\overline{SSx}$ ↓ to SCKx ↑ or SCKx Input | 120 | — | — | ns | |
| SP51 | TssH2doZ | $\overline{SSx}$ ↑ to SDOx Output High-Impedance | 10 | — | 50 | ns | See **Note 4** |
| SP52 | TscH2ssH TscL2ssH | $\overline{SSx}$ after SCKx Edge | 1.5 TCY + 40 | — | — | ns | See **Note 4** |
| SP60 | TssL2doV | SDOx Data Output Valid after $\overline{SSx}$ Edge | — | — | 50 | ns | |

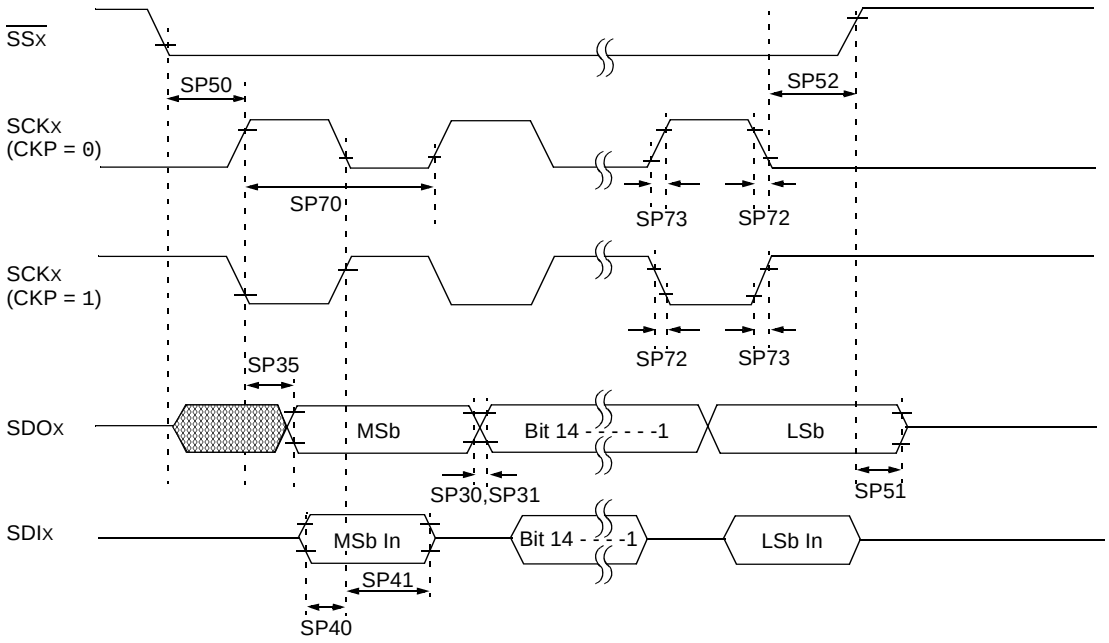
**Note 1:** These parameters are characterized, but are not tested in manufacturing.

**2:** Data in "Typ" column is at 3.3V, +25°C unless otherwise stated.

**3:** The minimum clock period for SCKx is 91 ns. Therefore, the SCKx clock generated by the master must not violate this specification.

**4:** Assumes 50 pF load on all SPIx pins.

**FIGURE 26-25: SPIx SLAVE MODE (FULL-DUPLEX, CKE = 0, CKP = 1, SMP = 0) TIMING CHARACTERISTICS FOR dsPIC33FJ32(GP/MC)10X**




**Note:** Refer to Figure 26-1 for load conditions.


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**TABLE 26-43: SPIx SLAVE MODE (FULL-DUPLEX, CKE = 0, CKP = 1, SMP = 0) TIMING REQUIREMENTS FOR dsPIC33FJ32(GP/MC)10X**

| AC CHARACTERISTICS | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | | |
|---|---|---|---|---|---|---|---|
| **Param No.** | **Symbol** | **Characteristic(1)** | **Min** | **Typ(2)** | **Max** | **Units** | **Conditions** |
| SP70 | TscP | Maximum SCKx Input Frequency | — | — | 15 | MHz | See **Note 3** |
| SP72 | TscF | SCKx Input Fall Time | — | — | — | ns | See Parameter DO32 and **Note 4** |
| SP73 | TscR | SCKx Input Rise Time | — | — | —w | ns | See Parameter DO31 and **Note 4** |
| SP30 | TdoF | SDOx Data Output Fall Time | — | — | — | ns | See Parameter DO32 and **Note 4** |
| SP31 | TdoR | SDOx Data Output Rise Time | — | — | — | ns | See Parameter DO31 and **Note 4** |
| SP35 | TscH2doV, TscL2doV | SDOx Data Output Valid after SCKx Edge | — | 6 | 20 | ns | |
| SP36 | TdoV2scH, TdoV2scL | SDOx Data Output Setup to First SCKx Edge | 30 | — | — | ns | |
| SP40 | TdiV2scH, TdiV2scL | Setup Time of SDIx Data Input to SCKx Edge | 30 | — | — | ns | |
| SP41 | TscH2diL, TscL2diL | Hold Time of SDIx Data Input to SCKx Edge | 30 | — | — | ns | |
| SP50 | TssL2scH, TssL2scL | $\overline{SSx}$ ↓ to SCKx ↑ or SCKx Input | 120 | — | — | ns | |
| SP51 | TssH2doZ | $\overline{SSx}$ ↑ to SDOx Output High-Impedance | 10 | — | 50 | ns | See **Note 4** |
| SP52 | TscH2ssH TscL2ssH | $\overline{SSx}$ after SCKx Edge | 1.5 TCY + 40 | — | — | ns | See **Note 4** |

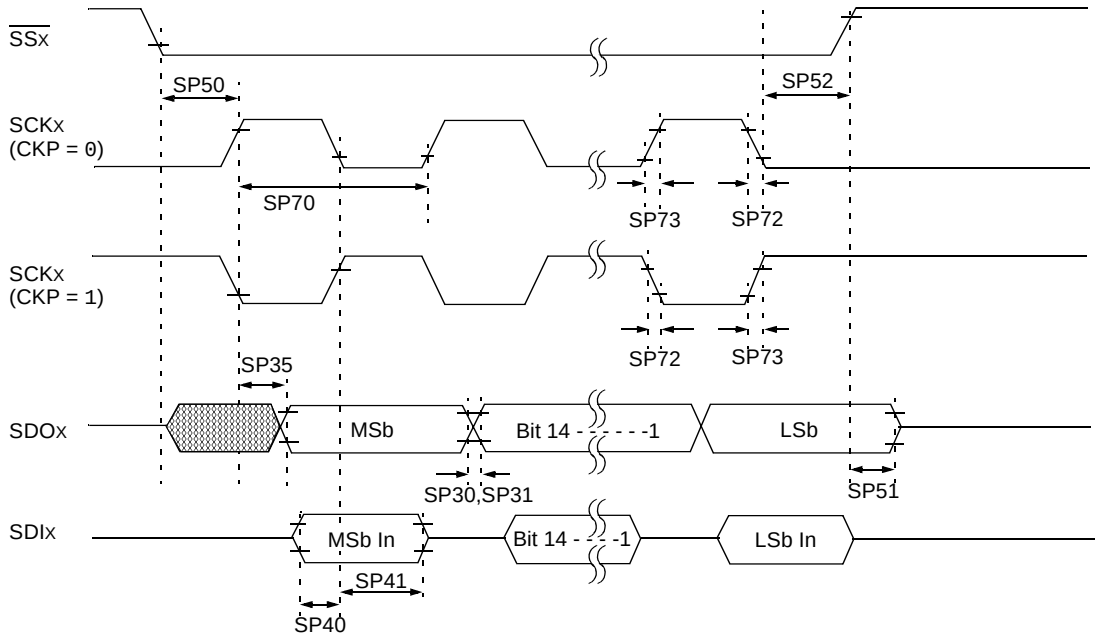
**Note 1:** These parameters are characterized, but are not tested in manufacturing.

**2:** Data in “Typ” column is at 3.3V, +25°C unless otherwise stated.

**3:** The minimum clock period for SCKx is 66.7 ns. Therefore, the SCKx clock generated by the Master must not violate this specification.

**4:** Assumes 50 pF load on all SPIx pins.

**FIGURE 26-26: SPIx SLAVE MODE (FULL-DUPLEX, CKE = 0, CKP = 0, SMP = 0) TIMING CHARACTERISTICS FOR dsPIC33FJ32(GP/MC)10X**




**Note:** Refer to Figure 26-1 for load conditions.


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**TABLE 26-44: SPIx SLAVE MODE (FULL-DUPLEX, CKE = 0, CKP = 0, SMP = 0) TIMING REQUIREMENTS FOR dsPIC33FJ32(GP/MC)10X**

| AC CHARACTERISTICS | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | | |
|---|---|---|---|---|---|---|---|
| **Param No.** | **Symbol** | **Characteristic(1)** | **Min** | **Typ(2)** | **Max** | **Units** | **Conditions** |
| SP70 | TscP | Maximum SCKx Input Frequency | — | — | 11 | MHz | See **Note 3** |
| SP72 | TscF | SCKx Input Fall Time | — | — | — | ns | See Parameter DO32 and **Note 4** |
| SP73 | TscR | SCKx Input Rise Time | — | — | — | ns | See Parameter DO31 and **Note 4** |
| SP30 | TdoF | SDOx Data Output Fall Time | — | — | — | ns | See Parameter DO32 and **Note 4** |
| SP31 | TdoR | SDOx Data Output Rise Time | — | — | — | ns | See Parameter DO31 and **Note 4** |
| SP35 | TscH2doV, TscL2doV | SDOx Data Output Valid after SCKx Edge | — | 6 | 20 | ns | |
| SP36 | TdoV2scH, TdoV2scL | SDOx Data Output Setup to First SCKx Edge | 30 | — | — | ns | |
| SP40 | TdiV2scH, TdiV2scL | Setup Time of SDIx Data Input to SCKx Edge | 30 | — | — | ns | |
| SP41 | TscH2diL, TscL2diL | Hold Time of SDIx Data Input to SCKx Edge | 30 | — | — | ns | |
| SP50 | TssL2scH, TssL2scL | $\overline{SSx}$ ↓ to SCKx ↑ or SCKx Input | 120 | — | — | ns | |
| SP51 | TssH2doZ | $\overline{SSx}$ ↑ to SDOx Output High-Impedance | 10 | — | 50 | ns | See **Note 4** |
| SP52 | TscH2ssH TscL2ssH | $\overline{SSx}$ after SCKx Edge | 1.5 TCY + 40 | — | — | ns | See **Note 4** |

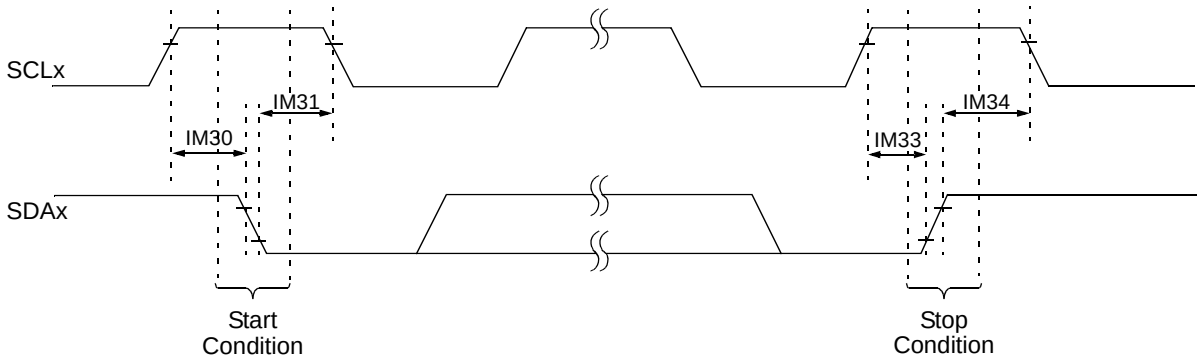
**Note 1:** These parameters are characterized, but are not tested in manufacturing.

**2:** Data in "Typ" column is at 3.3V, +25°C unless otherwise stated.

**3:** The minimum clock period for SCKx is 91 ns. Therefore, the SCKx clock generated by the Master must not violate this specification.

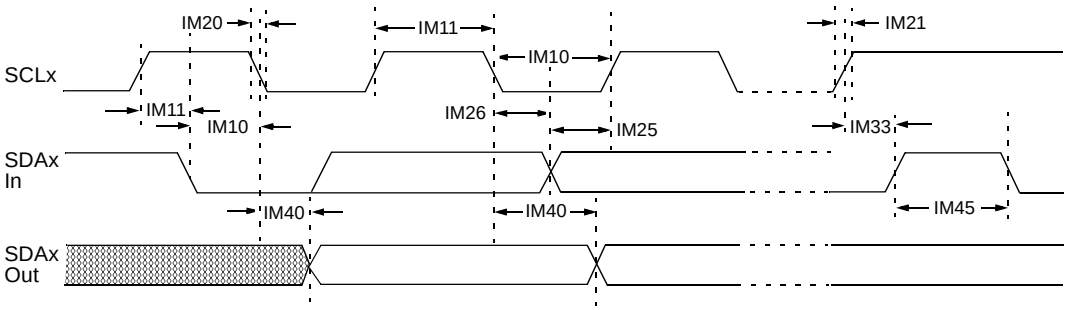
**4:** Assumes 50 pF load on all SPIx pins.

**FIGURE 26-27: I2Cx BUS START/STOP BITS TIMING CHARACTERISTICS (MASTER MODE)**




**Note:** Refer to Figure 26-1 for load conditions.

**FIGURE 26-28: I2Cx BUS DATA TIMING CHARACTERISTICS (MASTER MODE)**




**Note:** Refer to Figure 26-1 for load conditions.


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**TABLE 26-45: I2Cx BUS DATA TIMING REQUIREMENTS (MASTER MODE)**

| AC CHARACTERISTICS | | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | |
|---|---|---|---|---|---|---|---|
| **Param No.** | **Symbol** | **Characteristic** | | **Min(1)** | **Max** | **Units** | **Conditions** |
| IM10 | TLO:SCL | Clock Low Time | 100 kHz mode | TCY/2 (BRG + 1) | — | µs | |
| | | | 400 kHz mode | TCY/2 (BRG + 1) | — | µs | |
| | | | 1 MHz mode(2) | TCY/2 (BRG + 1) | — | µs | |
| IM11 | THI:SCL | Clock High Time | 100 kHz mode | TCY/2 (BRG + 1) | — | µs | |
| | | | 400 kHz mode | TCY/2 (BRG + 1) | — | µs | |
| | | | 1 MHz mode(2) | TCY/2 (BRG + 1) | — | µs | |
| IM20 | TF:SCL | SDAx and SCLx Fall Time | 100 kHz mode | — | 300 | ns | CB is specified to be from 10 to 400 pF |
| | | | 400 kHz mode | 20 + 0.1 CB | 300 | ns | |
| | | | 1 MHz mode(2) | — | 100 | ns | |
| IM21 | TR:SCL | SDAx and SCLx Rise Time | 100 kHz mode | — | 1000 | ns | CB is specified to be from 10 to 400 pF |
| | | | 400 kHz mode | 20 + 0.1 CB | 300 | ns | |
| | | | 1 MHz mode(2) | — | 300 | ns | |
| IM25 | TSU:DAT | Data Input Setup Time | 100 kHz mode | 250 | — | ns | |
| | | | 400 kHz mode | 100 | — | ns | |
| | | | 1 MHz mode(2) | 40 | — | ns | |
| IM26 | THD:DAT | Data Input Hold Time | 100 kHz mode | 0 | — | µs | |
| | | | 400 kHz mode | 0 | 0.9 | µs | |
| | | | 1 MHz mode(2) | 0.2 | — | µs | |
| IM30 | TSU:STA | Start Condition Setup Time | 100 kHz mode | TCY/2 (BRG + 1) | — | µs | Only relevant for Repeated Start condition |
| | | | 400 kHz mode | TCY/2 (BRG + 1) | — | µs | |
| | | | 1 MHz mode(2) | TCY/2 (BRG + 1) | — | µs | |
| IM31 | THD:STA | Start Condition Hold Time | 100 kHz mode | TCY/2 (BRG + 1) | — | µs | After this period the first clock pulse is generated |
| | | | 400 kHz mode | TCY/2 (BRG + 1) | — | µs | |
| | | | 1 MHz mode(2) | TCY/2 (BRG + 1) | — | µs | |
| IM33 | TSU:STO | Stop Condition Setup Time | 100 kHz mode | TCY/2 (BRG + 1) | — | µs | |
| | | | 400 kHz mode | TCY/2 (BRG + 1) | — | µs | |
| | | | 1 MHz mode(2) | TCY/2 (BRG + 1) | — | µs | |
| IM34 | THD:STO | Stop Condition Hold Time | 100 kHz mode | TCY/2 (BRG + 1) | — | ns | |
| | | | 400 kHz mode | TCY/2 (BRG + 1) | — | ns | |
| | | | 1 MHz mode(2) | TCY/2 (BRG + 1) | — | ns | |
| IM40 | TAA:SCL | Output Valid from Clock | 100 kHz mode | — | 3500 | ns | |
| | | | 400 kHz mode | — | 1000 | ns | |
| | | | 1 MHz mode(2) | — | 400 | ns | |
| IM45 | TBF:SDA | Bus Free Time | 100 kHz mode | 4.7 | — | µs | Time the bus must be free before a new transmission can start |
| | | | 400 kHz mode | 1.3 | — | µs | |
| | | | 1 MHz mode(2) | 0.5 | — | µs | |
| IM50 | CB | Bus Capacitive Loading | | — | 400 | pF | |
| IM51 | TPGD | Pulse Gobbler Delay | | 65 | 390 | ns | See **Note 3** |

**Note 1:** BRG is the value of the I2C™ Baud Rate Generator. Refer to **"Inter-Integrated Circuit (I2C™)"** (DS70195) in the "*dsPIC33/PIC24 Family Reference Manual*". Please see the Microchip web site for the latest "*dsPIC33/PIC24 Family Reference Manual*" sections.

**2:** Maximum pin capacitance = 10 pF for all I2Cx pins (for 1 MHz mode only).

**3:** Typical value for this parameter is 130 ns.

**FIGURE 26-29: I2Cx BUS START/STOP BITS TIMING CHARACTERISTICS (SLAVE MODE)**

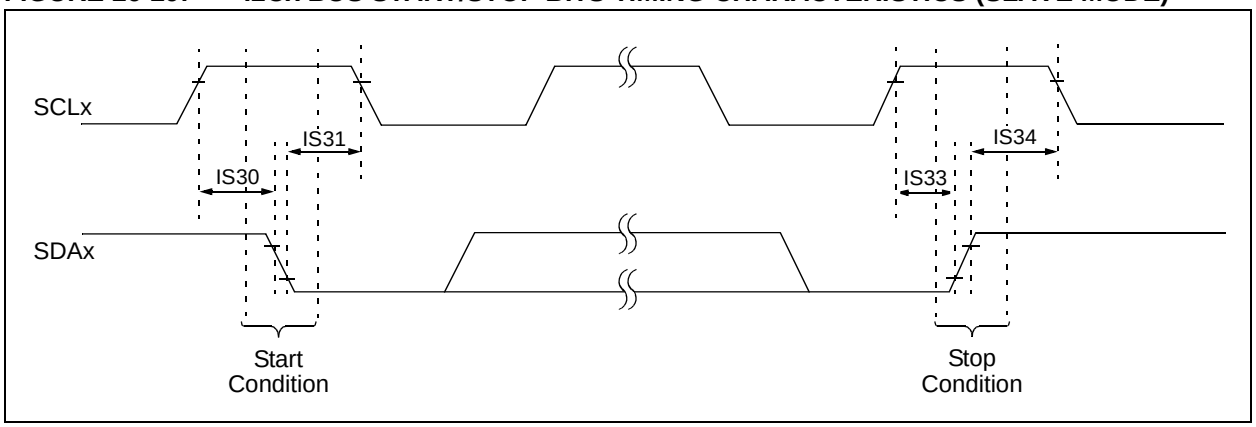


**FIGURE 26-30: I2Cx BUS DATA TIMING CHARACTERISTICS (SLAVE MODE)**

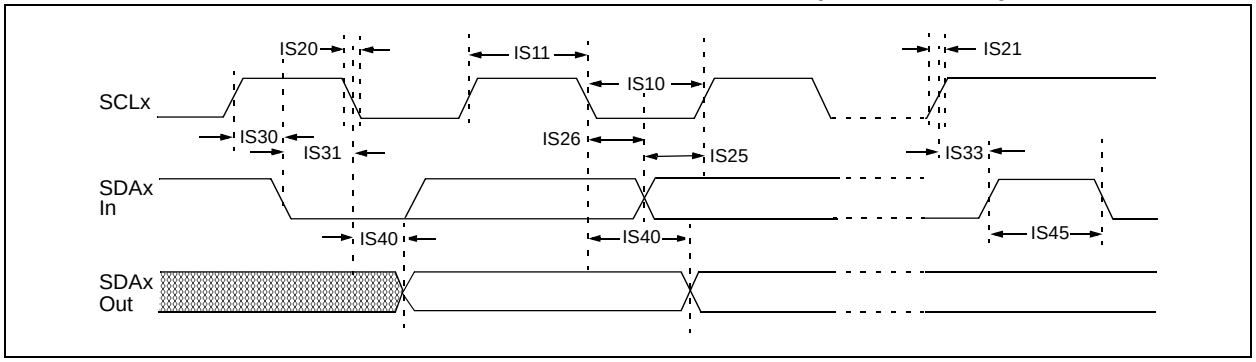



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**TABLE 26-46: I2Cx BUS DATA TIMING REQUIREMENTS (SLAVE MODE)**

| AC CHARACTERISTICS | | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | |
|---|---|---|---|---|---|---|---|
| **Param.** | **Symbol** | **Characteristic** | | **Min** | **Max** | **Units** | **Conditions** |
| IS10 | TLO:SCL | Clock Low Time | 100 kHz mode | 4.7 | — | µs | Device must operate at a minimum of 1.5 MHz |
| | | | 400 kHz mode | 1.3 | — | µs | Device must operate at a minimum of 10 MHz |
| | | | 1 MHz mode(1) | 0.5 | — | µs | |
| IS11 | THI:SCL | Clock High Time | 100 kHz mode | 4.0 | — | µs | Device must operate at a minimum of 1.5 MHz |
| | | | 400 kHz mode | 0.6 | — | µs | Device must operate at a minimum of 10 MHz |
| | | | 1 MHz mode(1) | 0.5 | — | µs | |
| IS20 | TF:SCL | SDAx and SCLx Fall Time | 100 kHz mode | — | 300 | ns | CB is specified to be from 10 to 400 pF |
| | | | 400 kHz mode | 20 + 0.1 CB | 300 | ns | |
| | | | 1 MHz mode(1) | — | 100 | ns | |
| IS21 | TR:SCL | SDAx and SCLx Rise Time | 100 kHz mode | — | 1000 | ns | CB is specified to be from 10 to 400 pF |
| | | | 400 kHz mode | 20 + 0.1 CB | 300 | ns | |
| | | | 1 MHz mode(1) | — | 300 | ns | |
| IS25 | TSU:DAT | Data Input Setup Time | 100 kHz mode | 250 | — | ns | |
| | | | 400 kHz mode | 100 | — | ns | |
| | | | 1 MHz mode(1) | 100 | — | ns | |
| IS26 | THD:DAT | Data Input Hold Time | 100 kHz mode | 0 | — | µs | |
| | | | 400 kHz mode | 0 | 0.9 | µs | |
| | | | 1 MHz mode(1) | 0 | 0.3 | µs | |
| IS30 | TSU:STA | Start Condition Setup Time | 100 kHz mode | 4.7 | — | µs | Only relevant for Repeated Start condition |
| | | | 400 kHz mode | 0.6 | — | µs | |
| | | | 1 MHz mode(1) | 0.25 | — | µs | |
| IS31 | THD:STA | Start Condition Hold Time | 100 kHz mode | 4.0 | — | µs | After this period, the first clock pulse is generated |
| | | | 400 kHz mode | 0.6 | — | µs | |
| | | | 1 MHz mode(1) | 0.25 | — | µs | |
| IS33 | TSU:STO | Stop Condition Setup Time | 100 kHz mode | 4.7 | — | µs | |
| | | | 400 kHz mode | 0.6 | — | µs | |
| | | | 1 MHz mode(1) | 0.6 | — | µs | |
| IS34 | THD:STO | Stop Condition Hold Time | 100 kHz mode | 4000 | — | ns | |
| | | | 400 kHz mode | 600 | — | ns | |
| | | | 1 MHz mode(1) | 250 | | ns | |
| IS40 | TAA:SCL | Output Valid from Clock | 100 kHz mode | 0 | 3500 | ns | |
| | | | 400 kHz mode | 0 | 1000 | ns | |
| | | | 1 MHz mode(1) | 0 | 350 | ns | |
| IS45 | TBF:SDA | Bus Free Time | 100 kHz mode | 4.7 | — | µs | Time the bus must be free before a new transmission can start |
| | | | 400 kHz mode | 1.3 | — | µs | |
| | | | 1 MHz mode(1) | 0.5 | — | µs | |
| IS50 | CB | Bus Capacitive Loading | | — | 400 | pF | |

**Note 1:** Maximum pin capacitance = 10 pF for all I2Cx pins (for 1 MHz mode only).

**TABLE 26-47: ADC MODULE SPECIFICATIONS**

| AC CHARACTERISTICS | | | Standard Operating Conditions: 3.0V to 3.6V[6] (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | | |
|---|---|---|---|---|---|---|---|
| **Param No.** | **Symbol** | **Characteristic** | **Min.** | **Typ** | **Max.** | **Units** | **Conditions** |
| **Device Supply** | | | | | | | |
| AD01 | AVDD | Module VDD Supply[2,4] | Greater of: VDD – 0.3 or 2.9 | — | Lesser of: VDD + 0.3 or 3.6 | V | |
| AD02 | AVSS | Module VSS Supply[2,5] | VSS – 0.3 | — | VSS + 0.3 | V | |
| AD09 | IAD | Operating Current | — | 7.0 | 9.0 | mA | See **Note 1** |
| **Analog Input** | | | | | | | |
| AD12 | VINH | Input Voltage Range VINH[2] | VINL | — | AVDD | V | This voltage reflects S&H Channels 0, 1, 2 and 3 (CH0-CH3), positive input |
| AD13 | VINL | Input Voltage Range VINL[2] | AVSS | — | AVSS + 1V | V | This voltage reflects S&H Channels 0, 1, 2 and 3 (CH0-CH3), negative input |
| AD17 | RIN | Recommended Impedance of Analog Voltage Source[3] | — | — | 200 | Ω | |

**Note 1:** These parameters are not characterized or tested in manufacturing.

**2:** These parameters are characterized, but are not tested in manufacturing.

**3:** These parameters are assured by design, but are not characterized or tested in manufacturing.

**4:** This pin may not be available on all devices; in which case, this pin will be connected to VDD internally. See the **"Pin Diagrams"** section for availability.

**5:** This pin may not be available on all devices; in which case, this pin will be connected to VSS internally. See the **"Pin Diagrams"** section for availability.

**6:** Overall functional device operation at VBOR < VDD < VDDMIN is ensured but not characterized. All device analog modules, such as the ADC, etc., will function but with degraded performance below VDDMIN.


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**TABLE 26-48: 10-BIT ADC MODULE SPECIFICATIONS**

| AC CHARACTERISTICS | | | Standard Operating Conditions: 3.0V to 3.6V[4] (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | | |
|---|---|---|---|---|---|---|---|
| **Param No.** | **Symbol** | **Characteristic** | **Min.** | **Typ** | **Max.** | **Units** | **Conditions** |
| **10-Bit ADC Accuracy – Measurements with AVDD/AVSS[3]** | | | | | | | |
| AD20b | Nr | Resolution | 10 Data Bits | | | bits | |
| AD21b | INL | Integral Nonlinearity | -1 | — | +1 | LSb | VINL = AVSS = 0V, AVDD = 3.6V |
| AD22b | DNL | Differential Nonlinearity | >-1 | — | <1 | LSb | VINL = AVSS = 0V, AVDD = 3.6V |
| AD23b | GERR | Gain Error | 3 | 7 | 15 | LSb | VINL = AVSS = 0V, AVDD = 3.6V |
| AD24b | EOFF | Offset Error | 1.5 | 3 | 7 | LSb | VINL = AVSS = 0V, AVDD = 3.6V |
| AD25b | — | Monotonicity | — | — | — | — | Guaranteed[1] |
| **Dynamic Performance (10-Bit Mode)[2]** | | | | | | | |
| AD30b | THD | Total Harmonic Distortion | — | — | -64 | dB | |
| AD31b | SINAD | Signal to Noise and Distortion | 57 | 58.5 | — | dB | |
| AD32b | SFDR | Spurious Free Dynamic Range | 72 | — | — | dB | |
| AD33b | FNYQ | Input Signal Bandwidth | — | — | 550 | kHz | |
| AD34b | ENOB | Effective Number of Bits | 9.16 | 9.4 | — | bits | |

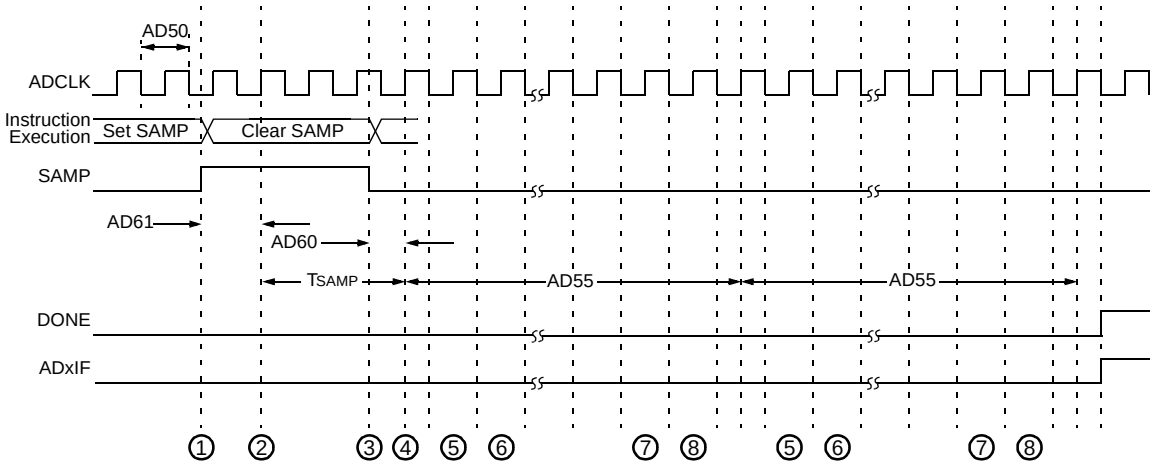
**Note 1:** The Analog-to-Digital conversion result never decreases with an increase in the input voltage and has no missing codes.

**2:** These parameters are characterized by similarity, but are not tested in manufacturing.

**3:** These parameters are characterized, but are tested at 20 ksps only.

**4:** Overall functional device operation at VBOR < VDD < VDDMIN is guaranteed but not characterized. All device analog modules, such as the ADC, etc., will function but with degraded performance below VDDMIN

**FIGURE 26-31: ADC CONVERSION TIMING CHARACTERISTICS (CHPS<1:0> = 01, SIMSAM = 0, ASAM = 0, SSRC<2:0> = 000)**




1 – Software sets ADxCON. SAMP to start sampling.

2 – Sampling starts after discharge period. TSAMP is described in **"Analog-to-Digital Converter (ADC)"** (DS70183) in the "*dsPIC33/PIC24 Family Reference Manual*".

3 – Software clears ADxCON. SAMP to start conversion.

4 – Sampling ends, conversion sequence starts.

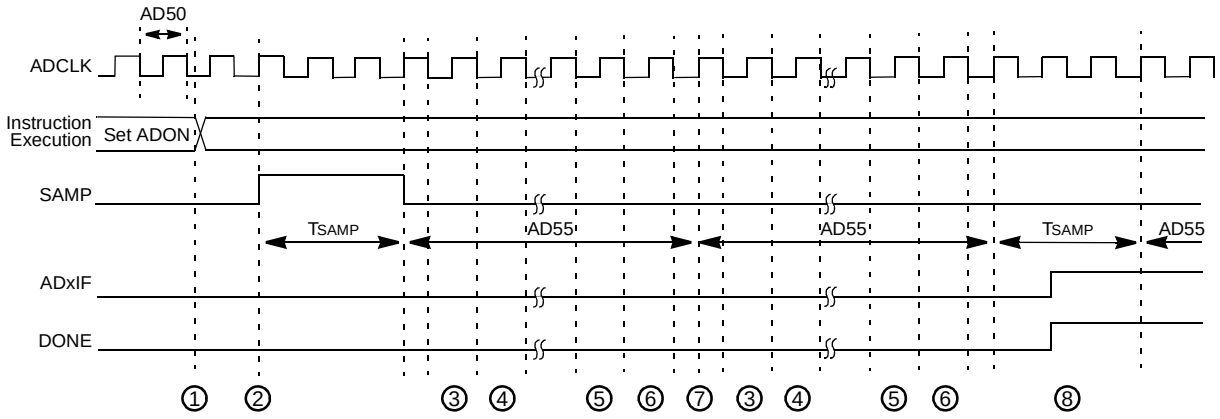
5 – Convert bit 9.

6 – Convert bit 8.

7 – Convert bit 0.

8 – One TAD for end of conversion.

**FIGURE 26-32: ADC CONVERSION TIMING CHARACTERISTICS (CHPS<1:0> = 01, SIMSAM = 0, ASAM = 1, SSRC<2:0> = 111, SAMC<4:0> = 00001)**




1 – Software sets ADxCON. ADON to start AD operation.

2 – Sampling starts after discharge period. TSAMP is described in **"Analog-to-Digital Converter (ADC)"** (DS70183) in the *"dsPIC33/PIC24 Family Reference Manual"*.

3 – Convert bit 9.

4 – Convert bit 8.

5 – Convert bit 0.

6 – One TAD for end of conversion.

7 – Begin conversion of next channel.

8 – Sample for time specified by SAMC<4:0>.


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**TABLE 26-49: 10-BIT ADC CONVERSION TIMING REQUIREMENTS**

| AC CHARACTERISTICS | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | | |
|---|---|---|---|---|---|---|---|
| **Param No.** | **Symbol** | **Characteristic** | **Min.** | **Typ(1)** | **Max.** | **Units** | **Conditions** |
| **Clock Parameters(2)** | | | | | | | |
| AD50 | TAD | ADC Clock Period | 76 | — | — | ns | |
| AD51 | tRC | ADC Internal RC Oscillator Period | — | 250 | — | ns | |
| **Conversion Rates** | | | | | | | |
| AD55 | tCONV | Conversion Time | — | 12 TAD | — | — | |
| AD56 | FCNV | Throughput Rate | — | — | 1.1 | Msps | |
| AD57 | TSAMP | Sample Time | 2.0 TAD | — | — | — | |
| **Timing Parameters** | | | | | | | |
| AD60 | tPCS | Conversion Start from Sample Trigger(1) | 2.0 TAD | — | 3.0 TAD | — | Auto-Convert Trigger (SSRC<2:0> = 111) not selected |
| AD61 | tPSS | Sample Start from Setting Sample (SAMP) bit(1) | 2.0 TAD | — | 3.0 TAD | — | |
| AD62 | tCSS | Conversion Completion to Sample Start (ASAM = 1)(1) | — | 0.5 TAD | — | — | |
| AD63 | tDPU | Time to Stabilize Analog Stage from ADC Off to ADC On(1) | — | — | 20 | μs | |

**Note 1:** These parameters are characterized but not tested in manufacturing.

**2:** Because the sample caps will eventually lose charge, clock rates below 10 kHz may affect linearity performance, especially at elevated temperatures.

**TABLE 26-50: COMPARATOR TIMING SPECIFICATIONS**

| AC CHARACTERISTICS | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | | |
|---|---|---|---|---|---|---|---|
| **Param No.** | **Symbol** | **Characteristic** | **Min.** | **Typ** | **Max.** | **Units** | **Conditions** |
| 300 | TRESP | Response Time(1,2) | — | 150 | 400 | ns | |
| 301 | TMC2OV | Comparator Mode Change to Output Valid(1) | — | — | 10 | µs | |
| 302 | TON2OV | Comparator Enabled to Output Valid(1) | — | — | 10 | µs | |

**Note 1:** Parameters are characterized but not tested.

**2:** Response time is measured with one comparator input at (VDD – 1.5)/2, while the other input transitions from VSS to VDD.

**TABLE 26-51: COMPARATOR MODULE SPECIFICATIONS**

| DC CHARACTERISTICS | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | | |
|---|---|---|---|---|---|---|---|
| **Param No.** | **Symbol** | **Characteristic** | **Min.** | **Typ** | **Max.** | **Units** | **Conditions** |
| D300 | VIOFF | Input Offset Voltage(1) | -20 | ±10 | 20 | mV | |
| D301 | VICM | Input Common-Mode Voltage(1) | 0 | — | AVDD – 1.5V | V | |
| D302 | CMRR | Common-Mode Rejection Ratio(1) | -54 | — | — | dB | |
| D305 | IVREF | Internal Voltage Reference(1) | 1.116 | 1.24 | 1.364 | V | |

**Note 1:** Parameters are characterized but not tested.

**TABLE 26-52: COMPARATOR VOLTAGE REFERENCE SETTLING TIME SPECIFICATIONS**

| AC CHARACTERISTICS | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | | |
|---|---|---|---|---|---|---|---|
| **Param No.** | **Symbol** | **Characteristic** | **Min.** | **Typ** | **Max.** | **Units** | **Conditions** |
| VR310 | TSET | Settling Time(1) | — | — | 10 | µs | |

**Note 1:** Settling time measured while CVRR = 1 and the CVR<3:0> bits transition from '0000' to '1111'.


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**TABLE 26-53: COMPARATOR VOLTAGE REFERENCE SPECIFICATIONS**

| DC CHARACTERISTICS | | | Standard Operating Conditions:3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | | |
|---|---|---|---|---|---|---|---|
| **Param No.** | **Symbol** | **Characteristic** | **Min.** | **Typ** | **Max.** | **Units** | **Conditions** |
| VRD310 | CVRES | Resolution | CVRSRC/24 | — | CVRSRC/32 | LSb | |
| VRD311 | CVRAA | Absolute Accuracy | — | — | 0.5 | LSb | |
| VRD312 | CVRUR | Unit Resistor Value (R) | — | 2k | — | Ω | |

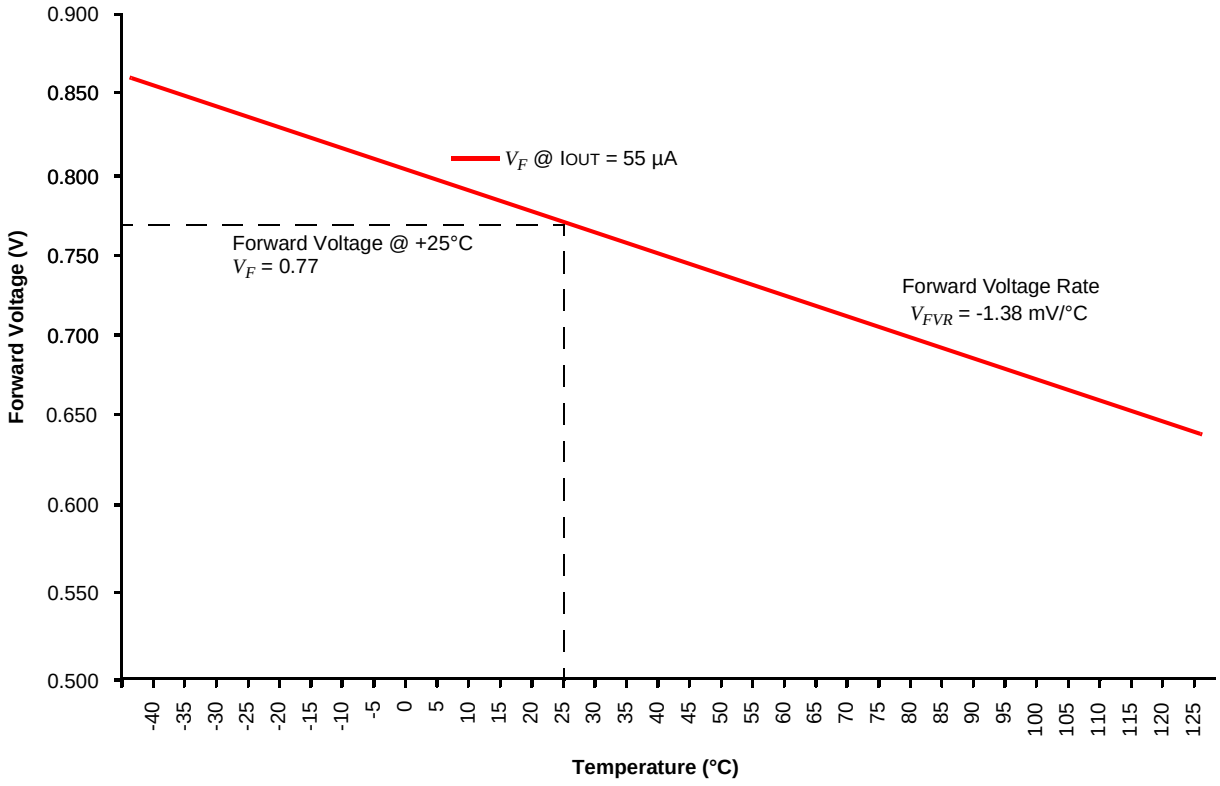
**TABLE 26-54: CTMU CURRENT SOURCE SPECIFICATIONS**

| DC CHARACTERISTICS | | | Standard Operating Conditions:3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +125°C for Extended | | | | |
|---|---|---|---|---|---|---|---|
| **Param No.** | **Symbol** | **Characteristic** | **Min.** | **Typ** | **Max.** | **Units** | **Conditions** |
| **CTMU Current Source** | | | | | | | |
| CTMUI1 | IOUT1 | Base Range(1) | 320 | 550 | 980 | na | IRNG<1:0> bits (CTMUICON<9:8>) = 0b01 |
| CTMUI2 | IOUT2 | 10x Range(1) | 3.2 | 5.5 | 9.8 | µA | IRNG<1:0> bits (CTMUICON<9:8>) = 0b10 |
| CTMUI3 | IOUT3 | 100x Range(1) | 32 | 55 | 98 | µA | IRNG<1:0> bits (CTMUICON<9:8>) = 0b11 |
| **Internal Diode** | | | | | | | |
| CTMUFV1 | VF | Forward Voltage(2) | — | 0.77 | — | V | IRNG<1:0> bits (CTMUICON<9:8>) = 0b11 @ +25°C |
| CTMUFV2 | VFVR | Forward Voltage Rate(2) | — | -1.38 | — | mV/ºC | IRNG<1:0> bits (CTMUICON<9:8>) = 0b11 |

**Note 1:** Nominal value at center point of current trim range (ITRIM<5:0> bits (CTMUICON<15:10>) = 0b000000).

**2:** ADC module configured for conversion speed of 500 ksps. Parameters are characterized but not tested in manufacturing.

**FIGURE 26-33: FORWARD VOLTAGE VERSUS TEMPERATURE**




**Note:** This graph is a statistical summary based on a limited number of samples and this data is characterized but not tested in manufacturing.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## 27.0 HIGH-TEMPERATURE ELECTRICAL CHARACTERISTICS

This section provides an overview of dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 family electrical characteristics for devices operating in an ambient temperature range of -40°C to +150°C.

The specifications between -40°C to +150°C are identical to those shown in **Section 26.0 "Electrical Characteristics"** for operation between -40°C to +125°C, with the exception of the parameters listed in this section.

Parameters in this section begin with an H, which denotes: High temperature. For example, Parameter DC10 in **Section 26.0 "Electrical Characteristics"** is the Industrial and Extended temperature equivalent of HDC10.

Absolute maximum ratings for the dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 high-temperature devices are listed below. Exposure to these maximum rating conditions for extended periods can affect device reliability. Functional operation of the device at these or any other conditions, above the parameters indicated in the operation listings of this specification, is not implied.

### Absolute Maximum Ratings(1)

Ambient temperature under bias(3) ..... -40°C to +150°C
Storage temperature ..... -65°C to +160°C
Voltage on $V_{DD}$ with respect to $V_{SS}$ ..... -0.3V to +4.0V
Voltage on any pin that is not 5V tolerant with respect to $V_{SS}$(4) ..... -0.3V to ($V_{DD}$ + 0.3V)
Voltage on any 5V tolerant pin with respect to $V_{SS}$ when $V_{DD}$ < 3.0V(4) ..... -0.3V to ($V_{DD}$ + 0.3V)
Voltage on any 5V tolerant pin with respect to $V_{SS}$ when $V_{DD} \geq$ 3.0V(4) ..... -0.3V to 5.6V
Maximum current out of $V_{SS}$ pin ..... 300 mA
Maximum current into $V_{DD}$ pin(2) ..... 250 mA
Maximum junction temperature ..... +155°C
Maximum current sourced/sunk by any 4x I/O pin ..... 4 mA
Maximum current sourced/sunk by any 8x I/O pin ..... 8 mA
Maximum current sunk by all ports combined ..... 80 mA
Maximum current sourced by all ports combined(2) ..... 80 mA

**Note 1:** Stresses above those listed under "Absolute Maximum Ratings" can cause permanent damage to the device. This is a stress rating only and functional operation of the device at those, or any other conditions above those indicated in the operation listings of this specification, is not implied. Exposure to maximum rating conditions for extended periods can affect device reliability.

**2:** Maximum allowable current is a function of device maximum power dissipation (see Table 27-2).

**3:** AEC-Q100 reliability testing for devices intended to operate at +150°C is 1,000 hours. Any design in which the total operating time from +125°C to +150°C will be greater than 1,000 hours is not warranted without prior written approval from Microchip Technology Inc.

**4:** Refer to the **"Pin Diagrams"** section for 5V tolerant pins.

## 27.1 High-Temperature DC Characteristics

**TABLE 27-1: OPERATING MIPS VS. VOLTAGE**

| Characteristic | VDD Range (in Volts) | Temperature Range (in °C) | Max MIPS |
|---|---|---|---|
| | | | dsPIC33FJ16(GP/MC)101/102 and dsPIC33FJ32(GP/MC)101/102/104 |
| HDC5 | VBOR – 3.6V(1) | -40°C to +150°C | 5 |

**Note 1:** Overall functional device operation at VBORMIN < VDD < VDDMIN is tested but not characterized. All device analog modules, such as the ADC, etc., may have degraded performances below VDDMIN.

**TABLE 27-2: THERMAL OPERATING CONDITIONS**

| Rating | Symbol | Min | Typ | Max | Unit |
|---|---|---|---|---|---|
| High Temperature Devices | | | | | |
| Operating Junction Temperature Range | TJ | -40 | — | +155 | °C |
| Operating Ambient Temperature Range | TA | -40 | — | +150 | °C |
| Power Dissipation:<br>Internal chip power dissipation:<br>PINT = VDD x (IDD – Σ IOH)<br>I/O Pin Power Dissipation:<br>I/O = Σ ({VDD – VOH} x IOH) + Σ (VOL x IOL) | PD | PINT + PI/O | | | W |
| Maximum Allowed Power Dissipation | PDMAX | (TJ – TA)/θJA | | | W |

**TABLE 27-3: DC CHARACTERISTICS: OPERATING CURRENT (IDD))**

| DC CHARACTERISTICS | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +150°C for High Temperature | | |
|---|---|---|---|---|---|
| Parameter No. | Typical | Max | Units | Conditions | |
| **Operating Current (IDD) – dsPIC33FJ16(GP/MC)10X Devices** | | | | | |
| DC20e | 1.3 | 1.7 | mA | 3.3V | LPRC (32.768 kHz) |
| DC22e | 7.0 | 8.5 | mA | 3.3V | 5 MIPS |

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**TABLE 27-4: DC CHARACTERISTICS: OPERATING CURRENT ($I_{DD}$))**

| DC CHARACTERISTICS | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +150°C for High Temperature | | |
|---|---|---|---|---|---|
| **Parameter No.** | **Typical** | **Max** | **Units** | **Conditions** | |
| **Operating Current ($I_{DD}$) – dsPIC33FJ32(GP/MC)10X Devices** | | | | | |
| DC20e | 1.3 | 2.0 | mA | 3.3V | LPRC (32.768 kHz) |
| DC22e | 7.25 | 8.5 | mA | 3.3V | 5 MIPS |

**TABLE 27-5: DC CHARACTERISTICS: IDLE CURRENT ($I_{IDLE}$))**

| DC CHARACTERISTICS | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +150°C for High Temperature | | |
|---|---|---|---|---|---|
| **Parameter No.** | **Typical** | **Max** | **Units** | **Conditions** | |
| **Idle Current ($I_{IDLE}$) – dsPIC33FJ16(GP/MC)10X Devices** | | | | | |
| DC40e | 0.5 | 1.0 | mA | 3.3V | LPRC (32.768 kHz) |
| DC22e | 1.2 | 1.6 | mA | 3.3V | 5 MIPS |
| **Idle Current ($I_{IDLE}$) – dsPIC33FJ32(GP/MC)10X Devices** | | | | | |
| DC40e | 0.5 | 1.0 | mA | 3.3V | LPRC (32.768 kHz) |
| DC22e | 1.4 | 1.8 | mA | 3.3V | 5 MIPS |

**TABLE 27-6: DC CHARACTERISTICS: POWER-DOWN CURRENT ($I_{PD}$)**

| DC CHARACTERISTICS | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +150°C for High Temperature | | |
|---|---|---|---|---|---|
| **Parameter No.** | **Typical(1)** | **Max** | **Units** | **Conditions** | |
| **Power-Down Current ($I_{PD}$) – dsPIC33FJXX(GP/MC)10X** | | | | | |
| DC60e | 500 | 1000 | μA | 3.3V | Base Power-Down Current |
| DC61e | 650 | 1000 | μA | 3.3V | Watchdog Timer Current: $\Delta I_{WDT}$ |

**Note 1:** Data in the Typical column is 3.3V unless otherwise stated.

**TABLE 27-7: DC CHARACTERISTICS: DOZE CURRENT (IDOZE)**

| DC CHARACTERISTICS | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +150°C for High Temperature | | | |
|---|---|---|---|---|---|---|
| **Parameter No.** | **Typical(1)** | **Max** | **Doze Ratio** | **Units** | **Conditions** | |
| **Doze Current (IDOZE) – dsPIC33FJ16(GP/MC)10X Devices** | | | | | | |
| DC74a | 4.3 | 7.2 | 1:2 | mA | 3.3V | 5 MIPS |
| DC74f | 1.6 | 6.2 | 1:64 | mA | 3.3V | 5 MIPS |
| DC74g | 1.5 | 6.2 | 1:128 | mA | 3.3V | 5 MIPS |
| **Doze Current (IDOZE) – dsPIC33FJ32(GP/MC)10X Devices** | | | | | | |
| DC74a | 4.7 | 7.2 | 1:2 | mA | 3.3V | 5 MIPS |
| DC74f | 1.9 | 6.2 | 1:64 | mA | 3.3V | 5 MIPS |
| DC74g | 1.4 | 6.2 | 1:128 | mA | 3.3V | 5 MIPS |

**Note 1:** Data in the Typical column is 3.3V unless otherwise stated.

**TABLE 27-8: DC CHARACTERISTICS: PROGRAM MEMORY**

| DC CHARACTERISTICS | | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +150°C for High Temperature | | | | |
|---|---|---|---|---|---|---|---|
| **Param No.** | **Symbol** | **Characteristic(1)** | **Min** | **Typ** | **Max** | **Units** | **Conditions** |
| | | **Program Flash Memory** | | | | | |
| HD130 | EP | Cell Endurance | 10,000 | — | — | E/W | -40°C to +150°C(2) |
| HD134 | TRETD | Characteristic Retention | 20 | — | — | Year | 1000 E/W cycles or less and no other specifications are violated |

**Note 1:** These parameters are assured by design, but are not characterized or tested in manufacturing.

**2:** Programming of the Flash memory is allowed up to +150°C.

**TABLE 27-9: AC CHARACTERISTICS: INTERNAL FAST RC (FRC) ACCURACY**

| AC CHARACTERISTICS | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) | | | | | |
|---|---|---|---|---|---|---|---|
| **Param No.** | **Characteristic** | **Min** | **Typ** | **Max** | **Units** | **Conditions** | |
| | **Internal FRC Accuracy @ 7.37 MHz(1)** | | | | | | |
| F20d | FRC | -8 | ±0.25 | +8 | % | -40°C ≤ TA ≤ +150°C | VDD 3.0-3.6V |

**Note 1:** Frequency is calibrated at +25°C and 3.3V. TUNx bits may be used to compensate for temperature drift.

**TABLE 27-10: INTERNAL LOW-POWER RC (LPRC) ACCURACY**

| AC CHARACTERISTICS | | Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) | | | | | |
|---|---|---|---|---|---|---|---|
| **Param No.** | **Characteristic** | **Min** | **Typ** | **Max** | **Units** | **Conditions** | |
| | **LPRC @ 32.768 kHz(1,2)** | | | | | | |
| F21c | LPRC | -40 | ±10 | +40 | % | -40°C ≤ TA ≤ +150°C | VDD 3.0-3.6V |

**Note 1:** Change of LPRC frequency as VDD changes.

**2:** LPRC accuracy impacts the Watchdog Timer Time-out Period (TWDT1). See **Section 23.4 "Watchdog Timer (WDT)"** for more information.

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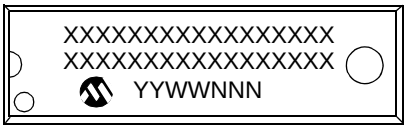
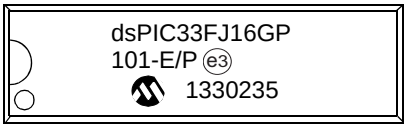
## 28.0 PACKAGING INFORMATION

### 28.1 Package Marking Information

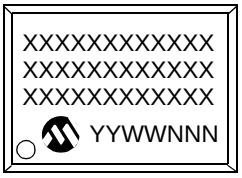
18-Lead PDIP




Example



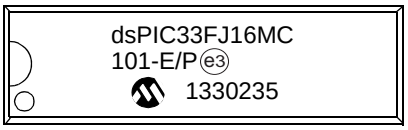

18-Lead SOIC



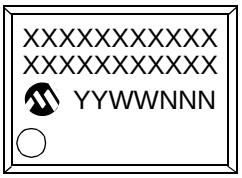

Example

20-Lead PDIP

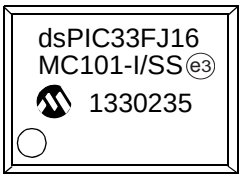
Example



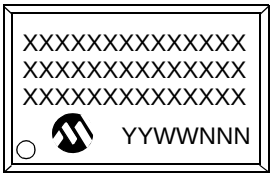

20-Lead SSOP



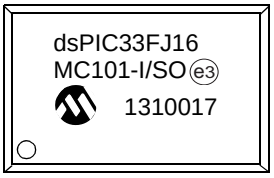

Example




20-Lead SOIC




Example

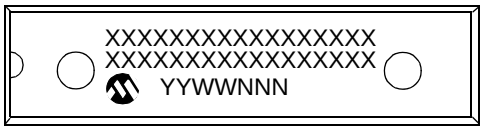



| | | |
|---|---|---|
| **Legend:** | XX...X | Customer-specific information |
| | Y | Year code (last digit of calendar year) |
| | YY | Year code (last 2 digits of calendar year) |
| | WW | Week code (week of January 1 is week ‘01’) |
| | NNN | Alphanumeric traceability code |
| | (e3) | Pb-free JEDEC designator for Matte Tin (Sn) |
| | * | This package is Pb-free. The Pb-free JEDEC designator ((e3)) can be found on the outer packaging for this package. |

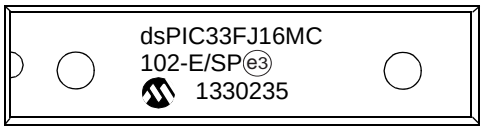
**Note:** If the full Microchip part number cannot be marked on one line, it is carried over to the next line, thus limiting the number of available characters for customer-specific information.

## 28.1 Package Marking Information (Continued)

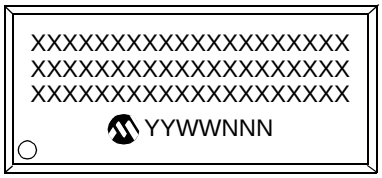
28-Lead SPDIP



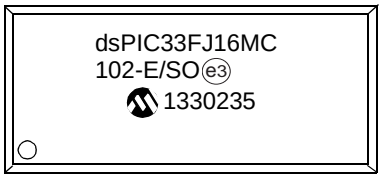

Example




28-Lead SOIC

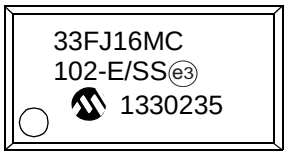



Example

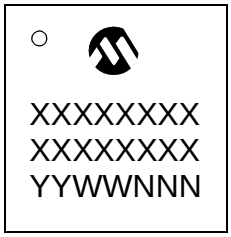



28-Lead SSOP

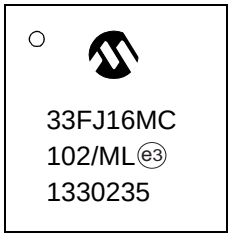
Example



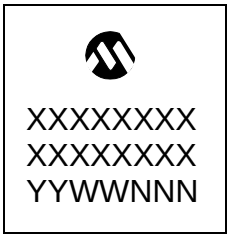

28-Lead QFN



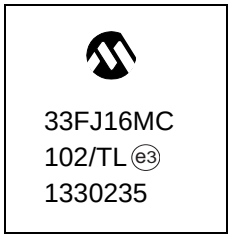

Example




36-Lead VTLA




Example





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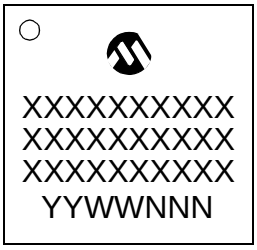
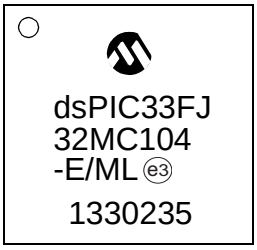
## 28.1 Package Marking Information (Continued)

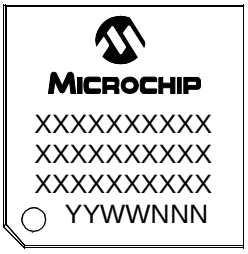
44-Lead QFN



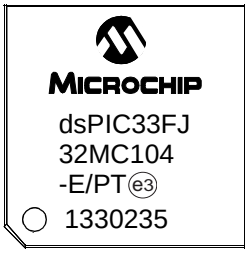

Example



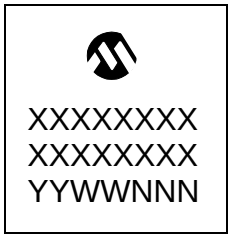

44-Lead TQFP




Example




44-Lead VTLA

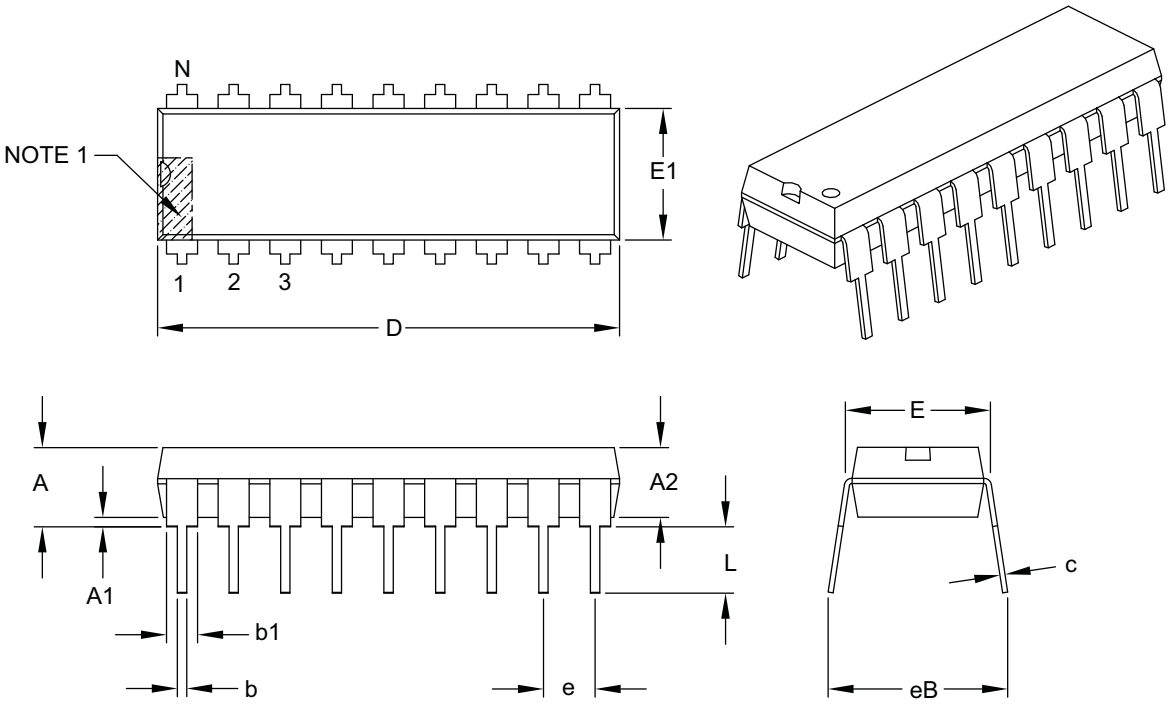



Example

## 28.2 Package Details

### 18-Lead Plastic Dual In-Line (P) – 300 mil Body [PDIP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging




| Units | | INCHES | | |
|---|---|---|---|---|
| Dimension Limits | | MIN | NOM | MAX |
| Number of Pins | N | | 18 | |
| Pitch | e | | .100 BSC | |
| Top to Seating Plane | A | – | – | .210 |
| Molded Package Thickness | A2 | .115 | .130 | .195 |
| Base to Seating Plane | A1 | .015 | – | – |
| Shoulder to Shoulder Width | E | .300 | .310 | .325 |
| Molded Package Width | E1 | .240 | .250 | .280 |
| Overall Length | D | .880 | .900 | .920 |
| Tip to Seating Plane | L | .115 | .130 | .150 |
| Lead Thickness | c | .008 | .010 | .014 |
| Upper Lead Width | b1 | .045 | .060 | .070 |
| Lower Lead Width | b | .014 | .018 | .022 |
| Overall Row Spacing § | eB | – | – | .430 |

**Notes:**

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. § Significant Characteristic.
3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" per side.
4. Dimensioning and tolerancing per ASME Y14.5M.

   BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-007B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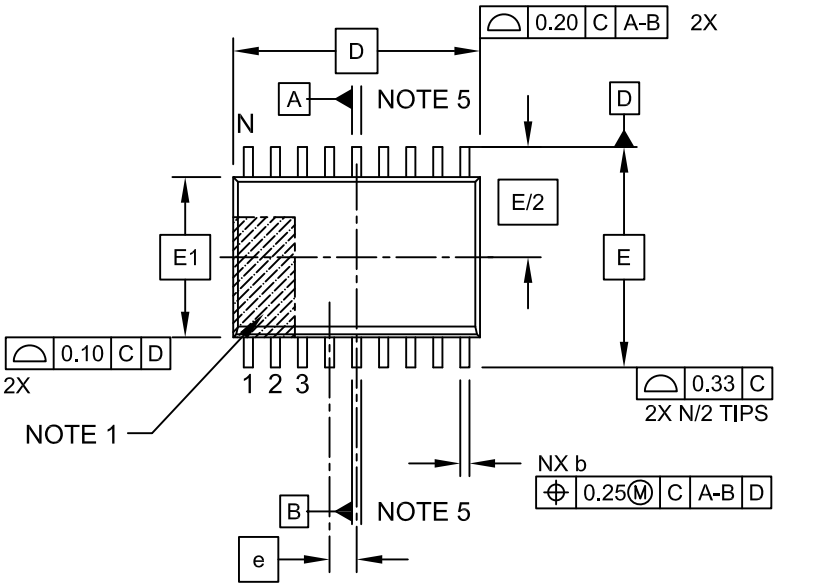
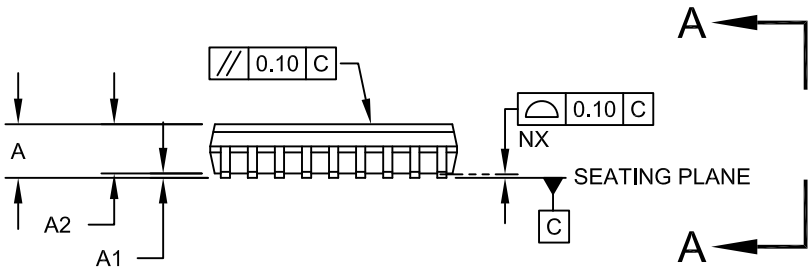
### 18-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

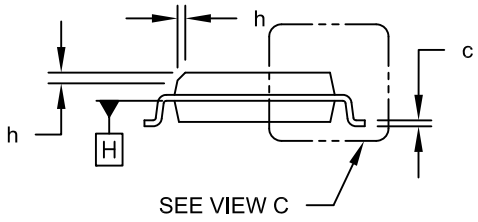
**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging




**TOP VIEW**




**SIDE VIEW**

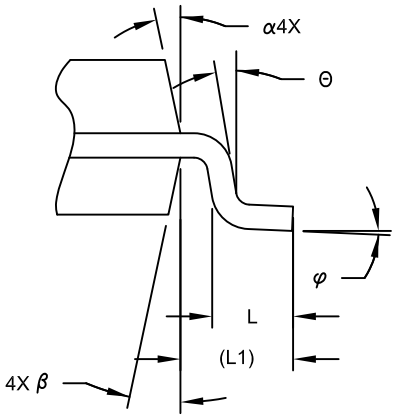



**VIEW A-A**

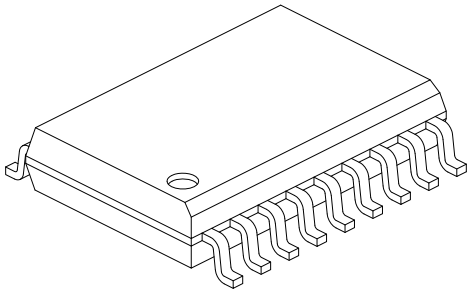
Microchip Technology Drawing C04-051C Sheet 1 of 2

## 18-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging




VIEW C



| Units | | MILLIMETERS | | |
|---|---|---|---|---|
| Dimension Limits | | MIN | NOM | MAX |
| Number of Pins | N | | 18 | |
| Pitch | e | | 1.27 BSC | |
| Overall Height | A | - | - | 2.65 |
| Molded Package Thickness | A2 | 2.05 | - | - |
| Standoff § | A1 | 0.10 | - | 0.30 |
| Overall Width | E | | 10.30 BSC | |
| Molded Package Width | E1 | | 7.50 BSC | |
| Overall Length | D | | 11.55 BSC | |
| Chamfer (Optional) | h | 0.25 | - | 0.75 |
| Foot Length | L | 0.40 | - | 1.27 |
| Footprint | L1 | | 1.40 REF | |
| Lead Angle | Θ | 0° | - | - |
| Foot Angle | φ | 0° | - | 8° |
| Lead Thickness | c | 0.20 | - | 0.33 |
| Lead Width | b | 0.31 | - | 0.51 |
| Mold Draft Angle Top | α | 5° | - | 15° |
| Mold Draft Angle Bottom | β | 5° | - | 15° |

**Notes:**

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. § Significant Characteristic
3. Dimension D does not include mold flash, protrusions or gate burrs, which shall not exceed 0.15 mm per end. Dimension E1 does not include interlead flash or protrusion, which shall not exceed 0.25 mm per side.
4. Dimensioning and tolerancing per ASME Y14.5M

   BSC: Basic Dimension. Theoretically exact value shown without tolerances.

   REF: Reference Dimension, usually without tolerance, for information purposes only.
5. Datums A & B to be determined at Datum H.

Microchip Technology Drawing No. C04-051C Sheet 2 of 2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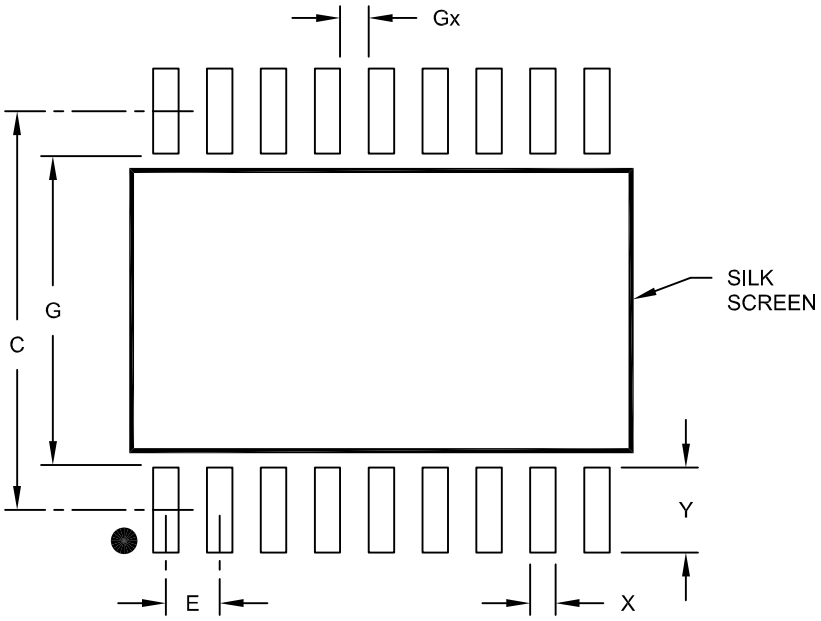
18-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging




RECOMMENDED LAND PATTERN

| Units | | MILLIMETERS | | |
|---|---|---|---|---|
| Dimension Limits | | MIN | NOM | MAX |
| Contact Pitch | E | 1.27 BSC | | |
| Contact Pad Spacing | C | | 9.40 | |
| Contact Pad Width | X | | | 0.60 |
| Contact Pad Length | Y | | | 2.00 |
| Distance Between Pads | Gx | 0.67 | | |
| Distance Between Pads | G | 7.40 | | |

Notes:

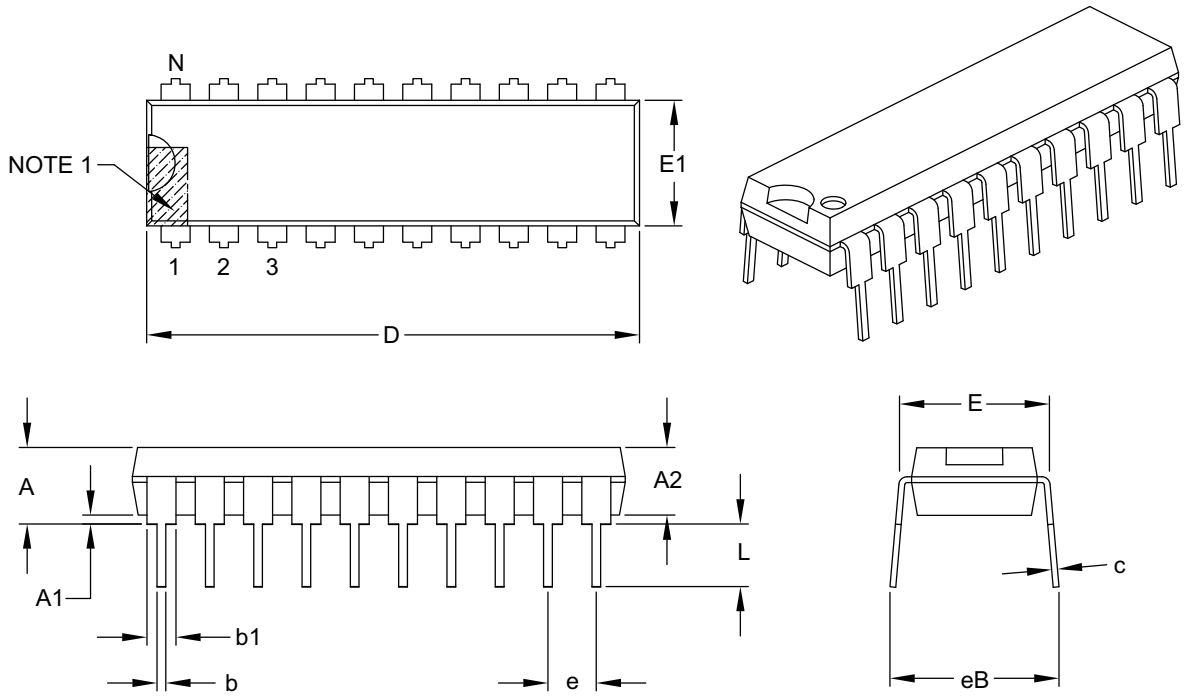
1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2051A

### 20-Lead Plastic Dual In-Line (P) – 300 mil Body [PDIP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging




| Units | | INCHES | | |
|---|---|---|---|---|
| Dimension Limits | | MIN | NOM | MAX |
| Number of Pins | N | | 20 | |
| Pitch | e | | .100 BSC | |
| Top to Seating Plane | A | – | – | .210 |
| Molded Package Thickness | A2 | .115 | .130 | .195 |
| Base to Seating Plane | A1 | .015 | – | – |
| Shoulder to Shoulder Width | E | .300 | .310 | .325 |
| Molded Package Width | E1 | .240 | .250 | .280 |
| Overall Length | D | .980 | 1.030 | 1.060 |
| Tip to Seating Plane | L | .115 | .130 | .150 |
| Lead Thickness | c | .008 | .010 | .015 |
| Upper Lead Width | b1 | .045 | .060 | .070 |
| Lower Lead Width | b | .014 | .018 | .022 |
| Overall Row Spacing § | eB | – | – | .430 |

**Notes:**

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. § Significant Characteristic.
3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" per side.
4. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-019B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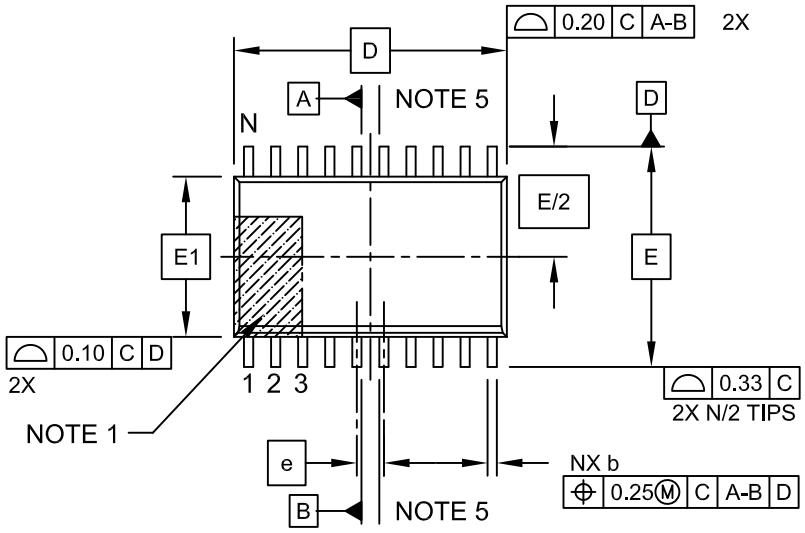
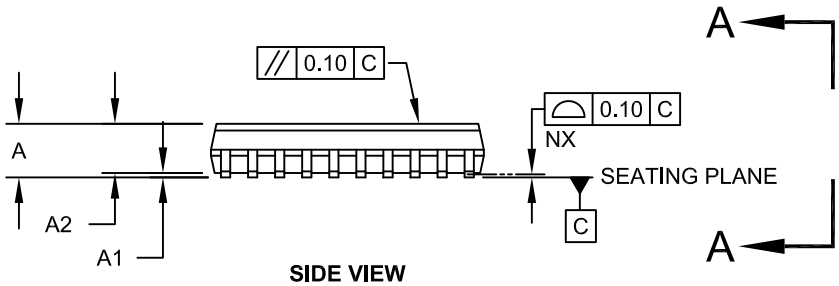
## 20-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

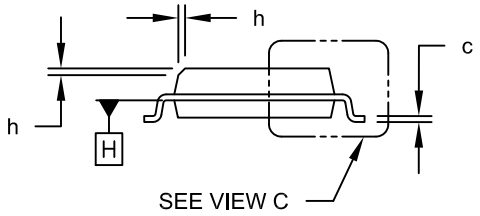
**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging




**TOP VIEW**




**SIDE VIEW**

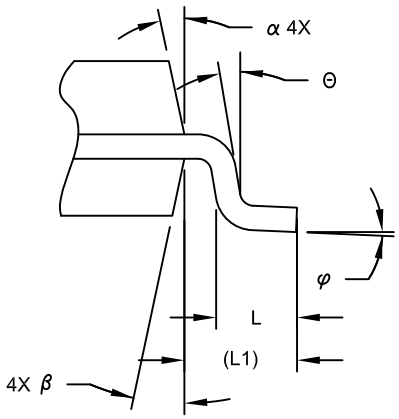



**VIEW A-A**

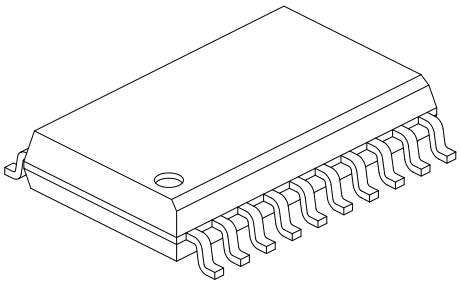
Microchip Technology Drawing C04-094C Sheet 1 of 2

## 20-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging




VIEW C



| Units | | MILLIMETERS | | |
|---|---|---|---|---|
| Dimension Limits | | MIN | NOM | MAX |
| Number of Pins | N | | 20 | |
| Pitch | e | | 1.27 BSC | |
| Overall Height | A | - | - | 2.65 |
| Molded Package Thickness | A2 | 2.05 | - | - |
| Standoff § | A1 | 0.10 | - | 0.30 |
| Overall Width | E | | 10.30 BSC | |
| Molded Package Width | E1 | | 7.50 BSC | |
| Overall Length | D | | 12.80 BSC | |
| Chamfer (Optional) | h | 0.25 | - | 0.75 |
| Foot Length | L | 0.40 | - | 1.27 |
| Footprint | L1 | | 1.40 REF | |
| Lead Angle | Θ | 0° | - | - |
| Foot Angle | φ | 0° | - | 8° |
| Lead Thickness | c | 0.20 | - | 0.33 |
| Lead Width | b | 0.31 | - | 0.51 |
| Mold Draft Angle Top | α | 5° | - | 15° |
| Mold Draft Angle Bottom | β | 5° | - | 15° |

**Notes:**

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. § Significant Characteristic
3. Dimension D does not include mold flash, protrusions or gate burrs, which shall not exceed 0.15 mm per end. Dimension E1 does not include interlead flash or protrusion, which shall not exceed 0.25 mm per side.
4. Dimensioning and tolerancing per ASME Y14.5M

   BSC: Basic Dimension. Theoretically exact value shown without tolerances.

   REF: Reference Dimension, usually without tolerance, for information purposes only.
5. Datums A & B to be determined at Datum H.

Microchip Technology Drawing No. C04-094C Sheet 2 of 2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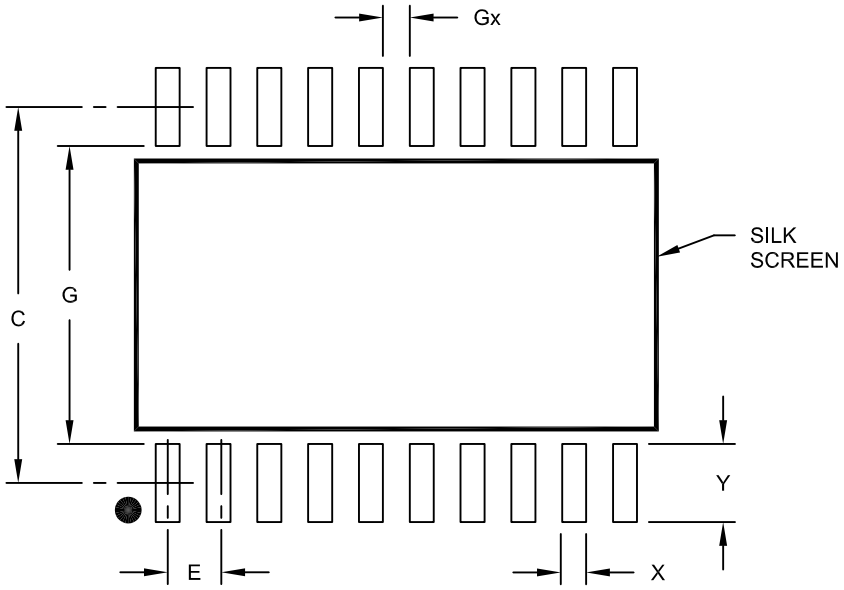
20-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging




RECOMMENDED LAND PATTERN

| Units | | MILLIMETERS | | |
|---|---|---|---|---|
| Dimension Limits | | MIN | NOM | MAX |
| Contact Pitch | E | 1.27 BSC | | |
| Contact Pad Spacing | C | | 9.40 | |
| Contact Pad Width (X20) | X | | | 0.60 |
| Contact Pad Length (X20) | Y | | | 1.95 |
| Distance Between Pads | Gx | 0.67 | | |
| Distance Between Pads | G | 7.45 | | |

Notes:

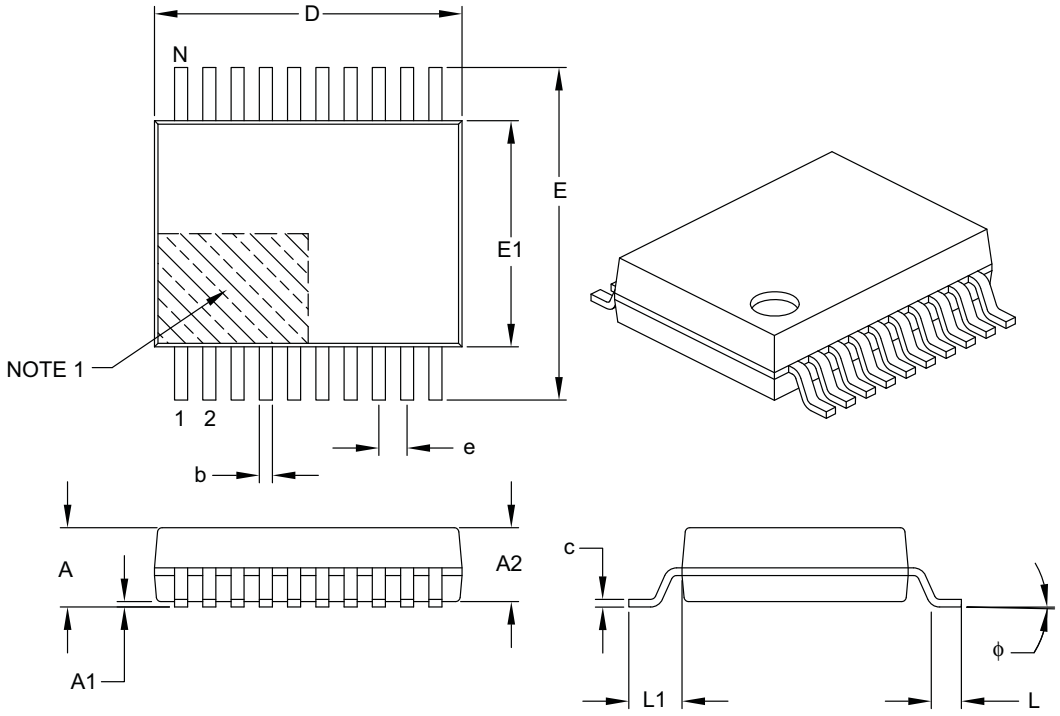
1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2094A

### 20-Lead Plastic Shrink Small Outline (SS) – 5.30 mm Body [SSOP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging




| Units | | MILLIMETERS | | |
|---|---|---|---|---|
| Dimension Limits | | MIN | NOM | MAX |
| Number of Pins | N | | 20 | |
| Pitch | e | | 0.65 BSC | |
| Overall Height | A | – | – | 2.00 |
| Molded Package Thickness | A2 | 1.65 | 1.75 | 1.85 |
| Standoff | A1 | 0.05 | – | – |
| Overall Width | E | 7.40 | 7.80 | 8.20 |
| Molded Package Width | E1 | 5.00 | 5.30 | 5.60 |
| Overall Length | D | 6.90 | 7.20 | 7.50 |
| Foot Length | L | 0.55 | 0.75 | 0.95 |
| Footprint | L1 | | 1.25 REF | |
| Lead Thickness | c | 0.09 | – | 0.25 |
| Foot Angle | ϕ | 0° | 4° | 8° |
| Lead Width | b | 0.22 | – | 0.38 |

**Notes:**

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.20 mm per side.
3. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.
REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-072B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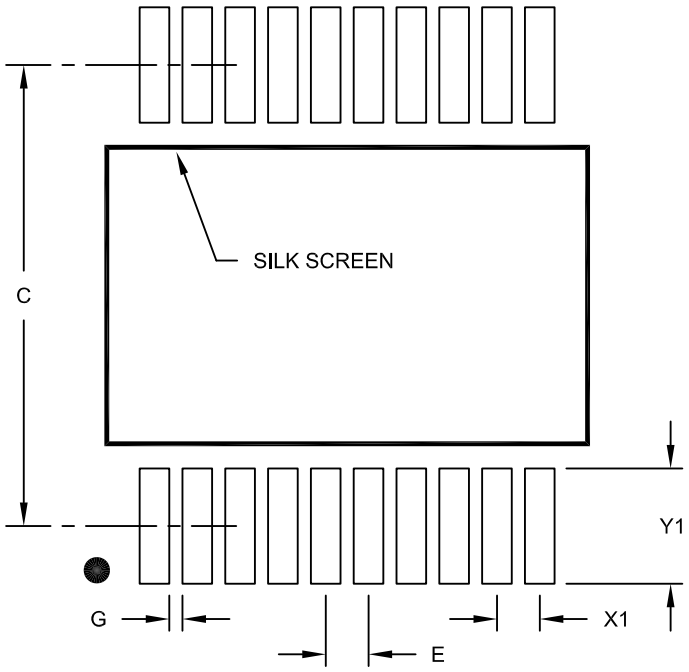
20-Lead Plastic Shrink Small Outline (SS) - 5.30 mm Body [SSOP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging




RECOMMENDED LAND PATTERN

| Units | | MILLIMETERS | | |
|---|---|---|---|---|
| Dimension Limits | | MIN | NOM | MAX |
| Contact Pitch | E | | 0.65 BSC | |
| Contact Pad Spacing | C | | 7.20 | |
| Contact Pad Width (X20) | X1 | | | 0.45 |
| Contact Pad Length (X20) | Y1 | | | 1.75 |
| Distance Between Pads | G | 0.20 | | |

Notes:

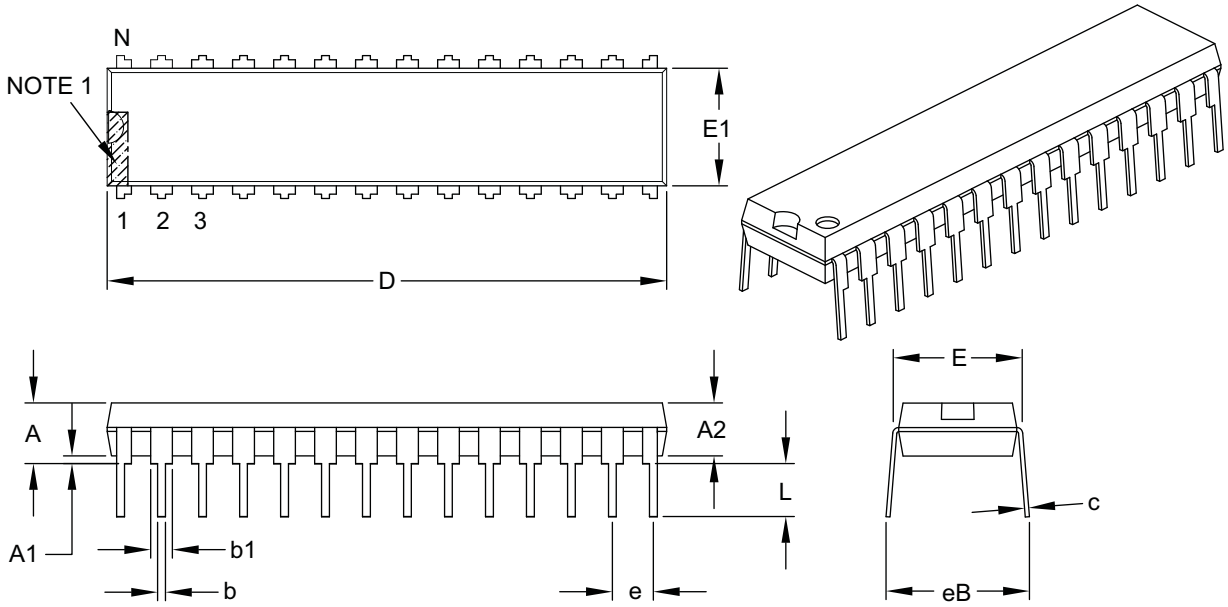
1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2072A

### 28-Lead Skinny Plastic Dual In-Line (SP) – 300 mil Body [SPDIP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging




| Units | | INCHES | | |
|---|---|---|---|---|
| Dimension Limits | | MIN | NOM | MAX |
| Number of Pins | N | | 28 | |
| Pitch | e | | .100 BSC | |
| Top to Seating Plane | A | – | – | .200 |
| Molded Package Thickness | A2 | .120 | .135 | .150 |
| Base to Seating Plane | A1 | .015 | – | – |
| Shoulder to Shoulder Width | E | .290 | .310 | .335 |
| Molded Package Width | E1 | .240 | .285 | .295 |
| Overall Length | D | 1.345 | 1.365 | 1.400 |
| Tip to Seating Plane | L | .110 | .130 | .150 |
| Lead Thickness | c | .008 | .010 | .015 |
| Upper Lead Width | b1 | .040 | .050 | .070 |
| Lower Lead Width | b | .014 | .018 | .022 |
| Overall Row Spacing § | eB | – | – | .430 |

**Notes:**

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. § Significant Characteristic.
3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" per side.
4. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-070B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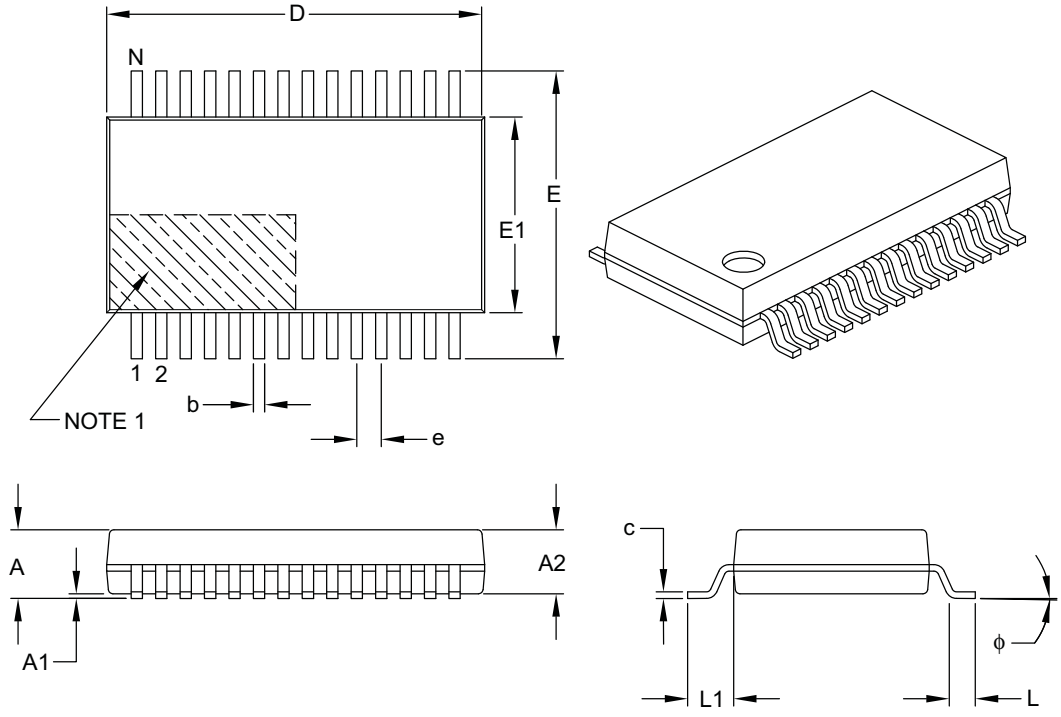
### 28-Lead Plastic Shrink Small Outline (SS) – 5.30 mm Body [SSOP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging




| Units | | MILLIMETERS | | |
|---|---|---|---|---|
| Dimension Limits | | MIN | NOM | MAX |
| Number of Pins | N | | 28 | |
| Pitch | e | | 0.65 BSC | |
| Overall Height | A | – | – | 2.00 |
| Molded Package Thickness | A2 | 1.65 | 1.75 | 1.85 |
| Standoff | A1 | 0.05 | – | – |
| Overall Width | E | 7.40 | 7.80 | 8.20 |
| Molded Package Width | E1 | 5.00 | 5.30 | 5.60 |
| Overall Length | D | 9.90 | 10.20 | 10.50 |
| Foot Length | L | 0.55 | 0.75 | 0.95 |
| Footprint | L1 | | 1.25 REF | |
| Lead Thickness | c | 0.09 | – | 0.25 |
| Foot Angle | ϕ | 0° | 4° | 8° |
| Lead Width | b | 0.22 | – | 0.38 |

**Notes:**

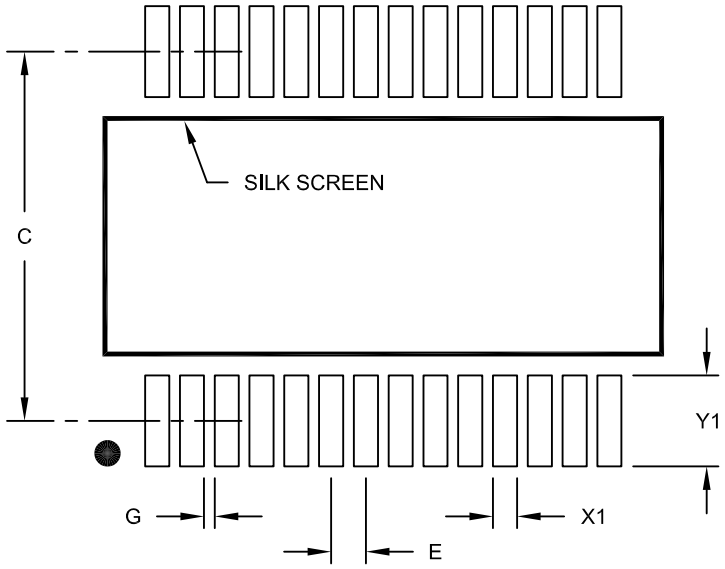
1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.20 mm per side.
3. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.
REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-073B

28-Lead Plastic Shrink Small Outline (SS) - 5.30 mm Body [SSOP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging




RECOMMENDED LAND PATTERN

| Units | | MILLIMETERS | | |
|---|---|---|---|---|
| Dimension Limits | | MIN | NOM | MAX |
| Contact Pitch | E | 0.65 BSC | | |
| Contact Pad Spacing | C | | 7.20 | |
| Contact Pad Width (X28) | X1 | | | 0.45 |
| Contact Pad Length (X28) | Y1 | | | 1.75 |
| Distance Between Pads | G | 0.20 | | |

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2073A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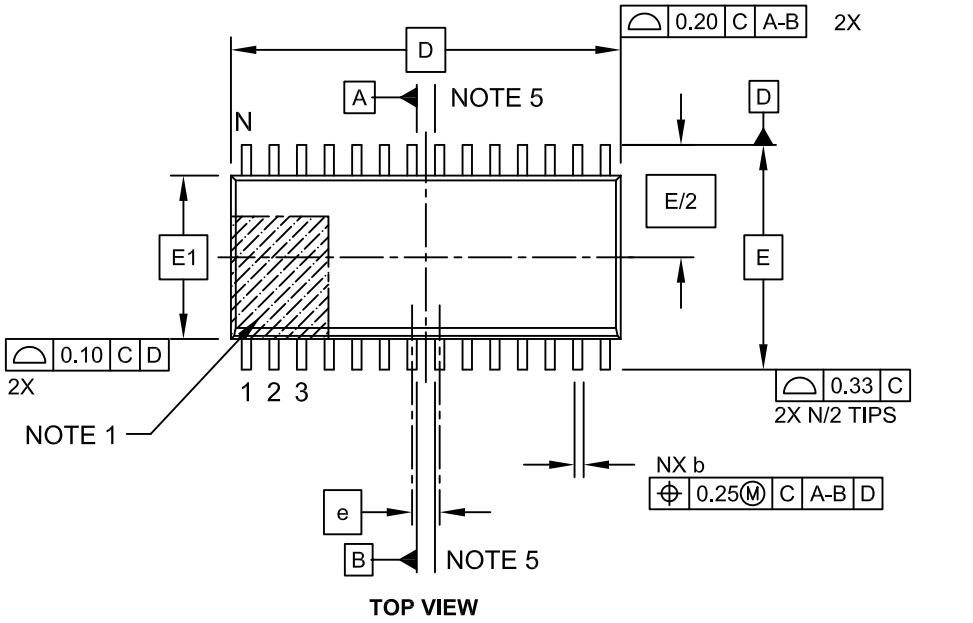
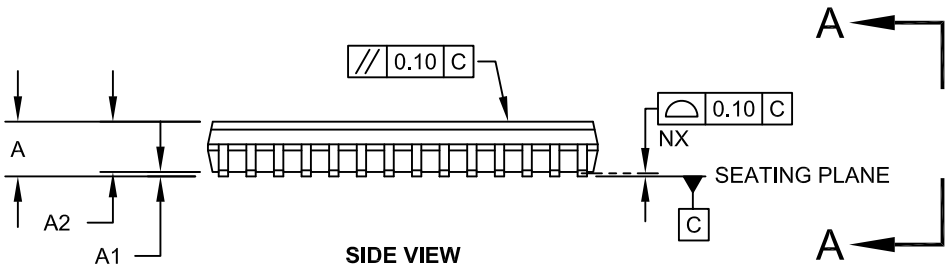
### 28-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

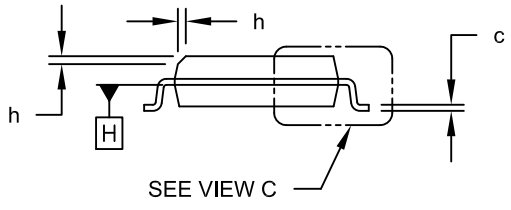
**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging




**TOP VIEW**




**SIDE VIEW**

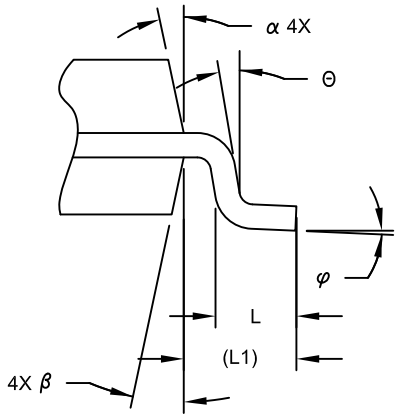



**VIEW A-A**

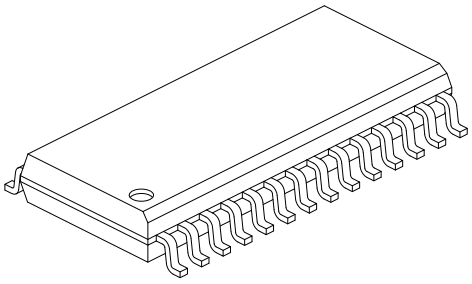
Microchip Technology Drawing C04-052C Sheet 1 of 2

## 28-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging




VIEW C



| Units | | MILLIMETERS | | |
|---|---|---|---|---|
| Dimension Limits | | MIN | NOM | MAX |
| Number of Pins | N | | 28 | |
| Pitch | e | | 1.27 BSC | |
| Overall Height | A | - | - | 2.65 |
| Molded Package Thickness | A2 | 2.05 | - | - |
| Standoff § | A1 | 0.10 | - | 0.30 |
| Overall Width | E | | 10.30 BSC | |
| Molded Package Width | E1 | | 7.50 BSC | |
| Overall Length | D | | 17.90 BSC | |
| Chamfer (Optional) | h | 0.25 | - | 0.75 |
| Foot Length | L | 0.40 | - | 1.27 |
| Footprint | L1 | | 1.40 REF | |
| Lead Angle | Θ | 0° | - | - |
| Foot Angle | φ | 0° | - | 8° |
| Lead Thickness | c | 0.18 | - | 0.33 |
| Lead Width | b | 0.31 | - | 0.51 |
| Mold Draft Angle Top | α | 5° | - | 15° |
| Mold Draft Angle Bottom | β | 5° | - | 15° |

**Notes:**

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. § Significant Characteristic
3. Dimension D does not include mold flash, protrusions or gate burrs, which shall not exceed 0.15 mm per end. Dimension E1 does not include interlead flash or protrusion, which shall not exceed 0.25 mm per side.
4. Dimensioning and tolerancing per ASME Y14.5M

   BSC: Basic Dimension. Theoretically exact value shown without tolerances.

   REF: Reference Dimension, usually without tolerance, for information purposes only.
5. Datums A & B to be determined at Datum H.

Microchip Technology Drawing C04-052C Sheet 2 of 2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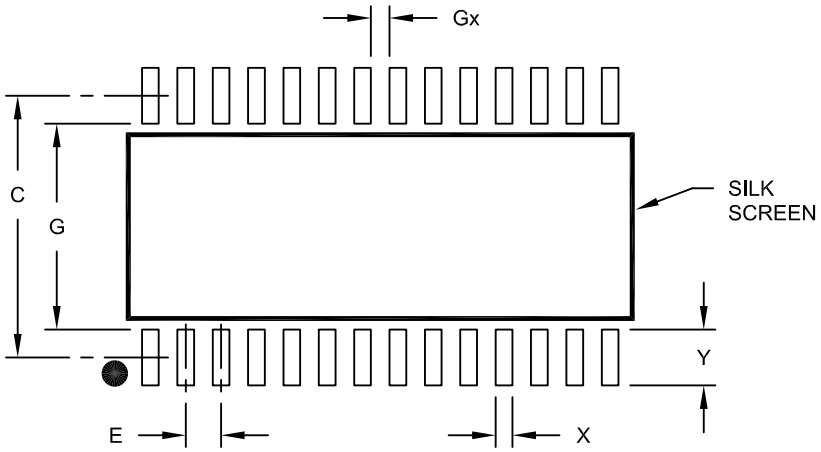
28-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging




RECOMMENDED LAND PATTERN

| Units | | MILLIMETERS | | |
|---|---|---|---|---|
| Dimension Limits | | MIN | NOM | MAX |
| Contact Pitch | E | | 1.27 BSC | |
| Contact Pad Spacing | C | | 9.40 | |
| Contact Pad Width (X28) | X | | | 0.60 |
| Contact Pad Length (X28) | Y | | | 2.00 |
| Distance Between Pads | Gx | 0.67 | | |
| Distance Between Pads | G | 7.40 | | |

Notes:

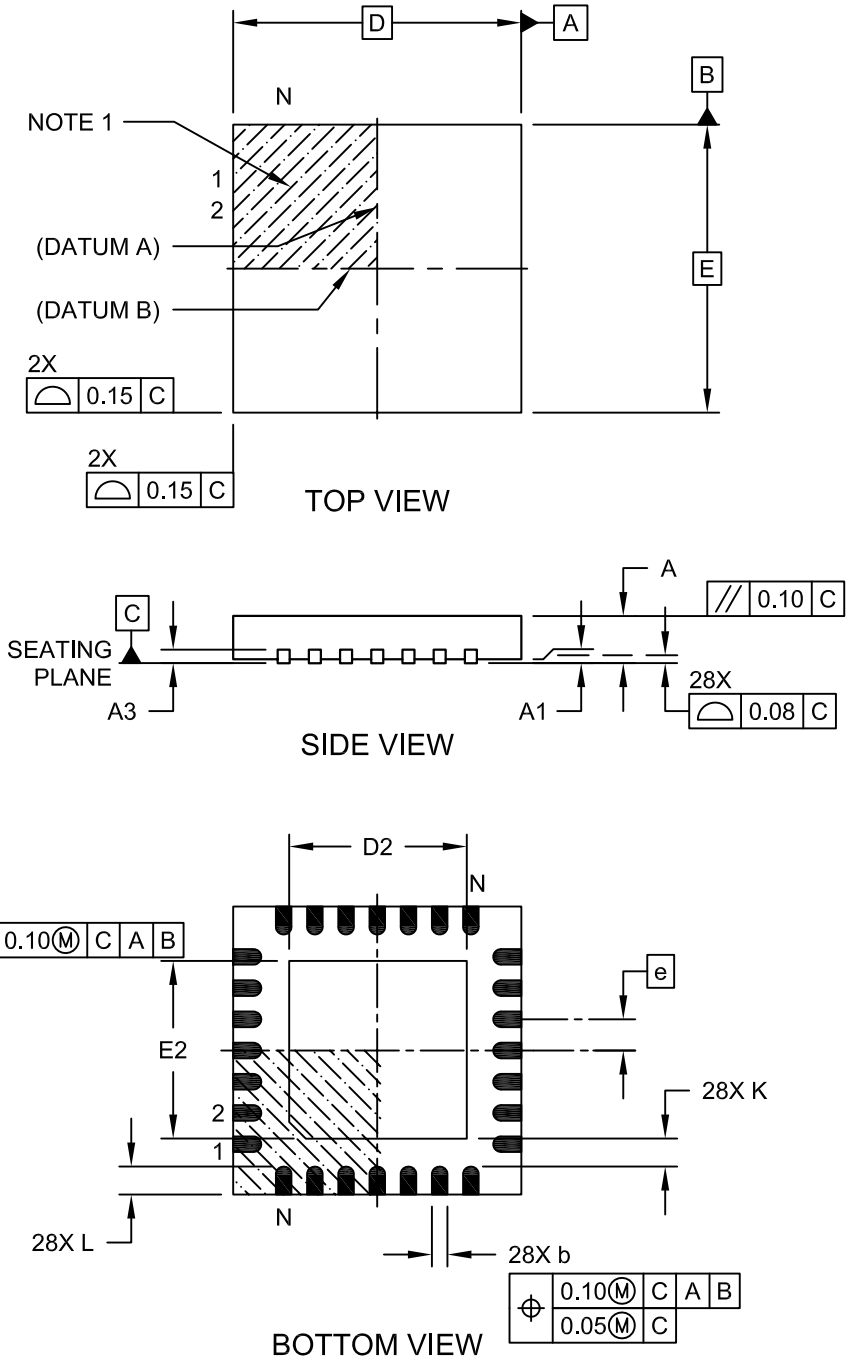
1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2052A

**28-Lead Plastic Quad Flat, No Lead Package (ML) - 6x6 mm Body [QFN]**
**With 0.55 mm Terminal Length**

| **Note:** | For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging |
|---|---|




Microchip Technology Drawing C04-105C Sheet 1 of 2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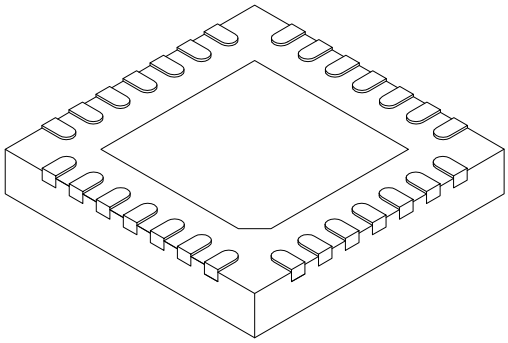
## 28-Lead Plastic Quad Flat, No Lead Package (ML) - 6x6 mm Body [QFN] With 0.55 mm Terminal Length

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



| | Units | MILLIMETERS | | |
|---|---|---|---|---|
| Dimension | Limits | MIN | NOM | MAX |
| Number of Pins | N | | 28 | |
| Pitch | e | | 0.65 BSC | |
| Overall Height | A | 0.80 | 0.90 | 1.00 |
| Standoff | A1 | 0.00 | 0.02 | 0.05 |
| Terminal Thickness | A3 | | 0.20 REF | |
| Overall Width | E | | 6.00 BSC | |
| Exposed Pad Width | E2 | 3.65 | 3.70 | 4.20 |
| Overall Length | D | | 6.00 BSC | |
| Exposed Pad Length | D2 | 3.65 | 3.70 | 4.20 |
| Terminal Width | b | 0.23 | 0.30 | 0.35 |
| Terminal Length | L | 0.50 | 0.55 | 0.70 |
| Terminal-to-Exposed Pad | K | 0.20 | - | - |

**Notes:**

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Package is saw singulated
3. Dimensioning and tolerancing per ASME Y14.5M.

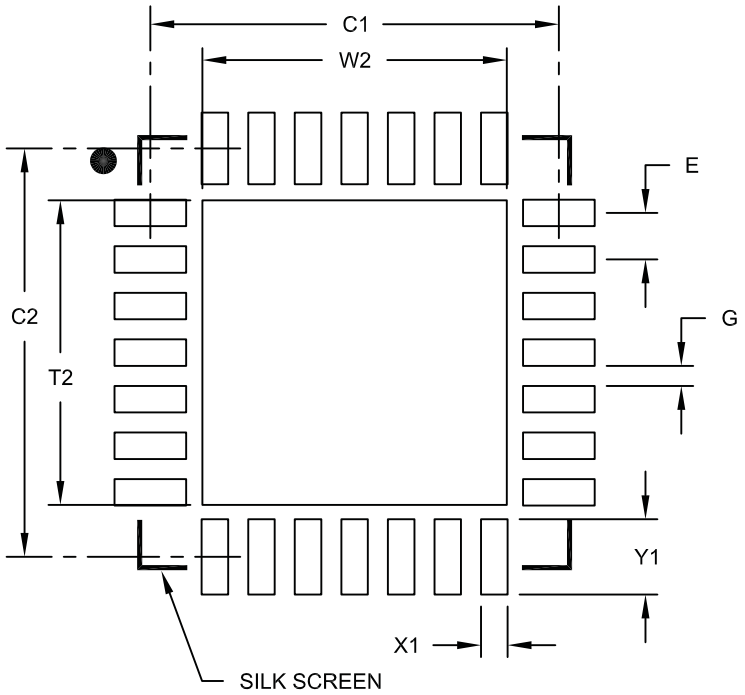
   BSC: Basic Dimension. Theoretically exact value shown without tolerances.

   REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-105C Sheet 2 of 2

### 28-Lead Plastic Quad Flat, No Lead Package (ML) – 6x6 mm Body [QFN] with 0.55 mm Contact Length

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging




RECOMMENDED LAND PATTERN

| Units | | MILLIMETERS | | |
|---|---|---|---|---|
| Dimension Limits | | MIN | NOM | MAX |
| Contact Pitch | E | | 0.65 BSC | |
| Optional Center Pad Width | W2 | | | 4.25 |
| Optional Center Pad Length | T2 | | | 4.25 |
| Contact Pad Spacing | C1 | | 5.70 | |
| Contact Pad Spacing | C2 | | 5.70 | |
| Contact Pad Width (X28) | X1 | | | 0.37 |
| Contact Pad Length (X28) | Y1 | | | 1.00 |
| Distance Between Pads | G | 0.20 | | |

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2105A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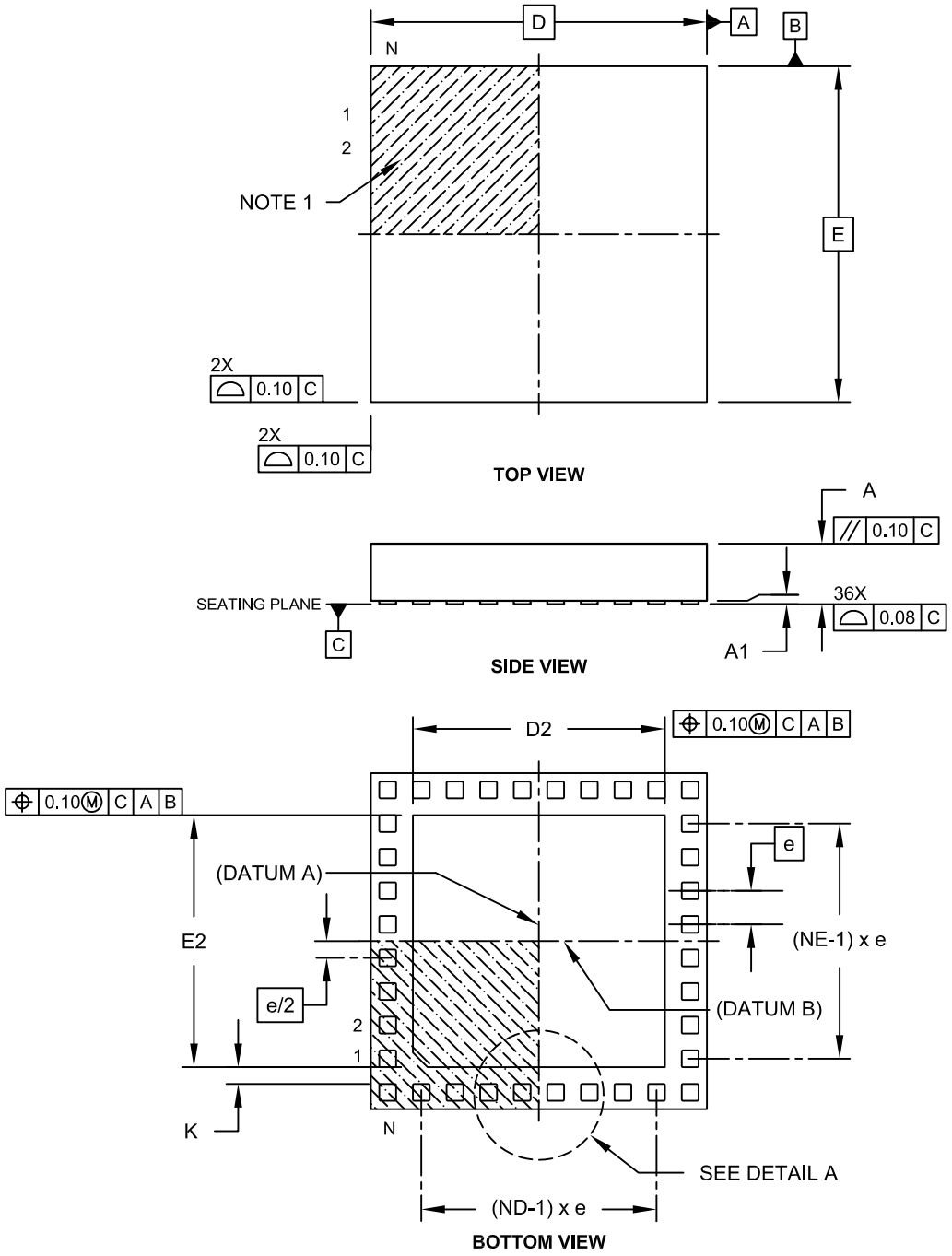
## 36-Terminal Very Thin Thermal Leadless Array Package (TL) – 5x5x0.9 mm Body with Exposed Pad [VTLA]

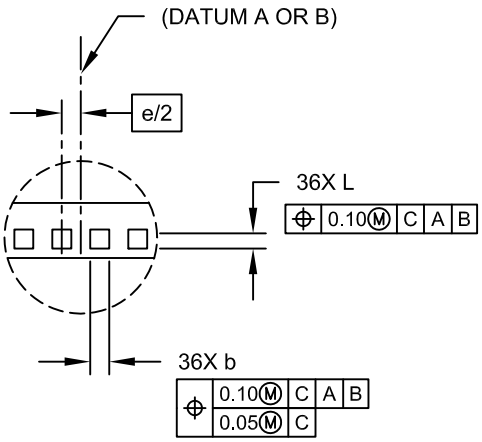
**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



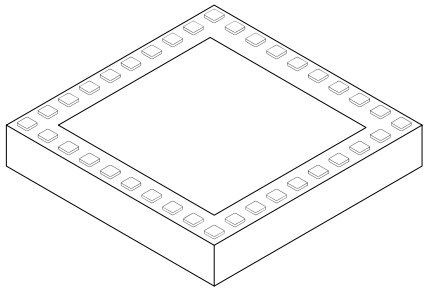

Microchip Technology Drawing C04-187C Sheet 1 of 2

## 36-Terminal Very Thin Thermal Leadless Array Package (TL) – 5x5x0.9 mm Body with Exposed Pad [VTLA]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging




**DETAIL A**



| Units | | MILLIMETERS | | |
|---|---|---|---|---|
| Dimension Limits | | MIN | NOM | MAX |
| Number of Pins | N | | 36 | |
| Number of Pins per Side | ND | | 10 | |
| Number of Pins per Side | NE | | 8 | |
| Pitch | e | | 0.50 BSC | |
| Overall Height | A | 0.80 | 0.90 | 1.00 |
| Standoff | A1 | 0.025 | - | 0.075 |
| Overall Width | E | | 5.00 BSC | |
| Exposed Pad Width | E2 | 3.60 | 3.75 | 3.90 |
| Overall Length | D | | 5.00 BSC | |
| Exposed Pad Length | D2 | 3.60 | 3.75 | 3.90 |
| Contact Width | b | 0.20 | 0.25 | 0.30 |
| Contact Length | L | 0.20 | 0.25 | 0.30 |
| Contact-to-Exposed Pad | K | 0.20 | - | - |

**Notes:**

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Package is saw singulated.
3. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.
REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-187C Sheet 2 of 2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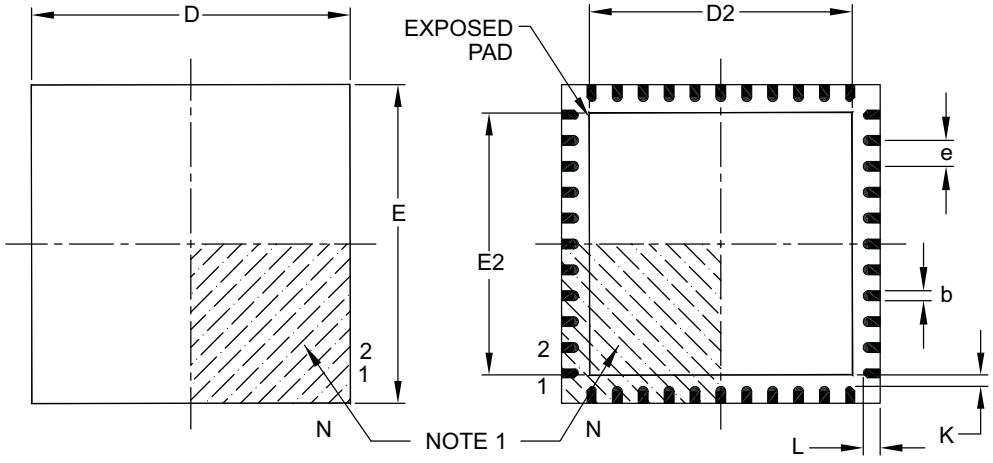
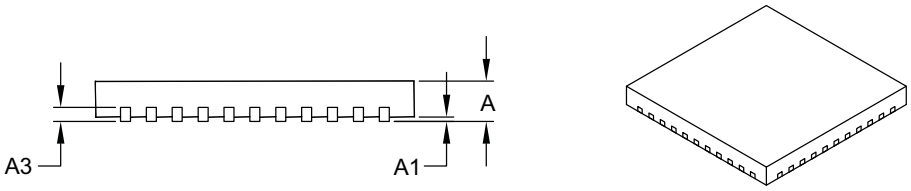
### 44-Lead Plastic Quad Flat, No Lead Package (ML) – 8x8 mm Body [QFN]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging




**TOP VIEW** **BOTTOM VIEW**




| Units | | MILLIMETERS | | |
|---|---|---|---|---|
| Dimension Limits | | MIN | NOM | MAX |
| Number of Pins | N | | 44 | |
| Pitch | e | | 0.65 BSC | |
| Overall Height | A | 0.80 | 0.90 | 1.00 |
| Standoff | A1 | 0.00 | 0.02 | 0.05 |
| Contact Thickness | A3 | | 0.20 REF | |
| Overall Width | E | | 8.00 BSC | |
| Exposed Pad Width | E2 | 6.30 | 6.45 | 6.80 |
| Overall Length | D | | 8.00 BSC | |
| Exposed Pad Length | D2 | 6.30 | 6.45 | 6.80 |
| Contact Width | b | 0.25 | 0.30 | 0.38 |
| Contact Length | L | 0.30 | 0.40 | 0.50 |
| Contact-to-Exposed Pad | K | 0.20 | – | – |

**Notes:**

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Package is saw singulated.
3. Dimensioning and tolerancing per ASME Y14.5M.

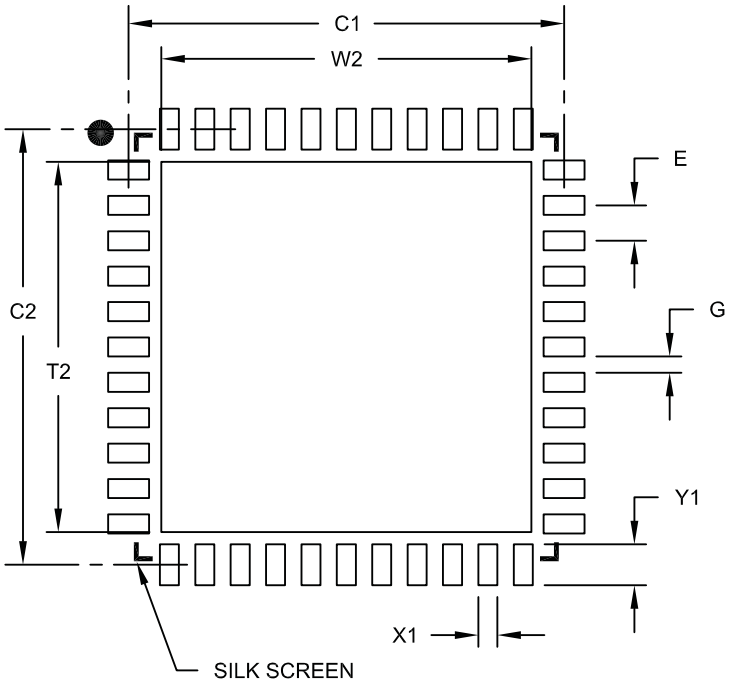
   BSC: Basic Dimension. Theoretically exact value shown without tolerances.

   REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-103B

### 44-Lead Plastic Quad Flat, No Lead Package (ML) – 8x8 mm Body [QFN]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging




RECOMMENDED LAND PATTERN

| Units | | MILLIMETERS | | |
|---|---|---|---|---|
| Dimension Limits | | MIN | NOM | MAX |
| Contact Pitch | E | | 0.65 BSC | |
| Optional Center Pad Width | W2 | | | 6.80 |
| Optional Center Pad Length | T2 | | | 6.80 |
| Contact Pad Spacing | C1 | | 8.00 | |
| Contact Pad Spacing | C2 | | 8.00 | |
| Contact Pad Width (X44) | X1 | | | 0.35 |
| Contact Pad Length (X44) | Y1 | | | 0.80 |
| Distance Between Pads | G | 0.25 | | |

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2103A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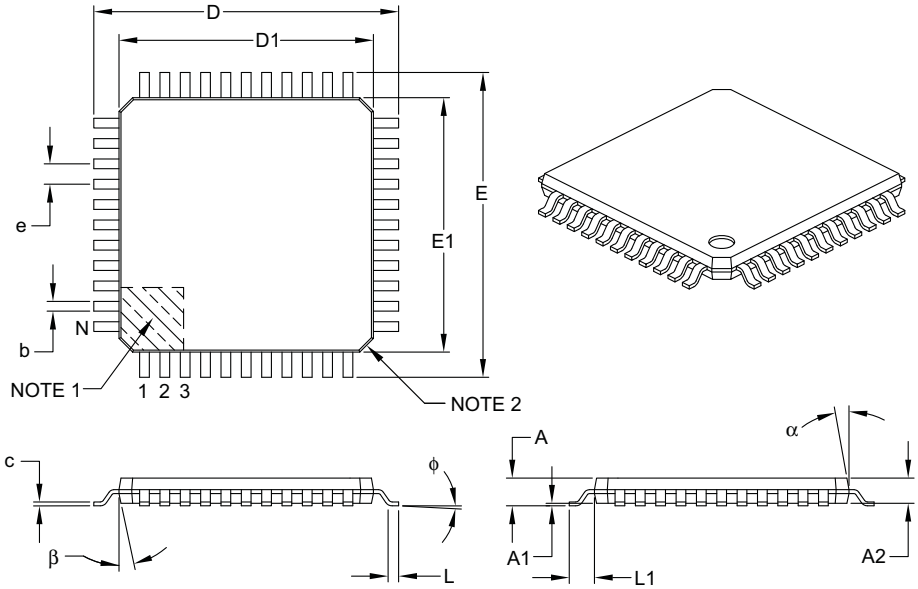
### 44-Lead Plastic Thin Quad Flatpack (PT) – 10x10x1 mm Body, 2.00 mm [TQFP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging




| Units | | MILLIMETERS | | |
|---|---|---|---|---|
| Dimension Limits | | MIN | NOM | MAX |
| Number of Leads | N | | 44 | |
| Lead Pitch | e | | 0.80 BSC | |
| Overall Height | A | – | – | 1.20 |
| Molded Package Thickness | A2 | 0.95 | 1.00 | 1.05 |
| Standoff | A1 | 0.05 | – | 0.15 |
| Foot Length | L | 0.45 | 0.60 | 0.75 |
| Footprint | L1 | | 1.00 REF | |
| Foot Angle | φ | 0° | 3.5° | 7° |
| Overall Width | E | | 12.00 BSC | |
| Overall Length | D | | 12.00 BSC | |
| Molded Package Width | E1 | | 10.00 BSC | |
| Molded Package Length | D1 | | 10.00 BSC | |
| Lead Thickness | c | 0.09 | – | 0.20 |
| Lead Width | b | 0.30 | 0.37 | 0.45 |
| Mold Draft Angle Top | α | 11° | 12° | 13° |
| Mold Draft Angle Bottom | β | 11° | 12° | 13° |

**Notes:**

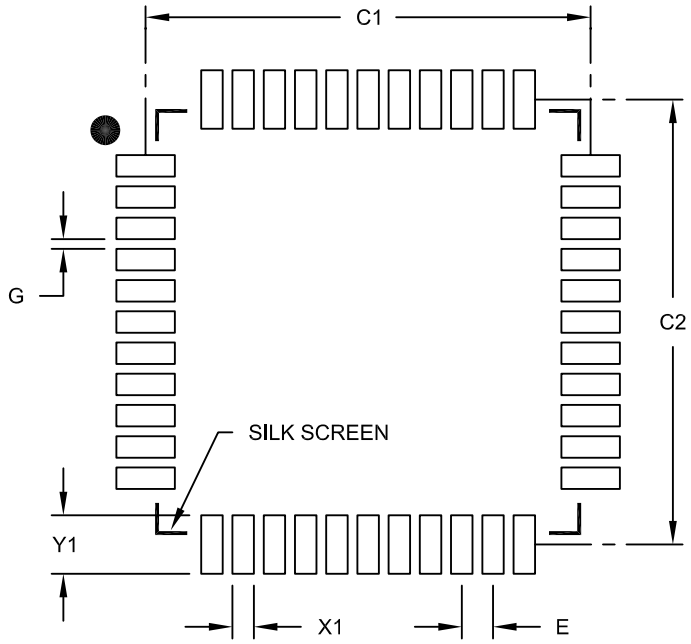
1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Chamfers at corners are optional; size may vary.
3. Dimensions D1 and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.25 mm per side.
4. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.
REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-076B

44-Lead Plastic Thin Quad Flatpack (PT) 10X10X1 mm Body, 2.00 mm Footprint [TQFP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging




RECOMMENDED LAND PATTERN

| Units | | MILLIMETERS | | |
|---|---|---|---|---|
| Dimension Limits | | MIN | NOM | MAX |
| Contact Pitch | E | | 0.80 BSC | |
| Contact Pad Spacing | C1 | | 11.40 | |
| Contact Pad Spacing | C2 | | 11.40 | |
| Contact Pad Width (X44) | X1 | | | 0.55 |
| Contact Pad Length (X44) | Y1 | | | 1.50 |
| Distance Between Pads | G | 0.25 | | |

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2076B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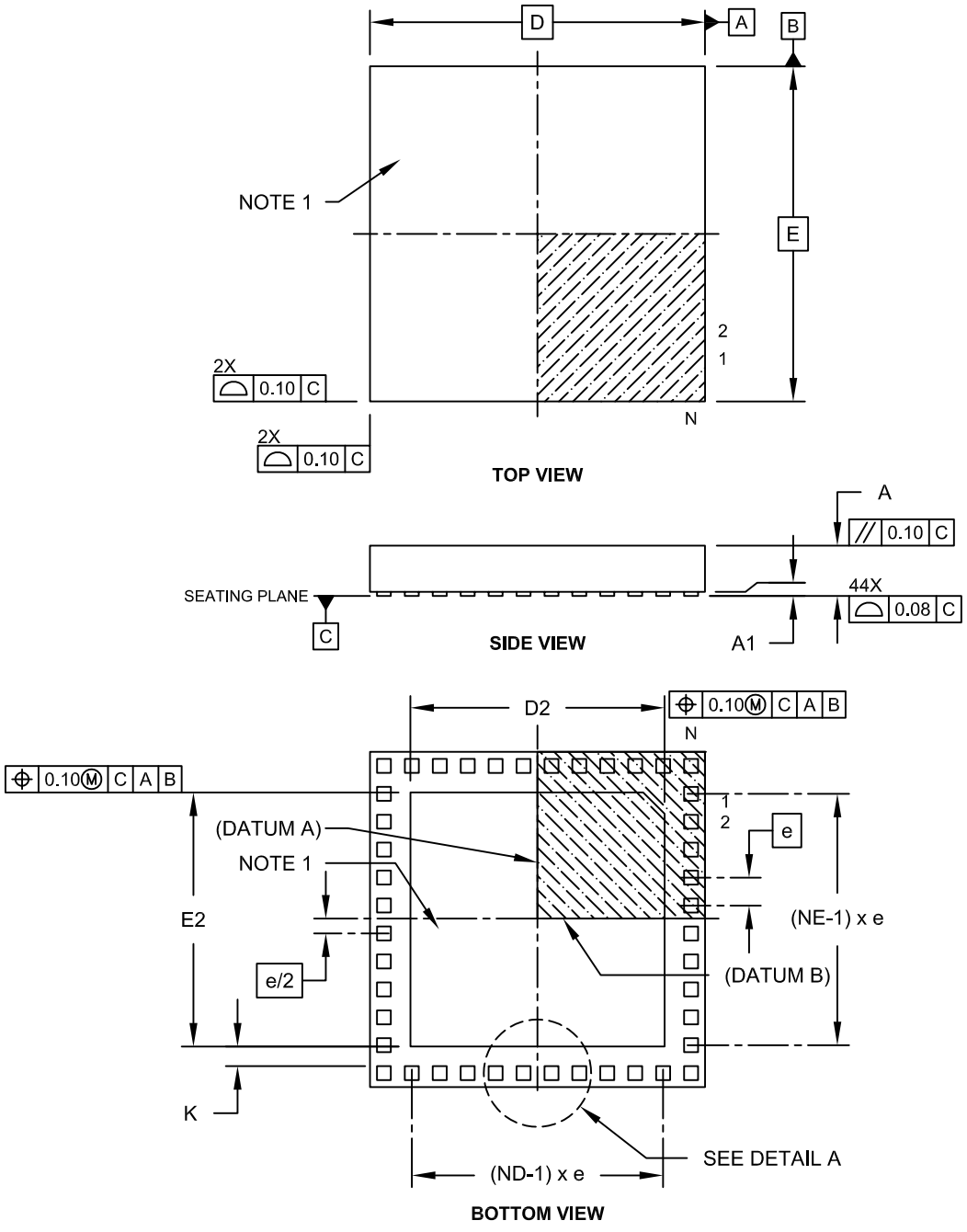
## 44-Terminal Very Thin Leadless Array Package (TL) – 6x6x0.9 mm Body With Exposed Pad [VTLA]

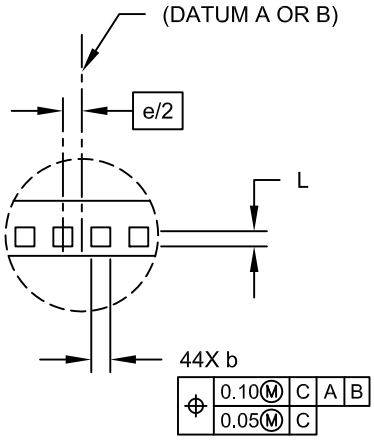
**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



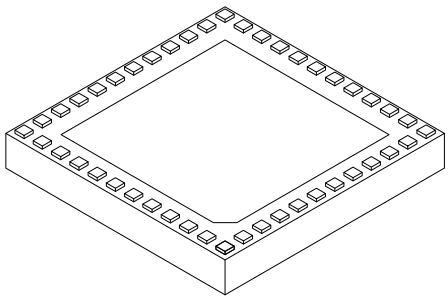

Microchip Technology Drawing C04-157C Sheet 1 of 2

## 44-Terminal Very Thin Leadless Array Package (TL) – 6x6x0.9 mm Body With Exposed Pad [VTLA]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging




**DETAIL A**



| Units | | MILLIMETERS | | |
|---|---|---|---|---|
| Dimension | Limits | MIN | NOM | MAX |
| Number of Pins | N | | 44 | |
| Number of Pins per Side | ND | | 12 | |
| Number of Pins per Side | NE | | 10 | |
| Pitch | e | | 0.50 BSC | |
| Overall Height | A | 0.80 | 0.90 | 1.00 |
| Standoff | A1 | 0.025 | - | 0.075 |
| Overall Width | E | | 6.00 BSC | |
| Exposed Pad Width | E2 | 4.40 | 4.55 | 4.70 |
| Overall Length | D | | 6.00 BSC | |
| Exposed Pad Length | D2 | 4.40 | 4.55 | 4.70 |
| Contact Width | b | 0.20 | 0.25 | 0.30 |
| Contact Length | L | 0.20 | 0.25 | 0.30 |
| Contact-to-Exposed Pad | K | 0.20 | - | - |

**Notes:**

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Package is saw singulated.
3. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.
REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-157C Sheet 2 of 2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# APPENDIX A: REVISION HISTORY

## Revision A (January 2011)

This is the initial released version of the document.

## Revision B (February 2011)

All major changes are referenced by their respective section in Table A-1.

In addition, minor text and formatting changes were incorporated throughout the document.

**TABLE A-1: MAJOR SECTION UPDATES**

| Section Name | Update Description |
|---|---|
| **High-Performance, Ultra Low Cost 16-bit Digital Signal Controllers** | Pin diagram updates (see **"Pin Diagrams"**):<br>• 20-pin PDIP/SOIC/SSOP (dsPIC33FJ16MC101): Removed the FLTB1 pin from pin 10<br>• 28-pin SPDIP/SOIC/SSOP (dsPIC33FJ16MC102): Relocated the FLTB1 pin from pin 12 to pin 14; relocated the FLTA1 pin from pin 16 to pin 15<br>• 28-pin QFN (dsPIC33FJ16MC102): Relocated the FLTA1 pin from pin 13 to pin 12; relocated the FLTB1 pin from pin 9 to pin 11<br>• 36-pin TLA (dsPIC33FJ16MC102): Relocated the FLTA1 pin from pin 17 to pin 16; relocated the FLTB1 pin from pin 10 to pin 15 |
| **Section 1.0 "Device Overview"** | Added Notes 1, 2, and 3 regarding the FLTA1 and FLTB1 pins to the Pinout I/O Descriptions (see Table 1-1).<br><br>Added **Section "".** |
| **Section 4.0 "Memory Organization"** | Updated All Resets value for PxFLTACON and PxFLTABCON to the 6-Output PWM1 Register Map (see Table 4-9).<br><br>Added Note 1 to the PMD Register Map (see Table 4-29). |
| **Section 6.0 "Resets"** | Removed Reset timing sequence information from **Section 6.2 "System Reset"**, as this information is provided in Figure 6-2. |
| **Section 15.0 "Motor Control PWM Module"** | Added Note 2 and Note 3 regarding the FLTA1 and FLTB1 pins to the 6-channel PWM Module Block Diagram (see Figure 15-1).<br><br>Added **Section 15.2 "PWM Faults"** and **Section 15.3 "Write-protected Registers"**.<br><br>Added Note 2 and Note 3 regarding the FLTA1 and FLTB1 pins to the note boxes located below the PxFLTACON and PxFLTBCON registers (see Register 15-9 and Register 15-10). |
| **Section 17.0 "Inter-Integrated Circuit™ ($I^2C$™)"** | Updated the descriptions for the conditional If STREN = 1 and If STREN = 0 statements for the SCLREL bit in the I2Cx Control Register (see Register 17-1). |
| **Section 23.0 "Special Features"** | Added the RTSP Effect column to the dsPIC33F Configuration Bits Description (see Table 23-3). |
| **Section 26.0 "Electrical Characteristics"** | Added Parameters 300 and D305 (see Table 26-42 and Table 26-43). |
| **Section 27.0 "Packaging Information"** | Modified the pending TLA packaging page. |

## Revision C (June 2011)

This revision includes the following global update:

- All JTAG references have been removed

All other major changes are referenced by their respective section in Table A-2.

In addition, minor text and formatting changes were incorporated throughout the document.

**TABLE A-2: MAJOR SECTION UPDATES**

| Section Name | Update Description |
|---|---|
| **High-Performance, Ultra Low Cost 16-bit Digital Signal Controllers** | The TMS, TDI, TDO, and TCK pin names were removed from these pin diagrams:<br>• 28-pin SPDIP/SOIC/SSOP<br>• 28-pin QFN<br>• 36-pin TLA |
| **Section 1.0 “Device Overview”** | Updated the Buffer Type to Digital for the CTED1 and CTED2 pins (see Table 1-1). |
| **Section 4.0 “Memory Organization”** | Updated the SFR Address for IC2CON, IC3BUF, and IC3CON in the Input Capture Register Map (see Table 4-7).<br><br>Added the VREGS bit to the RCON register in the System Control Register Map (see Table 4-27). |
| **Section 6.0 “Resets”** | Added the VREGS bit to the RCON register (see Register 6-1). |
| **Section 8.0 “Oscillator Configuration”** | Updated the definition for COSC<2:0> = 001 and NOSC<2:0> = 001 in the OSCCON register (see Register 8-1). |
| **Section 15.0 “Motor Control PWM Module”** | Updated the title for Example 15-1 to include a reference to the Assembly language.<br><br>Added Example 15-2, which provides a C code version of the write-protected register unlock and Fault clearing sequence. |
| **Section 19.0 “10-bit Analog-to-Digital Converter (ADC)”** | Updated the CH0 section and added Note 2 in both ADC block diagrams (see Figure 19-1 and Figure 19-2).<br><br>Updated the multiplexer values in the ADC Conversion Clock Period Block Diagram (see Figure 19-3.<br><br>Added the 01110 bit definitions and updated the 01101 bit definitions for the CH0SB<4:0> and CH0SA<4:0> bits in the AD1CHS0 register (see Register 19-5). |
| **Section 22.0 “Charge Time Measurement Unit (CTMU)”** | Removed Section 22.1 “Measuring Capacitance”, Section 22.2 “Measuring Time”, and Section 22.3 “Pulse Generation and Delay”<br><br>Updated the key features.<br><br>Added the CTMU Block Diagram (see Figure 22-1).<br><br>Updated the ITRIM<5:0> bit definitions and added Note 1 to the CTMU Current Control register (see Register 22-3). |


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**TABLE A-2: MAJOR SECTION UPDATES (CONTINUED)**

| Section Name | Update Description |
|---|---|
| **Section 23.0 "Special Features"** | Updated bits 5 and 4 of FPOR, modified Note 2, and removed Note 3 from the Configuration Shadow Register Map (see Table 23-1).<br><br>Updated bit 14 of CONFIG1 and removed Note 5 from the Configuration Flash Words (see Table 23-2).<br><br>Updated the PLLKEN Configuration bit description (see Table 23-3).<br><br>Added Note 3 to Connections for the On-Chip Voltage Regulator (see Figure 23-1). |
| **Section 26.0 "Electrical Characteristics"** | Updated the Standard Operating Conditions to: 3.0V to 3.6V in all tables.<br><br>Removed the Voltage on $V_{CAP}$ with respect to $V_{SS}$ entry in Absolute Maximum Ratings(1).<br><br>Updated the $V_{DD}$ Range (in Volts) in Operating MIPS vs. Voltage (see Table 26-1).<br><br>Removed Parameter DC18 and updated the minimum value for Parameter DC 10 in the DC Temperature and Voltage Specifications (see Table 26-4).<br><br>Updated the Characteristic definition and the Typical value for Parameter BO10 in Electrical Characteristics: BOR (see Table 26-5).<br><br>Updated Note 2 in the DC Characteristics: Operating Current ($I_{DD}$) (see Table 26-6).<br><br>Updated Note 2 in the DC Characteristics: Idle Current ($I_{IDLE}$) (see Table 26-7).<br><br>Updated Note 2 and Parameters DC60C and DC61a-DC61d in the DC Characteristics: Power-Down Current ($I_{PD}$) (see Table 26-8).<br><br>Updated Note 2 in the DC Characteristics: Doze Current ($I_{DOZE}$) (see Table 26-9).<br><br>Added Note 1 to the Internal Voltage Regulator Specifications (see Table 26-13).<br><br>Updated the Minimum and Maximum values for Parameter F20a and the Typical value for Parameter F20b in AC Characteristics: Internal Fast RC (FRC) Accuracy (see Table 26-18).<br><br>Updated the Minimum, Typical, and Maximum values for Parameter F21a and F21b in Internal Low-Power RC (LPRC) Accuracy (see Table 26-19).<br><br>Updated the Minimum, Typical, and Maximum values for Parameter D305 in the Comparator Module Specifications (see Table 26-43).<br><br>Added Parameters CTMUFV1 and CTMUFV2 and updated Note 1 and the Conditions for all parameters in the CTMU Current Source Specifications (see Table 26-46).<br><br>Added Forward Voltage Versus Temperature (see Figure 26-25). |

## Revision D (April 2012)

This revision includes updates in support of the following new devices:

- dsPIC33FJ32GP101
- dsPIC33FJ32GP102
- dsPIC33FJ32GP104
- dsPIC33FJ32MC101
- dsPIC33FJ32MC102
- dsPIC33FJ32MC104

Also, where applicable, new sections were added to peripheral chapters that provide information and links to the related resources, as well as helpful tips. For examples, see **Section 18.1 "UART Helpful Tips"** and **Section 18.2 "UART Resources"**.

This revision includes text and formatting changes that were incorporated throughout the document.

All other major changes are referenced by their respective section in Table A-3.

**TABLE A-3: MAJOR SECTION UPDATES**

| Section Name | Update Description |
|---|---|
| **"16-Bit Digital Signal Controllers (up to 32-Kbyte Flash and 2-Kbyte SRAM)"** | The content on the first page of this section was extensively reworked to provide the reader with the key features and functionality of this device family in an "at-a-glance" format.<br>**TABLE 2: "dsPIC33FJ32(GP/MC)101/102/104 Device Features"** was added, which provides a feature overview of the new devices.<br>All pin diagrams were updated (see **"Pin Diagrams"**). |
| **Section 1.0 "Device Overview"** | Updated the notes in the device family block diagram (see Figure 1-1).<br>Updated the following pinout I/O descriptions (Table 1-1):<br>• ANx<br>• CNx<br>• RAx<br>• RCx<br>• CVREFIN (formerly CVREF)<br>Relocated **1.1 "Referenced Sources"** to the previous chapter (see **"Referenced Sources"**). |
| **Section 2.0 "Guidelines for Getting Started with 16-bit Digital Signal Controllers"** | Updated the Recommended Minimum Connection diagram (see Figure 2-1). |
| **Section 4.0 "Memory Organization"** | Updated the existing Program Memory Map (see Figure 4-1) and added the Program Memory Map for dsPIC33FJ16(GP/MC)101/102 Devices (see Figure 4-1).<br>Updated the existing Data Memory Map (see Figure 4-4) and added the Data Memory Map for dsPIC33FJ32(GP/MC)101/102/104 Devices with 2-Kbyte RAM (see Figure 4-5).<br>The following Special Function Register maps were updated or added:<br>• TABLE 4-5: Change Notification Register Map for dsPIC33FJ32(GP/MC)104 Devices<br>• TABLE 4-6: Interrupt Controller Register Map<br>• TABLE 4-8: Timers Register Map for dsPIC33FJ32(GP/MC)10X Devices<br>• TABLE 4-15: ADC1 Register Map for dsPIC33FJXX(GP/MC)101 Devices<br>• TABLE 4-17: ADC1 Register Map for dsPIC33FJ32(GP/MC)104 Devices<br>• TABLE 4-22: Peripheral Pin Select Input Register Map<br>• TABLE 4-26: Peripheral Pin Select Output Register Map for dsPIC33FJ32(GP/MC)104 Devices<br>• TABLE 4-28: PORTA Register Map for dsPIC33FJ32(GP/MC)101/102 Devices<br>• TABLE 4-29: PORTA Register Map for dsPIC33FJ32(GP/MC)104 Devices<br>• TABLE 4-36: PORTC Register Map for dsPIC33FJ32(GP/MC)104 Devices<br>• TABLE 4-39: PMD Register Map |


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**TABLE A-3: MAJOR SECTION UPDATES (CONTINUED)**

| Section Name | Update Description |
|---|---|
| **Section 7.0 "Interrupt Controller"** | Updated the Interrupt Vectors (see Table 7-1).<br><br>The following registers were updated or added:<br>• Register 7-5: IFS0: Interrupt Flag Status Register 0<br>• Register 7-11: IEC1: Interrupt Enable Control Register 1<br>• Register 7-21: IPC6: Interrupt Priority Control Register 6 |
| **Section 9.0 "Power-Saving Features"** | Updated 9.5 PMD Control Registers. |
| **Section 10.0 "I/O Ports"** | Updated TABLE 10-1: Selectable Input Sources (Maps Input to Function)(1).<br><br>Updated TABLE 10-2: Output Selection for Remappable Pin (RPn)<br><br>The following registers were updated or added:<br>• Register 10-4: RPINR4: Peripheral Pin Select Input Register 4<br>• Register 10-6: RPINR8: Peripheral Pin Select Input Register 8<br>• Register 10-19: RPOR8: Peripheral Pin Select Output Register 8<br>• Register 10-20: RPOR9: Peripheral Pin Select Output Register 9<br>• Register 10-21: RPOR10: Peripheral Pin Select Output Register 10<br>• Register 10-22: RPOR11: Peripheral Pin Select Output Register 11<br>• Register 10-23: RPOR12: Peripheral Pin Select Output Register 12 |
| **Section 12.0 "Timer2/3 and Timer4/5"** | The features and operation information was extensively updated in support of Timer4/5 (see **Section 12.1 "32-Bit Operation"** and **Section 12.2 "16-Bit Operation"**).<br><br>The block diagrams were updated in support of the new timers (see Figure 12-1, Figure 12-2, and Figure 12-3).<br><br>The following registers were added:<br>• Register 12-3: T4CON: Timer4 Control Register(1)<br>• Register 12-4: T5CON: Timer5 Control Register(1) |
| **Section 15.0 "Motor Control PWM Module"** | Updated TABLE 15-1: Internal Pull-down resistors on PWM Fault pins.<br><br>Note 2 was added to Register 15-5: PWMXCON1: PWMx Control Register 1(1). |
| **Section 19.0 "10-Bit Analog-to-Digital Converter (ADC)"** | The number of available input pins and channels were updated from six to 14.<br><br>Updated FIGURE 19-1: ADC1 Block Diagram for dsPIC33FJXX(GP/MC)101 Devices.<br><br>Updated FIGURE 19-2: ADC1 Block Diagram for dsPIC33FJXX(GP/MC)102 Devices.<br><br>Added FIGURE 19-3: ADC1 Block Diagram for dsPIC33FJ32(GP/MC)104 Devices.<br><br>The following registers were updated:<br>• Register 19-4: AD1CHS123: ADC1 Input Channel 1, 2, 3 Select Register<br>• Register 19-5: AD1CHS0: ADC1 INPUT Channel 0 select Register<br>• Register 19-6: AD1CSSL: ADC1 Input Scan Select Register Low(1,2,3)<br>• Register 19-7: AD1PCFGL: ADC1 Port Configuration Register Low(1,2,3) |

**TABLE A-3: MAJOR SECTION UPDATES (CONTINUED)**

| Section Name | Update Description |
|---|---|
| **Section 26.0 "Electrical Characteristics"** | Updated the Absolute Maximum Ratings.<br>Updated TABLE 26-3: Thermal Packaging Characteristics.<br>Updated TABLE 26-6: DC Characteristics: Operating Current (Idd).<br>Updated TABLE 26-7: DC Characteristics: Idle Current (Iidle).<br>Updated TABLE 26-8: DC Characteristics: Power-Down Current (Ipd).<br>Updated TABLE 26-9: DC Characteristics: Doze Current (Idoze).<br>Updated TABLE 26-10: DC Characteristics: I/O Pin Input Specifications.<br>Replaced all SPI specifications and figures (see Table 26-29 through Table 26-44 and Figure 26-11 through Figure 26-26). |
| **Section 28.0 "Packaging Information"** | Added the following Package Marking Information and Package Drawings:<br>• 44-Lead TQFP<br>• 44-Lead QFN<br>• 44-Lead VTLA (referred to as TLA in the package drawings) |


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### Revision E (September 2012)

This revision includes updates to the values in **Section 26.0 "Electrical Characteristics"** and updated packaging diagrams in **Section 28.0 "Packaging Information"**. There are minor text edits throughout the document.

### Revision F (January 2014)

This revision adds the High-Temperature Electrical Characteristics chapter and updated packaging diagrams in **Section 28.0 "Packaging Information"**. There are minor text edits throughout the document.

**NOTES:**


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# INDEX


## A

Absolute Maximum Ratings ..... 281
AC Characteristics ..... 294
  10-Bit ADC Specifications ..... 333
  ADC Specifications ..... 332
  Internal Fast RC (FRC) Accuracy ..... 296, 342
  Internal Low-Power RC (LPRC) Accuracy ..... 296, 342
  Load Conditions ..... 294
  PLL Clock ..... 296
  Temperature and Voltage Specifications ..... 294
ADC
  Control Registers ..... 222
  Helpful Tips ..... 221
  Initialization ..... 217
  Key Features ..... 217
  Resources ..... 221
Alternate Interrupt Vector Table (AIVT) ..... 95
Analog-to-Digital Converter (ADC) ..... 217
Arithmetic Logic Unit (ALU) ..... 43

## B

Bit-Reversed Addressing ..... 76
  Example ..... 77
  Implementation ..... 76
  Sequence Table (16-Entry) ..... 77
Block Diagrams
  16-Bit Timer1 Module ..... 165
  6-Channel PWM1 Module ..... 182
  ADC1 Conversion Clock Period ..... 221
  ADC1 for dsPIC33FJ32(GP/MC)104 Devices ..... 220
  ADC1 for dsPIC33FJXX(GP/MC)101 Devices ..... 218
  ADC1 for dsPIC33FJXX(GP/MC)102 Devices ..... 219
  Comparator I/O Operating Modes ..... 231
  Comparator Voltage Reference ..... 232
  Connections for On-Chip Voltage Regulator ..... 266
  CTMU Module ..... 256
  Digital Filter Interconnect ..... 233
  DSP Engine ..... 44
  dsPIC33FJXX(GP/MC)10X CPU Core ..... 38
  dsPIC33FJXX(GP/MC)10X Devices ..... 28
  $I^2C$ Module ..... 204
  Input Capture x Module ..... 175
  MCLR Pin Connections ..... 34
  Multiplexing of Remappable Output for RPn ..... 144
  Oscillator System ..... 125
  Output Compare x Module ..... 177
  Real-Time Clock and Calendar (RTCC) Module ..... 243
  Recommended Minimum Connection ..... 34
  Remappable MUX Input for U1RX ..... 142
  Reset System ..... 87
  Shared Port Structure ..... 140
  SPIx Module ..... 197
  Timer2 and Timer4 (16-Bit) ..... 169
  Timer2/3 and Timer4/5 (32-Bit) ..... 168
  Timer3 and Timer5 (16-Bit) ..... 169
  UARTx Simplified ..... 211
  User-Programmable Blanking Function ..... 232
  Watchdog Timer (WDT) ..... 267
Brown-out Reset (BOR) ..... 266

## C

Charge Time Measurement Unit. *See* CTMU.
Clock Switching ..... 132
  Enabling ..... 132
  Sequence ..... 132
Code Examples
  Assembly Code for Write-Protected Register Unlock, Fault Clearing Sequence ..... 184
  C Code for Write-Protected Register Unlock, Fault Clearing Sequence ..... 184
  Port Write/Read ..... 141
  PWRSAV Instruction Syntax ..... 133
  Setting the RTCWREN Bit ..... 244
Comparator ..... 231
  Control Registers ..... 234
Configuration Bits ..... 261
  Description ..... 263
CPU
  Control Registers ..... 40
  Data Addressing
    Overview ..... 37
  DSP Engine ..... 43
    Adder/Subtracter
      Overflow and Saturation ..... 45
    Barrel Shifter ..... 47
    Data Accumulators
      Write Back ..... 46
    Data Accumulators and Adder/Subtracter ..... 45
    Multiplier ..... 45
    Overview ..... 37
  Special MCU Features ..... 38
CPU Clocking System ..... 126
  Clock Selection ..... 126
  Clock Sources ..... 126
  Configuration Bit Values for Clock Selection ..... 127
  PLL Configuration ..... 127
CTMU
  Control Registers ..... 257
Customer Change Notification Service ..... 387
Customer Notification Service ..... 387
Customer Support ..... 387

## D

Data Address Space ..... 52
  Memory Map for dsPIC33FJ16(GP/MC)101/102 Devices, 1-Kbyte RAM ..... 53
  Memory Map for dsPIC33FJ32(GP/MC)101/102/104 Devices, 2-Kbyte RAM ..... 54
  Near Data Space ..... 52
  Organization and Alignment ..... 52
  SFR Space ..... 52
  Software Stack ..... 73
  Width ..... 52
  X and Y Spaces ..... 55

DC Characteristics ..... 282
Brown-out Reset (BOR) ..... 283
Doze Current (IDOZE) ..... 289, 342
High Temperature ..... 340
I/O Pin Input Specifications ..... 290
I/O Pin Output Specifications ..... 292
Idle Current (IIDLE) ..... 286, 341
Operating Current (IDD) ..... 284, 340, 341
Operating MIPS vs. Voltage ..... 282, 340
Power-Down Current (IPD) ..... 288, 341
Program Memory ..... 293
Temperature and Voltage Specifications ..... 283
Thermal Operating Conditions ..... 282, 340
Thermal Packaging ..... 282
Development Support ..... 277
Assembler
MPASM Assembler ..... 278
C Compilers
MPLAB XC ..... 278
Demonstration/Development Boards ..... 280
Evaluation and Starter Kits ..... 280
MPLAB Assembler, Linker, Librarian ..... 278
MPLAB ICD 3 In-Circuit Debugger System ..... 279
MPLAB PM3 Device Programmer ..... 279
MPLAB REAL ICE In-Circuit Emulator System ..... 279
MPLAB X Integrated Development
Environment Software ..... 277
MPLINK Object Linker/MPLIB Object Librarian ..... 278
PICkit 3 In-Circuit Debugger/Programmer ..... 279
Software Simulator (MPLAB X SIM) ..... 279
Third-Party Development Tools ..... 280
Doze Mode ..... 134
dsPIC33FJ16(GP/MC)101/102
Device Features ..... 2
dsPIC33FJ32(GP/MC)101/102/104
Device Features ..... 3

## E

Electrical Characteristics ..... 281
Equations
Device Operating Frequency ..... 126
Flash Programming Time ..... 84
Maximum Row Write Time ..... 84
Minimum Row Write Time ..... 84
MS with PLL Mode ..... 127
Errata ..... 24

## F

Flash Program Memory ..... 83
Control Registers ..... 85
Operations ..... 84
Programming Algorithm ..... 84
RTSP Operation ..... 84
Table Instructions ..... 83

## G

Getting Started with 16-Bit DSCs ..... 33
Analog and Digital Pins Configuration
During ICSP ..... 36
Connection Requirements ..... 33
Decoupling Capacitors ..... 33
External Oscillator Pins ..... 35
ICSP Pins ..... 35
Master Clear (MCLR) Pin ..... 34
Oscillator Value Conditions on Start-up ..... 36
Unused I/Os ..... 36

## H

High-Temperature Electrical Characteristics ..... 339

## I

I/O Ports ..... 139
Configuring Analog Port Pins ..... 141
Open-Drain Configuration ..... 141
Parallel I/O (PIO) ..... 139
Write/Read Timing ..... 141
I2C
Control Registers ..... 205
Operating Modes ..... 203
Registers ..... 203
In-Circuit Debugger ..... 268
In-Circuit Serial Programming (ICSP) ..... 268
Input Capture ..... 175
Control Register ..... 176
Input Change Notification (ICN) ..... 141
Instruction Addressing Modes ..... 73
File Register Instructions ..... 73
Fundamental Modes Supported ..... 74
MAC Instructions ..... 74
MCU Instructions ..... 73
Move and Accumulator Instructions ..... 74
Other Instructions ..... 74
Instruction Set
Summary ..... 269
Overview ..... 272
Symbols Used in Opcode Descriptions ..... 270
Instruction-Based Power-Saving Modes ..... 133
Idle ..... 134
Sleep ..... 133
Internet Address ..... 387
Interrupt Controller ..... 95
Interrupt Registers
IECx ..... 98
IFSx ..... 98
INTCON1 ..... 98
INTCON2 ..... 98
INTTREG ..... 98
IPCx ..... 98
Interrupt Setup Procedures ..... 124
Initialization ..... 124
Interrupt Disable ..... 124
Interrupt Service Routine (ISR) ..... 124
Trap Service Routine (TSR) ..... 124
Interrupt Vectors ..... 97
Reset Sequence ..... 95
Interrupt Vector Table (IVT) ..... 95
Interrupts Coincident with Power Save Instructions ..... 134

## L

LPRC Oscillator
Use with WDT ..... 267

## M

Memory Organization ..... 49
Microchip Internet Web Site ..... 387
Modulo Addressing ..... 75
Applicability ..... 76
Operation Example ..... 75
Start and End Address ..... 75
W Address Register Selection ..... 75


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Motor Control PWM ..... 181
6-Channel PWM1 Module ..... 181
Control Registers ..... 185
Faults ..... 183
At Reset ..... 183
Write-Protected Registers ..... 183

**O**

Oscillator Configuration
Control Registers ..... 128
Output Compare ..... 177
Control Register ..... 179
Modes ..... 178
Active-High One-Shot ..... 178
Active-Low One-Shot ..... 178
Continuous Pulse ..... 178
Delayed One-Shot ..... 178
Module Disabled ..... 178
PWM with Fault Protection ..... 178
PWM without Fault Protection ..... 178
Toggle ..... 178

**P**

Packaging ..... 343
Details ..... 346
Marking ..... 343, 344, 345
Peripheral Module Disable (PMD) ..... 134
Peripheral Pin Select (PPS) ..... 142
Available Pins ..... 142
Controlling ..... 142
Controlling Configuration Changes ..... 145
Helpful Tips ..... 146
I/O Resources ..... 146
Input Mapping ..... 142
Input Selection Sources for Remappable Pin (RPn) ..... 143
Output Mapping ..... 144
Output Selection Sources for Remappable Pin (RPn) ..... 144
Registers ..... 147
Pin Diagrams ..... 4
Pinout I/O Descriptions (table) ..... 29
PORTA
Register Map ..... 70
Power-Saving Features ..... 133
Clock Frequency and Switching ..... 133
Program Address Space ..... 49
Construction ..... 78
Data Access from Program Memory Using Table Instructions ..... 80
Data Access from, Address Generation ..... 79
Memory Map
dsPIC33FJ16(GP/MC)101/102 Devices ..... 49
dsPIC33FJ32(GP/MC)101/102/104 Devices ..... 50
PSV Operation ..... 81
Reading Data Using Program Space Visibility ..... 81
Table Read Instructions
TBLRDH ..... 80
TBLRDL ..... 80
Program Memory
Interrupt Vector ..... 51
Organization ..... 51
Reset Vector ..... 51
Programmer's Model ..... 39

**R**

Real-Time Clock and Calendar (RTCC) ..... 243
Register Maps
6-Output PWM1, dsPIC33FJXXMC10X Devices ..... 61
ADC1, dsPIC33FJ32(GP/MC)104 Devices ..... 65
ADC1, dsPIC33FJXX(GP/MC)101 Devices ..... 63
ADC1, dsPIC33FJXX(GP/MC)102 Devices ..... 64
Change Notification, dsPIC33FJ32(GP/MC)104 Devices ..... 58
Change Notification, dsPIC33FJXX(GP/MC)102 Devices ..... 58
Change Notification, dsPIC33FJXXGP101 Devices ..... 58
Change Notification, dsPIC33FJXXMC101 Devices ..... 58
Comparator ..... 67
Configuration Flash Words
dsPIC33FJ16(GP/MC)10X Devices ..... 262
dsPIC33FJ32(GP/MC)10X Devices ..... 262
Configuration Shadow Registers ..... 262
CPU Core ..... 56
CTMU ..... 66
I2C1 ..... 62
Input Capture ..... 61
Interrupt Controller ..... 59
NVM ..... 72
Output Compare ..... 61
PAD Configuration ..... 66
PMD ..... 72
PORTA, dsPIC33FJ16(GP/MC)101/102 Devices ..... 69
PORTA, dsPIC33FJ32(GP/MC)101/102 Devices ..... 69
PORTA, dsPIC33FJ32(GP/MC)104 Devices ..... 70
PORTB, dsPIC33FJ16GP101 Devices ..... 70
PORTB, dsPIC33FJ16MC101 Devices ..... 70
PORTB, dsPIC33FJ32(GP/MC)102 and dsPIC33FJ32(GP/MC)104 Devices ..... 71
PORTB, dsPIC33FJ32GP101 Devices ..... 71
PORTB, dsPIC33FJ32MC101 Devices ..... 71
PORTB, dsPIC33FJXX(GP/MC)102 and dsPIC33FJ16(GP/MC)102 Devices ..... 70
PORTC, dsPIC33FJ32(GP/MC)104 Devices ..... 71
PPS Input ..... 67
PPS Output, dsPIC33FJ32(GP/MC)104 Devices ..... 69
PPS Output, dsPIC33FJXX(GP/MC)102 Devices ..... 68
PPS Output, dsPIC33FJXXGP101 Devices ..... 68
PPS Output, dsPIC33FJXXMC101 Devices ..... 68
Real-Time Clock and Calendar ..... 66
SPI1 ..... 62
System Control ..... 72
Timers, dsPIC33FJ16(GP/MC)10X Devices ..... 60
Timers, dsPIC33FJ32(GP/MC)10X Devices ..... 60
UART1 ..... 62
Registers
AD1CHS0 (ADC1 Input Channel 0 Select) ..... 227
AD1CHS123 (ADC1 Input Channel 1, 2, 3 Select) ..... 226
AD1CON1 (ADC1 Control 1) ..... 222
AD1CON2 (ADC1 Control 2) ..... 224
AD1CON3 (ADC1 Control 3) ..... 225
AD1CSSL (ADC1 Input Scan Select Low) ..... 228
AD1PCFGL (ADC1 Port Configuration Low) ..... 229

ALCFGRPT (Alarm Configuration) ..... 248
ALRMVAL (Alarm Minutes and Seconds Value, ALRMPTR Bits = 00) ..... 254
ALRMVAL (Alarm Month and Day Value, ALRMPTR Bits = 10) ..... 252
ALRMVAL (Alarm Weekday and Hours Value, ALRMPTR Bits = 01) ..... 253
CLKDIV (Clock Divisor) ..... 130
CMSTAT (Comparator Status) ..... 234
CMxCON (Comparator x Control) ..... 235
CMxFLTR (Comparator x Filter Control) ..... 241
CMxMSKCON (Comparator x Mask Gating Control) ..... 239
CMxMSKSRC (Comparator x Mask Source Select) ..... 237
CORCON (Core Control) ..... 42, 99
CTMUCON1 (CTMU Control 1) ..... 257
CTMUCON2 (CTMU Control 2) ..... 258
CTMUICON (CTMU Current Control) ..... 259
CVRCON (Comparator Voltage Reference Control) ..... 242
DEVID (Device ID) ..... 265
DEVREV (Device Revision) ..... 265
I2CxCON (I2Cx Control) ..... 205
I2CxMSK (I2Cx Slave Mode Address Mask) ..... 209
I2CxSTAT (I2Cx Status) ..... 207
ICxCON (Input Capture x Control) ..... 176
IEC0 (Interrupt Enable Control 0) ..... 108
IEC1 (Interrupt Enable Control 1) ..... 109
IEC2 (Interrupt Enable Control 2) ..... 110
IEC3 (Interrupt Enable Control 3) ..... 110
IEC4 (Interrupt Enable Control 4) ..... 111
IFS0 (Interrupt Flag Status 0) ..... 103
IFS1 (Interrupt Flag Status 1) ..... 105
IFS2 (Interrupt Flag Status 2) ..... 106
IFS3 (Interrupt Flag Status 3) ..... 106
IFS4 (Interrupt Flag Status 4) ..... 107
INTCON1 (Interrupt Control 1) ..... 100
INTCON2 (Interrupt Control 2) ..... 102
INTTREG (Interrupt Control and Status) ..... 123
IPC0 (Interrupt Priority Control 0) ..... 112
IPC1 (Interrupt Priority Control 1) ..... 113
IPC14 (Interrupt Priority Control 14) ..... 119
IPC15 (Interrupt Priority Control 15) ..... 120
IPC16 (Interrupt Priority Control 16) ..... 121
IPC19 (Interrupt Priority Control 19) ..... 122
IPC2 (Interrupt Priority Control 2) ..... 114
IPC3 (Interrupt Priority Control 3) ..... 115
IPC4 (Interrupt Priority Control 4) ..... 116
IPC5 (Interrupt Priority Control 5) ..... 117
IPC6 (Interrupt Priority Control 6) ..... 117
IPC7 (Interrupt Priority Control 7) ..... 118
IPC9 (Interrupt Priority Control 9) ..... 119
NVMCON (Flash Memory Control) ..... 85
NVMKEY (Nonvolatile Memory Key) ..... 85
OCxCON (Output Compare x Control) ..... 179
OSCCON (Oscillator Control) ..... 128
OSCTUN (FRC Oscillator Tuning) ..... 131
PADCFG1 (Pad Configuration Control) ..... 247
PMD1 (Peripheral Module Disable Control 1) ..... 135
PMD2 (Peripheral Module Disable Control 2) ..... 136
PMD3 (Peripheral Module Disable Control 3) ..... 137
PMD4 (Peripheral Module Disable Control 4) ..... 137
PWMxCON1 (PWMx Control 1) ..... 188
PWMxCON2 (PWMx Control 2) ..... 189
PWMxKEY (PWMx Unlock) ..... 196
PxDC1 (PWMx Duty Cycle 1) ..... 195
PxDC2 (PWMx Duty Cycle 2) ..... 195
PxDC3 (PWMx Duty Cycle 3) ..... 195
PxDTCON1 (PWMx Dead-Time Control 1) ..... 190
PxDTCON2 (PWMx Dead-Time Control 2) ..... 191
PxFLTACON (PWMx Fault A Control) ..... 192
PxFLTBCON (PWMx Fault B Control) ..... 193
PxOVDCON (PWMx Override Control) ..... 194
PxSECMP (PWMx Special Event Compare) ..... 187
PxTCON (PWMx Time Base Control) ..... 185
PxTMR (PWMx Timer Count Value) ..... 186
PxTPER (PWMx Time Base Period) ..... 186
RCFGCAL (RTCC Calibration and Configuration) ..... 245
RCON (Reset Control) ..... 88
RPINR0 (Peripheral Pin Select Input 0) ..... 147
RPINR1 (Peripheral Pin Select Input 1) ..... 148
RPINR11 (Peripheral Pin Select Input 11) ..... 153
RPINR18 (Peripheral Pin Select Input 18) ..... 154
RPINR20 (Peripheral Pin Select Input 20) ..... 155
RPINR21 (Peripheral Pin Select Input 21) ..... 156
RPINR3 (Peripheral Pin Select Input 3) ..... 149
RPINR4 (Peripheral Pin Select Input 4) ..... 150
RPINR7 (Peripheral Pin Select Input 7) ..... 151
RPINR8 (Peripheral Pin Select Input 8) ..... 152
RPOR0 (Peripheral Pin Select Output 0) ..... 157
RPOR1 (Peripheral Pin Select Output 1) ..... 157
RPOR10 (Peripheral Pin Select Output 10) ..... 162
RPOR11 (Peripheral Pin Select Output 11) ..... 162
RPOR12 (Peripheral Pin Select Output 12) ..... 163
RPOR2 (Peripheral Pin Select Output 2) ..... 158
RPOR3 (Peripheral Pin Select Output 3) ..... 158
RPOR4 (Peripheral Pin Select Output 4) ..... 159
RPOR5 (Peripheral Pin Select Output 5) ..... 159
RPOR6 (Peripheral Pin Select Output 6) ..... 160
RPOR7 (Peripheral Pin Select Output 7) ..... 160
RPOR8 (Peripheral Pin Select Output 8) ..... 161
RPOR9 (Peripheral Pin Select Output 9) ..... 161
RTCVAL (RTCC Minutes and Seconds Value, RTCPTR Bits = 00) ..... 251
RTCVAL (RTCC Month and Day Value, RTCPTR Bits = 10) ..... 249
RTCVAL (RTCC Weekdays and Hours Value, RTCPTR Bits = 01) ..... 250
RTCVAL (RTCC Year Value, RTCPTR Bits = 11) ..... 249
SPIxCON1 (SPIx Control 1) ..... 200
SPIxCON2 (SPIx Control 2) ..... 202
SPIxSTAT (SPIx Status and Control) ..... 199
SR (CPU STATUS) ..... 40, 99
T1CON (Timer1 Control) ..... 166
T2CON (Timer2 Control) ..... 170
T3CON (Timer3 Control) ..... 171
T4CON (Timer4 Control) ..... 172
T5CON (Timer5 Control) ..... 173
UxMODE (UARTx Mode) ..... 213
UxSTA (UARTx Status and Control) ..... 215


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Resets ..... 87
BOR (Brown-out Reset) ..... 87
BOR and Power-up Timer (PWRT) ..... 92
CM (Configuration Mismatch Reset) ..... 87
Configuration Mismatch (CM) ..... 93
External (EXTR) ..... 93
Illegal Condition ..... 93
Illegal Opcode ..... 93
Security ..... 93, 94
Uninitialized W Register ..... 93, 94
IOPUWR (Illegal Condition Reset) ..... 87
Illegal Opcode ..... 87
Security ..... 87
Uninitialized W Register ..... 87
MCLR (Master Clear Pin) ..... 87
Oscillator Delays ..... 90
POR (Power-on Reset) ..... 87
Power-on Reset (POR) ..... 92
Software RESET Instruction (SWR) ..... 93
SWR (RESET Instruction) ..... 87
System
Cold Reset ..... 90
Warm Reset ..... 90
Trap Conflict ..... 93
TRAPR (Trap Conflict Reset) ..... 87
Watchdog Timer Time-out (WDTO) ..... 93
WDTO (Watchdog Timer Reset) ..... 87
Revision History ..... 373
RTCC
Control Registers ..... 245
Module Registers ..... 244
Register Mapping ..... 244

## S

Serial Peripheral Interface (SPI) ..... 197
Control Registers ..... 199
Helpful Tips ..... 198
Resources ..... 198
Software Stack Pointer, Frame Pointer
CALL Stack Frame ..... 73
Special Features ..... 261
Code Protection ..... 261
Flexible Configuration ..... 261
In-Circuit Emulation ..... 261
In-Circuit Serial Programming (ICSP) ..... 261
Watchdog Timer (WDT) ..... 261

## T

Timer1 ..... 165
Control Register ..... 166
Timer2/3 and Timer4/5 ..... 167
16-Bit Operation ..... 167
32-Bit Operation ..... 167
Control Registers ..... 170
Timing Diagrams
ADC Conversion Characteristics (CHPS<1:0> = 01, SIMSAM = 0, ASAM = 0, SSRC<2:0> = 000) ..... 334
ADC Conversion Characteristics (CHPS<1:0> = 01, SIMSAM = 0, ASAM = 1, SSRC<2:0> = 111, SAMC<4:0> = 00001) ..... 334
Brown-out Reset Situations ..... 92
CLKO and I/O ..... 297
External Clock ..... 295
I2Cx Bus Data (Master Mode) ..... 328
I2Cx Bus Data (Slave Mode) ..... 330
I2Cx Bus Start/Stop Bits (Master Mode) ..... 328
I2Cx Bus Start/Stop Bits (Slave Mode) ..... 330
Input Capture x (ICx) ..... 301
Motor Control PWMx ..... 303
Motor Control PWMx Fault ..... 303
OCx/PWMx ..... 302
Output Compare x (OCx) ..... 302
Output Compare x Operation ..... 178
Reset, Watchdog Timer, Oscillator Start-up Timer and Power-up Timer ..... 298
SPIx Master Mode (Full-Duplex, CKE = 0, CKP = x, SMP = 1) for dsPIC33FJ16(GP/MC)10X ..... 307
SPIx Master Mode (Full-Duplex, CKE = 0, CKP = x, SMP = 1) for dsPIC33FJ32(GP/MC)10X ..... 319
SPIx Master Mode (Full-Duplex, CKE = 1, CKP = x, SMP = 1) for dsPIC33FJ16(GP/MC)10X ..... 306
SPIx Master Mode (Full-Duplex, CKE = 1, CKP = x, SMP = 1) for dsPIC33FJ32(GP/MC)10X ..... 318
SPIx Master Transmit Mode (Half-Duplex, CKE = 0) for dsPIC33FJ16(GP/MC)10X ..... 304
SPIx Master Transmit Mode (Half-Duplex, CKE = 0) for dsPIC33FJ32(GP/MC)10X ..... 316
SPIx Master Transmit Mode (Half-Duplex, CKE = 1) for dsPIC33FJ16(GP/MC)10X ..... 305
SPIx Master Transmit Mode (Half-Duplex, CKE = 1) for dsPIC33FJ32(GP/MC)10X ..... 317
SPIx Slave Mode (Full-Duplex, CKE = 0, CKP = 0, SMP = 0) for dsPIC33FJ16(GP/MC)10X ..... 314
SPIx Slave Mode (Full-Duplex, CKE = 0, CKP = 0, SMP = 0) for dsPIC33FJ32(GP/MC)10X ..... 326
SPIx Slave Mode (Full-Duplex, CKE = 0, CKP = 1, SMP = 0) for dsPIC33FJ16(GP/MC)10X ..... 312
SPIx Slave Mode (Full-Duplex, CKE = 0, CKP = 1, SMP = 0) for dsPIC33FJ32(GP/MC)10X ..... 324
SPIx Slave Mode (Full-Duplex, CKE = 1, CKP = 0, SMP = 0) for dsPIC33FJ16(GP/MC)10X ..... 308
SPIx Slave Mode (Full-Duplex, CKE = 1, CKP = 0, SMP = 0) for dsPIC33FJ32(GP/MC)10X ..... 320
SPIx Slave Mode (Full-Duplex, CKE = 1, CKP = 1, SMP = 0) for dsPIC33FJ16(GP/MC)10X ..... 310
SPIx Slave Mode (Full-Duplex, CKE = 1, CKP = 1, SMP = 0) for dsPIC33FJ32(GP/MC)10X ..... 322
System Reset ..... 91
Timer1/2/3 External Clock ..... 299
Timing Requirements
10-Bit ADC Conversion ..... 335
Capacitive Loading on Output Pins ..... 294
CLKO and I/O ..... 297
External Clock ..... 295
I2Cx Bus Data (Master Mode) ..... 329
I2Cx Bus Data (Slave Mode) ..... 331
Input Capture x (ICx) ..... 301
Motor Control PWMx ..... 303
Output Compare x (OCx) ..... 302
Reset, Watchdog Timer, Oscillator Start-up Timer, Power-up Timer and Brown-out Reset ..... 298
Simple OCx/PWMx Mode ..... 302
SPIx Master Mode (Full-Duplex, CKE = 0, CKP = x, SMP = 1) for dsPIC33FJ16(GP/MC)10X ..... 307
SPIx Master Mode (Full-Duplex, CKE = 0, CKP = x, SMP = 1) for dsPIC33FJ32(GP/MC)10X ..... 319
SPIx Master Mode (Full-Duplex, CKE = 1, CKP = x, SMP = 1) for dsPIC33FJ16(GP/MC)10X ..... 306
SPIx Master Mode (Full-Duplex, CKE = 1, CKP = x, SMP = 1) for dsPIC33FJ32(GP/MC)10X ..... 318

SPIx Master Transmit Mode (Half-Duplex) for dsPIC33FJ16(GP/MC)10X ..... 305
SPIx Master Transmit Mode (Half-Duplex) for dsPIC33FJ32(GP/MC)10X ..... 317
SPIx Slave Mode (Full-Duplex, CKE = 0, CKP = 0, SMP = 0) for dsPIC33FJ16(GP/MC)10X ..... 315
SPIx Slave Mode (Full-Duplex, CKE = 0, CKP = 0, SMP = 0) for dsPIC33FJ32(GP/MC)10X ..... 327
SPIx Slave Mode (Full-Duplex, CKE = 0, CKP = 1, SMP = 0) for dsPIC33FJ16(GP/MC)10X ..... 313
SPIx Slave Mode (Full-Duplex, CKE = 0, CKP = 1, SMP = 0) for dsPIC33FJ32(GP/MC)10X ..... 325
SPIx Slave Mode (Full-Duplex, CKE = 1, CKP = 0, SMP = 0) for dsPIC33FJ16(GP/MC)10X ..... 309
SPIx Slave Mode (Full-Duplex, CKE = 1, CKP = 0, SMP = 0) for dsPIC33FJ32(GP/MC)10X ..... 321
SPIx Slave Mode (Full-Duplex, CKE = 1, CKP = 1, SMP = 0) for dsPIC33FJ16(GP/MC)10X ..... 311
SPIx Slave Mode (Full-Duplex, CKE = 1, CKP = 1, SMP = 0) for dsPIC33FJ32(GP/MC)10X ..... 323
Timer1 External Clock ..... 299
Timer2/4 External Clock ..... 300
Timer3/5 External Clock ..... 300
Timing Specifications
Comparator Module ..... 336
Comparator Timing ..... 336
Comparator Voltage Reference ..... 337
Comparator Voltage Reference Settling Time ..... 336
CTMU Current Source ..... 337

## U

UART
Control Registers ..... 213
Helpful Tips ..... 212
Resources ..... 212
Universal Asynchronous Receiver Transmitter (UART) ..... 211
Using the RCON Status Bits ..... 94

## V

Voltage Regulator (On-Chip) ..... 266

## W

Watchdog Timer (WDT) ..... 267
Programming Considerations ..... 267
WWW Address ..... 387
WWW, On-Line Support ..... 24


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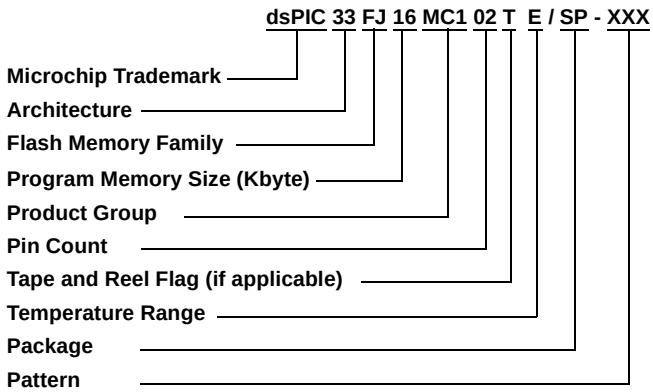


| | | | |
|---|---|---|---|
| Architecture: | 33 | = | 16-bit Digital Signal Controller |
| Flash Memory Family: | FJ | = | Flash program memory, 3.3V |
| Product Group: | GP1 | = | General Purpose family |
| | MC1 | = | Motor Control family |
| Pin Count: | 01 | = | 18-pin and 20-pin |
| | 02 | = | 28-pin and 32-pin |
| Temperature Range: | I | = | -40°C to +85°C (Industrial) |
| | E | = | -40°C to +125°C (Extended) |
| Package: | P | = | Plastic Dual In-Line - 300 mil body (PDIP) |
| | SS | = | Plastic Shrink Small Outline - 5.3 mm body (SSOP) |
| | SP | = | Skinny Plastic Dual In-Line - 300 mil body (SPDIP) |
| | SO | = | Plastic Small Outline - Wide - 7.50 mil body (SOIC) |
| | ML | = | Plastic Quad, No Lead - (28-pin) 6x6 mm body (QFN) |
| | PT | = | Plastic Thin Quad Flatpack - (44-pin) 10x10 mm body (TQFP) |
| | TL | = | Very Thin Leadless Array - (36-pin) 5x5 mm body (VTLA) |

**Examples:**

a) dsPIC33FJ16MC102-E/SP: Motor Control dsPIC33, 16-Kbyte Program Memory, 28-Pin, Extended Temperature, SPDIP package.

**NOTES:**


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